TOSHIBA

TOSHIBA Original CMOS 32-Bit Microcontroller

TLCS-900/H1 Series

TMP92CA25FG

TOSHIBA CORPORATION

Semiconductor Company

Preface

Thank you very much for making use of Toshiba microcomputer LSIs.
Before use this LSI, refer the section, “Points of Note and Restrictions”.

CMOS 32-bit Microcontroller

TMP92CA25FG/JTMP92CA25

1. Outline and Device Characteristics

The TMP92CA25 is a high-speed advanced 32-bit Microcontroller developed for controlling equipment which processes mass data.

The TMP92CA25 has a high-performance CPU (900/H1 CPU) and various built-in I/Os.

The TMP92CA25FG is housed in a 144-pin flat package. The JTMP92CA25 is a chip form product.

Device characteristics are as follows:

(1) CPU: 32-bit CPU (900/H1 CPU)

- Compatible with TLCS-900/L1 instruction code
- 16 Mbytes of linear address space
- General-purpose register and register banks
- Micro DMA: 8 channels (250 ns/4 bytes at f_{SYS} = 20 MHz, best case)

(2) Minimum instruction execution time: 50 ns (at f_{SYS} = 20 MHz)

RESTRICTIONS ON PRODUCT USE 070208EBP

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(3) Internal memory
- Internal RAM: 10 Kbytes (can be used for program, data and display memory)
- Internal ROM: 0 Kbytes (used as boot program)

(4) External memory expansion
- Expandable up to 512 Mbytes (shared program/data area)
- Can simultaneously support 8,- 16- or 32-bit width external data bus ... dynamic data bus sizing

(5) Memory controller
- Chip select output: 4 channels

(6) 8-bit timers: 4 channels

(7) 16-bit timer/event counter: 1 channel

(8) General-purpose serial interface: 1 channels
- UART/synchronous mode
- IrDA ver.1.0 (115 kbps) mode selectable

(9) Serial bus interface: 1 channel: 1 channel
- I^2C bus mode only

(10) I^2S (Inter-IC sound) interface: 1 channel
- I^2S bus mode/SIO mode selectable (Master, transmission only)
- 32-byte FIFO buffer

(11) LCD controller
- Supports monochrome for STN
- Built-in RAM LCD driver

(12) SPI controller
- Supported only SPI mode for SD card

(13) SDRAM controller: 1 channel
- Supports 16 M, 64 M, 128 M, 256 M, and up to 512-Mbit SDR (Single Data Rate)-SDRAM
- Supported not only operate as RAM and Data for LCD display but also programming directly from SDRAM

(14) Timer for real-time clock (RTC)
- Based on TC8521A

(15) Key-on wakeup (Interrupt key input)

(16) 10-bit AD converter (Built-in Sample Hold circuit): 4 channels

(17) Touch screen interface
- Available to reduce external components

(18) Watchdog timer

(19) Melody/alarm generator
- Melody: Output of clock 4 to 5461 Hz
- Alarm: Output of 8 kinds of alarm pattern and 5 kinds of interval interrupt

(20) MMU

- Expandable up to 512 Mbytes (3 local area/8 bank method)
- Independent bank for each program, read data, write data and LCD display data

(21) Interrupts: 49 interrupt

- 9 CPU interrupts: Software interrupt instruction and illegal instruction
- 34 internal interrupts: Seven selectable priority levels
- 7 external interrupts: Seven selectable priority levels (6-edge selectable)

(21) Input/output ports: 84 pins (Except Data bus (16bit), Address bus (24bit) and $\overline{RD}$ pin)

(22) NAND flash interface: 2 channels

- Direct NAND flash connection capability
- ECC (error detection) calculation (for SLC- type)

(23) Stand-by function

- Three HALT modes: IDLE2 (programmable), IDLE1, STOP
- Each pin status programmable for stand-by mode

(24) Triple-clock controller

- Clock doubler (PLL) supplies 40 system-clock from external 10MHz oscillator to CPU
- Clock gear function: Select high-frequency clock fc to fc/16
- RTC (fs = 32.768 kHz)

(25) Operating voltage:

- VCC = 3.0 V to 3.6 V (fc max = 40 MHz)
- VCC = 2.7 V to 3.6 V (fc max = 27 MHz)

(26) Package:

- 144-pin QFP (P-LQFP144 -1616-0.40C)
- 144-pin chip form is also available. For details, contact your local Toshiba sales representative.

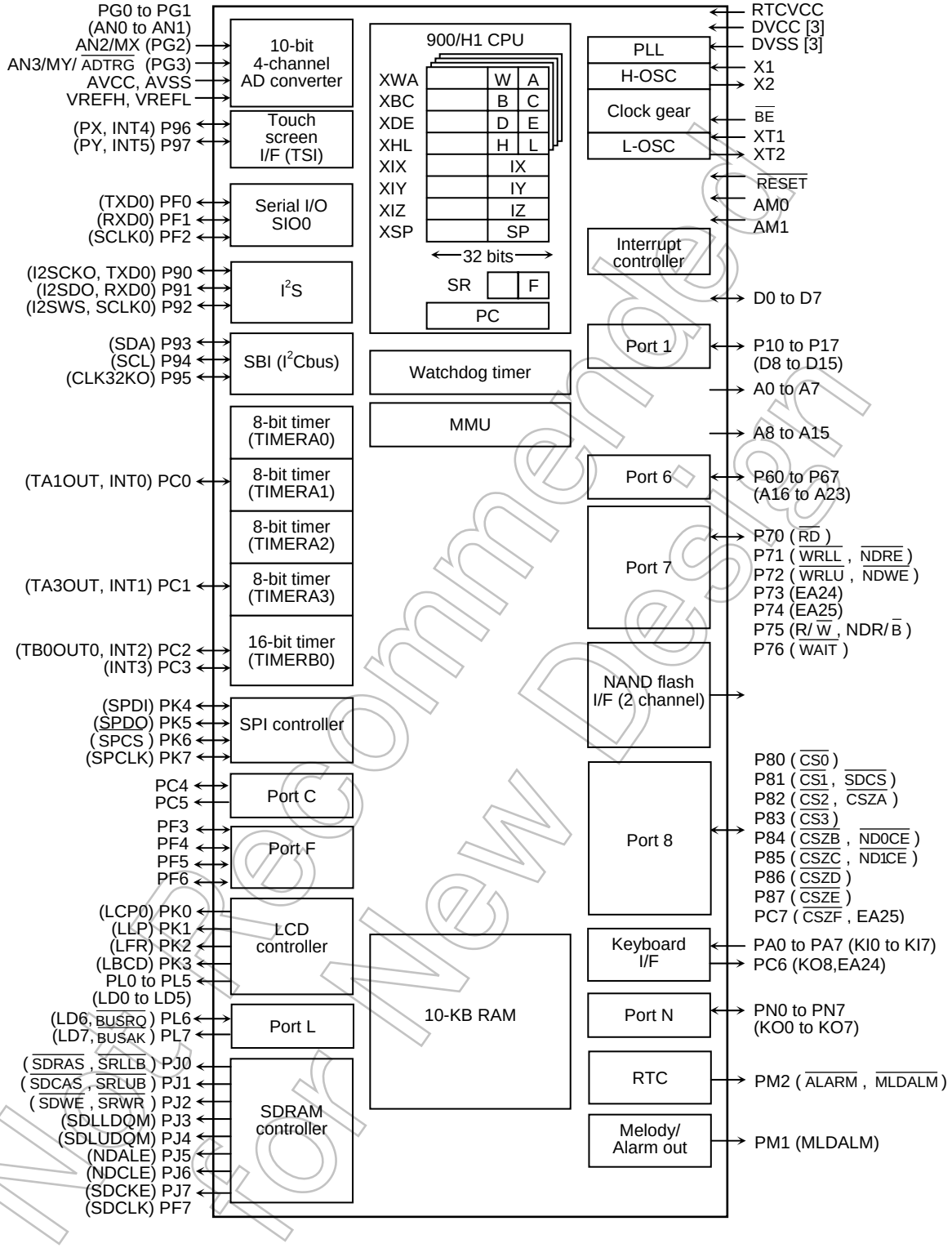


Figure 1.1 TMP92CA25 Block Diagram

2. Pin Assignment and Functions

The assignment of input/output pins for the TMP92CA25FG, their names and functions are as follows:

2.1 Pin Assignment

Figure 2.1.1 shows the pin assignment of the TMP92CA25FG.

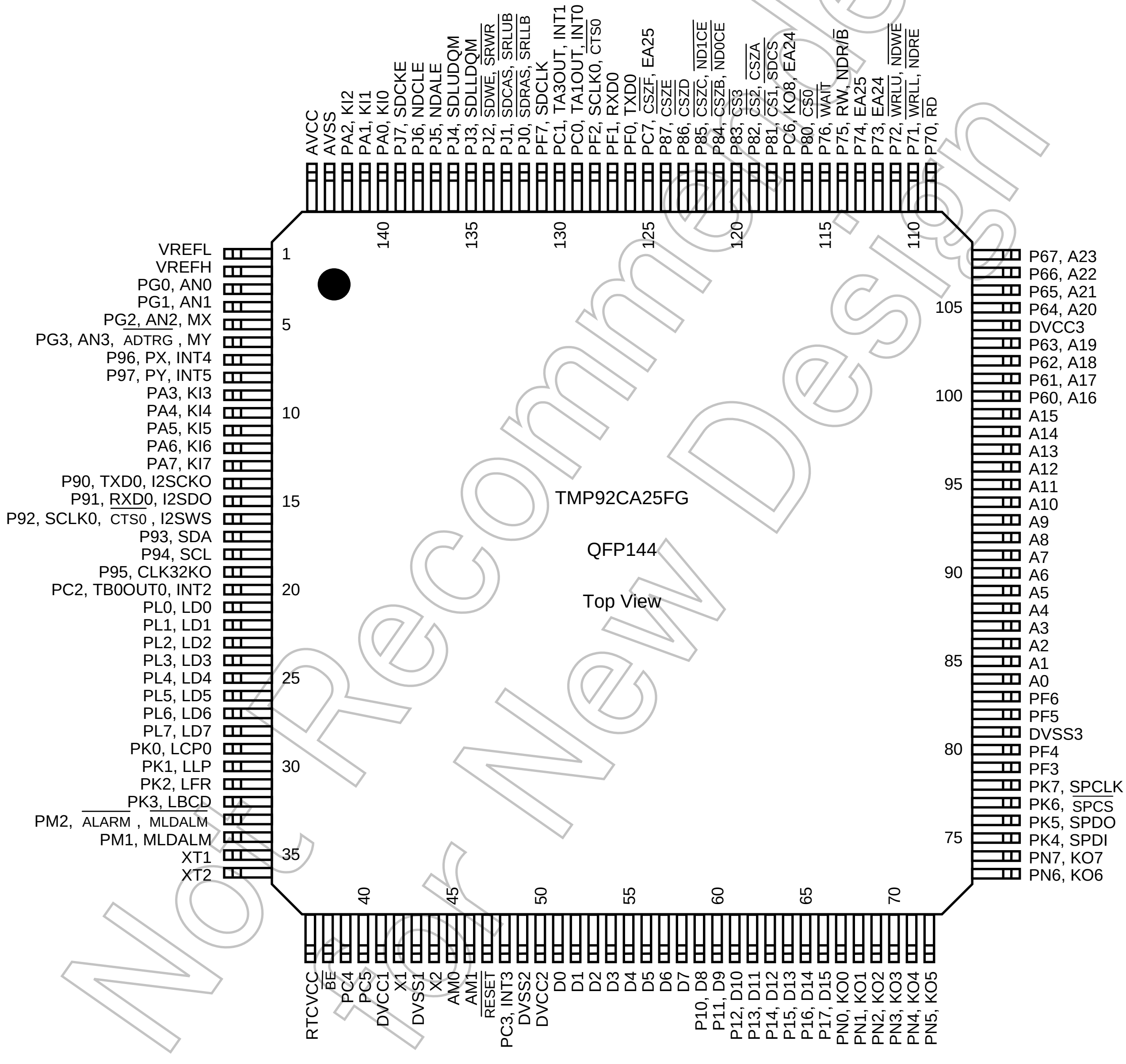


Figure 2.1.1 Pin Assignment Diagram (144-pin QFP)

2.2 PAD Assignment

(Chip size 4.98 mm × 5.61 mm)

Table 2.2.1 Pad Assignment Diagram (144-pin chip)

Unit: μm

Pin No.	Name	X point	Y point	Pin No.	Name	X point	Y point	Pin No.	Name	X point	Y point
1	VREFL	−2363	2309	49	DVSS2	−447	−2678	97	A13	2359	822
2	VREFH	−2363	2189	50	DVCC2	−297	−2678	98	A14	2359	939
3	PG0	−2363	1934	51	D0	−172	−2678	99	A15	2359	1055
4	PG1	−2363	1593	52	D1	−72	−2678	100	P60	2359	1171
5	PG2	−2363	1493	53	D2	28	−2678	101	P61	2359	1288
6	PG3	−2363	1393	54	D3	128	−2678	102	P62	2359	1400
7	P96	−2363	1293	55	D4	228	−2678	103	P63	2359	1514
8	P97	−2363	1192	56	D5	328	−2678	104	DVCC3	2359	1643
9	PA3	−2363	1088	57	D6	429	−2678	105	P64	2359	1779
10	PA4	−2363	988	58	D7	529	−2678	106	P65	2359	1902
11	PA5	−2363	888	59	P10	629	−2678	107	P66	2359	2027
12	PA6	−2363	788	60	P11	729	−2678	108	P67	2359	2309
13	PA7	−2363	688	61	P12	829	−2678	109	P70	1994	2675
14	P90	−2363	587	62	P13	929	−2678	110	P71	1874	2675
15	P91	−2363	487	63	P14	1029	−2678	111	P72	1753	2675
16	P92	−2363	387	64	P15	1129	−2678	112	P73	1633	2675
17	P93	−2363	287	65	P16	1229	−2678	113	P74	1527	2675
18	P94	−2363	187	66	P17	1329	−2678	114	P75	1420	2675
19	P95	−2363	87	67	PN0	1429	−2678	115	P76	1316	2675
20	PC2	−2363	−13	68	PN1	1529	−2678	116	P80	1211	2675
21	PL0	−2363	−113	69	PN2	1630	−2678	117	PC6	1104	2675
22	PL1	−2363	−213	70	PN3	1753	−2678	118	P81	999	2675
23	PL2	−2363	−313	71	PN4	1873	−2678	119	P82	893	2675
24	PL3	−2363	−413	72	PN5	1994	−2678	120	P83	787	2675
25	PL4	−2363	−514	73	PN6	2359	−2313	121	P84	682	2675
26	PL5	−2363	−614	74	PN7	2359	−2049	122	P85	574	2675
27	PL6	−2363	−714	75	PK4	2359	−1708	123	P86	468	2675
28	PL7	−2363	−814	76	PK5	2359	−1587	124	P87	363	2675
29	PK0	−2363	−914	77	PK6	2359	−1472	125	PC7	259	2675
30	PK1	−2363	−1014	78	PK7	2359	−1359	126	PF0	154	2675
31	PK2	−2363	−1114	79	PF3	2359	−1243	127	PF1	50	2675
32	PK3	−2363	−1215	80	PF4	2359	−1131	128	PF2	−55	2675
33	PM2	−2363	−1473	81	DVSS3	2359	−1012	129	PC0	−158	2675
34	PM1	−2363	−1594	82	PF5	2359	−885	130	PC1	−261	2675
35	XT1	−2363	−1935	83	PF6	2359	−749	131	PF7	−364	2675
36	XT2	−2363	−2313	84	A0	2359	−639	132	PJ0	−467	2675
37	RTCVCC	−1986	−2678	85	A1	2359	−530	133	PJ1	−568	2675
38	$\overline{BE}$	−1853	−2678	86	A2	2359	−420	134	PJ2	−669	2675
39	PC4	−1732	−2678	87	A3	2359	−311	135	PJ3	−771	2675
40	PC5	−1612	−2678	88	A4	2359	−199	136	PJ4	−872	2675
41	DVCC1	−1499	−2678	89	A5	2359	−88	137	PJ5	−972	2675
42	X1	−1386	−2678	90	A6	2359	23	138	PJ6	−1074	2675
43	DVSS1	−1261	−2678	91	A7	2359	134	139	PJ7	−1175	2675
44	X2	−972	−2678	92	A8	2359	245	140	PA0	−1278	2675
45	AM0	−872	−2678	93	A9	2359	356	141	PA1	−1379	2675
46	AM1	−772	−2678	94	A10	2359	473	142	PA2	−1499	2675
47	$\overline{RESET}$	−672	−2678	95	A11	2359	589	143	AVSS	−1860	2675
48	PC3	−572	−2678	96	A12	2359	705	144	AVCC	−1985	2675

2.3 Pin Names and Functions

The following table shows the names and functions of the input/output pins

Table 2.3.1 Pin Names and Functions (1/5)

Pin Name	Number of Pins	I/O	Function
D0 to D7	8	I/O	Data: Data bus 0 to 7
P10 to P17 D8 to D15	8	I/O I/O	Port 1: I/O port input or output specifiable in units of bits Data: Data bus 8 to 15
A0 to A7	8	Output	Address: Address bus 0 to 7
A8 to A15	8	Output	Address: Address bus 8 to 15
P60 to P67 A16 to A23	8	I/O Output	Port 6: I/O port input or output specifiable in units of bits Address: Address bus 16 to 23
P70 $\overline{RD}$	1	Output Output	Port70: Output port Read: Outputs strobe signal to read external memory
P71 $\overline{WRLL}$ $\overline{NDRE}$	1	I/O Output Output	Port 71: I/O port Write: Output strobe signal for writing data on pins D0 to D7 NAND flash read: Outputs strobe signal to read external NAND flash
P72 $\overline{WRLU}$ $\overline{NDWE}$	1	I/O Output Output	Port 72: I/O port Write: Output strobe signal for writing data on pins D8 to D15 Write Enable for NAND flash
P73 EA24	1	Output Output	Port 73: Output port Extended Address 24
P74 EA25	1	Output Output	Port 74: Output port Extended Address 25
P75 R/$\overline{W}$ NDR/$\overline{B}$	1	I/O Output Input	Port 75: I/O port Read/Write: 1 represents read or dummy cycle; 0 represents write cycle NAND flash ready (1)/Busy (0) input
P76 $\overline{WAIT}$	1	I/O Input	Port 76: I/O port Wait: Signal used to request CPU bus wait

Table 2.3.2 Pin Names and Functions (2/5)

Pin Name	Number of Pins	I/O	Function
P80 $\overline{CS0}$	1	Output Output	Port80: Output port Chip select 0: Outputs “low” when address is within specified address area
P81 $\overline{CS1}$ $\overline{SDCS}$	1	Output Output Output	Port81: Output port Chip select 1: Outputs “low” when address is within specified address area Chip select for SDRAM: Outputs “0” when address is within SDRAM address area
P82 $\overline{CS2}$ $\overline{CSZA}$	1	Output Output Output	Port82: Output port Chip select 2: Outputs “Low” when address is within specified address area Expand chip select: ZA: Outputs “0” when address is within specified address area
P83 $\overline{CS3}$	1	Output Output	Port83: Output port Chip select 3: Outputs “low” when address is within specified address area
P84 $\overline{CSZB}$ $\overline{ND0CE}$	1	Output Output Output	Port84: Output port Expand chip select: ZB: Outputs “0” when address is within specified address area Chip select for NAND flash 0: Outputs “0” when NAND flash 0 is enabled
P85 $\overline{CSZC}$ $\overline{ND1CE}$	1	Output Output Output	Port85: Output port Expand chip select: ZC: Outputs “0” when address is within specified address area Chip select for NAND flash 1: Outputs “0” when NAND flash 1 is enabled
P86 $\overline{CSZD}$	1	Output Output	Port86: Output port Expand chip select: ZD: outputs “0” when address is within specified address area
P87 $\overline{CSZE}$	1	Output Output	Port87: Output port Expand chip select: ZE: Outputs “0” when address is within specified address area
P90 TXD0 I2SCKO	1	I/O Output Output	Port90: I/O port Serial 0 send data: Open-drain output programmable I^2S clock output
P91 RXD0 I2SDO	1	I/O Input Output	Port91: I/O port (Schmitt-input) Serial 0 receive data I^2S data output
P92 SCLK0 $\overline{CTS0}$ I2SWS	1	I/O I/O Input Output	Port92: I/O port (Schmitt-input) Serial 0 clock I/O Serial 0 data send enable (Clear to send) I^2S word select output
P93 SDA	1	I/O I/O	Port 93: I/O port I^2C data I/O
P94 SCL	1	I/O I/O	Port 94: I/O port I^2C clock I/O
P95 CLK32KO	1	Output Output	Port95: Output port Output fs (32.768 kHz) clock
P96 INT4 PX	1	Input Input Output	Port 96: Input port (Schmitt-input) Interrupt request pin4: Interrupt request with programmable rising/falling edge X-Plus: Pin connectted to X+ for touch screen panel
P97 INT5 PY	1	Input Input Output	Port 97: Input port (Schmitt-input) Interrupt request pin5: Interrupt request with programmable rising/falling edge Y-Plus: Pin connectted to Y+ for touch screen panel
PA0 to PA7 KI0 to KI7	8	Input Input	Port: A0 to A7 port: Pin used to input ports (Schmitt input, with pull-up resistor) Key input 0 to 7: Pin used for key-on wakeup 0 to 7

Table 2.3.3 Pin Names and Functions (3/5)

Pin Name	Number of Pins	I/O	Function
PC0	1	I/O	Port C0: I/O port (Schmitt-input)
INT0		Input	Interrupt request pin 0: Interrupt request pin with programmable level/rising/falling edge
TA1OUT		Output	8-bit timer 1 output: Timer 1 output
PC1	1	I/O	Port C1: I/O port (Schmitt-input)
INT1		Input	Interrupt request pin 1: Interrupt request pin with programmable rising/falling edge
TA3OUT		Output	8-bit timer 3 output: Timer 3 output
PC2	1	I/O	Port C2: I/O port (Schmitt-input)
INT2		Input	Interrupt request pin 2: Interrupt request pin with programmable rising/falling edge
TB0OUT0		Output	Timer B0 output
PC3	1	I/O	Port C3: I/O port (Schmitt-input)
INT3		Input	Interrupt request pin 3: Interrupt request pin with programmable rising/falling edge
PC4 to PC5	2	I/O	Port C4 to C5: U/O port
PC6	1	I/O	Port C6: I/O port
KO8		Output	Key Output 8: Pin used of key-scan strobe (Open-drain output programmable)
EA24		Output	Extended Address 24
PC7	1	I/O	Port C7: I/O port
$\overline{\text{CSZF}}$		Output	Expand chip select: ZF: Outputs “0" when address is within specified address area
EA25		Output	Extended Address 25
PF0	1	I/O	Port F0: I/O port (Schmitt-input)
TXD0		Output	Serial 0 send data: Open-drain output programmable
PF1	1	I/O	Port F1: I/O port (Schmitt-input)
RXD0		Input	Serial 0 receive data
PF2	1	I/O	Port F2: I/O port (Schmitt-input)
SCLK0		I/O	Serial 0 clock I/O
$\overline{\text{CTS0}}$		Input	Serial 0 data send enable (Clear to send)
PF7	1	Output	Port F7: Output port
SDCLK		Output	Clock for SDRAM (When SDRAM is not used, SDCLK can be used as system clock)
PG0 to PG1	2	Input	Port G0 to G1 port: Pin used to input ports
AN0 to AN1		Input	Analog input 0 to 1: Pin used to Input to AD conveter
PG2	1	Input	Port G2 port: Pin used to input ports
AN2		Input	Analog input 2: Pin used to Input to AD conveter
MX		Output	X-Minus: Pin connectted to X– for touch screen panel
PG3	1	Input	Port G3 port: Pin used to input ports
AN3		Input	Analog input 3: Pin used to input to AD conveter
MY		Output	Y-Minus: Pin connectted to Y– for touch screen panel
$\overline{\text{ADTRG}}$		Intput	AD trigger: Signal used to request AD start

Table 2.3.4 Pin Names and Functions (4/5)

Pin Name	Number of Pins	I/O	Function
PJ0	1	Output	Port J0: Output port
$\overline{\text{SDRAS}}$		Output	Row address strobe for SDRAM
$\overline{\text{SRLLB}}$		Output	Data enable for SRAM on pins D0 to D7
PJ1	1	Output	Port J1: Output port
$\overline{\text{SDCAS}}$		Output	Column address strobe for SDRAM
$\overline{\text{SRLUB}}$		Output	Data enable for SRAM on pins D8 to D15
PJ2	1	Output	Port J2: Output port
$\overline{\text{SDWE}}$		Output	Write enable for SDRAM
$\overline{\text{SRWR}}$		Output	Write for SRAM: Strobe signal for writing data
PJ3	1	Output	Port J3: Output port
SDLLDQM		Output	Data enable for SDRAM on pins D0 to D7
PJ4	1	Output	Port J4: Output port
SDLUDQM		Output	Data enable for SDRAM on pins D8 to D15
PJ5	1	I/O	Port J5: I/O port
NDALE		Output	Address latch enable for NAND flash
PJ6	1	I/O	Port J6: I/O port
NDCLE		Output	Command latch enable for NAND flash
PJ7	1	Output	Port J7: Output port
SDCKE		Output	Clock enable for SDRAM
PK0	1	Output	Port K0: Output port
LCP0		Output	LCD driver output pin
PK1	1	Output	Port K1: Output port
LLP		Output	LCD driver output pin
PK2	1	Output	Port K2: Output port
LFR		Output	LCD driver output pin
PK3	1	Output	Port K3: Output port
LBCD		Output	LCD driver output pin
PK4	1	I/O	Port K4: I/O port
SPDI		Input	Data input pin for SD card
PK5	1	I/O	Port K5: I/O port
SPDO		Output	Data output pin for SD card
PK6	1	I/O	Port K6: I/O port
$\overline{\text{SPCS}}$		Output	Chip select pin for SD card
PK7	1	I/O	Port K7: I/O port
SPCLK		Output	Clock output pin for SD card
PL0 to PL3	4	Output	Port L0 to L3: Output port
LD0 to LD3		Output	Data bus for LCD driver
PL4 to PL5	2	I/O	Port L4 to L5: I/O port
LD4 to LD5		Output	Data bus for LCD driver
PL6	1	I/O	Port L6: I/O port
LD6		Output	Data bus for LCD driver
$\overline{\text{BUSRQ}}$		Input	Bus request: request pin that set external memory bus to high-impedance (for External DMAC)
PL7	1	I/O	Port L7: I/O port
LD7		Output	Data bus for LCD driver
$\overline{\text{BUSAK}}$		Output	Bus acknowledge: this pin show that external memory bus pin is set to high-impedance by receiving $\overline{\text{BUSRQ}}$ (for External DMAC)

Table 2.3.5 Pin Names and Functions (5/5)

Pin Name	Number of Pins	I/O	Function
PM1 MLDALM	1	Output Output	Port M1: Output port Melody/alarm output pin
PM2 $\overline{\text{ALARM}}$ $\overline{\text{MLDALM}}$	1	Output Output Output	Port M2: Output port RTC alarm output pin Melody/alarm output pin (inverted)
PN0 to PN7 KO0 to KO7	8	I/O Output	Port N0 to N7: I/O port Key out pin (Open-drain setting)
AM0, AM1	2	Input	Operation mode: Fix to AM1 = "0", AM0 = "1" for 16-bit external bus starting Fix to AM1 = "1", AM0 = "0" for 32-bit external bus starting Fix to AM1 = "1", AM0 = "1" Prohibit setting Fix to AM1 = "0", AM0 = "0" Prohibit setting
X1/X2	2	I/O	High-frequency oscillator connection pins
XT1/XT2	2	I/O	Low-frequency oscillator connection pins
$\overline{\text{RESET}}$	1	Input	Reset: Initializes TMP92CA25 (with pull-up resistor, Schmitt input)
VREFH	1	Input	Pin for reference voltage input to AD converter (H)
VREFL	1	Input	Pin for reference voltage input to AD converter (L)
RTCVCC	1	–	Power supply pin for RTC
$\overline{\text{BE}}$	1	Input	Back up enable pin: When power off DV_{CC} and AV_{SS} during RTC is operating, set to "L" level beforehand. Usually, this pin used to "H" level. (Schmitt input)
AVCC	1	–	Power supply pin for AD converter
AVSS	1	–	GND pin for AD converter (0 V)
DVCC	3	–	Power supply pins (All DV_{CC} pins should be connected to the power supply pin)
DVSS	3	–	GND pins (0 V) (All DV_{SS} pins should be connected to GND (0 V))

3. Operation

This section describes the basic components, functions and operation of the TMP92CA25.

3.1 CPU

The TMP92CA25 contains an advanced high-speed 32-bit CPU (TLCS-900/H1 CPU)

3.1.1 CPU Outline

The TLCS-900/H1 CPU is a high-speed, high-performance CPU based on the TLCS-900/L1 CPU. The TLCS-900/H1 CPU has an expanded 32-bit internal data bus to process instructions more quickly.

The following is an outline of the CPU:

Table 3.1.1 TMP92CA25 Outline

Parameter	TMP92CA25	
Width of CPU address bus	24 bits	
Width of CPU data bus	32 bits	
Internal operating frequency	Max 20 MHz	
Minimum bus cycle	1-clock access (50 ns at f_{SYS} = 20MHz)	
Internal RAM	32-bit 1-clock access	
Internal I/O	8-bit 2-clock access	INTC, SDRAMC, MEMC, NDFC, TSI, PORT
	16-bit 2-clock access	I2S, SPIC, LCDC
	8-bit 5~6-clock access	TMRA, TMRB, SIO, RTC, MLD/ALM, SBI, CGEAR, ADC
External SRAM, Masked ROM	8- or 16-bit 2-clock access (waits can be inserted)	
External SDRAM	16-bit 1-clock access	
External NAND flash	8-bit 4-clock access (waits can be inserted)	
Minimum instruction execution cycle	1-clock (50 ns at f_{SYS} = 20MHz)	
Conditional jump	2-clock (100 ns at f_{SYS} = 20MHz)	
Instruction queue buffer	12 bytes	
Instruction set	Compatible with TLCS-900/L1 (LDX instruction is deleted)	
CPU mode	Maximum mode only	
Micro DMA	8 channels	

3.1.2 Reset Operation

When resetting the TMP92CA25, ensure that the power supply voltage is within the operating voltage range, and that the internal high-frequency oscillator has stabilized. Then hold the $\overline{\text{RESET}}$ input low for at least 20 system clocks (16 μs at fc = 40 MHz).

At reset, since the clock doubler (PLL) is bypassed and the clock-gear is set to 1/16, the system clock operates at 1.25 MHz (fc = 40 MHz).

When the reset has been accepted, the CPU performs the following:

- Sets the program counter (PC) as follows in accordance with the reset vector stored at address FFFF00H to FFFF02H:

  PC<7:0> ← data in location FFFF00H
  PC<15:8> ← data in location FFFF01H
  PC<23:16> ← data in location FFFF02H

- Sets the stack pointer (XSP) to 00000000H.
- Sets bits <IFF2:0> of the status register (SR) to 111 (thereby setting the interrupt level mask register to level 7).
- Clears bits <RFP1:0> of the status register to 00 (there by selecting register bank 0).

When the reset is released, the CPU starts executing instructions according to the program counter settings. CPU internal registers not mentioned above do not change when the reset is released.

When the reset is accepted, the CPU sets internal I/O, ports and other pins as follows.

- Initializes the internal I/O registers as shown in the "Special Function Register" table in section 5.
- Sets the port pins, including the pins that also act as internal I/O, to general-purpose input or output port mode.

Internal reset is released as soon as external reset is released.

Memory controller operation cannot be ensured until the power supply becomes stable after power-on reset. External RAM data provided before turning on the TMP92CA25 may be corrupted because the control signals are unstable until the power supply becomes stable after power on reset.

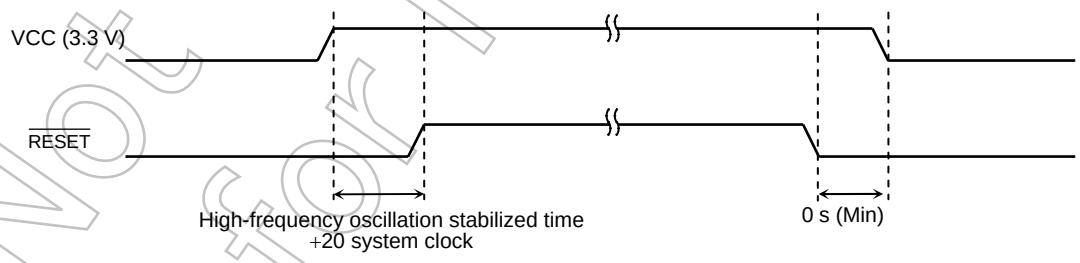


Figure 3.1.1 Power on Reset Timing Example

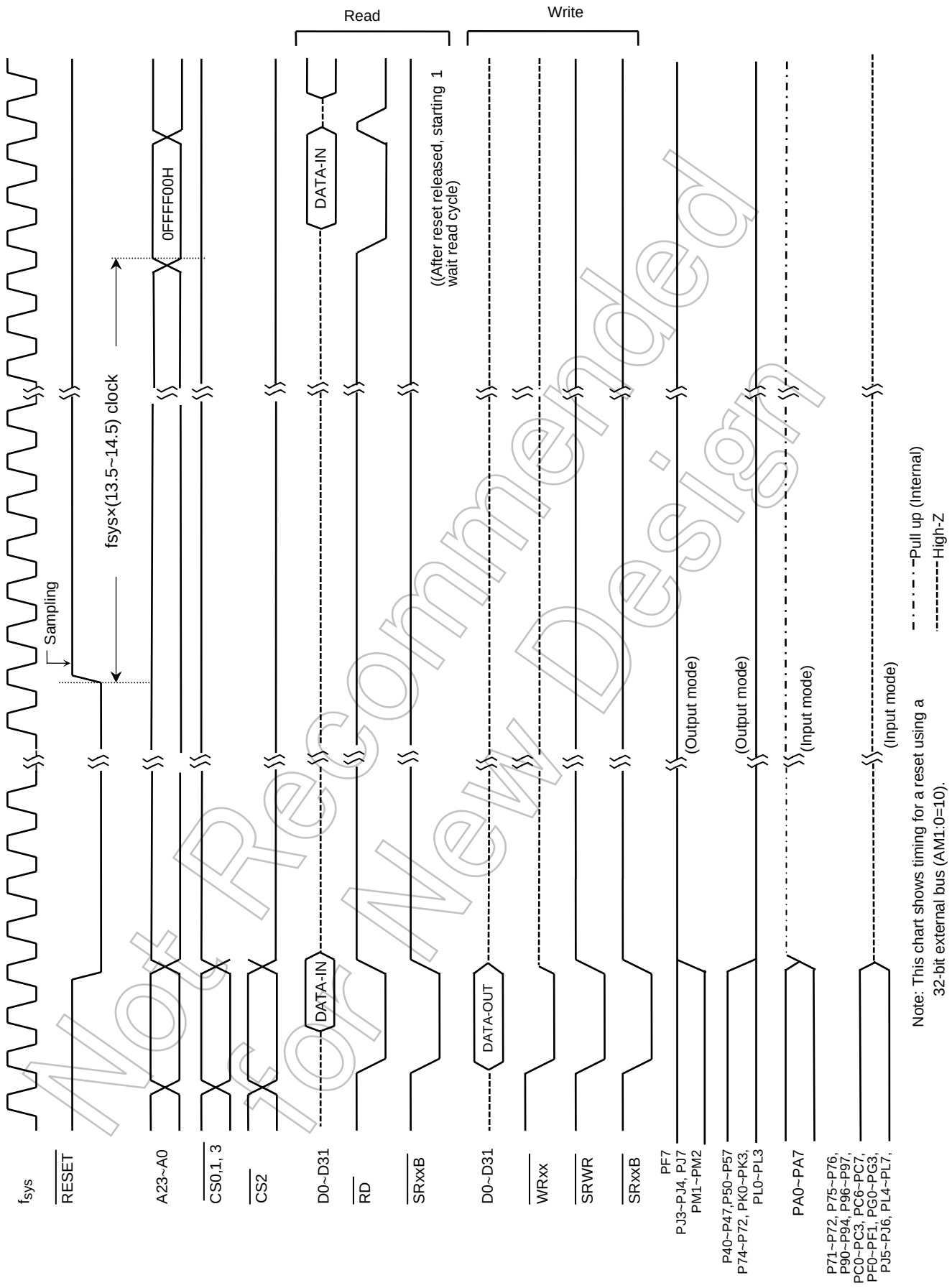


Figure 3.1.2 TMP92CA25 Reset Timing Chart

3.1.3 Setting of AM0 and AM1

Set AM1 and AM0 pins as shown in Table 3.1.2 according to system usage.

Table 3.1.2 Operation Mode Setup Table

Operation Mode	Mode Setup Input Pin		
	$\overline{\text{RESET}}$	AM1	AM0
16-bit external bus starting (MULTI 16 mode)		0	1
8-bit external bus starting (MULTI 8 mode)		1	0
Prohibit setting		1	1
Reserve (Toshiba test mode)		0	0

3.2 Memory Map

Figure 3.2.1 is a memory map of the TMP92CA25.

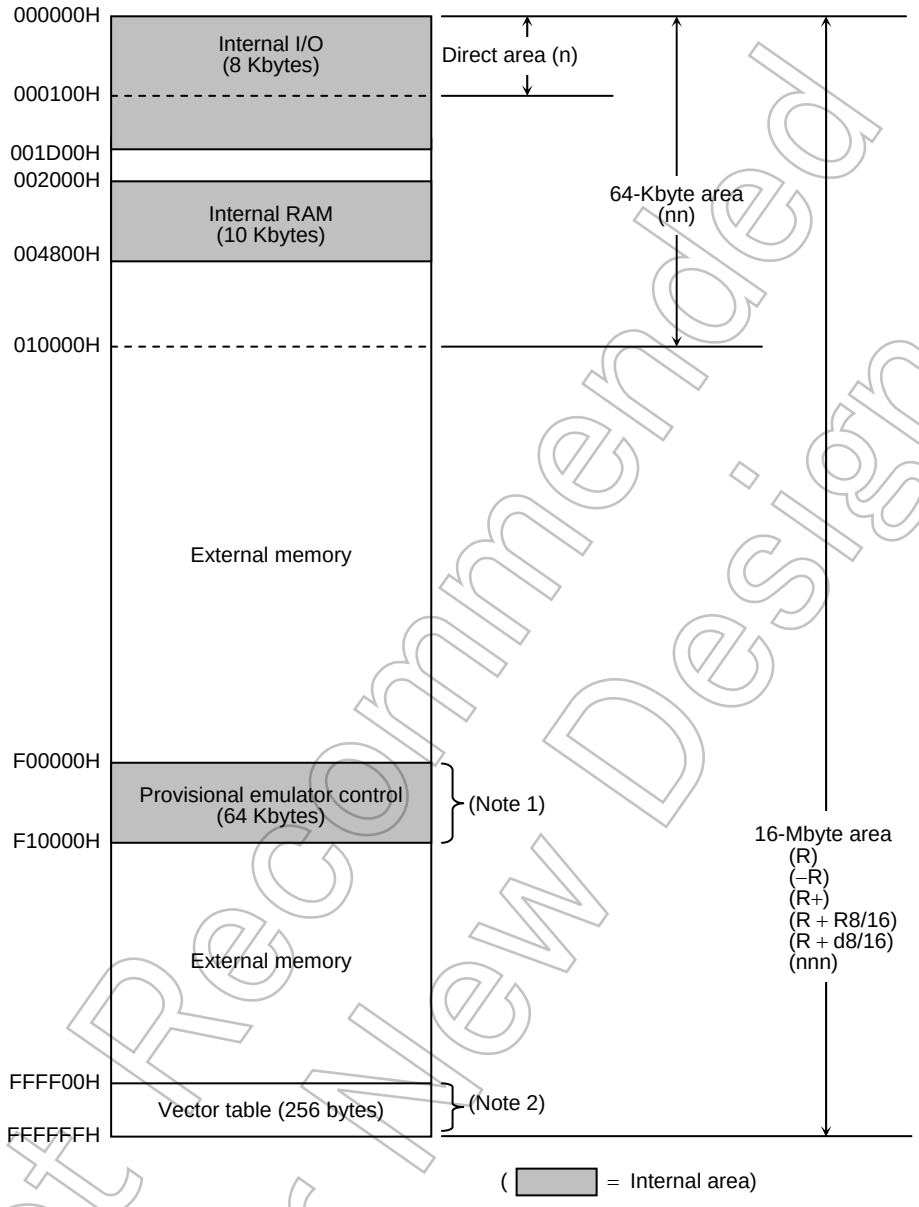


Figure 3.2.1 Memory Map

Note 1: The Provisional emulator control area, mapped F00000H to F0FFFFH after reset, is for emulator use and so is not available. When emulator $\overline{WR}$ signal and $\overline{RD}$ signal are asserted, this area is accessed. Ensure external memory is used.

Note 2: Do not use the last 16-byte area (FFFFF0H to FFFFFFH). This area is reserved for an emulator.

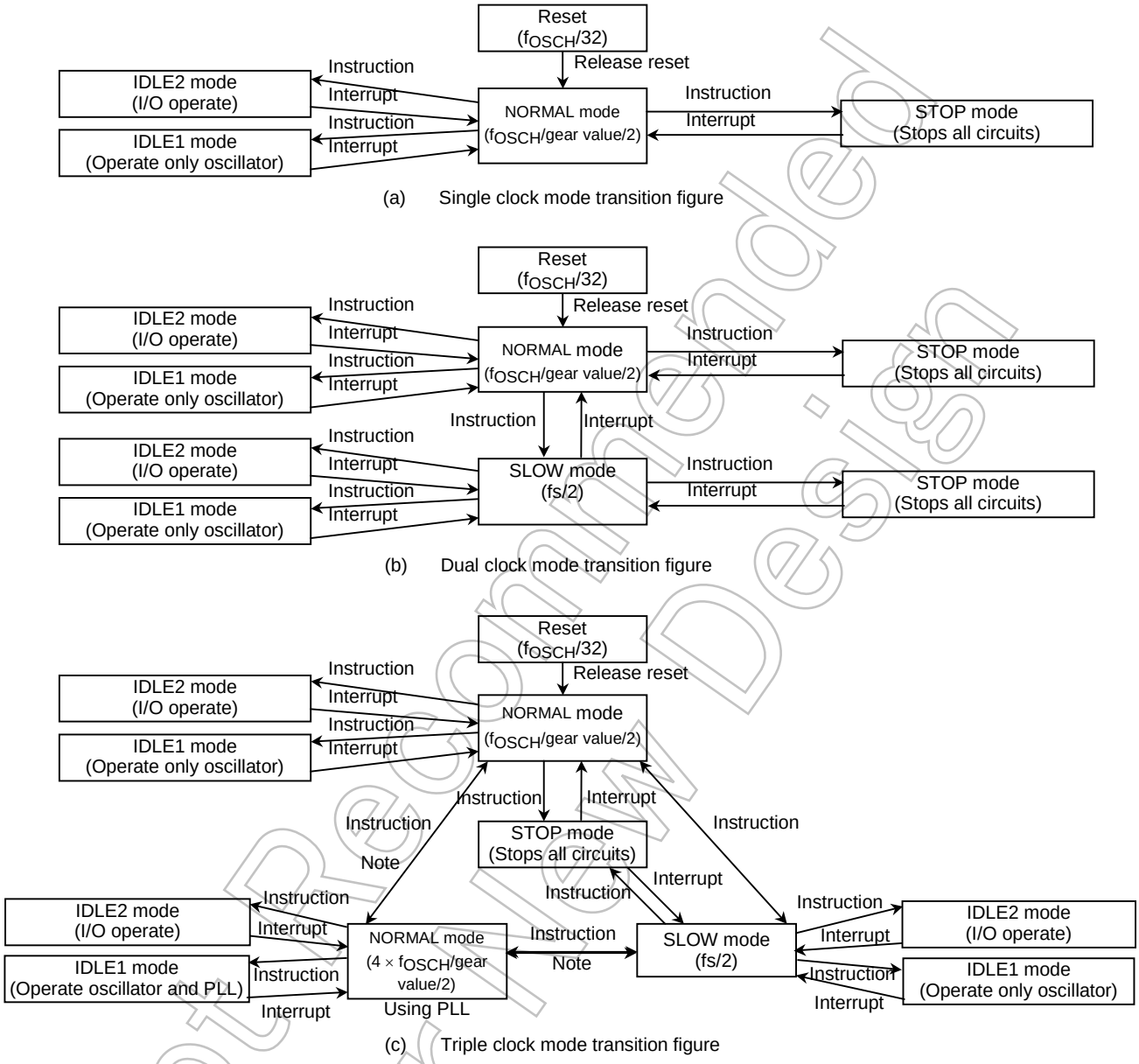
3.3 Clock Function and Stand-by Function

The TMP92CA25 contains (1) clock gear, (2) clock doubler (PLL), (3) stand-by controller and (4) noise reduction circuits. They are used for low power, low noise systems.

This chapter is organized as follows:

The clock operating modes are as follows: (a) single clock mode (X1, X2 pins only), (b) dual clock mode (X1, X2, XT1 and XT2 pins) and (c) triple clock mode (X1, X2, XT1 and XT2 pins and PLL).

Figure 3.3.1 shows a transition figure.



Note 1: It is not possible to control PLL in SLOW mode when shifting from SLOW mode to NORMAL mode with use of PLL. (PLL start up/stop/change write to PLLCR0<PLLON>, PLLCR1<FCSEL> register)

Note 2: When shifting from NORMAL mode with use of PLL to NORMAL mode, execute the following setting in the same order.

1) Change CPU clock (PLLCR0<FCSEL> ← "0")

2) Stop PLL circuit (PLLCR1<PLLON> ← "0")

Note 3: It is not possible to shift from NORMAL mode with use of PLL to STOP mode directly.

NORMAL mode should be set once before shifting to STOP mode. (Sstop the high-frequency oscillator after stopping PLL.)

Figure 3.3.1 System Clock Block Diagram

The clock frequency input from the X1 and X2 pins is called fc and the clock frequency input from the XT1 and XT2 pins is called fs. The clock frequency selected by SYSCR1<SYSCK> is called the clock f_{FPH}. The system clock f_{SYS} is defined as the divided clock of f_{FPH}, and one cycle of f_{SYS} is defined as one state.

3.3.1 Block Diagram of System Clock

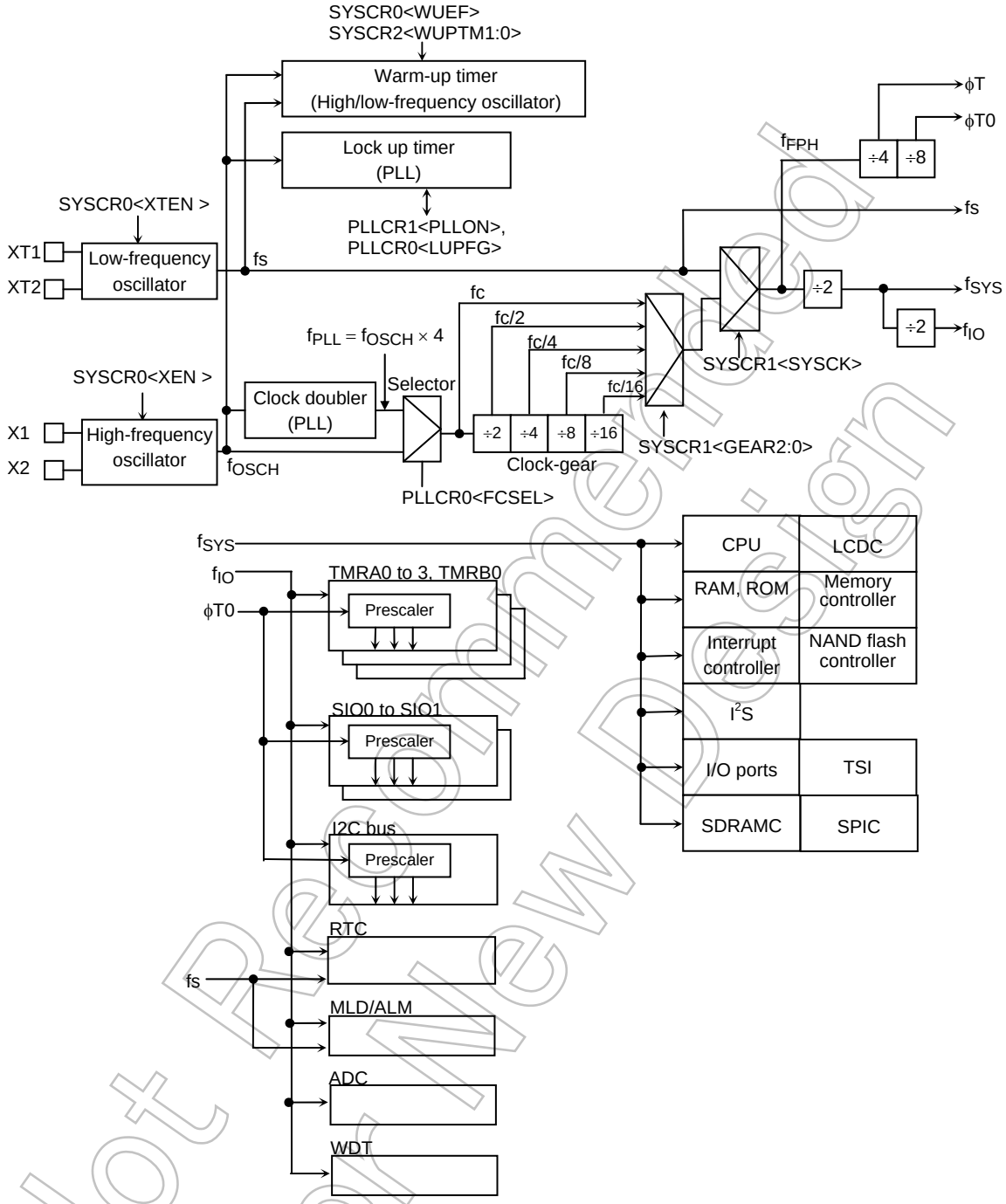


Figure 3.3.2 Block Diagram of System Clock

3.3.2 SFR

SYSCR0 (10E0H)

	7	6	5	4	3	2	1	0
Bit symbol	XEN	XTEN				WUEF		
Read/Write	R/W					R/W		
After reset	1	1				0		
Function	High-frequency oscillator (fc) 0: Stop 1: Oscillation	Low-frequency oscillator (fs) 0: Stop 1: Oscillation				Warm-up timer 0: Write don't care 1: Write start timer 0: Read end warm-up 1: Read do not end warm-up		

SYSCR1 (10E1H)

	7	6	5	4	3	2	1	0
Bit symbol					SYSCK	GEAR2	GEAR1	GEAR0
Read/Write					R/W			
After reset					0	1	0	0
Function					Select system clock 0: fc 1: fs	Select gear value of high-frequency (fc) 000: fc 001: fc/2 010: fc/4 011: fc/8 100: fc/16 101: (Reserved) 110: (Reserved) 111: (Reserved)		

SYSCR2 (10E2H)

	7	6	5	4	3	2	1	0
Bit symbol	–		WUPTM1	WUPTM0	HALTM1	HALTM0		
Read/Write	R/W		R/W					
After reset	0	–	1	0	1	1		
Function	Always write "0"		Warm-up timer 00: Reserved 01: 2^8/input frequency 10: 2^{14}/input frequency 11: 2^{16}/input frequency		HALT mode 00: Reserved 01: STOP mode 10: IDLE1 mode 11: IDLE2 mode			

Note 1: The unassigned registers, SYSCR0<bit5:3>, SYSCR0<bit1:0>, SYSCR1<bit7:4>, and SYSCR2<bit6, bit1:0> are read as undefined value.

Note 2: Low-frequency oscillator is enabled on reset.

Figure 3.3.3 SFR for System Clock

		7	6	5	4	3	2	1	0
EMCCR0 (10E3H)	Bit symbol	PROTECT					EXTIN	DRVOSCH	DRVOSCL
	Read/Write	R					R/W		
	After reset	0					0	1	1
	Function	Protect flag 0: OFF 1: ON					1: External clock	fc oscillator driver ability 1: Normal 0: Weak	fs oscillator driver ability 1: Normal 0: Weak
EMCCR1 (10E4H)	Bit symbol	Switch the protect ON/OFF by writing the following to 1st-KEY, 2nd-KEY 1st-KEY: write in sequence EMCCR1 = 5AH, EMCCR2 = A5H 2nd-KEY: write in sequence EMCCR1 = A5H, EMCCR2 = 5AH							
	Read/Write								
	After reset								
	Function								
EMCCR2 (10E5H)	Bit symbol								
	Read/Write								
	After reset								
	Function								

Note: When restarting the oscillator from the stop oscillation state (e.g. restarting the oscillator in STOP mode), set EMCCR0<DRVOSCH>, <DRVOSCL> = "1".

Figure 3.3.4 SFR for System Clock

PLLCR0 (10E8H)

	7	6	5	4	3	2	1	0
Bit symbol		FCSEL	LUPFG					
Read/Write		R/W	R					
After reset		0	0					
Function		Select fc clock 0: f_{OSCH} 1: f_{PLL}	Lock up timer status flag 0: Not end 1: End					

Note: Ensure that the logic of PLLCR0<LUPFG> is different from 900/L1's DFM.

PLLCR1 (10E9H)

	7	6	5	4	3	2	1	0
Bit symbol	PLLON							
Read/Write	R/W							
After reset	0							
Function	Control on/off 0: OFF 1: ON							

Figure 3.3.5 SFR for PLL

PxDR (xxxxH)

	7	6	5	4	3	2	1	0
Bit symbol	Px7D	Px6D	Px5D	Px4D	Px3D	Px2D	Px1D	Px0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Output/input buffer drive-register for stand-by mode							

(Purpose and use)

This register is used to set each pin status at stand-by mode.

All ports have registers of the format shown above. ("x" indicates the port name.)

For each register, refer to "3.5 Function of ports".

Before "Halt" instruction is executed, set each register according to the expected pin-status. They will be effective after the CPU has executed the "Halt" instruction.

This is the case regardless of stand-by mode (IDLE2, IDLE1 or STOP).

The output/input buffer control table is shown below.

OE	PxnD	Output Buffer	Input Buffer
0	0	OFF	OFF
0	1	OFF	ON
1	0	OFF	OFF
1	1	ON	OFF

Note 1: OE denotes an output enable signal before stand-by mode.
Basically, PxCR is used as OE.

Note 2: "n" in PxnD denotes the bit number of PORTx.

Figure 3.3.6 SFR for Drive Register

3.3.3 System Clock Controller

The system clock controller generates the system clock signal (f_{SYS}) for the CPU core and internal I/O. It contains two oscillation circuits and a clock gear circuit for high-frequency (fc) operation. The register SYSCR1<SYSCK> changes the system clock to either fc or fs, SYSCR0<XEN> and SYSCR0<XTEN> control enabling and disabling of each oscillator, and SYSCR1<GEAR2:0> sets the high-frequency clock gear to either 1, 2, 4, 8 or 16 (fc, fc/2, fc/4, fc/8 or fc/16). These functions can reduce the power consumption of the equipment in which the device is installed.

The combination of settings <XEN> = 1, <SYSCK> = 0 and <GEAR2:0> = 100 will cause the system clock (f_{SYS}) to be set to fc/32 (fc/16 × 1/2) after reset.

For example, f_{SYS} is set to 1.25 MHz when the 40 MHz oscillator is connected to the X1 and X2 pins.

(1) Switching from normal mode to slow mode

When the resonator is connected to the X1 and X2 pins, or to the XT1 and XT2 pins, the warm-up timer can be used to change the operation frequency after stable oscillation has been attained.

The warm-up time can be selected using SYSCR2<WUPTM1:0>.

This warm-up timer can be programmed to start and stop as shown in the following examples 1 and 2.

Table 3.3.1 shows the warm-up time.

Note 1: When using an oscillator (other than a resonator) with stable oscillation, a warm-up timer is not needed.

Note 2: The warm-up timer is operated by an oscillation clock. Hence, there may be some variation in warm-up time.

Table 3.3.1 Warm-up Times

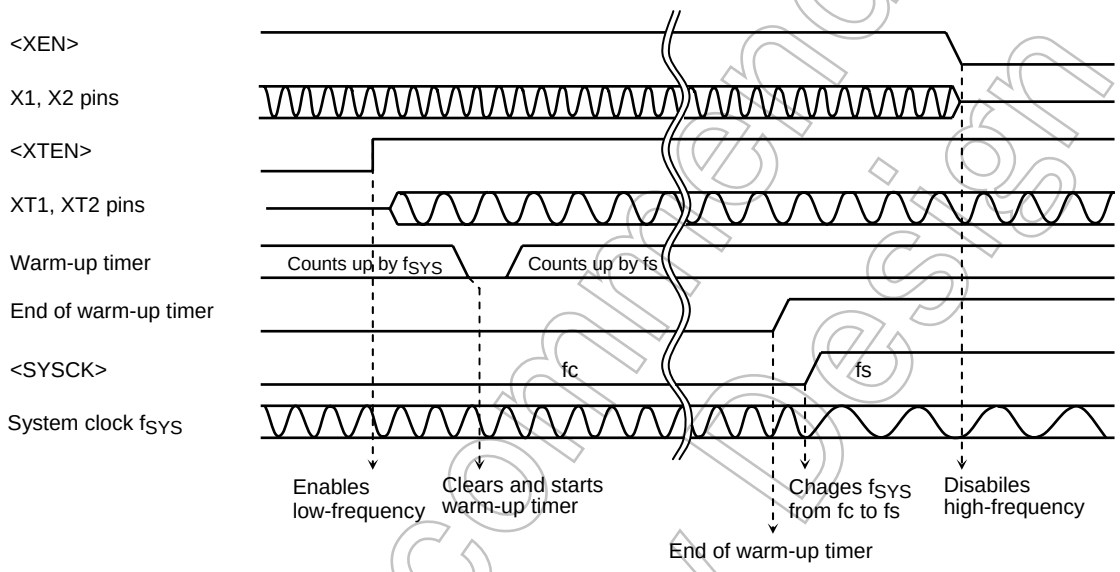
at f_{OSCH} = 40 MHz, fs = 32.768 kHz

Warm-up Time SYSCR2 <WUPTM1:0>	Change to Normal Mode	Change to Slow Mode
01 (2^8/frequency)	6.4 (μs)	7.8 (ms)
10 (2^{14}/frequency)	409.6 (μs)	500 (ms)
11 (2^{16}/frequency)	1.638 (ms)	2000 (ms)

Example 1: Setting the clock
Changing from high-frequency (fc) to low-frequency (fs).

```
SYSCR0   EQU   10E0H
SYSCR1   EQU   10E1H
SYSCR2   EQU   10E2H
         LD    (SYSCR2),  0 X 1 1 – – X X B  ;  Sets warm-up time to 2^16/fs.
         SET   6, (SYSCR0)                   ;  Enables low-frequency oscillation.
         SET   2, (SYSCR0)                   ;  Clears and starts warm-up timer.
WUP:     BIT   2, (SYSCR0)                   ;
         JR    NZ, WUP                       ;  Detects stopping of warm-up timer.
         SET   3, (SYSCR1)                   ;  Changes fSYS from fc to fs.
         RES   7, (SYSCR0)                   ;  Disables high-frequency oscillation.
```

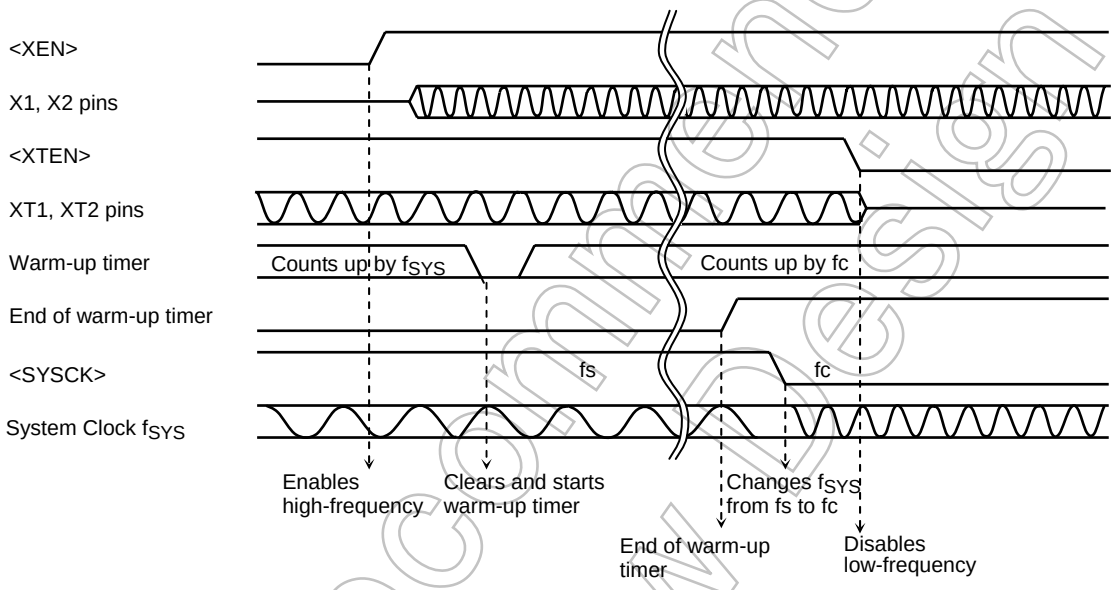
X: Don't care, –: No change



Example 2: Setting the clock
Changing from low-frequency (fs) to high-frequency (fc).

```
SYSCR0   EQU   10E0H
SYSCR1   EQU   10E1H
SYSCR2   EQU   10E2H
         LD    (SYSCR2),  0 X 1 0 – – X X B  ;  Sets warm-up time to 2^14/fc.
         SET   7, (SYSCR0)                   ;  Enables high-frequency oscillation.
         SET   2, (SYSCR0)                   ;  Clears and starts warm-up timer.
WUP:     BIT   2, (SYSCR0)                   ;  } Detects stopping of warm-up timer.
         JR    NZ, WUP                       ;  }
         RES   3, (SYSCR1)                   ;  Changes f_SYS from fs to fc.
         RES   6, (SYSCR0)                   ;  Disables low-frequency oscillation.
```

X: Don't care, –: No change



(2) Clock gear controller

f_{FPH} is set according to the contents of the clock gear select register SYSCR1<GEAR2:0> to either fc, fc/2, fc/4, fc/8 or fc/16. Using the clock gear to select a lower value of f_{FPH} reduces power consumption.

Example 3: Changing to a high-frequency gear

```
SYSCR1    EQU    10E1H

          LD     (SYSCR1), XXXX0000B   ;   Changes fSYS to fc/2.
          LD     (DUMMY), 00H          ;   Dummy instruction
```

X: Don't care

(High-speed clock gear changing)

To change the clock gear, write the register value to the SYSCR1<GEAR2:0> register.It is necessary for the warm-up time to elapse before the change occurs after writing the register value.

There is the possibility that the instruction following the clock gear changing instruction is executed by the clock gear before changing.To execute the instruction following the clock gear switching instruction by the clock gear after changing, input the dummy instruction as follows (instruction to execute the write cycle).

Example:

```
SYSCR1    EQU    10E1H
          LD     (SYSCR1), XXXX0001B   ;   Changes fSYS to fc/4.
          LD     (DUMMY), 00H          ;   Dummy instruction
          Instruction to be executed after clock gear has changed
```

3.3.4 Clock Doubler (PLL)

PLL outputs the f_{PLL} clock signal, which is four times as fast as f_{OSCH}. A low-speed-frequency oscillator can be used, even though the internal clock is high-frequency.

A reset initializes PLL to stop status, so setting to PLLCR0, PLLCR1 register is needed before use.

As with an oscillator, this circuit requires time to stabilize. This is called the lock up time and it is measured by a 16-stage binary counter. Lock up time is about 1.6 ms at f_{OSCH} = 10 MHz.

Note 1: Input frequency range for PLL

The input frequency range (High-frequency oscillation) for PLL is as follows:

f_{OSCH} = 6 to 10 MHz (V_{CC} = 3.0 to 3.6 V)

Note 2: PLLCR0<LUPFG>

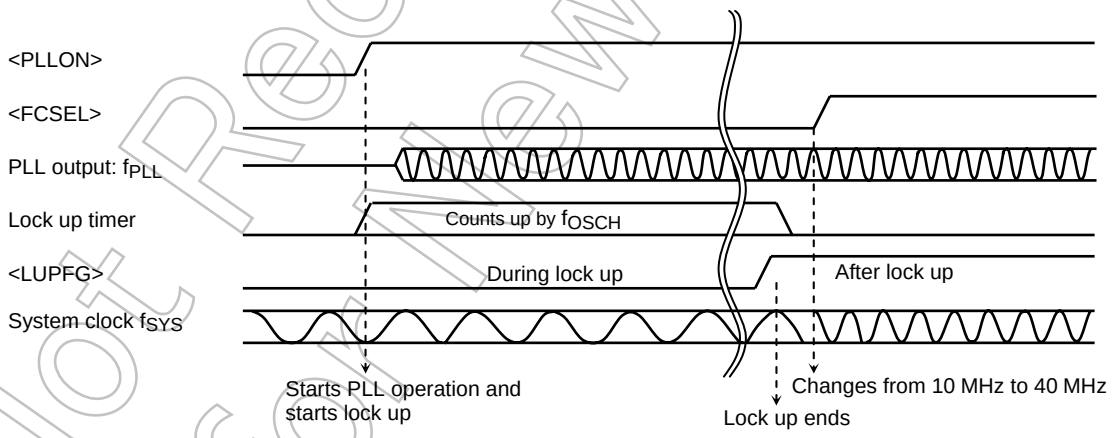
The logic of PLLCR0<LUPFG> is different from 900/L1's DFM.

Exercise care in determining the end of lock up time.

The following is an example of settings for PLL starting and PLL stopping.

Example 1: PLL starting

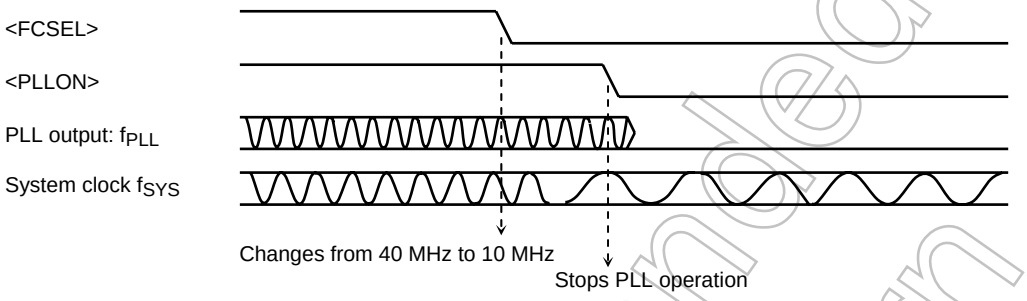
```
PLLCR0      EQU     10E8H
PLLCR1      EQU     10E9H
            LD      (PLLCR1),   1 X X X X X X X B  ;  Enables PLL operation and starts lock up.
LUP:        BIT     5, (PLLCR0)                    ;
            JR      Z, LUP                         ;  Detects end of lock up.
            LD      (PLLCR0),   X 1 X X X X X X B  ;  Changes fc from 10 MHz to 40 MHz.
X: Don't care
```



Example 2: PLL stopping

```
PLLCR0    EQU    10E8H
PLLCR1    EQU    10E9H
          LD     (PLLCR0), X0XXXXXXB    ;   Changes fc from 40 MHz to10 MHz.
          LD     (PLLCR1), 0XXXXXXXB    ;   Stop PLL.
```

X: Don't care



Limitations on the use of PLL

1. It is not possible to execute PLL enable/disable control in the SLOW mode (fs) (writing to PLLCR0 and PLLCR1).
   PLL should be controlled in the NORMAL mode.

2. When stopping PLL operation during PLL use, execute the following settings in the same order.

```
LD      (PLLCR0), 00H       ;   Change the clock fPLL to fOSCH
LD      (PLLCR1), 00H       ;   PLL stop
```

3. When stopping the high-frequency oscillator during PLL use, stop PLL before stopping the high-frequency oscillator.

Examples of settings are shown below:

(1) Start up/change control

(OK) Low-frequency oscillator operation mode (fs) (high-frequency oscillator STOP) → High-frequency oscillator start up → High-frequency oscillator operation mode (f_{OSCH}) → PLL start up → PLL use mode (f_{PLL})

```
      LD      (SYSCR0),   1 1 – – – 1 – – B ;   High-frequency oscillator start/warm-up start
WUP:  BIT     2, (SYSCR0)                 ;
      JR      NZ, WUP                     ;   Check for warm-up end flag
      LD      (SYSCR1),   – – – – 0 – – – B ;   Change the system clock fs to fOSCH
      LD      (PLLCR1),   1 – – – – – – – B ;   PLL start-up/lock up start
LUP:  BIT     5, (PLLCR0)                 ;
      JR      Z, LUP                      ;   Check for lock up end flag
      LD      (PLLCR0),   – 1 – – – – – – B ;   Change the system clock fOSCH to fPLL
```

(OK) Low-frequency oscillator operation mode (fs) (high-frequency oscillator Operate) → High-frequency oscillator operation mode (f_{OSCH}) → PLL start up → PLL use mode (f_{PLL})

```
      LD      (SYSCR1),   – – – – 0 – – – B ;   Change the system clock fs to fOSCH
      LD      (PLLCR1),   1 – – – – – – – B ;   PLL start-up/lock up start
LUP:  BIT     5, (PLLCR0)                 ;
      JR      Z, LUP                      ;   Check for lock up end flag
      LD      (PLLCR0),   – 1 – – – – – – B ;   Change the system clock fOSCH to fPLL
```

(Error) Low-frequency oscillator operation mode (fs) (high-frequency oscillator STOP) → High-frequency oscillator start up → PLL start up → PLL use mode (f_{PLL})

```
      LD      (SYSCR0),   1 1 – – – 1 – – B ;   High-frequency oscillator start/warm-up start
WUP:  BIT     2, (SYSCR0)                 ;
      JR      NZ, WUP                     ;   Check for warm-up end flag
      LD      (PLLCR1),   1 – – – – – – – B ;   PLL start-up/lock up start
LUP:  BIT     5, (PLLCR0)                 ;
      JR      Z, LUP                      ;   Check for lock up end flag
      LD      (PLLCR0),   – 1 – – – – – – B ;   Change the internal clock fOSCH to fPLL
      LD      (SYSCR1),   – – – – 0 – – – B ;   Change the system clock fs to fPLL
```

(2) Change/stop control

(OK) PLL use mode (f_{PLL}) → High-frequency oscillator operation mode (f_{OSCH}) → PLL Stop → Low-frequency oscillator operation mode (fs) → High-frequency oscillator stop

```
LD    (PLLCR0),   – 0 – – – – – – B ;  Change the system clock fPLL to fOSCH
LD    (PLLCR1),   0 – – – – – – – B ;  PLL stop
LD    (SYSCR1),   – – – – 1 – – – B ;  Change the system clock fOSCH to fs
LD    (SYSCR0),   0 – – – – – – – B ;  High-frequency oscillator stop
```

(Error) PLL use mode (f_{PLL}) → Low-frequency oscillator operation mode (fs) → PLL stop → High-frequency oscillator stop

```
LD    (SYSCR1),   – – – – 1 – – – B ;  Change the system clock fPLL to fs
LD    (PLLCR0),   – 0 – – – – – – B ;  Change the internal clock (fc) fPLL to fOSCH
LD    (PLLCR1),   0 – – – – – – – B ;  PLL stop
LD    (SYSCR0),   0 – – – – – – – B ;  High-frequency oscillator stop
```

(OK) PLL use mode (f_{PLL}) → Set the STOP mode → High-frequency oscillator operation mode (f_{OSCH}) → PLL stop → Halt (High-frequency oscillator stop)

```
LD    (SYSCR2),   – – – 0 1 – – B ;  Set the STOP mode
                                     (This command can be executed before use of PLL)
LD    (PLLCR0),   – 0 – – – – – – B ;  Change the system clock fPLL to fOSCH
LD    (PLLCR1),   0 – – – – – – – B ;  PLL stop
HALT                               ;  Shift to STOP mode
```

(Error) PLL use mode (f_{PLL}) → Set the STOP mode → Halt (High-frequency oscillator stop)

```
LD    (SYSCR2),   – – – – 0 1 – – B ;  Set the STOP mode
                                       (This command can execute before use of PLL)
HALT                               ;  Shift to STOP mode
```

3.3.5 Noise Reduction Circuits

Noise reduction circuits are built-in, allowing implementation of the following features.

(1) Reduced drivability for high-frequency oscillator

(2) Reduced drivability for low-frequency oscillator

(3) Single drive for high-frequency oscillator

(4) SFR protection of register contents

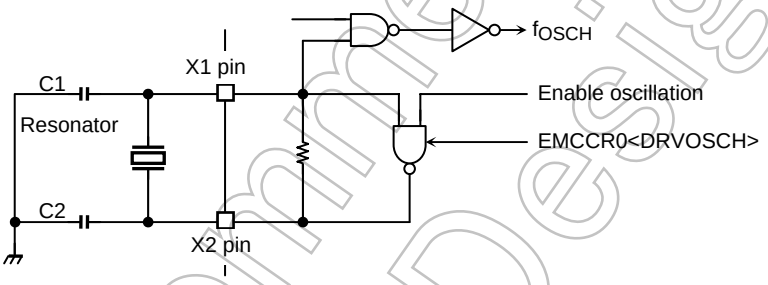
When above function is used, set EMCCR0 and EMCCR2 registers

(1) Reduced drivability for high-frequency oscillator

(Purpose)

Reduces noise and power for oscillator when a resonator is used.

(Block diagram)



(Setting method)

The drive ability of the oscillator is reduced by writing "0" to EMCCR0<DRVOSCH> register. At reset, <DRVOSCH> is initialized to "1" and the oscillator starts oscillation by normal drivability when the power-supply is on.

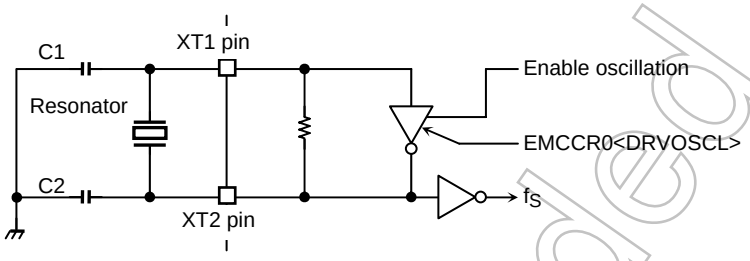
Note: This function (EMCCR0<DRVOSCH> = "0") is available when f_{OSCH} = 6 to 10 MHz.

(2) Reduced drivability for low-frequency oscillator

(Purpose)

Reduces noise and power for oscillator when a resonator is used.

(Block diagram)



(Setting method)

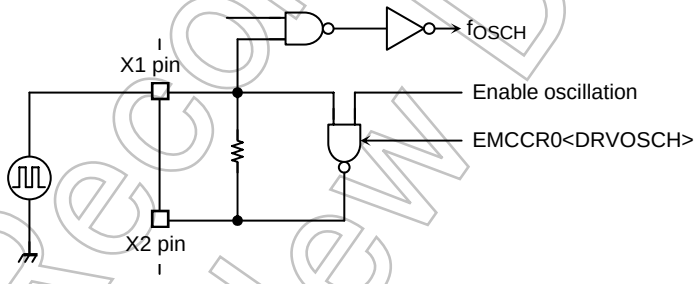
The drive ability of the oscillator is reduced by writing 0 to the EMCCR0<DRVOSCL> register. At reset, <DRVOSCL> is initialized to "1".

(3) Single drive for high-frequency oscillator

(Purpose)

Remove the need for twin drives and prevent operational errors caused by noise input to X2 pin when an external oscillator is used.

(Block diagram)



(Setting method)

The oscillator is disabled and starts operation as buffer by writing "1" to EMCCR0<EXTIN> register. X2 pin's output is always "1".

At reset, <EXTIN> is initialized to "0".

(4) Runaway prevention using SFR protection register

(Purpose)

Prevention of program runaway caused by introduction of noise.

Write operations to a specified SFR are prohibited so that the program is protected from runaway caused by stopping of the clock or by changes to the memory control register (memory controller, MMU) which prevent fetch operations.

Runaway error handling is also facilitated by INTP0 interruption.

Specified SFR list

1. Memory controller
   B0CSL/H, B1CSL/H, B2CSL/H, B3CSL/H, BECSL/H
   MSAR0, MSAR1, MSAR2, MSAR3,
   MAMR0, MAMR1, MAMR2, MAMR3, PMEMCR,
   MEMCR0
2. MMU
   LOCALPX/PY/PZ, LOCALLX/LY/LZ,
   LOCALRX/RY/RZ, LOCALWX/WY/WZ,
3. Clock gear
   SYSCR0, SYSCR1, SYSCR2, EMCCR0
4. PLL
   PLLCR0, PLLCR1

(Operation explanation)

Execute and release of protection (write operation to specified SFR) becomes possible by setting up a double key to EMCCR1 and EMCCR2 registers.

(Double key)

1st KEY: writes in sequence, 5AH at EMCCR1 and A5H at EMCCR2

2nd KEY: writes in sequence, A5H at EMCCR1 and 5AH at EMCCR2

Protection state can be confirmed by reading EMCCR0<PROTECT>.

At reset, protection becomes OFF.

INTP0 interruption also occurs when a write operation to the specified SFR is executed with protection in the ON state.

3.3.6 Stand-by Controller

(1) HALT modes and port drive register

When the HALT instruction is executed, the operating mode switches to IDLE2, IDLE1 or STOP mode, depending on the contents of the SYSCR2<HALTM1:0> register and each pin-status is set according to the PxDR register, as shown below:

PxDR (xxxxH)

	7	6	5	4	3	2	1	0
Bit symbol	Px7D	Px6D	Px5D	Px4D	Px3D	Px2D	Px1D	Px0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Output/input buffer drive register for stand-by mode							

(Purpose and use)

- This register is used to set each pin status at stand-by mode.
- All ports have this registers of the format shown above. (“x” indicates the port name.)
- For each register, refer to 3.5 function of ports.
- Before “Halt” instruction is executed, set each register according to the expected pin status. They will be effective after the CPU has executed the “Halt” instruction.
- This is the case regardless of stand-by mode (IDLE2, IDLE1 or STOP).
- The Output/Input buffer control table is shown below.

OE	PxnD	Output Buffer	Input Buffer
0	0	OFF	OFF
0	1	OFF	ON
1	0	OFF	OFF
1	1	ON	OFF

Note 1: OE denotes an output enable signal before stand-by mode.
Basically, PxCR is used as OE.

Note 2: “n” in PxnD denotes the bit number of PORTx

The subsequent actions performed in each mode are as follows:

1. IDLE2: only the CPU halts.

   The internal I/O is available to select operation during IDLE2 mode by setting the following register.

   Table 3.3.2 shows the register setting operation during IDLE2 mode.

Table 3.3.2 SFR Setting Operation during IDLE2 Mode

Internal I/O	SFR
TMRA01	TA01RUN<I2TA01>
TMRA23	TA23RUN<I2TA23>
TMRB0	TB0RUN<I2TB0>
SIO0	SC0MOD1<I2S0>
I^2C bus	SBI0BR0<I2SBI0>
AD converter	ADMOD1<I2AD>
WDT	WDMOD<I2WDT>

2. IDLE1: Only the oscillator, RTC (real-time clock) and MLD continue to operate.
3. STOP: All internal circuits stop operating.

The operation of each of the different HALT modes is described in Table 3.3.3.

Table 3.3.3 I/O Operation during HALT Modes

<table>
<tr><td colspan="2">HALT Mode</td><td>IDLE2</td><td>IDLE1</td><td>STOP</td></tr>
<tr><td colspan="2">SYSCR2<HALTM1:0></td><td>11</td><td>10</td><td>01</td></tr>
<tr><td rowspan="8">Block</td><td>CPU</td><td colspan="3">Stop</td></tr>
<tr><td>I/O ports</td><td colspan="3">Depend on PxDR register setting</td></tr>
<tr><td>TMRA, TMRB</td><td rowspan="4">Available to select operation block</td><td rowspan="3">Stop</td><td rowspan="4"></td></tr>
<tr><td>SIO, SBI</td></tr>
<tr><td>AD converter</td></tr>
<tr><td>WDT</td></tr>
<tr><td>I2S, LCDC, SDRAMC, Interrupt controller, USBC,</td><td rowspan="2">Operate</td><td rowspan="2"></td></tr>
<tr><td>RTC, MLD</td><td>Operate</td></tr>
</table>

(2) How to release the HALT mode

These halt states can be released by resetting or requesting an interrupt. The halt release sources are determined by the combination of the states of the interrupt mask register <IFF2:0> and the HALT modes. The details for releasing the halt status are shown in Table 3.3.4.

- Release by interrupt requesting

The HALT mode release method depends on the status of the enabled interrupt .When the interrupt request level set before executing the HALT instruction exceeds the value of the interrupt mask register, the interrupt is processed depending on its status after the HALT mode is released, and the CPU status executing the instruction that follows the HALT instruction. When the interrupt request level set before executing the HALT instruction is less than the value of the interrupt mask register, HALT mode release is not executed. (in non-maskable interrupts, interrupt processing is processed after releasing the HALT mode regardless of the value of the mask register.) However only for INT0 to INT4, INTKEY, INTRTC, INTALM and interrupts, even if the interrupt request level set before executing the halt instruction is less than the value of the interrupt mask register, HALT mode release is executed. In this case, the interrupt is processed, and the CPU starts executing the instruction following the HALT instruction, but the interrupt request flag is held at "1".

- Release by resetting

Release of all halt statuses is executed by resetting.

When the STOP mode is released by RESET, it is necessary to allow enough resetting time (see Table 3.3.5) for operation of the oscillator to stabilize.

When releasing the HALT mode by resetting, the internal RAM data keeps the state before the HALT instruction is executed. However the other settings contents are initialized. (Releasing due to interrupts keeps the state before the HALT instruction is executed.)

Table 3.3.4 Source of Halt State Clearance and Halt Clearance Operation

Status of Received Interrupt			Interrupt Enabled (Interrupt level) ≥ (Interrupt mask)			Interrupt Disabled (Interrupt level) < (Interrupt mask)		
HALT Mode			IDLE2	IDLE1	STOP	IDLE2	IDLE1	STOP
Source of Halt State Clearance	Interrupt	INTWD	♦	×	×	–	–	–
		INT0 to INT4 (Note 1)	♦	♦	♦*1	○	○	○*1
		INTALM0 to INTALM4	♦	♦	×	○	○	×
		INTTA0 to INTTA3, INTTB0 to INTTB1	♦	×	×	×	×	×
		INTRX0 to INTTX0, INTSBI	♦	×	×	×	×	×
		INTTBO0, INTI2S	♦	×	×	×	×	×
		INTAD, INT5, INTSPI	♦	×	×	×	×	×
		INTKEY	♦	♦	♦*1	○	○	○*1
		INTRTC	♦	♦	♦*1	○	○	○*1
		INTLCD	♦	×	×	×	×	×
	RESET		Initialize LSI					

♦: After clearing the HALT mode, CPU starts interrupt processing.

○: After clearing the HALT mode, CPU resumes executing starting from the instruction following the HALT instruction.

×: Cannot be used to release the HALT mode.

–: The priority level (interrupt request level) of non-maskable interrupts is fixed to 7, the highest priority level. This combination is not available.

*1: Release of the HALT mode is executed after warm-up time has elapsed.

Note 1: When the HALT mode is cleared by an INT0 interrupt of the level mode in the interrupt enabled status, hold level H until starting interrupt processing. If level L is set before holding level L, interrupt processing is correctly started.

Example: Releasing IDLE1 mode

An INT0 interrupt clears the halt state when the device is in IDLE1 mode.

```
Address
8200H   LD      (PCFC), 01H     ;   Sets PC0 to INT0.
8203H   LD      (IIMC), 00H     ;   Selects INT0 interrupt rising edge.
8206H   LD      (INTE0AD), 06H  ;   Sets INT0 interrupt level to 6.
8209H   EI      5               ;   Sets interrupt level to 5 for CPU.
820BH   LD      (SYSCR2), 28H   ;   Sets HALT mode to IDLE1 mode.
820EH   HALT                    ;   Halts CPU.
```


```
820FH   LD      XX, XX
```

(3) Operation

1. IDLE2 mode

In IDLE2 mode only specific internal I/O operations, as designated by the IDLE2 setting register, can take place. Instruction execution by the CPU stops.

Figure 3.3.7 illustrates an example of the timing for clearance of the IDLE2 mode halt state by an interrupt.

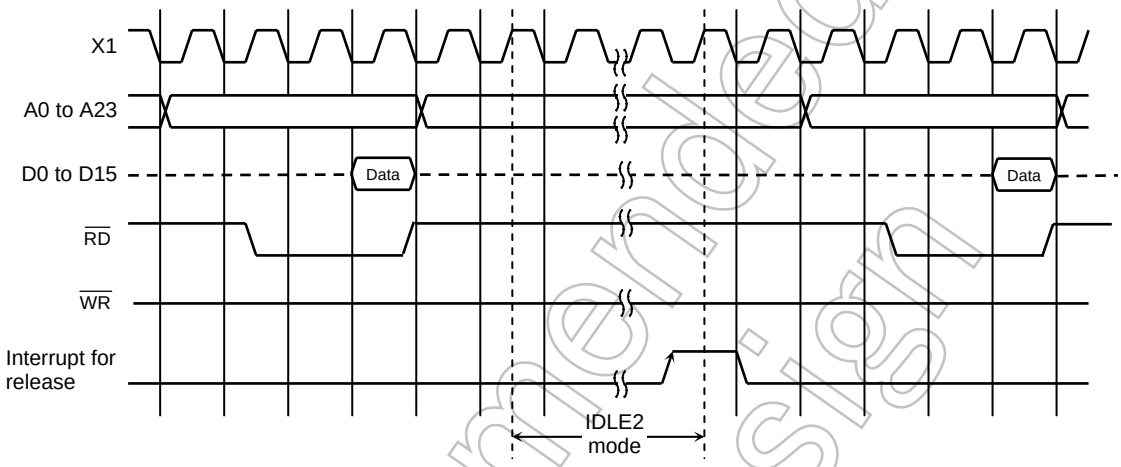


Figure 3.3.7 Timing Chart for IDLE2 Mode Halt State Cleared by Interrupt

2. IDLE1 mode

In IDLE1 mode, only the internal oscillator and the RTC and MLD continue to operate. The system clock stops.

In the halt state, the interrupt request is sampled asynchronously with the system clock; however, clearance of the halt state (e.g., restart of operation) is synchronous with it.

Figure 3.3.8 illustrates the timing for clearance of the IDLE1 mode halt state by an interrupt.

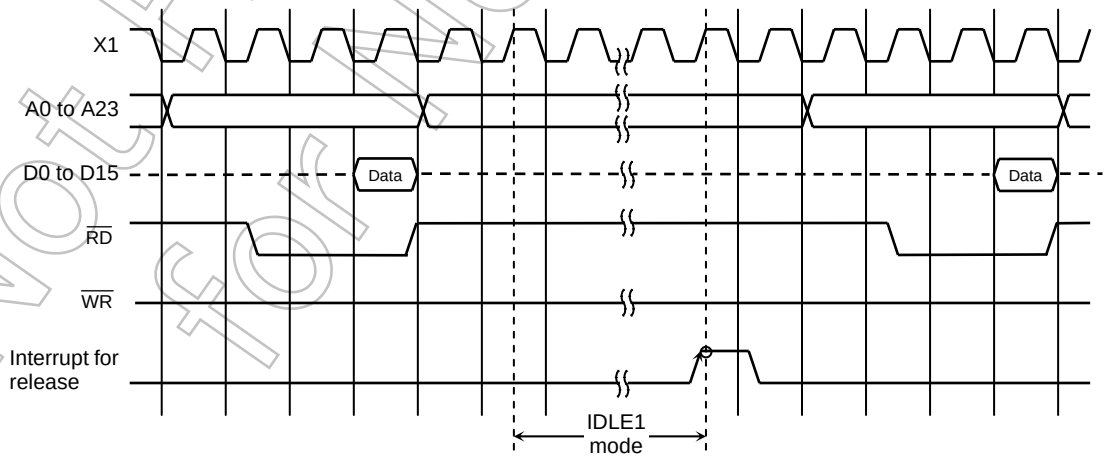


Figure 3.3.8 Timing Chart for IDLE1 Mode Halt State Cleared by Interrupt

3. STOP mode

When STOP mode is selected, all internal circuits stop, including the internal oscillator.

After STOP mode has been cleared system clock output starts when the warm-up time has elapsed, in order to allow oscillation to stabilize.

Figure 3.3.9 illustrates the timing for clearance of the STOP mode halt state by an interrupt.

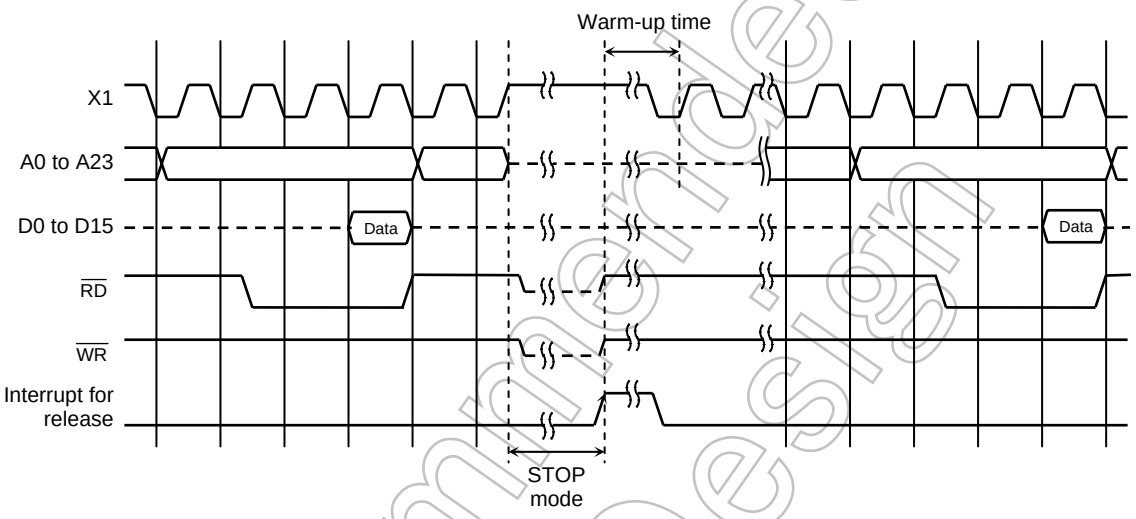


Figure 3.3.9 Timing Chart for STOP Mode Halt State Cleared by Interrupt

Table 3.3.5 Example of Warm-up Time after Releasing STOP Mode

at f_{OSCH} = 40 MHz, fs = 32.768 kHz

SYSCR1 <SYSCK>	SYSCR2<WUPTM1:0>		
	01 (2^8)	10 (2^{14})	11 (2^{16})
0 (fc)	6.4 μs	409.6 μs	1.638 ms
1 (fs)	7.8 ms	500 ms	2000 ms

Table 3.3.6 Input Buffer State Table

Port Name	Input Function Name	Input Buffer State						
		During Reset	When the CPU is operating		In HALT mode (IDLE1/2/STOP)			
					<PxDR> = 1		<PxDR> = 0	
			When used as Function pin	When used as Input pin	When used as Function pin	When used as Input pin	When used as Function pin	When used as Input pin
D0~D7	D0~D7	OFF	ON upon external read	–	OFF	–	OFF	–
P10~P17	D8~D15			ON upon port read		ON		OFF
P60~P67	–		–		–		–	
P71~P72	–	ON	–		–		–	
P75	NDR/$\overline{B}$		ON		ON		OFF	
P76	$\overline{WAIT}$							
P90	–		–		–		–	
P91	RXD0		ON		ON		OFF	
P92	$\overline{CTS0}$, SCLK0							
P93~P94	SDA, SCL							
P96 *1	INT4							
P97	INT5							
PA0~PA7 *1	KI0-KI7							
PC0	INT0							
PC1	INT1							
PC2	INT2							
PC3	INT3							
PC4~PC7	–		–		–		–	
PF0	–							
PF1	RXD0		ON		ON		OFF	
PF2	$\overline{CTS0}$ SCLK0							
PG0~PG2 *2	–	OFF	–	ON upon port read	–	OFF	–	
PG3 *2	$\overline{ADTRG}$		ON		ON		ON	
PJ5~PJ6	–	ON	–	ON	–	ON	–	
PK4	SPDI		ON		ON		OFF	
PK5~PK5	–		–		–		–	
PL4~PL5, PL7	–							
PL6	$\overline{BUSRQ}$		ON		ON		OFF	
PN0~PN7	–		–		–		–	
$\overline{BE}$	–		ON	–	ON	–	ON	–
$\overline{RESET}$	–							
AM0, AM1	–							
X1, XT1	–				IDLE2/IDLE1:ON, STOP:OFF			

ON: The buffer is always turned on. A current flows the input buffer if the input pin is not driven.

OFF: The buffer is always turned off.

–: No applicable

*1: Port having a pull-up/pull-down resistor.

*2: AIN input does not cause a current to flow through the buffer.

Table 3.3.7 Output Buffer State Table (1/2)

Port Name	Output Function Name	Output Buffer State						
		During Reset	When the CPU is operating		In HALT mode (IDLE1/2/STOP)			
					<PxDR> = 1		<PxDR> = 0	
			When used as Function pin	When used as Output pin	When used as Function pin	When used as Output pin	When used as Function pin	When used as Output pin
D0~D7	D0~D7	OFF	ON upon external write	–	OFF	–	OFF	–
P10~P17	D8~D15			ON		ON		OFF
A0~A15	A16~A15,	ON	ON	–	ON	–	OFF	–
P60~P67	A16~A23			ON		ON		OFF
P70	$\overline{RD}$							
P71	$\overline{WRLL}$, $\overline{NDRE}$	OFF						
P72	$\overline{WRLU}$, $\overline{NDWE}$							
P73	EA24							
P74	EA25							
P75	R/W							
P76	–		–		–		–	
P80	$\overline{CS0}$	ON	ON	ON	ON	ON	OFF	OFF
P81	$\overline{CS1}$, $\overline{SDCS}$							
P82	$\overline{CS2}$, $\overline{CSZA}$							
P83	$\overline{CS3}$							
P84	$\overline{CSZB}$, $\overline{ND0CE}$							
P85	$\overline{CSZC}$, $\overline{ND1CE}$							
P86	$\overline{CSZD}$							
P87	$\overline{CSZE}$							
P90	TXD0, I2SCKO	OFF						
P91	I2SDO							
P92	I2SWS							
P93	SDA							
P94	SCL							
P95	CLK32KO	ON						
P96	PX	OFF		–		–		–
P97	PY							

ON: The buffer is always turned on.

OFF: The buffer is always turned off.

–: Not applicable

*1: Port having a pull-up/pull-down resistor.

Table 3.3.8 Output Buffer State Table (2/2)

Port Name	Output Function Name	Output Buffer State						
		During Reset	When the CPU is operating		In HALT mode (IDLE1/2/STOP)			
					<PxDR> = 1		<PxDR> = 0	
			When used as Function pin	When used as Output pin	When used as Function pin	When used as Output pin	When used as Function pin	When used as Output pin
PC0	TA1OUT	OFF	ON	ON	ON	ON	OFF	OFF
PC1	TA3OUT							
PC2	TB0OUT0							
PC3	–		–		–		–	
PC6	KO8, EA24		ON		ON		OFF	
PC7	$\overline{\text{CSZF}}$, EA25							
PF0	TXD0							
PF1	–		–		–		–	
PF2	SCLK0		ON		ON		OFF	
PF7	SDCLK	ON						
PG2	MX	OFF		–		–		–
PG3	MY							
PJ0	$\overline{\text{SDRAS}}$ $\overline{\text{SRLLB}}$	ON		ON		ON		OFF
PJ1	$\overline{\text{SDCAS}}$, $\overline{\text{SRLUB}}$							
PJ2	$\overline{\text{SDWE}}$, $\overline{\text{SRWR}}$							
PJ3	SDLLDQM							
PJ4	SDLUDQM							
PJ5	NDALE	OFF						
PJ6	NDCLE							
PJ7	SDCKE	ON						
PK0	LCP							
PK1	LLP							
PK2	LFR							
PK3	LBCD							
PK4	–		–		–		–	
PK5	SPDO	OFF						
PK6	$\overline{\text{SPCS}}$							
PK7	SPCLK							
PL0~PL3	LD0~LD3	ON						
PL4~PL6	LD4~LD6	OFF						
PL7	LD7, $\overline{\text{BUSAK}}$							
PM1	MLDALM	ON						
PM2	$\overline{\text{MLDALM}}$, $\overline{\text{ALARM}}$							
PN0~PN7	KO0~KO7	OFF						
X2	–	ON		–		–	IDLE2/1:ON, STOP: output "H"	
XT2	–						IDLE2/1:ON, STOP: output "HZ"	

ON: The buffer is always turned on.

OFF: The buffer is always turned off.

–: Not applicable

*1: Port having a pull-up/pull-down resistor.

3.4 Interrupts

Interrupts are controlled by the CPU Interrupt mask register <IFF2:0> (bits12 to 14 of the status register) and by the built-in interrupt controller.

The TMP92CA25 has a total of 49 interrupts divided into the following five types:

Interrupts generated by CPU: 9 sources
- Software interrupts: 8 sources
- Illegal instruction interrupt: 1 source

Internal interrupts: 33 sources
- Internal I/O interrupts: 25 sources
- Micro DMA transfer end interrupts: 8 sources

External interrupts: 7 sources
- Interrupts on external pins (INT0 to INT5, INTKEY)

A fixed individual interrupt vector number is assigned to each interrupt source.

Any one of six levels of priority can also be assigned to each maskable interrupt. Non-maskable interrupts have a fixed priority level of 7, the highest level.

When an interrupt is generated, the interrupt controller sends the priority of that interrupt to the CPU. When more than one interrupt is generated simultaneously, the interrupt controller sends the priority value of the interrupt with the highest priority to the CPU. (The highest priority level is 7, the level used for non-maskable interrupts.)

The CPU compares the interrupt priority level which it receives with the value held in the CPU interrupt mask register <IFF2:0>. If the priority level of the interrupt is greater than or equal to the value in the interrupt mask register, the CPU accepts the interrupt.

However, software interrupts and illegal instruction interrupts generated by the CPU are processed irrespective of the value in <IFF2:0>.

The value in the interrupt mask register <IFF2:0> can be changed using the EI instruction (EI num sets <IFF2:0> to num). For example, the command EI 3 enables the acceptance of all non-maskable interrupts and of maskable interrupts whose priority level, as set in the interrupt controller, is 3 or higher. The commands EI and EI 0 enable the acceptance of all non-maskable interrupts and of maskable interrupts with a priority level of 1 or above (hence both are equivalent to the command EI 1).

The DI instruction (sets <IFF2:0> to 7) is exactly equivalent to the EI 7 instruction. The DI instruction is used to disable all maskable interrupts (since the priority level for maskable interrupts ranges from 1 to 6). The EI instruction takes effect as soon as it is executed.

In addition to the general purpose interrupt processing mode described above, there is also a micro DMA processing mode.

In micro DMA mode the CPU automatically transfers data in one-byte, two-byte or four-byte blocks; this mode allows high-speed data transfer to and from internal and external memory and internal I/O ports.

In addition, the TMP92CA25 also has a software start function in which micro DMA processing is requested in software rather than by an interrupt.

Figure 3.4.1 is a flowchart showing overall interrupt processing.

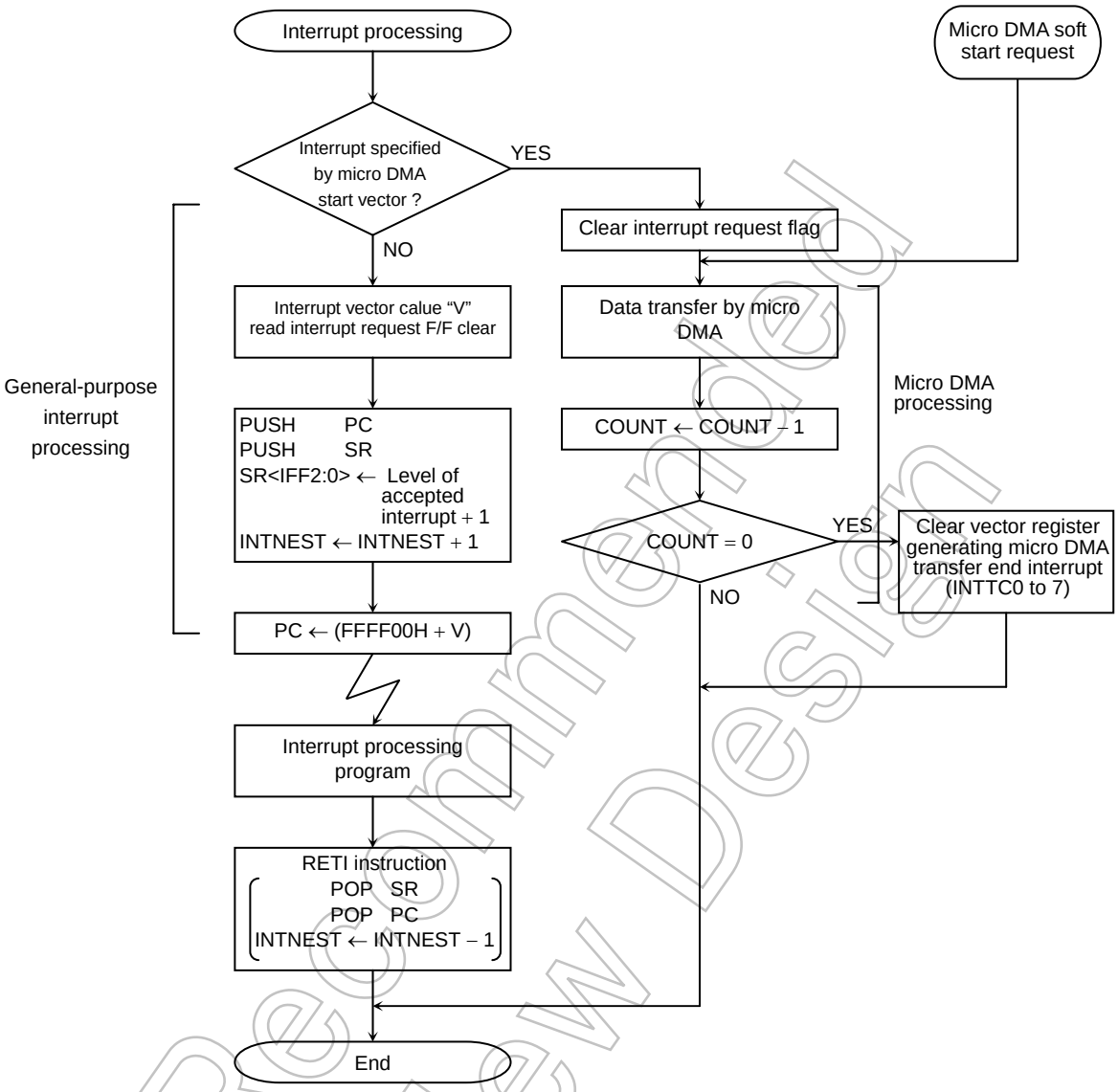


Figure 3.4.1 Interrupt and Micro DMA Processing Sequence

3.4.1 General-purpose Interrupt Processing

When the CPU accepts an interrupt, it usually performs the following sequence of operations. However, in the case of software interrupts and illegal instruction interrupts generated by the CPU, the CPU skips steps (1) and (3), and executes only steps (2), (4) and (5).

(1) The CPU reads the interrupt vector from the interrupt controller.

When more than one interrupt with the same priority level has been generated simultaneously, the interrupt controller generates an interrupt vector in accordance with the default priority and clears the interrupt requests.

(The default priority is determined as follows: the smaller the vector value, the higher the priority.)

(2) The CPU pushes the program counter (PC) and status register (SR) onto the top of the stack (pointed to by XSP).

(3) The CPU sets the value of the CPU's interrupt mask register <IFF2:0> to the priority level for the accepted interrupt plus 1. However, if the priority level for the accepted interrupt is 7, the register's value is set to 7.

(4) The CPU increments the interrupt nesting counter INTNEST by 1.

(5) The CPU jumps to the address given by adding the contents of address FFFF00H + the interrupt vector, then starts the interrupt processing routine.

On completion of interrupt processing, the RETI instruction is used to return control to the main routine. RETI restores the contents of the program counter and the status register from the stack and decrements the interrupt nesting counter INTNEST by 1.

Non-maskable interrupts cannot be disabled by a user program. Maskable interrupts, however, can be enabled or disabled by a user program. A program can set the priority level for each interrupt source. (A priority level setting of 0 or 7 will disable an interrupt request.)

If an interrupt request is received for an interrupt with a priority level equal to or greater than the value set in the CPU interrupt mask register <IFF2:0>, the CPU will accept the interrupt. The CPU interrupt mask register <IFF2:0> is then set to the value of the priority level for the accepted interrupt plus 1.

If during interrupt processing, an interrupt is generated with a higher priority than the interrupt currently being processed, or if, during the processing of a non-maskable interrupt processing, a non-maskable interrupt request is generated from another source, the CPU will suspend the routine which it is currently executing and accept the new interrupt. When processing of the new interrupt has been completed, the CPU will resume processing of the suspended interrupt.

If the CPU receives another interrupt request while performing processing steps (1) to (5), the new interrupt will be sampled immediately after execution of the first instruction of its interrupt processing routine. Specifying DI as the start instruction disables nesting of maskable interrupts.

A reset initializes the interrupt mask register <IFF2:0> to 111, disabling all maskable interrupts.

Table 3.4.1 shows the TMP92CA25 interrupt vectors and micro DMA start vectors. FFFF00H to FFFFFFH (256 bytes) is designated as the interrupt vector area.

Table 3.4.1 TMP92CA25 Interrupt Vectors and Micro DMA Start Vectors

Default Priority	Type	Interrupt Source and Source of Micro DMA Request	Vector Value	Address Refer to Vector	Micro DMA Start Vector
1	Non-maskable	Reset or [SWI0] instruction	0000H	FFFF00H	
2		[SWI1] instruction	0004H	FFFF04H	
3		Illegal instruction or [SWI2] instruction	0008H	FFFF08H	
4		[SWI3] instruction	000CH	FFFF0CH	
5		[SWI4] instruction	0010H	FFFF10H	
6		[SWI5] instruction	0014H	FFFF14H	
7		[SWI6] instruction	0018H	FFFF18H	
8		[SWI7] instruction	001CH	FFFF1CH	
9		(Reserved)	0020H	FFFF20H	
10		INTWD: Watchdog Timer	0024H	FFFF24H	
–	Maskable	Micro DMA	–	–	– (Note1)
11		INT0: INT0 pin input	0028H	FFFF28H	0AH (Note 2)
12		INT1: INT1 pin input	002CH	FFFF2CH	0BH
13		INT2: INT2 pin input	0030H	FFFF30H	0CH
14		INT3: INT3 pin input	0034H	FFFF34H	0DH
15		INT4: INT4 pin input (TSI)	0038H	FFFF38H	0EH
16		INTALM0: ALM0 (8192 Hz)	003CH	FFFF3CH	0FH
17		INTALM1: ALM1 (512 Hz)	0040H	FFFF40H	10H
18		INTALM2: ALM2 (64 Hz)	0044H	FFFF44H	11H
19		INTALM3: ALM3 (2 Hz)	0048H	FFFF48H	12H
20		INTALM4: ALM4 (1 Hz)	004CH	FFFF4CH	13H
21		INTP0: Protect0 (Write to special SFR)	0050H	FFFF50H	14H
22		(Reserved)	0054H	FFFF54H	15H
23		INTTA0: 8-bit timer 0	0058H	FFFF58H	16H
24		INTTA1: 8-bit timer 1	005CH	FFFF5CH	17H
25		INTTA2: 8-bit timer 2	0060H	FFFF60H	18H
26		INTTA3: 8-bit timer 3	0064H	FFFF64H	19H
27		INTTB0: 16-bit timer 0	0068H	FFFF68H	1AH
28		INTTB1: 16-bit timer 0	006CH	FFFF6CH	1BH
29		INTKEY: Key-on wakeup	0070H	FFFF70H	1CH
30		INTRTC: RTC (Alarm interrupt)	0074H	FFFF74H	1DH
31		INTTBO0: 16-bit timer 0 (Overflow)	0078H	FFFF78H	1EH
32		INTLCD: LCDC/LP pin	007CH	FFFF7CH	1FH
33		INTRX0: Serial receive (Channel 0)	0080H	FFFF80H	20H (Note 2)
34		INTTX0: Serial transmission (Channel 0)	0084H	FFFF84H	21H
35		(Reserved)	0088H	FFFF88H	22H (Note 2)
36		(Reserved)	008CH	FFFF8CH	23H
37		(Reserved)	0090H	FFFF90H	24H
38		(Reserved)	0094H	FFFF94H	25H
39		INT5: INT5 pin input	0098H	FFFF98H	26H
40		INTI2S: I^2S (Channel 0)	009CH	FFFF9CH	27H
41		INTNDF0 (NAND flash controller channel 0)	00A0H	FFFFA0H	28H
42		INTNDF1 (NAND flash controller channel 1)	00A4H	FFFFA4H	29H
43		INTSPI: SPIC	00A8H	FFFFA8H	2AH
44		INTSBI: SBI	00ACH	FFFFACH	2BH
45		(Reserved)	00B0H	FFFFB0H	2CH
46		(Reserved)	00B4H	FFFFB4H	2DH
47		(Reserved)	00B8H	FFFFB8H	2EH
48		(Reserved)	00BCH	FFFFBCH	2FH
49		(Reserved)	00C0H	FFFFC0H	30H
50		(Reserved)	00C4H	FFFFC4H	31H

Default Priority	Type	Interrupt Source and Source of Micro DMA Request	Vector Value	Address Refer to Vector	Micro DMA Start Vector
51	Maskable	(Reserved)	00C8H	FFFFC8H	32H
52		INTAD: AD conversion end	00CCH	FFFFCCH	33H
53		INTTC0: Micro DMA end (Channel 0)	00D0H	FFFFD0H	34H
54		INTTC1: Micro DMA end (Channel 1)	00D4H	FFFFD4H	35H
55		INTTC2: Micro DMA end (Channel 2)	00D8H	FFFFD8H	36H
56		INTTC3: Micro DMA end (Channel 3)	00DCH	FFFFDCH	37H
57		INTTC4: Micro DMA end (Channel 4)	00E0H	FFFFE0H	38H
58		INTTC5: Micro DMA end (Channel 5)	00E4H	FFFFE4H	39H
59		INTTC6: Micro DMA end (Channel 6)	00E8H	FFFFE8H	3AH
60		INTTC7: Micro DMA end (Channel 7)	00ECH	FFFFECH	3BH
– to –		(Reserved)	00F0H : 00FCH	FFFFF0H : FFFFFCH	– to –

Note 1: Micro DMA default priority.
Micro DMA initiation takes priority over other maskable interrupts.

Note 2: When initiating micro DMA, set at edge detect mode.

3.4.2 Micro DMA Processing

In addition to general purpose interrupt processing, the TMP92CA25 also includes a micro DMA function. Micro DMA processing for interrupt requests set by micro DMA is performed at the highest priority level for maskable interrupts (level 6), regardless of the priority level of the interrupt source.

Because the micro DMA function is implemented through the CPU, when the CPU is placed in a stand-by state by a Halt instruction, the requirements of the micro DMA will be ignored (pending).

Micro DMA supports 8 channels and can be transferred continuously by specifying the micro DMA burst function as below.

Note: When using the micro DMA transfer end interrupt, always write “1” to bit 7 of SIMC register.

(1) Micro DMA operation

When an interrupt request is generated by an interrupt source specified by the micro DMA start vector register, the micro DMA triggers a micro DMA request to the CPU at interrupt priority level 6 and starts processing the request. The eight micro DMA channels allow micro DMA processing to be set for up to eight types of interrupt at once.

When micro DMA is accepted, the interrupt request flip-flop assigned to that channel is cleared. Data in one-byte, two-byte or four-byte blocks, is automatically transferred at once from the transfer source address to the transfer destination address set in the control register, and the transfer counter is decremented by 1. If the value of the counter after it has been decremented is not 0, DMA processing ends with no change in the value of the micro DMA start vector register. If the value of the decremented counter is 0, a micro DMA transfer end interrupt (INTTC0 to INTTC7) is sent from the CPU to the interrupt controller. In addition, the micro DMA start vector register is cleared to 0, the next micro DMA operation is disabled and micro DMA processing terminates.

If micro DMA requests are set simultaneously for more than one channel, priority is not based on the interrupt priority level but on the channel number: the lower the channel number, the higher the priority (channel 0 thus has the highest priority and channel 7 the lowest).

If an interrupt request is triggered for the interrupt source in use during the interval between the time at which the micro DMA start vector is cleared and the next setting, general purpose interrupt processing is performed at the interrupt level set. Therefore, if the interrupt is only being used to initiate micro DMA (and not as a general-purpose interrupt), the interrupt level should first be set to 0 (i.e., interrupt requests should be disabled).

If micro DMA and general purpose interrupts are being used together as described above, the level of the interrupt which is being used to initiate micro DMA processing should first be set to a lower value than all the other interrupt levels. (Note) In this case, edge triggered interrupts are the only kinds of general interrupts which can be accepted.

Note: If the priority level of micro DMA is set higher than that of other interrupts, CPU operates as follows.
In case INTxxx interrupt is generated first and then INTyyy interrupt is generated between checking “Interrupt specified by micro DMA start vector” (in the Figure 3.4.1) and reading interrupt vector with setting below. The vector shifts to that of INTyyy at the time.
This is because the priority level of INTyyy is higher than that of INTxxx.
In the interrupt routine, CPU reads the vector of INTyyy because cheking of micro DMA has finished.
And INTyyy is generated regardless of transfer counter of micro DMA.
INTxxx: level 1 without micro DMA
INTyyy: level 6 with micro DMA

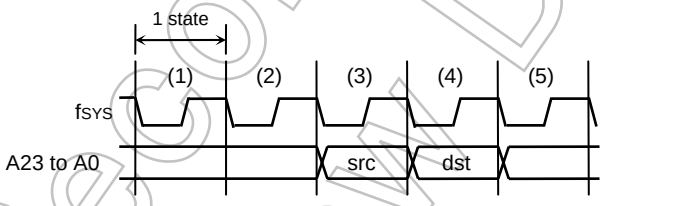
Although the control registers used for setting the transfer source and transfer destination addresses are 32 bits wide, this type of register can only output 24-bit addresses. Accordingly, micro DMA can only access 16 Mbytes (the upper eight bits of a 32-bit address are not valid).

Three micro DMA transfer modes are supported: one-byte transfers, two-byte (one-word) transfer and four-byte transfer. After a transfer in any mode, the transfer source and transfer destination addresses will either be incremented or decremented, or will remain unchanged. This simplifies the transfer of data from memory to memory, from I/O to memory, from memory to I/O, and from I/O to I/O. For details of the various transfer modes, see section 3.4.2 (1), detailed description of the transfer mode register.

Since a transfer counter is a 16-bit counter, up to 65536 micro DMA processing operations can be performed per interrupt source (provided that the transfer counter for the source is initially set to 0000H).

Micro DMA processing can be initiated by any one of 34 different interrupts – the 33 interrupts shown in the micro DMA start vectors in Table 3.4.1 and a micro DMA soft start.

Figure 3.4.2 shows a 2-byte transfer carried out using a micro DMA cycle in transfer destination address INC mode (micro DMA transfers are the same in every mode except counter mode). (The conditions for this cycle are as follows: Both source and destination memory are internal RAM and multiples by 4 numbered source and destination addresses.)



Note: In fact, src and dst address are not output to A23 to A0 pins because they are internal RAM address.

Figure 3.4.2 Timing for Micro DMA Cycle

State (1), (2): Instruction fetch cycle (Prefetches the next instruction code)

State (3): Micro DMA read cycle

State (4): Micro DMA write cycle

State (5): (The same in state (1), (2))

(2) Soft start function

The TMP92CA25 can initiate micro DMA either with an interrupt or by using the micro DMA soft start function, in which micro DMA is initiated by a write cycle which writes to the register DMAR.

Writing 1 to any bit of the register DMAR causes micro DMA to be performed once. (If write "0" to each bit, micro DMA doesn't operate). On completion of the transfer, the bits of DMAR which support the end channel are automatically cleared to 0.

Only one channel can be set for DMA request at once. (Do not write "1" to plural bits.)

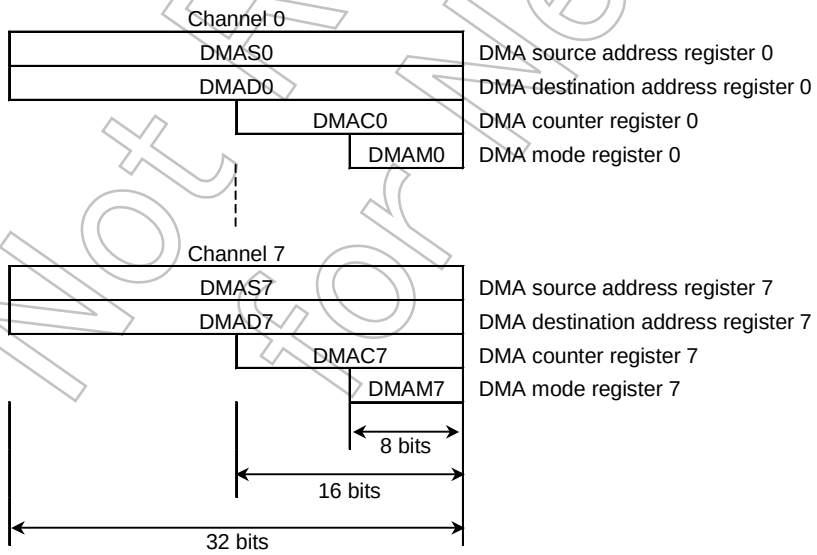
When writing again 1 to the DMAR register, check whether the bit is "0" before writing "1". If read "1", micro DMA transfer isn't started yet.

When a burst is specified by the DMAB register, data is transferred continuously from the initiation of micro DMA until the value in the micro DMA transfer counter is 0. If execatee soft start during micro DMA transfer by interrupt source, micro DMA transfer counter doesn't change. Don't use Read-modify-write instruction to avoid writign to other bits by mistake.

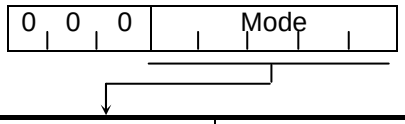
Symbol	Name	Address	7	6	5	4	3	2	1	0
DMAR	DMA Request	109H (Prohibit RMW)	DREQ7	DREQ6	DREQ5	DREQ4	DREQ3	DREQ2	DREQ1	DREQ0
			R/W							
			0	0	0	0	0	0	0	0
			1: DMA request in software							

(3) Transfer control registers

The transfer source address and the transfer destination address are set in the following registers. An instruction of the form LDC cr, r can be used to set these registers.



(4) Detailed description of the transfer mode register



DMAMn[4:0]	Mode Description	Execution State Number
0 0 0 z z	Destination INC mode (DMADn+) ← (DMASn) DMACn ← DMACn − 1 if DMACn = 0 then INTTCn	5 states
0 0 1 z z	Destination DEC mode (DMADn−) ← (DMASn) DMACn ← DMACn − 1 if DMACn = 0 then INTTCn	5 states
0 1 0 z z	Source INC mode (DMADn) ← (DMASn+) DMACn ← DMACn − 1 if DMACn = 0 then INTTCn	5 states
0 1 1 z z	Source DEC mode (DMADn) ← (DMASn−) DMACn ← DMACn − 1 if DMACn = 0 then INTTCn	5 states
1 0 0 z z	Source and destination INC mode (DMADn+) ← (DMASn+) DMACn ← DMACn − 1 If DMACn = 0 then INTTCn	6 states
1 0 1 z z	Source and destination DEC mode (DMADn−) ← (DMASn−) DMACn ← DMACn − 1 If DMACn = 0 then INTTCn	6 states
1 1 0 z z	Source and destination Fixed mode (DMADn) ← (DMASn) DMACn ← DMACn − 1 If DMACn = 0 then INTTCn	5 states
1 1 1 0 0	Counter mode DMASn ← DMASn + 1 DMACn ← DMACn − 1 if DMACn = 0 then INTTCn	5 states

ZZ: 00 = 1-byte transfer
01 = 2-byte transfer
10 = 4-byte transfer
11 = (Reserved)

Note1: N stands for the micro DMA channel number (0 to 7)
DMADn+/DMASn+: Post-increment (register value is incremented after transfer)
DMADn−/DMASn−: Post-decrement (register value is decremented after transfer)
“I/O” signifies fixed memory addresses; “memory” signifies incremented or decremented memory addresses.

Note2: The transfer mode register should not be set to any value other than those listed above.

Note3: The execution state number shows number of best case (1-state memory access).

3.4.3 Interrupt Controller Operation

The block diagram in Figure 3.4.3 shows the interrupt circuits. The left hand side of the diagram shows the interrupt controller circuit. The right hand side shows the CPU interrupt request signal circuit and the halt release circuit.

For each of the 52 interrupts channels there is an interrupt request flag (consisting of a flip-flop), an interrupt priority setting register and a micro DMA start vector register. The interrupt request flag latches interrupt requests from the peripherals. The flag is cleared to zero in the following cases: when a reset occurs, when the CPU reads the channel vector of an interrupt it has received, when the CPU receives a micro DMA request (when micro DMA is set), when a micro DMA burst transfer is terminated, and when an instruction that clears the interrupt for that channel is executed (by writing a micro DMA start vector to the INTCLR register).

An interrupt priority can be set independently for each interrupt source by writing the priority to the interrupt priority setting register (e.g., INTE0AD or INTE12). 6 interrupt priorities levels (1 to 6) are provided. Setting an interrupt source's priority level to 0 (or 7) disables interrupt requests from that source. The priority of non-maskable interrupt (watchdog timer interrupts) is fixed at 7. If more than one interrupt request with a given priority level are generated simultaneously, the default priority (the interrupt with the lowest priority or, in other words, the interrupt with the lowest vector value) is used to determine which interrupt request is accepted first.

The 3rd and 7th bit of the interrupt priority setting register indicate the state of the interrupt request flag and thus whether an interrupt request for a given channel has occurred.

If several interrupts are generated simultaneously, the interrupt controller sends the interrupt request for the interrupt with the highest priority and the interrupt's vector address to the CPU. The CPU compares the mask value set in <IFF2:0> of the status register (SR) with the priority level of the requested interrupt; if the latter is higher, the interrupt is accepted. Then the CPU sets SR<IFF2:0> to the priority level of the accepted interrupt + 1. Hence, during processing of the accepted interrupt, new interrupt requests with a priority value equal to or higher than the value set in SR<IFF2:0> (e.g., interrupts with a priority higher than the interrupt being processed) will be accepted.

When interrupt processing has been completed (e.g., after execution of a RETI instruction), the CPU restores to SR<IFF2:0> the priority value which was saved on the stack before the interrupt was generated.

The interrupt controller also includes eight registers which are used to store the micro DMA start vector. Writing the start vector of the interrupt source for the micro DMA processing (see Table 3.4.1), enables the corresponding interrupts to be processed by micro DMA processing. The values must be set in the micro DMA parameter registers (e.g., DMAS and DMAD) prior to micro DMA processing.

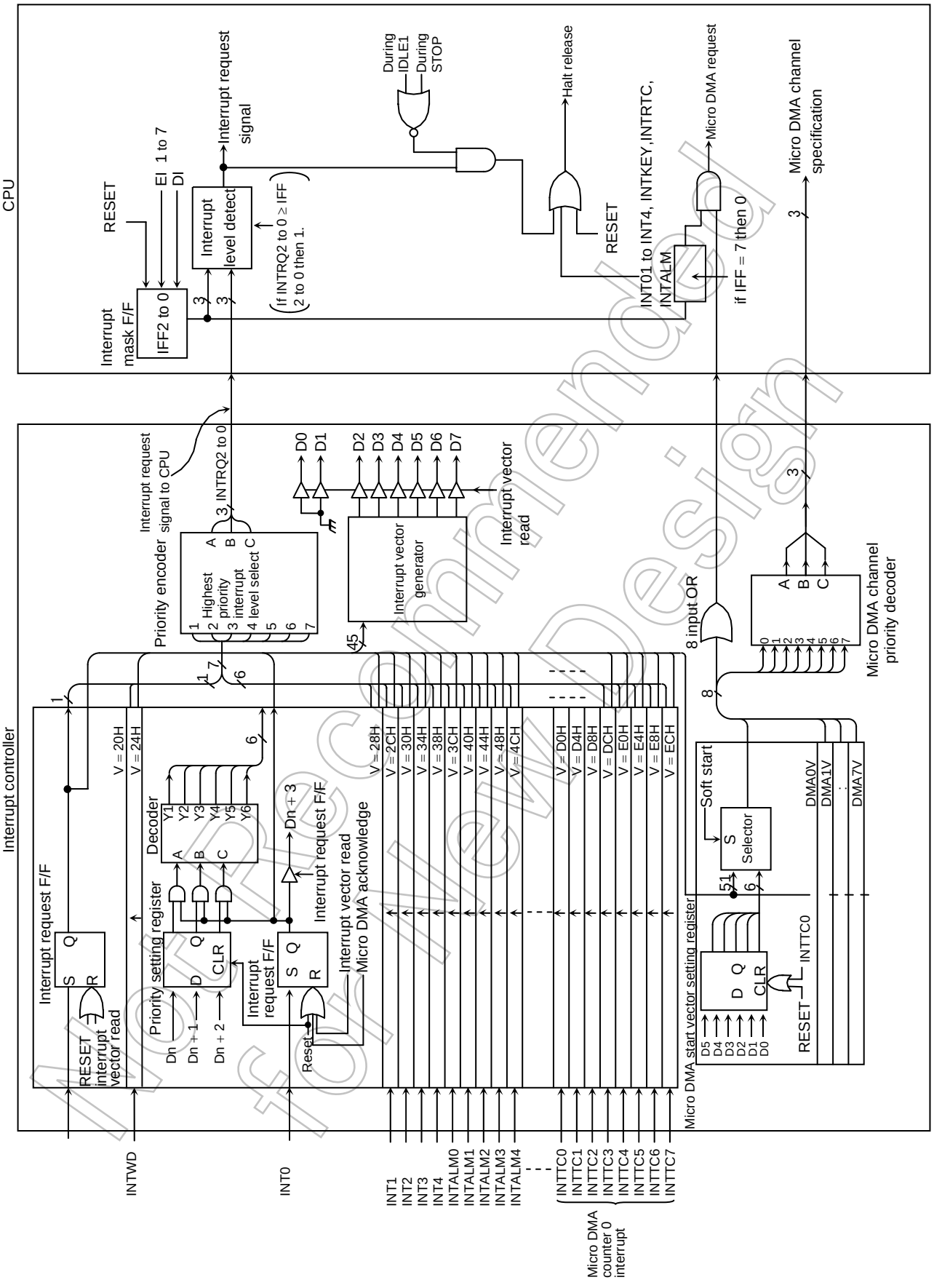
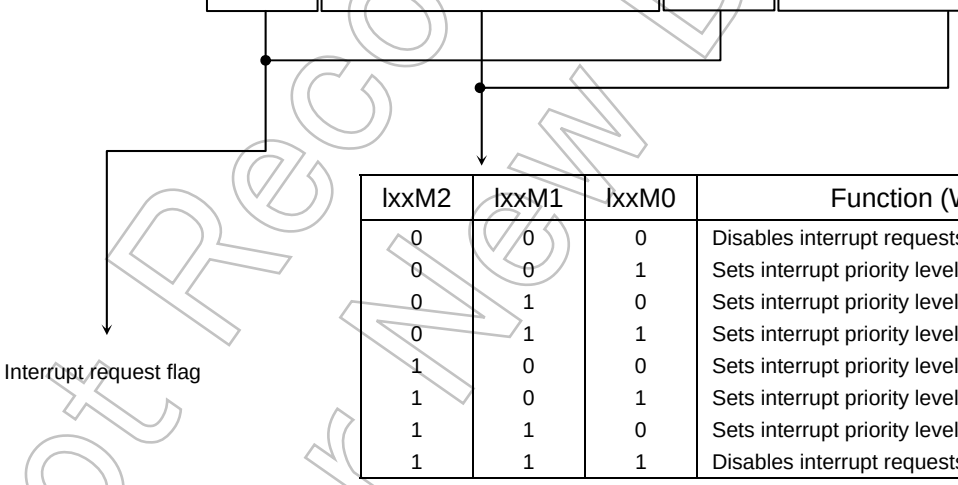


Figure 3.4.3 Block Diagram of Interrupt Controller

(1) Interrupt level setting registers

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTE0AD	INT0 & INTAD enable	F0H	INTAD				INT0			
			IADC	IADM2	IADM1	IADM0	I0C	I0M2	I0M1	I0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTE12	INT1 & INT2 enable	D0H	INT2				INT1			
			I2C	I2M2	I2M1	I2M0	I1C	I1M2	I1M1	I1M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTE34	INT3 & INT4 enable	D1H	INT4				INT3			
			I4C	I4M2	I4M1	I4M0	I3C	I3M2	I3M1	I3M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTE5I2S	INT5 & INTI2S enable	EBH	INTI2S				INT5			
			II2SC	II2SM2	II2SM1	II2SM0	I5C	I5M2	I5M1	I5M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETA01	INTTA0 & INTTA1 enable	D4H	INTTA1 (TMRA1)				INTTA0 (TMRA0)			
			ITA1C	ITA1M2	ITA1M1	ITA1M0	ITA0C	ITA0M2	ITA0M1	ITA0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETA23	INTTA2 & INTTA3 enable	D5H	INTTA3 (TMRA3)				INTTA2 (TMRA2)			
			ITA3C	ITA3M2	ITA3M1	ITA3M0	ITA2C	ITA2M2	ITA2M1	ITA2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETB01	INTTB0 & INTTB1 enable	D8H	INTTB1 (TMRB1)				INTTB0 (TMRB0)			
			ITB1C	ITB1M2	ITB1M1	ITB1M0	ITB0C	ITB0M2	ITB0M1	ITB0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETBO0	INTTBO0 (Overflow) enable	DAH	–				INTTBO0			
			–	–	–	–	ITBO0C	ITBO0M2	ITBO0M1	ITBO0M0
			Note: Always write 0				R	R/W		
							0	0	0	0
INTES0	INTRX0 & INTTX0 enable	DBH	INTTX0				INTRX0			
			ITX0C	ITX0M2	ITX0M1	ITX0M0	IRX0C	IRX0M2	IRX0M1	IRX0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTESPI	INTSPI enable	E0H	INTTX1				–			
			ITX1C	ITX1M2	ITX1M1	ITX1M0	–	–	–	–
			R	R/W						
			0	0	0	0	Note: Always write 0			
INTEALM01	INTALM0 & INTALM1 enable	E5H	INTALM1				INTALM0			
			IA1C	IA1M2	IA1M1	IA1M0	IA0C	IA0M2	IA0M1	IA0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTEALM23	INTALM2 & INTALM3 enable	E6H	INTALM3				INTALM2			
			IA3C	IA3M2	IA3M1	IA3M0	IA2C	IA2M2	IA2M1	IA2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTEALM4	INTALM4 enable	E7H	–				INTALM4			
			–	–	–	–	IA4C	IA4M2	IA4M1	IA4M0
			R				R	R/W		
			Note: Always write 0				0	0	0	0
INTERTC	INTRTC enable	E8H	–				INTRTC			
			–	–	–	–	IRC	IRM2	IRM1	IRM0
			R				R	R/W		
			Note: Always write 0				0	0	0	0
INTEKEY	INTKEY enable	E9H	–				INTKEY			
			–	–	–	–	IKC	IKM2	IKM1	IKM0
			R				R	R/W		
			Note: Always write 0				0	0	0	0
INTELCD	INTLCD enable	EAH	–				INTLCD			
			–	–	–	–	ILCD1C	ILCDM2	ILCDM1	ILCDM0
			R				R	R/W		
			Note: Always write 0				0	0	0	0
INTEND01	INTNDF0 & INTNDF1 enable	ECH	INTNDF1				INTNDF0			
			IN1C	IN1M2	IN1M1	IN1M0	IN0C	IN0M2	IN0M1	IN0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTEP0	INTP0 enable	EEH	–				INTP0			
			–	–	–	–	IP0C	IP0M2	IP0M1	IP0M0
			R				R	R/W		
			Note: Always write 0				0	0	0	0



IxxM2	IxxM1	IxxM0	Function (Write)
0	0	0	Disables interrupt requests
0	0	1	Sets interrupt priority level to 1
0	1	0	Sets interrupt priority level to 2
0	1	1	Sets interrupt priority level to 3
1	0	0	Sets interrupt priority level to 4
1	0	1	Sets interrupt priority level to 5
1	1	0	Sets interrupt priority level to 6
1	1	1	Disables interrupt requests

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTETC01	INTTC0 & INTTC1 enable	F1H	INTTC1 (DMA1)				INTTC0 (DMA0)			
			ITC1C	ITC1M2	ITC1M1	ITC1M0	ITC0C	ITC0M2	ITC0M1	ITC0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC23	INTTC2 & INTTC3 enable	F2H	INTTC3 (DMA3)				INTTC2 (DMA2)			
			ITC3C	ITC3M2	ITC3M1	ITC3M0	ITC2C	ITC2M2	ITC2M1	ITC2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC45	INTTC4 & INTTC5 enable	F3H	INTTC5 (DMA5)				INTTC4 (DMA4)			
			ITC5C	ITC5M2	ITC5M1	ITC5M0	ITC4C	ITC4M2	ITC4M1	ITC4M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC67	INTTC6 & INTTC7 enable	F4H	INTTC7 (DMA7)				INTTC6 (DMA6)			
			ITC7C	ITC7M2	ITC7M1	ITC7M0	ITC6C	ITC6M2	ITC6M1	ITC6M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTWDT	INTWD enable	F7H	–				INTWD			
			–	–	–	–	ITCWD	–	–	–
							R			
			Note: Always write 0				0	–	–	–

Interrupt request flag

IxxM2	IxxM1	IxxM0	Function (Write)
0	0	0	Disables interrupt requests
0	0	1	Sets interrupt priority level to 1
0	1	0	Sets interrupt priority level to 2
0	1	1	Sets interrupt priority level to 3
1	0	0	Sets interrupt priority level to 4
1	0	1	Sets interrupt priority level to 5
1	1	0	Sets interrupt priority level to 6
1	1	1	Disables interrupt requests

(2) External interrupt control

Symbol	Name	Address	7	6	5	4	3	2	1	0
IIMC	Interrupt input mode control	F6H (Prohibit RMW)	I5EDGE	I4EDGE	I3EDGE	I2EDGE	I1EDGE	I0EDGE	I0LE	–
			W						R/W	
			0	0	0	0	0	0	0	0
			INT5EDGE 0: Rising 1: Falling	INT4EDGE 0: Rising 1: Falling	INT3EDGE 0: Rising 1: Falling	INT2EDGE 0: Rising 1: Falling	INT1EDGE 0: Rising 1: Falling	INT0EDGE 0: Rising 1: Falling	0: INT0 edge mode 1: INT0 level mode	Always write "0"

*INT0 level enable

0	Edge detect INT
1	"H" level INT

Note 1: Disable INT0 request before changing INT0 pin mode from level sense to edge sense.

Setting example:

```
DI
LD      (IIMC), XXXXXX00B ; Switches from level to edge.
LD      (INTCLR), 0AH     ; Clears interrupt request flag.
NOP                       ; Wait EI execution
NOP
NOP
EI
```

X: Don't care, –: No change.

Note 2: See electrical characteristics in section 4 for external interrupt input pulse width.

Settings of External Interrupt Pin Function

Interrupt	Pin Name	Mode	Setting Method
INT0	PC0	Rising edge	<I0LE> = 0, <I0EDGE> = 0
		Falling edge	<I0LE> = 0, <I0EDGE> = 1
		High level	<I0LE> = 1
INT1	PC1	Rising edge	<I1EDGE> = 0
		Falling edge	<I1EDGE> = 1
INT2	PC2	Rising edge	<I2EDGE> = 0
		Falling edge	<I2EDGE> = 1
INT3	PC3	Rising edge	<I3EDGE> = 0
		Falling edge	<I3EDGE> = 1
INT4	P96	Rising edge	<I4EDGE> = 0
		Falling edge	<I4EDGE> = 1
INT5	P97	Rising edge	<I5EDGE> = 0
		Falling edge	<I5EDGE> = 1

(3) SIO receive interrupt control

Symbol	Name	Address	7	6	5	4	3	2	1	0
SIMC	SIO interrupt mode control	F5H (Prohibit RMW)	–						–	IR0LE
			W						W	
			0						1	1
			Always write “0” (Note)						Always write “0”	0: INTRX0 edge mode 1: INTRX0 level mode

Note: When using the micro DMA transfer end interrupt, always write “1”.

INTRX0 rising edge enable

0	Edge detect INTRX0
1	“H” level INTRX0

(4) Interrupt request flag clear register

The interrupt request flag is cleared by writing the appropriate micro DMA start vector, as given in Table 3.4.1, to the register INTCLR.

For example, to clear the interrupt flag INT0, perform the following register operation after execution of the DI instruction.

INTCLR ← 0AH Clears interrupt request flag INT0.

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTCLR	Interrupt clear control	F8H (Prohibit RMW)	CLRV7	CLRV6	CLRV5	CLRV4	CLRV3	CLRV2	CLRV1	CLRV0
			W							
			0	0	0	0	0	0	0	0
			Interrupt vector							

(5) Micro DMA start vector registers

These registers assign micro DMA processing to sets which source corresponds to DMA. The interrupt source whose micro DMA start vector value matches the vector set in one of these registers is designated as the micro DMA start source.

When the micro DMA transfer counter value reaches zero, the micro DMA transfer end interrupt corresponding to the channel is sent to the interrupt controller, the micro DMA start vector register is cleared, and the micro DMA start source for the channel is cleared. Therefore, in order for micro DMA processing to continue, the micro DMA start vector register must be set again during processing of the micro DMA transfer end interrupt.

If the same vector is set in the micro DMA start vector registers of more than one channel, the lowest numbered channel takes priority.

Accordingly, if the same vector is set in the micro DMA start vector registers for two different channels, the interrupt generated on the lower numbered channel is executed until micro DMA transfer is complete. If the micro DMA start vector for this channel has not been set in the channel's micro DMA start vector register again, micro DMA transfer for the higher-numbered channel will be commenced. (This process is known as micro DMA chaining.)

Symbol	Name	Address	7	6	5	4	3	2	1	0
DMA0V	DMA0 start vector	100H			DMA0V5	DMA0V4	DMA0V3	DMA0V2	DMA0V1	DMA0V0
					R/W					
					0	0	0	0	0	0
					DMA0 start vector					
DMA1V	DMA1 start vector	101H			DMA1V5	DMA1V4	DMA1V3	DMA1V2	DMA1V1	DMA1V0
					R/W					
					0	0	0	0	0	0
					DMA1 start vector					
DMA2V	DMA2 start vector	102H			DMA2V5	DMA2V4	DMA2V3	DMA2V2	DMA2V1	DMA2V0
					R/W					
					0	0	0	0	0	0
					DMA2 start vector					
DMA3V	DMA3 start vector	103H			DMA3V5	DMA3V4	DMA3V3	DMA3V2	DMA3V1	DMA3V0
					R/W					
					0	0	0	0	0	0
					DMA3 start vector					
DMA4V	DMA4 start vector	104H			DMA4V5	DMA4V4	DMA4V3	DMA4V2	DMA4V1	DMA4V0
					R/W					
					0	0	0	0	0	0
					DMA4 start vector					
DMA5V	DMA5 start vector	105H			DMA5V5	DMA5V4	DMA5V3	DMA5V2	DMA5V1	DMA5V0
					R/W					
					0	0	0	0	0	0
					DMA5 start vector					
DMA6V	DMA6 start vector	106H			DMA6V5	DMA6V4	DMA6V3	DMA6V2	DMA6V1	DMA6V0
					R/W					
					0	0	0	0	0	0
					DMA6 start vector					
DMA7V	DMA7 start vector	107H			DMA7V5	DMA7V4	DMA7V3	DMA7V2	DMA7V1	DMA7V0
					R/W					
					0	0	0	0	0	0
					DMA7 start vector					

(6) Specification of a micro DMA burst

Specifying the micro DMA burst function causes micro DMA transfer, once started, to continue until the value in the transfer counter register reaches zero. Setting any of the bits in the register DMAB which correspond to a micro DMA channel (as shown below) to 1 specifies that any micro DMA transfer on that channel will be a burst transfer.

Symbol	Name	Address	7	6	5	4	3	2	1	0
DMAB	DMA burst	108H	DBST7	DBST6	DBST5	DBST4	DBST3	DBST2	DBST1	DBST0
			R/W							
			0	0	0	0	0	0	0	0
			1: DMA burst request							

(7) Notes

The instruction execution unit and the bus interface unit in this CPU operate independently. Therefore, immediately before an interrupt is generated, if the CPU fetches an instruction which clears the corresponding interrupt request flag, the CPU may execute this instruction in between accepting the interrupt and reading the interrupt vector. In this case, the CPU will read the default vector 0004H and jump to interrupt vector address FFFF04H.

To avoid this, an instruction which clears an interrupt request flag should always be placed after a DI instruction. And in the case of setting an interrupt enable again by EI instruction after the execution of clearing instruction, execute EI instruction after clearing and more than 3–instructions (e.g., "NOP" × 3 times).

If it placed EI instruction without waiting NOP instruction after execution of clearing instruction, interrupt will be enabled before request flag is cleared.

In the case of changing the value of the interrupt mask register <IFF2:0> by execution of POP SR instruction, disable an interrupt by DI instruction before execution of POP SR instruction.

In addition, please note that the following two circuits are exceptional and demand special attention.

INT0 level mode	In level mode INT0 is not an edge triggered interrupt. Hence, in level mode the interrupt request flip-flop for INT0 does not function. The peripheral interrupt request passes through the S input of the flip-flop and becomes the Q output. If the interrupt input mode is changed from edge mode to level mode, the interrupt request flag is cleared automatically.

	If the CPU enters the interrupt response sequence as a result of INT0 going from 0 to 1, INT0 must then be held at 1 until the interrupt response sequence has been completed. If INT0 is set to level mode so as to release a halt state, INT0 must be held at 1 from the time INT0 changes from 0 to 1 until the halt state is released. (Hence, it is necessary to ensure that input noise is not interpreted as a 0, causing INT0 to revert to 0 before the halt state has been released.)
	When the mode changes from level mode to edge mode, interrupt request flags which were set in level mode will not be cleared. Interrupt request flags must be cleared using the following sequence.
	DI
	LD (IIMC), 00H ; Switches from level to edge.
	LD (INTCLR), 0AH ; Clears interrupt request flag.
	NOP ; Wait EI execution
	NOP
	NOP
	EI

INTRX	In level mode (the register SIMC<IRxLE> set to "0"), the interrupt request flip-flop can only be cleared by a reset or by reading the serial channel receive buffer. It cannot be cleared by writing INTCLR register.

Note: The following instructions or pin input state changes are equivalent to instructions which clear the interrupt request flag.

INT0: Instructions which switch to level mode after an interrupt request has been generated in edge mode.
The pin input changes from high to low after an interrupt request has been generated in level mode. ("H" → "L")
INTRX: Instructions which read the receive buffer.

INTRX: Instructions which read the receive buffer.

3.5 Function of Ports

The TMP92CA25 I/O port pins are shown in Table 3.5.1 and Table 3.5.2. In addition to functioning as general-purpose I/O ports, these pins are also used by the internal CPU and I/O functions. Table 3.5.3 to Table 3.5.5 list the I/O registers and their specifications.

Table 3.5.1 Port Functions (1/2)

(R: PD = with programmable pull-down resistor, U = with pull-up resistor)

Port Name	Pin Name	Number of Pins	I/O	R	I/O Setting	Pin Name for Built-in Function
Port 1	P10 to P17	8	I/O	–	Bit	D8 to D15
Port 6	P60 to P67	8	I/O	–	Bit	A16 to A23
Port 7	P70	1	Output	–	(Fixed)	$\overline{RD}$
	P71	1	I/O	–	Bit	$\overline{WRLL}$, $\overline{NDRE}$
	P72	1	I/O	–	Bit	$\overline{WRLU}$, $\overline{NDWE}$
	P73	1	I/O	–	Bit	EA24
	P74	1	I/O	–	Bit	EA25
	P75	1	I/O	–	Bit	R/$\overline{W}$, NDR/$\overline{B}$
	P76	1	I/O	–	Bit	$\overline{WAIT}$
Port 8	P80	1	Output	–	(Fixed)	$\overline{CS0}$
	P81	1	Output	–	(Fixed)	$\overline{CS1}$, $\overline{SDCS}$
	P82	1	Output	–	(Fixed)	$\overline{CS2}$, $\overline{CSZA}$
	P83	1	Output	–	(Fixed)	$\overline{CS3}$
	P84	1	Output	–	(Fixed)	$\overline{CSZB}$, $\overline{WRUL}$, $\overline{ND0CE}$
	P85	1	Output	–	(Fixed)	$\overline{CSZC}$, $\overline{WRUU}$, $\overline{ND1CE}$
	P86	1	Output	–	(Fixed)	$\overline{CSZD}$
	P87	1	Output	–	(Fixed)	$\overline{CSZE}$
Port 9	P90	1	I/O	–	Bit	TXD0, I2SCKO
	P91	1	I/O	–	Bit	RXD0, I2SDO
	P92	1	I/O	–	Bit	SCLK0, $\overline{CTS0}$, I2SWS
	P93	1	I/O	–	Bit	SDA
	P94	1	I/O	–	Bit	SCL
	P95	1	Output	–	(Fixed)	CLK32KO
	P96	1	Input	PD	(Fixed)	INT4, PX
	P97	1	Input	–	(Fixed)	INT5, PY
Port A	PA0 to PA7	8	Input	U	(Fixed)	KI0 to KI7
Port C	PC0	1	I/O	–	Bit	INT0, TA1OUT
	PC1	1	I/O	–	Bit	INT1, TA3OUT
	PC2	1	I/O	–	Bit	INT2, TB0OUT0
	PC3	1	I/O	–	Bit	INT3
	PC4	1	I/O	–	Bit	
	PC5	1	I/O	–	Bit	
	PC6	1	I/O	–	Bit	KO8, EA24
	PC7	1	I/O	–	Bit	$\overline{CSZF}$, EA25
Port F	PF0	1	I/O	–	Bit	TXD0
	PF1	1	I/O	–	Bit	RXD0
	PF2	1	I/O	–	Bit	SCLK0, $\overline{CTS0}$
	PF3	1	I/O	–	Bit	
	PF4	1	I/O	–	Bit	
	PF5	1	I/O	–	Bit	
	PF6	1	I/O	–	Bit	
	PF7	1	Output	–	(Fixed)	SDCLK

Table 3.5.2 Port Functions (2/2)

(R: PD = with programmable pull-down resistor, U = with pull-up resistor)

Port Name	Pin Name	Number of Pins	I/O	R	I/O Setting	Pin Name for Built-in Function
Port G	PG0 to PG1	2	Input	–	(Fixed)	AN0 to AN1
	PG2	1	Input	–	(Fixed)	AN2, MX
	PG3	1	Input	–	(Fixed)	AN3, $\overline{\text{ADTRG}}$, MY
Port J	PJ0	1	Output	–	(Fixed)	$\overline{\text{SDRAS}}$, $\overline{\text{SRLLB}}$
	PJ1	1	Output	–	(Fixed)	$\overline{\text{SDCAS}}$, $\overline{\text{SRLUB}}$
	PJ2	1	Output	–	(Fixed)	$\overline{\text{SDWE}}$, $\overline{\text{SRWR}}$
	PJ3	1	Output	–	(Fixed)	SDLLDQM
	PJ4	1	Output	–	(Fixed)	SDLUDQM
	PJ5	1	I/O	–	Bit	NDALE
	PJ6	1	I/O	–	Bit	NDCLE
	PJ7	1	Output	–	(Fixed)	SDCKE
Port K	PK0	1	Output	–	(Fixed)	LCP0
	PK1	1	Output	–	(Fixed)	LLP
	PK2	1	Output	–	(Fixed)	LFR
	PK3	1	Output	–	(Fixed)	LBCD
	PK4	1	I/O	–	Bit	SPDI
	PK5	1	I/O	–	Bit	SPDO
	PK6	1	I/O	–	Bit	$\overline{\text{SPCS}}$
	PK7	1	I/O	–	Bit	SPCLK
Port L	PL0 to PL3	4	Output	–	(Fixed)	LD0 to LD3
	PL4 to PL5	2	I/O	–	Bit	LD4 to LD5
	PL6	1	I/O	–	Bit	LD6, $\overline{\text{BUSRQ}}$
	PL7	1	I/O	–	Bit	LD7, $\overline{\text{BUSAK}}$
Port M	PM1	1	Output	–	(Fixed)	MLDALM
	PM2	1	Output	–	(Fixed)	$\overline{\text{ALARM}}$, $\overline{\text{MLDALM}}$
Port N	PN0 to PN7	8	I/O	–	Bit	KO0 to KO7

Table 3.5.3 I/O Registers and Specifications (1/3)

X: Don't care

Port	Pin Name	Specification	I/O Register			
			Pn	PnCR	PnFC	PnFC2
Port 1	P10 to P17	Input port	X	0	0	None
		Output port	X	1	0	
		D8 to D15 bus	X	X	1	
		A0 to A7 output	X		1	
Port 6	P60 to P67	Input port	X	0	0	None
		Output port	X	1	0	
		A16 to A23 output	X	X	1	
Port 7	P70 to P76	Output port	X	1	0	None
	P71 to P76	Input port	X	0	0	
	P70	$\overline{RD}$ output	X	None	1	
	P71	$\overline{WRLL}$ output	1	1	1	
		$\overline{NDRE}$ output	0	1	1	
	P72	$\overline{WRLU}$ output	1	1	1	
		$\overline{NDWE}$ output	0	1	1	
	P73	EA24 output	X	1	1	
	P74	EA25 output	X	1	1	
	P75	R/$\overline{W}$ output	X	1	1	
		NDR/$\overline{B}$ input	X	0	1	
	P76	$\overline{WAIT}$ input	X	0	1	
Port 8	P80 to P87	Output Port	X	None	0	0
	P80	$\overline{CS0}$ output	X		1	0
	P81	$\overline{CS1}$ output	X		1	0
		$\overline{SDCS}$ output	X		X	1
	P82	$\overline{CS2}$ output	X		1	0
		$\overline{CSZA}$ Output	X		0	1
	P83	$\overline{CS3}$ output	X		1	0
	P84	$\overline{CSZB}$ output	X		1	0
		$\overline{ND0CE}$ output	X		1	1
	P85	$\overline{CSZC}$ output	X		1	0
		$\overline{ND1CE}$ output	X		1	1
	P86	$\overline{CSZD}$ output	X		1	0
	P87	$\overline{CSZE}$ output	X		1	0

Table 3.5.4 I/O Registers and Specifications (2/3)

X: Don't care

Port	Pin Name	Specification	I/O Register			
			Pn	PnCR	PnFC	PnFC2
Port 9	P90 to P94, P96 to P97	Input port	X	0	0	0
	P90 to P94	Output port	X	1	0	
	P95		X	0	0	
	P90	TXD0 output	X	1	1	
		I2SCKO output	X	0	1	
		TXD0 output (Open drain)	X	1	1	1
	P91	RXD0 input	X	0	0	None
		I2SDO output	X	0	1	
	P92	SCLK0 output	X	1	1	
		I2SWS output	X	0	1	
		SCLK0, $\overline{CTS0}$ input (Note1)	X	0	0	
	P93	SDA I/O	X	1	1	0
		SDA I/O (Open drain)	X	1	1	1
	P94	SCL I/O	X	1	1	0
		SCL I/O (Open drain)	X	1	1	1
	P95	CLK32KO output	X	1	0	None
	P96	INT4 input	X	None	1	
	P97	INT5 input	X	None	1	
Port A	PA0 to PA7	Input port	None	None	0	None
		KI0 to KI7 input			1	
Port C	PC0 to PC3 PC6 to PC7	Input port	X	0	0	None
		Output port	X	1	0	
	PC0	INT0 input	X	0	1	
		TA1OUT output	X	1	1	None
	PC1	INT1 input	X	0	1	None
		TA3OUT output	X	1	1	
	PC2	INT2 input	X	0	1	None
		TB0OUT0 output	X	1	1	None
	PC3	INT3 input	X	0	1	None
	PC6	KO8 output (Open drain)	X	0	1	
		EA24 output	0	1	1	
	PC7	$\overline{CSZF}$ output	X	0	1	
		EA25 output	0	1	1	
Port F	PF0 to PF6	Input port	X	0	0	0
	PF0 toPF7	Output port	X	1	0	
	PF0	TXD0 output	X	1	1	0
		TXD0 output (Open drain)	X	1	1	1
	PF1	RXD0 input	X	0	0	None
	PF2	SCLK0 output	X	1	1	
		SCLK0, $\overline{CTS0}$ input	X	0	0	
	PF7	SDCLK output	X	None	1	

Note: To use P92-pin as SCLK0 input or $\overline{CTS0}$ input, set "1" to PF<PF2>

Table 3.5.5 I/O Registers and Specifications (3/3)

X: Don't care

Port	Pin Name	Specification	I/O Register			
			Pn	PnCR	PnFC	PnFC2
Port G	PG0 to PG3	Input port	X	None	None	None
		AN0 to AN3 input				
	PG3	$\overline{\text{ADTRG}}$ input				
	PG2	MX output				
	PG3	MY output				
Port J	PJ0 to PJ7	Output port	X	1	0	None
	PJ5 to PJ6	Input port	X	0	0	
	PJ0	$\overline{\text{SDRAS}}$, $\overline{\text{SRLLB}}$ output	X	None	1	
	PJ1	$\overline{\text{SDCAS}}$, $\overline{\text{SRLUB}}$ output	X		1	
	PJ2	$\overline{\text{SDWE}}$, $\overline{\text{SRWR}}$ output	X		1	
	PJ3	SDLLDQM output	X		1	
	PJ4	SDLUDQM output	1		1	
	PJ5	NDALE output	0	1	1	
	PJ6	NDCLE output	0	1	1	
	PJ7	SDCKE output	X	None	1	
Port K	PK4 to PK7	Input port	X	0	0	None
	PK0 to PK3	Output port	X	None	0	None
	PK4 to PK7	Output port	X	1	0	
	PK0	LCP0 output	X	None	1	
	PK1	LLP output	X		1	
	PK2	LFR output	X		1	
	PK3	LBCD output	X		1	
	PK4	SPDI input	X	0	1	
	PK5	SPDO output	X	1	1	
	PK6	$\overline{\text{SPCS}}$ output	X	1	1	
	PK7	SPCLK output	X	1	1	
Port L	PL4 to PL7	Input Port	X	0	0	None
	PL0 to PL7	Output Port	X	1	0	
	PL0 to PL7	LD0 to LD7 output	X	1	1	
	PL6	$\overline{\text{BUSRQ}}$ input	X	1	1	
	PL7	$\overline{\text{BUSAK}}$ output	X	1	1	
Port M	PM1 to PM2	Output Port	X	None	0	None
	PM1	MLDALM output	X		1	
	PM2	$\overline{\text{MLDALM}}$ output	0		1	
		$\overline{\text{ALARM}}$ output	1		1	
Port N	PN0 to PN7	Input Port	X	0	0	None
		Output Port (CMOS output)	X	1	0	
		KO output (Open drain output)	X	1	1	

3.5.1 Port 1 (P10 to P17)

Port 1 is an 8-bit general-purpose I/O port. Bits can be individually set as either inputs or outputs by control register P1CR and function register P1FC.

In addition to functioning as a general-purpose I/O port, port1 can also function as a data bus (D8 to D15).

AM1	AM0	Function Setting after Reset is Released
0	0	Don't use this setting
0	1	Data bus (D8 to D15)
1	0	Data bus (D8 to D15)
1	1	Input port

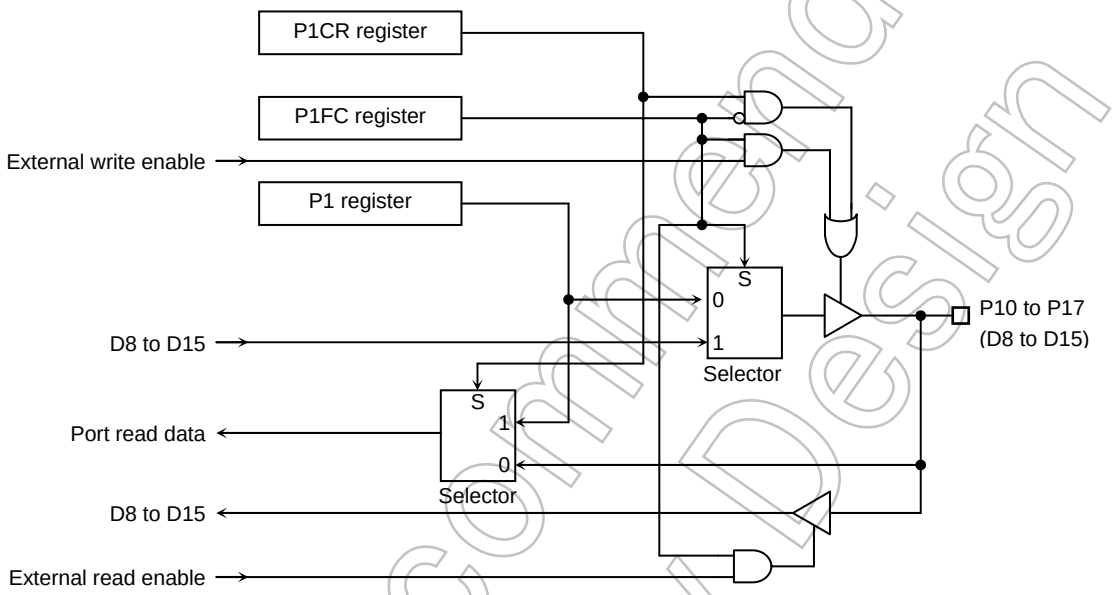


Figure 3.5.1 Port 1

Port 1 register

P1 (0004H)

	7	6	5	4	3	2	1	0
Bit symbol	P17	P16	P15	P14	P13	P12	P11	P10
Read/Write	R/W							
After reset	Data from external port (Output latch register is cleared to “0”)							

Port 1 Control register

P1CR (0006H)

	7	6	5	4	3	2	1	0
Bit symbol	P17C	P16C	P15C	P14C	P13C	P12C	P11C	P10C
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Input 1: Output							

Port 1 Function register

P1FC (0007H)

	7	6	5	4	3	2	1	0
Bit symbol								P1F
Read/Write								W
After reset								0/1 Note 2
Function								0: Port 1: Data bus (D8 to D15)

Port 1 Drive register

P1DR (0081H)

	7	6	5	4	3	2	1	0
Bit symbol	P17D	P16D	P15D	P14D	P13D	P12D	P11D	P10D
Read/Write	W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note1: Read-modify-write is prohibited for P1CR and P1FC.

Note2: It is set to “Port” or “Data bus” by AM pin setting.

Figure 3.5.2 Register for Port 1

3.5.2 A0 to A7

A0 to A7 pin function is Address bus function only. Driver register is following register.

Port 4 Drive register

P4DR (0084H)

	7	6	5	4	3	2	1	0
Bit symbol	P57D	P56D	P55D	P54D	P53D	P52D	P51D	P50D
Read/Write	W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Figure 3.5.3 Driver register for A0 to A7

3.5.3 A8 to A15

A8 to A15 pin function is Address bus function only. Driver register is following register.

Port 5 Drive register

P5DR (0085H)

	7	6	5	4	3	2	1	0
Bit symbol	P57D	P56D	P55D	P54D	P53D	P52D	P51D	P50D
Read/Write	W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Figure 3.5.4 Drive register for A8 to A15

3.5.4 Port 6 (P60 to P67)

Port 6 is an 8-bit general-purpose I/O port. Bits can be individually set as either inputs or outputs by control register P6CR and function register P6FC.

In addition to functioning as a general-purpose I/O port, port 6 can also function as an address bus (A16 to A23).

AM1	AM0	Function Setting after Reset is Released
0	0	Don't use this setting
0	1	Address bus (A16 to A23)
1	0	Address bus (A16 to A23)
1	1	Input port

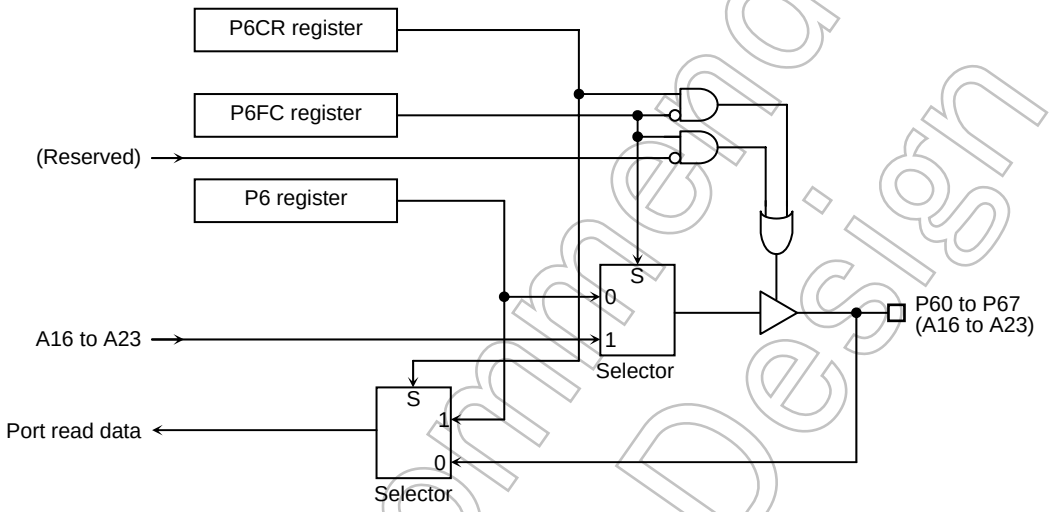


Figure 3.5.5 Port 6

Port 6 register

P6 (0018H)

	7	6	5	4	3	2	1	0
Bit symbol	P67	P66	P65	P64	P63	P62	P61	P60
Read/Write	R/W							
After reset	Data from external port (Output latch register is cleared to “0”)							

Port 6 Control register

P6CR (001AH)

	7	6	5	4	3	2	1	0
Bit symbol	P67C	P66C	P65C	P64C	P63C	P62C	P61C	P60C
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Input 1: Output							

Port 6 Function register

P6FC (001BH)

	7	6	5	4	3	2	1	0
Bit symbol	P67F	P66F	P65F	P64F	P63F	P62F	P61F	P60F
Read/Write	W							
After reset Note 2	0/1	0/1	0/1	0/1	0/1	0/1	0/1	0/1
Function	0: Port 1: Address bus (A16 to A23)							

Port 6 Drive register

P6DR (0086H)

	7	6	5	4	3	2	1	0
Bit symbol	P67D	P66D	P65D	P64D	P63D	P62D	P61D	P60D
Read/Write	W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note 1: Read-modify-write is prohibited for P6CR and P6FC.

Note 2: It is set to “Port” or “Address bus” by AM pin setting.

Figure 3.5.6 Register for Port 6

3.5.5 Port 7 (P70 to P76)

Port 7 is a 7-bit general-purpose I/O port (P70 is used for output only).

Bits can be individually set as either inputs or outputs by control register P7CR and function register P7FC.

In addition to functioning as a general-purpose I/O port, P70 to P76 pins can also function as interface pins for external memory.

A reset initializes P70 pin to output port mode, and P71to P76 pin to input port mode.

AM1	AM0	Function Setting after Reset is Released
0	0	Don't use this setting
0	1	$\overline{RD}$ pin
1	0	$\overline{RD}$ pin
1	1	P70 output port

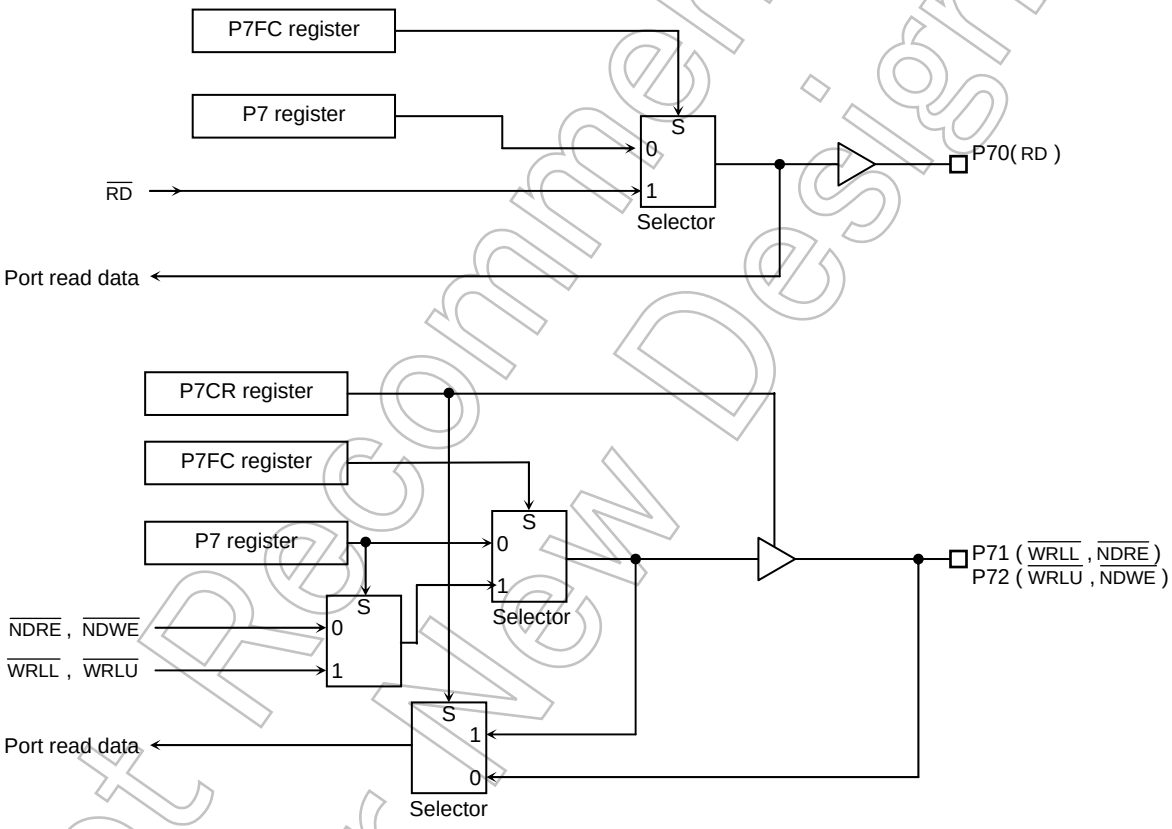


Figure 3.5.7 Port 7

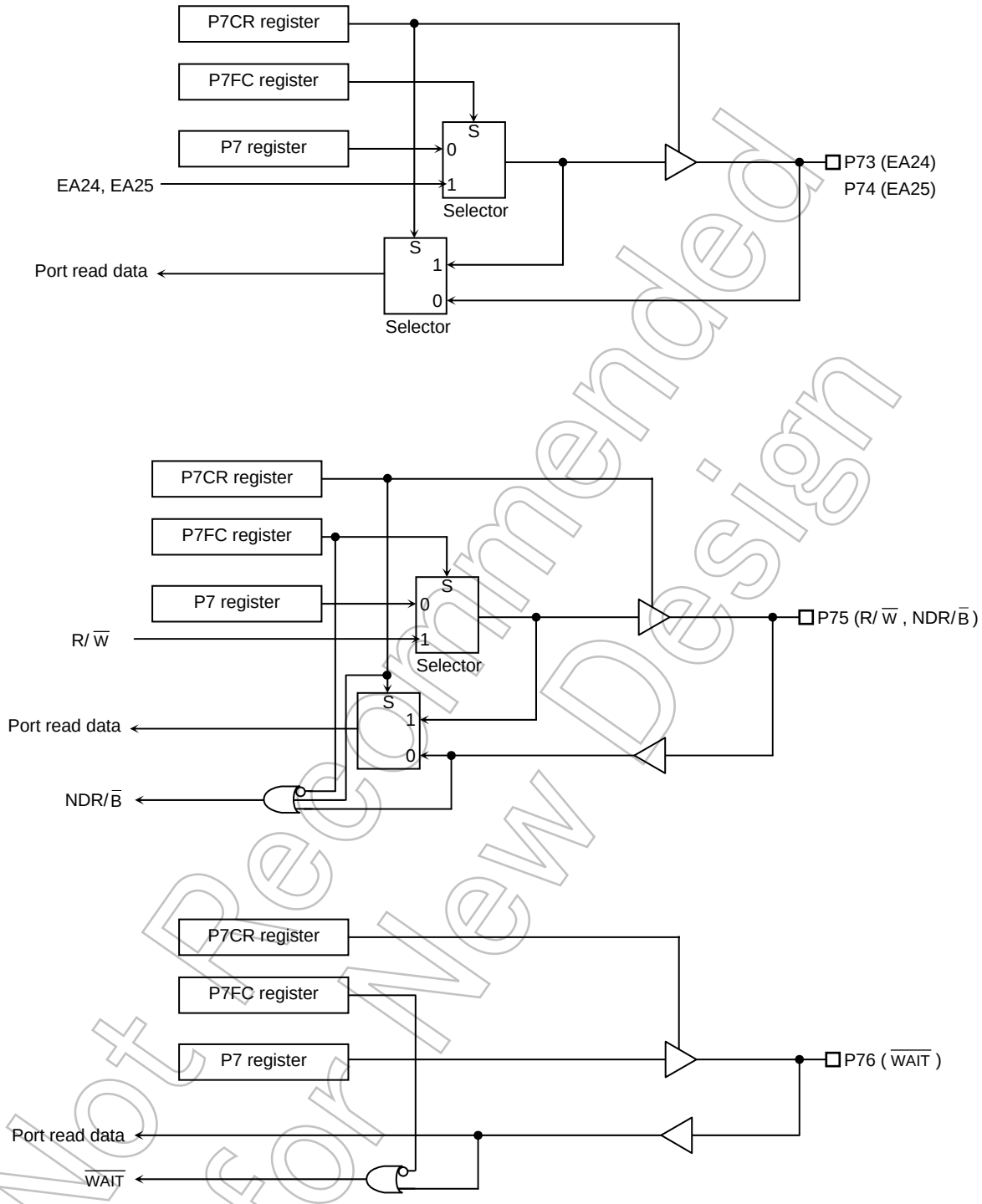


Figure 3.5.8 Port 7

Port 7 register

P7 (001CH)

	7	6	5	4	3	2	1	0
Bit symbol		P76	P75	P74	P73	P72	P71	P70
Read/Write		R/W						
After reset		Data from external port (Output latch register is set to “1”)		Data from external port (Output latch register is set to “0”)		Data from external port (Output latch register is set to “1”)		1

Port 7 Control register

P7CR (001EH)

	7	6	5	4	3	2	1	0
Bit symbol		P76C	P75C	P74C	P73C	P72C	P71C	
Read/Write		W						
After reset		0	0	0	0	0	0	
Function		0: Input 1: Output						

Port 7 Function register

P7FC (001FH)

	7	6	5	4	3	2	1	0
Bit symbol		P76F	P75F	P74F	P73F	P72F	P71F	P70F
Read/Write		W						
After reset		0	0	0	0	0	0	0/1 Note 2
Function		0: Input port 1: $\overline{WAIT}$	Refer to following table					0: port 1: $\overline{RD}$

Port 7 Drive register

P7DR (0087H)

	7	6	5	4	3	2	1	0
Bit symbol		P76D	P75D	P94D	P73D	P72D	P71D	P70D
Read/Write		R/W						
After reset		1	1	1	1	1	1	1
Function		Input/Output buffer drive register for standby mode						

P73 Setting

<P73C> / <P73F>	0	1
0	Input port	Output port
1	(Reserved)	EA24 output

P72 Setting

<P72C> / <P72F>	0	1
0	Input port	Output port
1	(Reserved)	$\overline{NDWE}$ output (at <P72> = 0) $\overline{WRLH}$ output (at <P72> = 1)

P71 Setting

<P71C> / <P71F>	0	1
0	Input port	Output port
1	(Reserved)	$\overline{NDRE}$ output at (<P71> = 0) $\overline{WRLL}$ output (at <P71> = 1)

P76 Setting

<P76C> / <P76F>	0	1
0	Input port	Output port
1	$\overline{WAIT}$ input	(Reserved)

P75 Setting

<P75C> / <P75F>	0	1
0	Input port	Output port
1	NDR/$\overline{B}$ input (at <P75> = 1)	R/$\overline{W}$ output

P74 Setting

<P74C> / <P74F>	0	1
0	Input port	Output port
1	(Reserved)	EA25 output

Note 1: Read-modify-write is prohibited for P7CR and P7FC.

Note 2: It is set to “Port” or “$\overline{RD}$” by AM pin setting.

Note 3: When $\overline{NDRE}$ and $\overline{NDWE}$ are used, set registers in the following order to avoid outputting a negative glitch.

Order	Register	Bit2	Bit1
(1)	P7	0	0
(2)	P7FC	1	1
(3)	P7CR	1	1

Figure 3.5.9 Register for Port 7

3.5.6 Port 8 (P80 to P87)

Ports 80 to 87 are 8-bit output ports. Resetting sets the output latch of P82 to "0" and the output latches of P80 to P81, P83 to P87 to "1".

Port 8 can also be set to function as an interface pin for external memory using function register P8FC.

Writing "1" in the corresponding bit of P8FC and P8FC2 enables the respective functions.

Resetting <P80F> to <P87F> of P8FC to "0" and P8FC2 to "0", sets all bits to output ports.

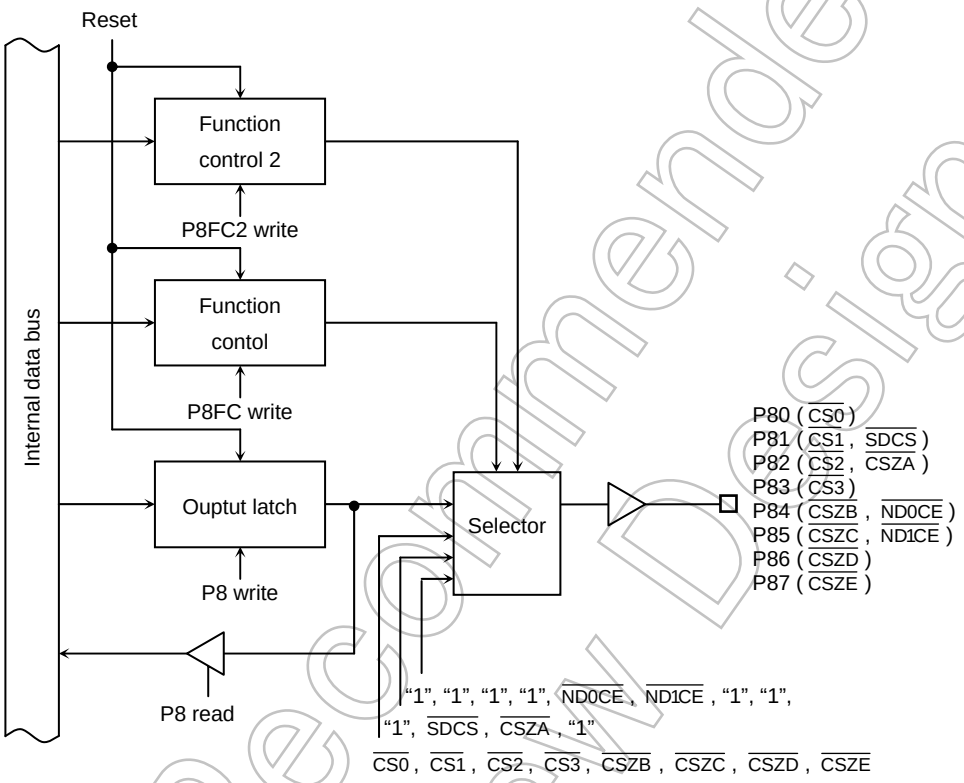


Figure 3.5.10 Port 8

Port 8 Register

P8 (0020H)

	7	6	5	4	3	2	1	0
Bit symbol	P87	P86	P85	P84	P83	P82	P81	P80
Read/Write	R/W							
After reset	1	1	1	1	1	0	1	1

Port 8 Function Register

P8FC (0023H)

	7	6	5	4	3	2	1	0
Bit symbol	P87F	P86F	P85F	P84F	P83F	P82F	P81F	P80F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Port 1: $\overline{CSZE}$	0: Port 1: $\overline{CSZD}$	Refer to following table	Refer to following table	0: Port 1: $\overline{CS3}$	Refer to following table	0: Port 1: $\overline{CS1}$	0: Port 1: $\overline{CS0}$

Port 8 Function Register 2

P8FC2 (0021H)

	7	6	5	4	3	2	1	0
Bit symbol	P87F2	P86F2	P85F2	P84F2	P83F2	P82F2	P81F2	P80F2
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: <P87F> 1:Reserved	0: <P86F> 1:Reserved	Refer to following table	Refer to following table	Always write "0"	Refer to table below	0: <P81F> 1: $\overline{SDCS}$	Always write "0"

Port 8 Drive Register

P8DR (0088H)

	7	6	5	4	3	2	1	0
Bit symbol	P87D	P86D	P85D	P84D	P83D	P82D	P81D	P80D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

P85 Setting

<P85F> / <P85F2>	0	1
0	Output port	$\overline{CSZC}$ output
1	(Reserved)	$\overline{ND1CE}$ output

P84 Setting

<P84F> / <P84F2>	0	1
0	Output port	$\overline{CSZB}$ output
1	(Reserved)	$\overline{ND0CE}$ output

P82 Setting

<P82F> / <P82F2>	0	1
0	Output port	$\overline{CS2}$ output
1	$\overline{CSZA}$ output	Reserved

Note 1: Read-modify-write is prohibited for P8FC and P8FC2.

Note 2: Don't write "1" to P8<P82> register before setting P82 pin to $\overline{CS2}$ or $\overline{CSZA}$ because P82 pin output "0" as $\overline{CE}$ for program memory by reset.

Figure 3.5.11 Register for Port 8

3.5.7 Port 9 (P90 to P97)

P90 to P94 are 5-bit general-purpose I/O ports. I/O can be set on a bit basis using the control register. Resetting sets P90 to P94 to input port and all bits of output latch to"1".

P95 is 1-bit general-purpose output port and P96 to P97 are 2-bit general-purpose input ports.

Setting the corresponding bits of P9FC enables the respective functions.

Resetting resets the P9FC to "0", and sets all bits except P95 to input ports.

(1) Port 90 (TXD0, I2SCKO), Port91 (RXD0, I2SDO), Port 92 (SCLK0, $\overline{CTS0}$ I2SWS)

Ports 90 to 92 are general-purpose I/O ports. They also function as either SIO0 or I²S. Each pin is detailed below.

	SIO mode (SIO0 module)	UART, IrDA mode (SIO0 module)	I^2S mode (I^2S module)	SIO mode (I^2S module)
P90	TXD0 (Data output)	TXD0 (Data output)	I2SCKO (Clock output)	I2SCKO (Clock output)
P91	RXD0 (Data input)	RXD0 (Data input)	I2SDO (Data output)	I2SDO (Data output)
P92	SCLK0 (Clock input or output)	$\overline{CTS0}$ (Clear to send)	I2SWS (Word select output)	(No use)

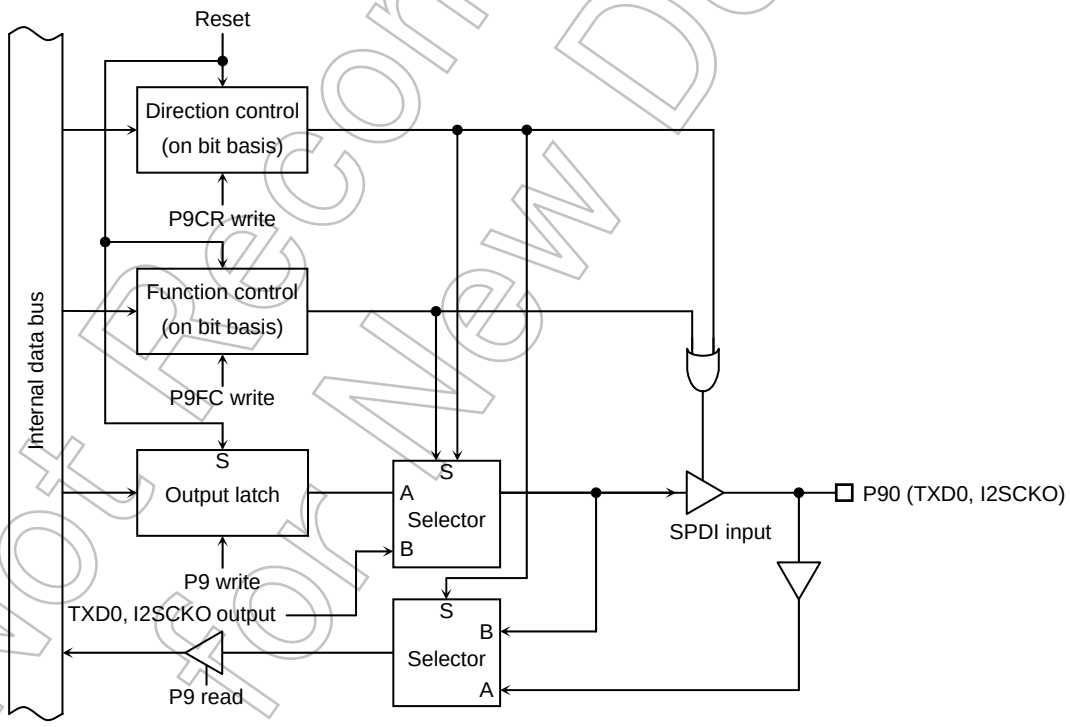


Figure 3.5.12 P90

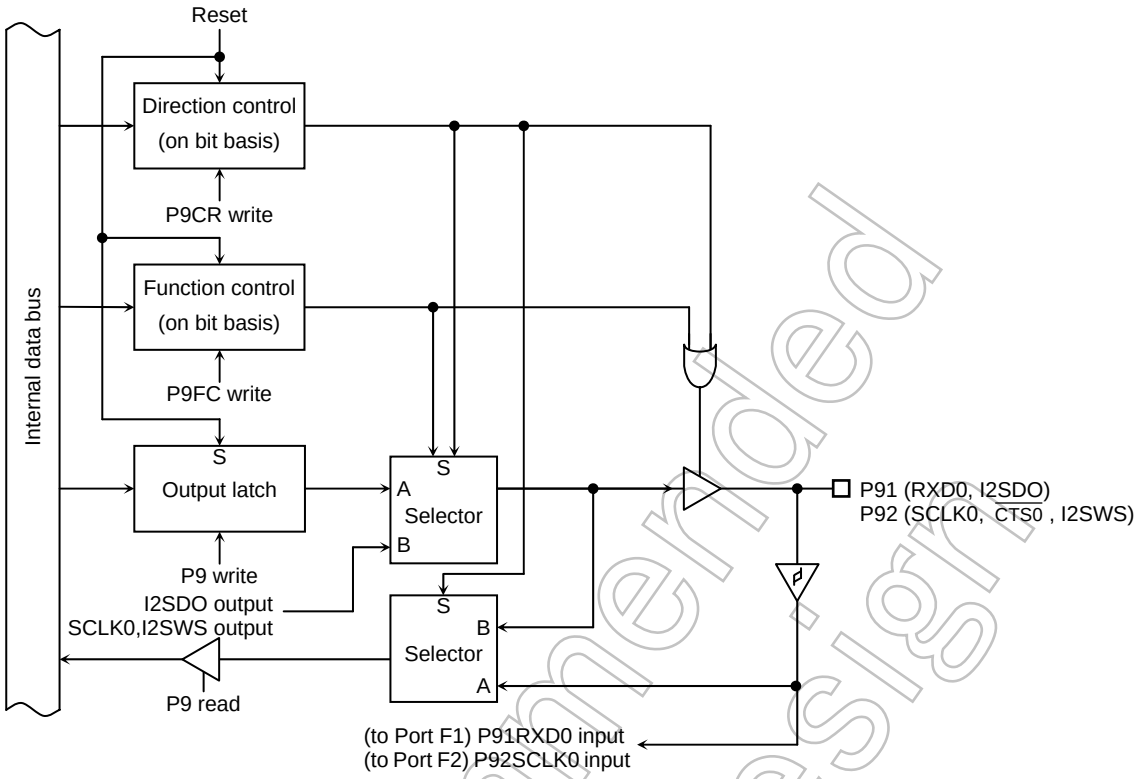


Figure 3.5.13 P91 and P92

(2) P93 (SDA), P94 (SCL)

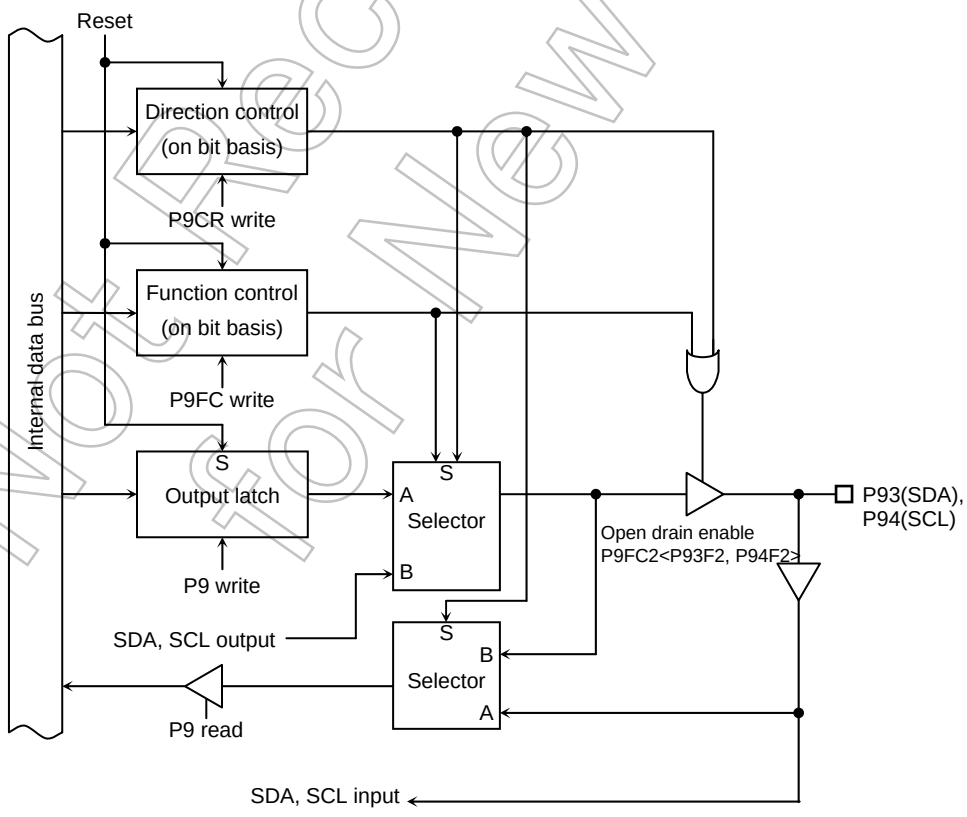


Figure 3.5.14 Port 93 and 94

(3) P95 (CLK32KO)

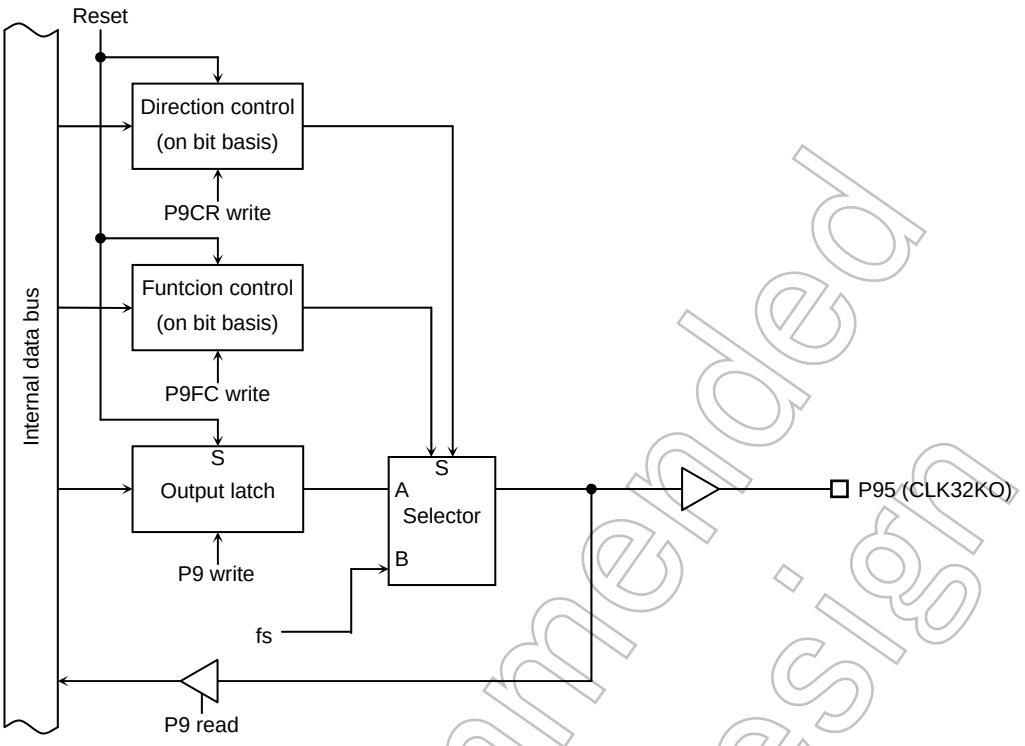


Figure 3.5.15 Port 95

(4) P96 (INT4, PX), P97 (INT5, PY)

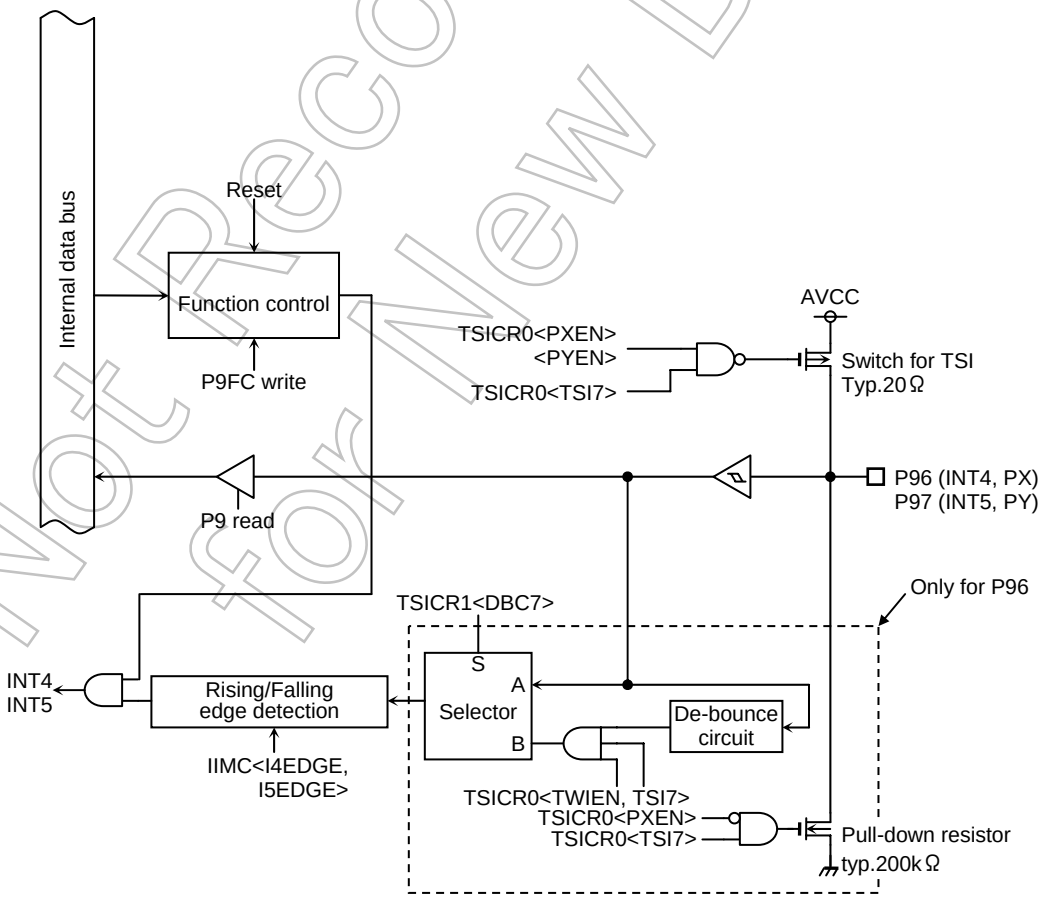


Figure 3.5.16 Port 96, 97

Port 9 Register

P9 (0024H)

	7	6	5	4	3	2	1	0
Bit symbol	P97	P96	P95	P94	P93	P92	P91	P90
Read/Write	R		R/W					
After reset	Data from external port		0	Data from external port (Output latch register is set to "1")				

Port 9 Control Register

P9CR (0026H)

	7	6	5	4	3	2	1	0
Bit symbol			P95C	P94C	P93C	P92C	P91C	P90C
Read/Write			W					
After reset			0	0	0	0	0	0
Function			Refer to following table					

Port 9 Function Register

P9FC (0027H)

	7	6	5	4	3	2	1	0
Bit symbol	P97F	P96F	P95F	P94F	P93F	P92F	P91F	P90F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Input port 1: INT5	0: Input port 1: INT4	Refer to following table					

P92 Setting

<P92C> / <P92F>	0	1
0	Input port SCLK0, $\overline{\text{CTS0}}$ input	Output port
1	I2SWS output	SCLK0 output

P91 Setting

<P91C> / <P91F>	0	1
0	Input port RXD0 input	Output port
1	I2SDO output	(Reserved)

P90 Setting

<P90C> / <P90F>	0	1
0	Input port	Output port
1	I2SCKO output	TXD0 output

P95 Setting

<P95C> / <P95F>	0	1
0	Output port	CLK32KO output
1	(Reserved)	(Reserved)

P94 Setting

<P94C> / <P94F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

P93 Setting

<P93C> / <P93F>	0	1
0	Input port	Output port
1	(Reserved)	SDA I/O

Port 9 Function Register 2

P9FC2 (0025H)

	7	6	5	4	3	2	1	0
Bit symbol				P94F2	P93F2			P90F2
Read/Write				W				W
After reset				0	0			0
Function				0: CMOS 1: Open drain	0: CMOS 1: Open drain			0: CMOS 1: Open drain

Port 9 Drive Register

P9DR (0089H)

	7	6	5	4	3	2	1	0
Bit symbol	P97D	P96D	P95D	P94D	P93D	P92D	P91D	P90D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Output/Input buffer drive register for standby mode							

Note 1: Read modify write is prohibited for P9CR, P9FC and P9FC2.

Note 2: When setting P97 and P96 pin to INT5 and INT4 input, set P9DR<P97D, P96D> to "00"(prohibit input), and when driving P96 and P97 pins to "0", execute HALT instruction. This setting generates INT5 and INT4 inside. If don't use external interrupt in HALT condition, set like a interrupt don't generated. (e.g. change port setting)

Figure 3.5.17 Register for Port 9

3.5.8 Port A (PA0 to PA7)

Ports A0 to A7 are 8-bit input general-purpose ports with pull-up resistor. In addition to functioning as general-purpose I/O ports, ports A0 to A7 can also, as a keyboard interface, operate a key-on wakeup function. The various functions can each be enabled by writing a "1" to the corresponding bit of the port A function register (PAFC).

Resetting resets all bits of the register PAFC to "0" and sets all pins to be input port.

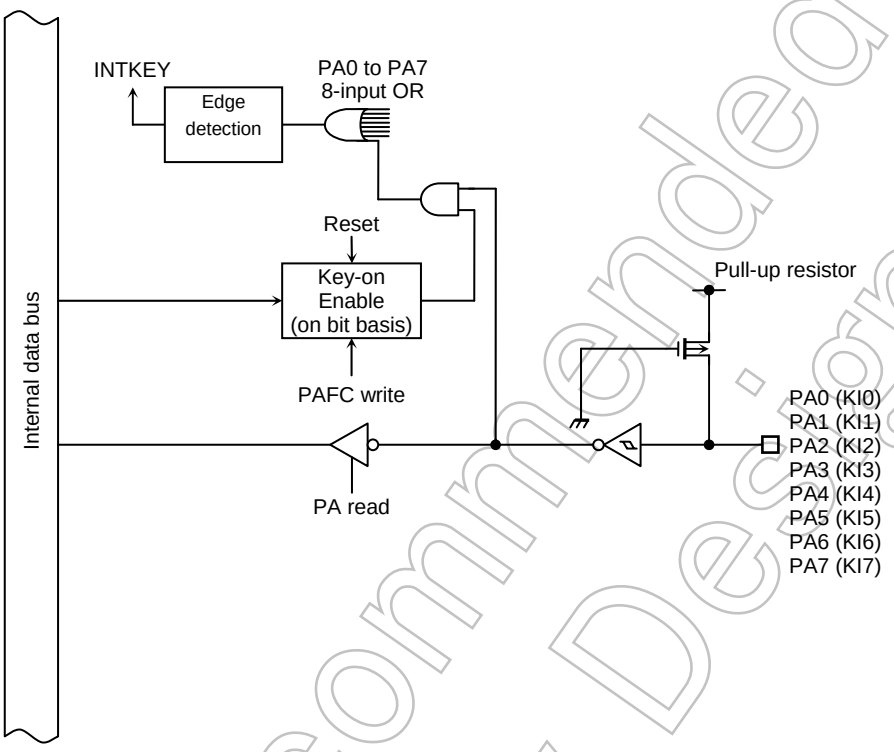


Figure 3.5.18 Port A

When PAFC = "1", if the input of any of KI0 to KI7 pins fall down, an INTKEY interrupt is generated. An INTKEY interrupt can be used to release all HALT modes.

Port A Register

PA (0028H)

	7	6	5	4	3	2	1	0
Bit symbol	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
Read/Write	R/W							
After reset	Data from external port							

Port A Function Register

PAFC (002BH)

	7	6	5	4	3	2	1	0
Bit symbol	PA7F	PA6F	PA5F	PA4F	PA3F	PA2F	PA1F	PA0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Key input disable 1: Key input enable							

Port A Drive register

PADR (008AH)

	7	6	5	4	3	2	1	0
Bit symbol	PA7D	PA6D	PA5D	PA4D	PA3D	PA2D	PA1D	PA0D
Read/Write	W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note: Read-modify-write is prohibited for PACR and PAFC.

Figure 3.5.19 Register for Port A

3.5.9 Port C (PC0 to PC3, PC6 to PC7)

PC0 to PC7 are 8-bit general-purpose I/O ports. Each bit can be set individually for input or output. Resetting sets port C to an input port.

In addition to functioning as a general-purpose I/O port, port C can also function as an output pin for timers (TA1OUT, TA3OUT and TB0OUT0), input pin for external interruption (INT0 to INT3), output pin for memory ($\overline{\text{CSZF}}$), output pin for key (KO8). These settings are made using the function register PCFC. The edge select for external interruption is determined by the IIMC register in the interruption controller.

(1) PC0 (INT0, TA1OUT)

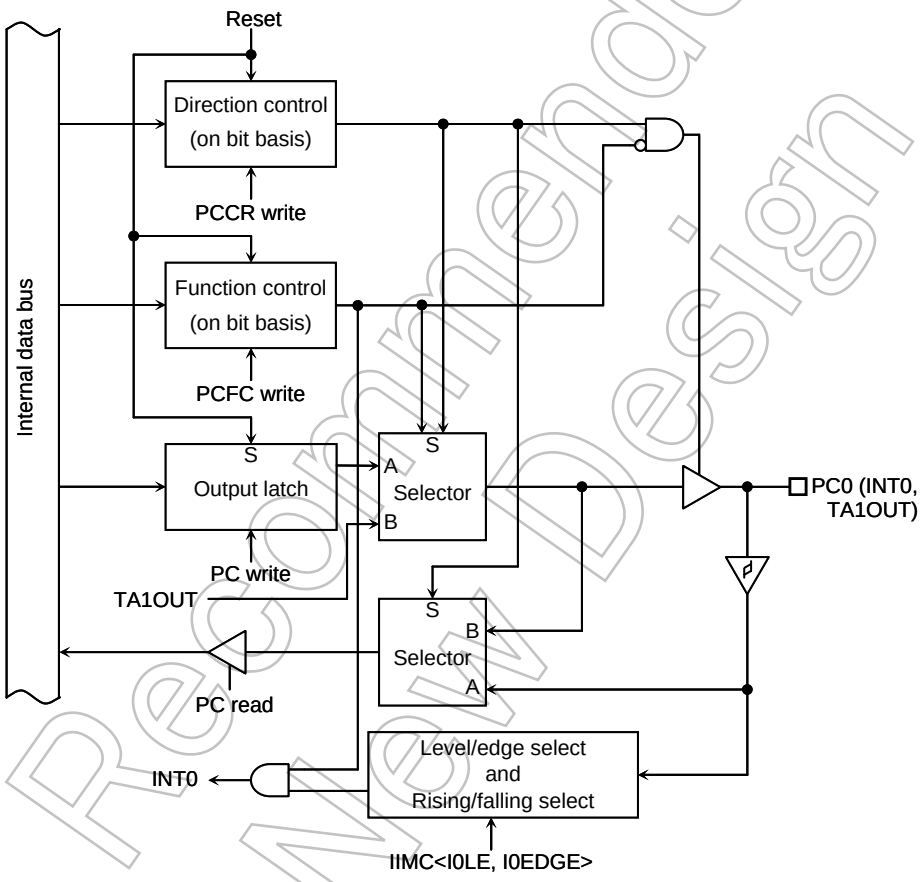


Figure 3.5.20 Port C0

(2) PC1 (INT1, TA3OUT), PC2 (INT2, TB0OUT0), PC3 (INT3, TB0OUT1)

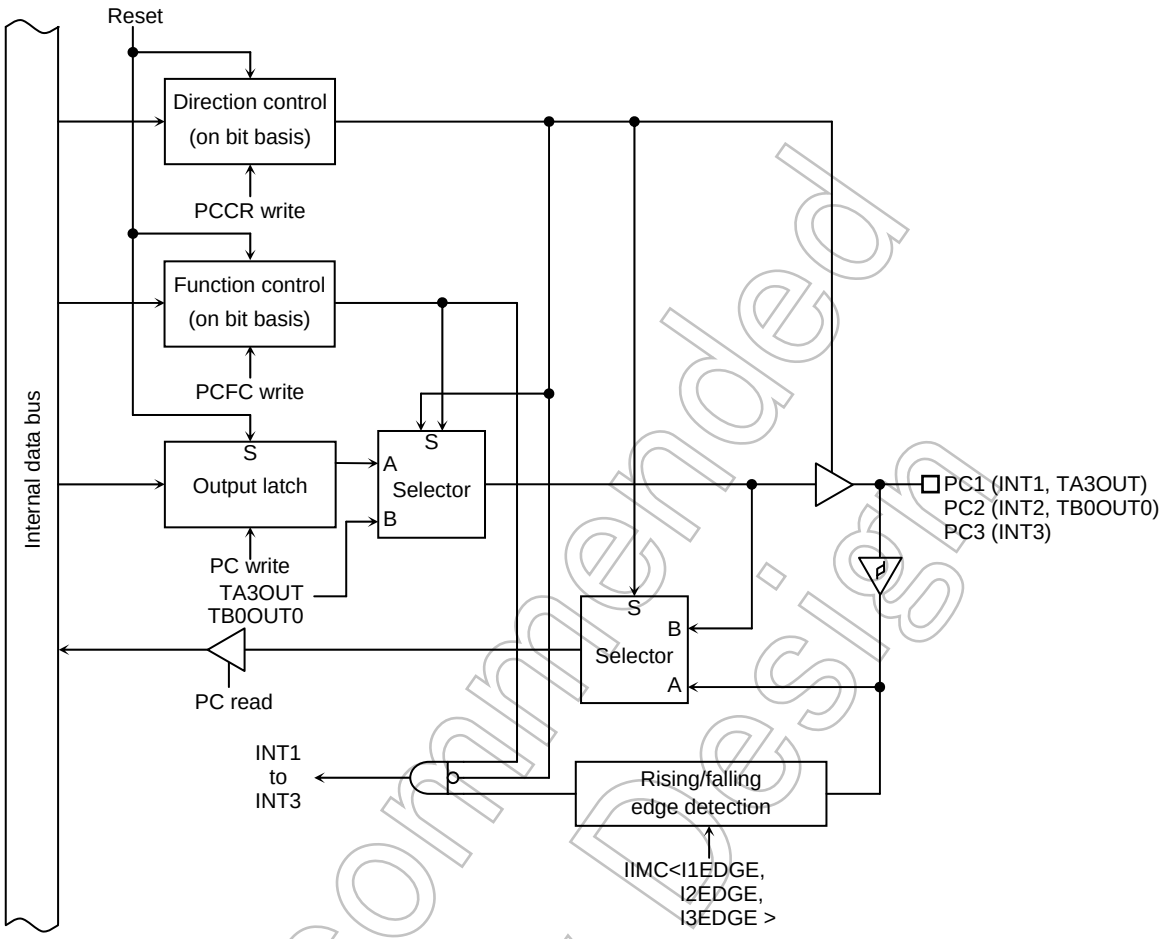


Figure 3.5.21 Port C1, C2, C3

(3) PC4, PC5

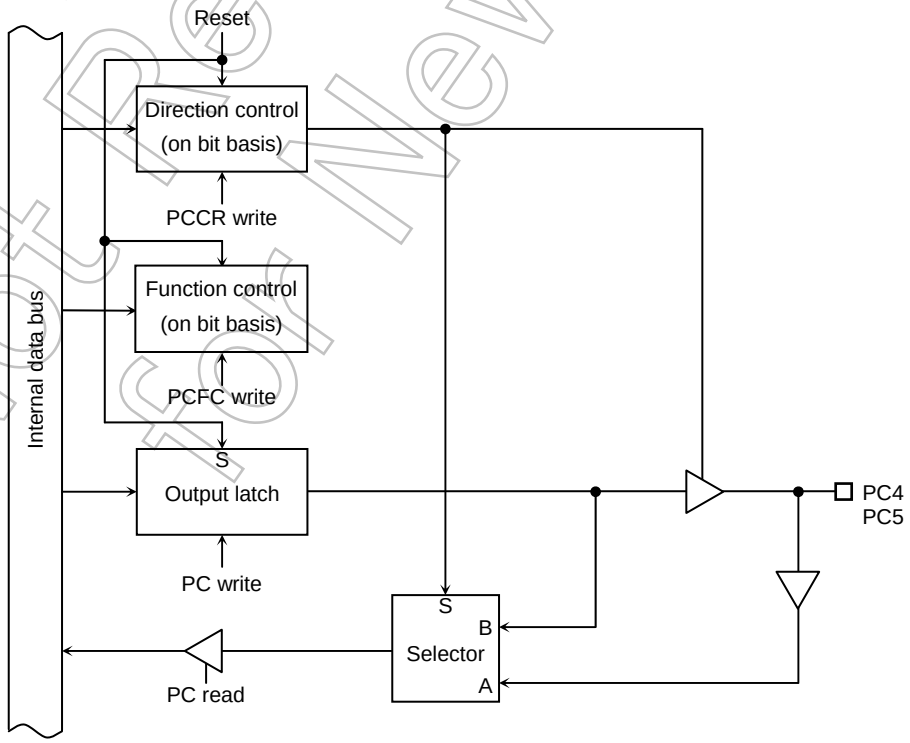


Figure 3.5.22 Port C4, C5

(4) PC6 (KO8, EA24)

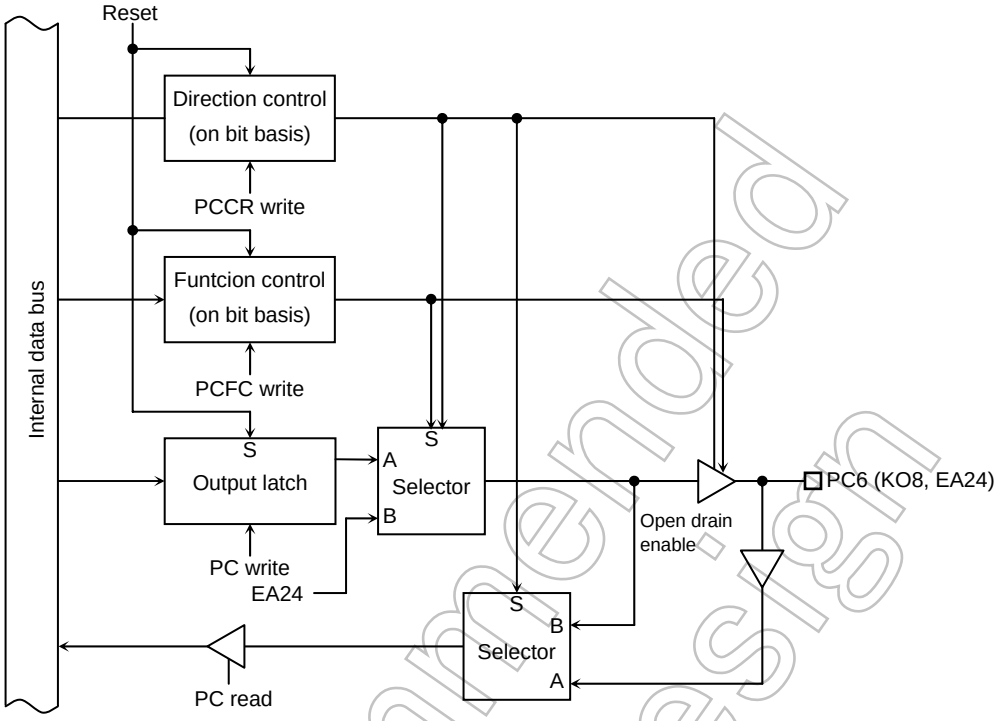


Figure 3.5.23 Port C6

(4) PC7 ($\overline{\text{CSZF}}$, EA25)

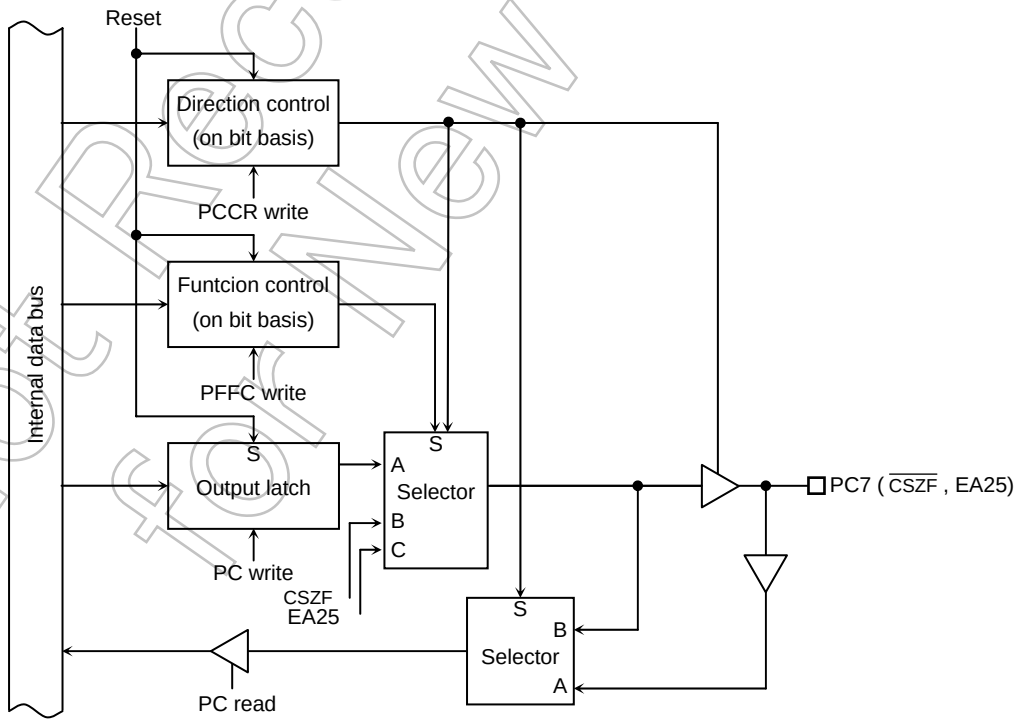


Figure 3.5.24 Port C7

Port C Register

PC (0030H)

	7	6	5	4	3	2	1	0
Bit symbol	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
Read/Write	R/W							
After reset	Data from external port (Output latch register is set to “1”)							

Port C Control Register

PCCR (0032H)

	7	6	5	4	3	2	1	0
Bit symbol	PC7C	PC6C	PC5C	PC4C	PC3C	PC2C	PC1C	PC0C
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	Refer to following table							

Port C Function Register

PCFC (0033H)

	7	6	5	4	3	2	1	0
Bit symbol	PC7F	PC6F	PC5F	PC4F	PC3F	PC2F	PC1F	PC0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	Refer to following table							

PC2 Setting

<PC2C> / <PC2F>	0	1
0	Input port	Output port
1	INT2	TB0OUT

PC1 Setting

<PC1C> / <PC1F>	0	1
0	Input port	Output port
1	INT1	TA3OUT

PC0 Setting

<PC0C> / <PC0F>	0	1
0	Input port	Output port
1	INT0	TA1OUT

PC5 Setting

<PC5C> / <PC5F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

PC4 Setting

<PC4C> / <PC4F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

PC3 Setting

<PC3C> / <PC3F>	0	1
0	Input port	Output port
1	INT3	(Reserved)

PC7 Setting

<PC7C> / <PC7F>	0	1
0	Input port	Output port
1	$\overline{CSZF}$ I/O	EA25 output at <PC7>= 0

PC6 Setting

<PC6C> / <PC6F>	0	1
0	Input port	Output port
1	KO8 (Open drain)	EA24 output at <PC6>= 0

Port C Drive Register

PCDR (008CH)

	7	6	5	4	3	2	1	0
Bit symbol	PC7D	PC6D	PC5D	PC4D	PC3D	PC2D	PC1D	PC0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note1: Read-modify-write is prohibited for the registers PCCR and PCFC.

Note2: When setting PC3-PC0 pins to INT3-INT0 input, set PCDR<PC3D:PC0D> to “0000”(prohibit input), and when driving PC3-PC0 pins to “0”, execute HALT instruction. This setting generates INT3-INT0 inside. If don’t use external interrupt in HALT condition, set like an interrupt don’t generated. (e.g. change port setting)

Figure 3.5.25 Register for Port C

3.5.10 Port F (PF0 to PF7)

Ports F0 to F6 are 7-bit general-purpose I/O ports. Resetting sets PF0 to PF6 to be input ports. It also sets all bits of the output latch register to "1". In addition to functioning as general-purpose I/O port pins, PF0 to PF6 can also function as the I/O for serial channels 0 and 1. A pin can be enabled for I/O by writing a "1" to the corresponding bit of the port F function register (PFFC).

Port F7 is a 1-bit general-purpose output port. In addition to functioning as a general-purpose output port , PF7 can also function as the SDCLK output. Resetting sets PF7 to be an SDCLK output port.

(1) Port F0 (TXD0), F1 (RXD0), F2 (SCLK0, $\overline{\text{CTS0}}$)

Ports F0 to F2 are general-purpose I/O ports. They also function as either SIO0. Each pin is detailed below.

	SIO mode (SIO0 module)	UART, IrDA mode (SIO0 module)
PF0	TXD0 (Data output)	TXD0 (Data output)
PF1	RXD0 (Data input)	RXD0 (Data input)
PF2	SCLK0 (Clock input or output)	$\overline{\text{CTS0}}$ (Clear to send)

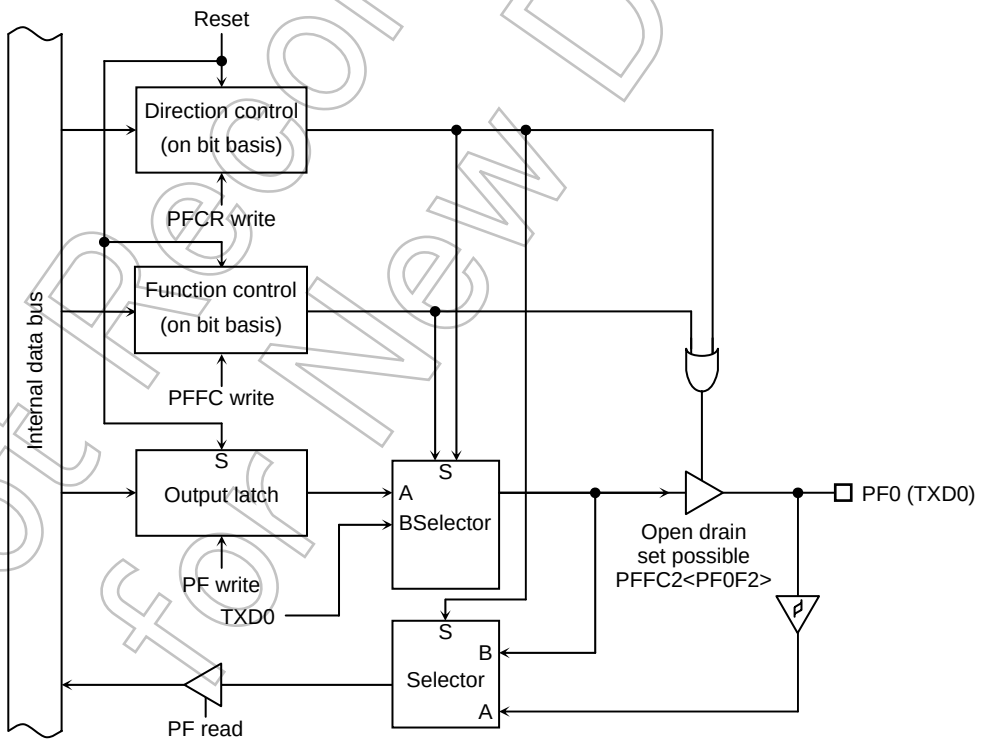


Figure 3.5.26 Port F0

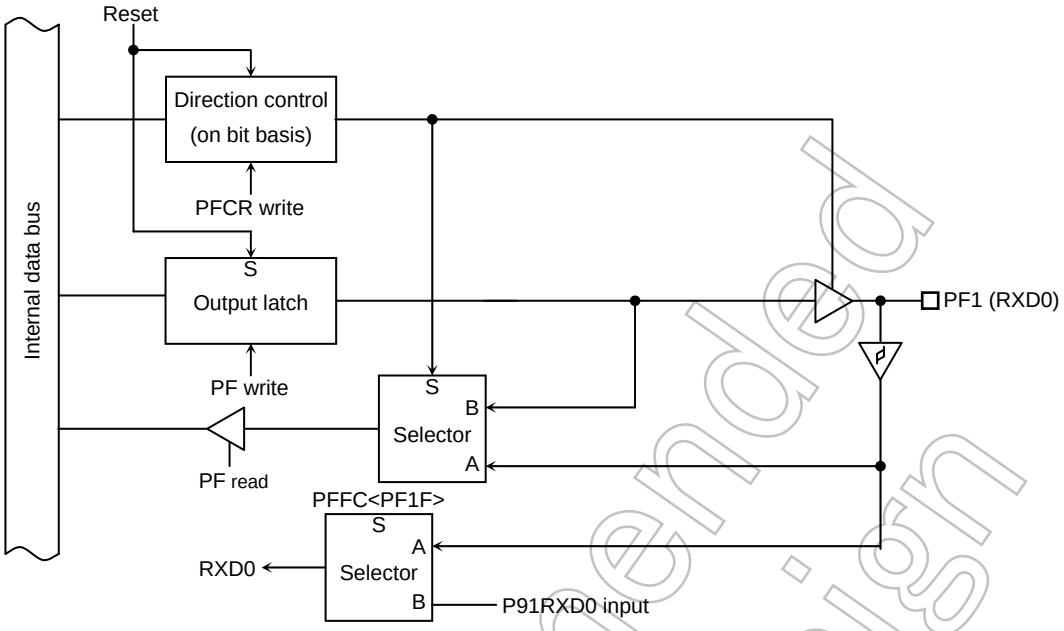


Figure 3.5.27 Port F1

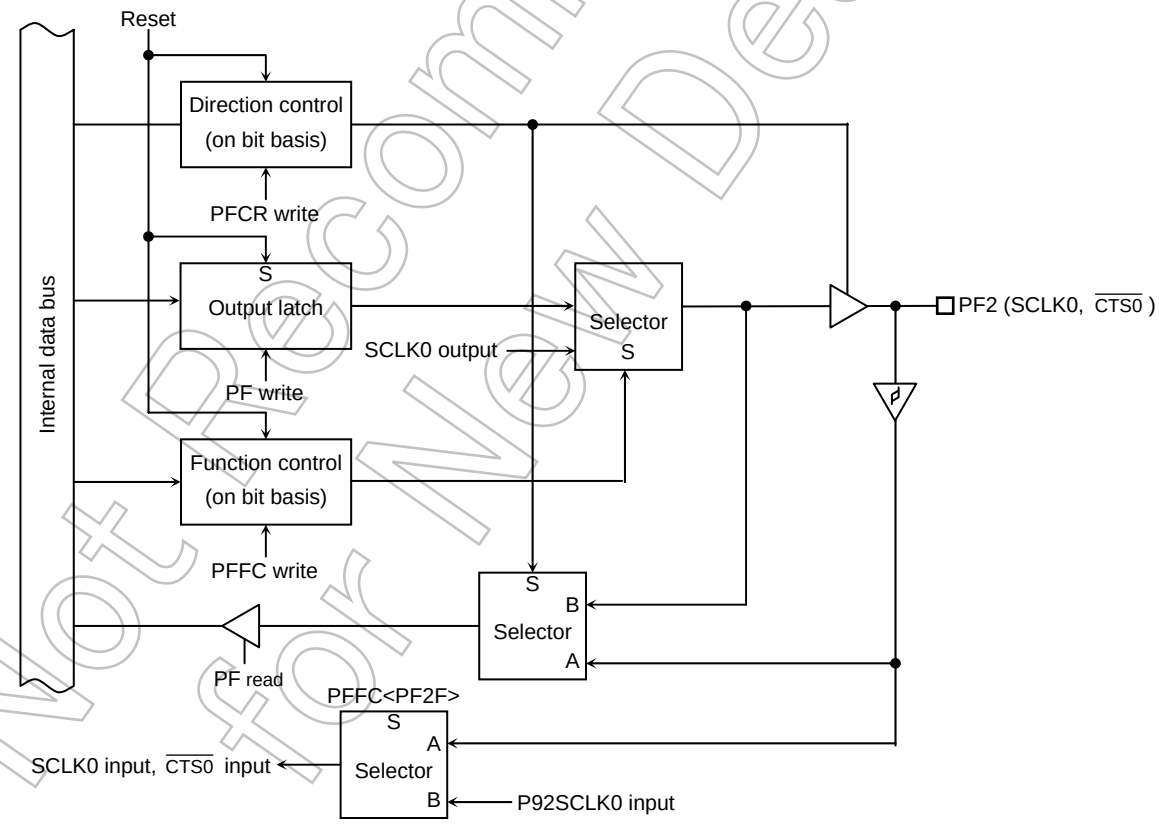


Figure 3.5.28 Port F2

(2) PF3, PF4, PF5, PF6, PF7

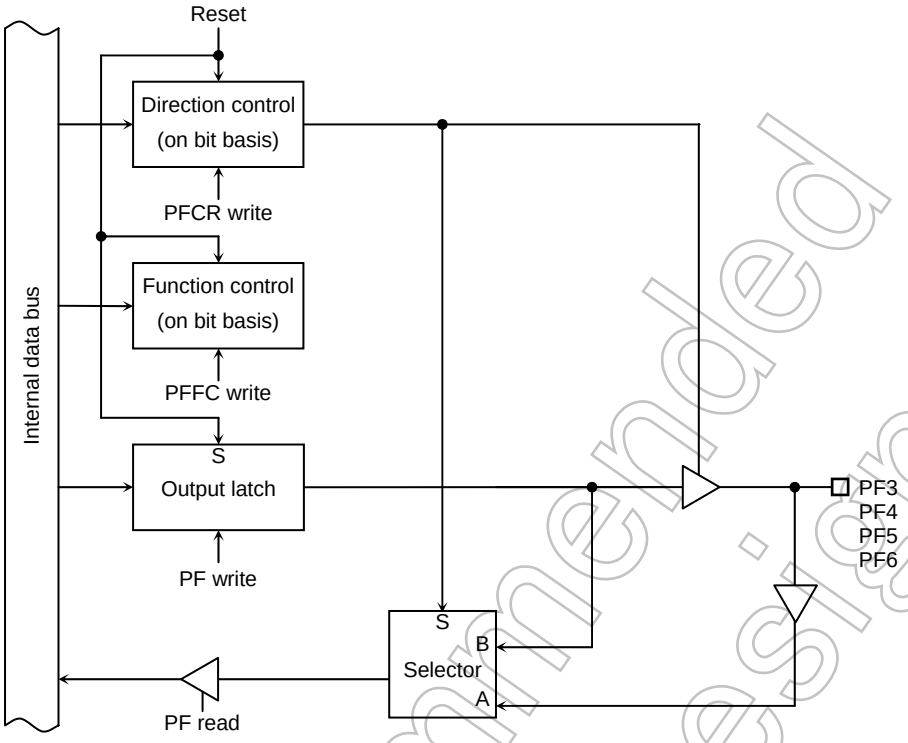


Figure 3.5.29 Port F3, F4. F5 and F6

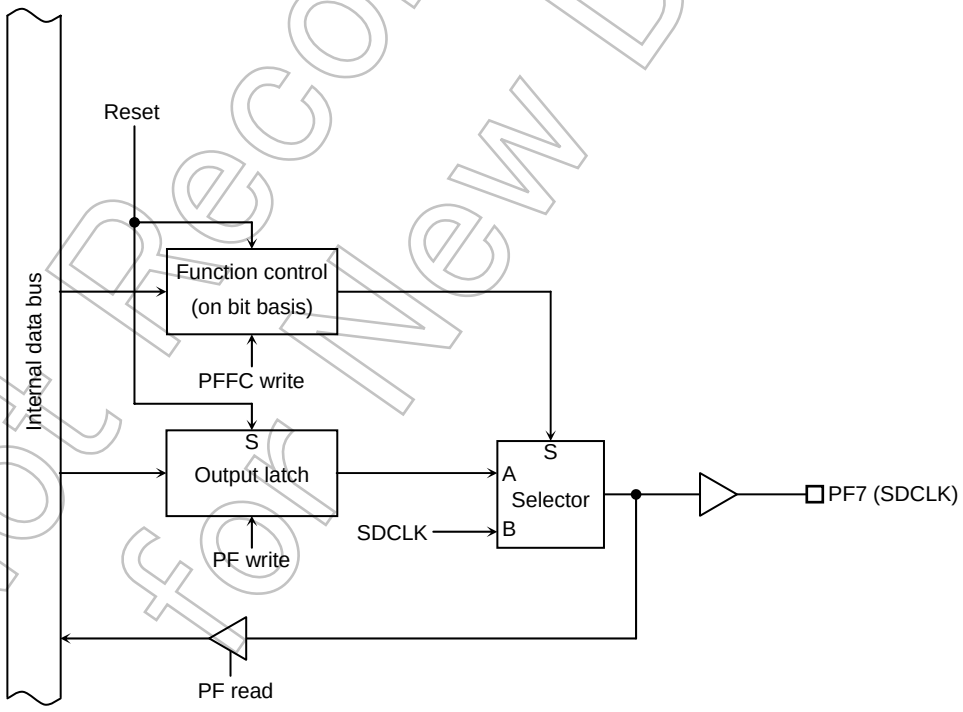


Figure 3.5.30 Port F7

Port F Register

PF (003CH)

	7	6	5	4	3	2	1	0
Bit symbol	PF7	PF6	PF5	PF4	PF3	PF2	PF1	PF0
Read/Write	R/W							
After reset	1	Data from external port (Output latch register is set to “1”)						

Port F Control Register

PFCR (003EH)

	7	6	5	4	3	2	1	0
Bit symbol		PF6C	PF5C	PF4C	PF3C	PF2C	PF1C	PF0C
Read/Write		W						
After reset		0	0	0	0	0	0	0
Function		Refer to following table						

Port F Functon Register

PFFC (003FH)

	7	6	5	4	3	2	1	0
Bit symbol	PF7F	PF6F	PF5F	PF4F	PF3F	PF2F	PF1F	PF0F
Read/Write	W							
After reset	1	0	0	0	0	0	0	0
Function	Refer to following table						RXD0 pin selection 0: Port F1 1: Port 91	Refer to following table

PF2 Setting

<PF2C> / <PF2F>	0	1
0	Input port, SCLK0, $\overline{CTS0}$ input From PF2 pin at <PF2> = 0 From P92 pin at <PF2> = 1	Output port
1	(Reserved)	SCLK0 output

PF1 Setting

<PF1C> / <PF1F>	0	1
0	Input port, RXD0 input from PF1,	Output port
1	RXD0 input from P91	Reserved

PF0 Setting

<PF0C> / <PF0F>	0	1
0	Input port	Output port
1	(Reserved)	TXD0 output

PF5 Setting

<PF5C> / <PF5F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

PF4 Setting

<PF4C> / <PF4F>	0	1
0	Input	Output
1	(Reserved)	(Reserved)

PF3 Setting

<PF3C> / <PF3F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

PF7 Setting

<PF7F>	
0	Output port
1	SDCLK output

PF6 Setting

<PF6C> / <PF6F>	0	1
0	Input port	Output port
1	(Reserved)	(Reserved)

Port F Functon Register 2

PFFC2 (003DH)

	7	6	5	4	3	2	1	0
Bit symbol	–					–		PF0F2
Read/Write	W					W		W
After reset	0					0		0
Function	Always write “0”					Always write “0”		Output buffer 0: CMOS 1: Open drain

Port F Drive Register

PFDR (008FH)

	7	6	5	4	3	2	1	0
Bit symbol	PF7D	PF6D	PF5D	PF4D	PF3D	PF2D	PF1D	PF0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note: Read-modify-write is prohibited for the registers PFCR, PFFC and PFFC2.

Figure 3.5.31 Register for Port F

3.5.11 Port G (PG0 to PG3)

PG0 to PG3 are 4-bit input ports and can also be used as the analog input pins for the internal AD converter. PG3 can also be used as the ADTRG pin for the AD converter.

PG2 and PG3 can also be used as the MX and MY pins for a touch screen interface.

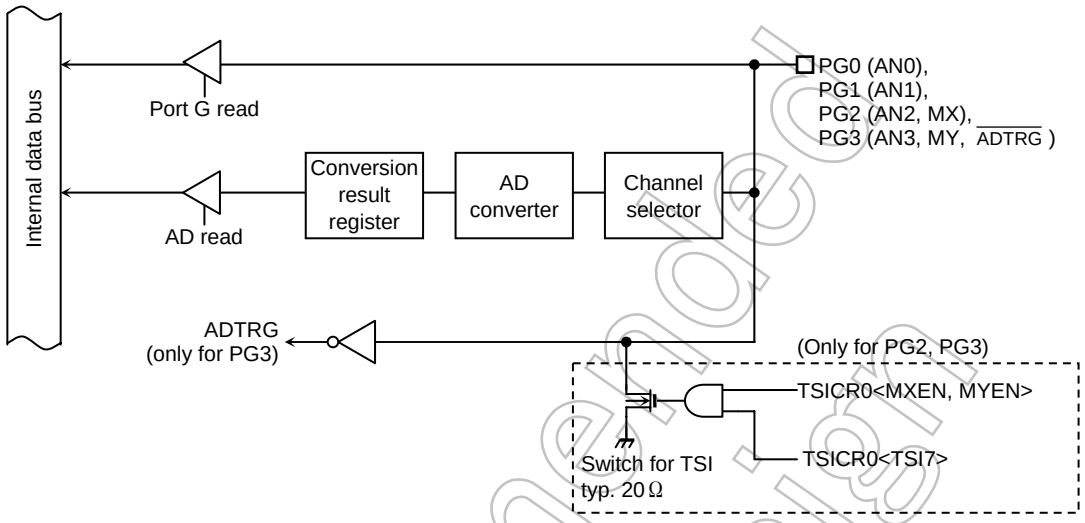


Figure 3.5.32 Port G

Port G Register

		7	6	5	4	3	2	1	0
PG (0040H)	Bit symbol					PG2	PG2	PG1	PG0
	Read/Write					R			
	After reset					Data from external port			

Note: The input channel selection of the AD converter and the permission for ADTRG input are set by AD converter mode register ADMOD1.

Port G Drive Register

		7	6	5	4	3	2	1	0
PGDR (0090H)	Bit symbol					PG3D	PG2D		
	Read/Write					R/W			
	After reset					1	1		
	Function					Input/Output buffer drive register for standby mode			

Figure 3.5.33 Register for Port G

3.5.12 Port J (PJ0 to PJ7)

PJ0 to PJ4 and PJ7 are 6-bit output ports. Resetting sets the output latch PJ to "1", and they output "1". PJ5 to PJ6 are 2-bit I/O ports.

In addition to functioning as a port, port J also functions as output pins for SDRAM ($\overline{\text{SDRAS}}$, $\overline{\text{SDCAS}}$, $\overline{\text{SDWE}}$, SDLLDQM, SDLUDQM and SDCKE), SRAM ($\overline{\text{SRWR}}$, $\overline{\text{SRLLB}}$, $\overline{\text{SRLUB}}$) and NAND flash (NDALE and NDCLE).

The above settings are made using the function register PJFC.

However, H either SDRAM or SRAM output signals for PJ0 to PJ2 are selected automatically according to the setting of the memory controller.

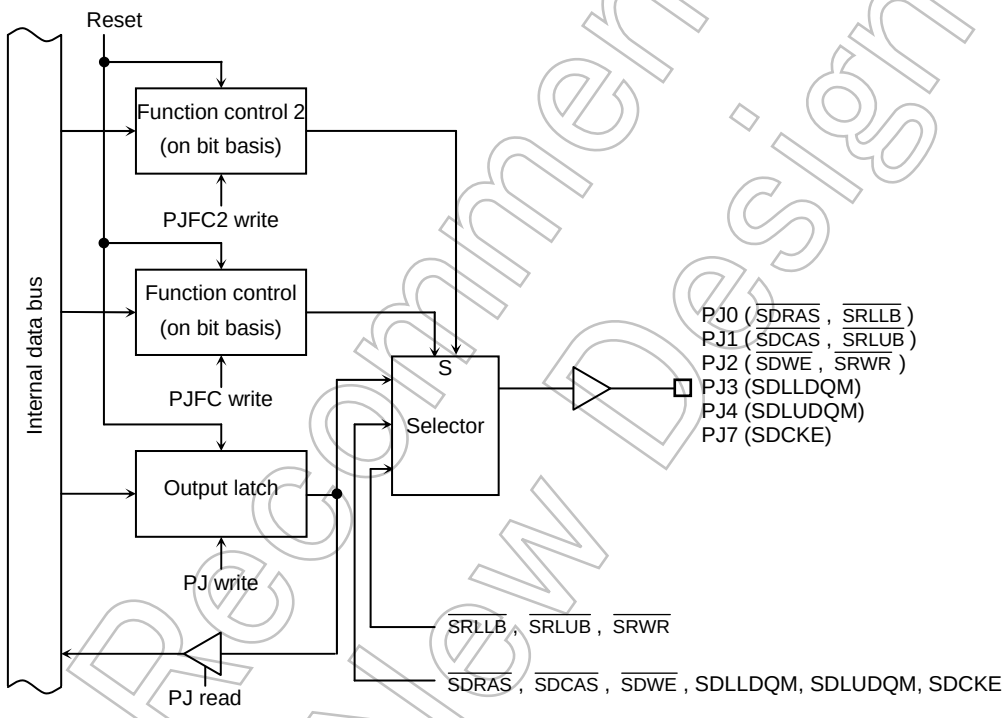


Figure 3.5.34 Port J0, J1, J2, J3, J4 and J7

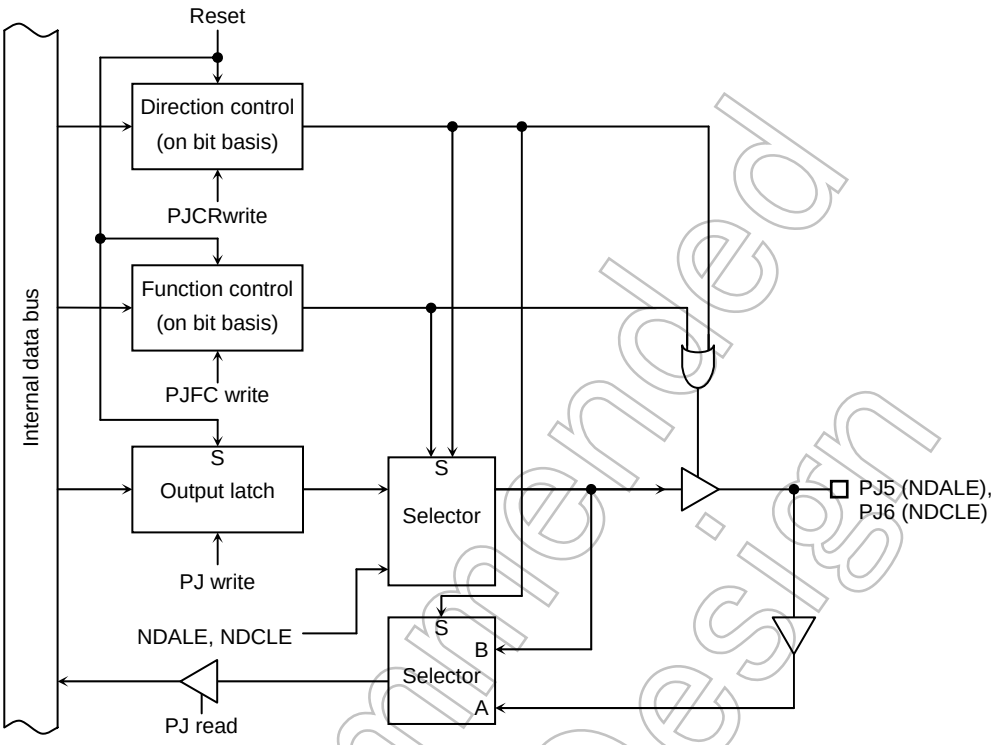


Figure 3.5.35 Port J5 and J6

Port J Register

PJ (004CH)

	7	6	5	4	3	2	1	0
Bit symbol	PJ7	PJ6	PJ5	PJ4	PJ3	PJ2	PJ1	PJ0
Read/Write	R/W							
After reset	1	Data from external port (Output latch register is set to "1")		1	1	1	1	1

Port J Control Register

PJCR (004EH)

	7	6	5	4	3	2	1	0
Bit symbol		PJ6C	PJ5C					
Read/Write		W						
After reset		0	0					
Function		0: Input 1: Output						

Port J Function Register

PJFC (004FH)

	7	6	5	4	3	2	1	0
Bit symbol	PJ7F	PJ6F	PJ5F	PJ4F	PJ3F	PJ2F	PJ1F	PJ0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Port 1: SDCKE at <PJ7> = 1	0: Port 1: NDCLE at <PJ6> = 0,	0: Port 1: NDALE at <PJ5> = 0	0: Port 1: SDLUDQM at <PJ4> = 1	0: Port 1: SDLLDQM at <PJ3> = 1	0: Port 1: $\overline{\text{SDWE}}$, $\overline{\text{SDWR}}$	0: Port 1: $\overline{\text{SDCAS}}$, $\overline{\text{SRLUB}}$	0: Port 1: $\overline{\text{SRRAS}}$, $\overline{\text{SRLLB}}$

Port J Drive Register

PJDR (0093H)

	7	6	5	4	3	2	1	0
Bit symbol	PJ7D	PJ6D	PJ5D	PJ4D	PJ3D	PJ2D	PJ1D	PJ0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note: Read-modify-write is prohibited for the registers PJCR and PJFC.

Figure 3.5.36 Register for Port J

3.5.13 Port K (PK0 to PK7)

Port K is a 4-bit output port. Resetting sets the output latch PK to "0", and PK0 to PK3 pins output "0".

PK4 to PK7 are 4-bit input ports. Resetting sets the PLCR to "0", and set input port.

In addition to functioning as an output port, port K also functions as output pins for an LCD controller (LCP0, LLP, LFR and LBCD) and pin for an SPI controller (SPCLK, $\overline{\text{SPCS}}$, SPDO and SPDI).

The above settings are made using the function register PKFC.

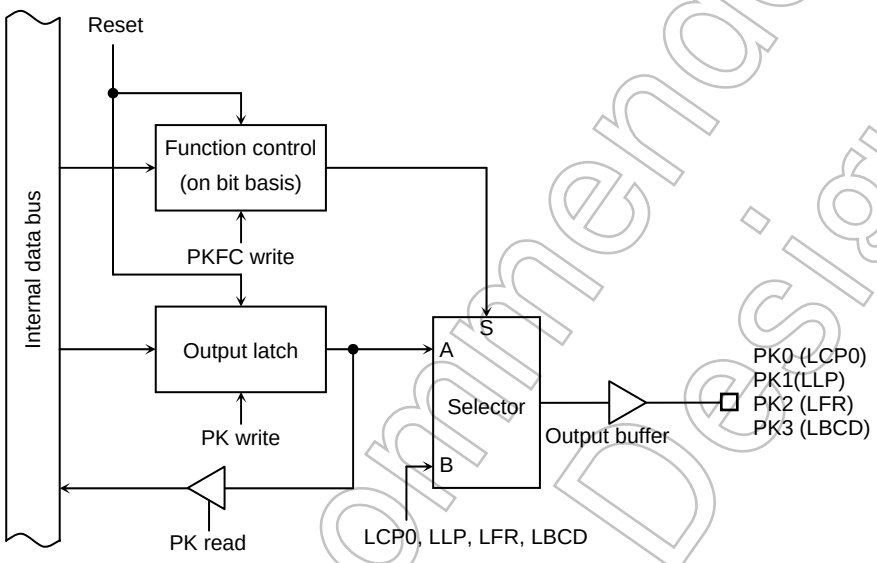


Figure 3.5.37 Port K0 to K3

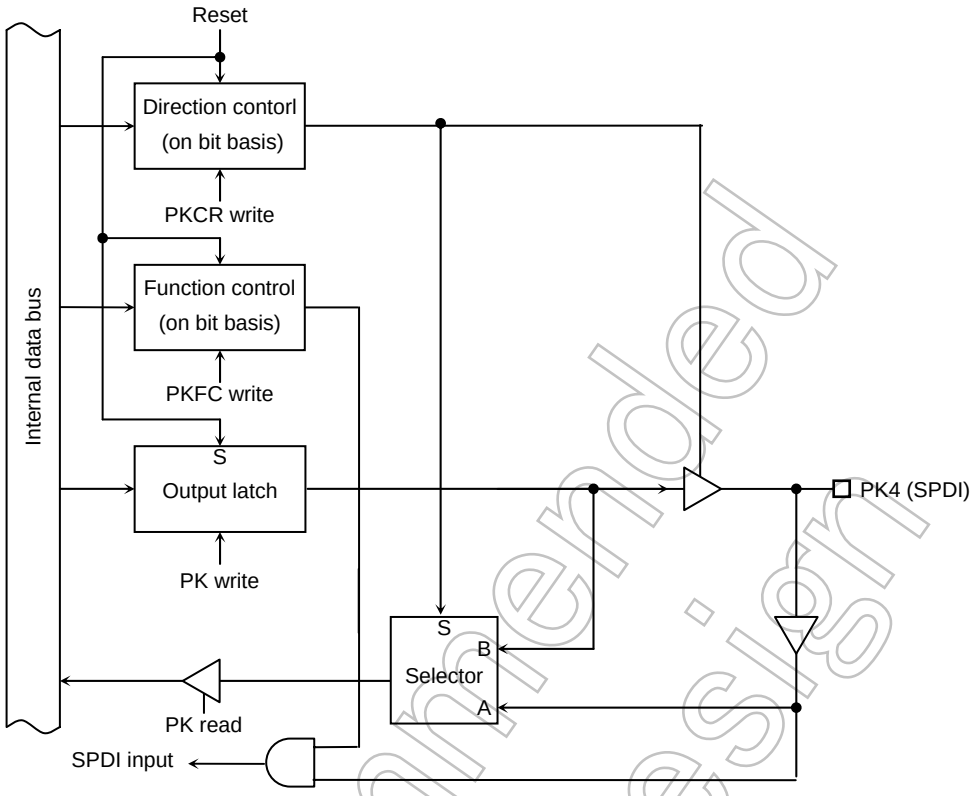


Figure 3.5.38 Port K4

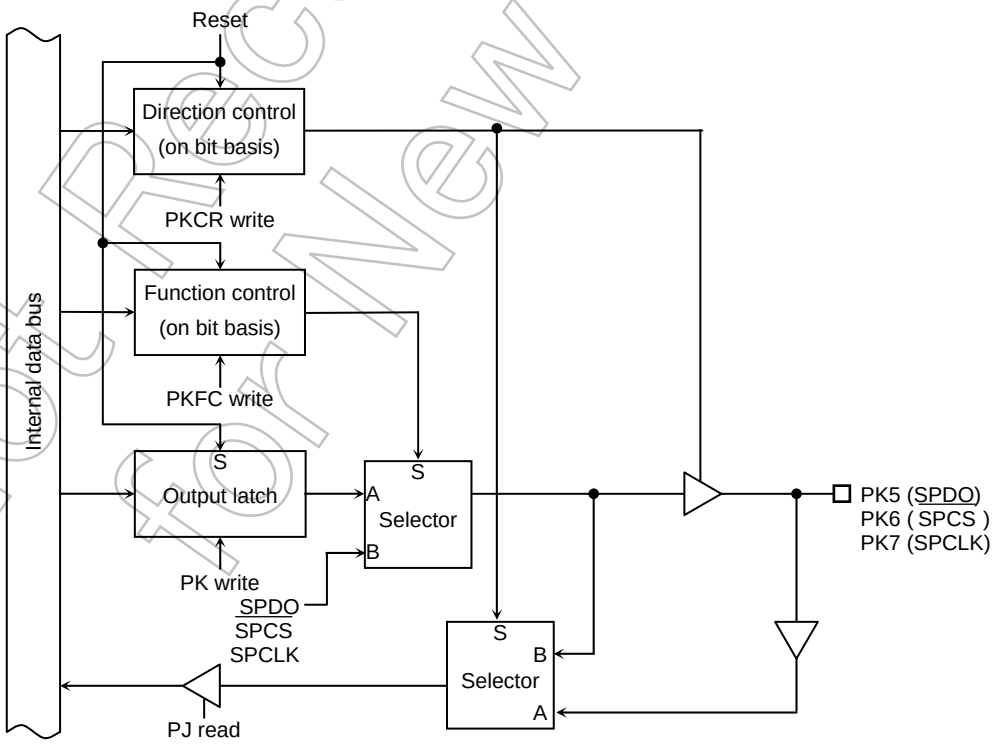


Figure 3.5.39 Port K5 to K7

Port K Register

PK (0050H)

	7	6	5	4	3	2	1	0
Bit symbol	PK7	PK6	PK5	PK4	PK3	PK2	PK1	PK0
Read/Write	R/W							
After reset	Data from external port (Output latch register is cleared to "0")				0	0	0	0

Port K Control Register

PKCR (0052H)

	7	6	5	4	3	2	1	0
Bit symbol	PK7C	PK6C	PK5C	PK4C				
Read/Write	W							
After reset	0	0	0	0				
Function	0: Input 1: Output							

Port K Function Register

PKFC (0053H)

	7	6	5	4	3	2	1	0
Bit symbol	PK7F	PK6F	PK5F	PK4F	PK3F	PK2F	PK1F	PK0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Port 1: SPCLK output	0: Port 1: $\overline{\text{SPCS}}$ output	0: Port 1: SPDO output	0: Port 1: SPDI output	0: Port 1: LBCD	0: Port 1: LFR	0: Port 1: LLP	0: Port 1: LCP0

PK5 Setting

<PK5C> / <PK5F>	0	1
0	Input port	Output port
1	Reserved	SPDO output

PK4 Setting

<PK4C> / <PK4F>	0	1
0	Input port	Output port
1	SPDI input	Reserved

PK7 Setting

<PK7C> / <PK7F>	0	1
0	Input port	Output port
1	Reserved	SPCLK output

PK6 Setting

<PK6C> / <PK6F>	0	1
0	Input port	Output port
1	Reserved	SPCS output

Port K Drive Register

PKDR (0094H)

	7	6	5	4	3	2	1	0
Bit symbol	PK7D	PK6D	PK5D	PK4D	PK3D	PK2D	PK1D	PK0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note: Read-modify-write is prohibited for the register PKFC.

Figure 3.5.40 Register for Port K

3.5.14 Port L (PL0 to PL7)

PL0 to PL3 are 4-bit output ports. Resetting sets the output latch PL to "0", and PL0 to PL3 pins output "0".

PL4 to PL7 are 4-bit general-purpose I/O ports. Each bit can be set individually for input or output using the control register PLCR. Resetting resets the control register PLCR to "0" and sets PL4 to PL7 to input ports. In addition to functioning as a general-purpose I/O port, port L can also function as a data bus for an LCD controller (LD0 to LD7) and external bus open request input ($\overline{\text{BUSRQ}}$),answer output ($\overline{\text{BUSAK}}$). The above settings are made using the function register PLFC.

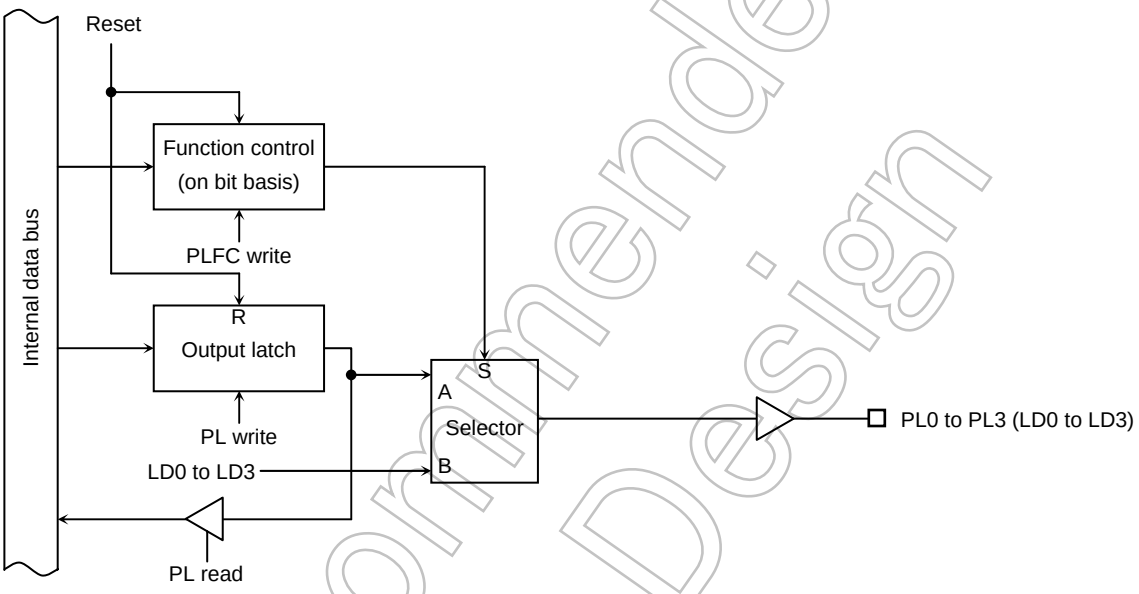


Figure 3.5.41 Register for Port L0 to L3

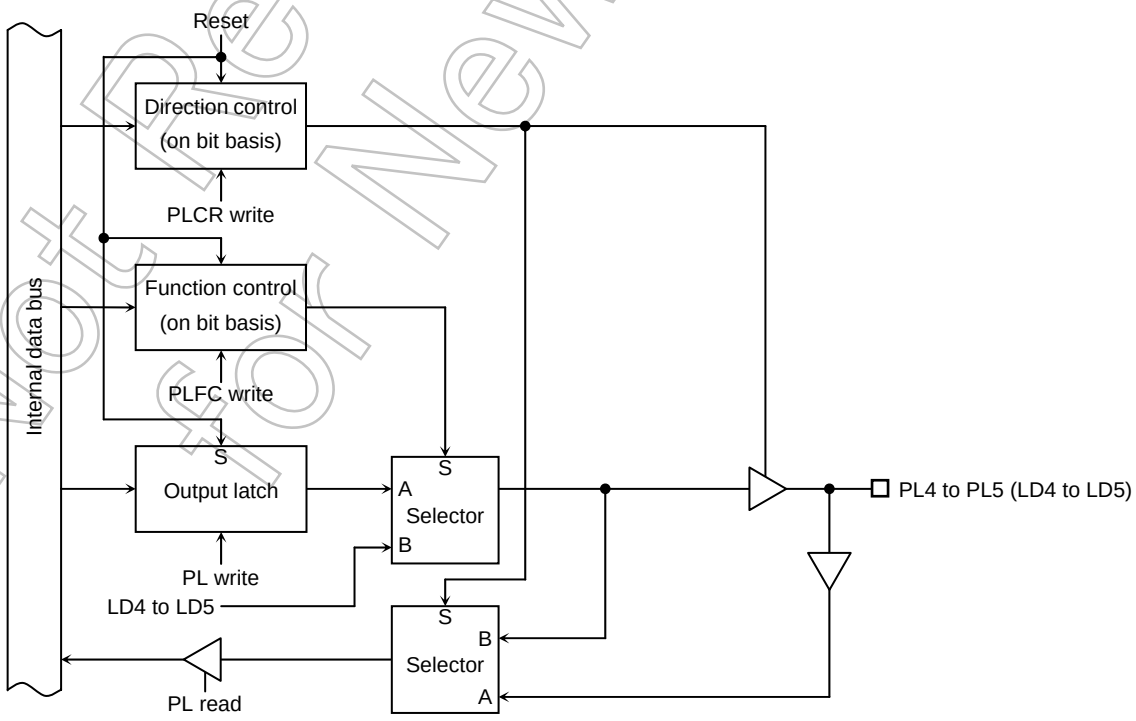


Figure 3.5.42 Register for Port L4 to L5

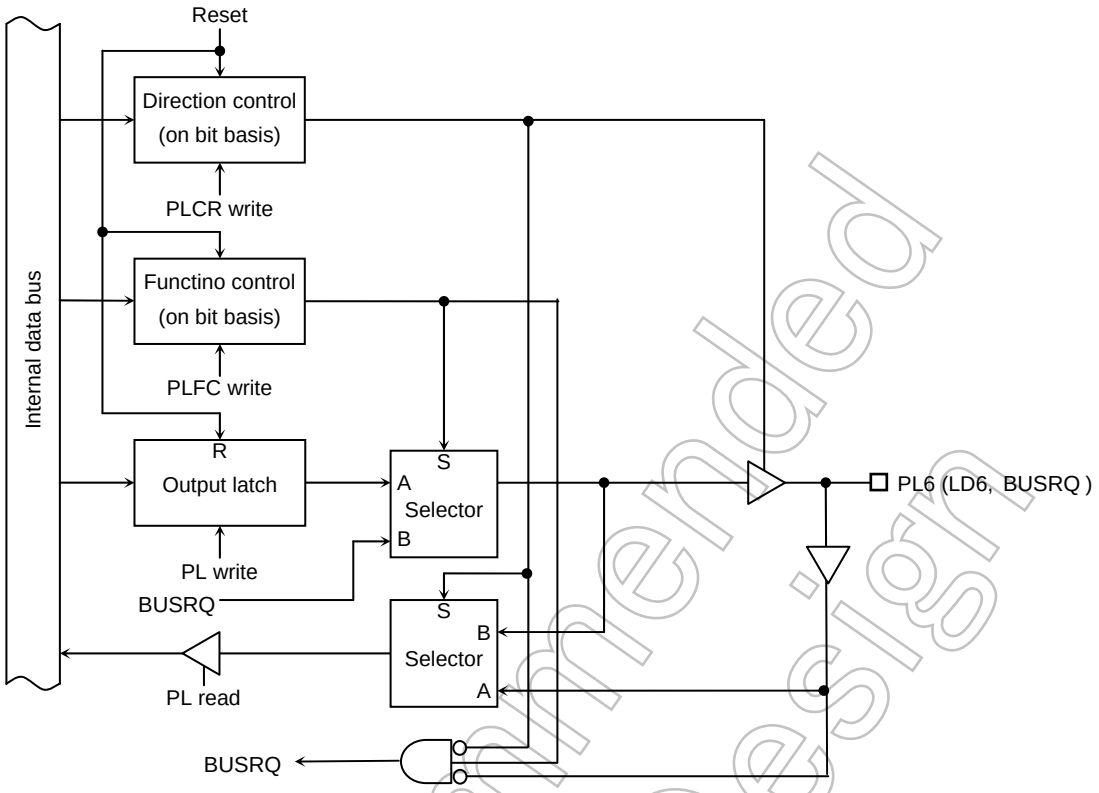


Figure 3.5.43 Port L6

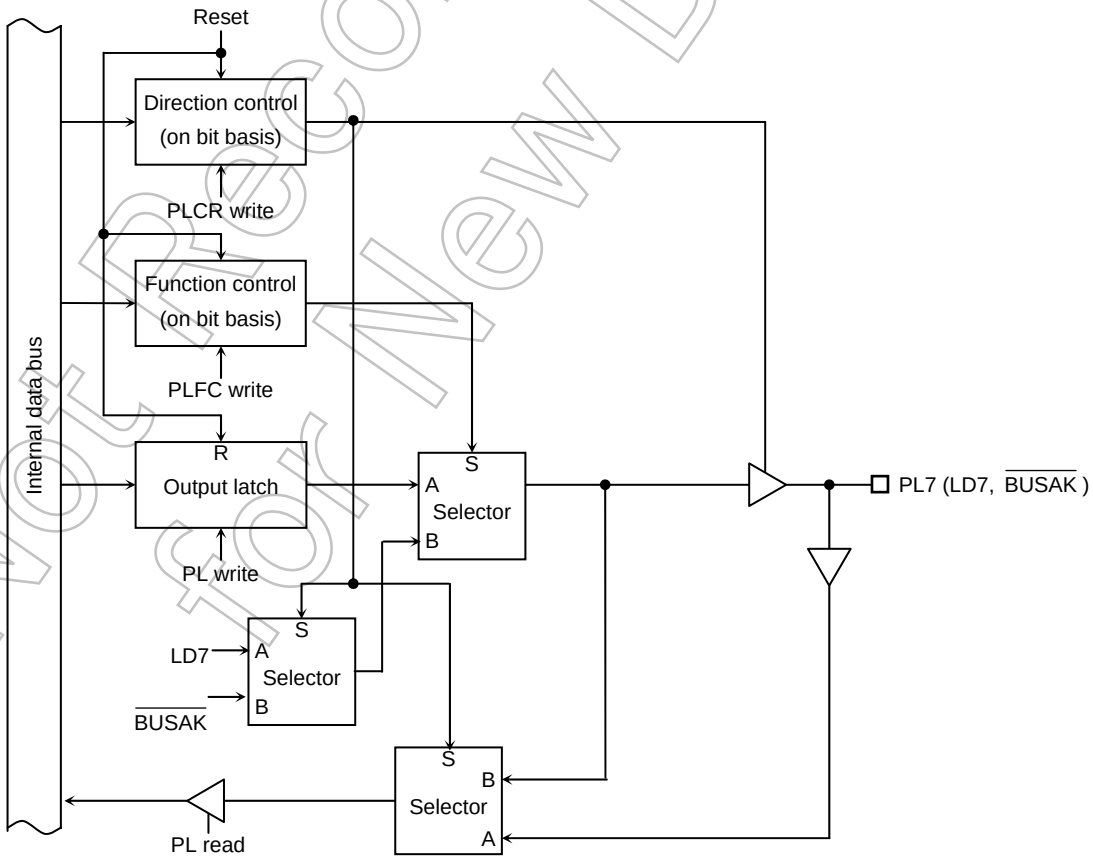


Figure 3.5.44 Port L7

Port L Register

PL (0054H)

	7	6	5	4	3	2	1	0
Bit symbol	PL7	PL6	PL5	PL4	PL3	PL2	PL1	PL0
Read/Write	R/W							
After reset	Data from external port (Output latch register is cleared to "0")				0	0	0	0

Port L Control Register

PLCR (0056H)

	7	6	5	4	3	2	1	0
Bit symbol	PL7C	PL6C	PL5C	PL4C				
Read/Write	W							
After reset	0	0	0	0				
Function	0: Input 1: Output							

Port L Function Register

PLFC (0057H)

	7	6	5	4	3	2	1	0
Bit symbol	PL7F	PL6F	PL5F	PL4F	PL3F	PL2F	PL1F	PL0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	Refer following table				0: Port 1: Data bus for LCDC (LD3 to LD0)			

PL5 Setting

<PL5C> / <PL5F>	0	1
0	Input port	Output port
1	Reserved	LD5 output

PL4 Setting

<PL4C> / <PL4F>	0	1
0	Input port	Output port
1	Reserved	LD4 output

PL7 Setting

<PL7C> / <PL7F>	0	1
0	Input port	Output port
1	$\overline{\text{BUSAK}}$ output	LD7 output

PL6 Setting

<PL6C> / <PL6F>	0	1
0	Input port	Output port
1	$\overline{\text{BUSRQ}}$ input	LD6 output

Port L Drive Register

PLDR (0095H)

	7	6	5	4	3	2	1	0
Bit symbol	PL7D	PL6D	PL5D	PL4D	PL3D	PL2D	PL1D	PL0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note1: Read-modify-write is prohibited for the registers PLCR and PLFC.

Note2: When Port L are used at LD0 to LD7, If set PL6 pin to $\overline{\text{BUSRQ}}$ function input temporarily, CPU may not be operate normally. Therefore, set registers by following order.

Order	Register	Setting value
(1)	PLCR	1
(2)	PLFC	1

Figure 3.5.45 Port L Register

3.5.15 Port M (PM1 to PM2)

PM1 and PM2 are 2-bit output ports. Resetting sets the output latch PM to "1", and PM1 and PM2 pins output "1".

In addition to functioning as a port, port M also functions as output pins for the RTC alarm ($\overline{\text{ALARM}}$), and as the output pin for the melody/alarm generator (MLDALM, $\overline{\text{MLDALM}}$).

The above settings are made using the function register PMFC.

Only PM2 has two output functions - $\overline{\text{ALARM}}$ and $\overline{\text{MLDALM}}$. These are selected using PM<PM2>.

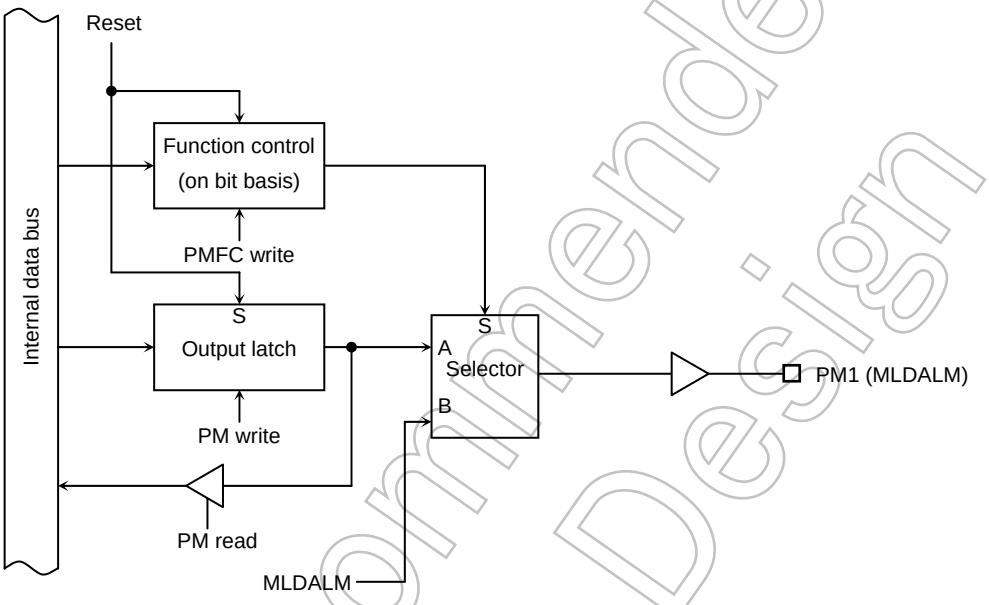


Figure 3.5.46 Port M1

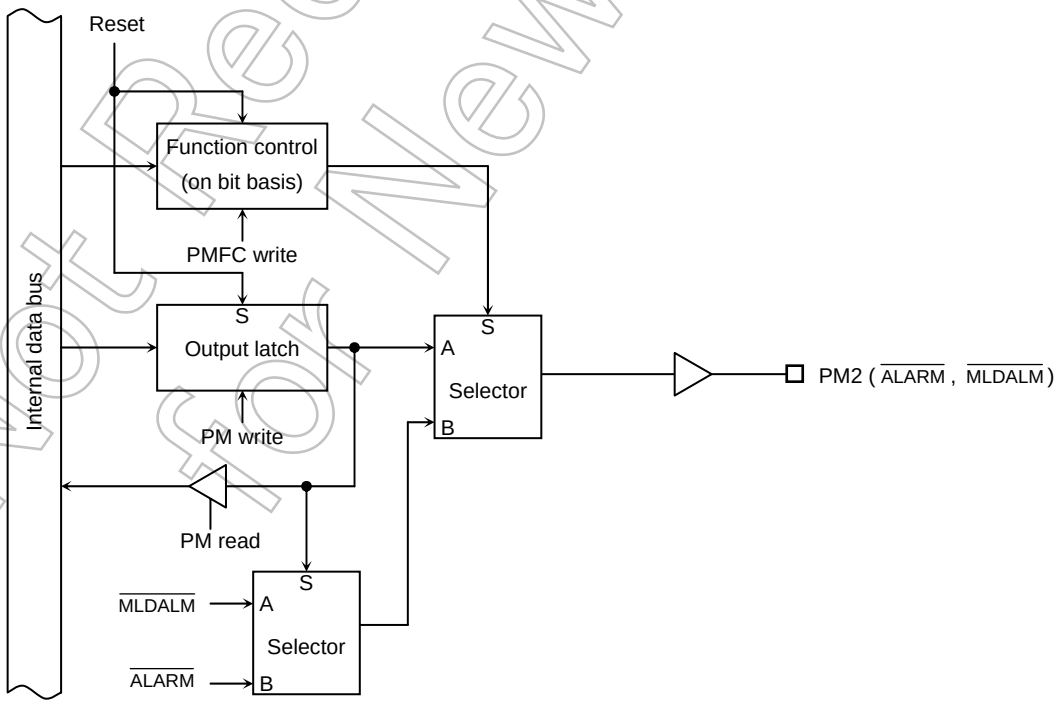


Figure 3.5.47 Port M2

Port M Register

PM (0058H)

	7	6	5	4	3	2	1	0
Bit symbol						PM2	PM1	
Read/Write						R/W		
After reset						1	1	

Port M Function Register

PMFC (005BH)

	7	6	5	4	3	2	1	0
Bit symbol						PM2F	PM1F	
Read/Write						W		
After reset						0	0	
Function						0: Port 1: $\overline{\text{ALARM}}$ at <PM2> = "1" 1: $\overline{\text{MLDALM}}$ at <PM2> = "0"	0: Port 1: MLDALM output	

Port M Drive Register

PMDR (0096H)

	7	6	5	4	3	2	1	0
Bit symbol						PM2D	PM1D	
Read/Write						R/W		
After reset						1	1	
Function						Input/Output buffer drive register for standby mode		

Note: Read-modify-write is prohibited for the register PMFC.

Figure 3.5.48 Register for Port M

3.5.16 Port N (PN0 to PN7)

PN0 to PN7 are 8-bit general-purpose I/O port. Each bit can be set individually for input or output. Resetting sets Port N to an input port.

In addition to functioning as a general-purpose I/O port, Port N can also as interface pin for key-board (KO0 to KO7). This function can set to open-drain type output buffer.

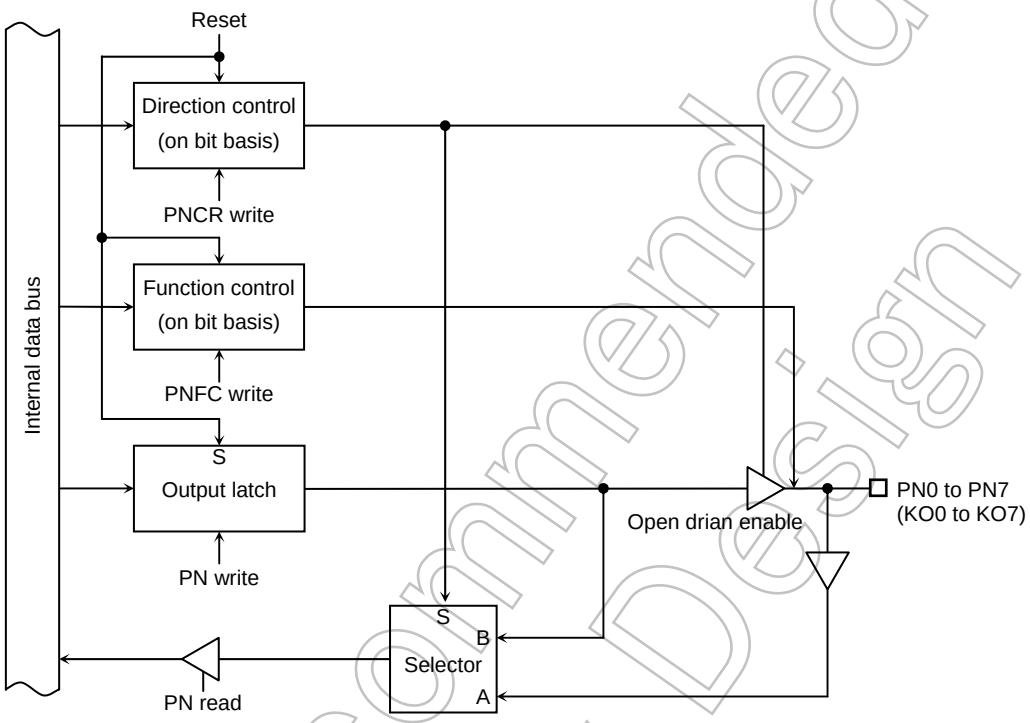


Figure 3.5.49 Port N

Port N register

PN (005CH)

	7	6	5	4	3	2	1	0
Bit symbol	PN7	PN6	PN5	PN4	PN3	PN2	PN1	PN0
Read/Write	R/W							
After reset	Data from external port (Output latch register is set to “1”)							

Port N Control Register

PNCR (005EH)

	7	6	5	4	3	2	1	0
Bit symbol	PN7C	PN6C	PN5C	PN4C	PN3C	PN2C	PN1C	PN0C
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: Input 1: Output							

Port N Function Register

PNFC (005FH)

	7	6	5	4	3	2	1	0
Bit symbol	PN7F	PN6F	PN5F	PN4F	PN3F	PN2F	PN1F	PN0F
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	0: CMOS output 1:Open drain output							

Port N Drive Register

PNDR (0097H)

	7	6	5	4	3	2	1	0
Bit symbol	PN7D	PN6D	PN5D	PN4D	PN3D	PN2D	PN1D	PN0D
Read/Write	R/W							
After reset	1	1	1	1	1	1	1	1
Function	Input/Output buffer drive register for standby mode							

Note: Read modify write is prohibited for the registers PNCR and PNFC.

Figure 3.5.50 Register for Port N

3.6 Memory Controller

3.6.1 Functions

The TMP92CA25 has a memory controller with a variable 4-block address area that controls as follows.

(1) 4-block address area support

Specifies a start address and a block size for the 4-block address area (block 0 to 3).

- SRAM or ROM: All CS blocks (CS0 to CS3) are supported.
- SDRAM : Only either CS1 or CS2 blocks are supported.
- Page ROM : Only CS2 blocks are supported.
- NAND flash : CS setting is not needed.

(2) Connecting memory specifications

Specifies SRAM, ROM and SDRAM as memories that connect with the selected address areas.

(3) Data bus width selection

Whether 8 bits, 16 bits is selected as the data bus width of the respective block address areas.

(4) Wait control

Wait specification bit in the control register and $\overline{\text{WAIT}}$ input pin control the number of waits in the external bus cycle. Read cycle and write cycle can specify the number of waits individually.

The number of waits is controlled in the 6 modes listed below.

0 waits, 1 wait,

2 waits, 3 waits, 4 waits

N waits (controls with $\overline{\text{WAIT}}$ pin)

3.6.2 Control Register and Operation after Reset Release

This section describes the registers that control the memory controller, the state following reset release and the necessary settings.

(1) Control register

The control registers of the memory controller are as follows and in Table 3.6.1 and Table 3.6.2.

- Control register: BnCSH/BnCSL (n = 0 to 3, EX)
  Sets the basic functions of the memory controller; the memory type that is connected, the number of waits which are read and written.
- Memory start address register: MSARn (n = 0 to 3)
  Sets a start address in the selected address areas.
- Memory address mask register: MAMR (n = 0 to 3)
  Sets a block size in the selected address areas.
- Page ROM control register: PMEMCR
  Sets the method of accessing page ROM.
- Memory controls control register: MEMCR0
  Sets waveform selection of $\overline{\text{RD}}$ pin and setting method of $\overline{\text{CS0}}$ to $\overline{\text{CS3}}$.

Table 3.6.1 Control Register

		7	6	5	4	3	2	1	0
B0CSL (0140H)	Bit symbol		B0WW2	B0WW1	B0WW0		B0WR2	B0WR1	B0WR0
	Read/Write		W				W		
	After reset		0	1	0		0	1	0
B0CSH (0141H)	Bit symbol	B0E	–	–	B0REC	B0OM1	B0OM0	B0BUS1	B0BUS0
	Read/Write	W							
	After reset	0	0 (Note)	0 (Note)	0	0	0	0	0
MAMR0 (0142H)	Bit symbol	M0V20	M0V19	M0V18	M0V17	M0V16	M0V15	M0V14 to M0V9	M0V8
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
MSAR0 (0143H)	Bit symbol	M0S23	M0S22	M0S21	M0S20	M0S19	M0S18	M0S17	M0S16
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
B1CSL (0144H)	Bit symbol		B1WW2	B1WW1	B1WW0		B1WR2	B1WR1	B1WR0
	Read/Write		W				W		
	After reset		0	1	0		0	1	0
B1CSH (0145H)	Bit symbol	B1E	–	–	B1REC	B1OM1	B1OM0	B1BUS1	B1BUS0
	Read/Write	W							
	After reset	0	0 (Note)	0 (Note)	0	0	0	0	0
MAMR1 (0146H)	Bit symbol	M1V21	M1V20	M1V19	M1V18	M1V17	M1V16	M1V15 to M1V9	M1V8
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
MSAR1 (0147H)	Bit symbol	M1S23	M1S22	M1S21	M1S20	M1S19	M1S18	M1S17	M1S16
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
B2CSL (0148H)	Bit symbol		B2WW2	B2WW1	B2WW0		B2WR2	B2WR1	B2WR0
	Read/Write		W				W		
	After reset		0	1	0		0	1	0
B2CSH (0149H)	Bit symbol	B2E	B2M	–	B2REC	B2OM1	B2OM0	B2BUS1	B2BUS0
	Read/Write	W							
	After reset	1	0	0 (Note)	0	0	0	0	0
MAMR2 (014AH)	Bit symbol	M2V22	M2V21	M2V20	M2V19	M2V18	M2V17	M2V16	M2V15
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
MSAR2 (014BH)	Bit symbol	M2S23	M2S22	M2S21	M2S20	M2S19	M2S18	M2S17	M2S16
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
B3CSL (014CH)	Bit symbol		B3WW2	B3WW1	B3WW0		B3WR2	B3WR1	B3WR0
	Read/Write		W				W		
	After reset		0	1	0		0	1	0
B3CSH (014DH)	Bit symbol	B3E	–	–	B3REC	B3OM1	B3OM0	B3BUS1	B3BUS0
	Read/Write	W							
	After reset	0	0 (Note)	0 (Note)	0	0	0	0	0
MAMR3 (014EH)	Bit symbol	M3V22	M3V21	M3V20	M3V19	M3V18	M3V17	M3V16	M3V15
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1
MSAR3 (014FH)	Bit symbol	M3S23	M3S22	M3S21	M3S20	M3S19	M3S18	M3S17	M3S16
	Read/Write	R/W							
	After reset	1	1	1	1	1	1	1	1

Note 1: Always write “0”.

Note 2:Read-modify-write is prohibited for BnCS0 and BnCSH (n = 0 to 3) registers.

Table 3.6.2 Control Register

		7	6	5	4	3	2	1	0
BEXCSH (0159H)	Bit symbol					BEXOM1	BEXOM0	BEXBUS1	BEXBUS0
	Read/Write					W			
	After reset					0	0	0	0
BEXCSL (0158H)	Bit symbol		BEXWW2	BEXWW1	BEXWW0		BEXWR2	BEXWR1	BEXWR0
	Read/Write		W				W		
	After reset		0	1	0		0	1	0
PMEMCR (0166H)	Bit symbol				OPGE	OPWR1	OPWR0	PR1	PR0
	Read/Write				R/W				
	After reset				0	0	0	1	0
MEMCR0 (0168H)	Bit symbol						CSDIS	RDTMG1	RDTMG0
	Read/Write						R/W		
	After reset						0	0	0

Note: Read-modify-write is prohibited for BEXCSH and BEXCSL registers.

(2) Operation after reset release

The start data bus width is determined by the state of AM1/AM0 pins just after reset release. The external memory is then accessed as follows

AM1	AM0	Start Mode
0	0	Don't use this setting
0	1	Start with 16-bit data bus (Note)
1	0	Start with 8-bit data bus (Note)
1	1	Don't use this setting

Note: The memory to be used on starting after reset must be either NOR flash or masked ROM. NAND flash and SDRAM cannot be used.

AM1/AM0 pins are valid only just after reset release. In other cases, the data bus width is set by the control register <BnBUS1:0> .

On reset, only the control register (B2CSH/B2CSL) of the block address area 2 becomes effective automatically (B2CSH<B2E> is set to "1" on reset).

The data bus width which is specified by AM1/AM0 pins is loaded to the bit for specification of the bus width of the control register in the block address area 2.

The block address area 2 is set to 000000H to FFFFFFH address on reset (B2CSH<B2M> is reset to "0").

After reset release, the block address areas are specified by the memory start address register (MSARn) and the memory address mask register (MAMRn). The control register (BnCS) is then set.

Set the enable bit (BnE) of the control register to "1" to enable the setting.

3.6.3 Basic Functions and Register Setting

This section describes the setting of the block address area, the connecting memory and the number of waits out of the memory controller's functions.

(1) Block address area specification

The block address area is specified by two registers.

The memory start address register (MSARn) sets the start address of the block address areas. The memory controller compares the register value and the address every bus cycle. The address bit which is masked by the memory address mask register (MAMRn) is not compared by the memory controller. The block address area size is determined by setting the memory address mask register. The value that is set to the register is compared with the block address area on the bus. If the result is a match, the memory controller sets the chip select signal (CSn) to "low".

(i) Memory start address register setting

The MS23 to MS16 bits of the memory start address register correspond with addresses A23 to A16 respectively. The lower start addresses A15 to A0 are always set to address 0000H.

Therefore the start addresses of the block address area are set to all 64 Kbytes of addresses 000000H to FF0000H.

(ii) Memory address mask register setting

The memory address mask register determines whether an address bit is compared or not. In register setting, "0" is "compare", and "1" is "do not compare".

The address bits that can be set depends on the block address area.

Block address area 0: A20 to A8

Block address area 1: A21 to A8

Block address area 2 to 3: A22 to A15

The upper bits are always compared. The block address area size is determined by the result of the comparison.

The size to be set depending on the block address area is as follows.

Size (bytes) / CS area	256	512	32 K	64 K	128 K	256 K	512 K	1 M	2 M	4 M	8 M
CS0	○	○	○	○	○	○	○	○	○		
CS1	○	○		○	○	○	○	○	○	○	
CS2 to CS3			○	○	○	○	○	○	○	○	○

Note: After reset release, only the control register of the block address area 2 is valid. The control register of block address area 2 has the <B2M> bit. If the <B2M> bit is set to "0", block address area 2 is set to addresses 000000H to FFFFFFH. (This is the state following reset release .) If the <B2M> bit is set to "1", the start address and the address area size are set, as in the other block address areas.

(iii) Example of register setting

To set the block address area 64 Kbytes from address 110000H, set the register as follows.

MSAR1 Register

Bit	7	6	5	4	3	2	1	0
Bit symbol	M1S23	M1S22	M1S21	M1S20	M1S19	M1S18	M1S17	M1S16
Specified value	0	0	0	1	0	0	0	1

M1S23 to M1S16 bits of the memory start address register MSAR1 correspond with address A23 to A16.

A15 to A0 are set to "0". Therefore, if MSAR1 is set to the above mentioned value, the start address of the block address area is set to address 110000H.

MAMR1 Register

Bit	7	6	5	4	3	2	1	0
Bit symbol	M1V21	M1V20	M1V19	M1V18	M1V17	M1V16	M1V15 to M1V9	M1V8
Specified value	0	0	0	0	0	0	0	1

M1V21 to M1V16 and M1V8 bits of the memory address mask register MAMR1 are set whether addresses A21 to A16 and A8 are compared or not. In register setting, "0" is "compare", and "1" is "do not compare". M1V15 to M1V9 bits determine whether addresses A15 to A9 are compared or not with bit 1. A23 and A22 are always compared.

When set as above, A23 to A9 are compared with the value that is set as the start addresses. Therefore, 512 bytes (addresses 110000H to 1101FFH) are set as block address area 1, and if it is compared with the addresses on the bus, the chip select signal CS1 is set to "low".

The other block address area sizes are specified in the same way.

A23 and A22 are always compared with block address area 0. Whether A20 to A8 are compared or not is determined by the register.

Similarly, A23 is always compared with block address areas 2 to 5. Whether A22 to A15 are compared or not is determined by the register.

Note 1: When the set block address area overlaps with the built-in memory area, or both two address areas overlap, the block address area is processed according to priority as follows.

Built-in I/O > Built-in memory > Block address area 0 > 1 > 2 > 3

Note 2: If an address area other than $\overline{CS0}$ to $\overline{CS3}$ is accessed, this area is regarded as $\overline{CSEX}$. Therefore, wait number and data bus width controls follow the setting of $\overline{CSEX}$ (BEXCSH, BEXCSL register).

(2) Connection memory specification

Setting the <BnOM1:0> bit of the control register (BnCSH) specifies the memory type that is connected with the block address areas. The interface signal is outputted according to the set memory as follows.

<BnOM1: 0> Bit (BnCSH Register)

<BnOM1>	<BnOM0>	Function
0	0	SRAM/ROM (Default)
0	1	Reserved
1	0	Reserved
1	1	SDRAM

Note 1: SDRAM should be set to block either 1 or 2.

Note 2: Set "00" for NAND flash, RAM built-in LCDD.

(3) Data bus width specification

The data bus width is set for every block address area. The bus size is set by setting the control register (BnCSH)<BnBUS1:0> as follows.

<BnBUS1:0> bit (BnCSH Register)

BnBUS 1	BnBUS 0	Function
0	0	8-bit bus mode (Default)
0	1	16-bit bus mode
1	0	Reserved
1	1	Don't use this setting

Note: SDRAM should be set to either "01" (16-bit bus).

This method of changing the data bus width depending on the accessing address is called "dynamic bus sizing". The part of the data bus to which the data is output depends on the data size, baus width and start address.

Number of external data bus pin in TMP92CA25 are 16 pins. Therefore, please ignore case of memory data size is 32 in each tables.

Note: Since there is a possibility of abnormal writing/reading of the data if two memories with different bus width are put in consecutive addresses, do not execute an access to both memories with one command.

Operand Data Size (bit)	Operand Start Address	Memory Data Size (bit)	CPU Address	CPU Data			
				D31 to D24	D23 to D16	D15 to D8	D7 to D0
8	4n + 0	8/16/32	4n + 0	xxxxx	xxxxx	xxxxx	b7 to b0
	4n + 1	8	4n + 1	xxxxx	xxxxx	xxxxx	b7 to b0
		16/32	4n + 1	xxxxx	xxxxx	b7 to b0	xxxxx
	4n + 2	8/16	4n + 2	xxxxx	xxxxx	xxxxx	b7 to b0
		32	4n + 2	xxxxx	b7 to b0	xxxxx	xxxxx
	4n + 3	8	4n + 3	xxxxx	xxxxx	xxxxx	b7 to b0
		16	4n + 3	xxxxx	xxxxx	b7 to b0	xxxxx
		32	4n + 3	b7 to b0	xxxxx	xxxxx	xxxxx
16	4n + 0	8	(1) 4n + 0	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 1	xxxxx	xxxxx	xxxxx	b15 to b8
		16/32	4n + 0	xxxxx	xxxxx	b15 to b8	b7 to b0
	4n + 1	8	(1) 4n + 1	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 2	xxxxx	xxxxx	xxxxx	b15 to b8
		16	(1) 4n + 1	xxxxx	xxxxx	b7 to b0	xxxxx
			(2) 4n + 2	xxxxx	xxxxx	xxxxx	b15 to b8
		32	4n + 1	xxxxx	b15 to b8	b7 to b0	xxxxx
	4n + 2	8	(1) 4n + 2	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 1	xxxxx	xxxxx	xxxxx	b15 to b8
		16	4n + 2	xxxxx	xxxxx	b15 to b8	b7 to b0
		32	4n + 2	b15 to b8	b7 to b0	xxxxx	xxxxx
	4n + 3	8	(1) 4n + 3	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 4	xxxxx	xxxxx	xxxxx	b15 to b8
		16	(1) 4n + 3	xxxxx	xxxxx	b7 to b0	xxxxx
			(2) 4n + 4	xxxxx	xxxxx	xxxxx	b15 to b8
		32	(1) 4n + 3	b7 to b0	xxxxx	xxxxx	xxxxx
			(2) 4n + 4	xxxxx	xxxxx	xxxxx	b15 to b8
32	4n + 0	8	(1) 4n + 0	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 1	xxxxx	xxxxx	xxxxx	b15 to b8
			(3) 4n + 2	xxxxx	xxxxx	xxxxx	b23 to b16
			(4) 4n + 3	xxxxx	xxxxx	xxxxx	b31 to b24
		16	(1) 4n + 0	xxxxx	xxxxx	b15 to b8	b7 to b0
			(2) 4n + 2	xxxxx	xxxxx	b31 to b24	b23 to b16
		32	4n + 0	b31 to b24	b23 to b16	b15 to b8	b7 to b0
	4n + 1	8	(1) 4n + 0	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 1	xxxxx	xxxxx	xxxxx	b15 to b8
			(3) 4n + 2	xxxxx	xxxxx	xxxxx	b23 to b16
			(4) 4n + 3	xxxxx	xxxxx	xxxxx	b31 to b24
		16	(1) 4n + 1	xxxxx	xxxxx	b7 to b0	xxxxx
			(2) 4n + 2	xxxxx	xxxxx	b23 to b16	b15 to b8
			(3) 4n + 4	xxxxx	xxxxx	xxxxx	b31 to b24
		32	(1) 4n + 1	b23 to b16	b15 to b8	b7 to b0	xxxxx
			(2) 4n + 4	xxxxx	xxxxx	xxxxx	b31 to b24
	4n + 2	8	(1) 4n + 2	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 3	xxxxx	xxxxx	xxxxx	b15 to b8
			(3) 4n + 4	xxxxx	xxxxx	xxxxx	b23 to b16
			(4) 4n + 5	xxxxx	xxxxx	xxxxx	b31 to b24
		16	(1) 4n + 2	xxxxx	xxxxx	b15 to b8	b7 to b0
			(2) 4n + 4	xxxxx	xxxxx	b31 to b24	b23 to b16
		32	(1) 4n + 2	b15 to b8	b7 to b0	xxxxx	xxxxx
			(2) 4n + 4	xxxxx	xxxxx	b31 to b24	b23 to b16
	4n + 3	8	(1) 4n + 3	xxxxx	xxxxx	xxxxx	b7 to b0
			(2) 4n + 4	xxxxx	xxxxx	xxxxx	b15 to b8
			(3) 4n + 5	xxxxx	xxxxx	xxxxx	b23 to b16
			(4) 4n + 6	xxxxx	xxxxx	xxxxx	b31 to b24
		16	(1) 4n + 3	xxxxx	xxxxx	b7 to b0	xxxxx
			(2) 4n + 4	xxxxx	xxxxx	b23 to b16	b15 to b8
			(3) 4n + 6	xxxxx	xxxxx	xxxxx	b31 to b24
		32	(1) 4n + 3	b7 to b0	xxxxx	xxxxx	xxxxx
			(2) 4n + 4	xxxxx	b31 to b24	b23 to b16	b15 to b8

xxxxx: During a read, data input to the bus ignored. At write, the bus is at high impedance and the write strobe signal remains non active.

(4) Wait control

The external bus cycle completes a wait of at least two states (100 ns at f_{SYS} = 20 MHz).

Setting the <BnWW2:0> and <BnWR2:0> of BnCSL specifies the number of waits in the read cycle and the write cycle. <BnWW2:0> is set using the same method as <BnWR2:0>.

<BnWW>/<BnWR> (BnCSL Register)

<BnWW2> <BnWR2>	<BnWW1> <BnWR1>	<BnWW0> <BnWR0>	Function
0	0	1	2 states (0 waits) access fixed mode
0	1	0	3 states (1 wait) access fixed mode (Default)
1	0	1	4 states (2 waits) access fixed mode
1	1	0	5 states (3 waits) access fixed mode
1	1	1	6 states (4 waits) access fixed mode
0	1	1	$\overline{\text{WAIT}}$ pin input mode
Others			(Reserved)

Note 1: For SDRAM, the above setting is ineffective. Refer to 3.16 SDRAM controller.

Note 2: For NAND flash, this setting is ineffective.
For RAM built-in LCDD, this setting is effective.

(i) Waits number fixed mode

The bus cycle is completed following the number of states set. The number of states is selected from 2 states (0 waits) to 6 states (4 waits).

(ii) $\overline{\text{WAIT}}$ pin input mode

This mode samples the $\overline{\text{WAIT}}$ input pins. In this mode, a wait is inserted continuously while the signal is active. The bus cycle is a minimum 2 states. The bus cycle is completed if the wait signal is non active ("High" level) at the second state. The bus cycle continues if the wait signal is active after 2 states or more.

(5) Recovery (Data hold) cycle control

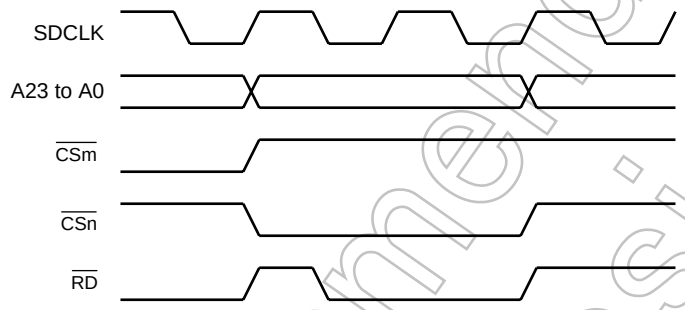
Some memory is defined by AC specification about data hold time by $\overline{CE}$ or $\overline{OE}$ for read cycle. Therefore, a data conflict problem may occur. To avoid this problem, 1-dummy cycle can be inserted after CSm-block access cycle by setting "1" to BmCSH<BmREC> register.

This 1-dummy cycle is inserted when the next cycle is for another CS-block.

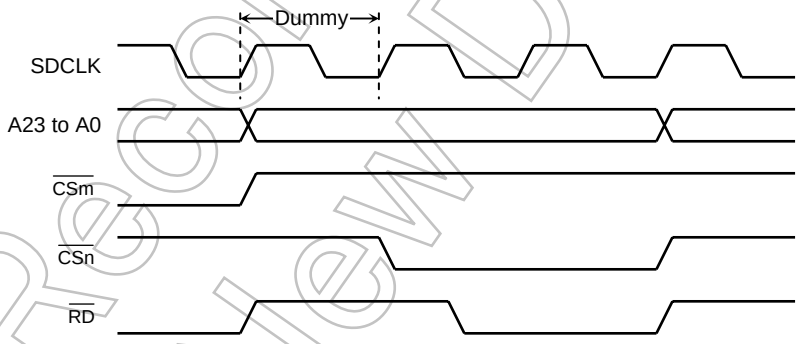
<BnREC> (BnCSH register)

0	No dummy cycle is inserted (Default).
1	Dummy cycle is inserted.

- When no dummy cycle is inserted (0 waits)



- When inserting a dummy cycle (0 waits)

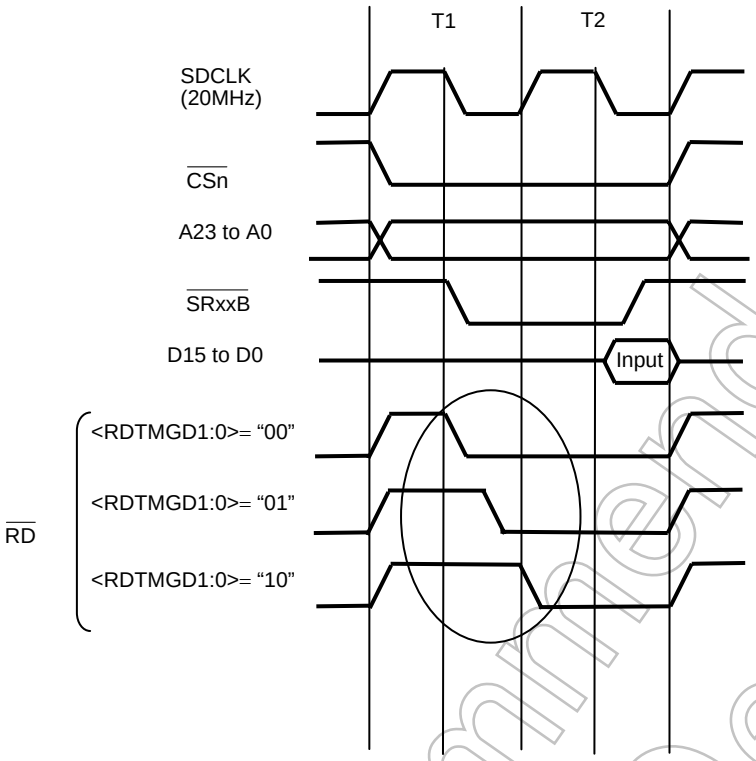


Above function (BnCSH<BnREC>) is inserted dummy cycle and performance go down. Therefore, TMP92CA25 have changing function of $\overline{RD}$ pin falling timing except for <BnREC>. This function can be changed falling timing of $\overline{RD}$ pin by changing MEMCR0<RDTMG1:0>. This function can be avoided A.C speck shortage about data-hold time from $\overline{OE}$, and it can be avoided data conflict problem.

This function can use with <BnREC>. And, this function doesn't depend on CS block. Cycle until from memory $\overline{OE}$ to data output becomes short by using this function. If using this function, please be careful.

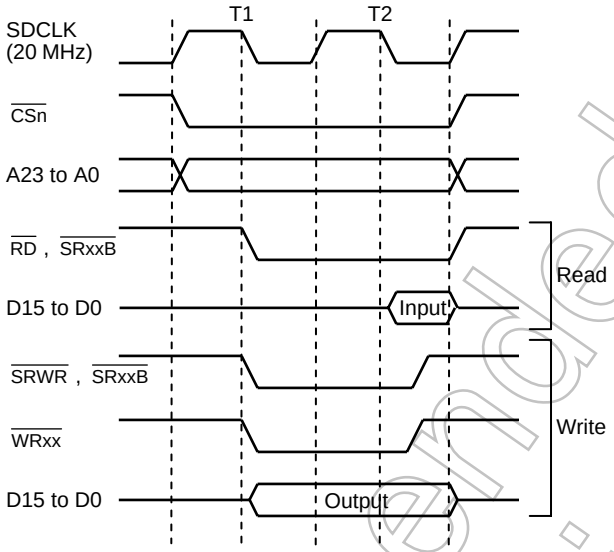
<RDTMG1:0> (MEMCR0 register)

00	$\overline{RD}$ "H" pulse width = 0.5T(Default)
01	$\overline{RD}$ "H" pulse width = 0.75T
10	$\overline{RD}$ "H" pulse width = 1.0T
11	(Reserved)

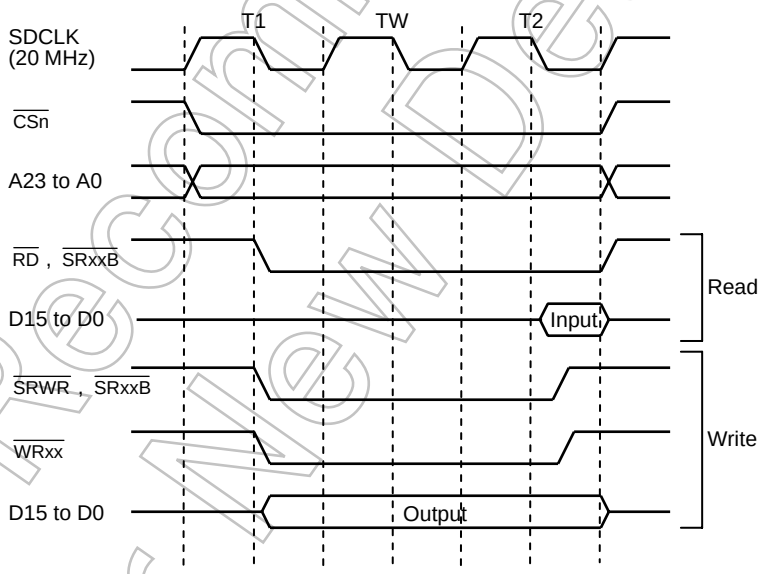


(6) Basic bus timing

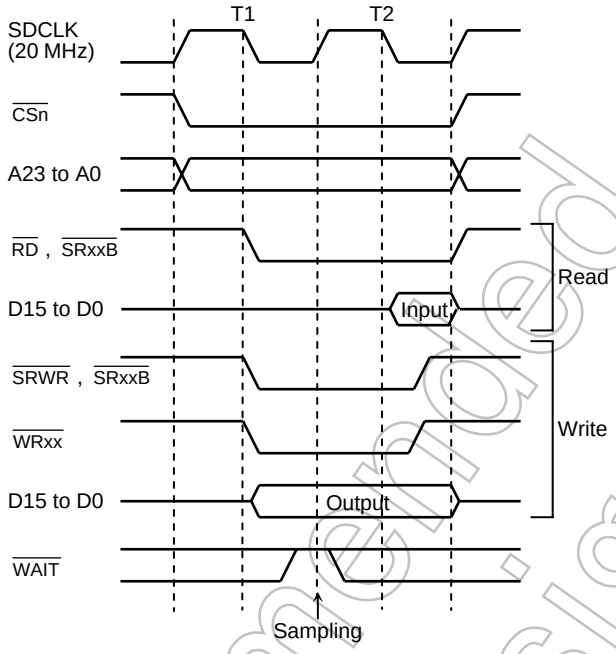
(a) External read/write cycle (0 waits)



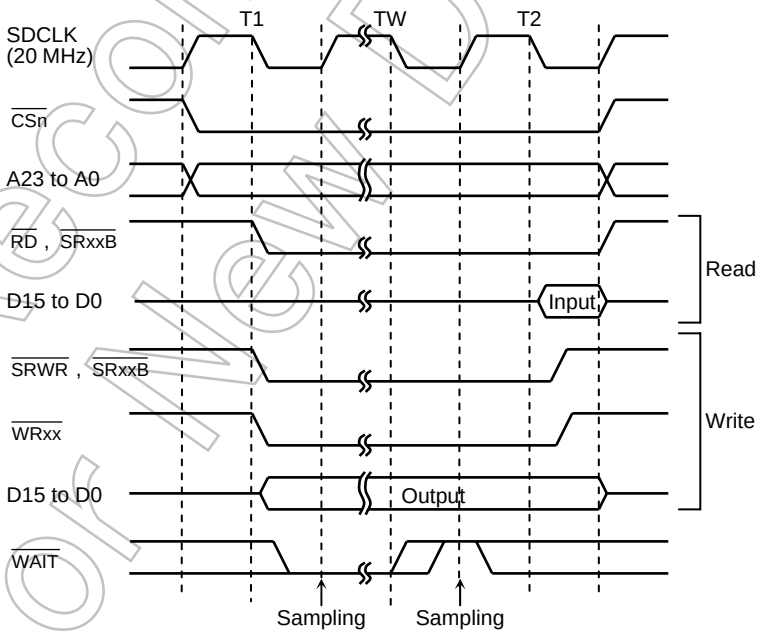
(b) External read/write cycle (1 wait)



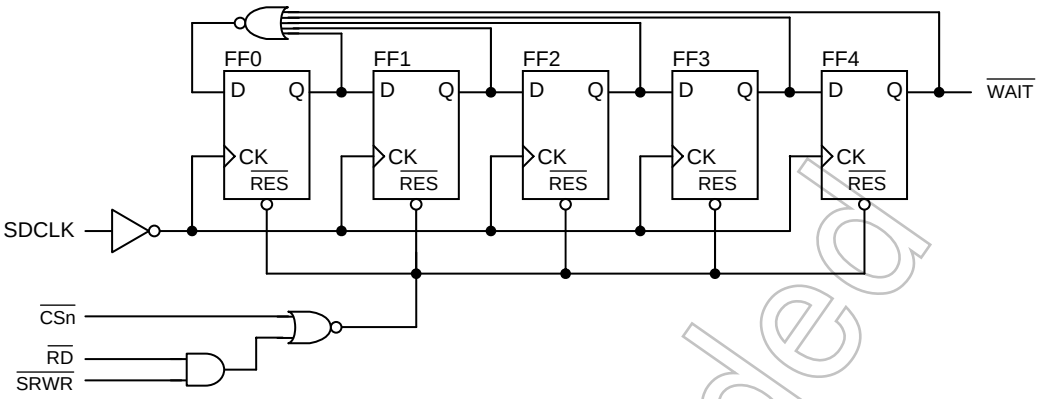
(c) External read/write cycle (0 waits at $\overline{\text{WAIT}}$ pin input mode)

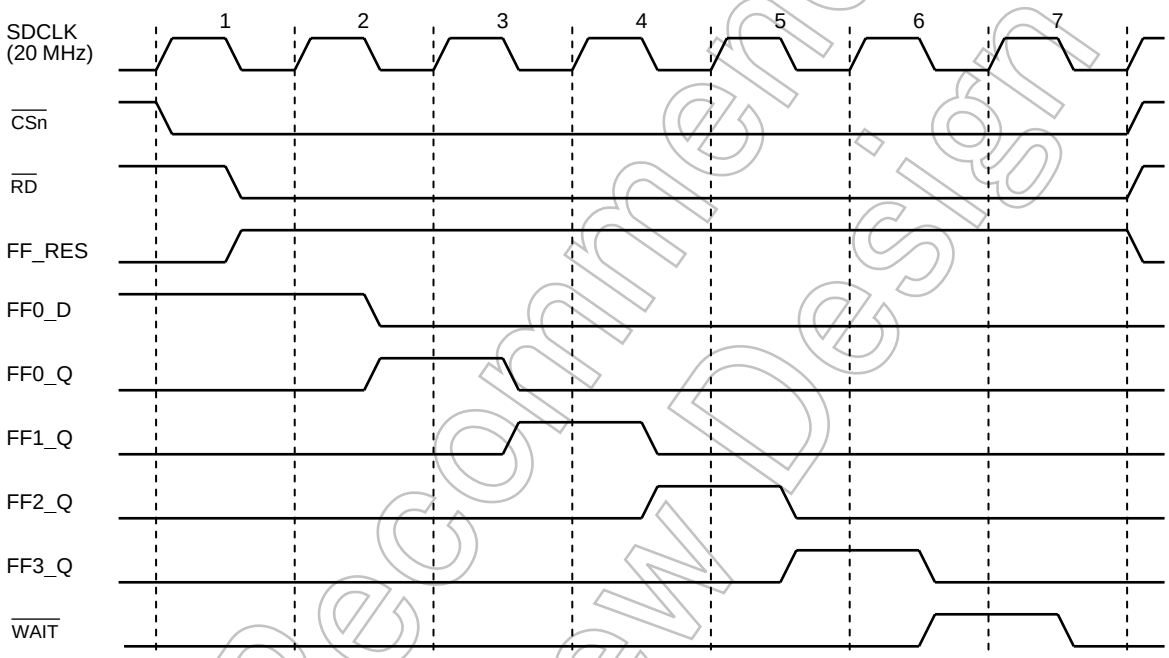


(d) External read/write cycle (n waits at $\overline{\text{WAIT}}$ pin input mode)



Example of wait input cycle (5 waits)





(7) Connecting external memory

Figure 3.6.1 shows an example of how to connect an external 16-bit SRAM and 16-bit NOR flash to the TMP92CA25.

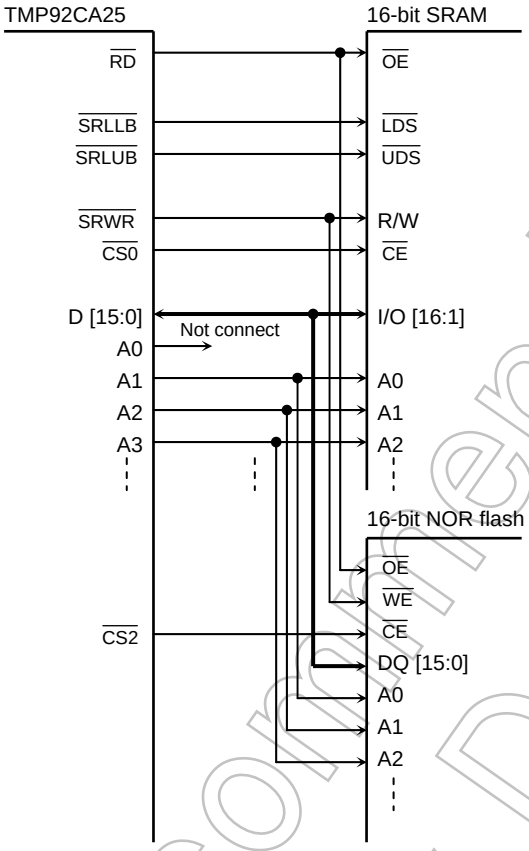


Figure 3.6.1 Example of External 16-Bit SRAM and NOR Flash Connection

3.6.4 ROM Control (Page mode)

This section describes ROM page mode accessing and how to set registers. ROM page mode is set by the page ROM control register.

(1) Operation and how to set the registers

The TMP92CA25 supports ROM access of the page mode. ROM access of the page mode is specified only in block address area 2.

ROM page mode is set by the page ROM control register (PMEMCR). Setting <OPGE> of the PMEMCR register to "1" sets the memory access of the block address area to ROM page mode access.

The number of read cycles is set by the <OPWR1:0> of the PMEMCR register.

<OPWR1:0> (PMEMCR register)

<OPWR1>	<OPWR0>	Number of Cycle in a Page
0	0	1 state (n-1-1-1 mode) (n ≥ 2)
0	1	2 state (n-2-2-2 mode) (n ≥ 3)
1	0	3 state (n-3-3-3 mode) (n ≥ 4)
1	1	(Reserved)

Note: Set the number of waits ("n") using the control register (BnCSL) in each block address area.

The page size (the number of bytes) of ROM in the CPU size is set by the <PR1:0> of the PMEMCR register. When data is read out up to the border of the set page, the controller completes the page reading operation. The start data of the next page is read in the normal cycle. The following data is set to page read again.

<PR1:0> Bit (PMEMCR register)

<PR1>	<PR0>	ROM Page Size
0	0	64 bytes
0	1	32 bytes
1	0	16 bytes (Default)
1	1	8 bytes

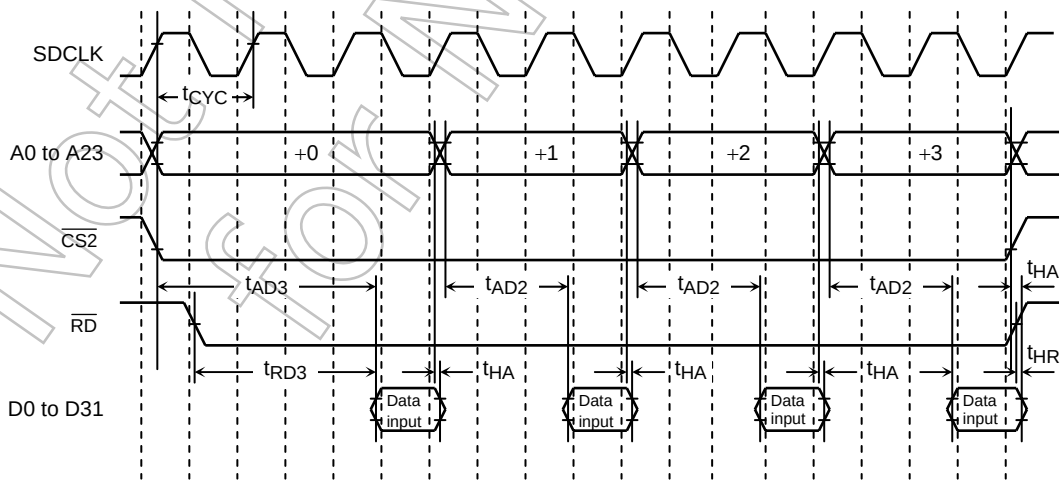


Figure 3.6.2 Page mode access Timing (8-byte example)

3.6.5 Cautions

(1) Note on timing between $\overline{CS}$ and $\overline{RD}$

If the parasitic capacitance of the $\overline{RD}$ (Read signal) is greater than that of the $\overline{CS}$ (Chip select signal), it is possible that an unintended read cycle occurs due to a delay in the read signal. Such an unintended read cycle may cause a problem, as in the case of (a) in Figure 3.6.3.

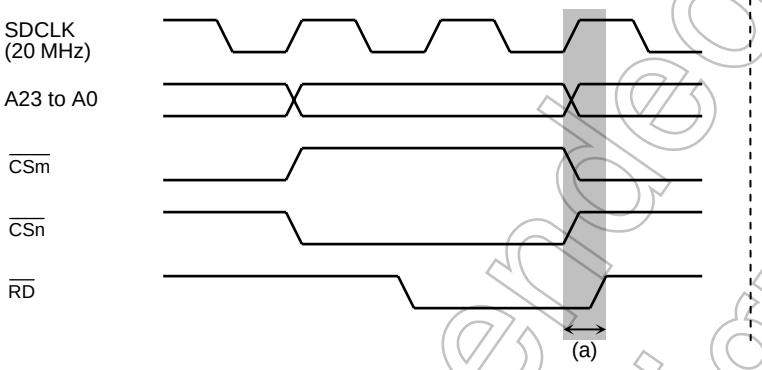


Figure 3.6.3 Read Signal Delay Read Cycle

Example: When using an externally connected NOR flash which uses JEDEC standard commands, note that the toggle bit may not be read out correctly. If the read signal in the cycle immediately preceding the access to the NOR flash does not go high in time, as shown in Figure 3.6.4, an unintended read cycle like the one shown in (b) may occur.

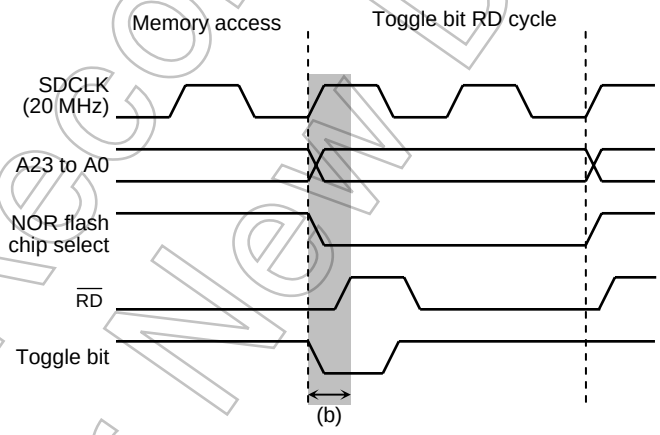


Figure 3.6.4 NOR Flash Toggle Bit Read Cycle

When the toggle bit is reversed by this unexpected read cycle, the CPU cannot read the toggle bit correctly since it always reads same value for the toggle bit. To avoid this phenomenon, data polling function control is recommended.

(2) Note on NAND flash area setting, LCD driver area setting with built-in RAM

Figure 3.6.5 shows a memory map for a NAND flash and RAM built-in LCD driver.

Since it is recommended that CS3 area be assigned to the address 000000H to 3FFFFFH, the following explanation is given.

In this case, the NAND flash and RAM built-in LCD driver overlap with CS3 area.

However, each access control circuit in the TMP92CA25 operates independently.

So, if a program on CS3 area accesses NAND flash, both $\overline{CS3}$ and NAND flash will be accessed at the same time and a problem such as data conflict will occur.

To avoid this phenomenon, TMP92CA25 have MEMCR0<CSDIS>. If set <CSDIS> to "1", $\overline{CS3}$ pin don't active in case of access 001D00H to 001FFFH (768B) in area that is set as CS3 area. Above phenomenon can be avoided by this setting. This function is valid not only $\overline{CS3}$ but also all $\overline{CS0}$ to $\overline{CS3}$ pins.

Note1: In above setting, the address from 000000H to 005FFFH of 24 Kbytes for CS3's memory can't be used.

Note2: 512 byte area (001D00H to 001EFFH) for NAND flash are fixedlike a following without relation ship to setting CS block. Therefore, NAND flash area don't conform to CS3 area setting.

(NAND flash area specification)

1. bus width : Fixed 8 bit
2. WAIT control : Depend on NDnFSPR<SPW> of NAND flash controller

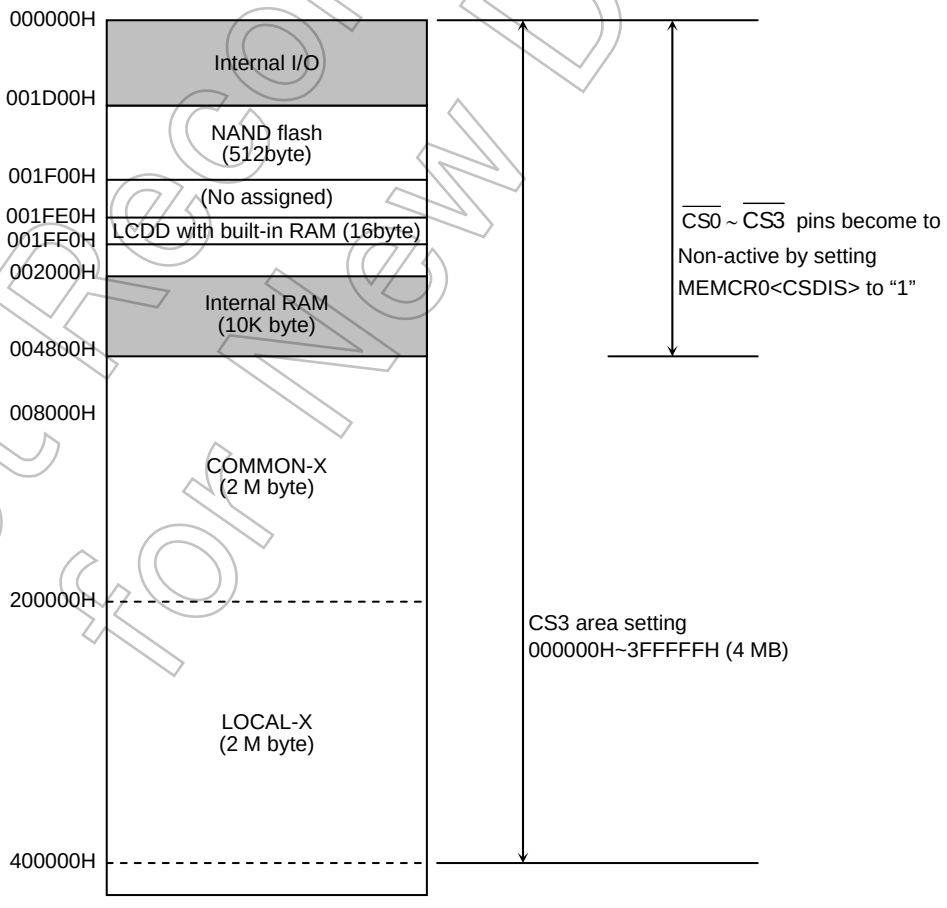


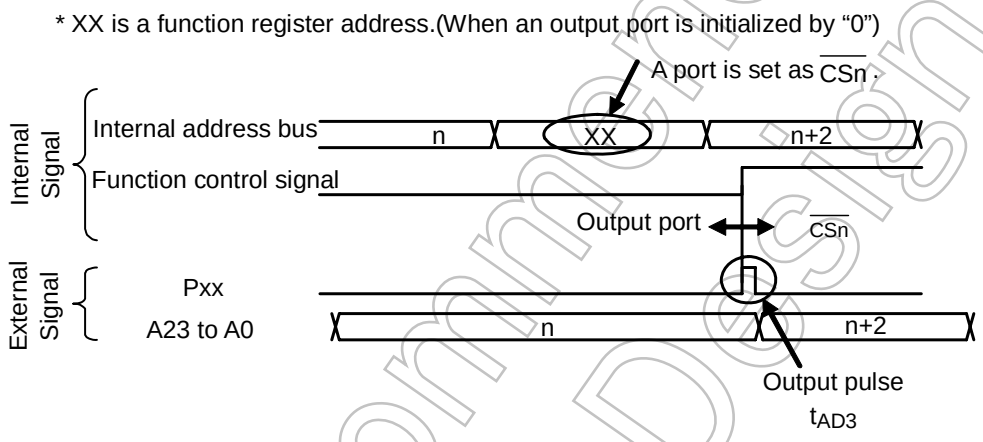
Figure 3.6.5 Recommended CS3 and CS0 Setting

(3) The cautions at the time of the functional change of a $\overline{CSn}$.

A chip select signal output has the case of a combination terminal with a general-purpose port function. In this case, an output latch register and a function control register are initialized by the reset action, and an object terminal is initialized by the port output ("1" or "0") by it.

Functional change

Although an object terminal is changed from a port to a chip select signal output by setting up a function control register (PnFC register), the short pulse for several ns may be outputted to the changing timing. Although it does not become especially a problem when using the usual memory, it may become a problem when using a special memory.

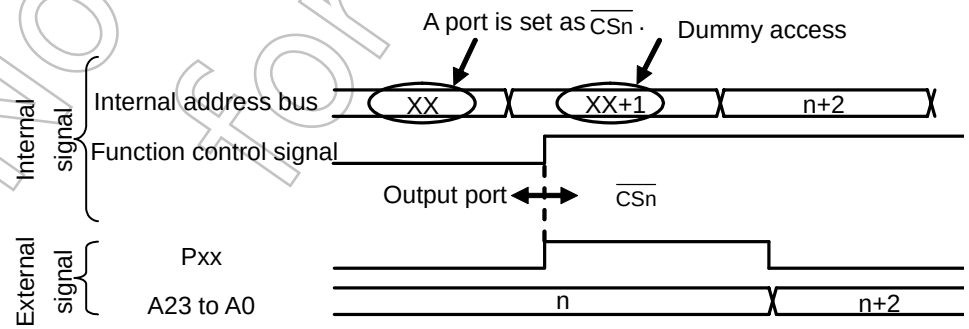


The measure by software

The countermeasures in S/W for avoiding this phenomenon are explained.

Since CS signal decodes the address of the access area and is generated, an unnecessary pulse is outputted by access to the object CS area immediately after setting it as a CSn function. Then, if internal area is accessed also immediately after setting a port as CS function, an unnecessary pulse will not output.

1. The ban on interruption under functional change (DI command)
2. A dummy command is added in order to carry out continuous internal access.
3. (Access to a functional change register is corresponded by 16-bit command. (LDW command))



3.7 8-Bit Timers (TMRA)

The TMP92CA25 features 4 built-in 8-bit timers (TMRA0-TMRA3).
These timers are paired into two modules: TMRA01 and TMRA23. Each module consists of two channels and can operate in any of the following four operating modes.

- 8-bit interval timer mode
- 16-bit interval timer mode
- 8-bit programmable square wave pulse generation output mode (PPG: Variable duty cycle with variable period)
- 8-bit pulse width modulation output mode (PWM: Variable duty cycle with constant period)

Figure 3.7.1 and Figure 3.7.2 show block diagrams for TMRA01 and TMRA23.

Each channel consists of an 8-bit up counter, an 8-bit comparator and an 8-bit timer register. In addition, a timer flip-flop and a prescaler are provided for each pair of channels.

The operation mode and timer flip-flops are controlled by a five-byte SFR (special function register).

Each of the two modules (TMRA01 and TMRA23) can be operated independently. All modules operate in the same manner; hence only the operation of TMRA01 is explained here.

The contents of this chapter are as follows.

Table 3.7.1 Registers and Pins for Each Module

Module		TMRA01	TMRA23
External pin	Input pin for external clock	No	No
	Output pin for timer flip-flop	TA1OUT (Shared with PC0)	TA3OUT (Shared with PC1)
SFR (Address)	Timer run register	TA01RUN (1100H)	TA23RUN (1108H)
	Timer register	TA0REG (1102H) TA1REG (1103H)	TA2REG (110AH) TA3REG (110BH)
	Timer mode register	TA01MOD (1104H)	TA23MOD (110CH)
	Timer flip-flop control register	TA1FFCR (1105H)	TA3FFCR (110DH)

3.7.1 Block Diagrams

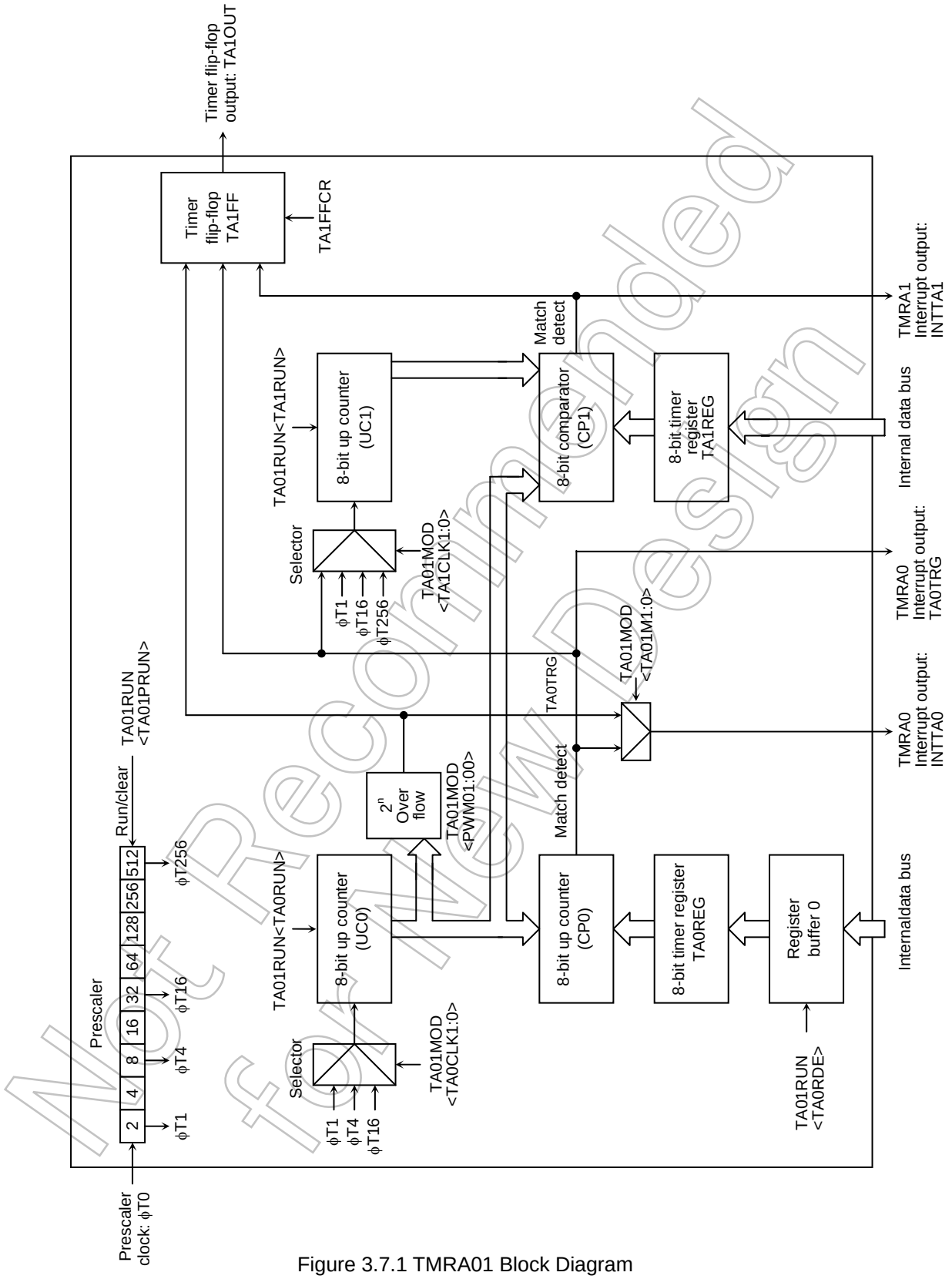


Figure 3.7.1 TMRA01 Block Diagram

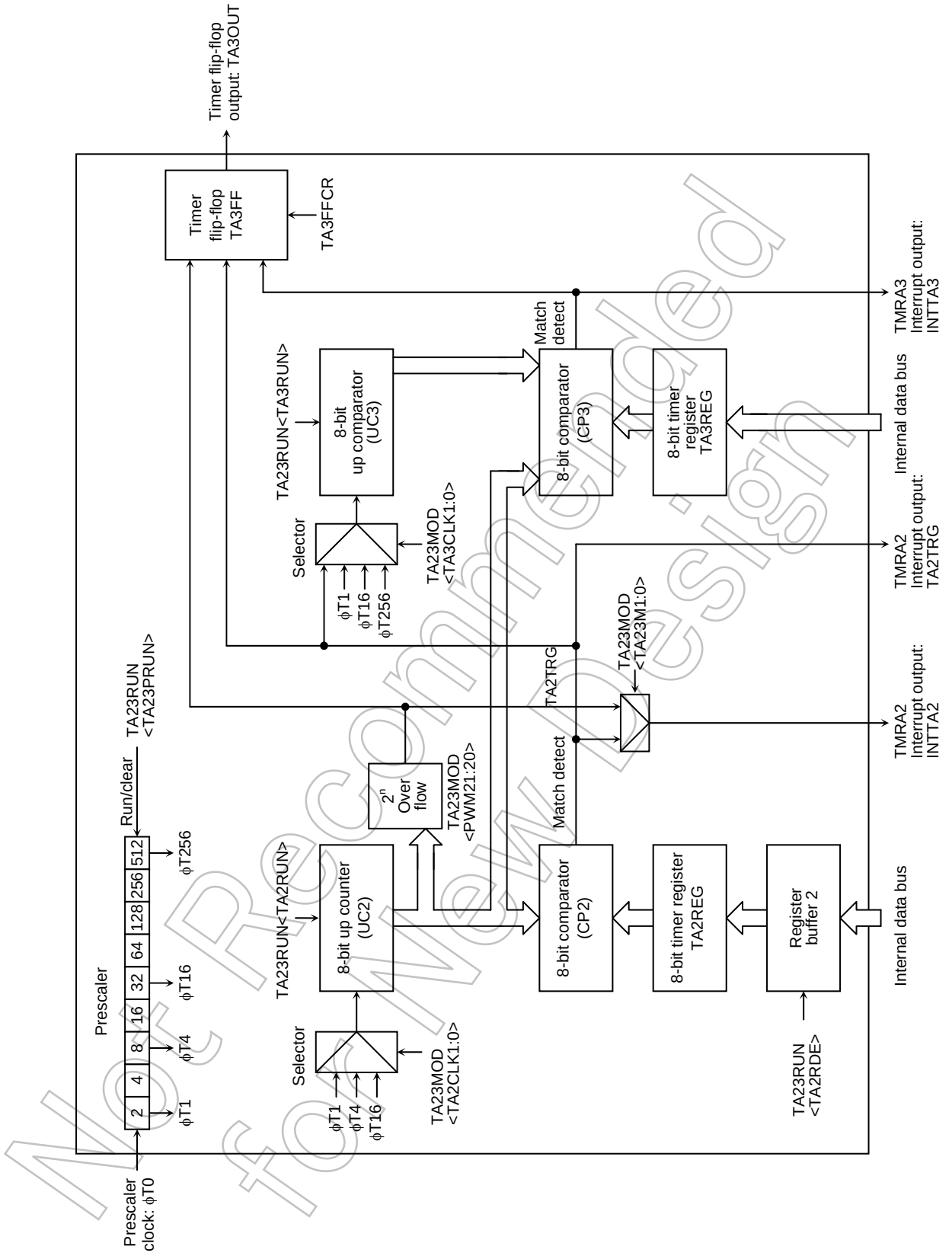


Figure 3.7.2 TMRA23 Block Diagram

3.7.2 Operation of Each Circuit

(1) Prescalers

A 9-bit prescaler generates the input clock to TMRA01.

The clock ϕT0 is divided into 8 by the CPU clock f_{SYS} and input to this prescaler.

The prescaler operation can be controlled using TA01RUN<TA01PRUN> in the timer control register. Setting <TA01PRUN> to "1" starts the count; setting <TA0PRUN> to "0" clears the prescaler to "0" and stops operation. Table 3.7.2 shows the various prescaler output clock resolutions.

Table 3.7.2 Prescaler Output Clock Resolution

System clock selection SYSCR1 <SYSCK>	Clock gear selection SYSCR1 <GEAR2:0>	–	Timer counter input clock TMRA prescaler TAxMOD<TAxCLK1:0>			
			ϕT1(1/2)	ϕT4(1/8)	ϕT16(1/32)	ϕT256(1/512)
1 (fs)	–	1/8	fs/16	fs/64	fs/256	fs/4096
0 (fc)	000 (1/1)		fc/16	fc/64	fc/256	fc/4096
	001 (1/2)		fc/32	fc/128	fc/512	fc/8192
	010 (1/4)		fc/64	fc/256	fc/1024	fc/16384
	011 (1/8)		fc/128	fc/512	fc/2048	fc/32768
	100 (1/16)		fc/256	fc/1024	fc/4096	fc/65536

xxx: Don't care

(2) Up counters (UC0 and UC1)

These are 8-bit binary counters which count up the input clock pulses for the clock specified by TA01MOD.

The input clock for UC0 is selectable and can be either the external clock input via the TA0IN pin or one of the three internal clocks ϕT1, ϕT4 or ϕT16. The clock setting is specified by the value set in TA01MOD<TA01CLK1:0>.

The input clock for UC1 depends on the operation mode. In 16-bit timer mode, the overflow output from UC0 is used as the input clock. In any mode other than 16-bit timer mode, the input clock is selectable and can either be one of the internal clocks ϕT1, ϕT16 or ϕT256, or the comparator output (the match detection signal) from TMRA0.

For each interval timer the timer operation control register bits TA01RUN<TA0RUN> and TA01RUN<TA1RUN> can be used to stop and clear the up counters and to control their count. A reset clears both up counters, stopping the timers.

(3) Timer registers (TA0REG and TA1REG)

These are 8-bit registers, which can be used to set a time interval. When the value set in the timer register TA0REG or TA1REG matches the value in the corresponding up counter, the comparator match detect signal goes Active. If the value set in the timer register is 00H, the signal goes Active when the up counter overflows.

TA0REG has a double buffer structure, making a pair with the register buffer.

The setting of the bit TA01RUN<TA0RDE> determines whether TA0REG's double buffer structure is enabled or disabled. It is disabled if <TA0RDE> = "0" and enabled if <TA0RDE> = "1".

When the double buffer is enabled, data is transferred from the register buffer to the timer register when a 2^n overflow occurs in PWM mode, or at the start of the PPG cycle in PPG mode. Hence the double buffer cannot be used in timer mode.

A reset initializes <TA0RDE> to "0", disabling the double buffer. To use the double buffer, write data to the timer register, set <TA0RDE> to "1", and write the following data to the register buffer. Figure 3.7.3 show the configuration of TA0REG.

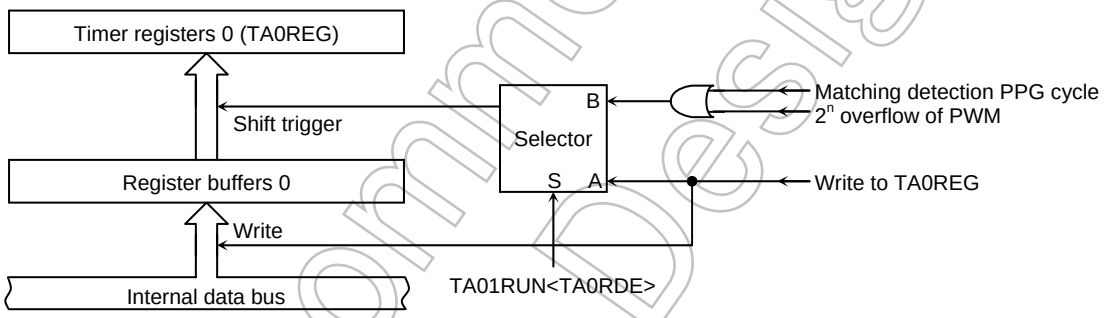


Figure 3.7.3 Configuration of TA0REG

Note: The same memory address is allocated to the timer register and the register buffer. When <TA0RDE> = 0, the same value is written to the register buffer and the timer register; when <TA0RDE> = 1, only the register buffer is written to.

The address of each timer register is as follows.

TA0REG: 001102H TA1REG: 001103H

TA2REG: 00110AH TA3REG: 00110BH

All these registers are write only and cannot be read.

(4) Comparator (CP0)

The comparator compares the value in an up counter with the value set in a timer register. If they match, the up counter is cleared to "0" and an interrupt signal (INTTA0 or INTTA1) is generated. If timer flip-flop inversion is enabled, the timer flip-flop is inverted at the same time.

(5) Timer flip-flop (TA1FF)

The timer flip-flop (TA1FF) is a flip-flop inverted by the match detects signals (8-bit comparator output) of each interval timer.

Whether inversion is enabled or disabled is determined by the setting of the bit TA1FFCR<TA1FFIE> in the timer flip-flops control register. A reset clears the value of TA1FF to "0". Writing "01" or "10" to TA1FFCR<TA1FFC1:0> sets TA1FF to "0" or "1". Writing "00" to these bits inverts the value of TA1FF (this is known as software inversion).

The TA1FF signal is output via the TA1OUT pin (which can also be used as PC0).

When this pin is used as the timer output, the timer flip-flop should be set beforehand using the port C function register PCCR and PCFC.

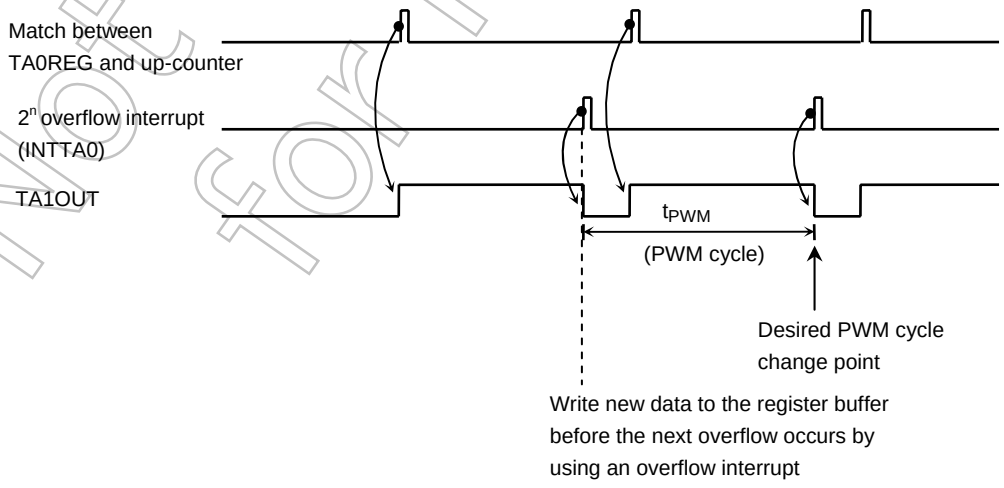
Note: When the double buffer is enabled for an 8-bit timer in PWM or PPG mode, caution is required as explained below.

If new data is written to the register buffer immediately before an overflow occurs by a match between the timer register value and the up-counter value, the timer flip-flop may output an unexpected value.

For this reason, make sure that in PWM mode new data is written to the register buffer by six cycles ($f_{SYS} \times 6$) before the next overflow occurs by using an overflow interrupt.

When using PPG mode, make sure that new data is written to the register buffer by six cycles before the next cycle compare match occurs by using a cycle compare match interrupt.

Example when using PWM mode



3.7.3 SFR

TMRA01 Run Register

TA01RUN (1100H)

	7	6	5	4	3	2	1	0
Bit symbol	TA0RDE				I2TA01	TA01PRUN	TA1RUN	TA0RUN
Read/Write	R/W				R/W			
After reset	0				0	0	0	0
Function	Double buffer 0: Disable 1: Enable				IDLE2 0: Stop 1: Operate	TMRA01 prescaler	UP counter (UC1)	UP counter (UC0)
						0: Stop and clear 1: Run (Count up)		

TA0REG double buffer control

0	Disable
1	Enable

Timer run/stop control

0	Stop and clear
1	Run (Count up)

Note: The values of bits 4 to 6 of TA01RUN are undefined when read.

TMRA23 Run Register

TA23RUN (1108H)

	7	6	5	4	3	2	1	0
Bit symbol	TA2RDE				I2TA23	TA23PRUN	TA3RUN	TA2RUN
Read/Write	R/W				R/W			
After reset	0				0	0	0	0
Function	Double buffer 0: Disable 1: Enable				IDLE2 0: Stop 1: Operate	TMRA23 prescaler	UP counter (UC3)	UP counter (UC4)
						0: Stop and clear 1: Run (Count up)		

TA2REG double buffer control

0	Disable
1	Enable

Timer run/stop control

0	Stop and clear
1	Run (Count up)

Note: The values of bits 4 to 6 of TA23RUN are undefined when read.

Figure 3.7.4 TMRA01 Run Register and TMRA23 Run Register

TMRA01 Mode Register

TA01MOD (1104H)	7	6	5	4	3	2	1	0
Bit symbol	TA01M1	TA01M0	PWM01	PWM00	TA1CLK1	TA1CLK0	TA0CLK1	TA0CLK0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Operation mode 00: 8-bit timer mode 01: 16-bit timer mode 10: 8-bit PPG mode 11: 8-bit PWM mode		PWM cycle 00: Reserved 01: 2^6 10: 2^7 11: 2^8		Source clock for TMRA1 00: TA0TRG 01: φT1 10: φT16 11: φT256		Source clock for TMRA0 00: Reserved 01: φT1 10: φT4 11: φT16	

→TMRA0 source clock selection

00	(Reserved)
01	φT1 (Prescaler)
10	φT4 (Prescaler)
11	φT16 (Prescaler)

→TMRA1 source clock selection

	TA01MOD <TA01M1:0> ≠ 01	TA01MOD <TA01M1:0> = 01
00	Comparator output from TMRA0	Overflow output from TMRA0
01	φT1	
10	φT16	(16-bit timer mode)
11	φT256	

→PWM cycle selection

00	Reserved
01	2^6× Source clock
10	2^7 × Source clock
11	2^8 × Source clock

→TMRA01 operation mode selection

00	8-bit timers × 2ch
01	16-bit timer
10	8-bit PPG
11	8-bit PWM (TMRA0) 8-bit timer (TMRA1)

Figure 3.7.5 TMRA Mode Register

TMRA23 Mode Register

TA23MOD (110CH)

	7	6	5	4	3	2	1	0
Bit symbol	TA23M1	TA23M0	PWM21	PWM20	TA3CLK1	TA3CLK0	TA2CLK1	TA2CLK0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Operation mode 00: 8-bit timer mode 01: 16-bit timer mode 10: 8-bit PPG mode 11: 8-bit PWM mode		PWM cycle 00: Reserved 01: 2^6 10: 2^7 11: 2^8		Source clock for TMRA3 00: TA2TRG 01: φT1 10: φT16 11: φT256		Source clock for TMRA2 00: Reserved 01: φT1 10: φT4 11: φT16	

→TMRA2 source clock selection

00	(Reserved)
01	φT1 (Prescaler)
10	φT4 (Prescaler)
11	φT16 (Prescaler)

→TMRA3 source clock selection

	TA23MOD <TA23M1:0> ≠ 01	TA23MOD <TA23M1:0> = 01
00	Comparator output from TMRA2	Overflow output from TMRA2
01	φT1	
10	φT16	(16-bit timer mode)
11	φT256	

→PWM cycle selection

00	Reserved
01	2^6 × Source clock
10	2^7 × Source clock
11	2^8 × Source clock

→TMRA23 operation mode selection

00	8-bit timers × 2ch
01	16-bit timer
10	8-bit PPG
11	8-bit PWM (TMRA2) 8-bit timer (TMRA3)

Figure 3.7.6 TMRA23 Mode Register

TMRA1 Flip-Flop Control Register

		7	6	5	4	3	2	1	0
TA1FFCR (1105H)	Bit symbol					TA1FFC1	TA1FFC0	TA1FFIE	TA1FFIS
	Read/Write					R/W			
	After reset					1	1	0	0
Read-modify-write instruction is prohibited.	Function					00: Invert TA1FF 01: Set TA1FF 10: Clear TA1FF 11: Don't care		TA1FF control for inversion 0: Disable 1: Enable	TA1FF inversion select 0: TMRA0 1: TMRA1

Inverse signal for timer flop-flop 1 (TA1FF)
(Don't care except in 8-bit timer mode)

0	Inversion by TMRA0
1	Inversion by TMRA1

Inversion of TA1FF

0	Disabled
1	Enabled

Control of TA1FF

00	Inverts the value of TA1FF
01	Sets TA1FF to "1"
10	Clears TA1FF to "0"
11	Don't care

Note: The values of bits4 to 6 of TA1FFCR are undefined when read.

Figure 3.7.7 TMRA Flip-Flop Control Register

TMRA3 Flip-Flop Control Register

		7	6	5	4	3	2	1	0
TA3FFCR (110DH)	Bit symbol					TA3FFC1	TA3FFC0	TA3FFIE	TA3FFIS
	Read/Write					R/W			
	After reset					1	1	0	0
Read-modify-write instruction is prohibited.	Function					00: Invert TA3FF 01: Set TA3FF 10: Clear TA3FF 11: Don't care		TA3FF control for inversion 0: Disable 1: Enable	TA3FF inversion select 0: TMRA2 1: TMRA3

Inverse signal for timer flip-flop 3 (TA3FF)
(Don't care except in 8-bit timer mode)

0	Inversion by TMRA2
1	Inversion by TMRA3

Inversion of TA3FF

0	Disabled
1	Enabled

Control of TA3FF

00	Inverts the value of TA3FF
01	Sets TA3FF to "1"
10	Clears TA3FF to "0"
11	Don't care

Note: The values of bits4 to 6 of TA3FFCR are undefined when read.

Figure 3.7.8 TMRA3 Flip-Flop Control Register

TMRA Register

Symbol	Address	7	6	5	4	3	2	1	0
TA0REG	1102H	–							
		W							
		Undefined							
TA1REG	1103H	–							
		W							
		Undefined							
TA2REG	110AH	–							
		W							
		Undefined							
TA3REG	110BH	–							
		W							
		Undefined							

Note: Read-modify-write instruction is prohibited.

Figure 3.7.9 8-Bit Timers Register

3.7.4 Operation in Each Mode

(1) 8-bit timer mode

Both TMRA0 and TMRA1 can be used independently as 8-bit interval timers.

1. Generating interrupts at a fixed interval (using TMRA1)

To generate interrupts at constant intervals using TMRA1 (INTTA1), first stop TMRA1 then set the operation mode, input clock and a cycle to TA01MOD and TA1REG register, respectively. Then, enable the interrupt INTTA1 and start TMRA1 counting.

Example: To generate an INTTA1 interrupt every 40 μs at f_C = 40 MHz, set each register as follows:

	MSB 7	6	5	4	3	2	1	LSB 0	
TA01RUN	← –	X	X	X	–	–	0	–	Stop TMRA1 and clear it to "0".
TA01MOD	← 0	0	X	X	0	1	–	–	Select 8-bit timer mode and select φT1 (= (16/fc)s at f_C = 40 MHz) as the input clock.
TA1REG	← 0	1	1	0	0	1	0	0	Set TREG1 to 40 μs ÷ φT1 = 100 = 64H.
INTETA01	← X	1	0	1	–	–	–	–	Enable INTTA1 and set it to level 5.
TA01RUN	← –	X	X	X	–	1	1	–	Start TMRA1 counting.

X: Don't care, –: No change

Select the input clock using Table 3.7.3.

Table 3.7.3 Selecting Interrupt Interval and the Input Clock Using 8-Bit Timer

Input Clock		Interrupt Interval (at f_{SYS} = 20 MHz)	Resolution
φT1	($8/f_{SYS}$)	0.4 μs to 102.4 μs	0.4 μs
φT4	($32/f_{SYS}$)	1.6 μs to 409.6 μs	1.6 μs
φT16	($128/f_{SYS}$)	6.4 μs to 1.638 ms	6.4 μs
φT256	($2048/f_{SYS}$)	102.4 μs to 26.21 ms	102.4 μs

Note: The input clocks for TMRA0 and TMRA1 differ as follows:
TMRA0: Uses TMRA0 input (TA0IN) and can be selected from φT1, φT4 or φT16
TMRA1: Matches output of TMRA0 (TA0TRG) and can be selected from φT1, φT16, φT256

2. Generating a 50 % duty ratio square wave pulse

The state of the timer flip-flop (TA1FF1) is inverted at constant intervals and its status output via the timer output pin (TA1OUT).

Example: To output a 2.4-μs square wave pulse from the TA1OUT pin at f_C = 40 MHz, use the following procedure to make the appropriate register settings. This example uses TMRA1; however, either TMRA0 or TMRA1 may be used.

		7	6	5	4	3	2	1	0	
TA01RUN	←	–	X	X	X	–	–	0	–	Stop TMRA1 and clear it to "0".
TA01MOD	←	0	0	X	X	0	1	–	–	Select 8-bit timer mode and select φT1 (= (16/fc)s at f_C = 40 MHz) as the input clock.
TA1REG	←	0	0	0	0	0	0	1	1	Set the timer register to 2.4 μs ÷ φT1 ÷ 2 = 3
TA1FFCR	←	X	X	X	X	1	0	1	1	Clear TA1FF to "0" and set it to invert on the match detect signal from TMRA1.
PCCR	←	–	–	–	–	–	–	–	1	Set PC0 to function as the TA1OUT pin.
PCFC	←	–	–	–	–	–	–	–	1	
TA01RUN	←	–	X	X	X	–	1	1	–	Start TMRA1 counting.

X: Don't care, –: No change

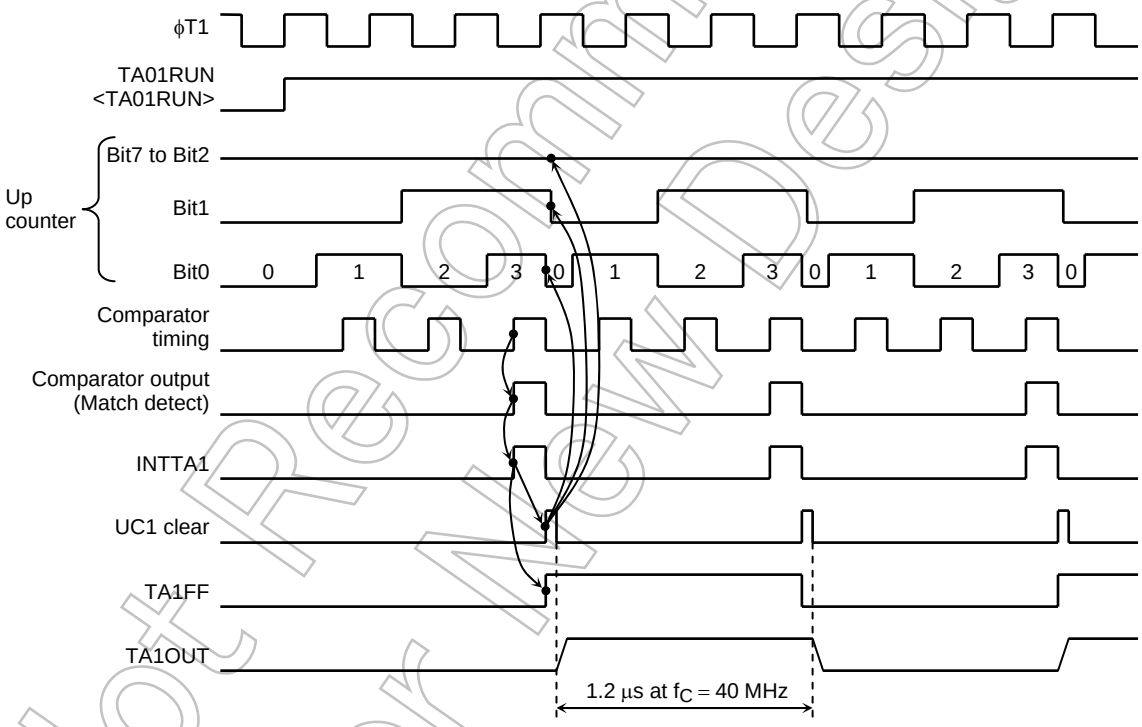


Figure 3.7.10 Square Wave Output Timing Chart (50 % Duty)

3. Making TMRA1 count up on the match signal from the TMRA0 comparator

Select 8-bit timer mode and set the comparator output from TMRA0 to be the input clock to TMRA1.

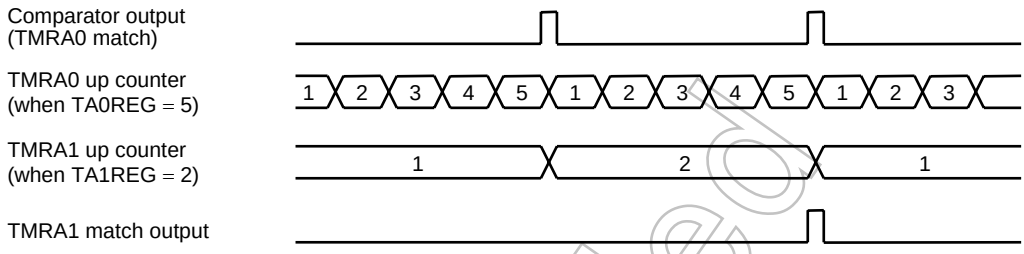


Figure 3.7.11 TMRA1 Count Up on Signal from TMRA0

(2) 16-bit timer mode

A 16-bit interval timer is configured by pairing the two 8-bit timers TMRA0 and TMRA1.

To make a 16-bit interval timer in which TMRA0 and TMRA1 are cascaded together, set TA01MOD<TA01M1:0> to "01".

In 16-bit timer mode, the overflow output from TMRA0 is used as the input clock for TMRA1, regardless of the value set in TA01MOD<TA01CLK1:0>. Table 3.7.2 shows the relationship between the timer (interrupt) cycle and the input clock selection.

To set the timer interrupt interval, set the lower eight bits in timer register TA0REG and the upper eight bits in TA1REG. Be sure to set TA0REG first (as entering data in TA0REG temporarily disables the compare, while entering data in TA1REG starts the compare).

Setting example: To generate an INTTA1 interrupt every 0.4 s at f_C = 40 MHz, set the timer registers TA0REG and TA1REG as follows:

If ϕT16 (= (256/fc)s at f_C = 40 MHz) is used as the input clock for counting, set the following value in the registers: 0.4 s ÷ =(256/fc)s = 62500 = F424H; e.g. set TA1REG to F4H and TA0REG to 24H.

The comparator match signal is output from TMRA0 each time the up counter UC0 matches TA0REG, though the up counter UC0 is not cleared.

In the case of the TMRA1 comparator, the match detect signal is output on each comparator pulse on which the values in the up counter UC1 and TA1REG match. When the match detect signal is output simultaneously from both the comparator TMRA0 and TMRA1, the up counters UC0 and UC1 are cleared to "0" and the interrupt INTTA1 is generated. Also, if inversion is enabled, the value of the timer flip-flop TA1FF is inverted.

Example: When TA1REG = 04H and TA0REG = 80H

Figure 3.7.12 Timer Output by 16-Bit Timer Mode

(3) 8-bit PPG (Programmable pulse generation) output mode

Square wave pulses can be generated at any frequency and duty ratio by TMRA0. The output pulses may be active low or active high. In this mode TMRA1 cannot be used.

TMRA0 outputs pulses on the TA1OUT pin (which can also be used as PC0).

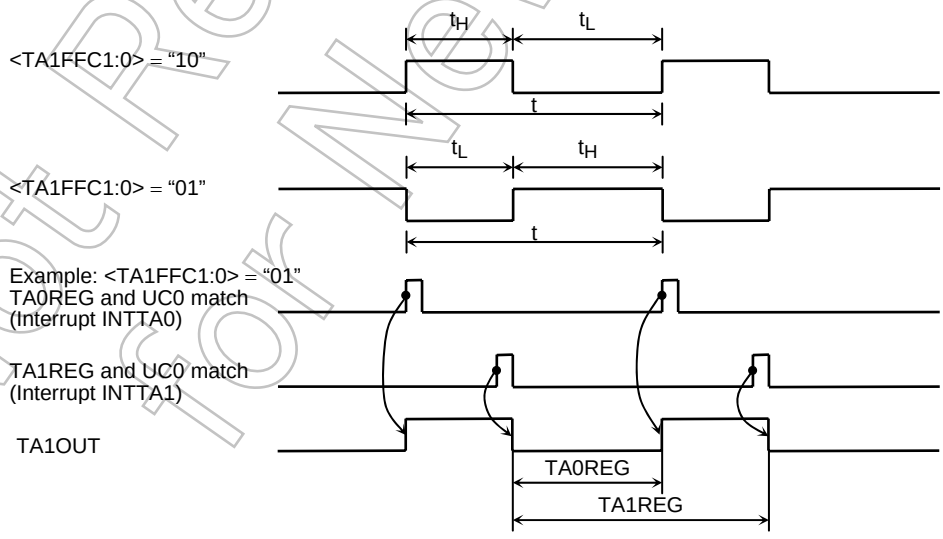


Figure 3.7.13 8-Bit PPG Output Waveforms

In this mode a programmable square wave is generated by inverting the timer output each time the 8-bit up counter (UC0) matches the value in one of the timer registers TA0REG or TA1REG.

The value set in TA0REG must be smaller than the value set in TA1REG.

Although the up counter for TMRA1 (UC1) is not used in this mode, TA01RUN<TA1RUN> should be set to "1" so that UC1 is set for counting.

Figure 3.7.14 shows a block diagram representing this mode.

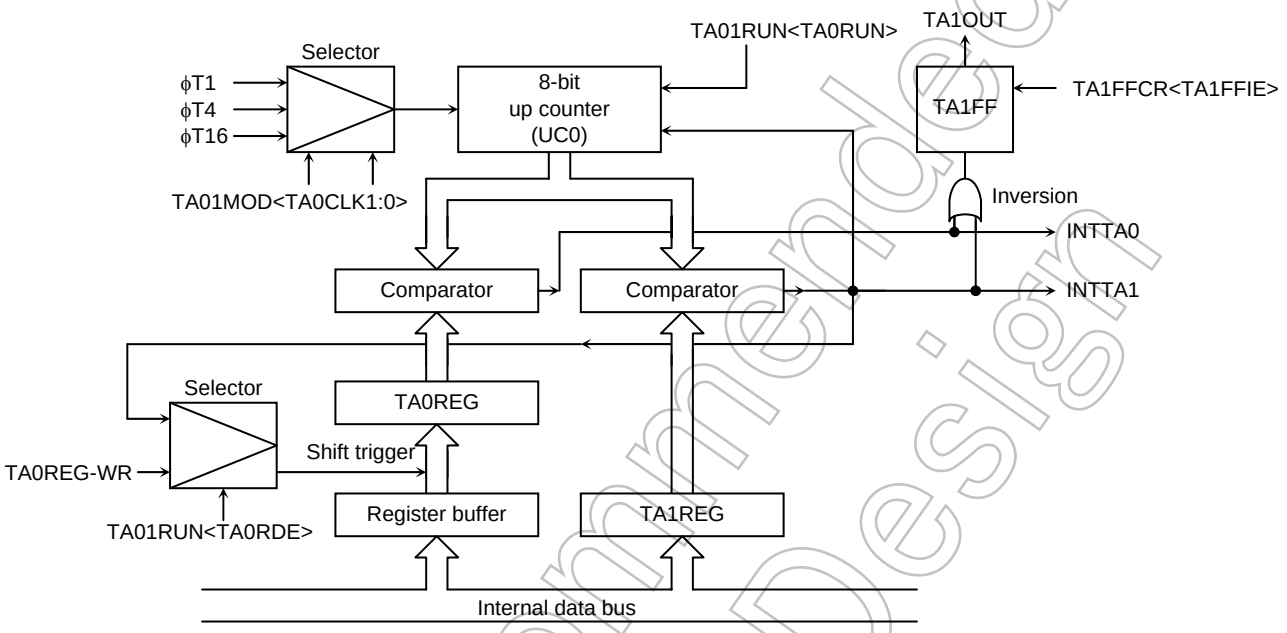


Figure 3.7.14 Block Diagram of 8-Bit PPG Output Mode

If the TA0REG double buffer is enabled in this mode, the value of the register buffer will be shifted into TA0REG each time TA1REG matches UC0.

Use of the double buffer facilitates the handling of low duty waves (when duty is varied).

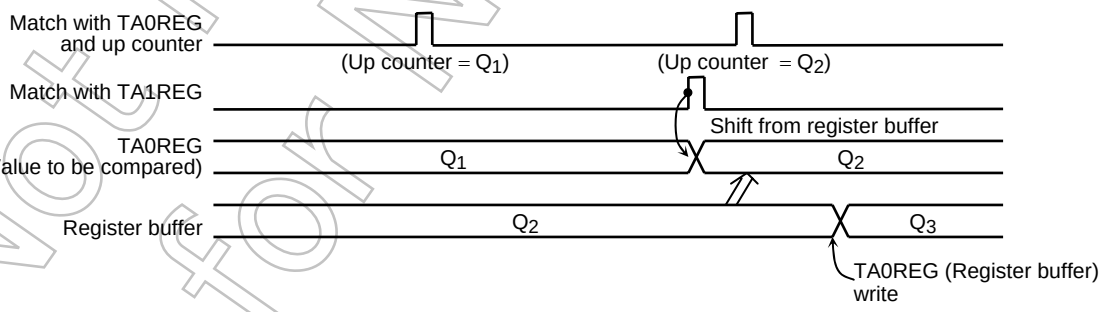
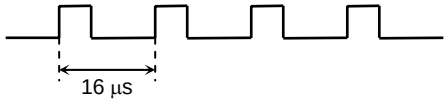


Figure 3.7.15 Operation of Register Buffer

Example: To generate 1/4 duty 62.5 kHz pulses (at f_C = 40 MHz)



Calculate the value which should be set in the timer register.

To obtain a frequency of 62.5 kHz, the pulse cycle t should be: t = 1/62.5 kHz = 16 μs

φT1 (=(16/fc)s (at f_C = 40 MHz);

16 μs ÷ (16/fc)s = 40

Therefore set TA1REG to 40 (28H)

The duty is to be set to 1/4: t × 1/4 = 16 μs × 1/4 = 4 μs

4 μs ÷ (16/fc)s = 10

Therefore, set TA0REG = 10 = 0AH.

		7	6	5	4	3	2	1	0	
TA01RUN	←	0	X	X	X	–	0	0	0	Stop TMRA0 and TMRA1 and clear it to "0".
TA01MOD	←	1	0	X	X	X	X	0	1	Set the 8-bit PPG mode, and select φT1 as input clock.
TA0REG	←	0	0	0	0	1	0	1	0	Write 0AH.
TA1REG	←	0	0	1	0	1	0	0	0	Write 28H.
TA1FFCR	←	X	X	X	X	0	1	1	X	Set TA1FF, enabling both inversion and the double buffer. 10 generate a negative logic pulse.
PCCR	←	–	–	–	–	–	–	–	1	Set PC0 as the TA1OUT pin.
PCFC	←	–	–	–	–	–	–	–	1	
TA01RUN	←	1	X	X	X	–	1	1	1	Start TMRA0 and TMRA1 counting.

X: Don't care, –: No change

(4) 8-bit PWM output mode

This mode is only valid for TMRA0. In this mode, a PWM pulse with the maximum resolution of 8 bits can be output.

When TMRA0 is used the PWM pulse is output on the TA1OUT pin (which is also used as PC1). TMRA1 can also be used as an 8-bit timer.

The timer output is inverted when the up counter (UC0) matches the value set in the timer register TA0REG or when 2^n counter overflow occurs (n = 6, 7 or 8 as specified by TA01MOD<PWM01:00>). The up counter UC0 is cleared when 2^n counter overflow occurs. The following conditions must be satisfied before this PWM mode can be used.

Value set in TA0REG < value set for 2^n counter overflow

Value set in TA0REG ≠ 0

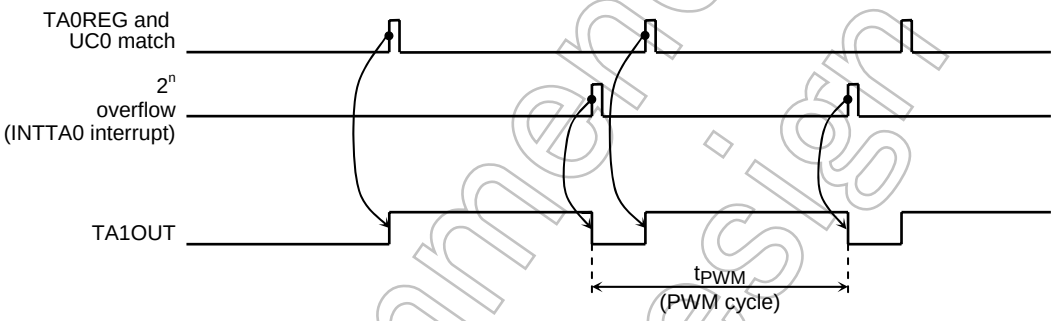


Figure 3.7.16 8-Bit PWM Waveforms

Figure 3.7.17 shows a block diagram representing this mode.

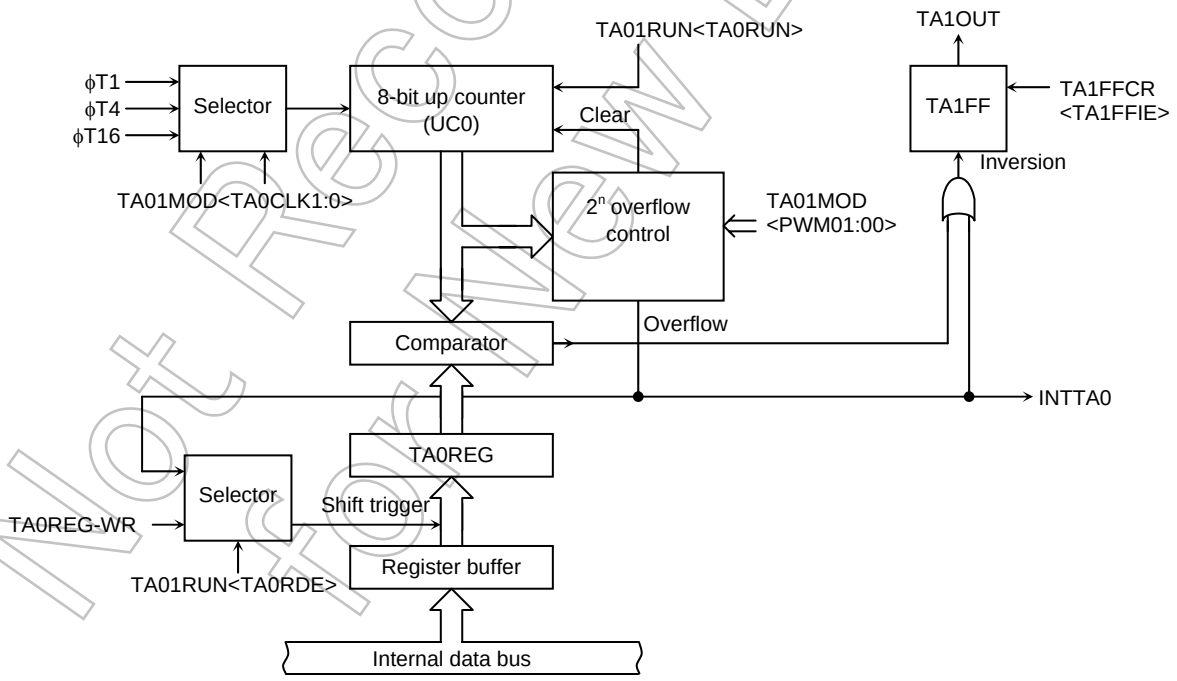


Figure 3.7.17 Block Diagram of 8-Bit PWM Mode

In this mode the value of the register buffer will be shifted into TA0REG if 2^n overflow is detected when the TA0REG double buffer is enabled.

Use of the double buffer facilitates the handling of low duty ratio waves.

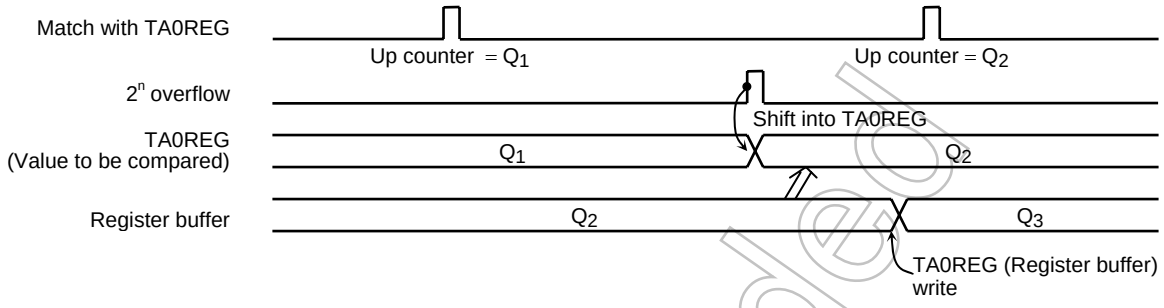
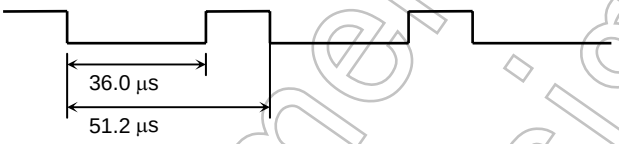


Figure 3.7.18 Register Buffer Operation

Example: To output the following PWM waves on the TA1OUT pin (at f_C = 40 MHz).



To achieve a 51.2-μs PWM cycle by setting φT1 (= (16/fc)s (@f_C = 40 MHz):
51.2 μs ÷ (16/fc)s = 128
2^n = 128
Therefore n should be set to 7.
Since the low level period is 36.0 μs when φT1 = (16/fc)s,
set the following value for TREG0:
36.0 μs ÷ (16/fc)s = 90 = 5AH

	MSB 7	6	5	4	3	2	1	LSB 0	
TA01RUN	← –	X	X	X	–	–	–	0	Stop TMRA0 and clear it to 0
TA01MOD	← 1	1	1	0	–	–	0	1	Select 8-bit PWM mode (cycle: 2^7) and select φT1 as the input clock.
TA0REG	← 0	1	0	1	1	0	1	0	Write 5AH.
TA1FFCR	← X	X	X	X	1	0	1	X	Clear TA1FF to 0; enable the inversion and double buffer.
PCCR	← –	–	–	–	–	–	–	1	Set PC0 as the TA1OUT pin.
PCFC	← –	–	–	–	–	–	–	1	
TA01RUN	← 1	X	X	X	–	1	–	1	Start TMRA0 counting.

X: Don't care, –: No change

Table 3.7.4 PWM Cycle

System clock SYSCR0 <SYSCK>	Clock gear SYSCR1 <GEAR2:0>	–	PWM cycle TAxxMOD<PWMx1:0>								
			2^6 (x64)			2^7(x128)			2^8(x256)		
			TAxxMOD<TAxCLK1:0>			TAxxMOD<TAxCLK1:0>			TAxxMOD<TAxCLK1:0>		
			φT1(x2)	φT4(x8)	φT16(x32)	φT1(x2)	φT4(x8)	φT16(x32)	φT1(x2)	φT4(x8)	φT16(x32)
1(fs)	–	×8	1024/fs	4096/fs	16384/fs	2048/fs	8192/fs	32768/fs	4096/fs	16384/fs	65536/fs
0(fc)	000(x1)		1024/fc	4096/fc	16384/fc	2048/fc	8192/fc	32768/fc	4096/fc	16384/fc	65536/fc
	001(x2)		2048/fc	8192/fc	32768/fc	4096/fc	16384/fc	65536/fc	8192/fc	32768/fc	131072/fc
	010(x4)		4096/fc	16384/fc	65536/fc	8192/fc	32768/fc	131072/fc	16384/fc	65536/fc	262144/fc
	011(x8)		8192/fc	32768/fc	131072/fc	16384/fc	65536/fc	262144/fc	32768/fc	131072/fc	524288/fc
	100(x16)		16384/fc	65536/fc	262144/fc	32768/fc	131072/fc	524288/fc	65536/fc	262144/fc	1048576/fc

(5) Settings for each mode

Table 3.7.5 shows the SFR settings for each mode.

Table 3.7.5 Timer Mode Setting Registers

Register name	TA01MOD				TA1FFCR
<Bit Symbol>	<TA01M1: 0>	<PWM01: 00>	<TA1CLK1: 0>	<TA0CLK1: 0>	<TA1FFIS>
Function	Timer Mode	PWM Cycle	Upper Timer Input Clock	Lower Timer Input Clock	Timer F/F Invert Signal Select
8-bit timer × 2 channels	00	–	Lower timer match, φT1, φT16, φT256 (00, 01, 10, 11)	External clock, φT1, φT4, φT16 (00, 01, 10, 11)	0: Lower timer output 1: Upper timer output
16-bit timer mode	01	–	–	External clock, φT1, φT4, φT16 (00, 01, 10, 11)	–
8-bit PPG × 1 channel	10	–	–	External clock, φT1, φT4, φT16 (00, 01, 10, 11)	–
8-bit PWM × 1 channel	11	2^6, 2^7, 2^8 (01, 10, 11)	–	External clock, φT1, φT4, φT16 (00, 01, 10, 11)	–
8-bit timer × 1 channel	11	–	φT1, φT16, φT256 (01, 10, 11)	–	Output disabled

–: Don't care

3.8 External Memory Extension Function (MMU)

By providing 3 local areas, the MMU function allows for the expansion of the program/data area up to 512 Mbytes.

The recommended address memory map is shown in Figure 3.8.1.

However, when the memory used is less than 16 Mbytes, it is not necessary to set the MMU register. In this case, please refer to the Memory Controller section.

An area which can be set as a bank is called a local area. Since the address for local areas is fixed, it cannot be changed. And, area which cannot be set as a bank is called Common area.

Basically one series of program should be closed within one bank. Please don't jump to the same LOCAL-area in the different bank directly by JP instruction and so on. Refer to the examples as follows.

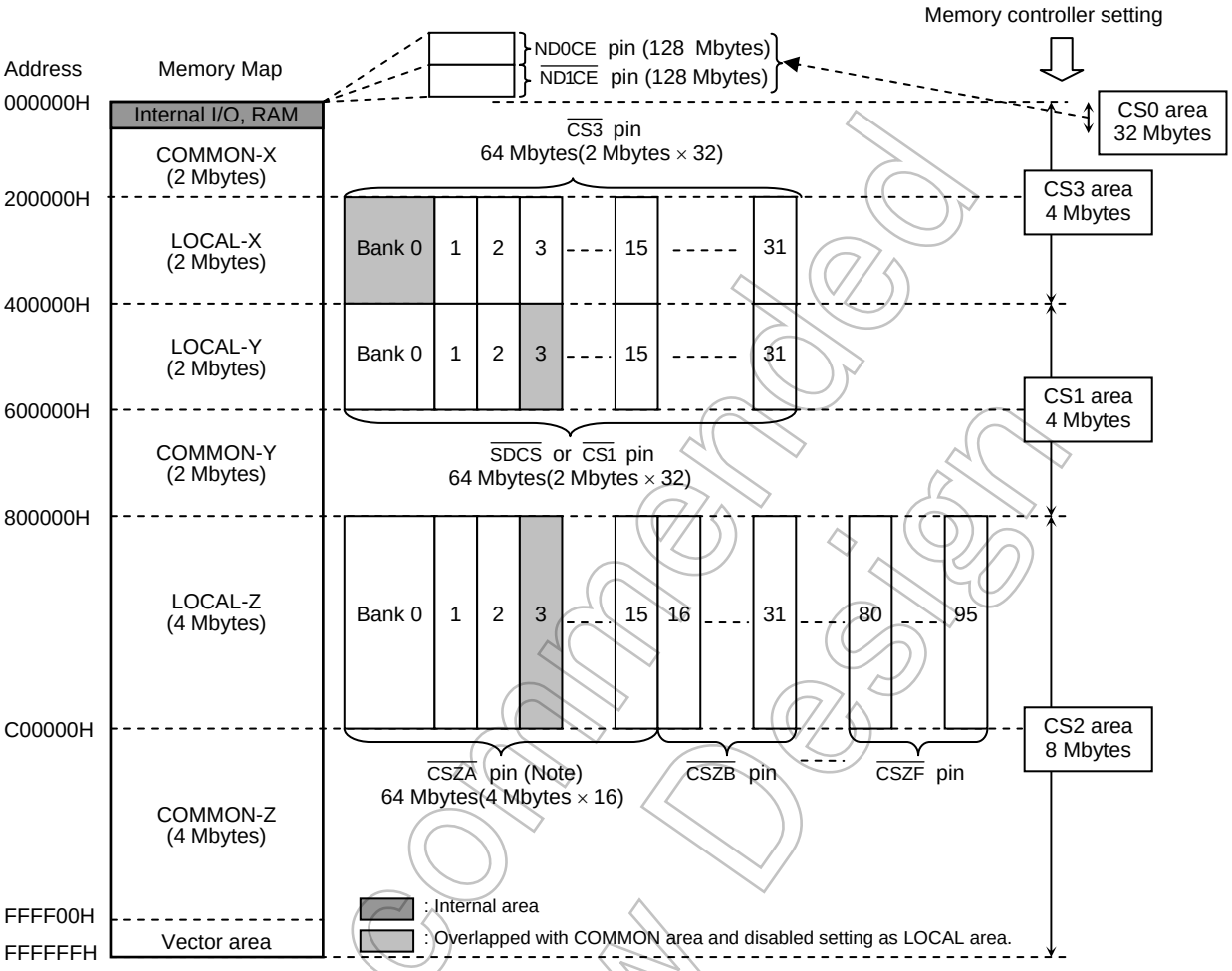
It is not possible for a program to branch between different banks of the same local area.

The TMP92CA25 has the following external pins for memory LSI connection.

Address bus: EA25, EA24 and A23 to A0
Chip select: $\overline{CS0}$ to $\overline{CS3}$, $\overline{CSZA}$ to $\overline{CSZF}$, $\overline{SDCS}$ $\overline{ND0CE}$ and $\overline{ND1CE}$
Data bus: D15 to D0

3.8.1 Recommended Memory Map

Figure 3.8.1 shows one recommended address memory map. This is for maximum expanded memory size and for a system in which an internal boot ROM with NAND flash is not required.



Note: $\overline{\text{CSZA}}$ is a chip select for not only bank 0 to 15 of LOCAL-Z but also COMMON-Z.

Figure 3.8.1 Recommended Memory Map for Maximum Specification (Logical address)

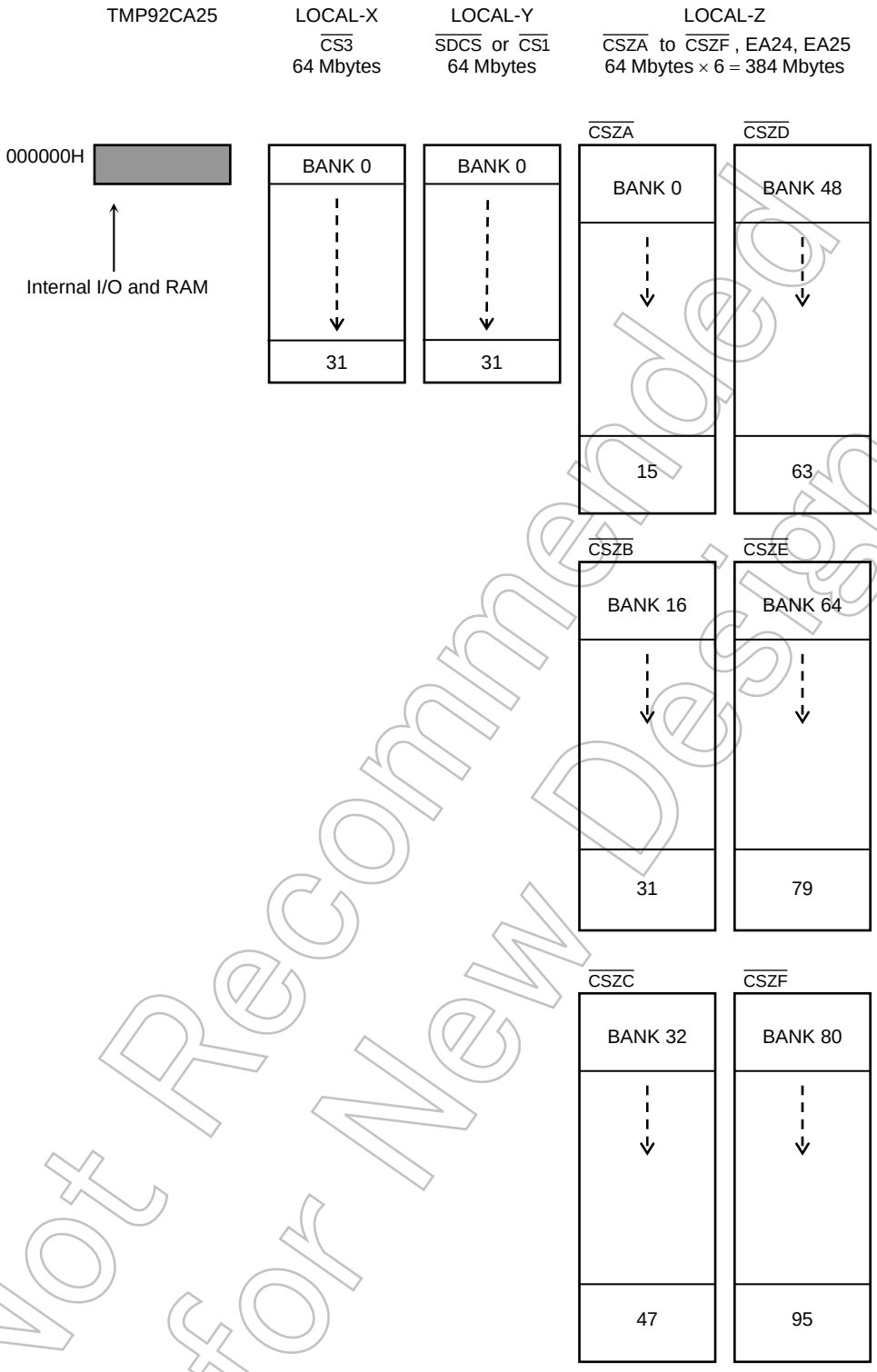


Figure 3.8.2 Recommended Memory Map for Maximum Specification (Physical address)

3.8.2 Control Registers

There are 12 MMU registers, covering 4 functions (program, data read, data write and LCDC display data), in each of 3 local areas (Local-X, Y and Z), providing easy data access.

(Instructions for use)

First, set the enable register and bank number for each LOCAL register.

The relevant pin and memory settings should then be set to the ports and memory controller.

When the CPU or LCDC outputs a local area logical address, the MMU converts and outputs this to the physical address according to the bank number. The physical address bus is output to the external address bus pin, thereby enabling access to external memory.

Note 1: Since the common area cannot be used as local area, do not set a bank number to LOCAL register which overlaps with the common area.

Note 2: Changing program BANK number (LOCALPX, Y or Z) is disabled in the LOCAL area. The program bank setting for each local area must be changed in the common area. (But bank setting of read data, write data and data for LCD display can be changed in the local area.)

Note 3: After data bank number register (LOCALRn, LOCALWn or LOCALLn; where "n" means X, Y or Z) is set by an instruction, do not access its memory by the following instruction because several clocks are required for effective MMU setting. For this reason, insert between them a dummy instruction which accesses SFR or another memory, as in the following example.

(Example)

```
ld    xix, 200000H          ;
ld    (localrx), 81H        ;  Data bank number is set
ld    wa, (localrx)         ;  ← Inserted dummy instruction which accesses SFR
ld    wa, (xix)             ;  Instruction which reads BANK 1 of LOCAL-X area.
```

Note 4: When LOCAL-Z area is used, chip select signal $\overline{CSZA}$ should be assigned to P82 pin.

In this case, $\overline{CSZA}$ works as chip select signal for not only BANK 0 to 15 but also COMMON-Z.

The following setting after reset is required before setting Port82.

```
ld    (localpz), 80H            ;  LOCAL-Z bank enable for program
ld    (localrz), 80H            ;  LOCAL-Z bank enable for data read
ld    (localwz), 80H            ;  LOCAL-Z bank enable for data write          (*1)
ld    (locallz), 80H            ;  LOCAL-Z bank enable for LCD display memory  (*2)
ld    (p8fc),  – – – – – 0 – – B ;  Set P82 pin to CSZA output
ld    (p8fc2), – – – – – 1 – – B ;
```

(*1) If COMMON-Z area is not used as data write memory, this setting is not required.

(*2) If COMMON-Z area is not used as LCD display memory, this setting is not required.

(1) Program bank register

The bank number used as program memory is set to these registers. It is not possible to change program bank number in the same local area.

LOCAL-X Register for Program

LOCALPX (01D0H)

	7	6	5	4	3	2	1	0
Bit symbol	LXE			X4	X3	X2	X1	X0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-X 0: Not use 1: Use			Set wBANK number for LOCAL-X ("0" is disabled because of overlap with COMMON area.)				

LOCAL-Y Register for Program

LOCALPY (01D1H)

	7	6	5	4	3	2	1	0
Bit symbol	LYE			Y4	Y3	Y2	Y1	Y0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-Y 0: Not use 1: Use			Set BANK number for LOCAL-Y ("3" is disabled because of overlap with COMMON area.)				

LOCAL-Z Register for Program

LOCALPZ (01D3H)

	7	6	5	4	3	2	1	0
Bit symbol	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Use BANK for LOCAL-Z 0: Disable 1: Enable	Set BANK number for LOCAL-Z ("3" is disabled because of overlap with COMMON area.)						

(2) LCD Display bank register

The bank number used as LCD display memory is set to these registers. Since the bank registers for CPU and LCDC are prepared independently, the bank number for CPU (Program, Read data or Write data) can be changed during LCD display.

LOCAL-X Register for LCDC Display Data

LOCALLX (01D4H)

	7	6	5	4	3	2	1	0
Bit symbol	LXE			X4	X3	X2	X1	X0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-X 0: Not use 1: Use			Set BANK number for LOCAL-X ("0" is disabled because of overlap with COMMON area.)				

LOCAL-Y Register for LCDC Display Data

LOCALLY (01D5H)

	7	6	5	4	3	2	1	0
Bit symbol	LYE			Y4	Y3	Y2	Y1	Y0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-Y 0: Not use 1: Use			Set BANK number for LOCAL-Y ("3" is disabled because of overlap with COMMON area.)				

LOCAL-Z Register for LCDC Display Data

LOCALLZ (01D7H)

	7	6	5	4	3	2	1	0
Bit symbol	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Use BANK for LOCAL-Z 0: Disable 1: Enable	Set BANK number for LOCAL-Z ("3" is disabled because of overlap with COMMON area.)						

(3) Read data bank register

The bank register number used as read data memory is set to these registers. The following is an example where the read data bank register of LOCAL-X is set to "1". When "ld wa, (xix)" instruction is executed, the bank becomes effective only at the read cycle for xix address.

(Example)

```
ld      xix, 200000h      ;
ld      (localrx), 81h    ; Set Read data bank.
ld      wa, (localrx)     ; <-- Insert dummy instruction which accesses SFR
ld      wa, (xix)         ; Read bank1 of LOCAL-X area
```

LOCAL-X Register for Read Data

LOCALRX (01D8H)

	7	6	5	4	3	2	1	0
Bit symbol	LXE			X4	X3	X2	X1	X0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-X 0: Not use 1: Use			Set BANK number for LOCAL-X ("0" is disabled because of overlap with COMMON area.)				

LOCAL-Y Register for Read Data

LOCALRY (01D9H)

	7	6	5	4	3	2	1	0
Bit symbol	LYE			Y4	Y3	Y2	Y1	Y0
Read/Write	R/W			R/W				
After reset	0			0	0	0	0	0
Function	Use BANK for LOCAL-Y 0: Not use 1: Use			Set BANK number for LOCAL-Y ("3" is disabled because of overlap with COMMON area.)				

LOCAL-Z Register for Read Data

LOCALRZ (01DBH)

	7	6	5	4	3	2	1	0
Bit symbol	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Use BANK for LOCAL-Z 0: Disable 1: Enable	Set BANK number for LOCAL-Z ("3" is disabled because of overlap with COMMON area.)						

(4) Write data bank register

The bank number used as write data memory is set to these registers. The following is an example where the data bank register of LOCAL-X is set to "1". When "ld (xix), wa" instruction is executed, the bank becomes effective only at the write cycle for xix address.

(Example)

```
        ld      xix, 200000h    ;
        ld      (localx), 81h   ; Set write data bank.
        ld      wa, (localwx)   ; <--Insert dummy instruction which accesses SFR
        ld      wa, (xix)       ; Write to bank 1 of LOCAL-X area
```

LOCAL-X Register for Write Data

		7	6	5	4	3	2	1	0
LOCALWX (01DCH)	Bit symbol	LXE			X4	X3	X2	X1	X0
	Read/Write	R/W			R/W				
	After reset	0			0	0	0	0	0
	Function	Use BANK for LOCAL-X 0: Not use 1: Use			Set BANK number for LOCAL-X ("0" is disabled because of overlap with COMMON area.)				

LOCAL-Y Register for Write Data

		7	6	5	4	3	2	1	0
LOCALWY (01DDH)	Bit symbol	LYE			Y4	Y3	Y2	Y1	Y0
	Read/Write	R/W			R/W				
	After reset	0			0	0	0	0	0
	Function	Use BANK for LOCAL-Y 0: Not use 1: Use			Set BANK number for LOCAL-Y ("3" is disabled because of overlap with COMMON area.)				

LOCAL-Z Register for Write Data

		7	6	5	4	3	2	1	0
LOCALWZ (01DFH)	Bit symbol	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
	Read/Write	R/W							
	After reset	0	0	0	0	0	0	0	0
	Function	Use BANK for LOCAL-Z 0: Disable 1: Enable	Set BANK number for LOCAL-Z ("3" is disabled because of overlap with COMMON area.)						

3.8.3 Setting Example

Below is a setting example.

No.	Used as	Memory	Setting	MMU Area	Logical Address	Physical Address
(a)	Main routine	NOR flash (16 Mbytes, 1 pcs)	$\overline{CSZA}$, 32 bits, 1 wait	COMMON-Z	C00000H to FFFFFFH	
(b)	Character ROM			Bank 0 in LOCAL-Z	800000H to BFFFFFH	000000H to 3FFFFFH
(c)	Sub routine	SRAM (16 Mbytes, 1 pcs)	$\overline{CS1}$, 16 bits, 0 waits	Bank 0 in LOCAL-Y	400000H to 5FFFFFH	000000H to 1FFFFFH
(d)	LCD display RAM			Bank 1 in LOCAL-Y		200000H to 3FFFFFH
(e)	Stack RAM	Internal RAM (16 Kbytes)	– (32 bits, 1 clock)	–	002000H to 005FFFH	

(a) Main routine (COMMON-Z)

Logical Address	Physical Address	No	Instruction		Comment
		1	org	C00000H	;
C00000H	← (Same)	2	ldw	(mamr2), 80FFH	; CS2 800000-FFFFFF/8 Mbytes
C000xxH	←	3	ldw	(b2csl), C222H	; CS2 32-bit ROM, 1 wait
		4	ldw	(mamr1), 40FFH	; CS1 400000-7FFFFF/4 Mbytes
		5	ldw	(b1csl), 8111H	; CS1 16-bit RAM, 0 waits
		5.1	ld	(localpz), 80H	; LOCAL-Z bank enable for program
		5.2	ld	(localrz), 80H	; LOCAL-Z bank enable for data read
		6	ld	(p8fc), 02H	; P81: $\overline{CS1}$
		7	ld	(p8fc2), 04H	; P82: $\overline{CSZA}$
		8	ld	(pjfc), 07H	; PJ2: $\overline{SRWR}$, PJ1: $\overline{SRLUB}$, PJ0: $\overline{SRLLB}$
		9	ld	xsp, 6000H	; Stack pointer = 6000H
		10	ld	(localpy), 80H	; BANK 0 in LOCAL-Y is set as program for sub routine
		11	:		;
C000yyH	←	12	call	400000H	; Call sub routine
		13	:		;
		14	:		;
		15	:		;

- Instructions from No.2 to No.8 are settings for ports and memory controller.
- No.9 is a setting for stack pointer. It is assigned to internal RAM.
- No.10 is a setting to execute No.12's instruction.
- No.12 is an instruction to call sub routine. When CPU outputs 400000H address, this MMU will convert and output 000000H address to external address bus: A23 to A0. And $\overline{CS1}$ for SRAM will be asserted because its logical address is in the CS1area at the same time. These instructions allow the CPU to branch to sub routine.

  Note:This example assumes a sub routine program is already written on SRAM.

(b) Sub routine (Bank 0 in LOCAL-Y)

Logical Address	Physical Address	No	Instruction		Comment
		16	org	400000H	;
400000H	000000H	17	ld	(localwy), 81H	; BANK 1 in LOCAL-Y is set as write data for LCD display RAM
4000xxH	0000xxH	18	ld	(locally), 81H	; BANK 1 in LOCAL-Y is set as LCD display data for LCD display RAM
		19	ld	(localrz), 80H	; BANK 0 in LOCAL-Z is set as read data for character ROM
		20	ld	xiy, 800000H	; Index address register to read character ROM
		21	ld	wa, (xiy)	; Reading character ROM
		22	:		; Convert it to display data
		23	ld	~~(localpy), 82H~~	;
		24	ld	xix, 400000H	; Index address register to write LCD display data
		25	ld	(xix), bc	; Writing LCD display data
		26	:		; Setting LCD controller
		27	:		;
		28	ld	xiz, 400000H	; Setting LCD start address to LCDC
		29	ld	(lsarcl), xiz	;
		30	ld	(lcdctl0), 01H	; Start LCD display operation
		31	:		;
5000yyH	1000yyH	32	ret		;

- No.17 and No.18 are settings for BANK 1 of LOCAL-Y. In this case, LCD display data is written to SRAM by CPU.
  So, (LOCALWY) and (LOCALLY) should be set to the same BANK 1.
- No.19 is a setting for BANK 0 of LOCAL-Z to read data from character ROM.
- No.20 and No.21 are instructions to read data from character ROM. When CPU outputs 800000H address, this MMU will convert and output 000000H address to external address bus: A23 to A0. And $\overline{CSZA}$ for NOR flash will be asserted because its logical address is in the CS2 area at the same time.
  These instructions allow the CPU to read data from character ROM.
- No.23 is an instruction which changes the program BANK number in the local area. This setting is disabled.
- No.24 and No.25 are instructions to write data to SRAM. When CPU outputs 400000H address, this MMU will convert and output 200000H address to external address bus: A23 to A0. And $\overline{CS1}$ for SRAM will be asserted because its logical address is in the CS1area at the same time.
  These instructions allow the CPU to write data to SRAM.
- No.28 and No.29 are settings to set LCD starting address to LCD controller. When LCDC outputs 400000H address in DMA cycle, this MMU will convert and output 200000H address to external address bus: A23 to A0. And $\overline{CS1}$ for SRAM will be asserted because its logical address is in the CS1 area at the same time.
  These instructions allow the LCDC to read data from SRAM.
- No.30 is an instruction to start LCD display operation.

3.9 Serial Channels

The TMP92CA25 includes 1 serial I/O channels. For the channel, either UART mode (asynchronous transmission) or I/O interface mode (synchronous transmission) can be selected. And SIO0 includes data modulator that supports the IrDA 1.0 infrared data communication specification.

- I/O interface mode
  - Mode 0: For transmitting and receiving I/O data using the synchronizing signal SCLK for extending I/O.
- UART mode
  - Mode 1: 7-bit data
  - Mode 2: 8-bit data
  - Mode 3: 9-bit data

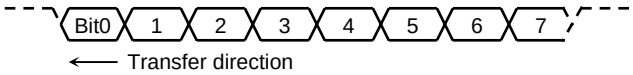
In mode 1 and mode 2 a parity bit can be added. Mode 3 has a wakeup function for making the master controller start slave controllers via a serial link (a multi controller system).

Figure 3.9.2 is block diagrams for SIO0.

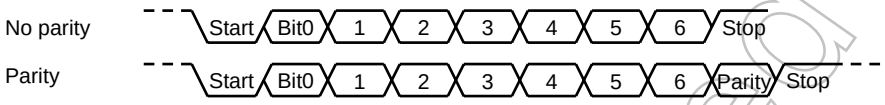
SIO0 is compounded mainly prescaler, serial clock generation circuit, receiving buffer and control circuit, transmission buffer and control circuit.

This chapter contains the following sections:

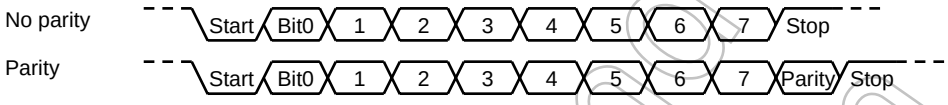
- Mode 0 (I/O interface mode)



- Mode 1 (7-bit UART mode)



- Mode 2 (8-bit UART mode)



- Mode 3 (9-bit UART mode)

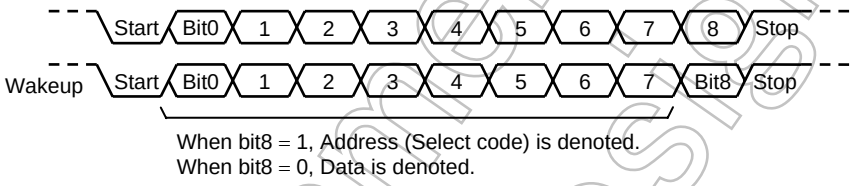


Figure 3.9.1 Data Formats

3.9.1 Block Diagrams

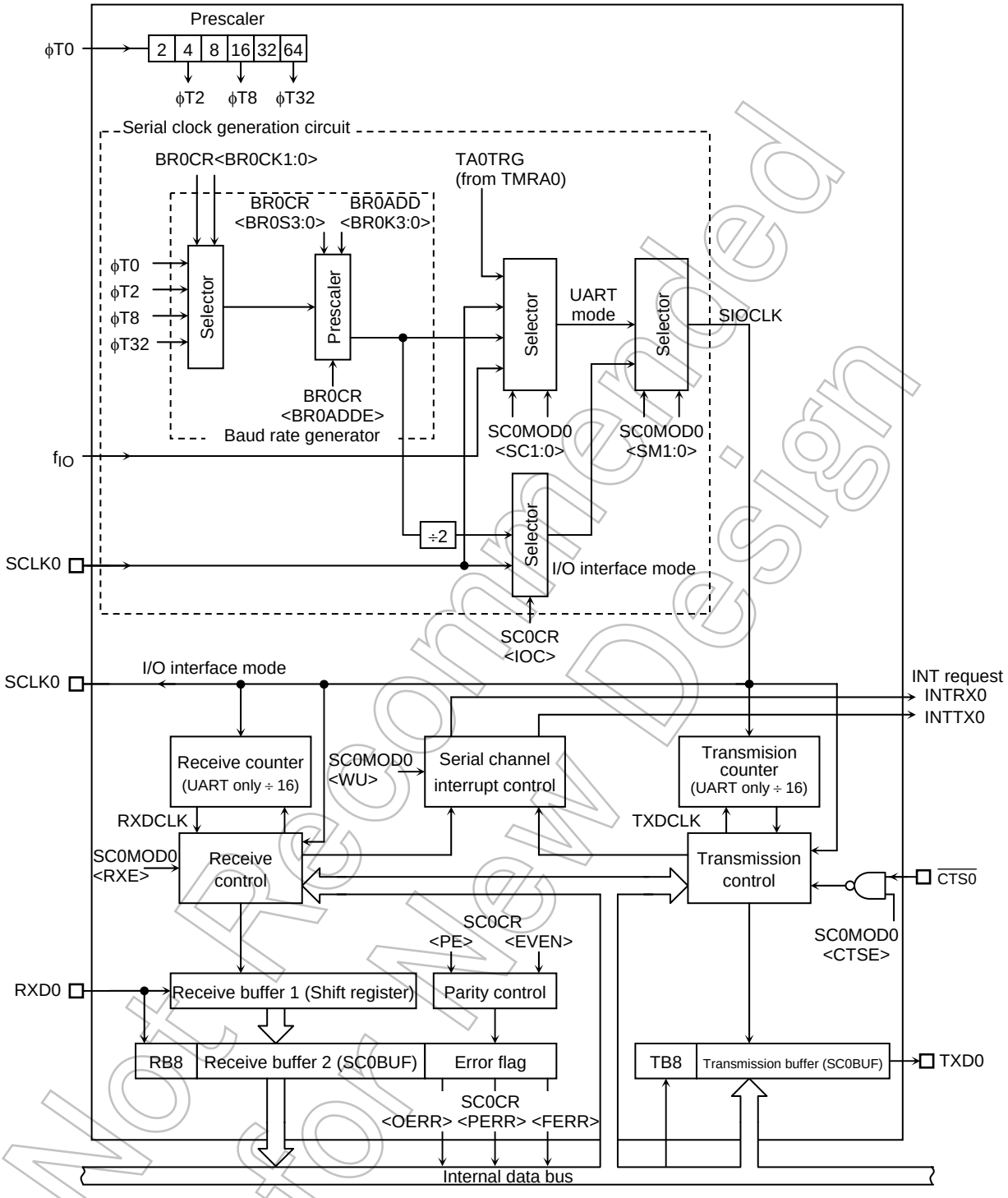


Figure 3.9.2 Block Diagram of Serial Channel 0

3.9.2 Operation for Each Circuit

(1) SIO Prescaler and prescaler clock select

There is a 6-bit prescaler for waking serial clock.

The prescaler can be run by selecting the baud rate generator as the waking serial clock.

Table 3.9.1 shows prescaler clock resolution into the baud rate generator.

Table 3.9.1 Prescaler Clock Resolution to Baud Rate Generator

System clock selection SYSCR1 <SYSCK>	Clock gear selection SYSCR1 <GEAR2:0>	–	Baud rate generator input clock SIO prescaler BR0CR<BR0CK1:0>			
			ϕT0	ϕT2(1/4)	ϕT8(1/16)	ϕT32(1/64)
1(fs)	–	1/8	fs/8	fs/32	fs/128	fs/512
0(fc)	000(1/1)		fc/8	fc/32	fc/128	fc/512
	001(1/2)		fc/16	fc/64	fc/256	fc/1024
	010(1/4)		fc/32	fc/128	fc/512	fc/2048
	011(1/8)		fc/64	fc/256	fc/1024	fc/4096
	100(1/16)		fc/128	fc/512	fc/2048	fc/8192

The baud rate generator selects between 4 clock inputs: ϕT0, ϕT2, ϕT8, and ϕT32 among the prescaler outputs.

(2) Baud rate generator

The baud rate generator is a circuit which generates transmission and receiving clocks that determine the transfer rate of the serial channels.

The input clock to the baud rate generator, ϕT0, ϕT2, ϕT8 or ϕT32, is generated by the 6-bit SIO prescaler, which is shared by the timers. One of these input clocks is selected using the BR0CR<BR0CK1:0> field in the baud rate generator control register.

The baud rate generator includes a frequency divider, which divides the frequency by 1 or N + (16 – K)/16 or 16 values, thereby determining the transfer rate.

The transfer rate is determined by the settings of BR0CR<BR0ADDE, BR0S3:0> and BR0ADD<BR0K3:0>.

- In UART mode

(1) When BR0CR<BR0ADDE> = 0

The settings BR0ADD<BR0K3:0> are ignored. The baud rate generator divides the selected prescaler clock by N, which is set in BR0CK<BR0S3:0>. (N = 1, 2, 3 …16)

(2) When BR0CR<BR0ADDE> = 1

The N + (16 – K)/16 division function is enabled. The baud rate generator divides the selected prescaler clock by N + (16 – K)/16 using the value of N set in BR0CR<BR0S3:0> (N = 2, 3…15) and the value of K set in BR0ADD<BR0K3:0> (K = 1, 2, 3…15)

Note: If N = 1 or N = 16, the N + (16 – K)/16 division function is disabled. Set BR0CR<BR0ADDE> to 0.

- In I/O interface mode

The N + (16 – K)/16 division function is not available in I/O interface mode. Set BR0CR<BR0ADDE> to 0 before dividing by N.

The method for calculating the transfer rate when the baud rate generator is used is explained below.

- In UART mode

$$\text{Baud rate} = \frac{\text{Input clock of baud rate generator}}{\text{Frequency divider for baud rate generator}} \div 16$$

- In I/O interface mode

$$\text{Baud rate} = \frac{\text{Input clock of baud rate generator}}{\text{Frequency divider for baud rate generator}} \div 2$$

- Integer divider (N divider)

  For example, when the source clock frequency (f_C) is 39.3216 MHz, the input clock is ϕT2 (f_C/32), the frequency divider N (BR0CR<BR0S3:0>) = 8, and BR0CR<BR0ADDE> = 0, the baud rate in UART mode is as follows:

  * Clock condition { Clock gear : 1/1

  $$\text{Baud rate} = \frac{\text{Input clock of baud rate generator}}{\text{Frequency divider for baud rate generator}} \div 16$$

  $$= \frac{f_C/32}{8} \div 16$$

  $$= 39.3216 \times 10^6 \div 16 \div 8 \div 16 = 9600 \text{ (bps)}$$

  Note: The N + (16 − K)/16 division function is disabled and setting BR0ADD<BR0K3:0> is invalid.

- N + (16 − K)/16 divider (UART mode only)

  Accordingly, when the source clock frequency (f_C) = 31.9488 MHz, the input clock is ϕT2 (f_C/32), the frequency divider N (BR0CR<BR0S3:0>) = 6, K (BR0ADD<BR0K3:0>) = 8, and BR0CR<BR0ADDE> = 1, the baud rate in UART mode is as follows:

  * Clock condition { Clock gear : 1/1

  $$\text{Baud rate} = \frac{\text{Input clock of baud rate generator}}{\text{Frequency divider for baud rate generator}} \div 16$$

  $$= \frac{f_C/32}{6 + \frac{(16-8)}{16}} \div 16$$

  $$= 31.9488 \times 10^6 \div 16 \div \left(6 + \frac{8}{16}\right) \div 16 = 9600 \text{ (bps)}$$

  Table 3.9.2 show examples of UART mode transfer rates.

  Additionally, the external clock input is available in the serial clock. (Serial channels 0 and 1). The method for calculating the baud rate is explained below:

  - In UART mode

    Baud rate = external clock input frequency ÷ 16

    It is necessary to satisfy (External clock input cycle) ≥ $4/f_{SYS}$

  - In I/O interface mode

    Baud rate = external clock input frequency

    It is necessary to satisfy (External clock input cycle) ≥ $16/f_{SYS}$

Table 3.9.2 Selection of Transfer Rate (1)

(when baud rate generator is used and BR0CR<BR0ADDE> = 0)

Unit (Kbps)

f_{SYS} [MHz]	Input Clock / Frequency Divider	φT0 (f_{SYS}/4)	φT2 (f_{SYS}/16)	φT8 (f_{SYS}/64)	φT32 (f_{SYS}/256)
9.8304	2	76.800	19.200	4.800	1.200
↑	4	38.400	9.600	2.400	0.600
↑	8	19.200	4.800	1.200	0.300
↑	10	9.600	2.400	0.600	0.150
12.2880	5	38.400	9.600	2.400	0.600
↑	A	19.200	4.800	1.200	0.300
14.7456	2	115.200	28.800	7.200	1.800
↑	3	76.800	19.200	4.800	1.200
↑	6	38.400	9.600	2.400	0.600
↑	C	19.200	4.800	1.200	0.300
19.6608	1	307.200	76.800	19.200	4.800
↑	2	153.600	38.400	9.600	2.400
↑	4	76.800	19.200	4.800	1.200
↑	8	38.400	9.600	2.400	0.600
↑	10	19.200	4.800	1.200	0.300
22.1184	3	115.200	28.800	7.200	1.800
24.5760	1	384.000	96.000	24.000	6.000
↑	2	192.000	48.000	12.000	3.000
↑	4	96.000	24.000	6.000	1.500
↑	5	76.800	19.200	4.800	1.200
↑	8	48.000	12.000	3.000	0.750
↑	A	38.400	9.600	2.400	0.600
↑	10	24.000	6.000	1.500	0.375

Note: Transfer rates in I/O interface mode are eight times faster than the values given above.

In UART mode, TMRA match detect signal (TA0TRG) can be used for serial transfer clock.

Method for calculating the timer output frequency which is needed when outputting trigger of timer

TA0TRG frequency = Baud rate × 16

Note: The TMRA0 match detect signal cannot be used as the transfer clock in I/O Interface mode.

(3) Serial clock generation circuit

This circuit generates the basic clock for transmitting and receiving data.

- In I/O interface mode

  In SCLK output mode with the setting SC0CR<IOC> = 0, the basic clock is generated by dividing the output of the baud rate generator by 2, as described previously.

  In SCLK input mode with the setting SC0CR<IOC> = 1, the rising edge or falling edge will be detected according to the setting of the SC0CR<SCLKS> register to generate the basic clock.

- In UART mode

  The SC0MOD0<SC1:0> setting determines whether the baud rate generator clock, the internal clock f_{IO}, the match detect signal from TMRA0 or the external clock (SCLK0) is used to generate the basic clock SIOCLK.

(4) Receiving counter

The receiving counter is a 4-bit binary counter used in UART mode, which counts up the pulses of the SIOCLK clock. It takes 16 SIOCLK pulses to receive 1 bit of data; each data bit is sampled three times, on the 7th, 8th and 9th clock cycles.

The value of the data bit is determined from these three samples using the majority rule.

For example, if the data bit is sampled respectively as 1, 0 and 1 on 7th, 8th and 9th clock cycles, the received data bit is taken to be 1. A data bit sampled as 0, 0 and 1 is taken to be 0.

(5) Receiving control

- In I/O interface mode

  In SCLK output mode with the setting SC0CR<IOC> = 0, the RXD0 signal is sampled on the rising edge or falling of the shift clock, which is output on the SCLK0 pin, according to the SC0CR<SCLKS> setting.

  In SCLK input mode with the setting SC0CR<IOC> = 1, the RXD0 signal is sampled on the rising or falling edge of the SCLK0 input, according to the SC0CR<SCLKS> setting.

- In UART mode

  The receiving control block has a circuit which detects a start bit using the majority rule. Received bits are sampled three times; when two or more out of three samples are 0, the bit is recognized as the start bit and the receiving operation commences.

  The values of the data bits that are received are also determined using the majority rule.

(6) The receiving buffers

To prevent overrun errors, the receiving buffers are arranged in a double buffer structure.

Received data is stored one bit at a time in receiving buffer 1 (which is a shift register). When 7 or 8 bits of data have been stored in receiving buffer 1, the stored data is transferred to receiving buffer 2 (SC0BUF); this causes an INTRX0 interrupt to be generated. The CPU only reads receiving buffer 2 (SC0BUF). Even before the CPU reads receiving buffer 2 (SC0BUF), the received data can be stored in receiving buffer 1. However, unless receiving buffer 2 (SC0BUF) is read before all bits of the next data are received by receiving buffer 1, an overrun error occurs. If an overrun error occurs, the contents of receiving buffer 1 will be lost, although the contents of receiving buffer 2 and SC0CR<RB8> will be preserved.

SC0CR<RB8> is used to store either the parity bit – added in 8-bit UART mode – or the most significant bit (MSB) – in 9-bit UART mode.

In 9-bit UART mode the wakeup function for the slave controller is enabled by setting SC0MOD0<WU> to 1; in this mode INTRX0 interrupts occur only when the value of SC0CR<RB8> is 1.

SIO interrupt mode is selectable by the register SIMC.

(7) Transmission counter

The transmission counter is a 4-bit binary counter used in UART mode and which, like the receiving counter, counts the SIOCLK clock pulses; a TXDCLK pulse is generated every 16 SIOCLK clock pulses.

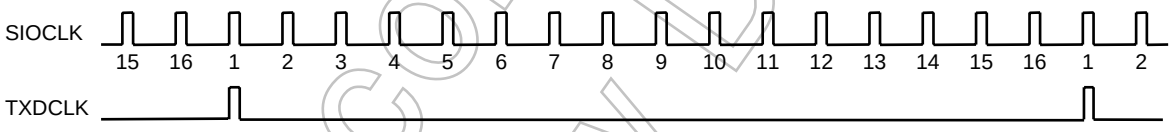


Figure 3.9.3 Generation of the Transmission Clock

(8) Transmission controller

- In I/O interface mode

In SCLK output mode with the setting SC0CR<IOC> = 0, the data in the transmission buffer is output one bit at a time to the TXD0 pin on the rising or falling edge of the shift clock which is output on the SCLK0 pin, according to the SC0CR<SCLKS> setting.

In SCLK input mode with the setting SC0CR<IOC> = 1, the data in the transmission buffer is output one bit at a time on the TXD0 pin on the rising or falling edge of the SCLK0 input, according to the SC0CR<SCLKS> setting.

- In UART mode

When transmission data sent from the CPU is written to the transmission buffer, transmission starts on the rising edge of the next TXDCLK, generating a transmission shift clock TXDSFT.

Handshake function

Use of $\overline{CTS0}$ pin allows data to be sent in units of one frame; thus, overrun errors can be avoided. The handshake function is enabled or disabled by the SC0MOD<CTSE> setting.

When the $\overline{CTS0}$ pin goes high on completion of the current data send, data transmission is halted until the $\overline{CTS0}$ pin goes low again. However, the INTTX0 interrupt is generated, and it requests the next data send from the CPU. The next data is written in the transmission buffer and data sending is halted.

Though there is no $\overline{RTS}$ pin, a handshake function can be easily configured by setting any port assigned to be the $\overline{RTS}$ function. The $\overline{RTS}$ should be output "high" to request send data halt after data receive is completed by software in the RXD interrupt routine.

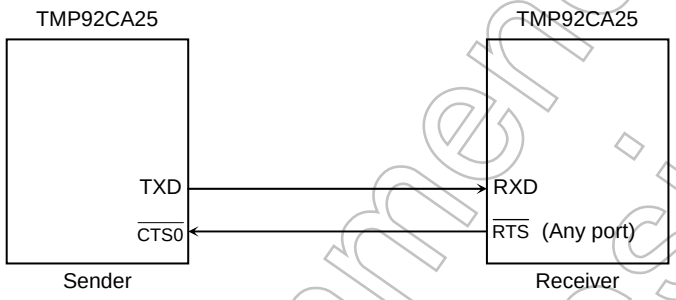
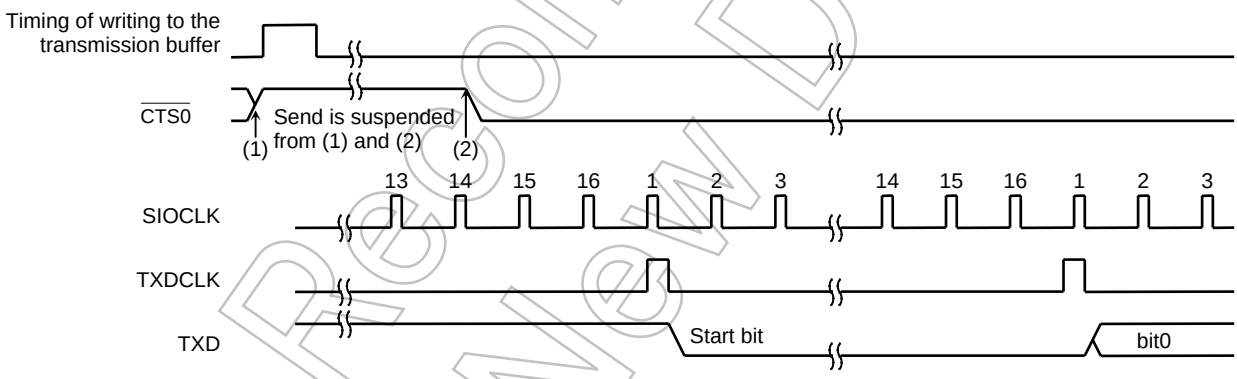


Figure 3.9.4 Handshake Function



Note 1: If the $\overline{CTS0}$ signal goes high during transmission, no more data will be sent after completion of the current transmission.

Note 2: Transmission starts on the first falling edge of the TXDCLK clock after the $\overline{CTS0}$ signal has fallen.

Figure 3.9.5 $\overline{CTS0}$ (Clear to send) Timing

(9) Transmission buffer

The transmission buffer (SC0BUF) shifts out and sends the transmission data written from the CPU in order from the least significant bit (LSB). When all the bits are shifted out, the transmission buffer becomes empty and generates an INTTX0 interrupt.

(10) Parity control circuit

When SC0CR<PE> in the serial channel control register is set to "1", it is possible to transmit and receive data with parity. However, parity can be added only in 7-bit UART mode or 8-bit UART mode. The SC0CR<EVEN> field in the serial channel control register allows either even or odd parity to be selected.

In the case of transmission, parity is automatically generated when data is written to the transmission buffer SC0BUF. The data is transmitted after the parity bit has been stored in SC0BUF<TB7> in 7-bit UART mode or in SC0MOD0<TB8> in 8-bit UART mode. SC0CR<PE> and SC0CR<EVEN> must be set before the transmission data is written to the transmission buffer.

In the case of receiving, data is shifted into receiving buffer 1, and the parity is added after the data has been transferred to receiving buffer 2 (SC0BUF), and then compared with SC0BUF<RB7> in 7-bit UART mode or with SC0CR<RB8> in 8-bit UART mode. If they are not equal, a parity error is generated and the SC0CR<PERR> flag is set.

(11) Error flags

Three error flags are provided to increase the reliability of data reception.

1. Overrun error <OERR>

If all the bits of the next data item have been received in receiving buffer 1 while valid data still remains stored in receiving buffer 2 (SC0BUF), an overrun error is generated.

The below is a recommended flow when the overrun-error is generated.

(INTRX interrupt routine)

1) Read receiving buffer
2) Read error flag
3) If <OERR> = 1

then

a) Set to disable receiving (Write "0" to SC0MOD0<RXE>)
b) Wait to terminate current frame
c) Read receiving buffer
d) Read error flag
e) Set to enable receiving (Write "1" to SC0MOD0<RXE>)
f) Request to transmit again

4) Other

2. Parity error <PERR>

   The parity generated for the data shifted into receiving buffer 2 (SC0BUF) is compared with the parity bit received via the RXD pin. If they are not equal, a parity error is generated.

3. Framing error <FERR>

   The stop bit for the received data is sampled three times around the center. If the majority of the samples are 0, a framing error is generated.

(12) Timing generation

1. In UART mode

Receiving

Mode	9 Bits (Note)	8 Bits + Parity (Note)	8 Bits, 7 Bits + Parity, 7 Bits
Interrupt Timing	Center of last bit (bit8)	Center of last bit (parity bit)	Center of stop bit
Framing Error Timing	Center of stop bit	Center of stop bit	Center of stop bit
Parity Error Timing	–	Center of last bit (parity bit)	Center of stop bit
Overrun Error Timing	Center of last bit (bit8)	Center of last bit (parity bit)	Center of stop bit

Note1: In 9-bit and 8-bit + parity modes, interrupts coincide with the ninth bit pulse.
Thus, when servicing the interrupt, it is necessary to wait for a 1-bit period (to allow the stop bit to be transferred) to allow checking for a framing error.

Note2: The higher the transfer rate, the later than the middle receive interrupts and errors occur.

Transmitting

Mode	9 Bits	8 Bits + Parity	8 Bits, 7 Bits + Parity, 7 Bits
Interrupt Timing	Just before stop bit is transmitted	Just before stop bit is transmitted	Just before stop bit is transmitted

2. I/O interface

Transmission Interrupt Timing	SCLK output mode	Immediately after last bit data. (See Figure 3.9.13.)
	SCLK input mode	Immediately after rise of last SCLK signal rising mode, or immediately after fall in falling mode. (See Figure 3.9.14.)
Receiving Interrupt Timing	SCLK output mode	Timing used to transfer received to data receive buffer 2 (SC0BUF) (e.g. immediately after last SCLK). (See Figure 3.9.15.)
	SCLK input mode	Timing used to transfer received data to receive buffer 2 (SC0BUF) (e.g. immediately after last SCLK). (See Figure 3.9.16.)

3.9.3 SFR

SC0MOD0 (1202H)

	7	6	5	4	3	2	1	0
Bit symbol	TB8	CTSE	RXE	WU	SM1	SM0	SC1	SC0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Transfer data bit8	Hand shake 0: CTS disable 1: CTS enable	Receive function 0: Receive disable 1: Receive enable	Wakeup function 0: Disable 1: Enable	Serial transmission mode 00: I/O interface mode 01: 7-bit UART mode 10: 8-bit UART mode 11: 9-bit UART mode		Serial transmission clock (UART) 00: TMRA0 trigger 01: Baud rate generator 10: Internal clock f_{IO} 11: External clcok (SCLK0 input)	

Serial transmission clock source (UART)

00	TMRA0 match detect signal
01	Baud rate generator
10	Internal clock f_{IO}
11	External clock (SCLK0 input)

Note: The clock selection for the I/O interface mode is controlled by the serial control register (SC0CR).

Serial transmission mode

00	I/O interface mode	
01	UART mode	7-bit mode
10		8-bit mode
11		9-bit mode

Wakeup function

	9-bit UART	Other modes
0	Interrupt generated when data is received	Don't care
1	Interrupt generated only when SC0CR<RB8> = 1	

Receiving function

0	Receive disabled
1	Receive enabled

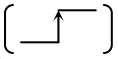
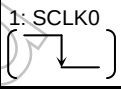
Handshake function ($\overline{CTS}$ pin)

0	Disabled (always transferable)
1	Enabled

Transmission data bit8

Figure 3.9.6 Serial Mode Control Register (Channel 0, SC0MOD0)

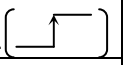
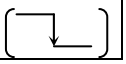
SC0CR (1201H)

	7	6	5	4	3	2	1	0
Bit symbol	RB8	EVEN	PE	OERR	PERR	FERR	SCLKS	IOC
Read/Write	R	R/W		R (Cleared to 0 when read)			R/W	
After reset	Undefined	0	0	0	0	0	0	0
Function	Received data bit8	Parity 0: Odd 1: Even	Parity addition 0: Disable 1: Enable	1: Error			0: SCLK0  1: SCLK0 	0: Baud rate generator 1: SCLK0 pin input
				Overrun	Parity	Framing		

I/O interface input clock selection

0	Baud rate generator
1	SCLK0 pin input

Edge selection for SCLK pin (I/O mode)

0	Transmits and receives data on rising edge of SCLK0. 
1	Transmits and receives data on falling edge SCLK0. 

Framing error flag
Parity error flag
Overrun error flag
} Cleared to 0 when read

Parity additions enable

0	Disabled
1	Enabled

Even parity addition/check

0	Odd parity
1	Even parity

Received data bit8

Note: As all error flags are cleared after reading do not test only a single bit with a bit testing instruction.

Figure 3.9.7 Serial Control Register (Channel 0, SC0CR)

BR0CR (1203H)

	7	6	5	4	3	2	1	0
Bit symbol	–	BR0ADDE	BR0CK1	BR0CK0	BR0S3	BR0S2	BR0S1	BR0S0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Always write "0".	+(16 – K)/16 division 0: Disable 1: Enable	00: φT0 01: φT2 10: φT8 11: φT32		Divided frequency setting			

+(16 – K)/16 division enable

0	Disable
1	Enable

Setting the input clock of baud rate generator

00	Internal clock φT0
01	Internal clock φT2
10	Internal clock φT8
11	Internal clock φT32

BR0ADD (1204H)

	7	6	5	4	3	2	1	0
Bit symbol					BR0K3	BR0K2	BR0K1	BR0K0
Read/Write					R/W			
After reset					0	0	0	0
Function					Sets frequency divisor "K" (divided by N + (16 – K)/16).			

Sets baud rate generator frequency divisor

	BR0CR<BR0ADDE> = 1		BR0CR<BR0ADDE> = 0
BR0CR <BR0S3:0> / BR0ADD <BR0K3:0>	0000 (N = 16) or 0001 (N = 1)	0010 (N = 2) to 1111 (N = 15)	0001 (N = 1) (Only UART) to 1111 (N = 15) 0000 (N = 16)
0000	Disable	Disable	Divided by N
0001 (K = 1) to 1111 (K = 15)	Disable	Divided by N + (16 – K)/16	

Note1:Availability of +(16-K)/16 division function

N	UART mode	I/O mode
2 to 15	○	×
1 , 16	×	×

The baud rate generator can be set to "1" in UART mode only when the +(16-K)/16 division function is not used. Do not use in I/O interface mode.

Note2:Set BR0CR <BR0ADDE> to 1 after setting K (K = 1 to 15) to BR0ADD<BR0K3:0> when +(16-K)/16 division function is used. Writes to unused bits in the BR0ADD register do not affect operation, and undefined data is read from these unused bits.

Figure 3.9.8 Baud Rate Generator Control (Channel 0, BR0CR, BR0ADD)

SC0BUF (1200H)

7	6	5	4	3	2	1	0	
TB7	TB6	TB5	TB4	TB3	TB2	TB1	TB0	(Transmission)
RB7	RB6	RB5	RB4	RB3	RB2	RB1	RB0	(Receiving)

Note: Prohibit read-modify-write for SC0BUF.

Figure 3.9.9 Serial Transmission/Receiving Buffer Registers (Channel 0, SC0BUF)

SC0MOD1 (1205H)

	7	6	5	4	3	2	1	0
Bit symbol	I2S0	FDPX0						
Read/Write	R/W	R/W						
After reset	0	0						
Function	IDLE2 0: Stop 1: Run	Duplex 0: Half 1: Full						

Figure 3.9.10 Serial Mode Control Register 1 (Channel 0, SC0MOD1)

3.9.4 Operation in Each Mode

(1) Mode 0 (I/O interface mode)

This mode allows an increase in the number of I/O pins available for transmitting data to or receiving data from an external shift register.

This mode includes the SCLK output mode to output synchronous clock SCLK, and SCLK input mode to input external synchronous clock SCLK.

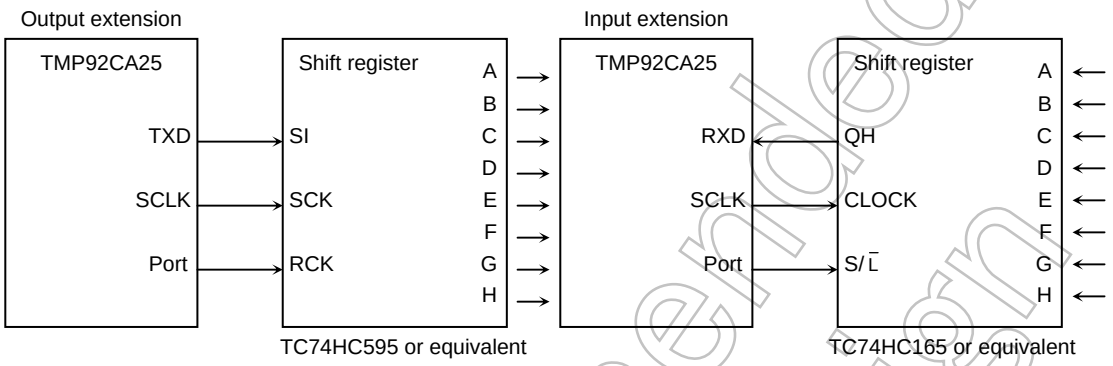


Figure 3.9.11 SCLK Output Mode Connection Example

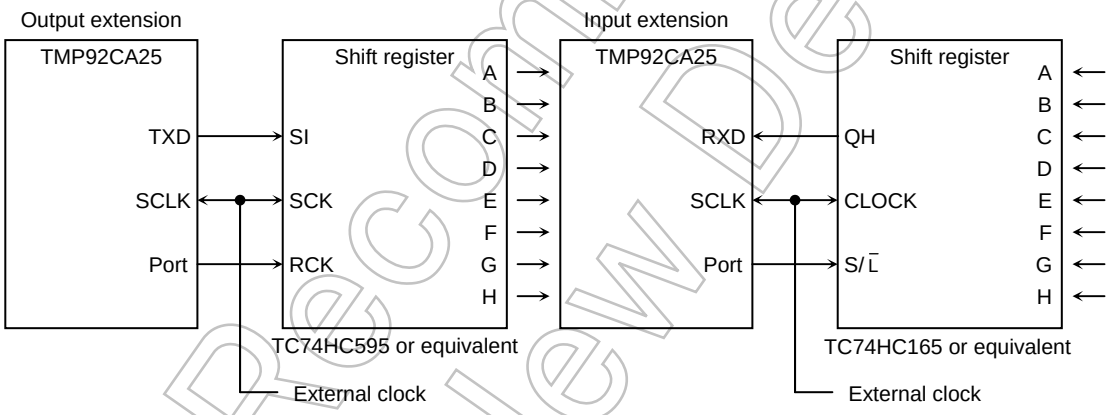


Figure 3.9.12 Example of SCLK Input Mode Connection

1. Transmission

In SCLK output mode 8-bit data and a synchronous clock are output on the TXD0 and SCLK0 pins respectively each time the CPU writes data to the transmission buffer. When all data is output, INTES0<ITX0C> will be set to generate the INTTX0 interrupt.

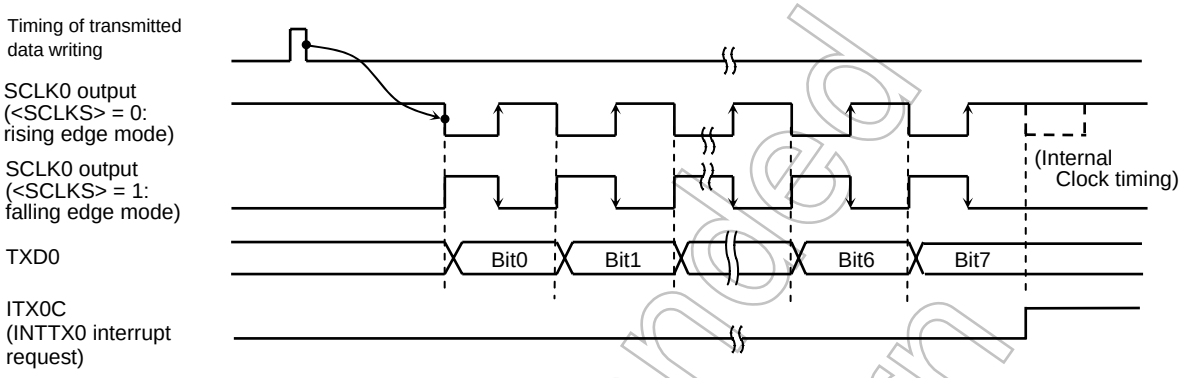


Figure 3.9.13 Transmitting Operation in I/O Interface Mode (SCLK0 output mode) (Channel 0)

In SCLK input mode, 8-bit data is output on the TXD0 pin when the SCLK0 input becomes active after the data has been written to the transmission buffer by the CPU. When all data is output, INTES0<ITX0C> will be set to generate an INTTX0 interrupt.

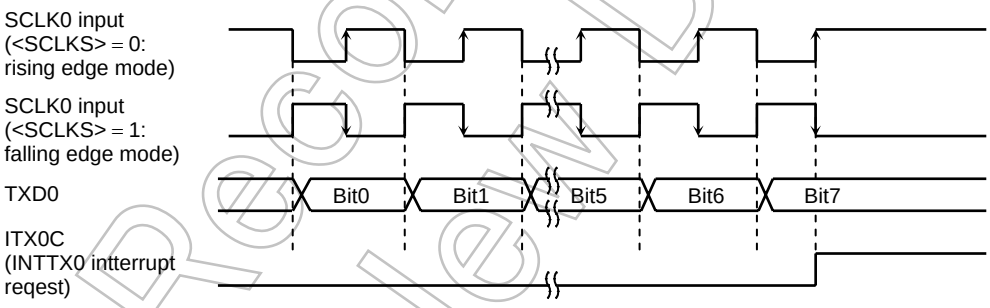


Figure 3.9.14 Transmitting Operation in I/O Interface Mode (SCLK0 input mode) (Channel 0)

2. Receiving

In SCLK output mode the synchronous clock is output on the SCLK0 pin and the data is shifted to receiving buffer 1. This is initiated when the receive interrupt flag INTES0<IRX0C> is cleared as the received data is read. When 8-bit data is received, the data is transferred to receiving buffer 2 (SC0BUF) following the timing shown below and INTES0<IRX0C> is set to 1 again, causing an INTRX0 interrupt to be generated.

Setting SC0MOD0<RXE> to 1 initiates SCLK0 output.

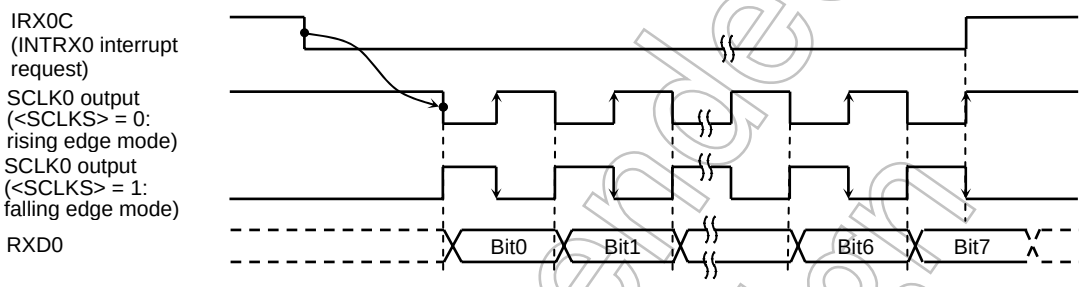


Figure 3.9.15 Receiving Operation in I/O Interface Mode (SCLK0 output mode)

In SCLK input mode the data is shifted to receiving buffer 1 when the SCLK input goes active. The SCLK input goes active when the receive interrupt flag INTES0<IRX0C> is cleared as the received data is read. When 8-bit data is received, the data is shifted to receiving buffer 2 (SC0BUF) following the timing shown below and INTES0<IRX0C> is set to 1 again, causing an INTRX0 interrupt to be generated.

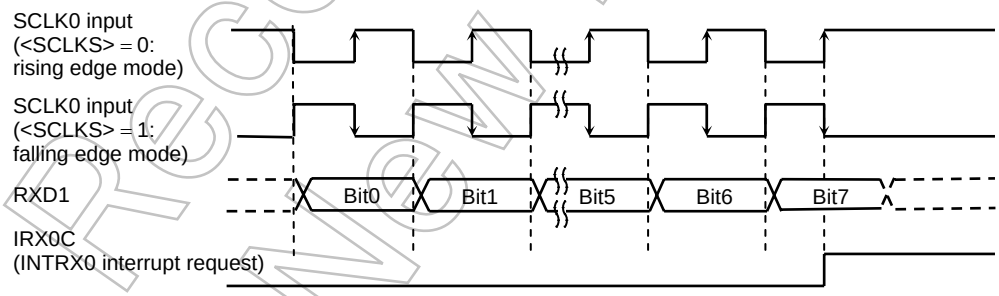


Figure 3.9.16 Receiving Operation in I/O Interface Mode (SCLK0 input mode)

Note: The system must be put in the receive-enable state (SC0MOD0<RXE> = 1) before data can be received.

3. Transmission and receiving (Full duplex mode)

When full duplex mode is used, set the receive interrupt level to 0, and only set the interrupt level (from 1 to 6) of the transmit interrupt. Ensure that the program which transmits the interrupt reads the receiving buffer before setting the next transmit data.

The following is an example of this:

Example: Channel 0, SCLK output
Baud rate = 9600 bps
fc = 4.9152 MHz
*Clock condition: Clock gear 1/1(fc)

Main routine

	7	6	5	4	3	2	1	0	
INTES0	X	0	0	1	X	0	0	0	Set the INTTX0 level to 1. Set the INTRX0 level to 0.
PFCR	–	–	–	–	–	1	0	1	Set PF0, PF1 and PF2 to function as the TXD0, RXD0 and SCLK0 pins respectively.
PFFC	–	–	–	–	–	1	0	1	
SC0MOD0	0	0	0	0	0	0	0	0	Select I/O interface mode.
SC0MOD1	1	1	0	0	0	0	0	0	Select full duplex mode.
SC0CR	0	0	0	0	0	0	0	0	SCLK output, transmit on negative edge, receive on positive edge.
BR0CR	0	0	0	1	1	0	0	0	Baud rate = 9600 bps.
SC0MOD0	0	0	1	0	0	0	0	0	Enable receiving.
SC0BUF	*	*	*	*	*	*	*	*	Set the transmit data and start.

INTTX0 interrupt routine

A_{CC}	←	SC0BUF							Read the receiving buffer.
SC0BUF		*	*	*	*	*	*	*	*	Set the next transmit data.

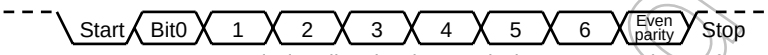
X: Don't care, –: No change

(2) Mode 1 (7-bit UART mode)

7-bit UART mode is selected by setting the serial channel mode register SC0MOD0<SM1:0> field to 01.

In this mode a parity bit can be added. Use of a parity bit is enabled or disabled by the setting of the serial channel control register SC0CR<PE> bit; whether even parity or odd parity will be used is determined by the SC0CR<EVEN> setting when SC0CR<PE> is set to 1 (enabled).

Setting example: When transmitting data of the following format, the control registers should be set as described below.



← Transmission direction (Transmission rate: 2400 bps at f_C = 39.3216 MHz)

*Clock condition: Clock gear 1/1(fc)

		7	6	5	4	3	2	1	0	
PFCR	←	–	–	–	–	–	–	–	1	} Set PF0 to function as the TXD0 pin.
PFFC	←	–	–	–	–	–	–	–	1	
SC0MOD0	←	X	0	–	X	0	1	0	1	Select 7-bit UART mode.
SC0CR	←	X	1	1	X	X	X	0	0	Add even parity.
BR0CR	←	0	0	1	0	1	0	0	0	Set the transfer rate to 2400 bps.
INTES0	←	X	1	0	0	–	–	–	–	Enable the INTTX0 interrupt and set it to interrupt level 4.
SC0BUF	←	*	*	*	*	*	*	*	*	Set data for transmission.

X: Don't care, –: No change

(3) Mode 2 (8-bit UART mode)

8-bit UART mode is selected by setting SC0MOD0<SM1:0> to 10. In this mode a parity bit can be added (use of a parity bit is enabled or disabled by the setting of SC0CR<PE>); whether even parity or odd parity will be used is determined by the SC0CR<EVEN> setting when SC0CR<PE> is set to 1 (enabled).

Setting example: When receiving data of the following format, the control registers should be set as described below.

← Transmission direction (Transmission rate: 9600 bps at f_C = 39.3216 MHz)

Main settings

		7	6	5	4	3	2	1	0	
PFCR	←	–	–	–	–	–	–	0	–	Set PF1 to function as the RXD0 pin.
PFFC	←	–	–	–	–	–	–	0	–	
SC0MOD0	←	–	0	1	X	1	0	0	1	Enable receiving in 8-bit UART mode.
SC0CR	←	X	0	1	X	X	X	0	0	Add odd parity.
BR0CR	←	0	0	0	1	1	0	0	0	Set the transfer rate to 9600 bps.
INTES0	←	–	–	–	–	X	1	0	0	Enable the INTTX0 interrupt and set it to interrupt level 4.

Interrupt processing

A_{CC} ← SC0CR AND 00011100
if $A_{CC} \neq 0$ then ERROR } Check for errors

A_{CC} ← SC0BUF Read the received data

X: Don't care, –: No change

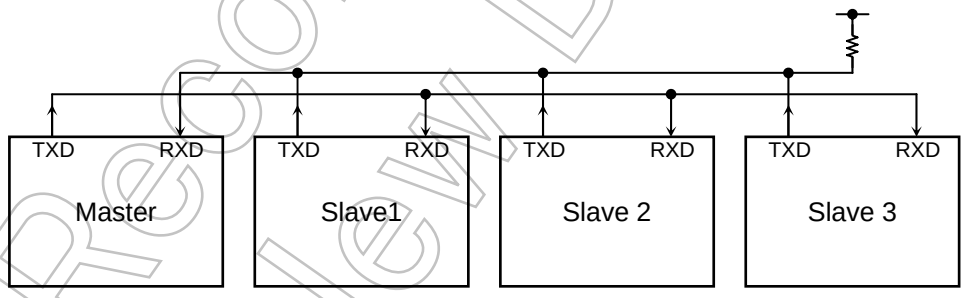
(4) Mode 3 (9-bit UART mode)

9-bit UART mode is selected by setting SC0MOD0<SM1:0> to 11. In this mode a parity bit cannot be added.

In the case of transmission the MSB (9th bit) is written to SC0MOD0<TB8>. In the case of receiving it is stored in SC0CR<RB8>. When the buffer is written or read, <TB8>or <RB8> is read or written first, before the rest of the SC0BUF data.

Wakeup function

In 9-bit UART mode, the wakeup function for slave controllers is enabled by setting SC0MOD0<WU> to 1. The interrupt INTRX0 can only be generated when<RB8> = 1.

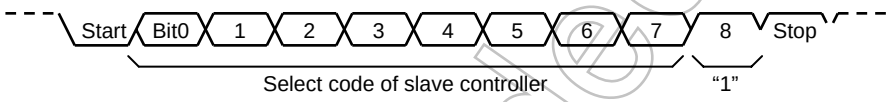


Note: The TXD pin of each slave controller must be in open-drain output mode.

Figure 3.9.17 Serial Link Using Wakeup Function

Protocol

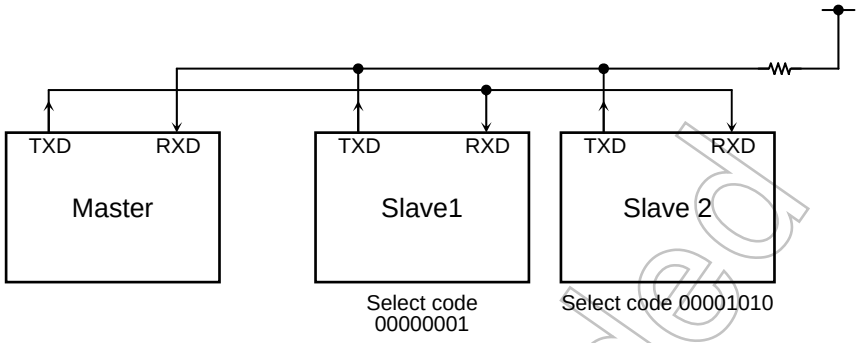
1. Select 9-bit UART mode on the master and slave controllers.
2. Set the SC0MOD0<WU> bit on each slave controller to 1 to enable data receiving.
3. The master controller transmits data one frame at a time. Each frame includes an 8-bit select code which identifies a slave controller. The MSB (bit8) of the data (<TB8>) is set to 1.



4. Each slave controller receives the above frame. Each controller checks the above select code against its own select code. The controller whose code matches clears its <WU> bit to 0.
5. The master controller transmits data to the specified slave controller (the controller whose SC0MOD0<WU> bit has been cleared to 0). The MSB (bit8) of the data (<TB8>) is cleared to 0.

6. The other slave controllers (whose <WU> bits remain at 1) ignore the received data because their MSBs (bit8 or <RB8>) are set to 0, disabling INTRX0 interrupts.
   The slave controller whose <WU> bit = 0 can also transmit to the master controller. In this way it can signal the master controller that the data transmission from the master controller has been completed.

Setting example: To link two slave controllers serially with the master controller using the internal clock f_{IO} as the transfer clock.



- Setting the master controller

Main

PFCR	←	–	–	–	–	–	–	0	1	Set PF0 and PF1 to function as the TXD0 and RXD0 pins respectively.
PFFC	←	–	–	–	–	–	–	0	1	
INTES0	←	1	1	0	0	1	1	0	1	Enable the INTTX0 interrupt and set it to interrupt level 4. Enable the INTRX0 interrupt and set it to interrupt level 5.
SC0MOD0	←	1	0	1	0	1	1	1	0	Set f_{IO} as the transmission clock for 9-bit UART mode.
SC0BUF	←	0	0	0	0	0	0	0	1	Set the select code for slave controller 1.

INTTX0 interrupt

SC0MOD0	←	0	–	–	–	–	–	–	–	Set TB8 to 0.
SC0BUF	←	*	*	*	*	*	*	*	*	Set data for transmission.

- Setting the slave controller

Main

PFCR	←	–	–	–	–	–	–	0	1	Select PF1 and PF0 to function as the RXD0 and TXD0 pins respectively (Open-drain output).
PFFC	←	–	–	–	–	–	–	0	1	
PFFC2	←	X	X	X	X	X	X	X	1	
INTES0	←	1	1	0	1	1	1	1	0	Enable INTRX0 and INTTX0.
SC0MOD0	←	1	0	1	1	1	1	1	0	Set <WU> to 1 in 9-bit UART transmission mode using f_{SYS} as the transfer clock.

INTRX0 interrupt

A_{CC}	←	SC0BUF							
if A_{CC} = select code									
Then SC0MOD0	←	–	–	–	0	–	–	–	–	Clear <WU> to 0

3.9.5 Support for IrDA

SIO0 includes support for the IrDA 1.0 infrared data communication specification. Figure 3.9.18 shows the block diagram.

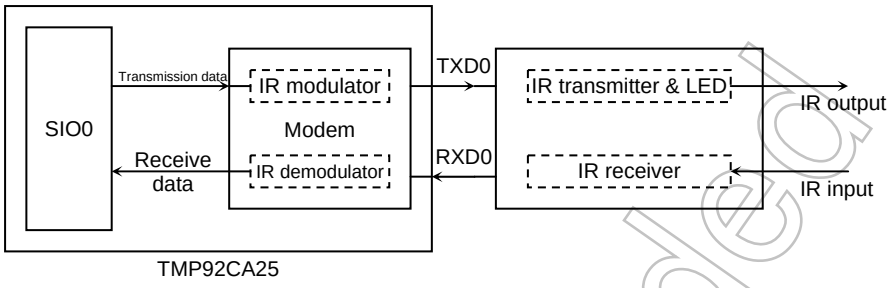


Figure 3.9.18 Block Diagram

(1) Modulation of the transmission data

When the transmit data is 0, the modem outputs 1 to TXD0 pin with either 3/16 or 1/16 times for width of baud rate. The pulse width is selected by the SIRCR<PLSEL>.

When the transmit data is 1, the modem outputs 0.

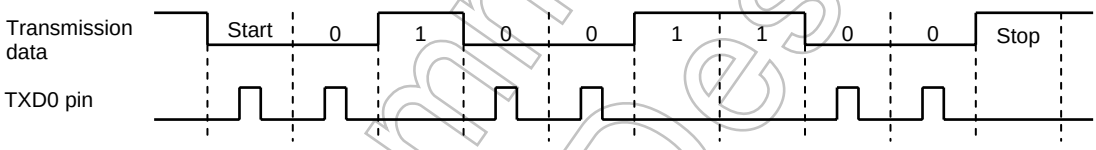


Figure 3.9.19 Transmission Example

(2) Modulation of the receive data

When the receive data has an effective pulse width of "1", the modem outputs "0" to SIO0. Otherwise the modem outputs "1" to SIO0. The effective pulse width is selected by SIRCR<SIRWD3:0>.

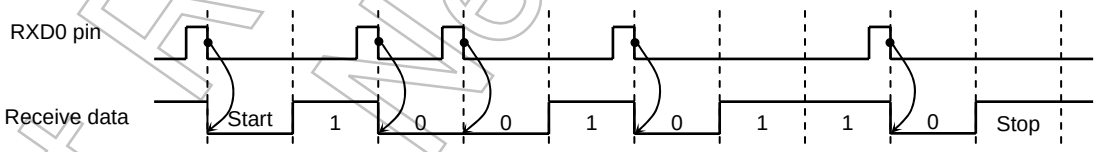


Figure 3.9.20 Receiving Example

(3) Data format

The data format is fixed as follows:

- Data length: 8 bits
- Parity bits: none
- Stop bits: 1 bit

(4) SFR

Figure 3.9.21 shows the control register SIRCR. Set SIRCR data while SIO0 is stopped. The following example describes how to set this register:

```
1) SIO setting                          ;  Set the SIO to UART mode.
   ↓
2) LD      (SIRCR), 07H                 ;  Set the receive data pulse width to 16×.
3) LD      (SIRCR), 37H                 ;  TXEN, RXEN Enable the transmission and receiving.
   ↓
4) Start transmission                   ;  The modem operates as follows:
   and receiving for SIO0                  • SIO0 starts transmitting.
                                           • IR receiver starts receiving.
```

(5) Notes

1. Baud rate for IrDA

When IrDA is operated, set 01 to SC0MOD0<SC1:0> to generate baud rate.

Settings other than the above (TA0TRG, f_{IO} and SCLK0 input) cannot be used.

2. The pulse width for transmission

The IrDA 1.0 specification is defined in Table 3.9.3.

Table 3.9.3 Baud Rate and Pulse Width Specifications

Baud Rate	Modulation	Rate Tolerance (% of rate)	Pulse Width (min)	Pulse Width (typ.)	Pulse Width (max)
2.4 Kbps	RZI	±0.87	1.41 μs	78.13 μs	88.55 μs
9.6 Kbps	RZI	±0.87	1.41 μs	19.53 μs	22.13 μs
19.2 Kbps	RZI	±0.87	1.41 μs	9.77 μs	11.07 μs
38.4 Kbps	RZI	±0.87	1.41 μs	4.88 μs	5.96 μs
57.6 Kbps	RZI	±0.87	1.41 μs	3.26 μs	4.34 μs
115.2 Kbps	RZI	±0.87	1.41 μs	1.63 μs	2.23 μs

The pulse width is defined as either baud rate T × 3/16 or 1.6 μs (1.6 μs is equal to 3/16 pulse width when baud rate is 115.2 Kbps).

The TMP92CA25 has a function which can select the pulse width of transmission as either 3/16 or 1/16. However, 1/16 pulse width can only be selected when the baud rate is equal to or less than 38.4 Kbps.

For the same reason, when using IrDA 115.2 Kbps with USB, the + (16 – K)/16 division function in the baud rate generator of SIO0 cannot be used to generate a 115.2 Kbps baud rate, except under special conditions as explained in (6) below.

The + (16 – K)/16 division function cannot be used alsowhen the baud rate is 38.4 Kbps and the pulse width is 1/16.

Table 3.9.4 Baud Rate and Pulse Width for (16 – K)/16 Division Function

Pulse Width	Baud Rate					
	115.2 Kbps	57.6 Kbps	38.4 Kbps	19.2 Kbps	9.6 Kbps	2.4 Kbps
T × 3/16	× (Note)	○	○	○	○	○
T × 1/16	–	–	×	○	○	○

○: (16 – K)/16 division function can be used.

×: (16 – K)/16 division function cannot be used.

–: Cannot be set to 1/16 pulse width.

Note: (16 – K)/16 division function can be used under special conditions.

SIRCR (1207H)

	7	6	5	4	3	2	1	0
Bit symbol	PLSEL	RXSEL	TXEN	RXEN	SIRWD3	SIRWD2	SIRWD1	SIRWD0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Select transmit pulse width 0: 3/16 1: 1/16	Receive data 0: "H" pulse 1: "L" pulse	Transmit 0: Disable 1: Enable	Receive 0: Disable 1: Enable	Select receive pulse width Set effective pulse width to equal to or more than 2x × (value + 1) + 100 ns Can be set: 1 to 14 Cannot be set: 0, 15			

Select receive pulse width

Formula: Effective pulse width ≥ 2x × (value + 1) + 100 ns

$x = 1/f_{SYS}$

0000	Cannot be set
0001	Equal to or more than 4x + 100 ns
to	
1110	Equal to or more than 30x + 100 ns
1111	Cannot be set

Receive operation

0	Disable (Received input is ignored)
1	Enable

Transmit operation

0	Disable (Input from SIO is ignored)
1	Enable

Select transmit pulse width

0	3/16
1	1/16

Note: If a pulse width complying with IrDA1.0 standard (1.6 μs min.) can be guaranteed with a low baud rate, setting this bit to "1" will result in reduced power dissipation.

Figure 3.9.21 IrDA Control Register

3.10 Serial Bus Interface (SBI)

The TMP92CA25 has 1-channel serial bus interface which an I²C bus mode.

The serial bus interface is connected to an external device through P93 (SDA) and P94 (SCL) in the I²C bus mode.

Each pin is specified as follows.

	P9F2<P94F2, P93F2>	P9CR<P94C, P93C>	P9FC<P94F, P93F >
I^2C Bus Mode	11	11	11

X: Don't care

3.10.1 Configuration

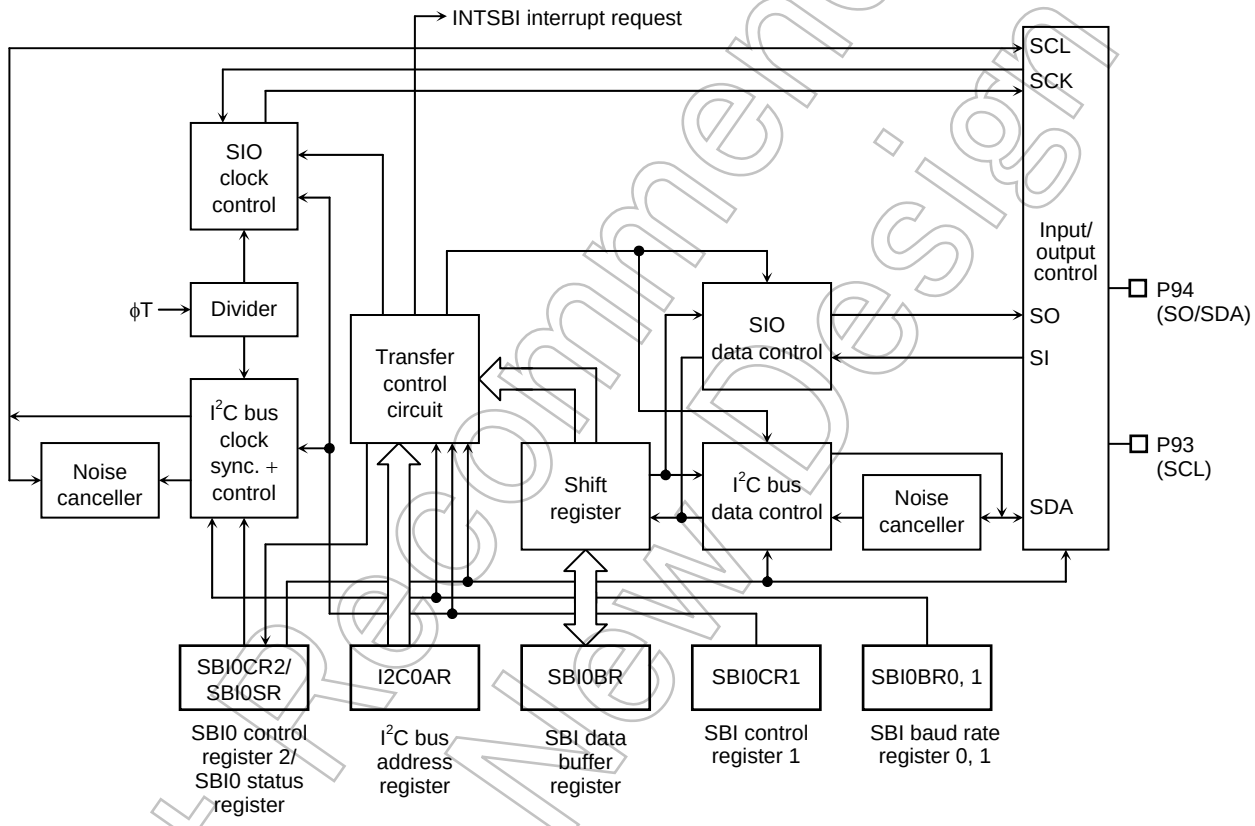


Figure 3.10.1 Serial Bus Interface (SBI)

3.10.2 Serial Bus Interface (SBI) Control

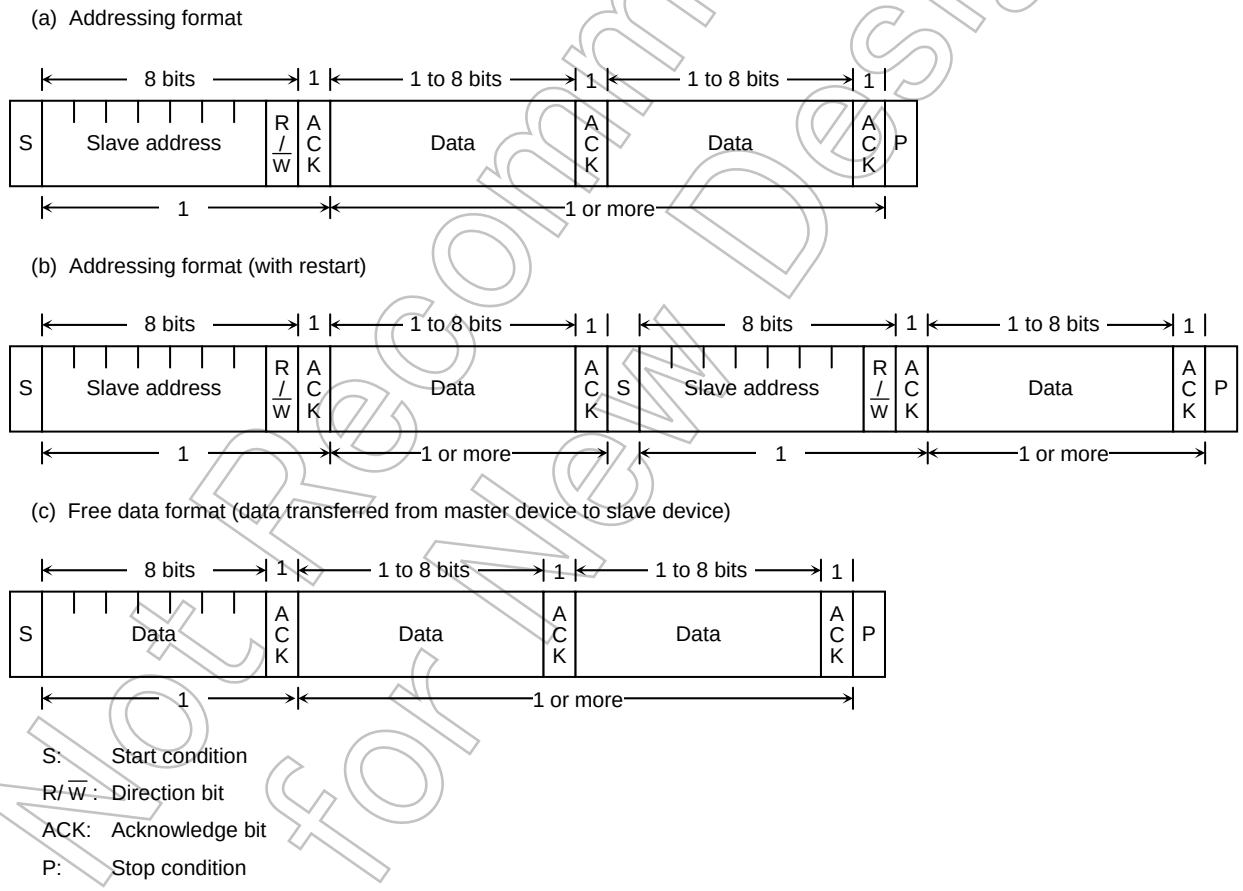
The following registers are used to control the serial bus interface and monitor the operation status.

- Serial bus interface 0 control register 1 (SBI0CR1)
- Serial bus interface 0 control register 2 (SBI0CR2)
- Serial bus interface 0 data buffer register (SBI0DBR)
- I²C bus 0 address register (I2C0AR)
- Serial bus interface 0 status register (SBI0SR)
- Serial bus interface 0 baud rate register 0 (SBI0BR0)
- Serial bus interface 0 baud rate register 1 (SBI0BR1)

The above registers differ depending on a mode to be used. Refer to section 3.10.4 "I²C Bus Mode Control Register".

3.10.3 The Data Formats in the I²C Bus Mode

The data formats in the I²C bus mode is shown below.



S: Start condition
R/$\overline{W}$: Direction bit
ACK: Acknowledge bit
P: Stop condition

Figure 3.10.2 Data Format in the I²C Bus Mode

3.10.4 I²C Bus Mode Control Register

The following registers are used to control and monitor the operation status when using the serial bus interface (SBI) in the I²C bus mode.

Serial Bus Interface 0 Control Register 1

	7	6	5	4	3	2	1	0
SBI0CR1 (1240H) Bit symbol	BC2	BC1	BC0	ACK		SCK2	SCK1	SCK0/ SWRMON
Read/Write	W			R/W		W		R/W
After reset	0	0	0	0		0	0	0/1 (Note 2)
Function	Number of transferred bits			Acknowledge mode specification 0: Not generate 1: Generate		Internal serial clock selection and software reset monitor (Note 1)		

Prohibit read-modify-write

Internal serial clock selection <SCK2:0> at write

000	n = 5	– (Note 3)
001	n = 6	– (Note 3)
010	n = 7	– (Note 3)
011	n = 8	– (Note 3)
100	n = 9	76.9 kHz
101	n = 10	38.8 kHz
110	n = 11	19.5 kHz
111	Reserved	(Reserved)

System clock: f_{SYS} = 20 MHz (internal SCL output)

$$fscl = \frac{f_{SYS}}{2^n + 8} \quad [Hz]$$

Software reset state monitor <SWRMON> at read

0	During software reset
1	Initial data

Acknowledge mode specification

0	Not generate clock pulse for acknowledge signal
1	Generate clock pulse for acknowledge signal

Number of bits transferred

<BC2:0>	<ACK> = 0		<ACK> = 1	
	Number of clock pulses	Bits	Number of clock pulses	Bits
000	8	8	9	8
001	1	1	2	1
010	2	2	3	2
011	3	3	4	3
100	4	4	5	4
101	5	5	6	5
110	6	6	7	6
111	7	7	8	7

Note 1: For the frequency of the SCL pin clock, see 3.10.5 (3) “Serial clock”.

Note 2: Initial data of SCK0 is “0”, SWRMON is “1”.

Note 3: This I²C bus circuit does not support fast mode, it supports the Standard mode only. Although the I²C bus circuit itself allows the setting of a baud rate over 100kbps, the compliance with the I²C specification is not guaranteed in that case.

Figure 3.10.3 Registers for the I²C Bus Mode

Serial Bus Interface Control Register 2

SBI0CR2 (1243H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	MST	TRX	BB	PIN	SBIM1	SBIM0	SWRST1	SWRST0
Read/Write	W				W (Note 1)		W (Note 1)	
After reset	0	0	0	1	0	0	0	0
Function	Master/ slave selection	Transmitter/ receiver selection	Start/stop condition generation	Cancel INTSBI interrupt request	Serial bus interface operating mode selection (Note 2) 00: Port mode 01: (Reserved) 10: I^2C bus mode 11: (Reserved)		Software reset generate write “10” and “01”, then an internal software reset signal is generated.	

Serial bus interface operating mode selection (Note 2)

00	Port mode (Serial bus interface output disabled)
01	(Reserved)
10	I^2C bus mode
11	(Reserved)

INTSBI interrupt request

0	– (Cannot clear to “0”)
1	Cancel interrupt request

Start/stop condition generation

0	Generates the stop condition (When MST, TRX, PIN are “1”)
1	Generates the start condition (When MST, TRX, PIN are “1”)

Transmitter/receiver selection

0	Receiver
1	Transmitter

Master/slave selection

0	Slave
1	Master

Note 1: Reading this register function as SBI0SR register.

Note 2: Switch a mode to port mode after confirming that the bus is free.

Switch a mode between I^2C bus mode after confirming that input signals via port are high level.

Figure 3.10.4 Registers for the I^2C Bus Mode

Serial Bus Interface Status Register

SBI0SR (1243H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	MST	TRX	BB	PIN	AL	AAS	AD0	LRB
Read/Write	R							
After reset	0	0	0	1	0	0	0	0
Function	Master/ slave status monitor	Transmitter/ receiver status monitor	I^2C bus status monitor	INTSBI interrupt request monitor	Arbitration lost detection monitor 0: – 1: Detected	Slave address match detection monitor 0: Undetected 1: Detected	GENERAL CALL detection monitor 0: Undetected 1: Detected	Last received bit monitor 0: “0” 1: “1”

Last received bit monitor

0	Last received bit was “0”
1	Last received bit was “1”

GENERAL CALL detection monitor

0	Undetected
1	GENERAL CALL detected

Slave address match detection monitor

0	Undetected
1	Slave address match or GENERAL CALL detected

Arbitration lost detection monitor

0	–
1	Arbitration lost

INTSBI interrupt request monitor

0	Interrupt requested
1	Interrupt canceled

I^2C bus status monitor

0	Free
1	Busy

Transmitter/receiver status monitor

0	Receiver
1	Transmitter

Master/slave status monitor

0	Slave
1	Master

Note: Writing in this register functions as SBI0CR2.

Figure 3.10.5 Registers for the I^2C Bus Mode

Serial Bus Interface Baud Rate Register 0

SBI0BR0 (1244H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	–	I2SBI0						
Read/Write	W	R/W						
After reset	0	0						
Function	Always write “0”.	IDLE2 0: Stop 1: Run						

Operation during IDLE2 mode

0	Stop
1	Operation

Serial Bus Interface Baud Rate Register 1

SBI0BR1 (1245H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	P4EN	–						
Read/Write	W							
After reset	0	0						
Function	Internal clock 0: Stop 1: Operate	Always write “0”.						

Baud rate clock control

0	Stop
1	Operate

Serial Bus Interface Data Buffer Register

SBI0DBR (1241H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
Read/Write	R (Received)/W (Transfer)							
After reset	Undefined							

Note 1: When writing transmitted data, start from the MSB (Bit7). Receiving data is placed from LSB (Bit0).

Note 2: SBI0DBR can’t be read the written data. Therefore read-modify-write instruction (e.g., “BIT” instruction) is prohibitted.

I^2C Bus 0 Address Register

I2C0AR (1242H)

Prohibit read-modify-write

	7	6	5	4	3	2	1	0
Bit symbol	SA6	SA5	SA4	SA3	SA2	SA1	SA0	ALS
Read/Write	W							
After reset	0	0	0	0	0	0	0	0
Function	Slave address selection for when device is operating as slave device							Address recognition mode specification

Address recognition mode specification

0	Slave address recognition
1	Non slave address recognition

Figure 3.10.6 Registers for the I^2C Bus Mode

3.10.5 Control in I²C Bus Mode

(1) Acknowledge mode specification

Set the SBI0CR1<ACK> to "1" for operation in the acknowledge mode. The TMP92CA25 generates an additional clock pulse for an acknowledge signal when operating in master mode. In the transmitter mode during the clock pulse cycle, the SDA pin is released in order to receive the acknowledge signal from the receiver. In the receiver mode during the clock pulse cycle, the SDA pin is set to the low in order to generate the acknowledge signal.

Clear the <ACK> to "0" for operation in the non-acknowledge mode. The TMP92CA25 does not generate a clock pulse for the acknowledge signal when operating in the master mode.

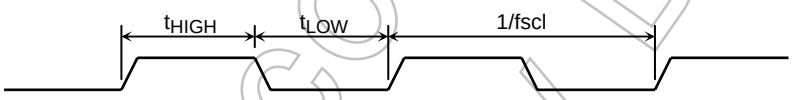
(2) Number of transfer bits

Since the SBI0CR1<BC2:0> is cleared to "000" on start up, a slave address and direction bit transmissions are executed in 8 bits. Other than these, the <BC2:0> retains a specified value.

(3) Serial clock

1. Clock source

The SBI0CR1<SCK2:0> is used to specify the maximum transfer frequency for output on the SCL pin in the master mode. Set the baud rates, which have been calculated according to the formula below, to meet the specifications of the I²C bus, such as the smallest pulse width of t_{LOW}.



$t_{LOW} = 2^{n-1}/f_{SBI}$
$t_{HIGH} = 2^{n-1}/f_{SBI} + 8/f_{SBI}$
$fscl = 1/(t_{LOW} + t_{HIGH})$
$\fallingdotseq \frac{f_{SBI}}{2^n + 8}$

Note: f_{SBI} is the clock f_{SYS}.

SBI0CR1<SCK2:0>	n
000	5
001	6
010	7
011	8
100	9
101	10
110	11

Figure 3.10.7 Clock Source

2. Clock synchronization

In the I²C bus mode, in order to wired-AND a bus, a master device which pulls down a clock pin to the low level, in the first place, invalidate a clock pulse of another master device which generates a high-level clock pulse. The master device with a high-level clock pulse needs to detect the situation and implement the following procedure.

This device has a clock synchronization function which allows normal data transfer even when more than one master exists on the bus.

The following example explains the clock synchronization procedures used when there are two masters present on the bus.

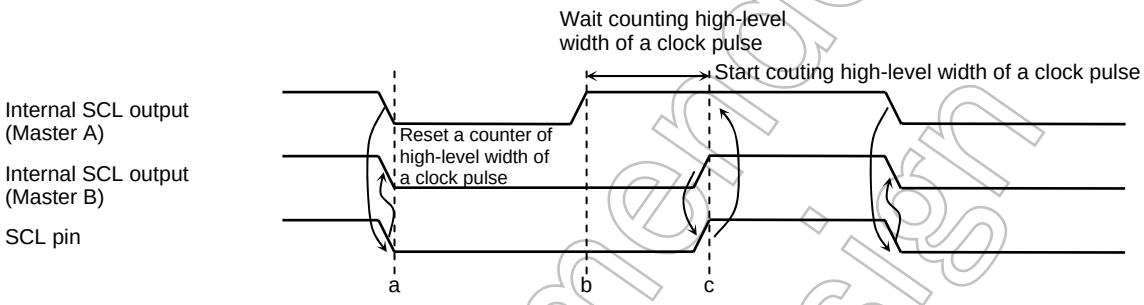


Figure 3.10.8 Clock Synchronization

When master A pulls the internal SCL output to the low level at point “a”, the bus’s SCL pin goes to the low level. After detecting this, master B resets a counter of high-level width of an own clock pulse and sets the internal SCL output the low level.

Master A finishes counting low-level width of an own clock pulse at point “b” and sets the internal SCL output to the high level. Since master B is holding the bus’s SCL pin the low level, master A waits for counting high-level width of an own clock pulse. After master B has finished counting low-level width of an own clock pulse at point “c” and master A detects the SCL pin of the bus at the high level, and starts counting high level of an own clock pulse.

The clock pulse on the bus is determined by the master device with the shortest high-level width and the master device with the longest low-level width from among those master devices connected to the bus.

(4) Slave address and address recognition mode specification

When this device is to be used as a slave device, set the slave address <SA6:0> and <ALS> in I2C0AR.

Clear the <ALS> to “0” for the address recognition mode.

(5) Master/slave selection

To operate this device as a master device set the SBI0CR2<MST> to “1”.

To operate it as a slave device clear the SBI0CR2<MST> to “0”. The <MST> is cleared to “0” in hardware when a stop condition is detected on the bus or when arbitration is lost.

(6) Transmitter/receiver selection

To operate this device as a transmitter set the SBI0CR2<TRX> to "1". To operate it as a receiver clear the SBI0CR2<TRX> to "0".

When data with an addressing format is transferred in the slave mode, when a slave address with the same value that an I2C0AR or a GENERAL CALL is received (All 8-bit data are "0" after a start condition), the <TRX> is set to "1" in hardware if the direction bit ($R/\overline{W}$) sent from the master device is "1", and is cleared to "0" in hardware if the bit is "0".

In the master mode, when an acknowledge signal is returned from the slave device, the <TRX> is cleared to "0" in hardware if the value of the transmitted direction bit is "1", and is set to "1" in hardware if the value of the bit is "0". If an acknowledge signal is not returned, the current state is maintained.

The <TRX> is cleared to "0" in hardware when a stop condition is detected on the I²C bus or when arbitration is lost.

(7) Start/stop condition generation

When the SBI0SR<BB> = "0", slave address and direction bit which are set to SBI0DBR is output on the bus after generating a start condition by writing "1111" to the SBI0CR2<MST, TRX, BB, PIN>. It is necessary to set transmitted data to the data buffer register (SBI0DBR) and set "1" to the <ACK> beforehand.

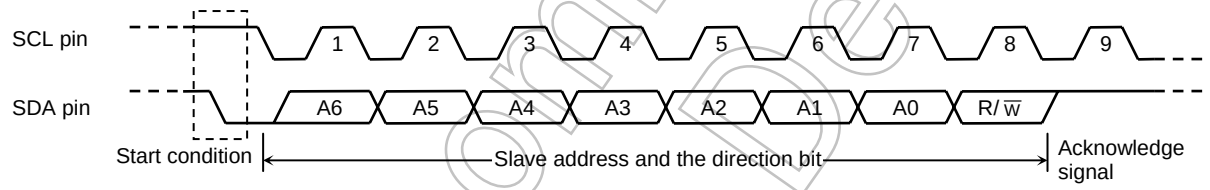


Figure 3.10.9 Start Condition Generation and Slave Address Generation

When the SBI0SR<BB> = "1", the sequence for generating a stop condition can be initiated by writing "111" to the SBI0CR2<MST, TRX, PIN> and writing "0" to the SBI0CR2<BB>. Do not modify the contents of the SBI0CR2<MST, TRX, BB, PIN> until a stop condition has been generated on the bus.

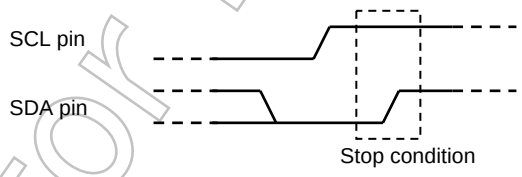


Figure 3.10.10 Stop Condition Generation

The state of the bus can be ascertained by reading the contents of the SBI0SR<BB>. The SBI0SR<BB> will be set to "1" if a start condition has been detected on the bus, and will be cleared to "0" if a stop condition has been detected.

Stop condition generation in master mode have limit. Therefore, please refer to 3.10.6 (4) "Stop condition generation".

(8) Interrupt service requests and interrupt cancellation

When a serial bus interface interrupt request 0 by transfer of the slave address or the data (INTSBI) is generated, the SBI0SR<PIN> is cleared to "0". The SCL pin is pulled down to the low-level while the <PIN> = "0".

The <PIN> is cleared to "0" when a single word of data is transmitted or received. Either writing data to or reading data from SBI0DBR sets the <PIN> to "1".

The time from the <PIN> being set to "1" until the release of the SCL pin is t_{LOW}.

In the address recognition mode (e.g., when <ALS> = "0"), the <PIN> is cleared to "0" when the slave address matches the value set in I2C0AR or when a GENERAL CALL is received (All 8-bit data are "0" after a start condition). Although the SBI0CR2<PIN> can be set to "1" by a program, writing "0" to the SBI0CR2<PIN> does not clear it to "0".

(9) Serial bus interface operation mode selection

The SBI0CR2<SBIM1:0> is used to specify the serial bus interface operation mode.

Set the SBI0CR2<SBIM1:0> to "10" when the device is to be used in I²C bus mode after confirming pin condition of serial bus interface to "H".

Switch a mode to port after confirming a bus is free.

(10) Arbitration lost detection monitor

Since more than one master device can exist simultaneously on the bus in I²C bus mode, a bus arbitration procedure has been implemented in order to guarantee the integrity of transferred data.

Data on the SDA pin is used for I²C bus arbitration.

The following example illustrates the bus arbitration procedure when there are two master devices on the bus. Master A and master B output the same data until point "a". After master A outputs "L" and master B, "H", the SDA pin of the bus is wire-AND and the SDA pin is pulled down to the low level by master A. When the SCL pin of the bus is pulled up at point "b", the slave device reads the data on the SDA pin, that is, data in master A. Data transmitted from master B becomes invalid. The master B state is known as "ARBITRATION LOST". Master B device which loses arbitration releases the internal SDA output in order not to affect data transmitted from other masters with arbitration. When more than one master sends the same data at the first word, arbitration occurs continuously after the second word.

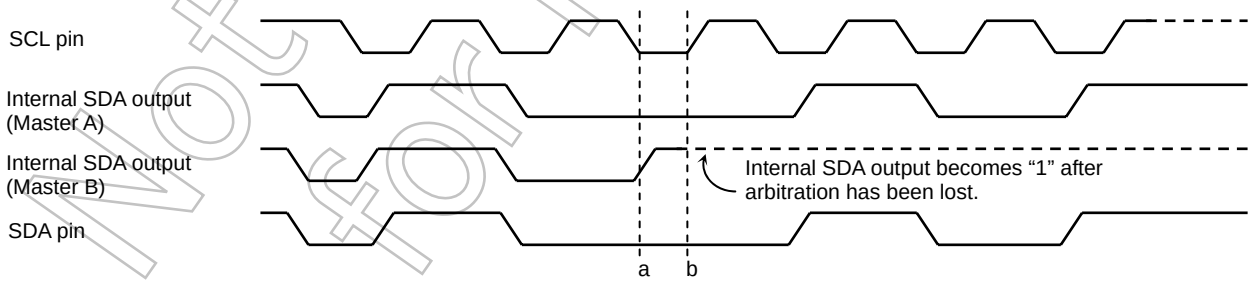


Figure 3.10.11 Arbitration Lost

This device compares the levels on the bus's SDA pin with those of the internal SDA output on the rising edge of the SCL pin. If the levels do not match, arbitration is lost and the SBI0SR<AL> is set to "1".

When the <AL> is set to "1", the SBI0SR<MST, TRX> are cleared to "00" and the mode is switched to a slave receiver mode. Thus, clock output is stopped in data transfer after setting <AL> = "1".

The <AL> is cleared to "0" when data is written to or read from SBI0DBR or when data is written to SBI0CR2.

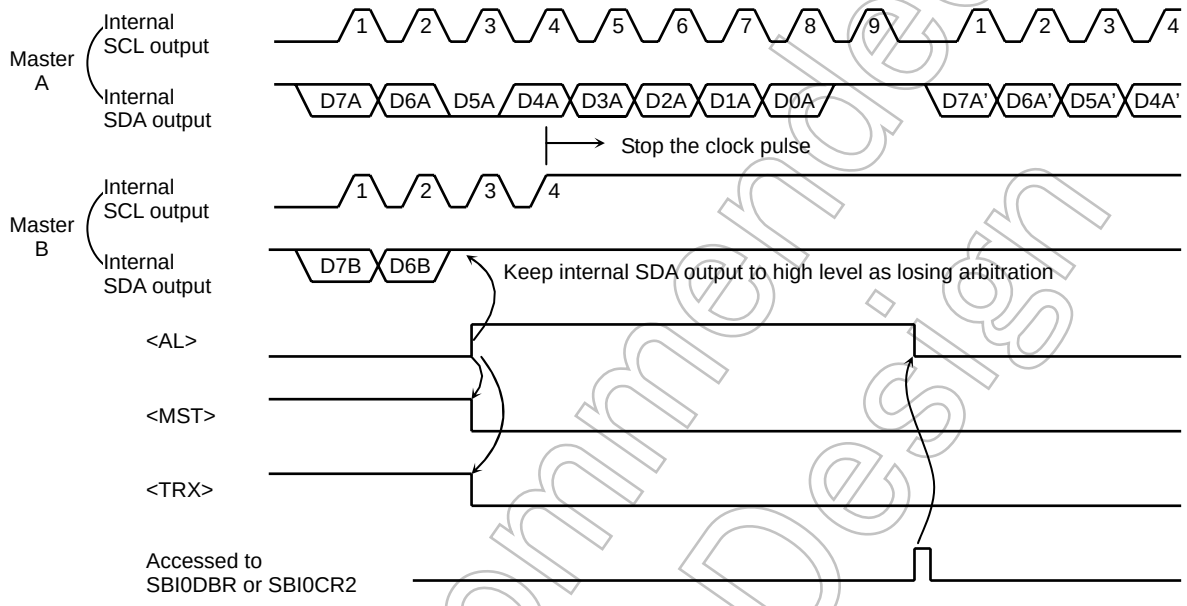


Figure 3.10.12 Example of a Master Device B (D7A = D7B, D6A = D6B)

(11) Slave address match detection monitor

The SBI0SR<AAS> is set to "1" in the slave mode, in the address recognition mode (e.g., when the I2C0AR<ALS> = "0"), when a GENERAL CALL is received, or when a slave address matches the value set in I2C0AR. When the I2C0AR<ALS> = "1", the SBI0SR<AAS> is set to "1" after the first word of data has been received. The SBI0SR<AAS> is cleared to "0" when data is written to or read from the data buffer register SBI0DBR.

(12) GENERAL CALL detection monitor

The SBI0SR<AD0> is set to "1" in the slave mode, when a GENERAL CALL is received (all 8-bit received data is "0", after a start condition). The SBI0SR<AD0> is cleared to "0" when a start condition or stop condition is detected on the bus.

(13) Last received bit monitor

The value on the SDA pin detected on the rising edge of the SCL pin is stored in the SBI0SR<LRB>.

In the acknowledge mode, immediately after an INTSBI interrupt request has been generated, an acknowledge signal is read by reading the contents of the SBI0SR<LRB>.

(14) Software reset function

The software reset function is used to initialize the SBI circuit, when SBI is locked by external noises, etc.

An internal reset signal pulse can be generated by setting SBI0CR2<SWRST1:0> to "10" and "01". This initializes the SBI circuit internally.

All command (except SBI0CR2<SBIM1:0>) registers and status registers are initialized as well.

The SBI0CR1<SWRMON> is automatically set to "1" after the SBI circuit has been initialized.

(15) Serial bus interface data buffer register (SBI0DBR)

The received data can be read and the transferred data can be written by reading or writing the SBI0DBR.

When the start condition has been generated in the master mode, the slave address and the direction bit are set in this register.

(16) I²C bus address register (I2C0AR)

I2C0AR<SA6:0> is used to set the slave address when this device functions as a slave device.

The slave address output from the master device is recognized by setting I2C0AR<ALS> is set to "0". The data format is the addressing format. When the slave address in not recognized at the <ALS> is set to "1", the data format is the free data format.

(17) Baud rate register (SBI0BR1)

Write "1" to the SBI0BR1<P4EN> before operation commences.

(18) Setting register for IDLE2 mode operation (SBI0BR0)

The setting of SBI0BR0<I2SBI0> determines whether the device is operating or is stopped in IDLE2 mode.

Therefore, setting <I2SBI0> is necessary before the HALT instruction is executed.

3.10.6 Data Transfer in I^2C Bus Mode

(1) Device initialization

Set the SBI0BR1<P4EN> and the SBI0CR1<ACK, SCK2:0>. Set the SBI0BR1<P4EN> to "1" and clear bits 7 to 5 and 3 of the SBI0CR1 to "0".

Set a slave address in I2C0AR<SA6:0> and the I2C0AR<ALS> (<ALS> = "0" when an addressing format.)

For specifying the default setting to a slave receiver mode, clear "000" to the <MST, TRX, BB>, set "1" to the <PIN>, set "10" to the <SBIM1:0> and set "00" to the <SWRST1:0>.

(2) Start condition and slave address generation

1. Master mode

In the master mode the start condition and the slave address are generated as follows.

Check a bus free status (when <BB> = "0").

Set the SBI0CR1<ACK> to "1" (Acknowledge mode) and specify a slave address and a direction bit to be transmitted to the SBI0DBR.

When the <BB> is "0", the start condition is generated by writing "1111" to the SBI0CR2<MST, TRX, BB, PIN>. Subsequently to the start condition, 9 clocks are output from the SCL pin. While 8 clocks are output, the slave address and the direction bit which are set to the SBI0DBR. At the 9th clock pulse the SDA pin is released and the acknowledge signal is received from the slave device.

An INTSBI interrupt request occurs on the falling edge of the 9th clock pulse. The <PIN> is cleared to "0". In the master mode the SCL pin is pulled down to the low level while the <PIN> is "0". When an INTSBI interrupt request occurs, the value of <TRX> is changed according to the direction bit setting only if the slave device returns an acknowledge signal.

2. Slave mode

In the slave mode, the start condition and the slave address are received.

After the start condition is received from the master device, while 8 clocks are output from the SCL pin, the slave address and the direction bit which are output from the master device are received.

When a GENERAL CALL or the same address as the slave address set in I2C0AR is received, the SDA line is pulled down to the low level at the 9th clock, and the low level at the 9th clock, and the acknowledge signal is output.

An INTSBI interrupt request occurs on the falling edge of the 9th clock. The <PIN> is cleared to "0". In slave mode the SCL line is pulled down to the low-level while the <PIN> = "0".

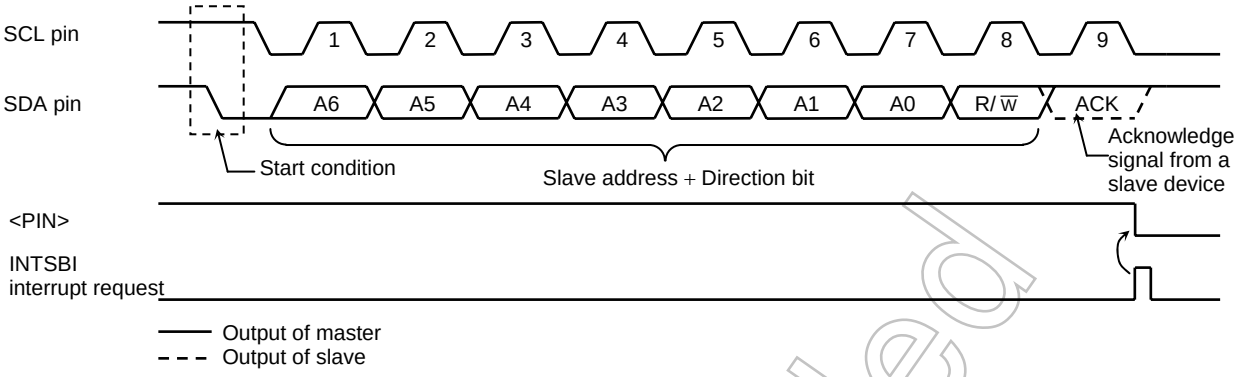


Figure 3.10.13 Start Condition Generation and Slave Address Transfer

(3) 1-word data transfer

Check the <MST> setting using an INTSBI interrupt process after the transfer of each word of data is completed and determine whether the device is in the master mode or the slave mode.

1. When the <MST> is "1" (Master mode)

Check the <TRX> setting and determine whether the device is in the transmitter mode or the receiver mode.

When the <TRX> is "1" (Transmitter mode)

Check the <LRB> setting. When the <LRB> = "1", there is no receiver requesting data. Implement the process for generating a stop condition (See section 3.10.6 (4).) and terminate data transfer.

When the <LRB> = "0", the receiver is requesting new data. When the next transmitted data is 8 bits, write the transmitted data to the SBI0DBR. When the next transmitted data is other than 8 bits, set the <BC2:0>, set the <ACK> to "1" and write the transmitted data to the SBI0DBR. After the data has been written, the <PIN> is set to "1", a serial clock pulse is generated to trigger transfer of the next word of data via the SCL pin, and the word is transmitted. After the data has been transmitted, an INTSBI interrupt request is generated. The <PIN> is set to "0" and the SCL pin is pulled down to the low level. If the length of the data to be transferred is greater than one word, repeat the latter steps of the procedure, starting from the check of the <LRB> setting.

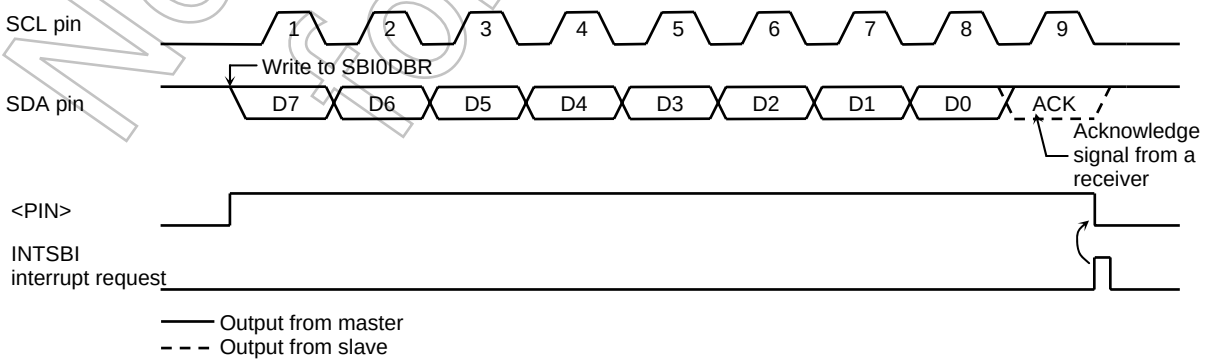


Figure 3.10.14 Example in which <BC2:0> = "000" and <ACK> = "1" in Transmitter Mode

When the <TRX> is "0" (Receiver mode)

When the next transmitted data is other than 8 bits, set the <BC2:0> again. Set the <ACK> to "1" and read the received data from the SBI0DBR so as to release the SCL pin. (The value of data which is read immediately after a slave address is sent is undefined.) After the data has been read, the <PIN> is set to "1". Serial clock pulse for transferring new 1 word of data is defined SCL and outputs "L" level from SDA pin with acknowledge timing.

An INTSBI interrupt request is generated and the <PIN> is set to "0". Then this device pulls down the SCL pin to the low level. This device outputs a clock pulse for 1 word of data transfer and the acknowledge signal each time that received data is read from SBI0DBR.

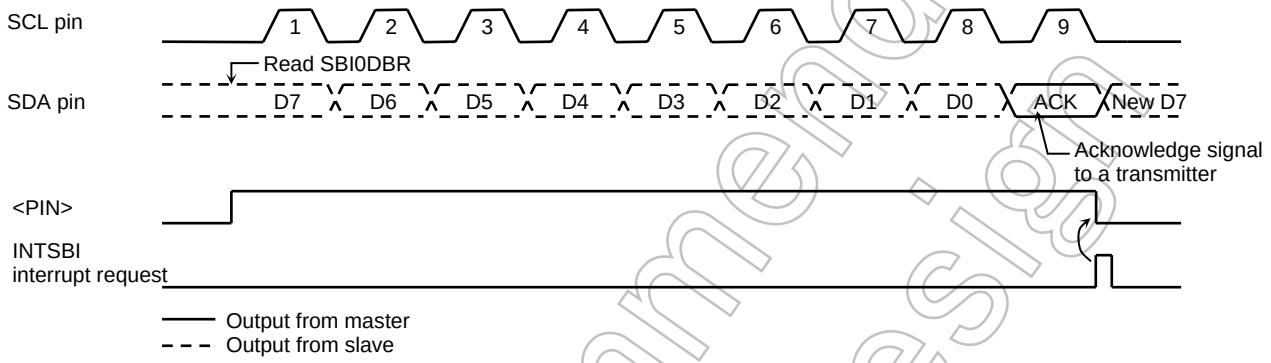


Figure 3.10.15 Example of when <BC2:0> = "000", <ACK> = "1" in Receiver Mode

In order to terminate the transmission of data to a transmitter, clear the <ACK> to "0" before reading data which is 1 word before the last data to be received. The last data does not generate a clock pulse for the acknowledge signal. After the data has been transmitted and an interrupt request has been generated, set the <BC2:0> to "001" and read the data. This device generates a clock pulse for a 1-bit data transfer. Since the master device is a receiver, the SDA pin on a bus keeps the high level. The transmitter receives the high-level signal as an ACK signal. The receiver indicates to the transmitter that data transfer is complete.

After 1-bit data is received and an interrupt request has occurred, this device generates a stop condition (See section 3.10.6 (4).) and terminates data transfer.

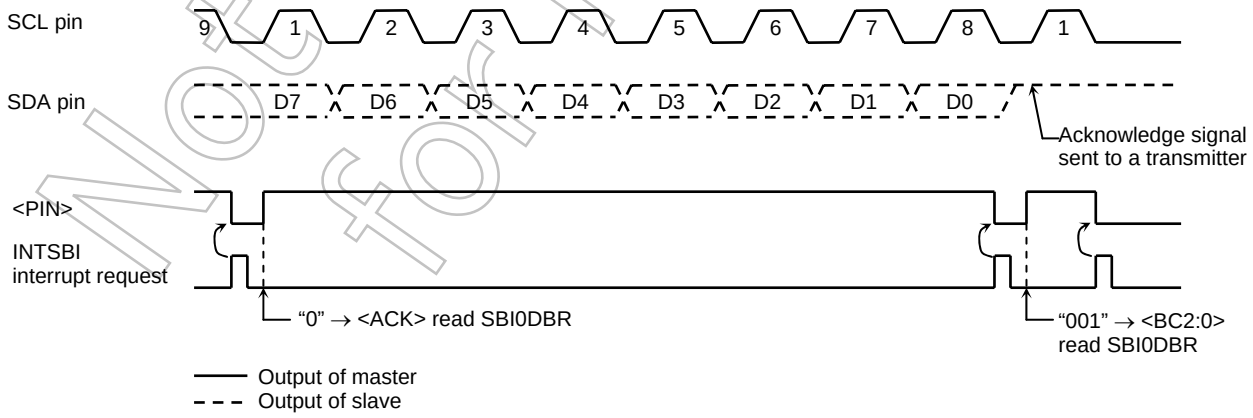


Figure 3.10.16 Termination of Data Transfer in Master Receiver Mode

2. When the <MST> is “0” (Slave mode)

In the slave mode, this device operates either in normal slave mode or in slave mode after losing arbitration.

In the slave mode, an INTSBI interrupt request occurs when this device receives a slave address or a GENERAL CALL from the master device, or when a GENERAL CALL is received and data transfer is complete, or after matching a received slave address. In the master mode, this device operates in a slave mode if it is losing arbitration. An INTSBI interrupt request occurs when word data transfer terminates after losing arbitration. When an INTSBI interrupt request occurs, the <PIN> is cleared to “0”, and the SCL pin is pulled down to the low level. Either reading data to or writing data from the SBI0DBR, or setting the <PIN> to “1” releases the SCL pin after taking t_{LOW} time.

Check the SBI0SR<AL>, <TRX>, <AAS>, and <AD0> and implements processes according to conditions listed in the next table.

Table 3.10.1 Operation in the Slave Mode

<TRX>	<AL>	<AAS>	<AD0>	Conditions	Process
1	1	1	0	This device loses arbitration when transmitting a slave address and receives a slave address of which the value of the direction bit sent from another master is “1”.	Set the number of bits in 1 word to the <BC2:0> and write the transmitted data to the SBI0DBR.
	0	1	0	In the slave receiver mode, this device receives a slave address of which the value of the direction bit sent from the master is “1”.	
		0	0	In the slave transmitter mode, 1-word data is transmitted.	Check the <LRB>. If the <LRB> is set to “1”, set the <PIN> to “1” since the receiver does not request the next data. Then, clear the <TRX> to “0” to release the bus. If the <LRB> is cleared to “0”, set the number of bits in a word to the <BC2:0> and write transmitted data to the SBI0DBR since the receiver requests next data.
0	1	1	1/0	This device loses arbitration when transmitting a slave address and receives a GENERAL CALL or slave address of which the value of the direction bit sent from another master is “0”.	Read the SBI0DBR for setting the <PIN> to “1” (Reading dummy data) or set the <PIN> to “1”.
		0	0	This device loses arbitration when transmitting a slave address or data and terminates transferring word data.	
	0	1	1/0	In the slave receiver mode, this device receives a GENERAL CALL or slave address of which the value of the direction bit sent from the master is “0”.	
		0	1/0	In the slave receiver mode, the device terminates receiving 1-word data.	Set the number of bits in a word to the <BC2:0> and read received data from the SBI0DBR.

(4) Stop condition generation

When the SBI0SR<BB> is "1", the sequence for generating a stop condition is started by writing "111" to SBI0CR2<MST, TRX, PIN> and "0" to SBI0CR2<BB>. Do not modify the contents of SBI0CR2<MST, TRX, PIN, BB> until a stop condition is generated on a bus.

When the bus's SCL line has been pulled down by other devices, this device generates a stop condition when the other device has released the SCL line and the SDA pin rising.

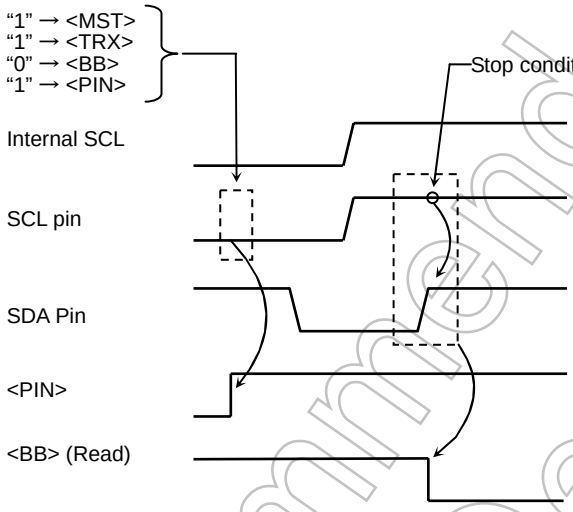


Figure 3.10.17 Stop Condition Generation (Single master)

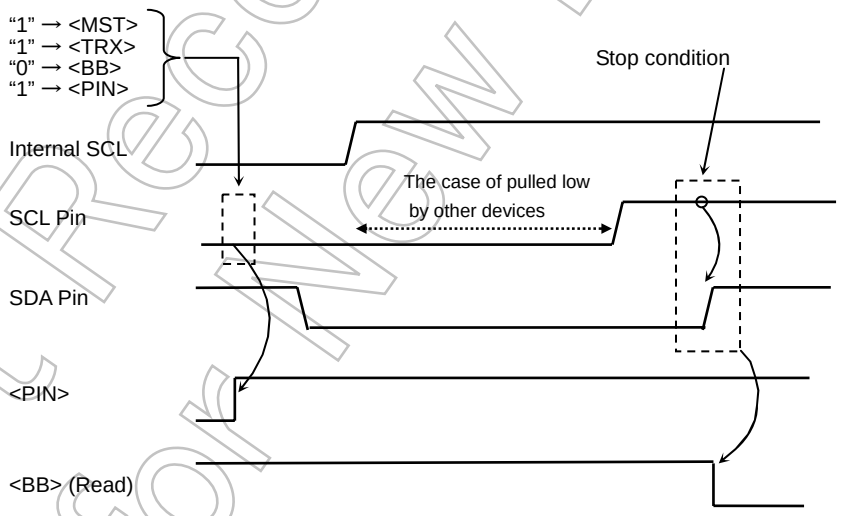


Figure 3.10.18 Stop Condition Generation (Multi master)

(5) Restart

Restart is used during data transfer between a master device and a slave device to change the data transfer direction. The following description explains how to restart when this device is in the master mode.

Clear the SBI0CR2<MST, TRX, BB> to "000" and set the SBI0CR2<PIN> to "1" to release the bus. The SDA line remains the high level and the SCL pin is released. Since a stop condition is not generated on the bus, other devices assume the bus to be in a busy state. Check the SBI0SR<BB> until it becomes "0" to check that the SCL pin of this device is released. Check the <LRB> until it becomes 1 to check that the SCL line on a bus is not pulled down to the low level by other devices. After confirming that the bus stays in a free state, generate a start condition with procedure described in 3.10.6 (2).

In order to meet setup time when restarting, take at least 4.7 μs of waiting time by software from the time of restarting to confirm that the bus is free until the time to generate the start condition.

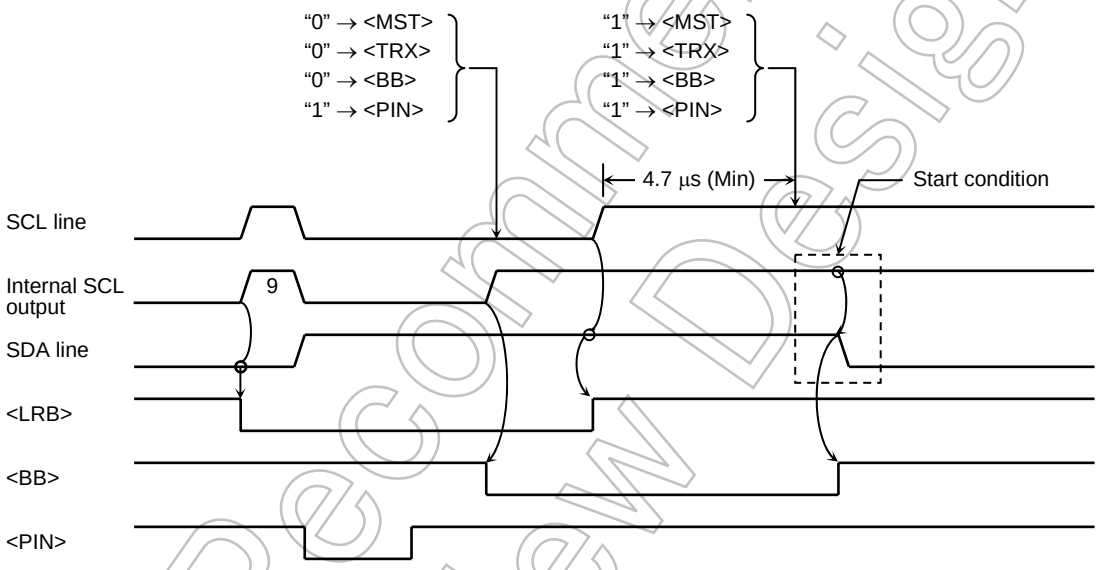


Figure 3.10.19 Timing Diagram when Restarting

3.11 SPIC (SPI Controller)

SPIC is the controller that can be connected to SD card, MMC (Multi Media Card) etc. in SPI mode.

The features as follows.

Double buffer (Transmit/Receive)

Generate CRC7 and CRC16 (Transmit/Receive data)

Baud Rate : 20Mbps max and 400Kbps min

Connect several SD cards and MMC.(Use other output port for $\overline{SPCS}$ pin as $\overline{CS}$)

Use as general clock synchronous SIO

MSB/LSB-first, 8/16bit data length, clock Rising/Falling edge

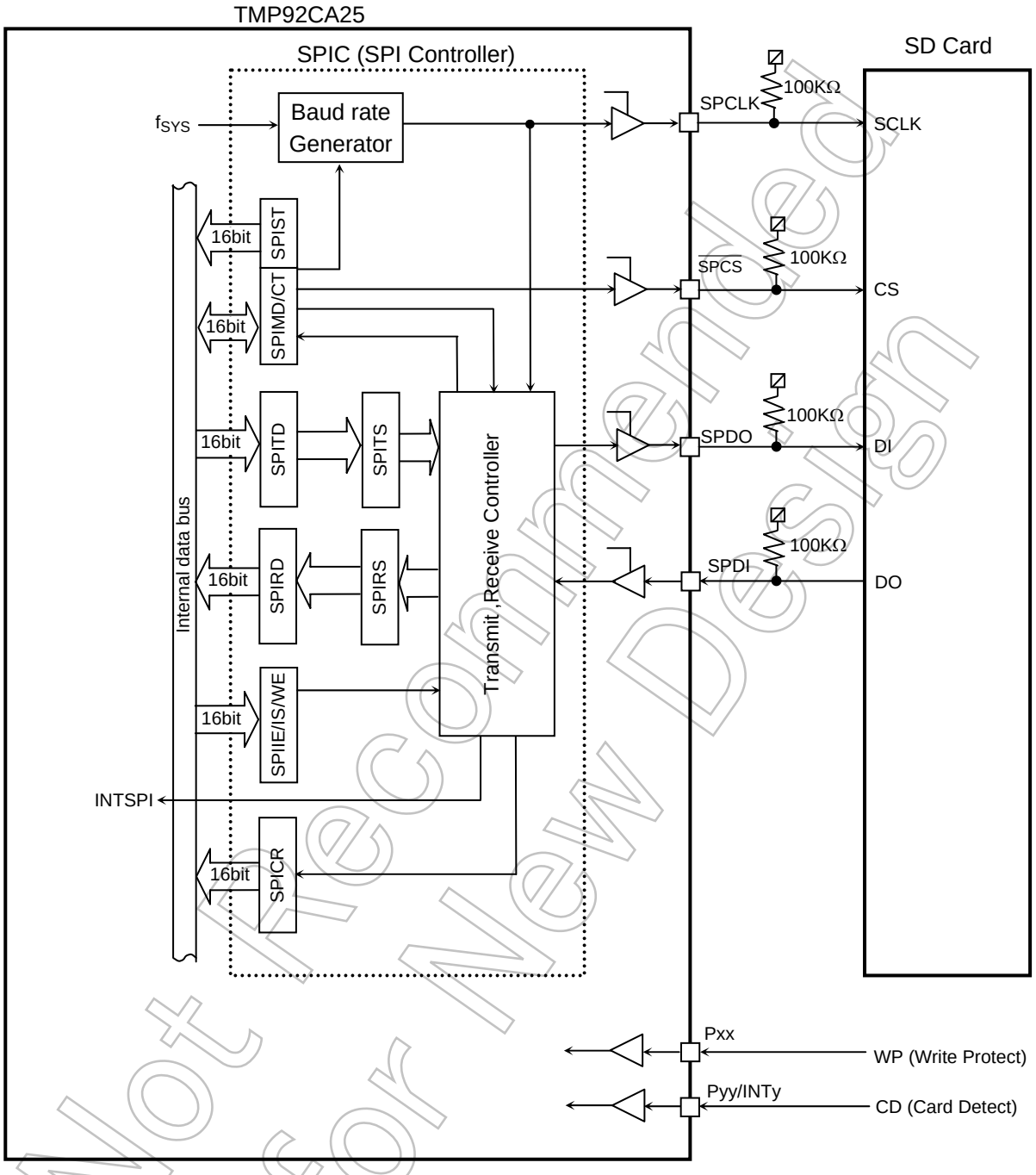
1 Interrupt : INTSPI

Read, Mask, Clear interrupt and Clear enable can control each 4 interrupts: RFR (Receive buffer of SPIRD: Full), RFW (Transmission buffer of SPITD: Empty), REND (Receive buffer of SPIRS: Full), TEND (Transmission buffer of SPITS: Empty).

RFR, RFW can high-speed transaction by micro DMA.

3.11.1 Block diagram

It shows block diagram and connection to SD card in Figure 3.11.1



Note1: SPCLK, $\overline{\text{SPCS}}$, SPDO and SPDI pins are set to input port (Port K7, K6, K5, K4) by reset. These signals are needed pull-up resister to fix voltage level, could you adjust resistance value for your final set.

Note2: Please use general input port or interrupt signal for WP (Write Protect) and CD (Card Detect).

Figure 3.11.1 SPIC Block diagram and Connection example

3.11.2 SFR

SFR of SPIC are as follows. These are connected to CPU with 16bit data bus.

(1) SPIMD (SPI Mode setting register)

SPIMD register is for operation mode or clock etc.

SPIMD Register

		7	6	5	4	3	2	1	0
SPIMD (0820H)	bit Symbol		XEN				CLKSEL2	CLKSEL1	CLKSEL0
	Read/Write		R/W				R/W		
	After Reset		0				1	0	0
	Function		SYSCK 0: disable 1: enable				Select baud rate 000:f_{SYS} 100: f_{SYS}/16 001: f_{SYS}/2 101: f_{SYS}/32 010: f_{SYS}/4 111: f_{SYS}/64 011: f_{SYS}/8 111:Reserved		
		15	14	13	12	11	10	9	8
(0821H)	bit Symbol	LOOPBACK	MSB1ST	DOSTAT		TCPOL	RCPOL	TDINV	RDINV
	Read/Write	R/W				R/W			
	After Reset	0	1	1		0	0	0	0
	Function	LOOPBACK test mode 0:disbale 1:enable	Start bit for transmit/receive 0:LSB 1:MSB	SPDO pin (no transmit) 0:fixed to "0" 1:fixed to "1"		Synchronous clock edge during transmitting 0: fall 1: rise	Synchronous clock edge during receiving 0: fall 1: rise	Invert data During transmitting 0: disable 1: enable	Invert data During receiving 0: disable 1: enable

Figure 3.11.2 SPIMD Register

(a) <LOOPBACK>

Because Internal SPDO can be input to internal SPDI, it can be used as test. Set <XEN>=1 and <LOOPBACK>=1, outputs clock from SPCLK pin regardless of operation of transmit/receive.

Please change the setting when transmitting/receiving is not in operation.

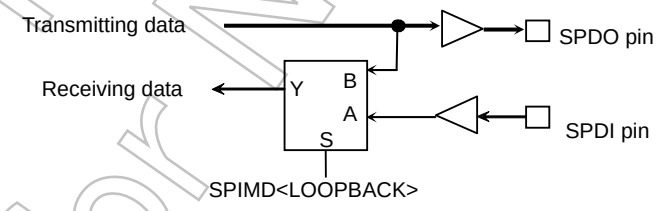


Figure 3.11.3 <LOOPBACK> Register Function

(b) <MSB1ST>

Select the start bit of transmit/receive data

Please change the setting when transmitting/receiving is not in operation.

(c) <DOSTAT>

Set the status of SPDO pin during no transmitting (after transmitting or during receiving).

Please change the setting when transmitting/receiving is not in operation.

(d) <TCPOL>

Select the edge of synchronous clock during transmitting.
Please change the setting during <XEN> = "0". And set the same value of <RCPOL>.

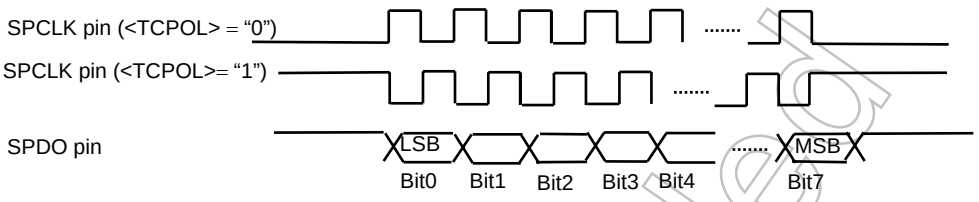


Figure 3.11.4 <TCPOL> Register function

(e) <RCPOL>

Select the edge of synchronous clock during receiving.
Please change the setting during <XEN>= "0". And set the same value of <TCPOL>.

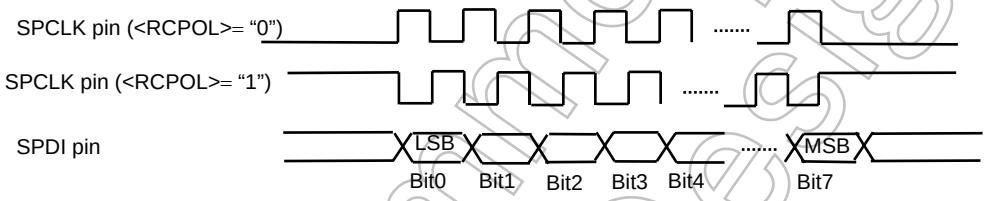


Figure 3.11.5 <TCPOL> Register function

(f) <TDINV>

Select logical invert/no invert when output transmitted data from SPDO pin.
Please change the setting when transmitting/receiving is not in operation.
Data that input to CRC calculation circuit is transmission data that is written to SPITD. This input data is not corresponded to <TDINV>.
<TDINV> is not corresponded to <DOSTAT>: it set condition of SPDO pin when it is not transferred.

(g) <RDINV>

Select logical invert/no invert for received data from SPDI pin.
Please change the setting when transmitting/receiving is not in operation.
Data that input to CRC calculation circuit is selected by <RDINV>.

(h) <XEN>

Select the operation for the internal clock.

(i) <CLKSEL2:0>

Select baud rate. Baud rate is created from f_{SYS} and settings are in under table. Please change the setting when transmitting/receiving is not in operation.

Table 3.11.1 Example of baud rate

<CLKSEL2:0>	Baud rate [Mbps]		
	f_{SYS} =12MHz	f_{SYS} =16MHz	f_{SYS} =20MHz
f_{SYS}	12	16	20
$f_{SYS}/2$	6	8	10
$f_{SYS}/4$	3	4	5
$f_{SYS}/8$	1.5	2	2.5
$f_{SYS}/16$	0.75	1	1.25
$f_{SYS}/32$	0.375	0.5	0.625
$f_{SYS}/64$	0.1875	0.25	0.3125

(2) SPICT(SPI Control Register)

SPICT register is for data length or CRC etc.

SPICT Register

		7	6	5	4	3	2	1	0
SPICT (0822H)	bit Symbol	CEN	SPCS_B	UNIT16			ALGNEN	RXWEN	RXUEN
	Read/Write	R/W					R/W		
	After Reset	0	1	0			0	0	0
	Function	communication control 0: disable 1: enable	$\overline{SPCS}$ pin 0: output "0" 1: output "1"	Data length 0: 8bit 1: 16bit			Full duplex alignment 0: disable 1: enable	Sequential receive 0: disable 1: enable	Receive UNIT 0: disable 1: enable
		15	14	13	12	11	10	9	8
(0822H)	bit Symbol	CRC16_7_B	CRCRX_TX_B	CRCRESET_B				DMAERFW	DMAERFR
	Read/Write	R/W						R/W	
	After Reset	0	0	0				0	0
	Function	CRC select 0: CRC7 1: CRC16	CRC data 0: Transmit 1: Receive	CRC calculate register 0:Reset 1:Release Reset				Micro DMA 0: Disable 1: Enable	Micro DMA 0: Disable 1: Enable

Figure 3.11.6 SPICT Register

(a) <CRC16_7_B>

Select CRC7 or CRC16 to calculate.

(b) <CRCRX_TX_B>

Select input data to CRC calculation circuit.

(c) <CRCRESET_B>

Initialize CRC calculate register.

The process that calculating CRC16 of transmits data and sending CRC next to transmit data is explained as follows.

1. Set SPICT <CRC16_7_B> for select CRC7 or CRC16 and <CRCRX_TX_B> for select calculating data.
2. For reset SPICR register, write "1" after set <CRCRESET_B> to "0".
3. Write transmit data to SPITD register, and wait for finish transmission all data.
4. Read SPICR register, and obtain the result of CRC calculation.
5. Transmit CRC which is obtained in (4) by the same way as (3).

CRC calculation of receive data is the same process.

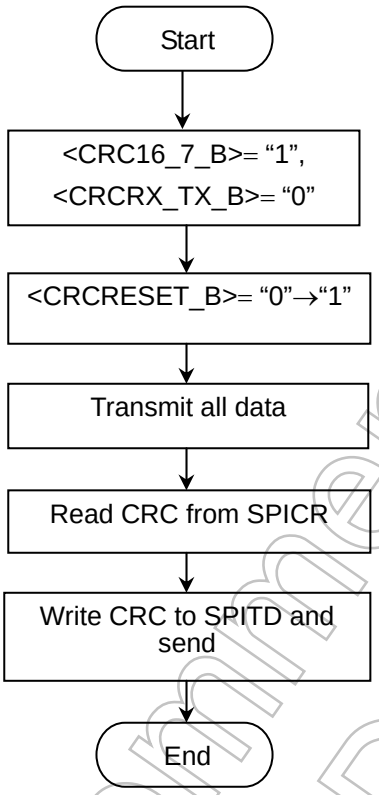


Figure 3.11.7 Flow chart of CRC calculation

(d) <DNAERFW>

Set clearing interrupt in CPU to unnecessary because be supported RFR interrupt to Micro DMA. If write "1" to, it be set to one-shot interrupt, clearing interrupt by SPIWE register become to unnecessary. SPIST<RFW> flag generate 1-shot interrupt when change from "0" to "1"(Rising).

(e) <DMAERFR>

Set clearing interrupt in CPU to unnecessary because be supported RFR interrupt to Micro DMA. If write "1" to, it be set to one-shot interrupt, clearing interrupt by SPIWE register become to unnecessary. SPIST<RFR> flag generate 1-shot interrupt when change from "0" to "1"(Rising).

(f) <CEN>

Select enable/disable of the pin for SD card or MMC. When the card isn't inserted or no-power supply to DVcc, penetrated current is flowed because SPDI pin becomes floating. In addition, current is flowed to the card because $\overline{\text{SPCS}}$, SPCLK and SPDO pin output "1". This register can avoid these matters.

If write "0" to <CEN> with PKCR and PKFC selecting $\overline{\text{SPCS}}$, SPCLK, SPDO and SPDI signal, SPDI pin is prohibit to input (avoiding penetrated current) and $\overline{\text{SPCS}}$, SPCLK, SPDO pin become high impedance.

Please write <CEN> = "1" after card is inserted, supply power to Vcc of card and supply clock to this circuit (SPIMD<XEN> = "1").

(g) <SPCS_B>

Set the value output to $\overline{\text{SPCS}}$ pin.

(h) <UNIT16>

Select the length of transmit/receive data. Data length is described as UNIT downward. Please change the setting when transmitting/receiving is not in operation.

(i) <ALGNEN>

Select whether using alignment function for transmit/receive per UNIT during full duplex.

Please change the setting when transmitting/receiving is not in operation.

(j) <RXWEN>

Set enable/disable of sequential receiving.

(k) <RXUEN>

Set enable/disable of receiving operation per UNIT. In case <RXWEN> = "1", this bit is not valid.

Please change the setting when transmitting/receiving is not in operation.

[Transmit / receive operation mode]

It is supported 8 operation modes. They are selected in <ALGNEN>, <RXWEN> and <RXUEN> registers.

Table 3.11.2 transmit/receive operation mode

Operation mode	Register setting			Note
	<ALGNEN>	<RXWEN>	<RXUEN>	
(1) Transmit UNIT	0	0	0	Transmit written data per UNIT
(2) Sequential transmit	0	0	0	Transmit written data sequentially
(3) Receive UNIT	0	0	1	Receive data of only 1 UNIT
(4) Sequential receive	0	1	0	Receive automatically if buffer has space
(5)Transmit/Receive UNIT with no alignment	0	0	1	Transmit/receive 1 UNIT at once with no alignment per each UNIT
(6) Sequential Transmit/Receive UNIT with no alignment	0	1	0	Transmit/receive sequentially at once with no alignment per each UNIT
(7) Transmit/Receive UNIT with alignment	1	0	1	Transmit/receive 1 UNIT with alignment per each UNIT
(8) Sequential Transmit/Receive UNIT with alignment	1	1	0	Transmit/receive sequentially with alignment per each UNIT

Difference between UNIT transmission and Sequential transmission

UNIT transmit mode is transmitted every 1 UNIT by writing data after confirmed SPIST<TEND>=1.The written transmission data is shifted in turn. In hard ware, transmission is kept executing as long as data exists. If it transmit data sequentially, write next data when SPITD is empty and SPIST<REND>=1.

UNIT transmission and sequential transmission depend on the way of using. Hardware doesn't depend on.

Figure 3.11.8 show Flow chart of UNIT transmission and Sequential transmission.

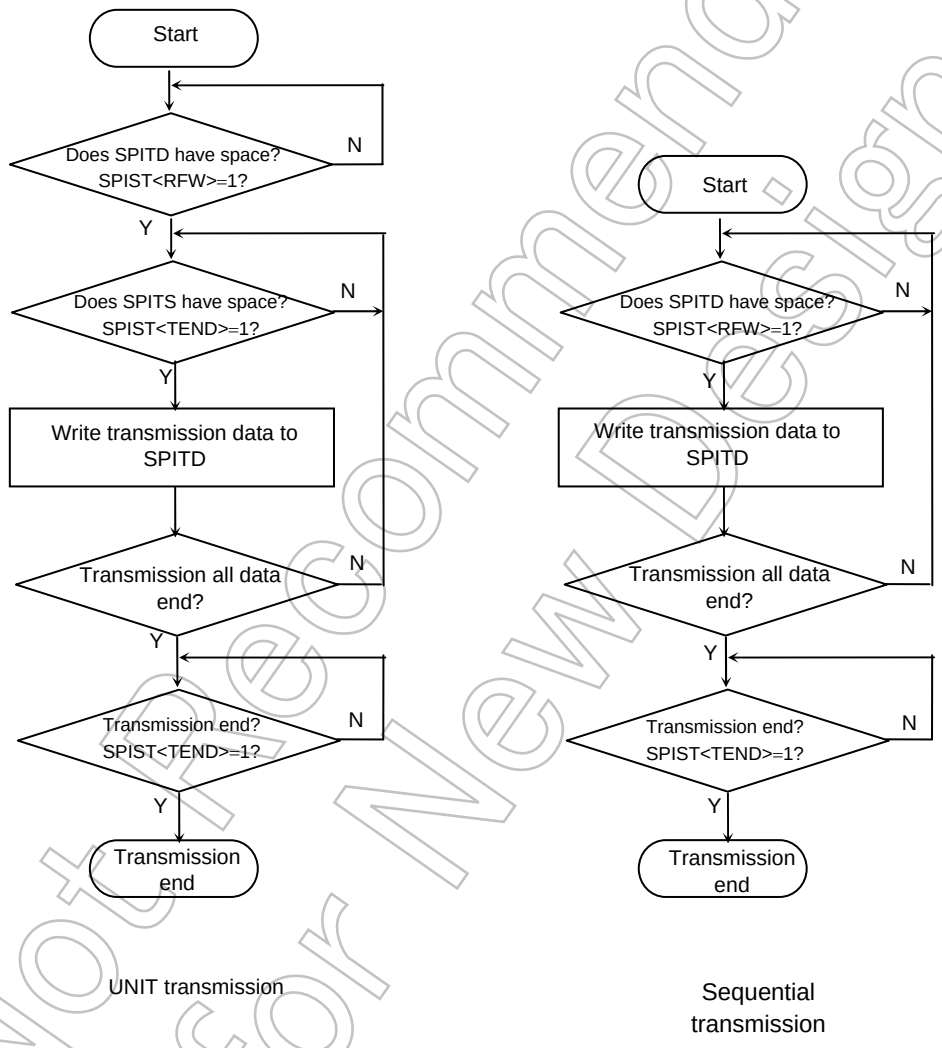


Figure 3.11.8 Flow chart of UNIT transmission and Sequential transmission

Difference between UNIT receive and Sequential receive

UNIT receive is the mode that receiving only 1 UNIT data.

By writing "1" to SPICT<RXUEN>, receives 1UNIT data, and received data is loaded in receive data register (SPIRD). When SPIRD register is read, read it after wrote "0" to SPICT<RXUEN>.

If data was read from SPIRD with the condition SPICT<RXE>= "1", 1 UNIT data is received again automatically. In hardware, this mode receives sequentially by Single buffer.

SPIST<REND> is changed during UNIT receiving.

Sequential receive is the mode that receive data and automatically when receive FIFO has space.

Whenever buffer has space, next data is received automatically. Therefore, if data was read after data is loaded in SPIRD, it is received sequentially every UNIT. In hardware, this mode receives sequentially by double buffer.

Figure 3.11.9 show Flow chart of UNIT receive and Sequential receive.

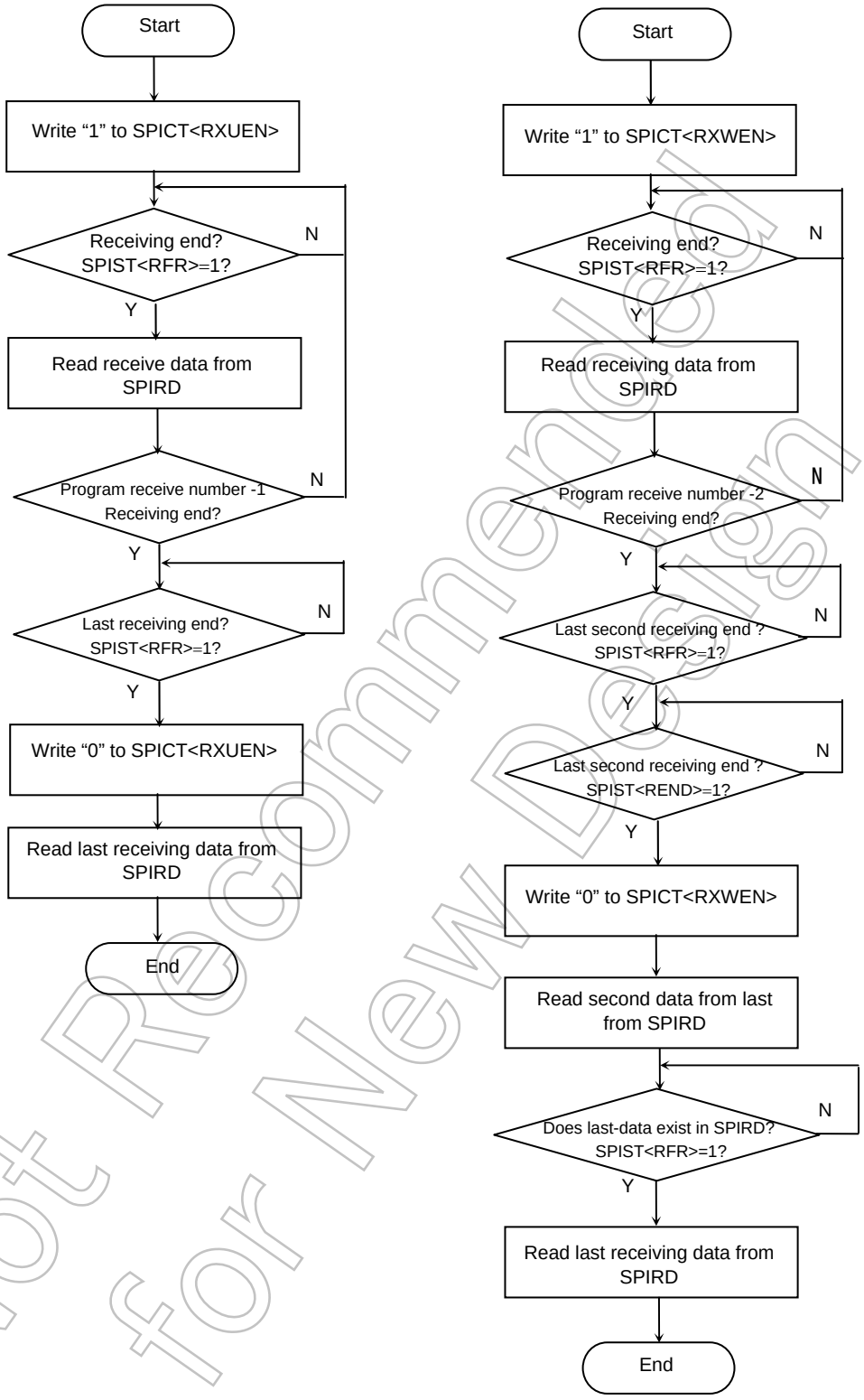
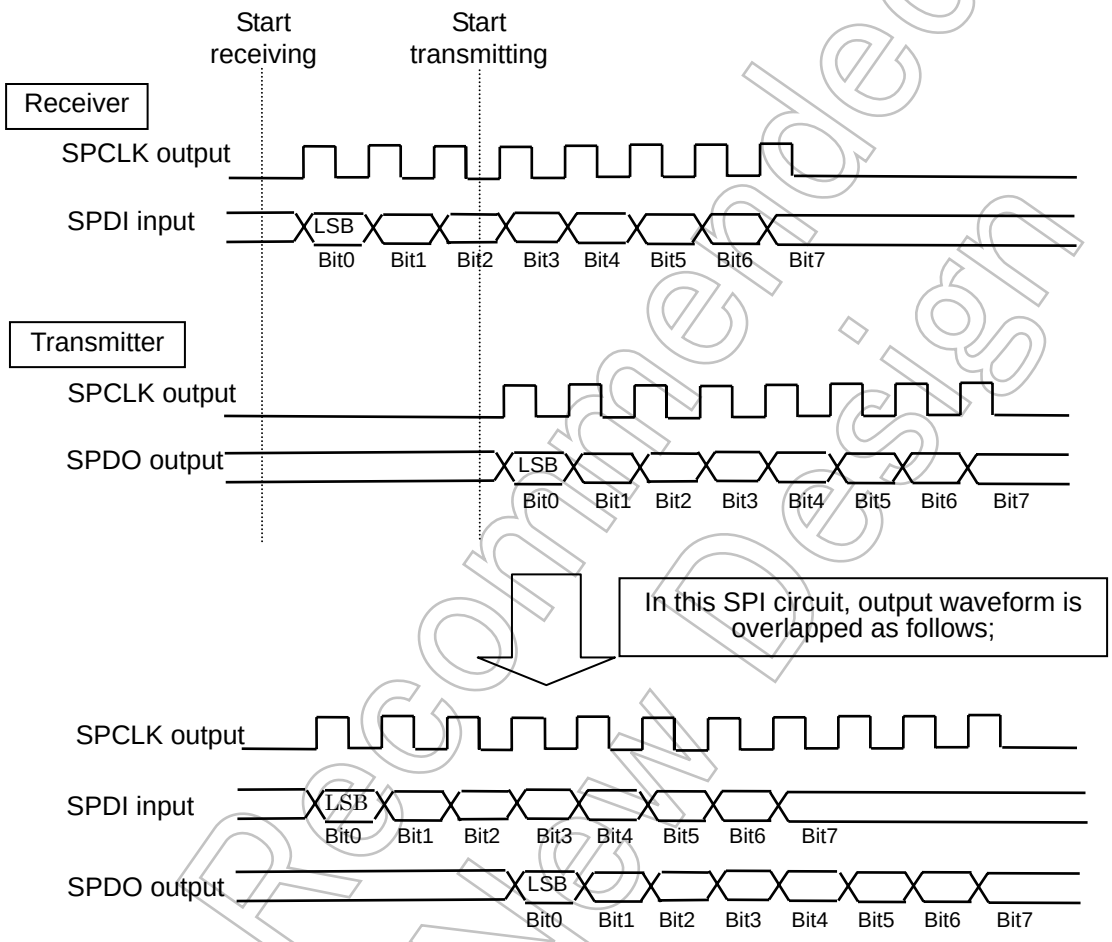


Figure 3.11.9 Flow chart of UNIT receive and Sequential receive

No alignment transmit/receive and alignment transmit/receive

In no-alignment mode, transmit/receive operate asynchronous and individually.

This is the sample waveform when starts UNIT receive by writing <RXUEN>= “1”, and then write transmit data in (SPITD) register before finishing the receiving.



Note: In no-alignment mode, clock is sometimes output from transmitter/receiver even when no data is in receiver/transmitter.

Figure 3.11.10 No-alignment transmit/receive

In alignment mode, it differs from no-alignment mode in transmit/receive is synchronous every UNIT though it is identical in transmit and receive operate simultaneously.

Writing <ALGNEN>= “1” first, and SPICT<RXE>= “1” and keep waiting state for starting UNIT receiving. When writing SPICT<RXE>= “1” after <ALGNEN>= “1”, receiving does not start right away. This is because the data to transmit at the same time has not been prepared. Transmit/receive start when writing the data to (SPITD) register with the condition <TXE>= “1”.

The waveform of each transmit/receive operation is as follows;

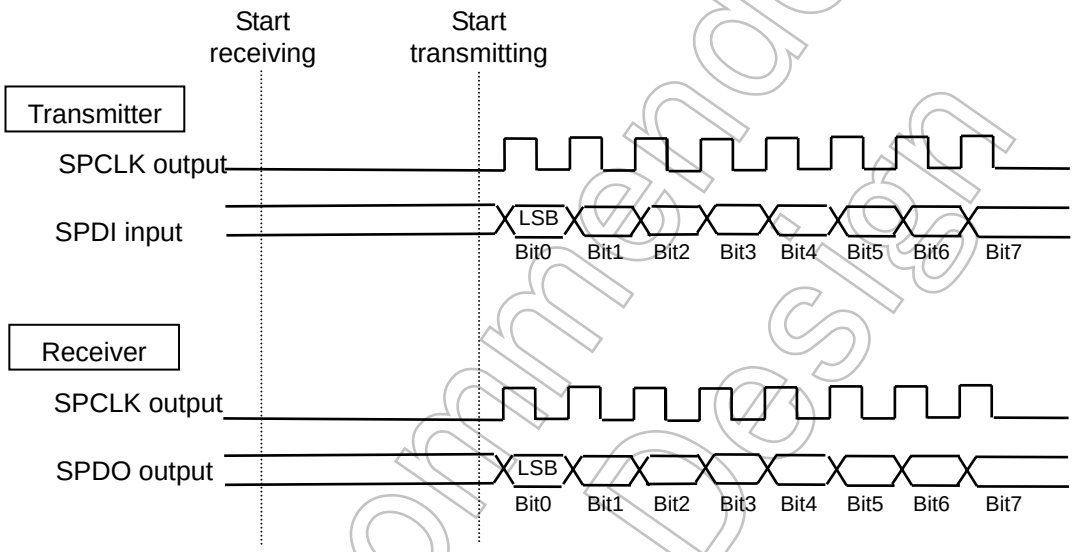


Figure 3.11.11 Alignment transmit/receive

(3) Interrupt , Status register

Read of condition, Mask of condition, Clear interrupt and Clear enable can control each 4 interrupts; RFR (SPIRD receiving buffer is full), RFW (SPITD transmission buffer is empty), REND (SPIRS receiving buffer is full), TEND (SPITS transmission buffer is empty).

RFR, RFW can high-speed transaction by micro DMA.

Following is description of Interrupt・status (example RFW).

Status register SPIST<RFW> show RFW (internal signal that show whether transmission data register exist or not). This register is "0" when transmission data exist. This register is "1" when transmission data doesn't exist. It can read internal signal directly. Therefore, it can confirm transmission data at any time.

Interrupt status register SPIIS<RFWIS> is set by rising edge of RFW. This register keeps that condition until write "1" to this register and reset when SPIWE<RFWWE> is "1".

RFW interrupt generate when interrupt enable register SPIIE<RFWIE> is "1". When it is "0", interrupt is not generated.

Interrupt request register SPIIR<RFWIR> show whether interrupt is generating or not.

Interrupt status write enable register SPIWE<RFWWE> set that enables reset for reset interrupts status register by mistake.

Circuit config of transmission data shift register (SPITS), receiving register (SPIRD), receiving data shift register (SPIRS) are same with above register.

Control register SPICT<DMAERFW>, SPICT<DMAERFR> is register for using micro DMA. When micro DMA transfer is executed by using RFW interrupt, set "1" to <DMAERFW>, and when it is executed by using RFR interrupt, set "1" to <DMAERFR>, and prohibit other interrupt.

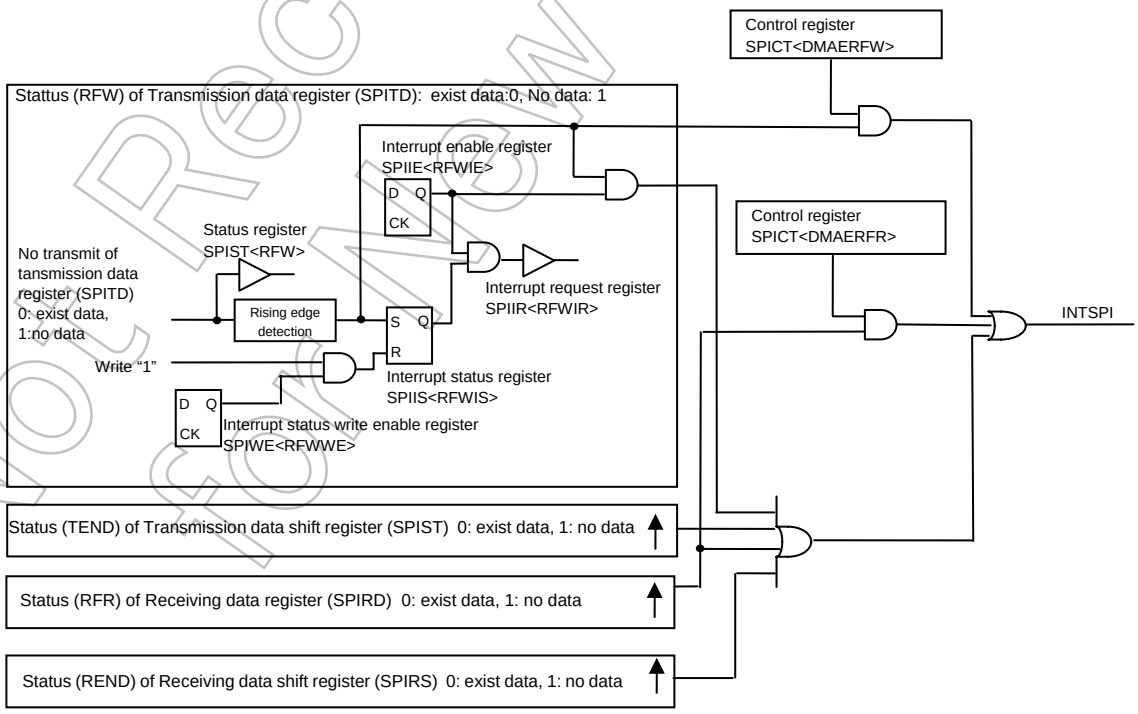


Figure 3.11.12 Figurer for interrupt, status

(3-1) SPIST(SPI status register)

SPIST shows 4 status.

SPIST Register

		7	6	5	4	3	2	1	0
SPIST (0824H)	bit Symbol					TEND	REND	RFW	RFR
	Read/Write					R			
	After Reset					1	0	1	0
	Function					Receiving 0:operation 1: no operation	Receive Shift register 0: no data 1: exist data	Transmit buffer 0: untransmitted data exist 1: no untransmitted data	Receive buffer 0:no valid data 1:valid data exist
		15	14	13	12	11	10	9	8
(0825H)	bit Symbol								
	Read/Write								
	After Reset								
	Function								

Figure 3.11.13 SPIST Register

(a) <TEND>

This bit is set to "0" when valid data to transmit exists in the shift register for transmit. It is set to "1" when finish transmitting all the data.

(b) <REND>

This bit is set to "0" when receiving is in operation or no valid data exist in receive shift register.

It is set to "1", when valid data exist in receive read register and keep the data without shifting.

It is cleared to "0", when CPU read the data and shift to receive read register.

(c) <RFW>

After wrote the received data to receive data write register, shift the data to receive data shift register. It keeps "0" until all valid data has moved. And it is set to "1" when it can accept the next data with no valid data.

(d) <RFR>

This bit is set to "1" when received data is shifted from received data shift register to received data read register and valid data exist. It is set to "0" when the data is read and no valid data.

(3-2) SPIIS(SPI interrupt status register)

SPIIS register read 4 interrupt status and clear interrupt.

This register is cleared to "0" by writing "1" to applicable bit. Status of this register show interrupt source state. This register can confirm changing of interrupt condition, even if SPI interrupt enable register (SPIIE) is masked.

SPIIS Register

		7	6	5	4	3	2	1	0
SPIIS (0828H)	bit Symbol					TENDIS	RENDIS	RFWIS	RFRIS
	Read/Write					R/W			
	After Reset					0	0	0	0
	Function					Read 0:no interrupt 1:interrupt Write 0:Don't care 1:clear	Read 0:no interrupt 1:interrupt Write 0:Don't care 1:clear	Read 0:no interrupt 1:interrupt Write 0:Don't care 1:clear	Read 0:nointerrupt 1:interrupt Write 0:Don't care 1:clear
		15	14	13	12	11	10	9	8
(0829H)	bit Symbol								
	Read/Write								
	After Reset								
	Function								

Figure 3.11.14 SPIIS Register

(a) <TENDIS>

This bit read status of TEND interrupt and clear interrupt.
If write this bit, set "1" to SPIWE<TENDWE>.

(b) <REMDIS>

This bit read status of REND interrupt and clear interrupt.
If write this bit, set "1" to SPIWE<RENDWE>.

(c) <RFWDIS>

This bit read status of RFW interrupt and clear interrupt.
If write this bit, set "1" to SPIWE<RFWWE>.

(d) <RFRIS>

This bit read status of RFR interrupt and clear interrupt.
If write this bit, set "1" to SPIWE<RFRWE>.

(3-3) SPIWE(SPI interrupt status write enable register)

SPIWE register set clear enable for 4 interrupt stasus bit.

SPIWE Register

		7	6	5	4	3	2	1	0
SPIWE (082AH)	bit Symbol					TENDWE	RENDWE	RFWWE	RFRWE
	Read/Write					R/W			
	After Reset					0	0	0	0
	Function					Clear SPIIS <TENDIS> 0: disable 1: enable	Clear SPIIS <RENDIS> 0: disable 1: enable	Clear SPIIS <TFWIS> 0: disable 1: enable	Clear SPIIS <RFRIS> 0: disable 1: enable
		15	14	13	12	11	10	9	8
(082BH)	bit Symbol								
	Read/Write								
	After Reset								
	Function								

Figure 3.11.15 SPIWE Register

(a) <TENDWE>

This bit set clear enable of SPIIS<TENDIS>.

(b) <RENDWE>

This bit set clear enable of SPIIS<RENDIS>.

(c) <RFWWE>

This bit set clear enable of SPIIS<RFWIS>.

(d) <RFRWE>

This bit set clear enable of SPIIS<RFRIS>.

(3-4) SPIIE(SPI interrupt enable register)

SPIIE register set output enable for 4 interrupt.

SPIIE Register

		7	6	5	4	3	2	1	0
SPIIE (082CH)	bit Symbol					TENDIE	RENDIE	RFWIE	RFRIE
	Read/Write					R/W			
	After Reset					0	0	0	0
	Function					TEND interrupt 0: Disable 1: Enable	REND interrupt 0: Disable 1: Enable	RFW interrupt 0: Disable 1: Enable	RFR interrupt 0: Disable 1: Enable
		15	14	13	12	11	10	9	8
(082DH)	bit Symbol								
	Read/Write								
	After Reset								
	Function								

Figure 3.11.16 SPIIE Register

(a) <TENDIE>

This bit set TEND interrupt enable.

(b) <RENDIE>

This bit set REND interrupt enable.

(c) <RFWIE>

This bit set RFW interrupt enable.

(d) <RFRIE>

This bit set RFR interrupt enable.

(3-5) SPIIR(SPI interrupt request register)

SPIIR register show generation condition for 4 interrupts.

This regiter read "0" (interrupt doesn't generate) always when SPIninterrupt enable register (SPIIE) is masled.

SPIIR Register

		7	6	5	4	3	2	1	0
SPIIR (082EH)	bit Symbol					TENDIR	RENDIR	RFWIR	RFRIR
	Read/Write					R			
	After Reset					0	0	0	0
	Function					TEND interrupt 0: none 1:generate	REND interrupt 0: none 1:generate	RFW interrupt 0: none 1:generate	RFR interrupt 0: none 1:generate
		15	14	13	12	11	10	9	8
(082FH)	bit Symbol								
	Read/Write								
	After Reset								
	Function								

Figure 3.11.17 SPIIR Register

(a) <TENDIR>

This bit shows condition of TEND interrupt generation.

(b) <TENDIR>

This bit shows condition of REND interrupt generation.

(c) <RFWIR>

This bit shows condition of RFW interrupt generation.

(d) <RFRIR>

This bit shows condition of RFR interrupt generation.

(4) SPICR (SPI CRC register)

SPICR register load result of CRC calculation for transmission/receiving in it.

SPICR register

		7	6	5	4	3	2	1	0
SPICR (0826H)	bit Symbol	CRCD7	CRCD6	CRCD5	CRCD4	CRCD3	CRCD2	CRCD1	CRCD0
	Read/Write	R							
	After reset	0	0	0	0	0	0	0	0
	Function	CRC calculation result load register [7:0]							
		15	14	13	12	11	10	9	8
(0827H)	bit Symbol	CRCD15	CRCD14	CRCD13	CRCD12	CRCD11	CRCD10	CRCD9	CRCD8
	Read/Write	R							
	After reset	0	0	0	0	0	0	0	0
	Function	CRC calculation result load register [15:8]							

Figure 3.11.18 SPICR register

(a) <CRCD15:0>

The result that is calculated according to the setting; SPICT<CRC16_7_b>, <CRCRX_TX_B> and <CRCRESET_B>, are loaded in this register.

In case CRC16, all bits are valid. In case CRC7, lower 7 bits are valid.

The flow will be showed to calculate CRC16 of received data for instance by flowchart.

Firstly, initialize CRC calculation register by writing <CRCRESET_B> = "1" after set <CRC16_7_b> = "1", <CRCRX_TX_B> = "0", <CRCRESET_B> = "0".

Next, finish transmitting all bits to calculate CRC by writing data in SPITD register.

Confirming whether receiving is finished or not use SPIST<TEND>.

If SPICR register was read after finish, CRC16 of transmission data can read.

(5) SPITD(SPI transmisson data register)

SPITD register is register for write transmission data.

SPITD Register

		7	6	5	4	3	2	1	0
SPITD (0830H)	bit Symbol	TXD7	TXD6	TXD5	TXD4	TXD3	TXD2	TXD1	TXD0
	Read/Write	R/W							
	After Reset	0	0	0	0	0	0	0	0
	Function	Transmission data register [7:0]							
		15	14	13	12	11	10	9	8
(0831H)	bit Symbol	TXD15	TXD14	TXD13	TXD12	TXD11	TXD10	TXD9	TXD8
	Read/Write	R/W							
	After Reset	0	0	0	0	0	0	0	0
	Function	Transmission data register [15:8]							

Figure 3.11.19 SPITD Register

(a) <TXD15:0>

This bit is bit for write transmission data. When read, the last written data is read.

The data is overwritten when next data was written with condition of this register does not empty. In this case, please write after checked the status of RFW.

In case SPICT<UNIT16>= “1”, all bits are valid.

In case SPICT<UNIT16>= “0”, lower 7 bits are valid.

(6) SPIRD(SPI receiving data register)

SPIRD register is register for read receiving data.

SPIRD Register

SPIRD (0832H)	7	6	5	4	3	2	1	0
bit Symbol	RXD7	RXD6	RXD5	RXD4	RXD3	RXD2	RXD1	RXD0
Read/Write	R							
After Reset	0	0	0	0	0	0	0	0
Function	Receive data register [7:0]							
(0833H)	15	14	13	12	11	10	9	8
bit Symbol	RXD15	RXD14	RXD13	RXD12	RXD11	RXD10	RXD9	RXD8
Read/Write	R							
After Reset	0	0	0	0	0	0	0	0
Function	Receive data register [15:8]							

Figure 3.11.20 SPIRD Register

(a) <RXD15:0>

SPIRD register is register for reading receiving data. Please read after checked status of RFK.

In case SPICT<UNIT16> = "1", all bits are valid.

In case SPICT<UNIT16> = "0", lower 7 bits are valid.

(7) SPITS (SPI receiving data shift register)

SPITS register change transmission data to serial. This register is used for confirming changing condition when LSI test.

SPITS Register

		7	6	5	4	3	2	1	0
SPITS (0834H)	bit Symbol	TSD7	TSD6	TSD5	TSD4	TSD3	TSD2	TSD1	TSD0
	Read/Write	R							
	After Reset	0	0	0	0	0	0	0	0
	Function	Transmit data shift register [7:0]							
		15	14	13	12	11	10	9	8
(0835H)	bit Symbol	TSD15	TSD14	TSD13	TSD12	TSD11	TSD10	TSD9	TSD8
	Read/Write	R							
	After Reset	0	0	0	0	0	0	0	0
	Function	Transmit data shift register [15:8]							

Figure 3.11.21 SPITS Register

(a) <TSD15:0>

This register is register for reading the status of transmission data shift register.
In case SPICT<UNIT16>= "1", all bits are valid.
In case SPICT<UNIT16>= "0", lower 8 bits are valid.

(8) SPIRS(SPI receive data shift register)

SPIRS register is register for reading receive data shift register.

SPIRS Register

		7	6	5	4	3	2	1	0
SPIRS (0836H)	bit Symbol	RSD7	RSD6	RSD5	RSD4	RSD3	RSD2	RSD1	RSD0
	Read/Write	R							
	After Reset	0	0	0	0	0	0	0	0
	Function	Receive data shift register [7:0]							
		15	14	13	12	11	10	9	8
(0837H)	bit Symbol	RSD15	RSD14	RSD13	RSD12	RSD11	RSD10	RSD9	RSD8
	Read/Write	R							
	After Reset	0	0	0	0	0	0	0	0
	function	Receive data shift register [15:8]							

Figure 3.11.22 SPIRS Register

(a) <RSD15:0>

This register is register for reading the status of receives data shift register.
In case SPICT<UNIT16>= “1”, all bits are valid.
In case SPICT<UNIT16>=“0”, lower 7 bits are valid.

3.11.3 Operation timing

Following examples show operation timing.

- Setting condition 1:

Transmission in UNIT=8bit, LSB first

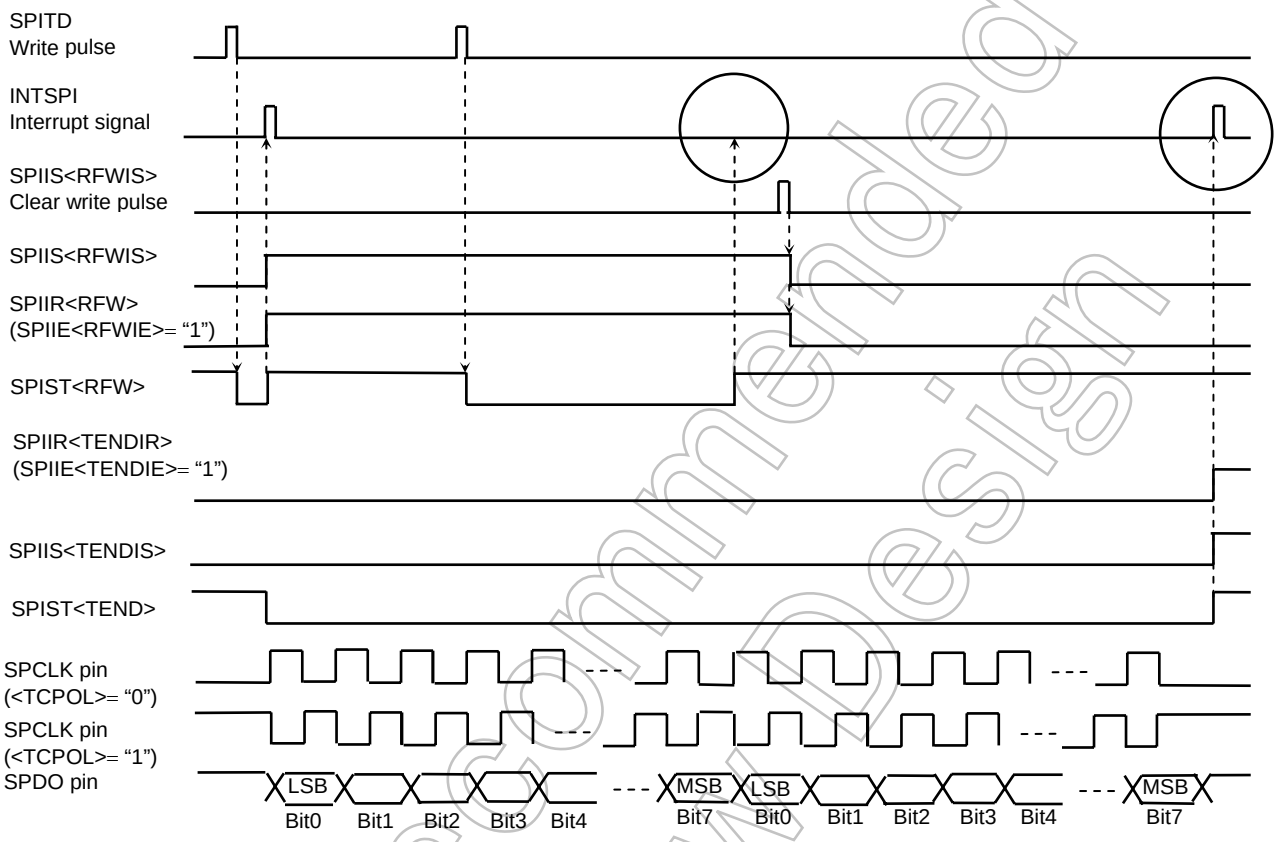


Figure 3.11.23 Transmission timing

In above condition, SPIST<RFW> flag is set to "0" just after wrote transmission data. When data of SPITD register finish shifting to transmission register (SPITS), SPIST<RFW> is set to "1", it is informed that can write next transmission data, start transmission clock and data from SPCLK pin and SPDO pin at same time with inform.

In this case, SPIIS, SPIIR change and INTSPI interrupt generate by synchronization to rising of SPIST<RFW> flag. When SPIIR register is setting to "1", interrupt is not generated even if SPIST<RFW> was set to "1".

When finish transmission and lose data that must to transmit to SPITD register and SPITS register, transmission data and clock are stopped by setting "1" to SPIST<TEND>, and INTSPI interrupt is generated at same time. In this case, if SPIST<TEND> is set to "1" at different interrupt source, INTSPI is not generated. Therefore must to clear SPIIS<RFW> to "0".

- Setting condition 2:

UNIT transmission in UNIT = 8bit, LSB first

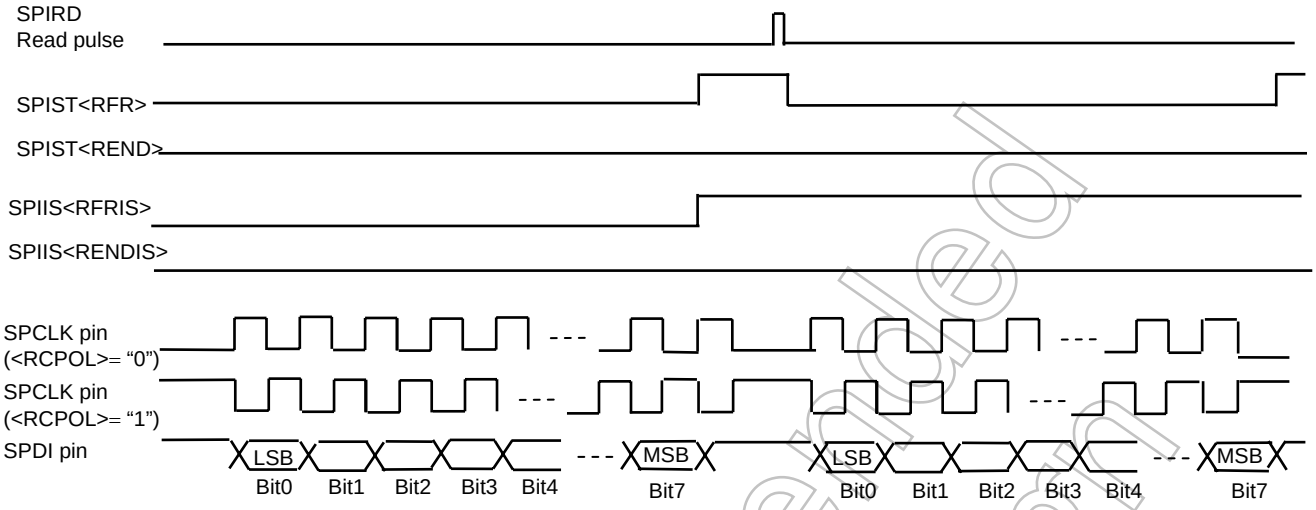


Figure 3.11.24 UNIT receiving (SPICT<RXUEN>=1)

If set SPICT<RXUEN> to "1" without valid receiving data to SPIRD register (SPIST<RFR>="0"), UNIT receiving is started. When receiving is finished and stored receiving data to SPIRD register, SPIST<RFR> flag is set to "1", and inform that can read receiving data. Just after read SPIRD register, SPIST<RFR> flag is cleared to "0" and it start receiving next data automatically.

If be finished UNIT receiving, set SPICT<RXUEN> to "0" after confirmed that SPIST<RFR> was set to "1".

- Setting condition 3:

Sequential receiving in UNIT=8 bit, LSB first

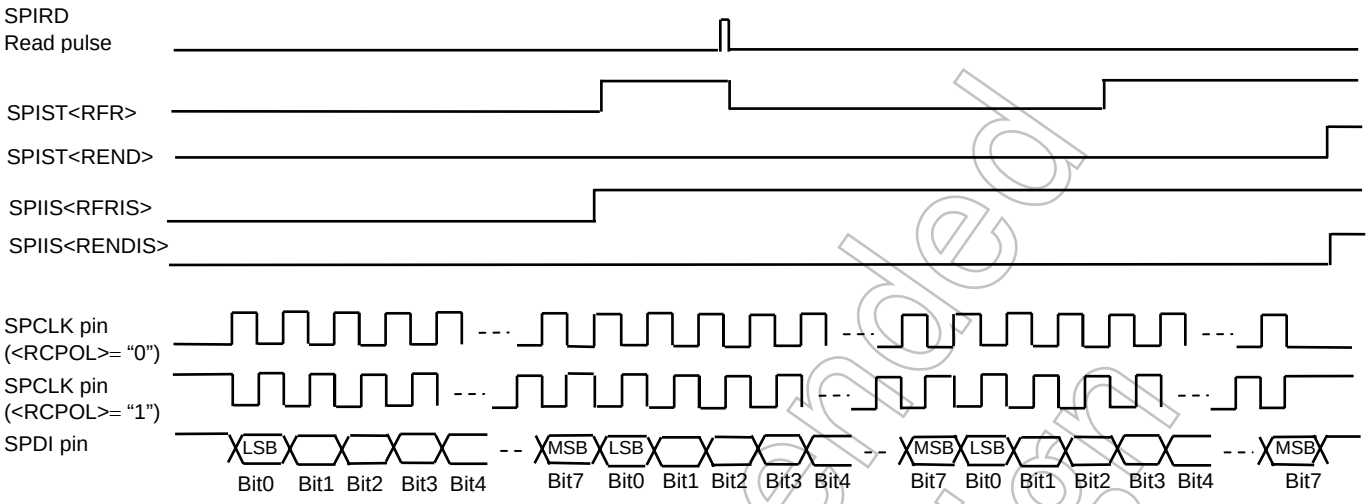


Figure 3.11.25 continuous receiving (SPICT<RXWEN>=1)

If set SPICT<RXWEN> to "1" without valid receiving data in SPIRD register (SPIST<RFR>=0), sequential receiving is started. When first receiving is finished and stored receiving data to SPIRD register, SPIST<RFR> flag is set to "1", and inform that can read receiving data. Sequential receiving is received until receiving data is stored to SPIRD and SPIRS registers If finished sequential receiving, set SPICT<RXWEN> to "0" after confirmed that SPIST<REND> was set to "1".

- Setting condition 4:

Transmission by using micro DMA in UNIT=8bit, LSB first

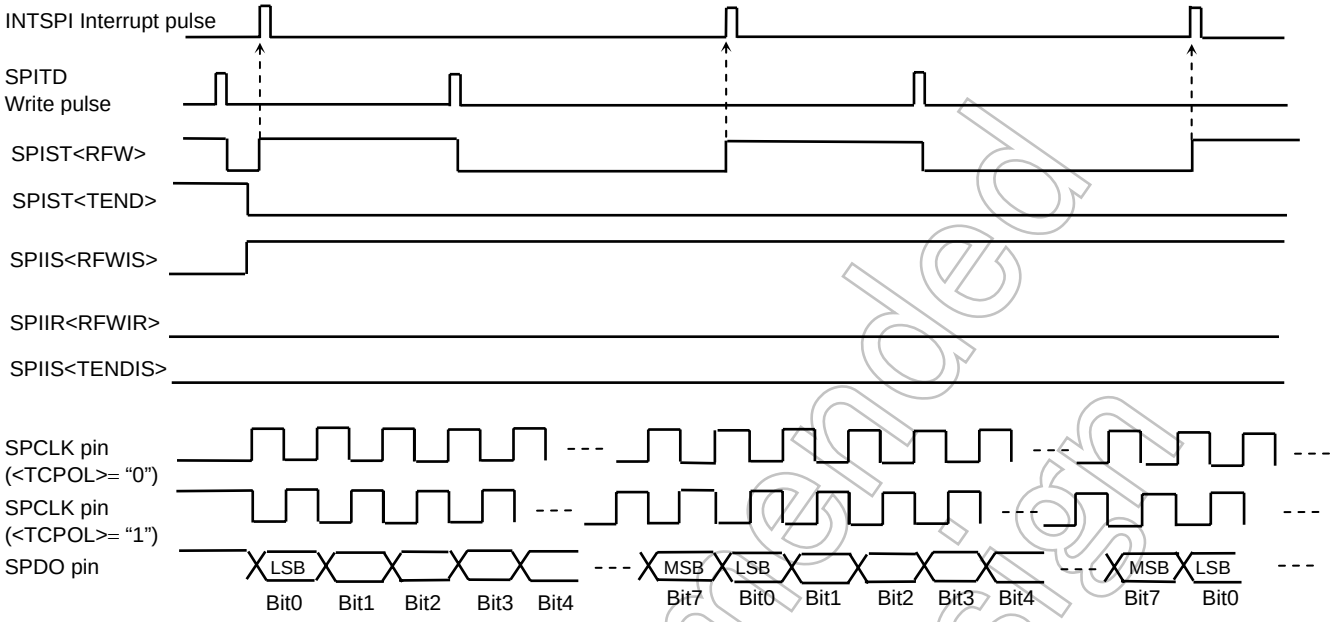


Figure 3.11.26 Micro DMA transmission (transmission)

If all bits of SPIIE register are "0" and SPICT<DMAERFW> is "1", transmission is started by writing transmission data to SPITD register.

If data of SPITD register is shifted to SPITS register and SPIST<RFW> is set to "1" and can write next transmission data, INTSPI interrupt (RFW interrupt) is generated. By starting Micro DMA at this interrupt, can transmit sequential data automatically.

However, If transmit it at Micro DMA, set Micro DMA beforehand.

- Setting condition 5:

Receiving by using micro DMA in UNIT=8bit, LSB first

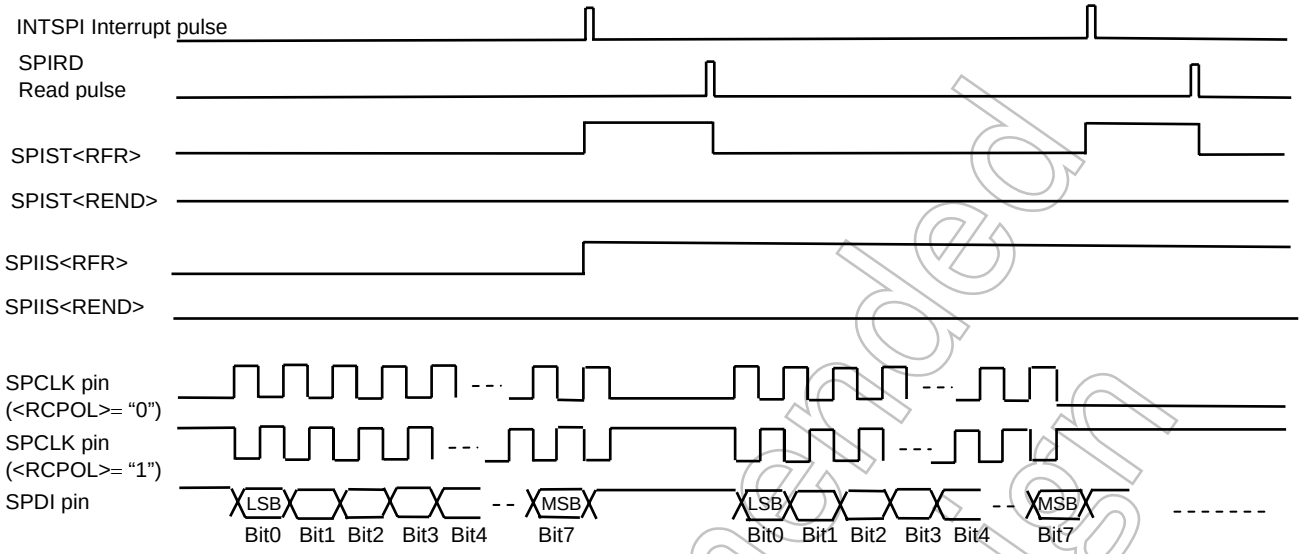


Figure 3.11.27 Micro DMA transmission (UNIT receiving (SPICT<RFUEN>=1))

If all bits of SPIIE register is "0" and SPICT<DMAERFR> is "1", UNIT receiving is started by setting SPICT<RXUEN> to "1". If receiving data is stored to SPIRD register and can read receiving data, INTSPI interrupt (RFR interrupt) is generated. By starting Micro DMA at this interrupt, it can be received sequential data automatically.

However, If receive it at Micro DMA, set Micro DMA beforehand.

3.11.4 Example

Following is discription of SPIDCC setting method.

(1) UNIT transmission

This example show case of transmission is executed by following setting, and it is generated INTSPI interrupt by finish transmission.

UNIT: 8bit
LSB first
Baud rate : $f_{SYS}/8$
Synchronous clock edge: Rising

Setting expample

```
ld    (pkfc), 0xf0        ; Port setting PK4: SPDI, PK5: SPDO, PK6:SPCS_B, PK7: SPCLK
ld    (pkcr), 0xe0        ; port setting PK4: SPDI, PK5: SPDO, PK6:SPCS_B, PK7: SPCLK

ldw   (spict),0x0080      ; Connection pin enable, SPCS pin output “0”, set data length to 8bit
ldw   (spimd),0x2c43      ; System clock enable, baud rate selection: fSYS/8
                          ; LSB first, synchronous clock edge setting: set to Rising

ld    (spiie),0x08        ; Set to TEND interrupt enable
ld    (intespi),0x10      ; Set INTSPI interrupt level to 1
ei                        ; Interrupt enable (iff=0)

loop                      ;Confirm that transmission data register doesn’t have no transmission data
   bit   1,(spist)        ; <RFW>=1 ?
   jr    z,loop

   ld    (spitd),0x3a     ; Write Transmission data and Start transmission
   .
   .
   .
```

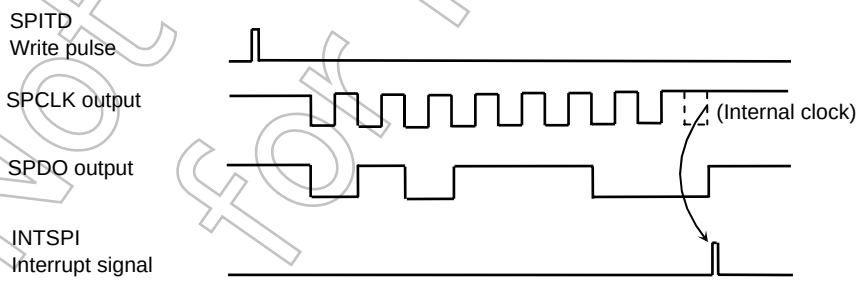


Figure 3.11.28 Example of UNIT transmission

(2) UNIT receiving

This example show case of receiving is executed by following setting, and it is generated INTSPI interrupt by finish receiving.

UNIT: 8bit
LSB first
Baud rate selection : $f_{SYS}/8$
Synchronous clock edge: Rising

Setting example

```
ld    (pkfc),0xf0          ; Port setting  PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK
ld    (pkcr),0xe0          ; Port setting  PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK

ldw   (spict),0x0080       ; Connection pin enable, SPCS pin "0" output, set data length to 8bit
ldw   (spimd),0x2c43       ; System clock enable, baud rate selection : fSYS/8
                           ; LSB first, synchronous clock edge setting: set to Rising

ld    (spiie),0x01         ; Set to RFR interrupt enable
ld    (intespi),0x10       ; Set INTSPI interrupt level to 1
ei                         ; Interrupt enable (iff=0)

set   0x0,(spict)          ; Start UNIT receiving
.
.
.
```

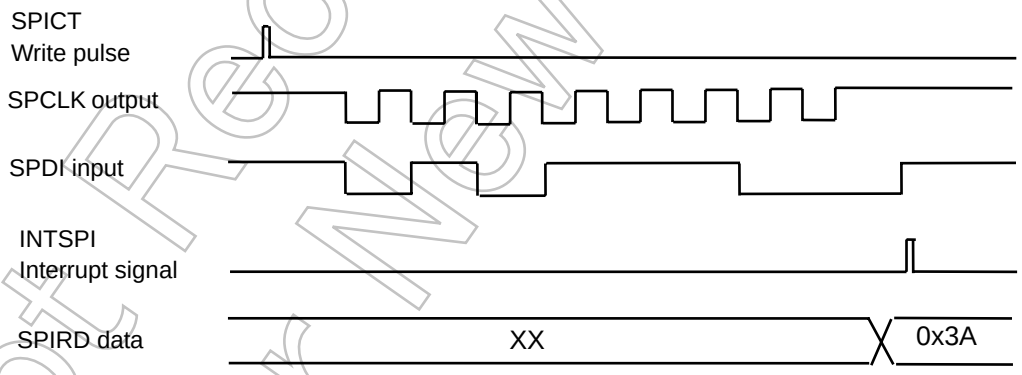


Figure 3.11.29 Example of UNIT receiving

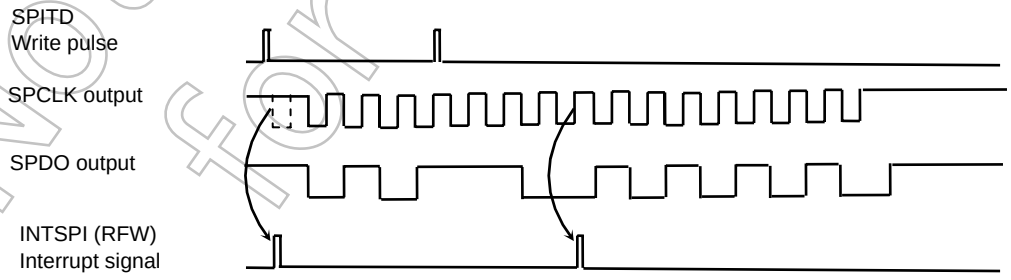
(3) Sequential transmission

This example show case of transmission is executed by following setting, and it is executed 2byte sequential transmission.

UNIT: 8bit
LSB first
Baud rate selection: $f_{SYS}/8$
Synchronous clock edge: Rising

Setting example

```
    ld     (pkfc),0xf0          ; Port setting  PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK
    ld     (pkcr),0xe0          ; Port setting  PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK

    ldw    (spict),0x0080       ; Connection pin enable, SPCS pin "0" output, set data length to 8bit
    ldw    (spimd),0x2c43       ; System clock enable, baud rate selection: fSYS/8
                                ; LSB first, synchronous clock edge setting: set to Rising

loop1:                          ; Confirm that transmission data register doesn't have no transmission data
    bit    1,(spist)            ; <RFW>=1 ?
    jr     z,loop1

    ld     (spitd),0x3a         ; Write transmission data of first byte and start transmission

loop2                           ; Confirm that transmission data register doesn't have no-transmission data
    bit    1,(spist)            ; <RFW>=1 ?
    jr     z,loop2

    ld     (spitd),0x55         ; Write transmission data of second byte

loop3:                          ; Confirm that transmission data register doesn't have no-transmission data
    bit    3,(spist)            ; <TEND>=1 ?
    jr     z,loop3
    .                           ; Finish transmission
    .
```



Note: Timing of this figure is an example. There is also that transmission interbal between first byte and sescond byte generate. (High baud rate etc.)

Figure 3.11.30 Example of sequential transmission

(4) Sequential receiving

This example show case of receiving is executed by following setting, and it is executed 2byte sequential receiving.

UNIT: 8bit
LSB first
Baud rate selection: $f_{SYS}/8$
Synchronous clock edge: Rising

Setting example

```
    ld    (pkfc),0xf0          ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK
    ld    (pkcr),0xe0          ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK

    ldw   (spict),0x0080       ; Connection pin enable, SPCS pin output "0", set data length to 8bit
    ldw   (spimd),0x2c43       ; System clock enable, baud rate selection: fSYS/8
                               ; LSB first, synchronous clock edge setting: set to Rising

    set   0x01,(spict)         ; Start sequential receiving

loop1:                         ; Confirm that receiving data register has receiving data of first byte
    bit   0,(spist)            ; <RFR>=1 ?
    jr    z,loop1

loop2:                         ; Confirm that receiving data register has receiving data of second byte
    bit   2,(spist)            ; <REND>=1 ?
    jr    z,loop2

    res   0x01,(spict)         ; Sequential receiving disable

    ld    a,(spird)            ; Read receiving data of first byte

loop3:                         ; Confirm that receiving data of second byte is shifted from receiving data
                                 shift register to receiving data register
    bit   0,(spist)            ; <RFR>=1 ?
    jr    z,loop3
    ld    w(spird)             ; Read receiving data of second byte
```

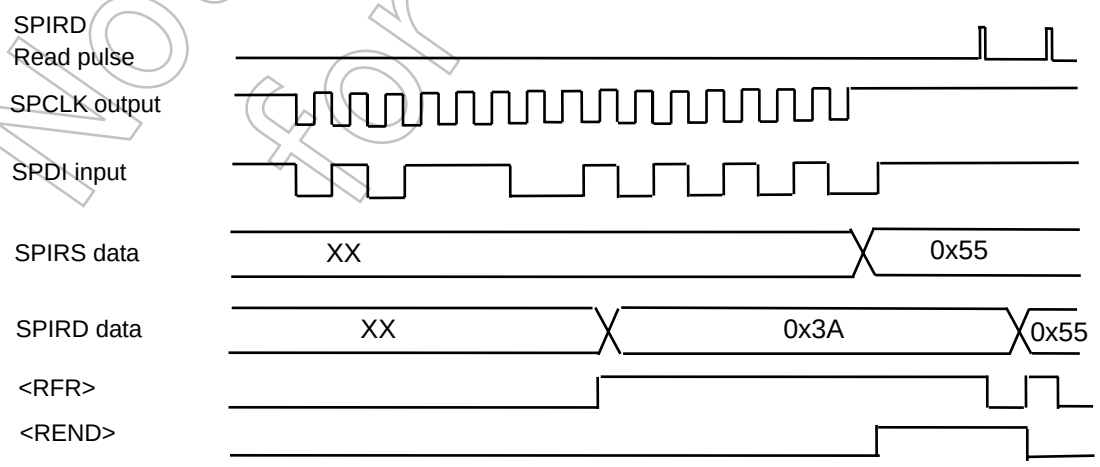


Figure 3.11.31 Example of sequential receiving

(5) Sequeintial Transmission by using micro DMA

This example show case of sequential transmission of 4byte is executed at using micro DMA by following setting.

UNIT: 8bit
LSB first
Baud rate : $f_{SYS}/8$
Synchronous clock edge: Rising

Setting example

Main routine

```
;-- micro DMA setting --
    ld     (dma0v),0x2a          ; Set micro DMA0 to INTSPI
    ld     wa,0x0003             ; Set number of micro DMA transmission  to that number -1 (third time)
    ldc    dmac0,wa
    ld     a,0x08                ; micro DMA mode setting: source INC mode, 1 byte transfer
    ldc    dmam0,a

    ld     xwa,0x806000          ; Set source address
    ldc    dmas0,xwa
    ld     xwa,0x830             ; Set source address to SPITD register
    ldc    dmad0,xwa

;-- SPIC setting --
    ld     (pkfc),0xf0           ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK
    ld     (pkcr),0xe0           ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK

    ldw    (spict),0x0080        ; Connection pin enable, SPCS pin output "0", set data length to 8bit
    ldw    (spimd),0x2c43        ; System clock enable, baud rate selection: fSYS/8
                                 ; LSB first, synchronous clock edge setting: set to Rising

    ld     (spiie),0x00          ;Set to interrupt disable
    set    1,(spict+1)           ; Set micro DMA operation by RFW to enable
    ld     (intetc01),0x01       ; Set INTTC0 interrupt level to 1
    ei                           ; Interrupt enable (iff=0)

loop1:                           ; Confirm that transmission data register doesn't have no transmission data
    bit    1,(spist)             ; <RFW>=1 ?
    jr     z,loop1

    ld     (spitd),0x3a          ; Write Transmission data and Start transmission
```

Interrupt routine (INTTC0)

```
loop2:
    bit    1,(spist)             ; <RFW> = 1 ?
    jr     z,loop2
    bit    3,(spist)             ; <TEND> = 1 ?
    jr     z,loop2
    nop
```

(6) UNIT receiving by using micro DMA

This example show case of UNIT receiving sequentially 4byte is executed at using micro DMA by following setting.

UNIT: 8bit
LSB first
Baud rate : $f_{SYS}/8$
Synchronous clock edge: Rising

Setting example

Main routine

```
;-- micro DMA setting --
    ld     (dma0v),0x2a          ; Set micro DMA0 to INTSPI
    ld     wa,0x0003             ; Set number of micro DMA transmission to that number -1 (third time)
    ldc    dmac0,wa
    ld     a,0x00                ; micro DMA mode setting: source INC mode, 1 byte transfer
    ldc    dmam0,a

    ld     xwa,0x832             ; Set source address to SPIRD register
    ldc    dmas0,xwa
    ld     xwa,0x807000          ; Set source address
    ldc    dmad0,xwa

;-- SPIC setting --
    ld     (pkfc),0xf0           ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK
    ld     (pkcr),0xe0           ; Port setting PK4:SPDI, PK5:SPDO, PK6:SPCS_B, PK7:SPCLK

    ldw    (spict),0x0080        ; Connection pin enable, SPCS pin output "0", set data length to 8bit
    ldw    (spimd),0x2c43        ; System clock enable, baud rate selection: fSYS/8
                                 ; LSB first, synchronous clock edge setting: set to Rising

    ld     (spiie),0x00          ; Set to interrupt disable
    set    0,(spict+1)           ; Set micro DMA operation by RFR to enable
    ld     (intetc01),0x01       ; Set INTTC0 interrupt level to 1
    ei                           ; Interrupt enable (iff=0)

    set    0x0,(spict)           ; Start UNIT receiving
```

Interrupt routine (INTTC0)

```
loop2:                           ; Wait receiving finish case of UNIT receiving
    bit    0,(spist)             ; <RFR> = 1 ?
    jr     z,loop2
    res    0,(spict)             ; UNIT receiving disable
    ld     a,(spird)             ; Read last receiving data
    nop
```

3.12 Analog/Digital Converter

The TMP92CA25 incorporates a 10-bit successive approximation type analog/digital converter (AD converter) with 4-channel analog input.

Figure 3.12.1 is a block diagram of the AD converter. The 4-channel analog input pins (AN0 to AN3) are shared with the input only port G so they can be used as an input port.

Note: When IDLE2, IDLE1 or STOP mode is selected, in order to reduce power consumption, the system may enter a stand-by mode with some timings even though the internal comparator is still enabled. Therefore be sure to check that AD converter operations are halted before a HALT instruction is executed.

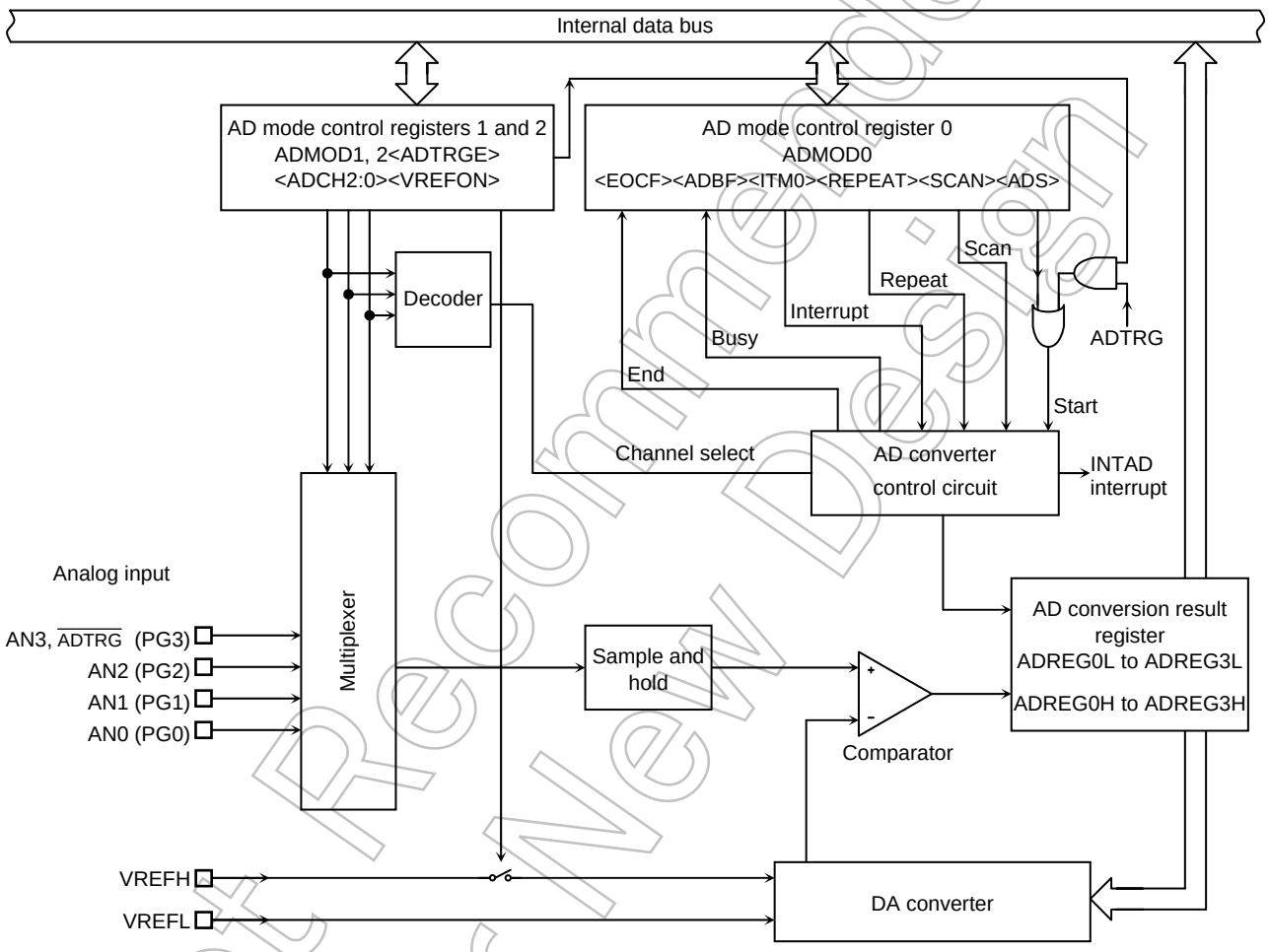


Figure 3.12.1 Block Diagram of AD Converter

3.12.1 Analog/Digital Converter Registers

The AD converter is controlled by the three AD mode control registers: ADMOD0, ADMOD1 and ADMOD2. The four AD conversion data result registers (ADREG0H/L to ADREG3H/L) store the results of AD conversion.

Figure 3.12.2 shows the registers related to the AD converter.

AD Mode Control Register 0

ADMOD0 (12B8H)

	7	6	5	4	3	2	1	0
Bit symbol	EOCF	ADBF	–	–	ITM0	REPEAT	SCAN	ADS
Read/Write	R		R/W					
After reset	0	0	0	0	0	0	0	0
Function	AD conversion end flag 0: Conversion in progress 1: Conversion complete	AD conversion busy flag 0: Conversion stopped 1: Conversion in progress	Always write "0"	Always write "0"	Interrupt specification in conversion channel fixed repeat mode 0: Every conversion 1: Every fourth conversion	Repeat mode specification 0: Single conversion 1: Repeat conversion mode	Scan mode specification 0: Conversion channel fixed mode 1: Conversion channel scan mode	AD conversion start 0: Don't care 1: Start conversion Always "0" when read

AD conversion start

0	Don't care
1	Start AD conversion

Note: Always read as "0".

AD scan mode setting

0	AD conversion channel fixed mode
1	AD conversion channel scan mode

AD repeat mode setting

0	AD single conversion mode
1	AD repeat conversion mode

Specify AD conversion interrupt for channel fixed repeat conversion mode

	Channel fixed repeat conversion mode <SCAN> = "0", <REPEAT> = "1"
0	Generates interrupt every conversion.
1	Generates interrupt every fourth conversion.

AD conversion busy flag

0	AD conversion stopped
1	AD conversion in progress

AD conversion end flag

0	Before or during AD conversion
1	AD conversion complete

Figure 3.12.2 AD Converter Related Register

AD Mode Control Register 1

ADMOD1 (12B9H)

	7	6	5	4	3	2	1	0
Bit symbol	VREFON	I2AD	–	–	–	–	ADCH1	ADCH0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	VREF application control 0: Off 1: On	IDLE2 0: Stop 1: Operate	Always write “0”	Always write “0”	Always write “0”	Always write “0”	Analog input channel selection	

Analog input channel selection

<ADCH1:0> \ <SCAN>	0 (Channel fixed)	1 (Channel scanned)
00	AN0	AN0
01	AN1	AN0→AN1
10	AN2	AN0→AN1→AN2
11 (Note)	AN3	AN0→AN1→AN2→AN3

IDLE2 control

0	Stopped
1	In operation

Control of application of reference voltage to AD converter

0	Off
1	On

Before starting conversion (before writing 1 to ADMOD0<ADS>), set the <VREFON> bit to 1.

AD Mode Control Register 2

ADMOD2 (12BAH)

	7	6	5	4	3	2	1	0
Bit symbol	–	–	–	–	–	–	–	ADTRGE
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Always write “0”	Always write “0”	Always write “0”	Always write “0”	Always write “0”	Always write “0”	Always write “0”	AD external trigger start control 0: Disable 1: Enable

AD conversion start control by external trigger ($\overline{\text{ADTRG}}$ input)

0	Disabled
1	Enabled

Note: As pin AN3 also functions as the $\overline{\text{ADTRG}}$ input pin, do not set <ADCH1:0> = “11” when using $\overline{\text{ADTRG}}$ with < ADTRGE > set to “1”.

Figure 3.12.3 AD Converter Related Register

AD Conversion Result Register 0 Low

ADREG0L (12A0H)	7	6	5	4	3	2	1	0
Bit symbol	ADR01	ADR00						ADR0RF
Read/Write	R							R
After reset	Undefined							0
Function	Stores lower 2 bits of AD conversion result.							AD conversion data storage flag 1: Conversion result stored

AD Conversion Result Register 0 High

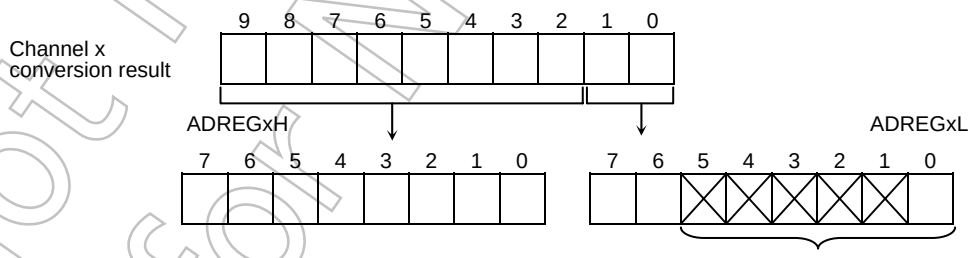
ADREG0H (12A1H)	7	6	5	4	3	2	1	0
Bit symbol	ADR09	ADR08	ADR07	ADR06	ADR05	ADR04	ADR03	ADR02
Read/Write	R							
After reset	Undefined							
Function	Stores upper 8 bits of AD conversion result.							

AD Conversion Result Register 1 Low

ADREG1L (12A2H)	7	6	5	4	3	2	1	0
Bit symbol	ADR11	ADR10						ADR1RF
Read/Write	R							R
After reset	Undefined							0
Function	Stores lower 2 bits of AD conversion result.							AD conversion result flag 1: Conversion result stored

AD Conversion Result Register 1 High

ADREG1H (12A3H)	7	6	5	4	3	2	1	0
Bit symbol	ADR19	ADR18	ADR17	ADR16	ADR15	ADR14	ADR13	ADR12
Read/Write	R							
After reset	Undefined							
Function	Stores upper 8 bits of AD conversion result.							



- Bits 5 to 1 are always read as 1.
- Bit0 is the AD conversion data storage flag <ADRxRF>. When the AD conversion result is stored, the flag is set to 1. When either of the registers (ADREGxH, ADREGxL) is read, the flag is cleared to 0.

Figure 3.12.4 AD Converter Related Registers

AD Conversion Result Register 2 Low

ADREG2L (12A4H)	7	6	5	4	3	2	1	0
Bit symbol	ADR21	ADR20						ADR2RF
Read/Write	R							R
After reset	Undefined							0
Function	Stores lower 2 bits of AD conversion result.							AD conversion data storage flag 1: Conversion result stored

AD Conversion Result Register 2 High

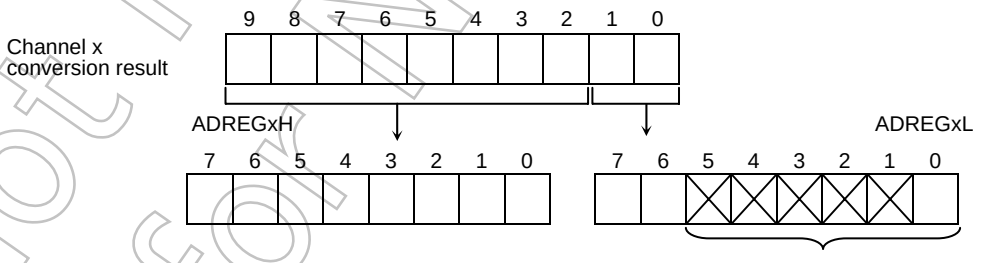
ADREG2H (12A5H)	7	6	5	4	3	2	1	0
Bit symbol	ADR29	ADR28	ADR27	ADR26	ADR25	ADR24	ADR23	ADR22
Read/Write	R							
After reset	Undefined							
Function	Stores upper 8 bits of AD conversion result.							

AD Conversion Result Register 3 Low

ADREG3L (12A6H)	7	6	5	4	3	2	1	0
Bit symbol	ADR31	ADR30						ADR3RF
Read/Write	R							R
After reset	Undefined							0
Function	Stores lower 2 bits of AD conversion result.							AD conversion data storage flag 1: Conversion result stored

AD Conversion Result Register 3 High

ADREG3H (12A7H)	7	6	5	4	3	2	1	0
Bit symbol	ADR39	ADR38	ADR37	ADR36	ADR35	ADR34	ADR33	ADR32
Read/Write	R							
After reset	Undefined							
Function	Stores upper 8 bits of AD conversion result.							



- Bits 5 to 1 are always read as 1.
- Bit0 is the AD conversion data storage flag <ADRxRF>. When the AD conversion result is stored, the flag is set to 1. When either of the registers (ADREGxH, ADREGxL) is read, the flag is cleared to 0.

Figure 3.12.5 AD Converter Related Registers

3.12.2 Description of Operation

(1) Analog reference voltage

A high level analog reference voltage is applied to the VREFH pin; a low level analog reference voltage is applied to the VREFL pin. To perform AD conversion, the reference voltage, the difference between VREFH and VREFL, is divided by 1024 using string resistance. The result of the division is then compared with the analog input voltage.

To turn off the switch between VREFH and VREFL, write a 0 to ADMOD1 <VREFON> in AD mode control register 1. To start AD conversion in the OFF state, first write a 1 to ADMOD1<VREFON>, wait 3 μs until the internal reference voltage stabilizes (this is not related to fc), then set ADMOD0<ADS> to 1.

(2) Analog input channel selection

The analog input channel selection varies depending on the operation mode of the AD converter.

- In analog input channel fixed mode (ADMOD0<SCAN> = 0)
  Setting ADMOD1<ADCH1:0> selects one of the input pins AN0 to AN3 as the input channel.
- In analog input channel scan mode (ADMOD0<SCAN> = 1)
  Setting ADMOD1<ADCH1:0> selects one of the four scan modes.

Table 3.12.1 illustrates analog input channel selection in each operation mode.

On a reset, ADMOD0<SCAN> is set to 0 and ADMOD1<ADCH1:0> is initialized to 00. Thus pin AN0 is selected as the fixed input channel. Pins not used as analog input channels can be used as standard input port pins.

Table 3.12.1 Analog Input Channel Selection

<ADCH1:0>	Channel Fixed <SCAN> = "0"	Channel Scan <SCAN> = "1"
00	AN0	AN0
01	AN1	AN0 → AN1
10	AN2	AN0 → AN1 → AN2
11	AN3	AN0 → AN1 → AN2 → AN3

(3) Starting AD conversion

To start AD conversion, write a 1 to ADMOD0<ADS> in AD mode control register "0" or ADMOD2<ADTRGE> in AD mode control register 2, and input falling edge on $\overline{\text{ADTRG}}$ pin. When AD conversion starts, the AD conversion busy flag ADMOD0<ADBF> will be set to 1, indicating that AD conversion is in progress.

During AD conversion, a falling edge input on the $\overline{\text{ADTRG}}$ pin will be ignored.

(4) AD conversion modes and the AD conversion end interrupt

The four AD conversion modes are:

- Channel fixed single conversion mode
- Channel scan single conversion mode
- Channel fixed repeat conversion mode
- Channel scan repeat conversion mode

The ADMOD0<REPEAT> and ADMOD0<SCAN> settings in AD mode control register 0 determine the AD mode setting.

Completion of AD conversion triggers an INTAD AD conversion end interrupt request. Also, ADMOD0<EOCF> will be set to 1 to indicate that AD conversion has been completed.

1. Channel fixed single conversion mode

   Setting ADMOD0<REPEAT> and ADMOD0<SCAN> to 00 selects conversion channel fixed single conversion mode.

   In this mode, data on one specified channel is converted once only. When the conversion has been completed, the ADMOD0<EOCF> flag is set to 1, ADMOD0<ADBF> is cleared to 0, and an INTAD interrupt request is generated.

2. Channel scan single conversion mode

   Setting ADMOD0<REPEAT> and ADMOD0<SCAN> to 01 selects conversion channel scan single conversion mode.

   In this mode, data on the specified scan channels is converted once only. When scan conversion has been completed, ADMOD0<EOCF> is set to 1, ADMOD0<ADBF> is cleared to 0, and an INTAD interrupt request is generated.

3. Channel fixed repeat conversion mode

   Setting ADMOD0<REPEAT> and ADMOD0<SCAN> to 10 selects conversion channel fixed repeat conversion mode.

   In this mode, data on one specified channel is converted repeatedly. When conversion has been completed, ADMOD0<EOCF> is set to 1 and ADMOD0<ADBF> is not cleared to 0 but held at 1. INTAD interrupt request generation timing is determined by the setting of ADMOD0<ITM0>.

   Setting <ITM0> to 0 generates an interrupt request every time an AD conversion is completed.

   Setting <ITM0> to 1 generates an interrupt request on completion of every fourth conversion.

4. Channel scan repeat conversion mode

   Setting ADMOD0<REPEAT> and ADMOD0<SCAN> to 11 selects conversion channel scan repeat conversion mode.

   In this mode, data on the specified scan channels is converted repeatedly. When each scan conversion has been completed, ADMOD0<EOCF> is set to 1 and an INTAD interrupt request is generated. ADMOD0<ADBF> is not cleared to 0 but held at 1.

   To stop conversion in a repeat conversion mode (e.g., in cases 3. and 4.), write a 0 to ADMOD0<REPEAT>. After the current conversion has been completed, the repeat conversion mode terminates and ADMOD0<ADBF> is cleared to 0.

   Switching to a halt state (IDLE2 mode with ADMOD1<I2AD> cleared to 0, IDLE1 mode or STOP mode) immediately stops operation of the AD converter even when AD conversion is still in progress. In repeat conversion modes (e.g., in cases 3. and 4.), when the halt is released, conversion restarts from the beginning. In single conversion modes (e.g., in cases 1. and 2.), conversion does not restart when the halt is released (the converter remains stopped).

   Table 3.12.2 shows the relationship between the AD conversion modes and interrupt requests.

Table 3.12.2 Relationship between AD Conversion Modes and Interrupt Requests

Mode	Interrupt Request Generation	ADMOD0		
		<ITM0>	<REPEAT>	<SCAN>
Channel fixed single conversion mode	After completion of conversion	X	0	0
Channel scan single conversion mode	After completion of scan conversion	X	0	1
Channel fixed repeat conversion mode	Every conversion	0	1	0
	Every fourth conversion	1		
Channel scan repeat conversion mode	After completion of every scan conversion	X	1	1

X: Don't care

(5) AD conversion time

84 states (8.4 μs at f_{SYS} = 20 MHz) are required for the AD conversion of one channel.

(6) Storing and reading the results of AD conversion

The AD conversion data upper and lower registers (ADREG0H/L to ADREG3H/L) store the results of AD conversion. (ADREG0H/L to ADREG3H/L are read-only registers.)

In channel fixed repeat conversion mode, the conversion results are stored successively in registers ADREG0H/L to ADREG3H/L. In other modes the AN0, AN1, AN2, AN3 and AN4 conversion results are stored in ADREG0H/L, ADREG1H/L, ADREG2H/L and ADREG3H/L respectively.

Table 3.12.3 shows the correspondence between the analog input channels and the registers which are used to hold the results of AD conversion.

Table 3.12.3 Correspondence between Analog Input Channels and AD Conversion Result Registers

Analog Input Channel (Port G)	AD Conversion Result Register	
	Conversion Modes Other than at Right	Channel Fixed Repeat Conversion Mode (ADMOD0<ITM0 = 1>)
AN0	ADREG0H/L	ADREG0H/L
AN1	ADREG1H/L	ADREG1H/L
AN2	ADREG2H/L	ADREG2H/L
AN3	ADREG3H/L	ADREG3H/L

<ADRxRF>, bit0 of the AD conversion data lower register, is used as the AD conversion data storage flag. The storage flag indicates whether the AD conversion result register has been read or not. When a conversion result is stored in the AD conversion result register, the flag is set to 1. When either of the AD conversion result registers (ADREGxH or ADREGxL) is read, the flag is cleared to 0.

Reading the AD conversion result also clears the AD conversion end flag ADMOD0<EOCF> to 0.

Setting example:

1. Convert the analog input voltage on the AN3 pin and write the result to memory address 2800H using the AD interrupt (INTAD) processing routine.

Main routine:

		7	6	5	4	3	2	1	0	
INTE0AD	←	1	1	0	0	–	–	–	–	Enable INTAD and set it to interrupt level 4.
ADMOD1	←	1	1	0	0	0	0	1	1	Set pin AN3 to be the analog input channel.
ADMOD0	←	X	X	0	0	0	0	0	1	Start conversion in channel fixed single conversion mode.

Interrupt routine processing example:

WA	←	ADREG3	Read value of ADREG3L and ADREG3H into 16-bits general-purpose register WA.
WA	←	> > 6	Shift contents read into WA six times to right and zero fill upper bits.
(2800H)	←	WA	Write contents of WA to memory address 2800H.

2. This example repeatedly converts the analog input voltages on the three pins AN0, AN1 and AN2, using channel scan repeat conversion mode.

		7	6	5	4	3	2	1	0	
INTE0AD	←	1	0	0	0	–	–	–	–	Disable INTAD.
ADMOD1	←	1	1	0	0	0	0	1	0	Set pins AN0 to AN2 to be the analog input channels.
ADMOD0	←	X	X	0	0	0	1	1	1	Start conversion in channel scan repeat conversion mode.

X: Don't care, –: No change

3.13 Watchdog Timer (Runaway detection timer)

The TMP92CA25 contains a watchdog timer of runaway detecting.

The watchdog timer (WDT) is used to return the CPU to the normal state when it detects that the CPU has started to malfunction (runaway) due to causes such as noise. When the watchdog timer detects a malfunction, it generates a non-maskable interrupt INTWD to notify the CPU of the malfunction.

Connecting the watchdog timer output to the reset pin internally forces a reset.

(The level of external $\overline{\text{RESET}}$ pin is not changed.)

3.13.1 Configuration

Figure 3.13.1 is a block diagram of the watchdog timer (WDT).

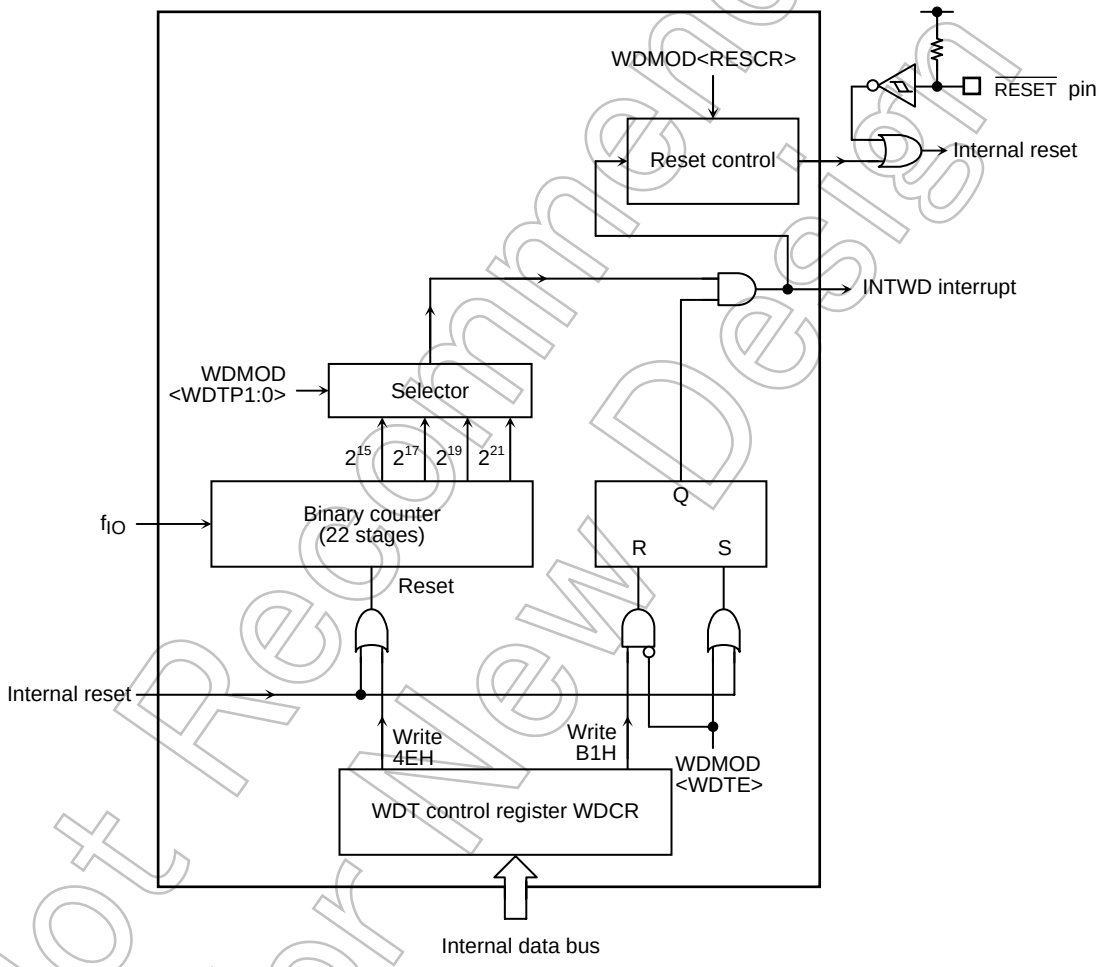


Figure 3.13.1 Block Diagram of Watchdog Timer

Note: Care must be exercised in the overall design of the apparatus since the watchdog timer may fail to function correctly due to external noise, etc.

3.13.2 Operation

The watchdog timer generates an INTWD interrupt when the detection time set in the WDMOD<WDTP1:0> has elapsed. The watchdog timer must be cleared to zero in software before an INTWD interrupt will be generated. If the CPU malfunctions (e.g., if runaway occurs) due to causes such as noise, but does not execute the instruction used to clear the binary counter, the binary counter will overflow and an INTWD interrupt will be generated. The CPU will detect malfunction (runaway) due to the INTWD interrupt, and in this case it is possible to return the CPU to normal operation by means of an anti-malfunction program.

The watchdog timer begins operating immediately on release of the watchdog timer reset.

The watchdog timer is reset and halted in IDLE1 or STOP mode. The watchdog timer counter continues counting during bus release (when $\overline{\text{BUSAK}}$ goes low).

When the device is in IDLE2 mode, the operation of the WDT depends on the WDMOD<I2WDT> setting. Ensure that WDMOD<I2WDT> is set before the device enters IDLE2 mode.

The watchdog timer consists of a 22-stage binary counter which uses the clock ϕ ($2/f_{IO}$) as the input clock. The binary counter can output $2^{15}/f_{IO}$, $2^{17}/f_{IO}$, $2^{19}/f_{IO}$ and $2^{21}/f_{IO}$.

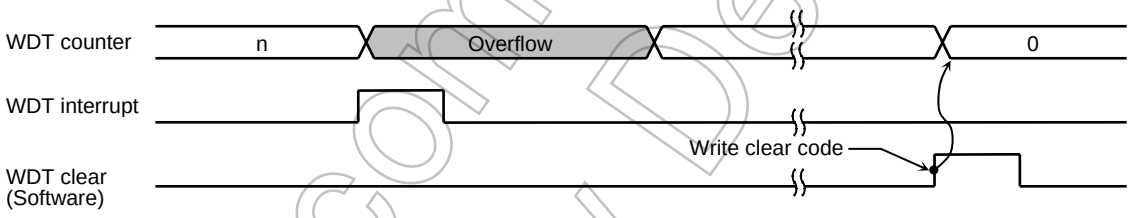


Figure 3.13.2 Normal Mode

The runaway detection result can also be connected to the reset pin internally.
In this case, the reset time will be between 22 and 29 system clocks (35.2 to 46.4 μs at f_{OSCH} = 40 MHz) as shown inFigure 3.13.3. After a reset, the f_{IO} clock is $f_{FPH}/4$, where f_{FPH} is generated by dividing the high-speed oscillator clock (f_{OSCH}) by sixteen through the clock gear function.

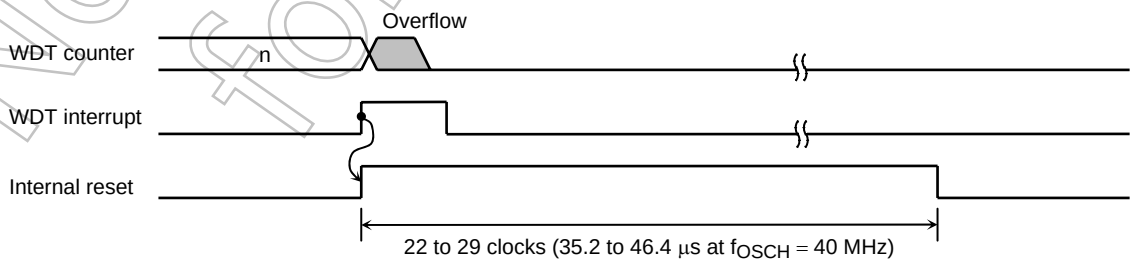


Figure 3.13.3 Reset Mode

3.13.3 Control Registers

The watchdog timer (WDT) is controlled by two control registers WDMOD and WDCR.

(1) Watchdog timer mode register (WDMOD)

1. Setting the detection time for the watchdog timer in <WDTP1:0>

   This 2-bit register is used for setting the watchdog timer interrupt time used when detecting runaway.

   On a reset this register is initialized to WDMOD<WDTP1:0> = 00.

   The detection time for WDT is $2^{15}/f_{IO}$ [s]. (The number of system clocks is approximately 65,536.)

2. Watchdog timer enable/disable control register <WDTE>

   At reset, the WDMOD<WDTE> is initialized to 1, enabling the watchdog timer.

   To disable the watchdog timer, it is necessary to set this bit to 0 and to write the disable code (B1H) to the watchdog timer control register (WDCR). This makes it difficult for the watchdog timer to be disabled by runaway.

   However, it is possible to return the watchdog timer from the disabled state to the enabled state merely by setting <WDTE> to 1.

3. Watchdog timer out reset connection <RESCR>

   This register is used to connect the output of the watchdog timer with the RESET terminal internally. Since WDMOD<RESCR> is initialized to 0 at reset, a reset by the watchdog timer will not be performed.

(2) Watchdog timer control register (WDCR)

This register is used to disable and clear the binary counter for the watchdog timer.

- Disable control

  The watchdog timer can be disabled by clearing WDMOD<WDTE> to 0 and then writing the disable code (B1H) to the WDCR register.

WDCR	←	0	1	0	0	1	1	1	0	Write the clear code (4EH).
WDMOD	←	0	–	–	–	0	–	–	0	Clear WDMOD <WDTE> to 0.
WDCR	←	1	0	1	1	0	0	0	1	Write the disable code (B1H).

- Enable control

  Set WDMOD<WDTE> to 1.

- Watchdog timer clear control

  To clear the binary counter and cause counting to resume, write the clear code (4EH) to the WDCR register.

WDCR	←	0	1	0	0	1	1	1	0	Write the clear code (4EH).

Note1: If the disable control is used, set the disable code (B1H) to WDCR after writing the clear code (4EH) once. (Please refer to setting example.)

Note2: If the watchdog timer setting is changed, change setting after setting to disable condition once.

WDMOD (1300H)

	7	6	5	4	3	2	1	0
Bit symbol	WDTE	WDTP1	WDTP0		–	I2WDT	RESCR	–
Read/Write	R/W				R/W			
After reset	1	0	0		0	0	0	0
Function	WDT control 1: Enable	Select detecting time 00: $2^{15}/f_{IO}$ 01: $2^{17}/f_{IO}$ 10: $2^{19}/f_{IO}$ 11: $2^{21}/f_{IO}$			Always write “0”	IDLE2 0: Stop 1: Operate	1: Internally connects WDT out to the reset pin	Always write “0”

Watchdog timer out control

0	–
1	Connects WDT out to a reset

IDLE2 control

0	Stop
1	Operation

Watchdog timer detection time

00	$2^{15}/f_{IO}$ (Approximately 3.28 ms at f_{IO} = 10 MHz)
01	$2^{17}/f_{IO}$ (Approximately 13.1 ms at f_{IO} = 10 MHz)
10	$2^{19}/f_{IO}$ (Approximately 52.4 ms at f_{IO} = 10 MHz)
11	$2^{21}/f_{IO}$ (Approximately 210 ms at f_{IO} = 10 MHz)

Watchdog timer enable/disable control

0	Disabled
1	Enabled

Figure 3.13.4 Watchdog Timer Mode Register

WDCR (1302H)

Read -modify -write instruction is prohibited

	7	6	5	4	3	2	1	0
Bit symbol	–							
Read/Write	W							
After reset	–							
Function	B1H: WDT disable code 4EH: WDT clear code							

WDT disable/clear control

B1H	Disable code
4EH	Clear code
Others	Don’t care

Figure 3.13.5 Watchdog Timer Control Register

3.14 Real Time Clock (RTC)

3.14.1 Function Description for RTC

1) Clock function (hour, minute, second)
2) Calendar function (month and day, day of the week, and leap year)
3) 24- or 12-hour (AM/PM) clock function
4) +/−30 s adjustment function (by software)
5) Alarm function (alarm output)
6) Alarm interrupt generate

3.14.2 Block Diagram

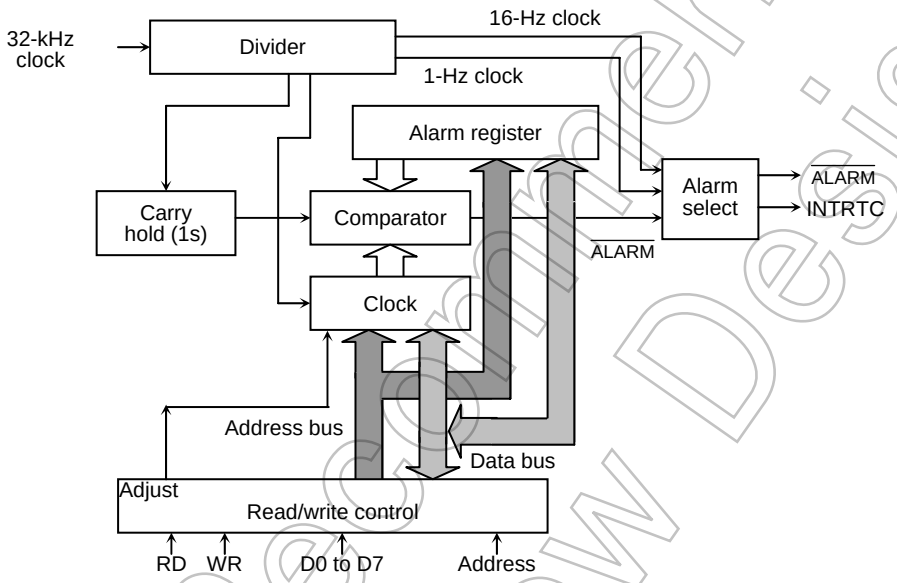


Figure 3.14.1 RTC Block Diagram

Note 1: Western calendar year column:

This product uses only the final two digits of the year. Therefore, the year following 99 is 00 years. In use, please take into account the first two digits when handling years in the western calendar.

Note 2: Leap year:

A leap year is divisible by 4, but the exception is any leap year which is divisible by 100; this is not considered a leap year. However, any year which is divisible by 400, is a leap year. This product does not take into account the above exceptions . Since this product accounts only for leap years divisible by 4, please adjust the system for any problems.

3.14.3 Control Registers

Table 3.14.1 PAGE 0 (Clock function) Registers

Symbol	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Function	Read/Write
SECR	1320H		40 sec	20 sec	10 sec	8 sec	4 sec	2 sec	1 sec	Second column	R/W
MINR	1321H		40 min	20 min	10 min	8 min	4 min	2 min	1 min	Minute column	R/W
HOURR	1322H			20 hours/ PM/AM	10 hours	8 hours	4 hours	2 hours	1 hour	Hour column	R/W
DAYR	1323H						W2	W1	W0	Day of the week column	R/W
DATER	1324H			Day 20	Day 10	Day 8	Day 4	Day 2	Day 1	Day column	R/W
MONTHR	1325H				Oct.	Aug.	Apr.	Feb.	Jan.	Month column	R/W
YEARR	1326H	Year 80	Year 40	Year 20	Year 10	Year 8	Year 4	Year 2	Year 1	Year column (Lower two columns)	R/W
PAGER	1327H	Interrupt enable			Adjustment function	Clock enable	Alarm enable		PAGE setting	PAGE register	W, R/W
RESTR	1328H	1Hz enable	16Hz enable	Clock reset	Alarm reset	Always write “0”				Reset register	W only

Note: When reading SECR, MINR, HOURR, DAYR, MONTHR and YEARR of PAGE0, the current state is read.

Table 3.14.2 PAGE 1 (Alarm function) Registers

Symbol	Address	Bit7	Bit6	Bit5	Bit4	Bit3	Bit2	Bit1	Bit0	Function	Read/Write
SECR	1320H										R/W
MINR	1321H		40 min	20 min	10 min	8 min	4 min	2 min	1 min	Minute column	R/W
HOURR	1322H			20 hours/ PM/AM	10 hours	8 hours	4 hours	2 hours	1 hour	Hour column	R/W
DAYR	1323H						W2	W1	W0	Day of the week column	R/W
DATER	1324H			Day 20	Day 10	Day 8	Day 4	Day 2	Day 1	Day column	R/W
MONTHR	1325H								24/12	24-hour clock mode	R/W
YEARR	1326H							LEAP1	LEAP0	Leap-year mode	R/W
PAGER	1327H	Interrupt enable			Adjustment function	Clock enable	Alarm enable		PAGE setting	PAGE register	W, R/W
RESTR	1328H	1Hz enable	16Hz enable	Clock reset	Alarm reset	Always write “0”				Reset register	W only

Note: When reading SECR, MINR, HOURR, DAYR, MONTHR, YEARR of PAGE1, the current state is read.

3.14.4 Detailed Explanation of Control Register

RTC is not initialized by system reset.

Therefore, all registers must be initialized at the beginning of the program.

(1) Second column register (for PAGE0 only)

SECR (1320H)

	7	6	5	4	3	2	1	0
Bit symbol		SE6	SE5	SE4	SE3	SE2	SE1	SE0
Read/Write		R/W						
After reset		Undefined						
Function	"0" is read.	40 sec. column	20 sec. column	10 sec. column	8 sec. column	4 sec. column	2 sec. column	1 sec. column

0	0	0	0	0	0	0	0 sec
0	0	0	0	0	0	1	1 sec
0	0	0	0	0	1	0	2 sec
0	0	0	0	0	1	1	3 sec
0	0	0	0	1	0	0	4 sec
0	0	0	0	1	0	1	5 sec
0	0	0	0	1	1	0	6 sec
0	0	0	0	1	1	1	7 sec
0	0	0	1	0	0	0	8 sec
0	0	0	1	0	0	1	9 sec
0	0	1	0	0	0	0	10 sec
			:				
0	0	1	1	0	0	1	19 sec
0	1	0	0	0	0	0	20 sec
			:				
0	1	0	1	0	0	1	29 sec
0	1	1	0	0	0	0	30 sec
			:				
0	1	1	1	0	0	1	39 sec
1	0	0	0	0	0	0	40 sec
			:				
1	0	0	1	0	0	1	49 sec
1	0	1	0	0	0	0	50 sec
			:				
1	0	1	1	0	0	1	59 sec

Note: Do not set data other than as shown above.

(2) Minute column register (for PAGE0/1)

MINR (1321H)

	7	6	5	4	3	2	1	0
Bit symbol		MI6	MI5	MI4	MI3	MI2	MI1	MI0
Read/Write		R/W						
After reset		Undefined						
Function	"0" is read.	40 min column	20 min column	10 min column	8 min column	4 min column	2 min column	1 min column

0	0	0	0	0	0	0	0 min
0	0	0	0	0	0	1	1 min
0	0	0	0	0	1	0	2 min
0	0	0	0	0	1	1	3 min
0	0	0	0	1	0	0	4 min
0	0	0	0	1	0	1	5 min
0	0	0	0	1	1	0	6 min
0	0	0	0	1	1	1	7 min
0	0	0	1	0	0	0	8 min
0	0	0	1	0	0	1	9 min
0	0	1	0	0	0	0	10 min
			:				
0	0	1	1	0	0	1	19 min
0	1	0	0	0	0	0	20 min
			:				
0	1	0	1	0	0	1	29 min
0	1	1	0	0	0	0	30 min
			:				
0	1	1	1	0	0	1	39 min
1	0	0	0	0	0	0	40 min
			:				
1	0	0	1	0	0	1	49 min
1	0	1	0	0	0	0	50 min
			:				
1	0	1	1	0	0	1	59 min

Note: Do not set data other than as shown above.

(3) Hour column register (for PAGE0/1)

1. In 24-hour clock mode (MONTHR<MO0> = "1")

HOURR (1322H)

	7	6	5	4	3	2	1	0
Bit symbol			HO5	HO4	HO3	HO2	HO1	HO0
Read/Write			R/W					
After reset			Undefined					
Function	"0" is read.		20 hours column	10 hours column	8 hours column	4 hours column	2 hours column	1 hour column

0	0	0	0	0	0	0 o'clock
0	0	0	0	0	1	1 o'clock
0	0	0	0	1	0	2 o'clock
			:			
0	0	1	0	0	0	8 o'clock
0	0	1	0	0	1	9 o'clock
0	1	0	0	0	0	10 o'clock
			:			
0	1	1	0	0	1	19 o'clock
1	0	0	0	0	0	20 o'clock
			:			
1	0	0	0	1	1	23 o'clock

Note: Do not set data other than as shown above.

2. In 12-hour clock mode (MONTHR<MO0> ="0")

HOURR (1322H)

	7	6	5	4	3	2	1	0
Bit symbol			HO5	HO4	HO3	HO2	HO1	HO0
Read/Write			R/W					
After reset			Undefined					
Function	"0" is read.		PM/AM	10 hours column	8 hours column	4 hours column	2 hours column	1 hour column

0	0	0	0	0	0	0 o'clock (AM)
0	0	0	0	0	1	1 o'clock
0	0	0	0	1	0	2 o'clock
			:			
0	0	1	0	0	1	9 o'clock
0	1	0	0	0	0	10 o'clock
0	1	0	0	0	1	11 o'clock
1	0	0	0	0	0	0 o'clock (PM)
1	0	0	0	0	1	1 o'clock

Note: Do not set data other than as shown above.

(4) Day of the week column register (for PAGE0/1)

DAYR (1323H)

	7	6	5	4	3	2	1	0
Bit symbol						WE2	WE1	WE0
Read/Write						R/W		
After reset						Undefined		
Function	"0" is read.					W2	W1	W0

0	0	0	Sunday
0	0	1	Monday
0	1	0	Tuesday
0	1	1	Wednesday
1	0	0	Thursday
1	0	1	Friday
1	1	0	Saturday

Note: Do not set data other than as shown above.

(5) Day column register (PAGE0/1)

DATER (1324H)

	7	6	5	4	3	2	1	0
Bit symbol			DA5	DA4	DA3	DA2	DA1	DA0
Read/Write			R/W					
After reset			Undefined					
Function	"0" is read.		Day 20	Day 10	Day 8	Day 4	Day 2	Day 1

0	0	0	0	0	0	0
0	0	0	0	0	1	1st day
0	0	0	0	1	0	2nd day
0	0	0	0	1	1	3rd day
0	0	0	1	0	0	4th day
			:			
0	0	1	0	0	1	9th day
0	1	0	0	0	0	10th day
0	1	0	0	0	1	11th day
			:			
0	1	1	0	0	1	19th day
1	0	0	0	0	0	20th day
			:			
1	0	1	0	0	1	29th day
1	1	0	0	0	0	30th day
1	1	0	0	0	1	31st day

Note1: Do not set data other than as shown above.

Note2: Do not set for non-existent days (e.g.: 30th Feb).

(6) Month column register (for PAGE0 only)

MONTHR (1325H)

	7	6	5	4	3	2	1	0
Bit symbol				MO4	MO4	MO2	MO1	MO0
Read/Write				R/W				
After reset				Undefined				
Function	"0" is read.			10 months	8 months	4 months	2 months	1 month

0	0	0	0	1	January
0	0	0	1	0	February
0	0	0	1	1	March
0	0	1	0	0	April
0	0	1	0	1	May
0	0	1	1	0	June
0	0	1	1	1	July
0	1	0	0	0	August
0	1	0	0	1	September
1	0	0	0	0	October
1	0	0	0	1	November
1	0	0	1	0	December

Note: Do not set data other than as shown above.

(7) Select 24-hour clock or 12-hour clock (for PAGE1 only)

MONTHR (1325H)

	7	6	5	4	3	2	1	0
Bit symbol								MO0
Read/Write								R/W
After reset								Undefined
Function	"0" is read.							1: 24-hour 0: 12-hour

(8) Year column register (for PAGE0 only)

YEARR (1326H)

	7	6	5	4	3	2	1	0
Bit symbol	YE7	YE6	YE5	YE4	YE3	YE2	YE1	YE0
Read/Write	R/W							
After reset	Undefined							
Function	80 years	40 years	20 years	10 years	8 years	4 years	2 years	1 year

0	0	0	0	0	0	0	0	00 years
0	0	0	0	0	0	0	1	01 years
0	0	0	0	0	0	1	0	02 years
0	0	0	0	0	0	1	1	03 years
0	0	0	0	0	1	0	0	04 years
0	0	0	0	0	1	0	1	05 years
				:				
1	0	0	1	1	0	0	1	99 years

Note: Do not set data other than as shown above.

(9) Leap year register (for PAGE1 only)

YEARR (1326H)

	7	6	5	4	3	2	1	0
Bit symbol							LEAP1	LEAP0
Read/Write							R/W	
After reset							Undefined	
Function	"0" is read.						00: Leap year 01: One year after leap year 10: Two years after leap year 11: Three years after leap year	

0	0	Current year is a leap year
0	1	Current year is the year following a leap year
1	0	Current year is two years after a leap year
1	1	Current year is three years after a leap year

(10) Setting PAGE register (for PAGE0/1)

PAGER (1327H)

Read-modify-write instruction is prohibited.

	7	6	5	4	3	2	1	0
Bit symbol	INTENA			ADJUST	ENATMR	ENAALM		PAGE
Read/Write	R/W			W	R/W			R/W
After reset	0			Undefined	Undefined			Undefined
Function	INTRTC 0: Disable 1: Enable	"0" is read.		0: Don't care 1: Adjust	Clock 0: Disable 1: Enable	ALARM 0: Disable 1: Enable	"0" is read.	PAGE selection

Note: Please keep the setting order below of <ENATMR>, <ENAAML> and <INTENA>. Set different times for Clock/Alarm setting and interrupt setting.

(Example) Clock setting/Alarm setting

```
ld      (pager), 0ch    :   Clock, Alarm enable

ld      (pager), 8ch    :   Interrupt enable
```

PAGE	0	Select Page0
	1	Select Page1

ADJUST	0	Don't care
	1	Adjust sec. counter. When this bit is set to "1" the sec. counter becomes "0" when the value of the sec. counter is 0 – 29. When the value of the sec. counter is 30-59, the min. counter is carried and sec. counter becomes "0". Output Adjust signal during 1 cycle of f_{SYS}. After being adjusted once, Adjust is released automatically. (PAGE0 only)

(11) Setting reset register (for PAGE0/1)

RESTR (1328H)

Read-modify write-instruction is prohibited.

	7	6	5	4	3	2	1	0
Bit symbol	DIS1Hz	DIS16Hz	RSTTMR	RSTALM	–	–	–	–
Read/Write	W							
After reset	Undefined							
Function	1Hz 0: Enable 1: Disable	16Hz 0: Enable 1: Disable	1:Clock reset	1: Alarm reset	Always write "0"			

RSTALM	0	Unused
	1	Reset alarm register

RSTTMR	0	Unused
	1	Reset counter

<DIS1HZ>	<DIS1HZ>	(PAGER) <ENAALM>	Source signal
1	1	1	Alarm
0	1	0	1Hz
1	0	0	16Hz
Others			Output "0"

3.14.5 Operational description

(1) Reading clock data

1. Using 1Hz interrupt

1Hz interrupt and the count up of internal data synchronize. Therefore, data can read correctly if reading data after 1Hz interrupt occurred.

2. Using two times reading

There is a possibility of incorrect clock data reading when the internal counter carries over. To ensure correct data reading, please read twice, as follows:

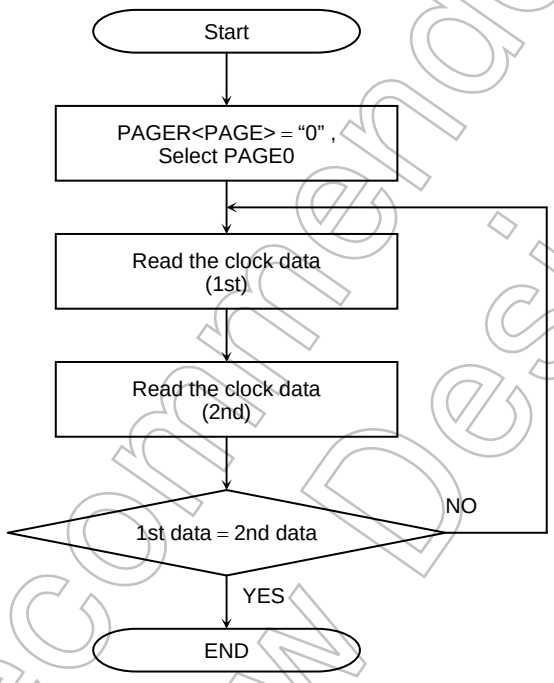


Figure 3.14.2 Flowchart of clock data read

(2) Writing clock data

When a carry over occurs during a write operation, the data cannot be written correctly. Please use the following method to ensure data is written correctly.

1. Using 1Hz interrupt

1Hz interrupt and the count up of internal data synchronize. Therefore, data can write correctly if writing data after 1Hz interrupt occurred.

2. Resetting a counter

There are 15-stage counter inside the RTC, which generate a 1Hz clock from 32,768 KHz. The data is written after reset this counter.

However, if clearing the counter, it is counted up only first writing at half of the setting time, first writing only. Therefore, if setting the clock counter correctly, after clearing the counter, set the 1Hz-interrupt to enable. And set the time after the first interrupt (occurs at 0.5Hz) is occurred.

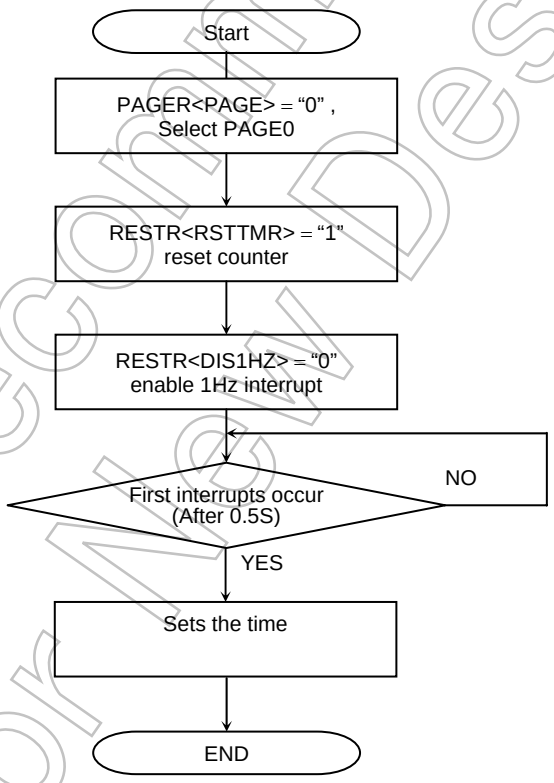


Figure 3.14.3 Flowchart of data write

2. Disabling the clock

A clock carry over is prohibited when "0" is written to PAGER<ENATMR> in order to prevent malfunction caused by the Carry hold circuit. While the clock is prohibited, the Carry hold circuit holds a one sec. carry signal from a divider. When the clock becomes enabled, the carry signal is output to the clock, the time is revised and operation continues. However, the clock is delayed when clock-disabled state continues for one second or more. Note that at this time system power is down while the clock is disabled. . In this case the clock is stopped and clock is delayed.

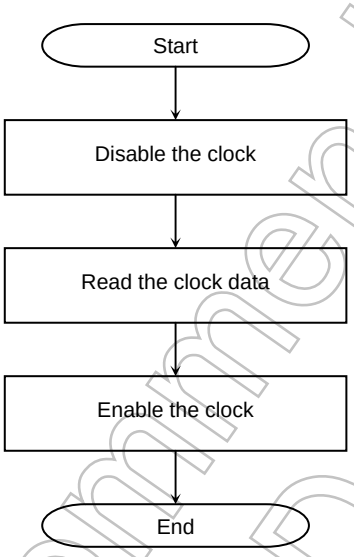


Figure 3.14.4 Flowchart of Clock disable

3.14.6 Explanation of the interrupt signal and alarm signal

The alarm function used by setting the PAGE1 register and outputting either of the following three signals from $\overline{\text{ALARM}}$ pin by writing "1" to PAGER<PAGE>. INTRTC outputs a 1-shot pulse when the falling edge is detected. RTC is not initialized by RESET. Therefore, when the clock or alarm function is used, clear interrupt request flag in INTC (interrupt controller).

(1) When the alarm register and the clock correspond, output "0".

(2) 1Hz Output clock .

(3) 16Hz Output clock.

(1) When the alarm register and the clock correspond, output "0"

When PAGER<ENAALM>= "1", and the value of PAGE0 clock corresponds with PAGE1 alarm register , output "0" to $\overline{\text{ALARM}}$ pin and generate INTRTC.

The methods for using the alarm are as follows:

Initialization of alarm is done by writing "1" to RESTR<RSTALM>. All alarm settings become Don't care. In this case, the alarm always corresponds with value of the clock, and if PAGER<ENAALM> is "1", INTRTC interrupt request is generated.

Setting alarm min., alarm hour, alarm date and alarm day is done by writing data to the relevant PAGE1 register.

When all setting contents correspond, RTC generates an INTRTC interrupt if PAGER<INTENA><ENAALM> is "1". However, contents which have not been set up (don't care state) are always considered to correspond.

Contents which have already been set up, cannot be returned independently to the Don't care state. In this case, the alarm must be initialized and alarm register reset.

The following is an example program for outputting an alarm from $\overline{\text{ALARM}}$ -pin at noon (PM12:00) every day.

```
LD      (PAGER), 09H        ;   Alarm disable, setting PAGE1
LD      (RESTR), D0H        ;   Alarm initialize
LD      (DAYR), 01H         ;   W0
LD      (DATAR),01H             1 day
LD      (HOURR), 12H        ;   Setting 12 o'clock
LD      (MINR), 00H         ;   Setting 00 min
                            ;   Set up time 31 μs (Note)
LD      (PAGER), 0CH        ;   Alarm enable
( LD    (PAGER), 8CH        ;   Interrupt enable )
```

When the CPU is operating at high frequency oscillation, it may take a maximum of one clock at 32 kHz (about 30us) for the time register setting to become valid. In the above example, it is necessary to set 31us of set up time between setting the time register and enabling the alarm register.

Note: This set up time is unnecessary when you use only internal interruption.

(2) With 1Hz output clock

RTC outputs a clock of 1Hz to $\overline{\text{ALARM}}$ pin by setting up PAGER<ENAALM>= "0", RESTR<DIS1HZ>= "0", <DIS16HZ>= "1". RTC also generates an INTRC interrupt on the falling edge of the clock.

(3) With 16Hz output clock

RTC outputs a clock of 16Hz to $\overline{\text{ALARM}}$ pin by setting up PAGER<ENAALM>= "0", RESTR<DIS1HZ>= "1", <DIS16HZ>= "0". RTC also generates INTRC an interrupt on the falling edge of the clock.

3.15 LCD Controller

This LSI incorporates two types of liquid crystal display driving circuit for controlling LCDs. One circuit supports an internal RAM LCD driver that can store display data in the LCD driver itself, and the other circuit supports a shift-register type (SR mode) LCD driver that must serially transfer the display data to the LCD driver for each display picture.

It is possible for SR type to use PAN function which is shifted the display without rewriting display data.

1) Shift register type LCD driver control mode (SR mode)

Before setting start register, set the mode of operation, the start address of source data save memory and LCD size to control register.

After setting start register, the LCDC outputs a bus release request to the CPU and reads data from source memory.

The LCDC then transmits LCD size data to the external LCD driver through the special LCDC data bus (LD7to LD0). At this time, the control signals connected to the LCD driver output the specified waveform which is synchronized with the data transmission. After display data reading from RAM is completed, the LCDC cancels the bus release request and the CPU will re-start. It is possible to read the data from display memory at high-speed by FIFO buffer. And it is possible to transfer from LCD-driver-bus corresponded to the AC-standard of connected LCD driver.

In the TMP92CA25, SRAM and SDRAM burst mode can be used for the display RAM. 10-Kbytes of internal RAM are available for use as display RAM. As internal SRAM access is very fast (32-bit bus width, 1 SYSCLK read/write), it is possible to reduce CPU load to a minimum, enabling LCDC DMA. In addition, it can decrease much power consumption during displaying by using internal SRAM. It is possible to display 320×240(QVGA size at max size) using internal SRAM.

2) Internal RAM LCD driver control mode (RAM mode)

Data transmission to the LCD driver is executed CPU command. After setting operation mode to control register, when CPU command is executed the LCDC outputs chip select signal to the LCD driver connected externally by control pin (LCP0 etc.). Therefore control of data transmission numbers corresponding to LCD size is controlled by CPU command.

This mode supports random-access-type and sequential-access-type.

3.15.1 LCDC features by Mode

The various features and pin operations of are as follows.

Table 3.15.1 LCDC features by Mode (example: using TOSHIBA LCD driver)

LCD driver		Shift Register Type LCD Driver Control Mode	RAM Built-in Type LCD Driver Control Mode
		STN	
Display color		Monochrome	Depends on LCD driver
The number of picture elements which can be handled		Monochrome, 4-, 8- and16-level grayscale Row (Common): 64, 120, 128, 160, 200, 240, 320, 480 Column (Segment): 64, 128, 160, 240, 320, 480, 640	Depends on LCD driver
Data bus width (SRAM, SDRAM)		16 bits, 32 bits (Internal RAM)	Depends on CS/WAIT controller (Same as normal memory access)
Data bus width (Destination: LCD driver)		4 bits, 8 bits	
Maximum transmission rate (at f_{SYS} = 20 [MHz])		12.5 ns/byte at Internal RAM 25 ns/byte at external SRAM, 50 ns/byte at external SRAM,	–
Pan function		Available to use	Depends on LCD driver
External pins	LCD data bus LD7 to LD0	Connect to data bus of LCD driver. • 8-bit LD7 to LD0 • 4-bit LD3 to LD0	Not used
	D7 to D0	Not used	Connect to data bus of LCD driver.
	Bus state R/W	Not used	Connect to $\overline{WR}$ pin of LCD driver.
	Address bus A0	Not used	Connect to D/I pin of LCD driver for distinction of data or instruction.
	LCP0	Shift clock 0 for column LCD driver Connect to CP pin of column LCD driver. LD bus data is latched at falling edge of this signal.	Chip enable signal for column LCD driver Connect to $\overline{CE}$ pin of 1st column LCD driver.
	LLP	Latch pulse output for column and row LCD driver Connect to LP pin of column and row LCD driver. Display data is renewed to output buffer at rising edge of this signal.	Chip enable signal for column LCD driver Connect to $\overline{CE}$ pin of 2nd column LCD driver.
	LFR	Alternating signal for LCD display control. Connect to FR pin of LCD driver.	Chip enable signal for column LCD driver Connect to $\overline{CE}$ pin of 3rd column LCD driver.
	LBCD	Refresh rate signal	Chip enable signal for row LCD driver Connect to $\overline{LE}$ pin of row LCD driver.

3.15.2 SFRs

LCDMODE0 Register

LCDMODE0 (0840H)

	7	6	5	4	3	2	1	0
Bit symbol	RAMTYPE1	RAMTYPE0	SCPW1	SCPW0	LMODE	INTMODE	LDO1	LDO0
Read/Write	R/W							
After reset	0	0	1	0	0	0	0	0
Function	Display RAM 00: Internal RAM1 01: External SRAM 10: SDRAM 11: Internal RAM2		LD bus transmission speed 00: Reserved 01: 2 × f_{SYS} 10: 4 × f_{SYS} 11: 8 × f_{SYS}		LCD driver type 0: SR 1: RAM built-in	Interrupt 0: LP 1: BCD	LD bus width control 00: 4bit A_type 01: 4bit B_type 10: 8bit type Others: Reserved	

Note: Only “burst 1clk access” SDRAM access is supported

LCD f_{FP} Register

LCDFFP (0282H)

	7	6	5	4	3	2	1	0
Bit symbol	FP7	FP6	FP5	FP4	FP3	FP2	FP1	FP0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Setting bit7 to bit0 for f_{FP}							

Divide FRM Register

LCDDVM (0283H)

	7	6	5	4	3	2	1	0
Bit symbol	FMN7	FMN6	FMN5	FMN4	FMN3	FMN2	FMN1	FMN0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Setting DVM bit7 to bit0							

LCD Size Setting Register

LCDSIZE (0843H)

	7	6	5	4	3	2	1	0
Bit symbol	COM3	COM2	COM1	COM0	SEG3	SEG2	SEG1	SEG0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Common setting 0000: Reserved 0001: 64 0010: 120 0011: 128 0100: 160 0101: 200 0110: 240 0111: 320 1000: 480 Others: Reserved				Segment setting 0000: Reserved 0001: 64 0010: 128 0011: 160 0100: 240 0101: 320 0110: 480 0111: 640 Others: Reserved			

LCD Control-0 Register

LCDCTL0 (0844H)

	7	6	5	4	3	2	1	0
Bit symbol		ALL0	FRMON	–	FP9	MMULCD	FP8	START
Read/Write		R/W		R/W	R/W			
After reset		0	0	0	0	0	0	0
Function		Column data setting 0: Normal 1: All display data “0”	Frame divide 0: Stop 1: Operate	Always write “0”	f_{FP} setting bit9	Built-in RAM type LCD driver 0: Sequential access 1: Random access	f_{FP} setting bit8	LCDC start 0: Stop 1: Start

LCDC Source Clock Counter Register

LCDSCC (0846H)

	7	6	5	4	3	2	1	0
Bit symbol	SCC7	SCC6	SCC5	SCC4	SCC3	SCC2	SCC1	SCC0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	LCDC source clock counter bit7 to bit0							

	Start Address Register			Number of Common Register		
	H (Bit23 to 16)	M (Bit15 to 8)	L (Bit7 to 1)	H (Bit8)	L (Bit7 to 0)	–
A area	LSARAH (0852H)	LSARAM (0851H)	LSARAL (0850H)	CMNAH (0855H)	CMNAL (0854H)	–
After reset	40H	00H	00H	00H	00H	
B area	LSARBH (0858H)	LSARBM (0857H)	LSARBL (0856H)	CMNBH (085BH)	CMNBL (085AH)	–
After reset	40H	00H	00H	00H	00H	
C area	LSARCH (085EH)	LSARCM (085DH)	LSARCL (085CH)	–	–	–
After reset	40H	00H	00H			

Note: All registers can read-modify-write.

LCDC0L/LCDC0H/LCDC1L/LCDC1H/LCDC2L/LCDC2H/LCDR0L/LCDR0H Register

	7	6	5	4	3	2	1	0
Bit symbol	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write	Depends on external LCD driver specification.							
After reset	Depends on external LCD driver specification.							
Function	Depends on external LCD driver specification.							

Address	Function	Chip Enable Pin
3C0000H to 3CFFFFH	Built-in RAM LCD Driver1	LCP0
3D0000H to 3DFFFFH	Built-in RAM LCD Driver2	LLP
3E0000H to 3EFFFFH	Built-in RAM LCD Driver3	LFR
3F0000H to 3FFFFFH	Built-in RAM LCD Driver4	LBCD

3.15.3 Shift Register Type LCD Driver Control Mode (SR mode)

3.15.3.1 Description of Operation

Set the mode of operation, start address of display memory, grayscale level and LCD size to control registers before setting start register.

After setting start register, the LCDC outputs a bus release request to the CPU and reads data from source memory. After data reading from source data is completed, the LCDC cancels the bus release request and the CPU will restart. The LCDC then transmits LCD size data to the external LCD driver through the LD bus (special data bus only for LCD driver). At this time, the control signals (LCP0 etc.) connected to the LCD driver output the specified waveform which is synchronized with the data transmission.

The LCD controller generates control signals (LFR, LBCD, LLP etc.) from base clock LCDSCC. LCDSCC is the clock generator for the LCD controller, which is generated by system clock f_{SYS}.

This LSI has a special clock generator for the LCDC. Details of LCD frame refresh rate can be set using this special generator. This generator is made from an 8-bit counter and 1/16 speed clock from the system clock.

Note 1: During display data read from source memory (during DMA operation), the CPU is stopped by the internal BUSREQ signal. When using SR mode LCDC, programmers must monitor CPU performance.

Note 2: This LSI has a 16-Kbyte SRAM, this internal RAM is available for use as display RAM. Internal RAM access is very fast (32-bit bus width, 1 SYSCLK read/write), it is possible to reduce CPU load to a minimum. It can also be used 16bits access mode if using internal RAM. This mode is for internal RAM to use as display RAM effectively.

When using display RAM as SDRAM, set SDRAM size by SDACR2 register of SDRAMC.

Data output width is selectable between 4 bits or 8 bits, and data output sequence selectable between 2 modes.

SR type LCD control setting is described below.

3.15.3.2 Memory Space (Common spec. SR mode and TFT mode)

The LCDC can display an LCD panel image which is divided horizontally into 3 parts; upper, middle and lower. Each area is called A area, B area and C area with the characteristics shown below.

The Start/End address of each area in the physical memory space can be defined in the LCD start/end address registers. C area can be defined only in start address.

A and B areas can be displayed by program and set to enable or not in Start Address register and Row Number register. When the Row Number registers of A and B areas are set to 0, C area takes over all panel space.

When the size of A or B area is greater than the LCD panel, the area of the panel is all C area because the displaying priority is A > B > C. If the A area is set to enable while the panel area is defined as all C area (A and B areas are disabled), C area is shifted below the LCD panel and A area is inserted from the top of the LCD panel. Similarly if the B area is set to enable while the panel area is defined as all C area, B area is inserted from the bottom of the C area overlapping.

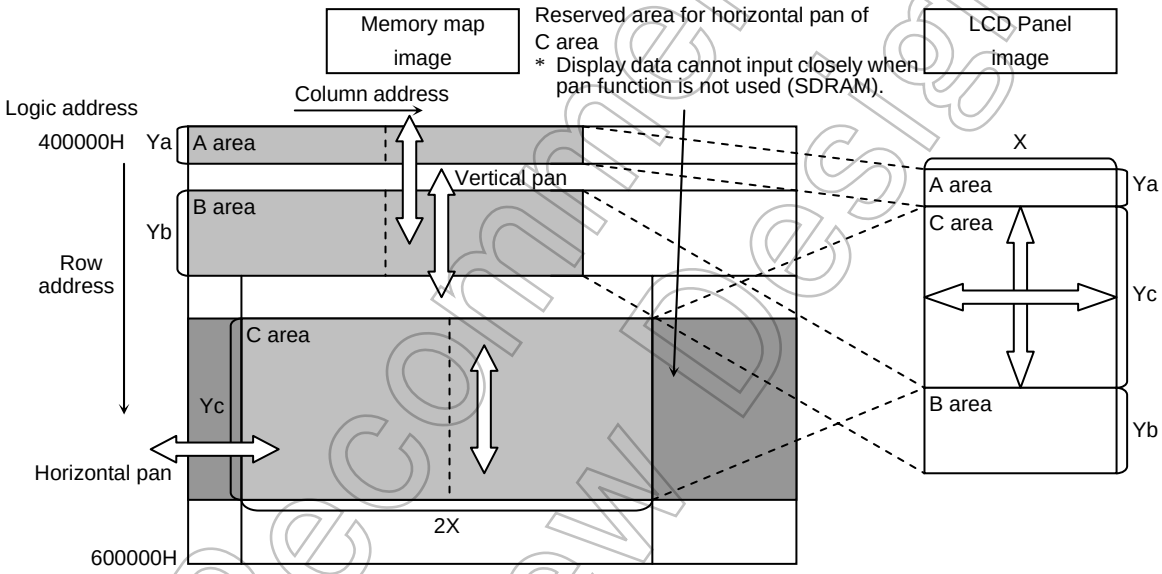


Figure 3.15.1 Memory Mapping from Physical Memory to LCD Panel

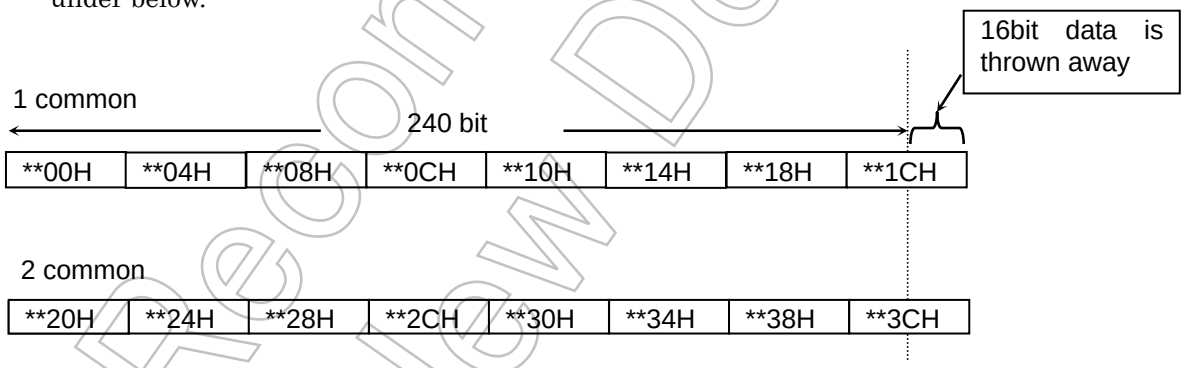
3.15.3.3 Display Memory Mapping and Panning Function (Common spec. SR mode and TFT mode)

The LCDC can only change the panel window if you change each start address of A, B and C areas. The display area can be panned vertically and horizontally by changing the row address and column address. This LCDC can select many display modes: 1 bpp (monochrome), 2 bpp (4 grayscales), 3 bpp (8 grayscales), 4 bpp (16 grayscales), 8 bpp (256 colors) and 12 bpp (4096 colors) and 1-line (row). Data volume is different for each display mode. When using the panning function, care must be exercised in calculating the address for each display mode. For details, refer to Figure 3.15.2, "Relation of memory map image and output data". This LCDC can also support external SDRAM, SRAM and internal SRAM for display RAM.

When using SDRAM for display RAM, data from one line to the next line cannot be input continuously in display RAM, even if the panning function is not used. One row address of display SDRAM corresponds to the first line of the display panel. Second line display data cannot now be set within the first row address of the display RAM even if the necessary data for the size you want to display does not fill the capacity of first row address of the display SDRAM. Adding one line to the display panel is equal to adding one address to the row address of the display SDRAM. In other words, when using SDRAM for display RAM, address calculation for panning is simple.

When using SRAM for display RAM, data from one line to the next line must be input continuously to the display RAM. However, address calculation for panning is complex and horizontal panning function is not supported.

And when setting segment = 240 and select internal RAM, the limitation is added under below.

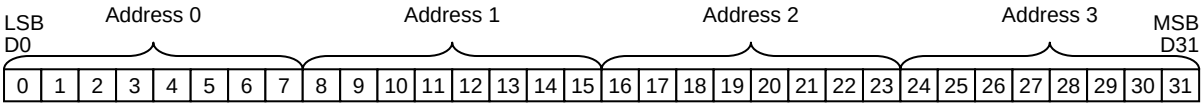


The last 16bits data in 8th access is thrown away. If using all data effectively, set internal SRAM2 mode (16bit access mode). And it is possible to allocate data tightly.

3.15.3.4 Data Transmission

This LSI has an LD bus (LD7 to LD0): a special data bus for LCD driver. Bus width of 4-bits_Atype, 4-bits_B-type or 8-bits type can be supported. Relation between memory mapping and Output data is shown to Figure 3.15.2.

- Monochrome: 1 bpp (bit per pixel)
  Display memory image



LD bus output sequence

4-bit width A type

LD0	0	→	4	→	8	→	12	...
LD1	1	→	5	→	9	→	13	...
LD2	2	→	6	→	10	→	14	...
LD3	3	→	7	→	11	→	15	...
LD4	Not use							
LD5	Not use							
LD6	Not use							
LD7	Not use							

4-bit width B type

LD0	4	→	0	→	12	→	8	...
LD1	5	→	1	→	13	→	9	...
LD2	6	→	2	→	14	→	10	...
LD3	7	→	3	→	15	→	11	...
LD4	Not used							
LD5	Not used							
LD6	Not used							
LD7	Not used							

8-bit width type

LD0	0	→	8	...
LD1	1	→	9	...
LD2	2	→	10	...
LD3	3	→	11	...
LD4	4	→	12	...
LD5	5	→	13	...
LD6	6	→	14	...
LD7	7	→	15	...

Figure 3.15.2 Relation of Memory Map Image and Output Data

3.15.3.5 Refresh Rate Setting

Frame cycle (refresh rate) is generated from setting of LSCC (LCDSCC<SCC7:0>) and FP [9:0] (LCDCTL0<FP9, 8>, LCDFFP<FP7:0>). The LBCD terminal outputs one pulse every cycle and the LFR normally outputs an inverted signal every cycle. But when the DIVIDE FRAME function is used, the LFR signal changes to a special signal for high quality display.

(1) Basic clock setting

This LSI has a special clock generator for basic source clock used in the LCD controller. This generator can set details of the refresh rate for the LCDC.

This generator is made by dividing the system clock by 16 and an 8-bit counter.

The following shows the method of setting and calculation.

f_{BCD}[Hz]: Frame rate (Refresh rate: Frequency of LBCD signal)
FP: FP [9:0] setting value of FFP register
SCC: <SCC7:0> setting value of LSCC register

$$f_{BCD}\,[Hz] = f_{SYS}\,[Hz] / ((SCC+1) \times 16 \times FP)$$

Example:

f_{SYS} [Hz] = 20MHz, 240COM (FP = 240), target refresh rate = 70Hz
70 [Hz] = 20000000 [Hz]/((SCC+1) × 16 × 240)
(SCC+1) = 20000000/(70 ×16 × 240) = 74.4
Value of setting to register is only integer, SCC = 73. The floating value is disregarded.

In this case, the refresh rate comes to 70.3 [Hz]

LCDC Source Clock Counter Register

LCDSCC (0846H)

	7	6	5	4	3	2	1	0
Bit symbol	SCC7	SCC6	SCC5	SCC4	SCC3	SCC2	SCC1	SCC0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	LCDC Source Clock Counter bit7 to bit0							

* Data should be written from 1-hex to FFFF-hex in the above register. It cancannot operate if set to “0”.

* If the refresh rate is set too fast, it may not be in time with the display data. t_{LP} time is determined by SCC.

$$t_{LP}\,[s] = (1/f_{SYS}\,[Hz]) \times 16 \times (SCC + 1)$$

t_{LP} is shown in 1-line (ROW) display time. 1-line data transmission must be completed during t_{LP} cycle time. AboutRefer to “Data transmission and bus occupation” for details of data transmission time.

(2) Refresh rate adjust function (Correct function)

In this function, the LBCD frequency: refresh rate is generated by setting LCDSCC<SCC7:0> and FP [9:0] register. The FFP value is normally set at the same value as the ROW number, but this value can be used for correction of BCD frequency: refresh rate.

This function always uses a value greater than the ROW number, set to slower frequency. The LCDC cannot operate correctly if a value smaller than the ROW number is set.

The following is an example of settings:

Example:

f_{SYS} [Hz] = 20 MHz, 240COM (FP = 240), Target refresh rate = 70 Hz

140 [Hz] = 20000000 [Hz]/((SCC+1) × 16 × 240)

(SCC+1) = 20000000/(70 × 16 × 240) = 74.4

Value of setting to register is only integer, SCC = 73. The floating value is disregarded.

In this case, refresh rate comes to 70.3 [Hz]

f_{BCD} [Hz] = f_{SYS} [Hz]/((SCC+1) × 16 × FP)

FP value is adjusted to set SCC=73 in above equation again.

70 [Hz] = 20000000/(74 × 16 × FP)

FP = 241.3

Value of setting to register is only integer, FP = 241.

In this case, refresh rate comes to 70.0 [Hz]

LCD f_{FP} Register

		7	6	5	4	3	2	1	0
LCDFFP (0841H)	Bit symbol	FP7	FP6	FP5	FP4	FP3	FP2	FP1	FP0
	Read/Write	R/W							
	After reset	0	0	0	0	0	0	0	0
	Function	Setting bit7 to bit0 for f_{FP}							

Reference) We recommend refresh rate values in the region of: Monochrome: 70 [Hz]

(3) Divide frame adjust function

The DIVIDE FRAME function allows for adjustments to reduce uneven display in large LCD panels.

When this function is enabled by setting <FRMON> = 1, the LFR signal alternates between high and low level with each LLP cycle for the LCDDVM register values given below.

When this function is disabled by setting LCDCTL<FRMON> = 0, the LFR signal alternates between high and low level with each LBCD cycle. This function is not affected by the LBCD timing.

Note: Availability of this function depends on the actual LCD driver or LCD panel used. We recommend checking that register's value when used in the proposed environment.

Divide Frame Register

		7	6	5	4	3	2	1	0
LCDDVM (0842H)	Bit symbol	FMN7	FMN6	FMN5	FMN4	FMN3	FMN2	FMN1	FMN0
	Read/Write	R/W							
	After reset	0	0	0	0	0	0	0	0
	Function	Setting DVM bit7 to bit0							

(Reference) In general, prime numbers (3, 5, 7, 11, 13 ...) are best for the value of the LCDDVM register.

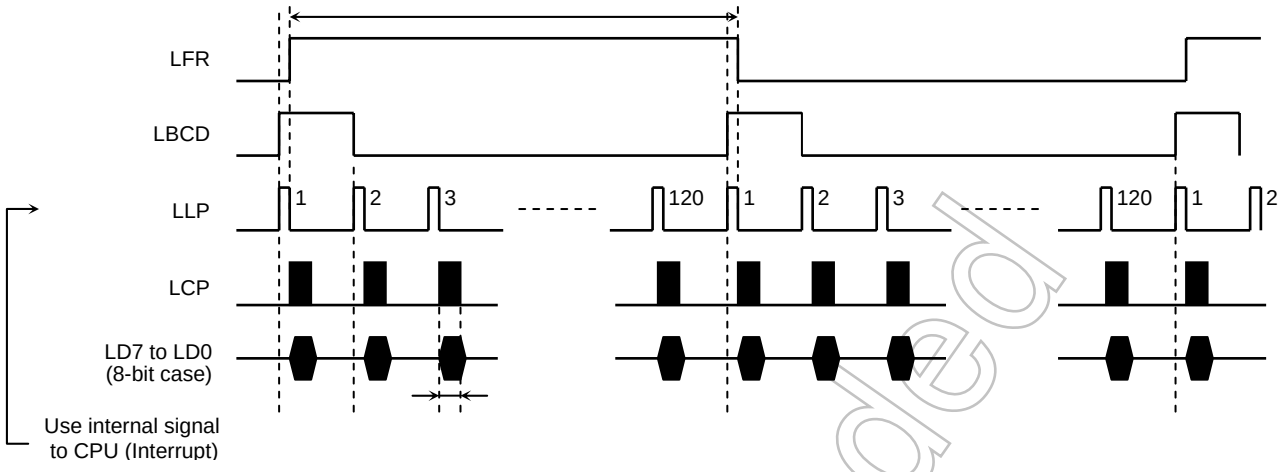
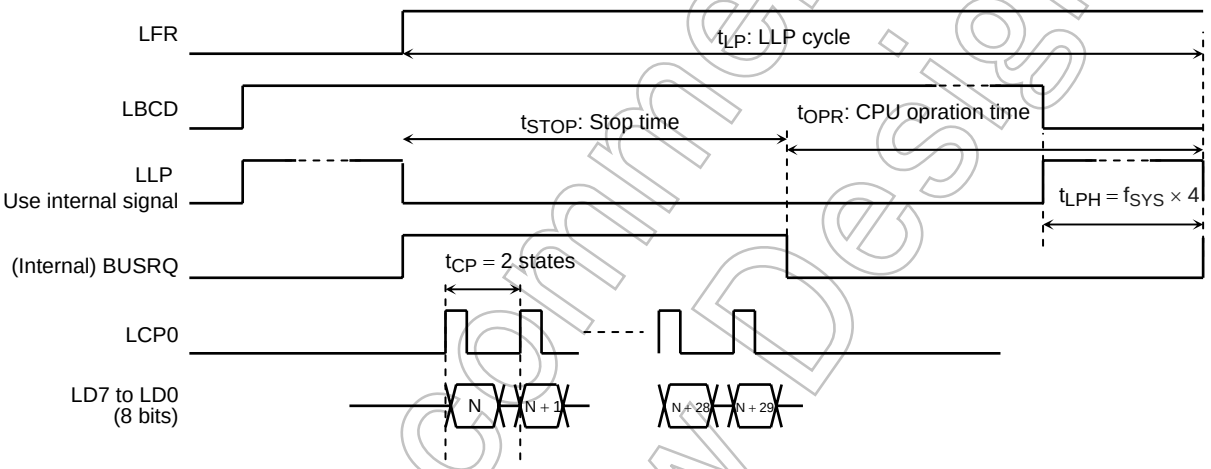


Figure 3.15.3 Whole Timing Diagram of SR Mode



Note: There is internal FI/FO_RAM (160bits) for controlling the speed of transfering to LCD driver. If the size of segment is over 160, several bus request is generated at one t_{LP} interval. (640segment: 5times max)

Figure 3.15.4 Detailed Timing Diagram of SR Mode

Condition: FFP [9:0] setting = 240 (COM) + 63, LCDDVM<FMN7:0> = 0BH

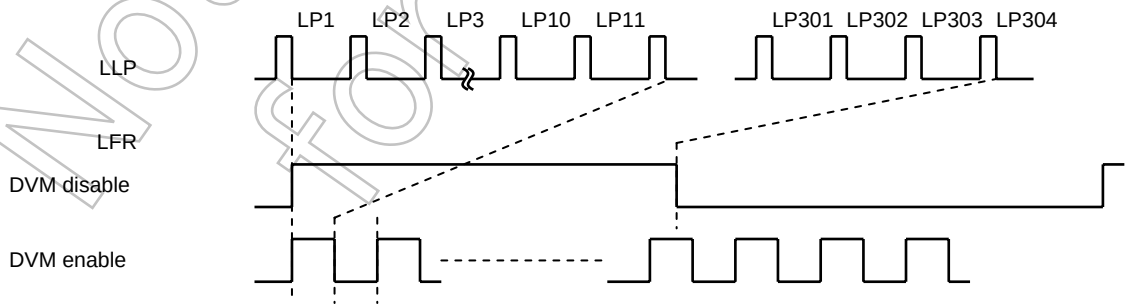


Figure 3.15.5 Waveform of LLP, LFR

3.15.3.6 LCD Data Transmission Speed and Data Bus Occupation Rate

After setting start register, the LCDC outputs a bus release request to the CPU and reads data from source memory. The LCDC then transmits LCD size data to the external LCD driver through the special LCDC data bus (LD11 to LD0). At this time, the control signals connected to the LCD driver output the specified waveform which is synchronized with the data transmission. After data reading from RAM for display is completed, the LCDC cancels the bus release request and the CPU will restart.

During data read from source memory (during DMA operation), the CPU is stopped by the internal BUSREQ signal. When using SR mode LCDC, programmers must monitor CPU performance. The occupation rate of the data bus depends on data size, transmission speed (CPU clock speed) and display RAM type used.

Display RAM	Bus Width	Valid Data Reading Time (f_{SYS} Clock/Byte)	Valid Data Reading Time t_{LRD} (ns/Byte) at f_{SYS} = 20 MHz
External SRAM	16 bits	2/2	50
	32 bits	2/4	25
Internal RAM	32 bits	1/4	12.5
External SDRAM	16 bits	*1/2	*25

Note: When using SDRAM for display RAM, overhead time (+ 8 clocks) is required for every 1 row data reading.

t_{STOP} refers to the CPU stoppage time during transmission of 1 row data. t_{STOP} is calculated by the equation below for each display mode.

$$t_{STOP} = (SegNum /8) \times t_{LRD}$$

SegNum : Number of segment

When SDRAM is used, more overhead time is required.

$$t_{STOP} = (SegNum /8) \times t_{LRD} + ((1/f_{SYS}) \times 8)$$

Data bus occupation rate equals the percentage of t_{STOP} time in t_{LP} time.

$$\text{Data bus occupation rate} = t_{STOP}/t_{LP}$$

Note: For t_{LP} time, refer to “refresh rate setting”.

3.15.3.7 Timing Diagram of LD Bus

The TMP92CA25 can select to display RAM for external SRAM: Available to set WAIT, internal SRAM of 10Kbyte and external SRAM: 64, 128, 256 and 512 Mbits.

As a 160-bit FIFO buffer is built into this LCDC, the LD bus speed can be controlled.

The speed can be selected from 3 kinds of LCP cycle: ($f_{SYS}/2$, $f_{SYS}/4$, and $f_{SYS}/8$)

LD bus data: LD7 to LD0 is out at rising edge of LCP, LCD driver receives at falling edge of LCP.

Note: If the LCP cycle is too slow it may not transfer correctly.

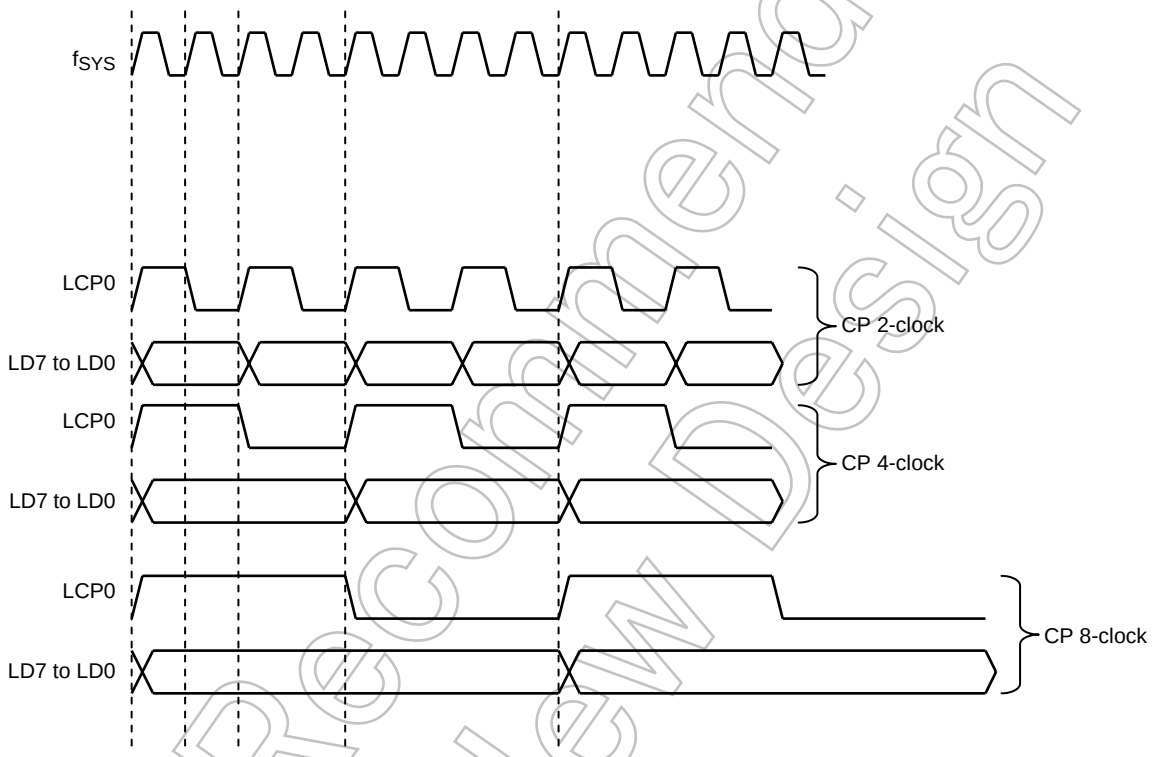


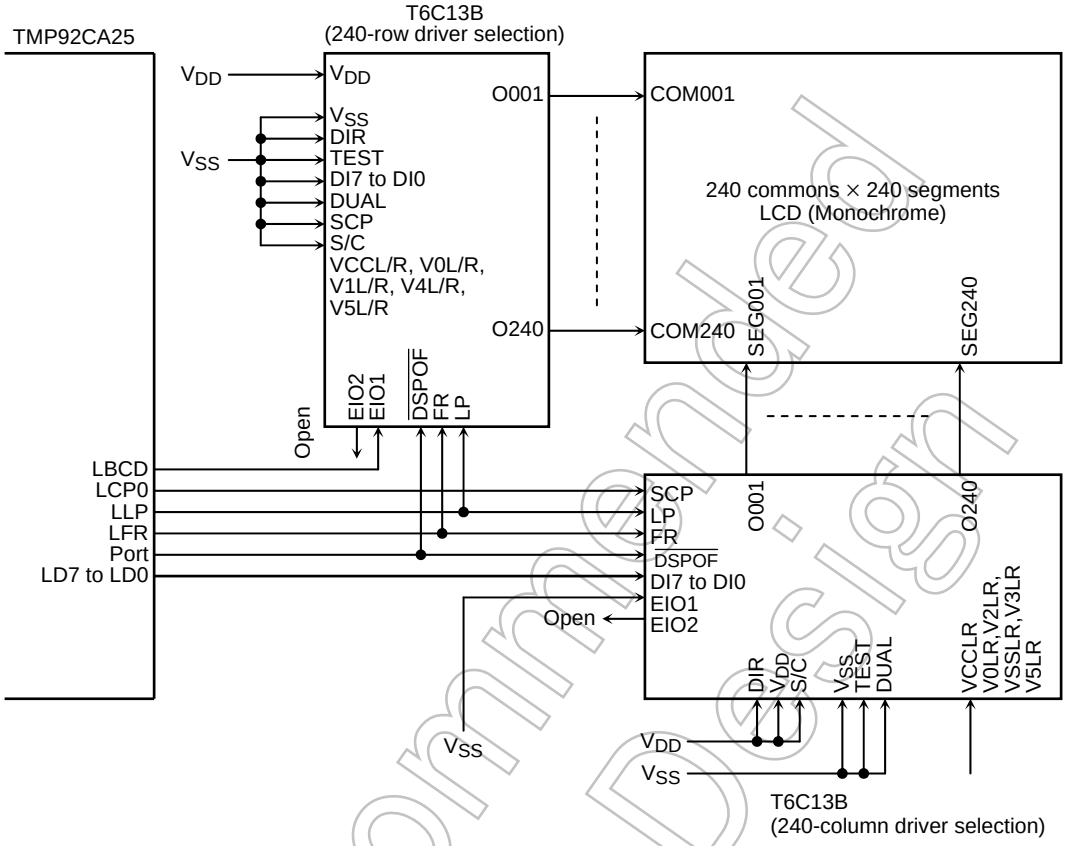
Figure 3.15.6 Selection of LCP Cycle

If LCP cycle is not set at a suitable speed with respect to the refresh rate, LD bus data will not transfer correctly. t_{LP} time is shown in the equation below.

$$t_{LP}\,[s] = (1/f_{SYS}\,[Hz]) \times 16 \times (SCC+1)$$

Data transmission must finish in t_{LP} time. Set SCC clock and LCP0 speed to be less than t_{LP} time. For setting of SCC, refer to “basic clock setting” of “refresh rate setting”.

3.15.3.8 Example of SR mode LCD driver connection



Note: Other circuit is necessary for LCD drive power supply for LCD driver display.

Figure 3.15.7 Interface Example for Shift Register Type LCD Driver

3.15.3.9 Program Example (4 K colors STN)

```
; LCDC condition
; Panel = 320seg × 240com,      fBCD = 70Hz(at fSYS = 20MHz)
; LD bus = 8bit, 4clock     Display memory = Internal RAM(2000H-)
; ********PORT settings *********
        ld      (pkfc),0x0f             ;  PK0-3: LCP0, LLP, LFR, LBCD
        ldw     (plcr),0xffff           ;  PL0-7: LD0-7

; ********LCD settings*********
        ld      xix,0x00002000          ;  Internal RAM start address
        ld      (lsarcl),xix            ;  Only C-area
        ld      (lcdmode0),0x22         ;  Display memory = Internal RAM, SCP = 4clock, 8bit bus
        ld      (lcdffp),240            ;
        ld      (lcdsize),0x65             240com × 320seg
        ld      (lcdctl0),0x00          ;
        ld      (lcdscc),74             ;  SCC = fSYS / (fBCD × 16 × FP)
                                        ;        = 20MHz/ (70 × 16 × 240) = 74.4
        set     0,(lcdctl0)             ;  Start LCDC display
```

3.15.4 Built-in RAM Type LCD driver Mode

3.15.4.1 Description of Operation

Data transmission to the LCD driver is executed by a transmit instruction from the CPU.

After setting operation mode of to the control register, when a CPU transmits instruction is executed the LCDC outputs a chip select signal to the LCD driver connected externally by the control pin (LCP0...). Therefore control of data transmission numbers corresponding to LCD size is controlled by CPU instruction. There are 2 kinds of LCD driver address in this case, which are selected by the LCDCTL<MMULCD> register.

3.15.4.2 Random Access Type

This corresponds to address direct writing type LCD driver when <MMULCD> = "1".

The transmission address can also assign the memory area 3C0000H – 3FFFFF, the four areas each being 64 Kbytes.

Interface and access timing are the same as for normal memory. Refer to the memory access timing section.

Table 3.15.2 Random Access Type Built-in RAM Type LCD driver

Address	Function	Chip Enable Terminal
3C0000H to 3CFFFFH	Built-in RAM LCD driver 1	LCP0
3D0000H to 3DFFFFH	Built-in RAM LCD driver 2	LLP
3E0000H to 3EFFFFH	Built-in RAM LCD driver 3	LFR
3F0000H to 3FFFFFH	Built-in RAM LCD driver 4	LBCD

3.15.4.3 Sequential Access Type

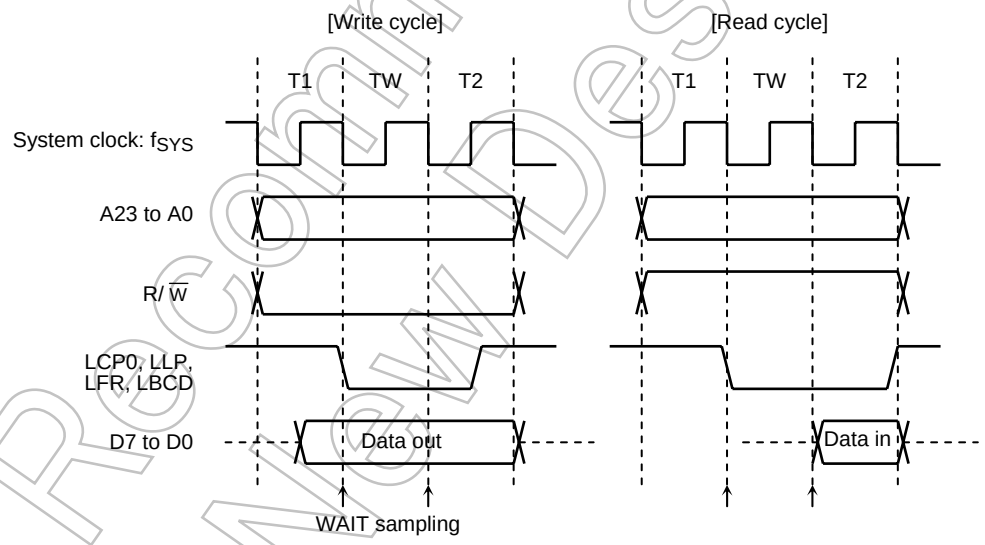
Data transmission to the LCD driver is executed by a transmit instruction from the CPU.

After setting operation mode to the control register, when a CPU transmit instruction is executed the LCDC outputs a chip select signal to the LCD driver connected externally by the control pin (LCP0...). Therefore control of data transmission numbers corresponding to LCD size is controlled by CPU instruction . There are 2 kinds of LCD driver address in this case, which are selected by the LCDCTL<MMULCD> register.

This corresponds to a LCD driver which has each 1 byte of instruction register and display data register in LCD driver when <MMULCD> = "0". Please select the transmission address at this time from 1FE0H to 1FE7H.

LCDC0L/LCDC0H/LCDC1L/LCDC1H/LCDC2L/LCDC2H/LCDR0L/LCDR0H Register

	7	6	5	4	3	2	1	0
Bit symbol	D7	D6	D5	D4	D3	D2	D1	D0
Read/Write	Depends on external LCDD specification							
After reset	Depends on external LCDD specification							
Function	Depends on external LCDD specification							

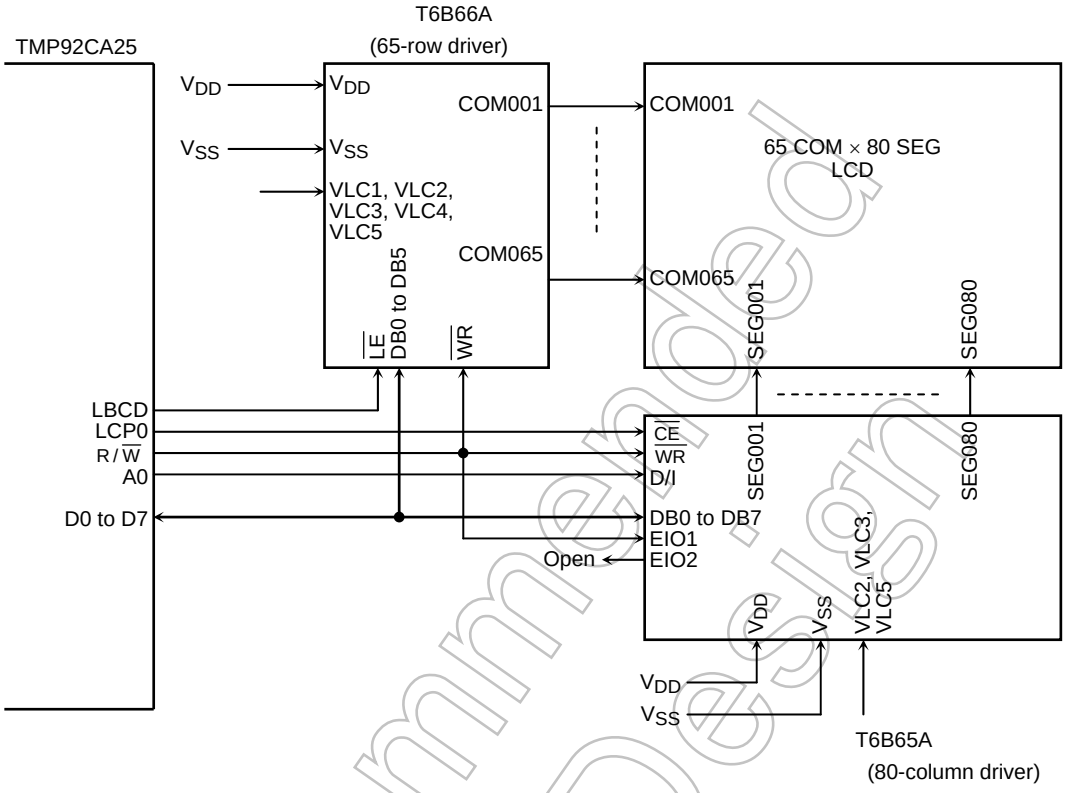


Note 1: This waveform is in the case of 3-state access.

Note 2: Rising timing of chip enable signal (e.g LCP0) is different.

Figure 3.15.8 Example of Access Timing for Built-in RAM Type LCD Driver (Wait = 0)

3.15.4.4 Example of Built-in RAM LCD driver connection



Note: Other circuit is required for power supply for LCD driver display.

Figure 3.15.9 Interface Example for Built-in RAM and Sequential Access Type LCD Driver

3.15.4.5 Program Example

- Setting example: when using 80 segments × 65 commons LCD driver.

  Assign external column driver to LCDC1 and row driver to LCDC4.

  This example uses LD instruction in setting of instruction and micro DMA burst function for soft start in setting of display data.

When storing 650-byte transfer data to LCD driver.

```
; ********Setting for LCDC*********
        ld      (lcdmode0), 00h     ;  Select RAM mode
        ld      (lcdctl0), 00h      ;  MMULCD = 0 (Sequential access mode)

; ********Setting for mode of LCDC0/LCDR0*********
        ld      (lcdc1l), xx        ;  Setting instruction for LCDC1
        ld      (lcdc4l), xx        ;  Setting instruction for LCDC4

; ********Setting for micro DMA and INTTC (ch0)*********
        ld      a, 08h              ;  Source address INC mode
        ldc     dmam0, a            ;
        ld      wa, 650             ;  Count = 650
        ldc     dmac0, wa           ;
        ld      xwa, 002000h        ;  Source address = 002000H
        ldc     dmas0, xwa          ;
        ld      xwa, 1fe1h          ;  Destination address = 1FE1H (LCDC0H)
        ldc     dmad0, xwa          ;
        ld      (intetc01), 06H     ;  INTTC0 level = 6
        ei      6                   ;
        ld      (dmab), 01h         ;  Burst mode
        ld      (dmar), 01h         ;  Soft start
```

3.16 Melody/Alarm Generator (MLD)

The TMP92CA25 contains a melody function and alarm function, both of which are output from the MLDALM pin. Five kinds of fixed cycle interrupt are generated using a 15-bit counter for use as the alarm generator.

The features are as follows.

1) Melody generator

The Melody function generates signals of any frequency (4 Hz to 5461 Hz) based on a low-speed clock (32.768 kHz), and outputs the signals from the MLDALM pin.

The melody tone can easily be heard by connecting an external loudspeaker.

2) Alarm generator

The alarm function generates eight kinds of alarm waveform having a modulation frequency (4096 Hz) determined by the low-speed clock (32.768 kHz). This waveform can be inverted by setting a value to a register.

The alarm tone can easily be heard by connecting an external loudspeaker.

Five kinds of fixed cycle interrupts are generated (1 Hz, 2 Hz, 64 Hz, 512 Hz, and 8192 Hz) by using a counter which is used for the alarm generator.

This section is constituted as follows.

3.16.1 Block Diagram

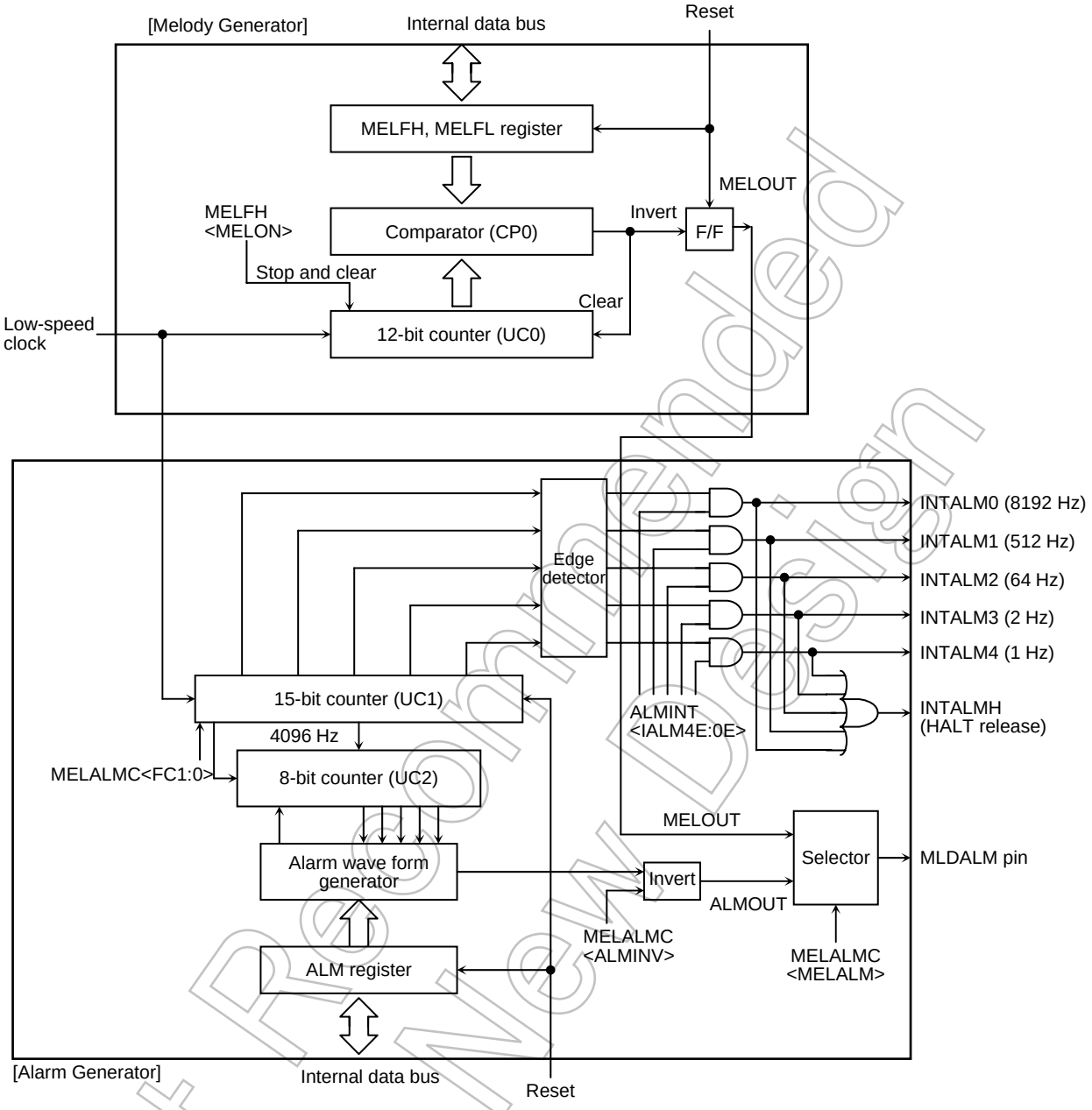


Figure 3.16.1 MLD Block Diagram

3.16.2 Control Registers

ALM Register

ALM (1330H)

	7	6	5	4	3	2	1	0
Bit symbol	AL8	AL7	AL6	AL5	AL4	AL3	AL2	AL1
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Setting alarm pattern							

MELALMC Register

MELALMC (1331H)

	7	6	5	4	3	2	1	0
Bit symbol	FC1	FC0	ALMINV	–	–	–	–	MELALM
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Free-run counter control 00: Hold 01: Restart 10: Clear 11: Clear and start		Alarm waveform invert 1: Invert	Always write “0”				Output waveform select 0: Alarm 1: Melody

Note 1: MELALMC<FC1> is always read “0”.

Note 2: When setting MELALMC register except <FC1:0> while the free-run counter is running, <FC1:0> is kept “01”.

MELFL Register

MELFL (1332H)

	7	6	5	4	3	2	1	0
Bit symbol	ML7	ML6	ML5	ML4	ML3	ML2	ML1	ML0
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	Setting melody frequency (Lower 8 bits)							

MELFH Register

MELFH (1333H)

	7	6	5	4	3	2	1	0
Bit symbol	MELON				ML11	ML10	ML9	ML8
Read/Write	R/W				R/W			
After reset	0				0	0	0	0
Function	Control melody counter 0: Stop and clear 1: Start				Setting melody frequency (Upper 4 bits)			

ALMINT Register

ALMINT (1334H)

	7	6	5	4	3	2	1	0
Bit symbol			–	IALM4E	IALM3E	IALM2E	IALM1E	IALM0E
Read/Write			R/W					
After reset			0	0	0	0	0	0
Function			Always write “0”	1: Interrupt enable for INTALM4 to INTALM0				

3.16.3 Operational description

3.16.3.1 Melody Generator

The Melody function generates signals of any frequency (4 Hz to 5461 Hz) based on a low-speed clock (32.768 kHz) and outputs the signals from the MLDALM pin.

The melody tone can easily be heard by connecting an external loud speaker.

(Operation)

MELALMC<MELALM> must first be set as 1 in order to select the melody waveform to be output from MLDALM. The melody output frequency must then be set to 12-bit registers MELFH and MELFL.

The following are examples of settings and calculations of melody output frequency.

(Formula for calculating melody waveform frequency)

at fs = 32.768 [kHz]

Melody output waveform f_{MLD} [Hz] = 32768/(2 × N + 4)

Setting value for melody N = (16384/ f_{MLD}) − 2

(Note: N = 1 to 4095 (001H to FFFH), 0 is not acceptable.)

(Example program)

When outputting an "A" musical note (440 Hz)

```
LD    (MELALMC), – – X X X X 1 B   ; Select melody waveform
LD    (MELFL), 23H                 ; N = 16384/440 – 2 = 35.2 = 023H
LD    (MELFH), 80H                 ; Start to generate waveform
```

Reference) Basic musical scale setting table

Scale	Frequency [Hz]	Register Value: N
C	264	03CH
D	297	035H
E	330	030H
F	352	02DH
G	396	027H
A	440	023H
B	495	01FH
C	528	01DH

3.16.3.2 Alarm Generator

The alarm function generates eight kinds of alarm waveform having a modulation frequency of 4096 Hz determined by the low-speed clock (32.768 kHz). This waveform is reversible by setting a value to a register.

The alarm tone can easily be heard by connecting an external loud speaker .

Five kinds of fixed cycle (interrupts can be generated 1 Hz, 2 Hz, 64 Hz, 512 Hz, 8 192 Hz) by using a counter which is used for the alarm generator.

(Operation)

MELALMC<MELALM> must first be set as 0 in order to select the alarm waveform to be output from MLDALMC. The "10" must be set on the MELALMC <FC1:0> register, and clear internal counter.

Finally the alarm pattern must then be set on the 8-bit register of ALM. If it is inverted output-data, set <ALMINV> as invert.

The following are examples of program, setting value of alarm pattern and waveform of each setting value.

(Setting value of alarm pattern)

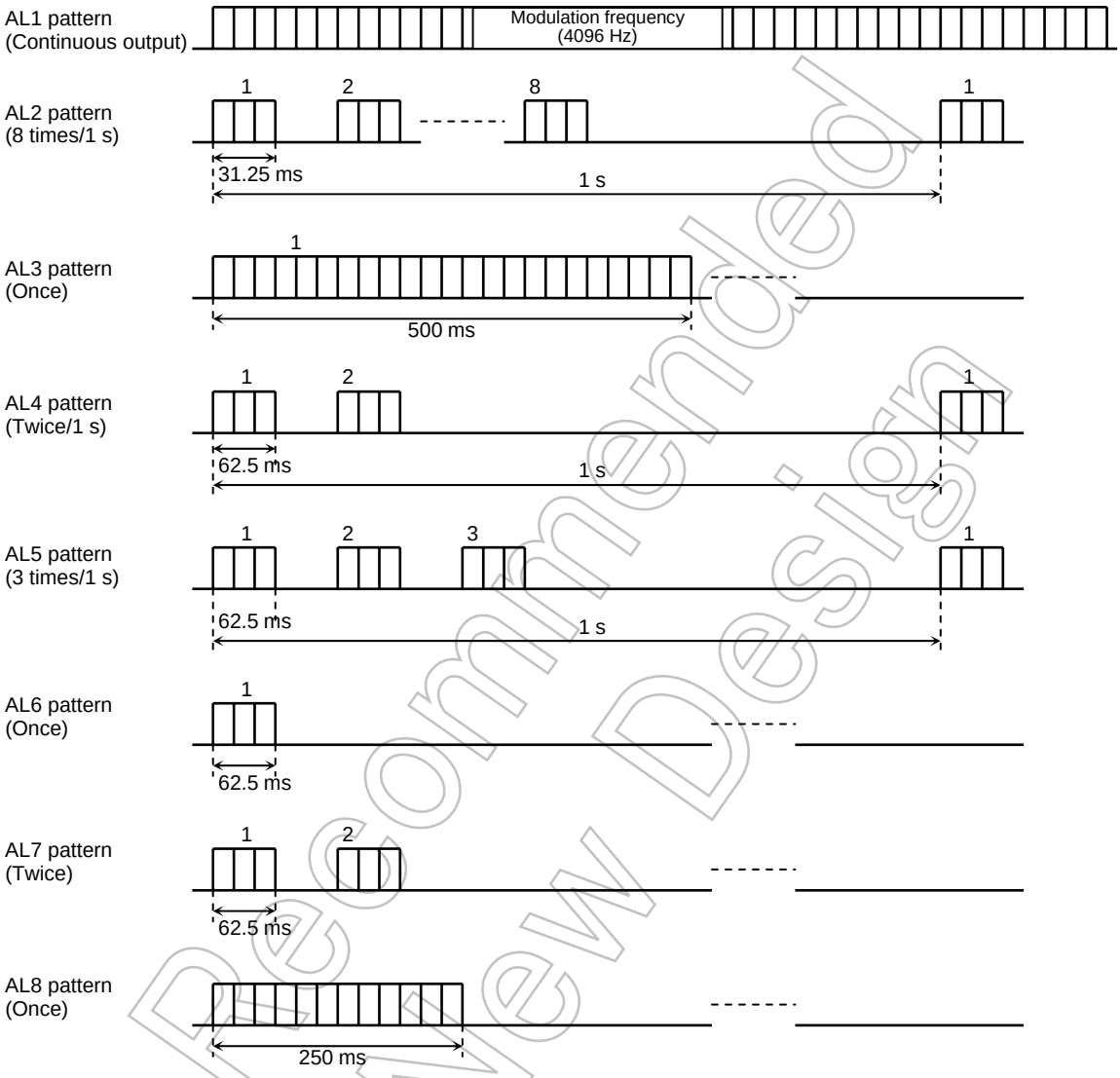
Setting Value for ALM Register	Alarm Waveform
00H	Write "0"
01H	AL1 pattern
02H	AL2 pattern
04H	AL3 pattern
08H	AL4 pattern
10H	AL5 pattern
20H	AL6 pattern
40H	AL7 pattern
80H	AL8 pattern
Others	Undefined (Do not set)

(Example program)

When outputting AL2 pattern (31.25 ms/8 times/1 s)

```
LD      (MELALMC), C0H      ;  Set output alarm waveform
                            ;  Free-run counter start
LD      (ALM), 02H          ;  Set AL2 pattern, start
```

Example: Waveform of alarm pattern for each setting value (Not inverted)



3.17 SDRAM Controller (SDRAMC)

The TMP92CA25 includes an SDRAM controller which supports SDRAM access by CPU/LCDC.

The features are as follows.

(1) Support SDRAM

Data rate type:	Only SDR (Single data rate) type
Bulk of memory:	16/64/128/256/512 Mbits
Number of banks:	2/4 banks
Width of data bus:	16
Read burst length:	1 word/full page
Write mode:	Single/burst

(2) Initialize function

All banks precharge command
8 times auto refresh command
Set the mode register command

(3) Access mode

	CPU Access	LCDC Access
Read burst length	1 word/full page selectable	Full page
Addressing mode	Sequential	Sequential
CAS latency (clock)	2	2
Write mode	Single/burst selectable	–

(4) Access cycle

CPU Access (Read/write)

Read cycle:	1 word– 4 states/full page – 1 state
Write cycle:	Single – 3 states/burst – 1 state
Access data width:	1 byte/ 1 word/ 1 long word

LCDC Burst Access (Read only)

Read cycle:	full page – 1 state
Full page Over head:	4 states (200 ns at f_{SYS} = 20 MHz)
Access data width:	1 word/ 1 long word

(5) Refresh cycle auto generate

Auto-refresh is generated while another area is being accessed.

Refresh interval is programmable.

Self-refresh is supported

Note 1: Display data for LCDC must be set from the head of each page.

Note 2: Condition of SDRAM's area set by CS1 setting of memory controller.

3.17.1 Control Registers

Figure 3.17.1 shows the SDRAMC control registers. Setting these registers controls the operation of SDRAMC.

SDRAM Access Control Register 1

SDACR1 (0250H)

	7	6	5	4	3	2	1	0
Bit symbol	–	–	SMRD	SWRC	SBST	SBL1	SBL0	SMAC
Read/Write	R/W							
After reset	0	0	0	0	0	1	0	0
Function	Always write “0”	Always write “0”	Mode register set delay time 0: 1 clock 1: 2 clocks	Write recover time 0: 1 clock 1: 2 clocks	Burst stop command 0: Precharge all 1: Burst stop	Selecting burst length (Note 1) 00: Reserved 01: Full-page read, burst write 10: 1-word read, single write 11: Full-page read, single write		SDRAM controller 0: Disable 1: Enable

Note 1: Issue mode register set command after changing <SBL1:0>. Exercise care in settings when changing from “full-page read” to “1-word read”. Please refer to “Limitations arising when using SDRAM”.

SDRAM Access Control Register 2

SDACR2 (0251H)

	7	6	5	4	3	2	1	0
Bit symbol				SBS	SDRS1	SDRS0	SMUXW1	SMUXW0
Read/Write				R/W				
After reset				0	0	0	0	0
Function				Number of banks 0: 2 banks 1: 4 banks	Selecting ROW address size 00: 2048 rows (11 bits) 01: 4096 rows (12 bits) 10: 8192 rows (13 bits) 11: Reserved		Selecting address multiplex type 00: TypeA (A9-) 01: TypeB (A10-) 10: TypeC (A11-) 11: Reserved	

SDRAM Refresh Control Register

SDRCR (0252H)

	7	6	5	4	3	2	1	0
Bit symbol	–			SSAE	SRS2	SRS1	SRS0	SRC
Read/Write	R/W			R/W				
After reset	0			1	0	0	0	0
Function	Always write “0”			SR Auto Exit function 0: Disable 1: Enable	Refresh interval 000: 47 states 001: 78 states 010: 97 states 011: 124 states 100: 156 states 101: 195 states 110: 249 states 111: 312 states			Auto refresh 0: Disable 1: Enable

SDRAM Command Register

SDCMM (0253H)

	7	6	5	4	3	2	1	0
Bit symbol						SCMM2	SCMM1	SCMM0
Read/Write						R/W		
After reset						0	0	0
Function						Command issue (Note 1) (Note 2) 000: Not execute 001: Initialization sequence a. Precharge All command b. Eight Auto Refresh commands c. Mode Register Set command 100: Mode Register Set command 101: Self Refresh Entry command 110: Self Refresh Exit command Others: Reserved		

Note 1: <SCMM2:0> is automatically cleared to “000” after the specified command is issued. Before writing the next command, make sure that <SCMM2:0> is “000”. In the case of the Self Refresh Entry command, however, <SCMM2:0> is not cleared to “000” by execution of this command. Thus, this register can be used as a flag for checking whether or not Self Refresh is being performed.

Note 2: The Self Refresh Exit command can only be specified while Self Refresh is being performed.

Figure 3.17.1 SDRAM Control Registers

3.17.2 Operation Description

(1) Memory access control

SDRAM controller is enabled when SDACR1<SMAC> = 1. And then SDRAM control signals ($\overline{SDCS}$, $\overline{SDRAS}$, $\overline{SDCAS}$, $\overline{SDWE}$, SDLLDQM, SDLUDQM, SDCLK and SDCKE) are operating during the time CPU or LCDC accesses CS1 area.

1. Address multiplex function

In the access cycle, outputs row/column address through A0 to A15 pin. And multiplex width is decided by setting SDACR2<SMUXW0:1> of use memory size. The relation between multiplex width and Row/Column address is shown in Table 3.17.1 Address Multiplex.

Table 3.17.1 Address Multiplex

TMP92CA25 Pin Name	Address of SDRAM Accessing Cycle				
	Row Address			Column Address	
	TypeA <SMUXW> "00"	TypeB <SMUXW> "01"	TypeC <SMUXW> "10"	16-Bit Data Bus Width B1CSH<BnBUS> = "01"	32-Bit Data Bus Width B1CSH<BnBUS> = "10"
A0	A9	A10	A11	A1	A2
A1	A10	A11	A12	A2	A3
A2	A11	A12	A13	A3	A4
A3	A12	A13	A14	A4	A5
A4	A13	A14	A15	A5	A6
A5	A14	A15	A16	A6	A7
A6	A15	A16	A17	A7	A8
A7	A16	A17	A18	A8	A9
A8	A17	A18	A19	A9	A10
A9	A18	A19	A20	A10	A11
A10	A19	A20	A21	AP *	AP *
A11	A20	A21	A22	Row address	
A12	A21	A22	A23		
A13	A22	A23	EA24		
A14	A23	EA24	EA25		
A15	EA24	EA25	EA26		

* AP: Auto Precharge

Burst length of SDRAM read/write by CPU can be select by setting SDACR1<SBL1:0>. Burst length of accessing by LCDC is fixed to operation contents.

SDRAM access cycle is shown in Figure 3.17.2 and Figure 3.17.3.

SDRAM access cycle number does not depend on the settings of B1CSL register. In the full page burst read cycle, a mode register set cycle and a precharge cycle are automatically inserted at the beginning and end of a cycle.

(2) Instruction executing on SDRAM

The CPU can execute instructions on SDRAM. However, the following functions do not operate.

a) Executing HALT instruction

b) Execute instructions that write to SDCMM register

These operations must be executed by another memory such as the built-in RAM.

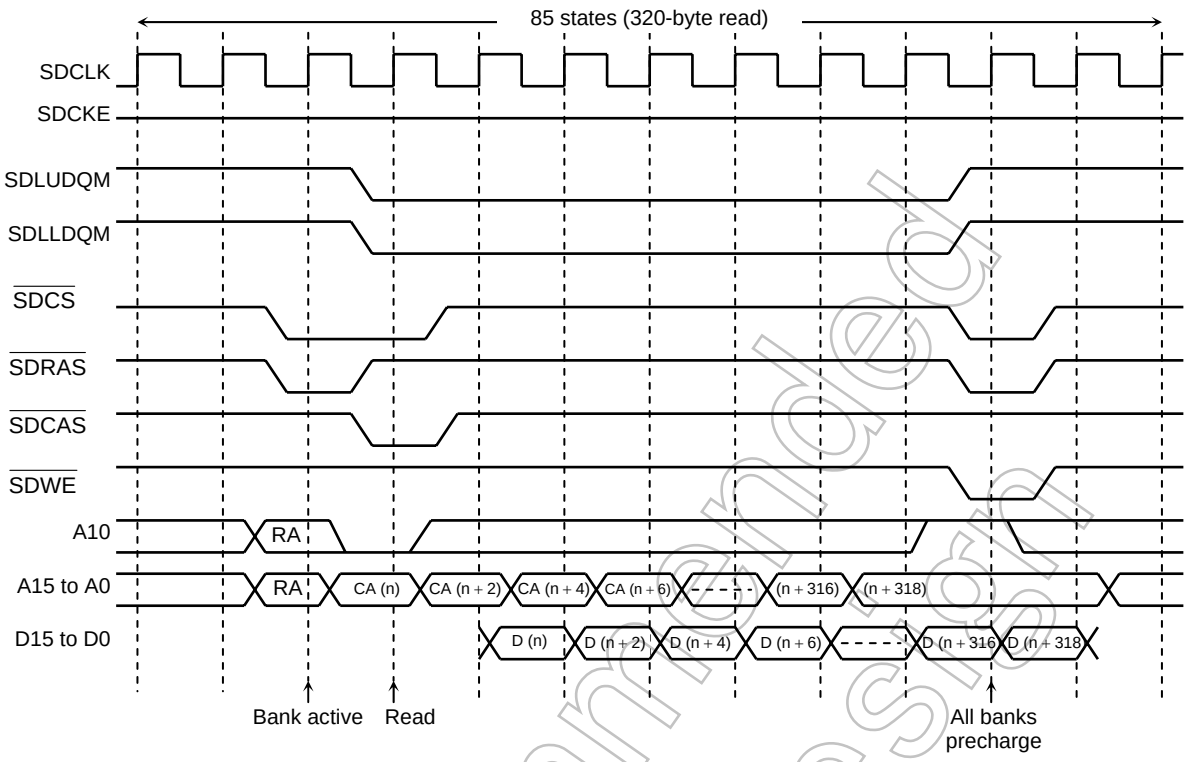


Figure 3.17.2 Timing of Burst Read Cycle

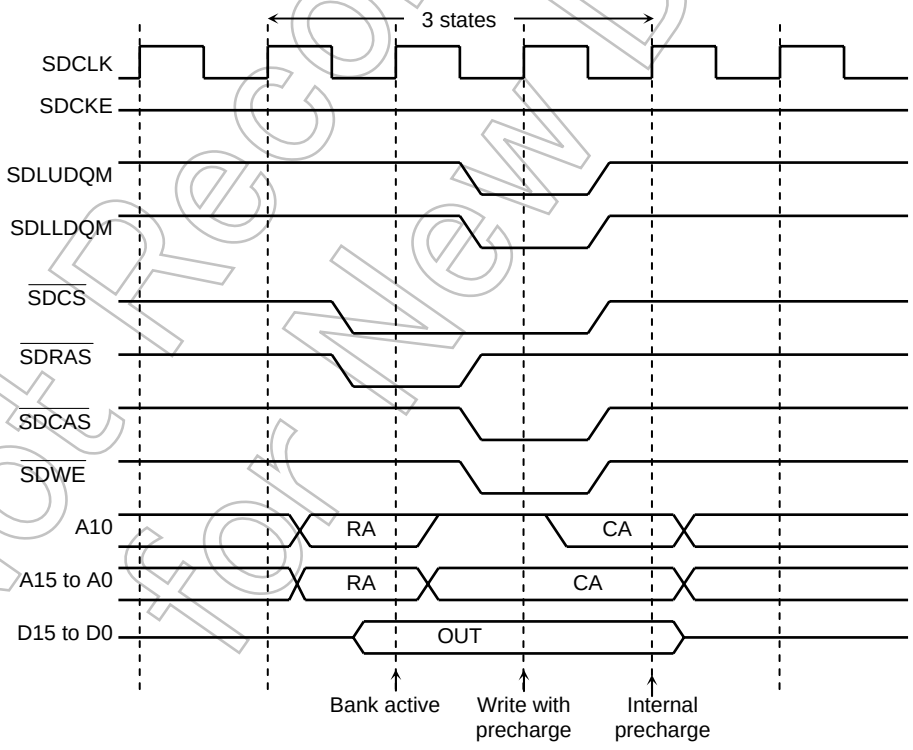


Figure 3.17.3 Timing of CPU Write Cycle

(Structure of Data Bus: 16 bits × 1, operand Size: 2 bytes, address: 2n + 0)

(3) Refresh control

This LSI supports two refresh commands: auto-refresh and self-refresh.

(a) Auto-refresh

The auto-refresh command is automatically generated at intervals set by SDRCR<SRS2:0> by setting SDRCR<SRC> to "1". The generation interval can be set from between 47 to 312 states (2.4 μs to 15.6 μs at f_{SYS} = 20 MHz).

CPU operation (instruction fetch and execution) stops while performing the auto-refresh command. The auto-refresh cycle is shown in Figure 3.17.4 and the auto-refresh generation interval is shown in Table 3.17.2. The Auto-Refresh function cannot be used in IDLE1 and STOP modes. In these modes, use the Self-Refresh function to be explained next.

Note: A system reset disables the Auto-Refresh function.

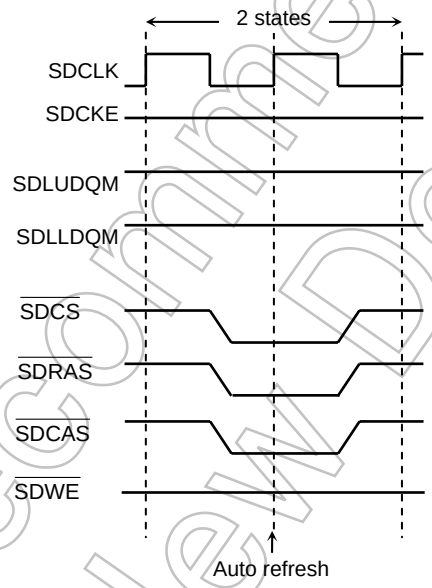


Figure 3.17.4 Timing of Auto-Refresh Cycle

Table 3.17.2 Refresh Cycle Insertion Interval (Unit: μs)

SDRCR<SRS2:0>			Insertion Interval (State)	f_{SYS} Frequency (System clock)					
SRS2	SRS1	SRS0		6 MHz	10 MHz	12.5 MHz	15 MHz	17.5 MHz	20 MHz
0	0	0	47	7.8	4.7	3.8	3.1	2.7	2.4
0	0	1	78	13.0	7.8	6.2	5.2	4.5	3.9
0	1	0	97	16.2	9.7	7.8	6.5	5.5	4.9
0	1	1	124	20.7	12.4	9.9	8.3	7.1	6.2
1	0	0	156	26.0	15.6	12.5	10.4	8.9	7.8
1	0	1	195	32.5	19.5	15.6	13.0	11.1	9.8
1	1	0	249	41.5	24.9	19.9	16.6	14.2	12.4
1	1	1	312	52.0	31.2	25.0	20.8	17.8	15.6

(b) Self-refresh

The self-refresh ENTRY command is generated by setting SDCMM<SCMM2:0> to "101". The self-refresh cycle is shown in Figure 3.17.5. During self-refresh Entry, refresh is performed within the SDRAM (an auto-refresh command is not needed).

Note 1: When standby mode is released by a system reset, the I/O registers are initialized and the Self Refresh state is exited. Note that the Auto Refresh function is also disabled at this time.

Note 2: The SDRAM cannot be accessed while it is in the Self Refresh state.

Note 3: To execute the HALT instruction after the Self Refresh Entry command, insert at least 10 bytes of NOP or other instructions between the instruction to set SDCMM<SCMM2:0> to "101" and the HALT instruction.

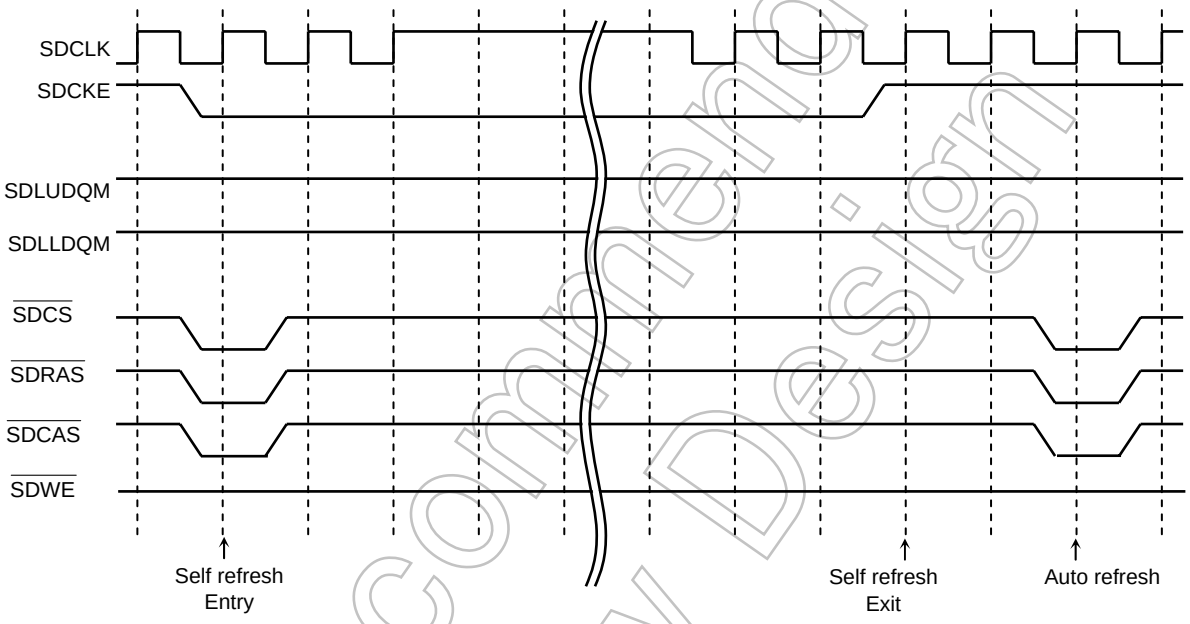


Figure 3.17.5 Timing of Self-Refresh Cycle

Self-Refresh condition is released by executing Serf-Refresh command. Way to execute Self-Refresh EXIT command is 2 ways: write "110" to SDCMM<SCMM2:0>, or execute EXIT automatically by synchronizing to releasing HALT condition. Both ways, after it executes Auto-Refresh at once just after Self-Refresh EXIT, it executes Auto-Refresh at setting condition. When it became EXIT by writing "110" to <SCMM2:0>, <SCMM2:0> is cleared to "000".

EXIT command that synchronize to release HALT condition can be prohibited by setting SDRCR<SSAE> to "0". If don't set to EXIT automatically, set to prohibit. If using condition of SDRAM is satisfied by operation clock frequency (clock gear down, SLOW mode condition and so on) is falling, set to prohibit. Figure 3.17.6 shows execution flow in this case.

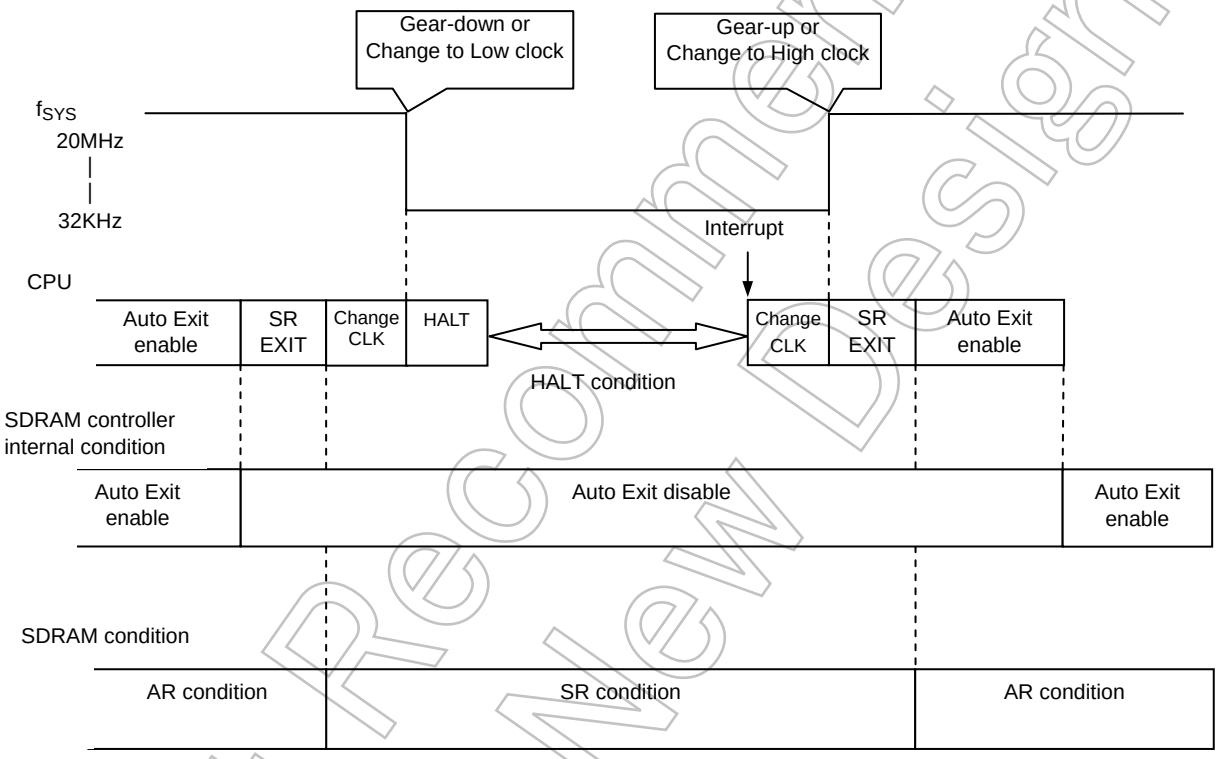


Figure 3.17.6 Execution flow example (Execute HALT instruction at low-speed clock).

```
; ********Sample program *********
LOOP1:
        LDB     A, (SDCMM)                  ;   Check the command register clear
        ANDB    A, 00000111B                ;
        J       NZ, LOOP1                   ;

        LDW     (SDRCR), 0000010100000011B  ;   Auto Exit disable→ Self-refresh Entry

        NOP×10                              ;   Wait for execution of self-refresh entry
        LD      (SYSCR1), 00001---B         ;   fs
        HALT
        NOP                                 ;   Self-refresh Exit (Internal signal only)

        LD      (SYSCR1), 00000---B         ;   fc
        LD      (SDCMM), 00000110B          ;   Self-refresh Exit (command)
        LD      (SDRCR), 0001---1B          ;   Auto Exit enable
```

(4) SDRAM initialize

This LSI can generate the following SDRAM initialize routine after introduction of power supply to SDRAM. The command is shown in Figure 3.17.7.

1. Precharge all command
2. Eight Auto Refresh commands
3. Mode Register set command

The above commands are issued by setting SDCMM<SCMM2:0> to "001".

While these commands are issued, the CPU operation (an instruction fetch, command execution) is halted.

Before executing the initialization sequence, appropriate port settings must be made to enable the SDRAM control signals and address signals (A0 to A15).

After the initialization sequence is completed, SDCMM<SCMM2:0> is automatically cleared to "000".

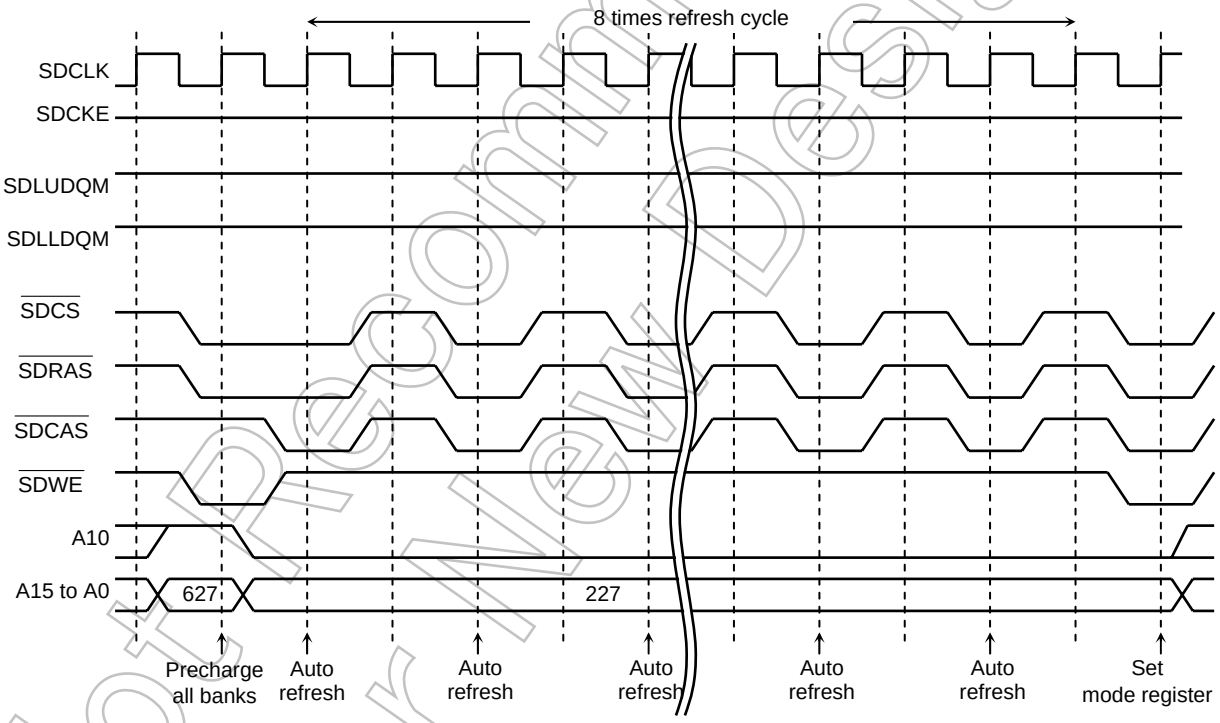


Figure 3.17.7 Timing of Initialization command

(5) Connection example

Figure 3.17.8 shows an example of connections between the TMP92CA25 and SDRAM

Table 3.17.3 Connection with SDRAM

TMP92CA25 Pin Name	SDRAM Pin Name Data Bus Width: 16 Bits				
	16 M	64 M	128 M	256 M	512 M
A0	A0	A0	A0	A0	A0
A1	A1	A1	A1	A1	A1
A2	A2	A2	A2	A2	A2
A3	A3	A3	A3	A3	A3
A4	A4	A4	A4	A4	A4
A5	A5	A5	A5	A5	A5
A6	A6	A6	A6	A6	A6
A7	A7	A7	A7	A7	A7
A8	A8	A8	A8	A8	A8
A9	A9	A9	A9	A9	A9
A10	A10	A10	A10	A10	A10
A11	BS	A11	A11	A11	A11
A12	–	BS0	BS0	A12	A12
A13	–	BS1	BS1	BS0	BS0
A14	–	–	–	BS1	BS1
A15	–	–	–	–	–
$\overline{SDCS}$	CS	CS	CS	CS	CS
SDLUDQM	UDQM	UDQM	UDQM	UDQM	UDQM
SDLLDQM	LDQM	LDQM	LDQM	LDQM	LDQM
$\overline{SDRAS}$	RAS	RAS	RAS	RAS	RAS
$\overline{SDCAS}$	CAS	CAS	CAS	CAS	CAS
$\overline{SDWE}$	WE	WE	WE	WE	WE
SDCKE	CKE	CKE	CKE	CKE	CKE
SDCLK	CLK	CLK	CLK	CLK	CLK
SDACR <SMUXW>	00: TypeA	00: TypeA	01: TypeB	01: TypeB	10: TypeC

(An): Row address

: Command address pin of SDRAM

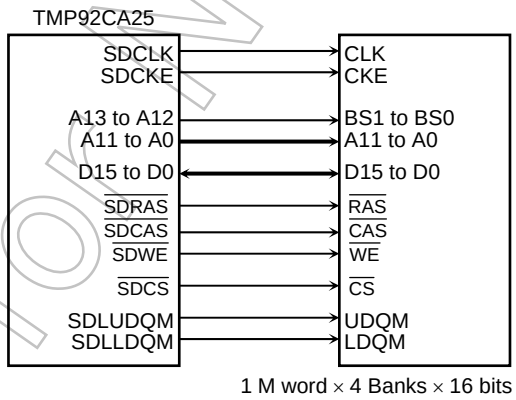


Figure 3.17.8 Connection with SDRAM (4 M word × 16 bits)

3.17.3 Limitations arising when using SDRAM

Take care to note the following points when using SDRAMC.

1. WAIT access

   When using SDRAM, some limitation is added when accessing memory other than SDRAM. In WAIT-pin input setting of the Memory Controller, if the setting time is inserted as an external WAIT, set a time less than the Auto-Refresh cycle × 8190 (Auto- Refresh function controlled by SDRAM controller).

2. Execution of SDRAM command before HALT instruction (SR (Self refresh)-Entry, Initialize, Mode-set)

   When a SDRAM controller command (SR-Entry, Initialize and Mode-set) is issued, several states are required for execution time after the SDCMM register is set.

   Therefore, when a HALT instruction is executed after the SDRAM command, please insert a NOP of more than 10 bytes or 10 other instructions before executing the HALT instruction.

3. AR (Auto-Refresh) interval time

   When using SDRAM, set the system clock frequency to satisfy the minimum operation frequency for the SDRAM and minimum refresh cycle.

   In a system in which SDRAM is used and the clock is geared up and down exercise care in AR cycle for SDRAM.

4. Note when changing access mode

If changing access mode from “full page read” to “1 word read”, execute the following program. This program must not be executed on the SDRAM.

```
di                                      ; Interrupt Disable (Added)
ld      a,(optional external memory     ; Dummy read instruction (Added)
        address)
ld      (sdacr1),00001101b              ; Change to “1-word read”
ld      (sdcmm),0x04                    ; Execute MRS (mode register setting)
ei                                      ; Interrupt enable (Added)
```

3.18 NAND-Flash Controller

3.18.1 Characteristics

The NAND-Flash controller (NDFC) is provided with dedicated pins for connecting with NAND-Flash memory. The NDFC also has an ECC calculation function for error correction.

Although the NDFC has two channels (channel 0, channel 1), all pins except for Chip Enable are shared between the two channels. These signals are controlled by NDCR<CHSEL>.

Only the operation of channel 0 is explained here.

The NDFC has the following features:

1) Controlled NAND-Flash interface by setting registers.

2) ECC calculating circuits. (for SCL-type)

Note 1: The $\overline{WP}$ (Write Protect) pin of NAND Flash is not supported. If this function is needed, prepare it on an external circuit.

Note 2: The two channels cannot be accessed simultaneously. It is necessary to switch between the two channels.

3.18.2 Block Diagram

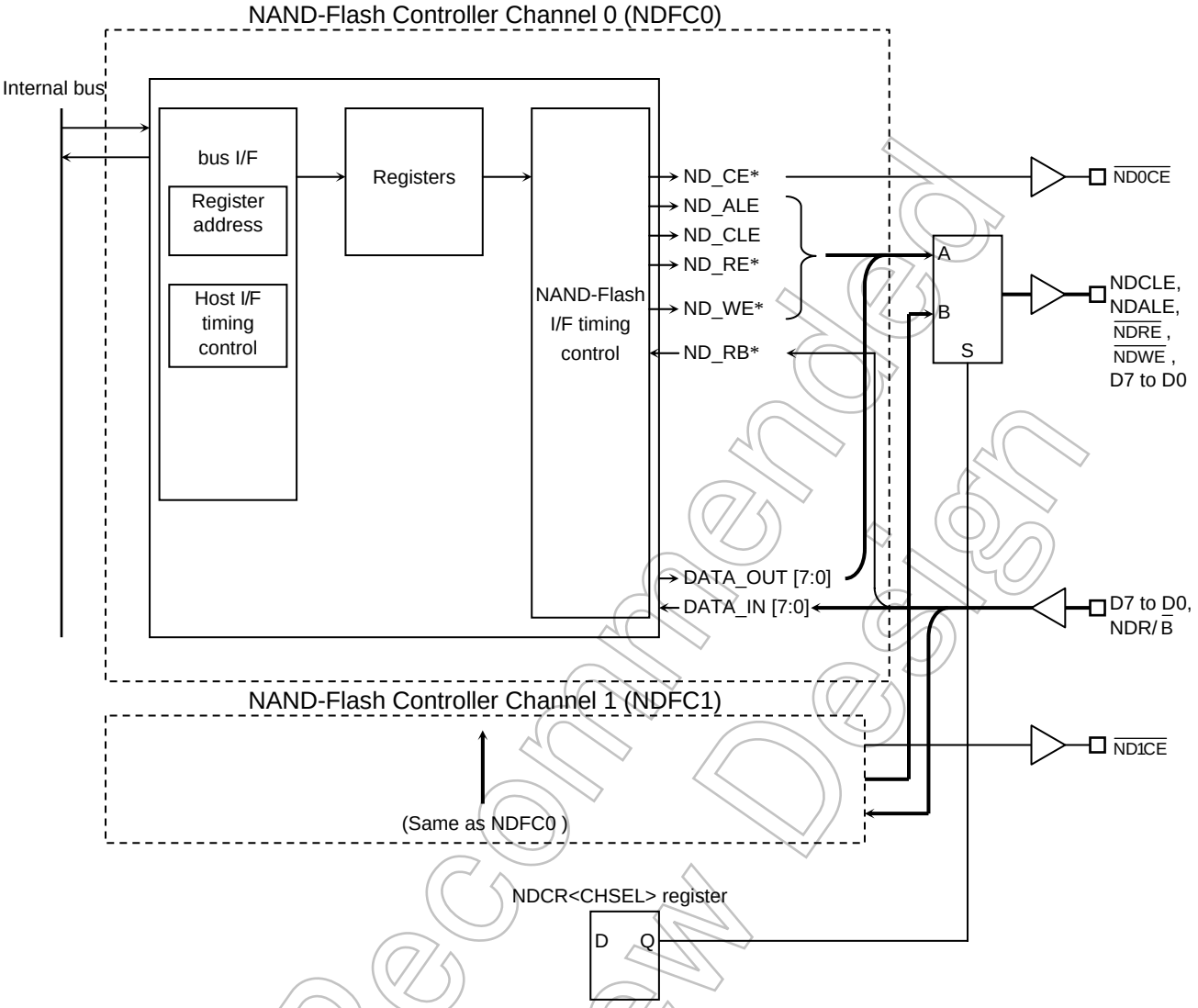


Figure 3.18.1 NAND-Flash Controller Block Diagram

3.18.3 Operation Description

3.18.3.1 Accessing NAND-Flash Memory

The NDFC accesses data on NAND Flash memory indirectly through its internal registers. It also contains the ECC calculating circuits. Please see 3.18.3.2 for details of the ECC. This section explains the operations for accessing the NAND Flash.

Basically, set the command in ND0FMCR and then read or write to ND0FDTR. The read cycle for ND0FDTR is completed after the external read cycle for the NAND-Flash is finished. Likewise, the write cycle for ND0FDTR is completed after the external write cycle for the NAND-Flash is finished.

1) Initialize

The initialize sequence is as follows.

(1) ND0FSPR: Set the low pulse width.

(2) ND0FIMR: Set 0x81 if interrupt is required.
(Release interrupt mask)

2) Write

The write sequence is as follows.

(1) ND0FMCR: Set 0x7C for ECC data reset.

(2) Write 512 bytes

ND0FMCR: Set 0x9D for NDCLE signal enable and command mode.
ND0FDTR: Set 0x80 for the serial data input command.
ND0FMCR: Set 0x9E for NDALE signal enable and address mode.
ND0FDTR: Write address. Set A [7:0], A [16:9], and A [24:17]. If it is required, set A [25].
ND0FMCR: Set 0xBC for the data mode.
ND0FDTR: Write 512 bytes data.

(3) Read ECC data

ND0FMCR: Set 0xDC for the ECC data read mode.
NDECCRD: Read 6 bytes ECC data.
First data: LPR [7:0]
Second data: LPR [15:8]
Third data: CPR [5:0], 2'b11
Fourth data: LPR [23:16]
Fifth data: LPR [31:24]
Sixth data: CPR [11:6], 2'b11

(4) Write 16-byte redundant data

ND0FMCR: Set 0x9C for the data mode without ECC calculation.

ND0FDTR: Write 16-byte redundant data.

D520: LPR [23:16]

D521: LPR [31:24]

D522: CPR [11:6], 2'b11

D525: LPR [7:0]

D526: LPR [15:8]

D527: CPR [5:0], 2'b11

(5) Run page program

ND0FMCR: Set 0x9D for NDCLE signal enable and command mode.

ND0FDTR: Set 0x10 for the page program command.

ND0FMCR: Set 0x1C for NDALE signal disable.

Wait several states (e.g., "NOP" × 10)

ND0FSR: Check BUSY flag. If it is 0, go to the next.
If it is 1, wait until it becomes 0.

(6) Read status

ND0FMCR: Set 0x1D for NDCLE signal and command mode.

ND0FDTR: Set 0x70 for Status read command.

ND0FMCR: Set 0x1C for NDCLE signal disable.

ND0FDTR: Read the Status data from the NAND-Flash.

(7) Repeat 1 to 6 for all other pages if required.

3) Read

The read sequence is as follows.

(1) ND0FMCR: Set 0x7C for ECC data reset.

(2) Read 512 bytes

ND0FMCR: Set 0x1D for NDCLE signal enable and command mode.

ND0FDTR: Set 0x00 for the read command.

ND0FMCR: Set 0x1E for NDALE signal enable and address mode.

ND0FDTR: Set A [7:0], A [16:9], and A [24:17]. If it is required, set A [25].

ND0FMCR: Set 0x1C for NDALE signal disable.

Wait several states (e.g., "NOP" × 10)

ND0FSR: Check BUSY flag. If it is 0, go to the next.
If it is 1, wait until it becomes 0.

ND0FMCR: Set 0x3C for the data mode with ECC calculation.

ND0FDTR: Read 512-byte data.

ND0FMCR: Set 0x1C for the data mode without ECC calculation.

ND0FDTR: Read 16-byte redundant data.

(3) Read ECC data

ND0FMCR: Set 0x5C for the ECC data read mode.

NDECCRD: Read 6-byte ECC data.

First data: LPR [7:0]
Second data: LPR [15:8]
Third data: CPR [5:0], 2'b11
Fourth data: LPR [23:16]
Fifth data: LPR [31:24]
Sixth data: CPR [11:6], 2'b11

(4) Software routine:

Compare ECC data and redundant data, run the error routine if error is generated.

(5) Read other pages

ND0FMCR: Set 0x1C.

ND0FSR: Check BUSY flag. If it is 0, go to the next.
If it is 1, wait until it becomes 0.

4) ID read

The ID read sequence is as follows.

(1) ND0FMCR: Set 0x1D for NDCLE signal enable and command mode.
(2) ND0FDTR: Set 0x90 for the ID Read command.
(3) ND0FMCR: Set 0x1E for NDALE signal enable and the address mode.
(4) ND0FDTR: Set 0x00.
(5) ND0FMCR: Set 0x1C for the data mode without ECC calculation.
(6) ND0FDTR: Read Maker code.
(7) ND0FDTR: Read Device code.

3.18.3.2 ECC Control

The NDFC contains the ECC calculating circuits. The circuits are controlled by ND0FMCR. This circuit executes ECC data calculation. However, ECC comparison and error correction is not executed. This must be executed using software.

The calculated ECC data can be read from the NDECCRD register when ND0FMCR is 0xD0 (write mode) or 0x50 (read mode). This is 6-byte data, and six NDECCRD read operations are required. The order of the data is as follows.

First data: LPR [7:0]
Second data: LPR [15:8]
Third data: CPR [5:0], 2'b11
Fourth data: LPR [23:16]
Fifth data: LPR [31:24]
Sixth data: CPR [11:6], 2'b11

3.18.4 Registers

Table 3.18.1 NAND-Flash Control Registers for Channel 0

Address	Register	Register Name
1D00H (1D00H to 1EFFH)	ND0FDTR	NAND-Flash data transfer register
1CB0H (1CB0H to 1CB5H)	ND0ECCRD	NAND-Flash ECC-code read register
1CC4H	ND0FMCR	NAND-Flash mode control register
1CC8H	ND0FSR	NAND-Flash status register
1CCCH	ND0FISR	NAND-Flash interrupt status register
1CD0H	ND0FIMR	NAND-Flash interrupt mask register
1CD4H	ND0FSPR	NAND-Flash strobe pulse width register
1CD8H	ND0FRSTR	NAND-Flash reset register

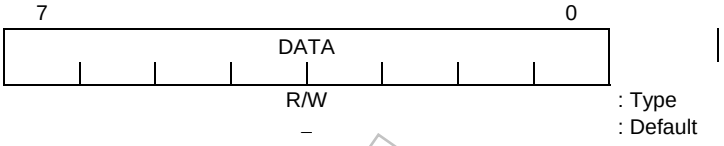
Table 3.18.2 NAND-Flash Control Registers for Channel 1

Address	Register	Register Name
1D00H (1D00H to 1EFFH)	ND1FDTR	NAND-Flash data transfer register
1CB0H (1CB0H to 1CB5H)	ND1ECCRD	NAND-Flash ECC-code read register
1CE4H	ND1FMCR	NAND-Flash mode control register
1CE8H	ND1FSR	NAND-Flash status register
1CECH	ND1FISR	NAND-Flash interrupt status register
1CF0H	ND1FIMR	NAND-Flash interrupt mask register
1CF4H	ND1FSPR	NAND-Flash strobe pulse width register
1CF8H	ND1FRSTR	NAND-Flash reset register

Table 3.18.3 NAND-Flash Control Registers

Address	Register	Register Name
01C0H	NDCR	NAND-Flash control register

3.18.4.1 NAND-Flash Data Transfer Register (ND0FDTR and ND1FDTR)



Bit (s)	Mnemonic	Field Name	Description
7:0	DATA	DATA	NAND-Flash data. Read: Read the data that was read from the NAND-Flash. Write: Write data to the NAND-Flash.

Note 1: This register has a 512-address window from 1D00H to 1EFFH since a NAND-Flash page size is either 256 or 512 bytes.

When the CPU reads from or writes to the NAND-Flash , and if the block transfer instruction (“LDIR” instruction) is used, the following restriction applies to the 900/H1 CPU.

[Restriction for using the block transfer instruction]

1) The source address for “LDIR” instruction should be set to (1F00H – read (or write) byte number)

Example 1) In case of 512-byte read

```
ld      bc, 512          ;  512 bytes
ld      xix, 2000H       ;  dst = 2000H
ld      xiy, 1D00H       ;  src = (1F00H – 512) = 1D00H
ldir    (xix + ), (xiy + )  ;  Block transfer instruction
```

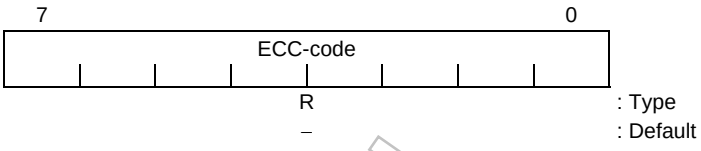
Example 2) In case of 16-byte read

```
ld      bc, 16           ;  16 bytes
ld      xix, 2000H       ;  dst = 2000H
ld      xiy, 1EF0H       ;  src = (1F00H – 16) = 1EF0H
ldir    (xix + ), (xiy + )  ;  Block transfer instruction
```

Note 2: Both ND0FDTR and ND1FDTR are assigned to the same address. The NDCR<CHSEL> register determines which channel is accessed.

Figure 3.18.2 NAND-Flash Data Transfer Register (ND0FDTR and ND1FDTR)

3.18.4.2 NAND-Flash ECC-code Read Register (ND0ECCRD and ND1ECCRD)



Bit (s)	Mnemonic	Field Name	Description
7:0	ECC-code	ECC-code	Read calculated ECC data.

Note 1: Both ND0ECCRD and ND1ECCRD are assigned to the same address. The NDCR<CHSEL> register determines which channel is accessed.

Figure 3.18.3 NAND-Flash ECC-code Read Register (ND0ECCRD and ND1ECCRD)

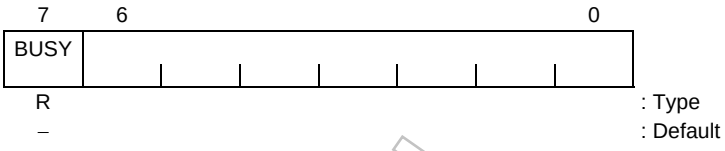
3.18.4.3 NAND-Flash Mode Control Register (ND0FMCR and ND1FMCR)

7	6	5	4	3	5	1	0	
WE	ECC1	ECC0	CE	PCNT1	PCNT0	ALE	CLE	
R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	: Type
0	0	0	0	0	0	0	0	: Default

Bits	Mnemonic	Field Name	Description
7	WE	Write enable	Write enable (Default: 0) This bit enables the data write operation. When writing the data to the NAND-Flash, set this bit to “1”. When writing command or address, this bit need not be set to “1”. 0: Disable write operation 1: Enable write operation
6	ECC1	ECC control	ECC control (Default: 00) Control the ECC calculating circuits with <CE> (bit4) register. 11 (at<CE> = X): Reset ECC circuits 00 (at<CE> = 1): ECC circuits are disabled. 01 (at<CE> = 1): ECC circuits are enabled. 10 (at<CE> = 1): Read ECC data calculated by NDFC 10 (at<CE> = 0): Read ID data
5	ECC0		
4	CE	Chip enable	Chip enable (Default: 0) Enable NAND-Flash access. Set “1” to this bit when accessing the NAND-Flash. 0: Disable ($\overline{\text{NDCE}}$ is High.) 1: Enable ($\overline{\text{NDCE}}$ is Low.)
3	PCNT1	Power control	Power control (Default: 00) Always write “11”
2	PCNT0		
1	ALE	Address latch enable	Address latch enable (Default: 0) This bit specifies the value of the NDALE signal. 0: Low 1: High
0	CLE	Command latch enable	Command latch enable (Default: 0) This bit specifies the value of the NDCLE signal. 0: Low 1: High

Figure 3.18.4 NAND-Flash Mode Control Register (ND0FMCR and ND1FMCR)

3.18.4.4 NAND-Flash Status Register (ND0FSR and ND1FSR)



Bits	Mnemonic	Field Name	Description
7	BUSY	BUSY	BUSY (Default: Undefined) This bit shows the status of the NAND-Flash. 0: Ready 1: Busy
6:0	–	–	Reserved

Note: A noise-filter for some states is built into the NDFC, so when the NDR/$\overline{B}$ pin changes, a <BUSY> flag is not renewed at the same time. Therefore, insert several delays (e.g., "NOP" instruction × 10) using software before starting this flag check.

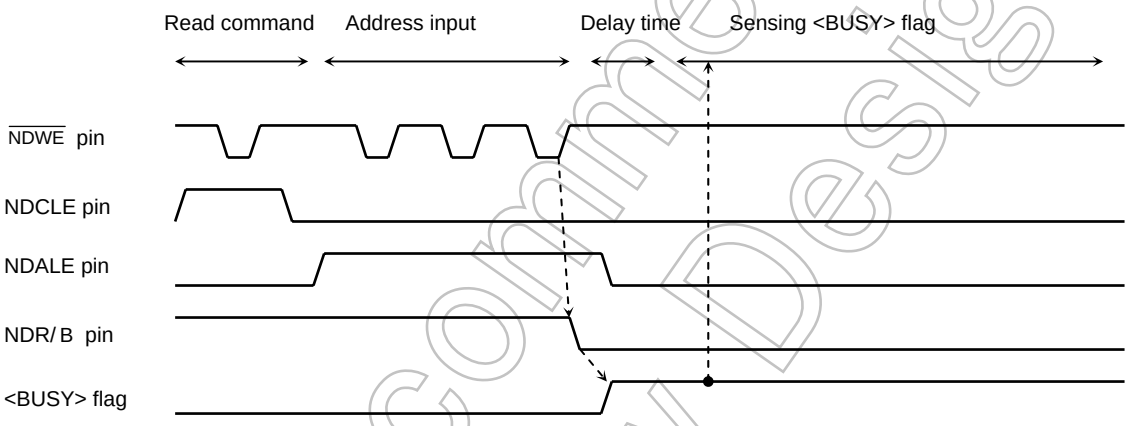
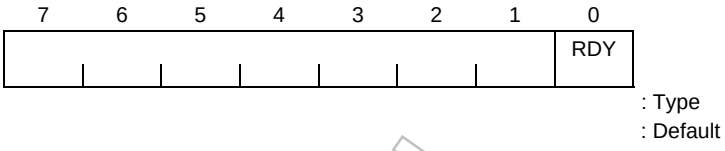


Figure 3.18.5 NAND-Flash Status Register (ND0FSR and ND1FSR)

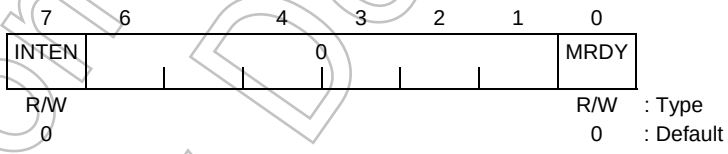
3.18.4.5 NAND-Flash Interrupt Status Register (ND0FISR and ND1FISR)



Bits	Mnemonic	Field Name	Description
7:1	–	–	Reserved
0	RDY	Ready	Ready (Default: 0) When NDR/$\overline{B}$ signal changes from low (BUSY) to High (READY) and NDFIMR<MRDY> is “1”, this bit is set to “1”. By writing “1”, this bit is cleared to 0. Read: 0: None 1: Change NDR/$\overline{B}$ signal from BUSY to READY. Write: 0: No change 1: Clear to “0”

Figure 3.18.6 NAND-Flash Interrupt Status Register (ND0FISR and ND1FISR)

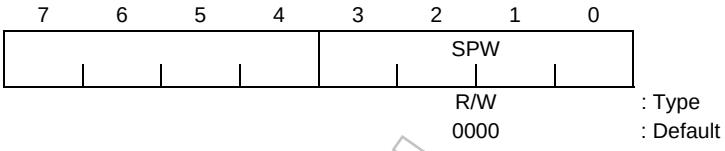
3.18.4.6 NAND-Flash Interrupt Mask Register (ND0FIMR and ND1FIMR)



Bits	Mnemonic	Field Name	Description
7	INTEN	Interrupt enable	Interrupt enable (Default: 0) When <INTEN> and <MRDY> are set “1” and NDFISR<RDY> becomes “1”, INTNDFC occurs. 0: Disable 1: Enable
6:1	–	–	Reserved
0	MRDY	Mask RDY interrupt	Mask RDY interrupt (Default: 0) This bit masks the NDFISR<RDY>. If <MRDY> is “1” and NDR/$\overline{B}$ signal changes from Low to High, NDFISR<RDY> is set to “1”. 0: Disable to set NDFISR<RDY> 1: Enable to set NDFISR<RDY>

Figure 3.18.7 NAND-Flash Interrupt Mask Register (ND0FIMR and ND1FIMR)

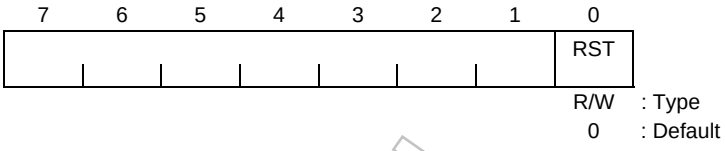
3.18.4.7 NAND-Flash Strobe Pulse Width Register (ND0FSPR and ND1FSPR)



Bits	Mnemonic	Field Name	Description
7:4	–	–	Reserved
3:0	SPW	Strobe pulse width	Strobe pulse width (Default: 0000) These bits set the Low pulse width of the $\overline{\text{NDRE}}$ and $\overline{\text{NDWE}}$ signals. The Low pulse width is ((value set to SPW) +1)× f_{SYS} clock

Figure 3.18.8 NAND-Flash Strobe Pulse Width Register (ND0FSPR and ND1FSPR)

3.18.4.8 NAND-Flash Reset Register (ND0FRSTR and ND1FRSTR)



Bits	Mnemonic	Field Name	Description
7:1	–	–	Reserved
0	RST	Reset	Reset (Default: 0) By setting this bit, reset the NDFC (except NDCR<CHSEL> register). By reset, this bit is automatically cleared to “0”. 0: Don’t care 1: Reset

Note: After writing <RST> register, several waits are required (about 10 states) before accessing the NDFC.

Figure 3.18.9 NAND-Flash Reset Register (ND0FRSTR and ND1FRSTR)

3.18.4.9 NAND-Flash Control Register (NDCR)

NDCR (01C0H)

	7	6	5	4	3	2	1	0
Bit symbol	CHSEL							
Read/Write	R/W							
After reset	0							
Function	0: Channel 0 1: Channel 1							

3.18.5 Timing Diagrams

3.18.5.1 Command and Address Cycle

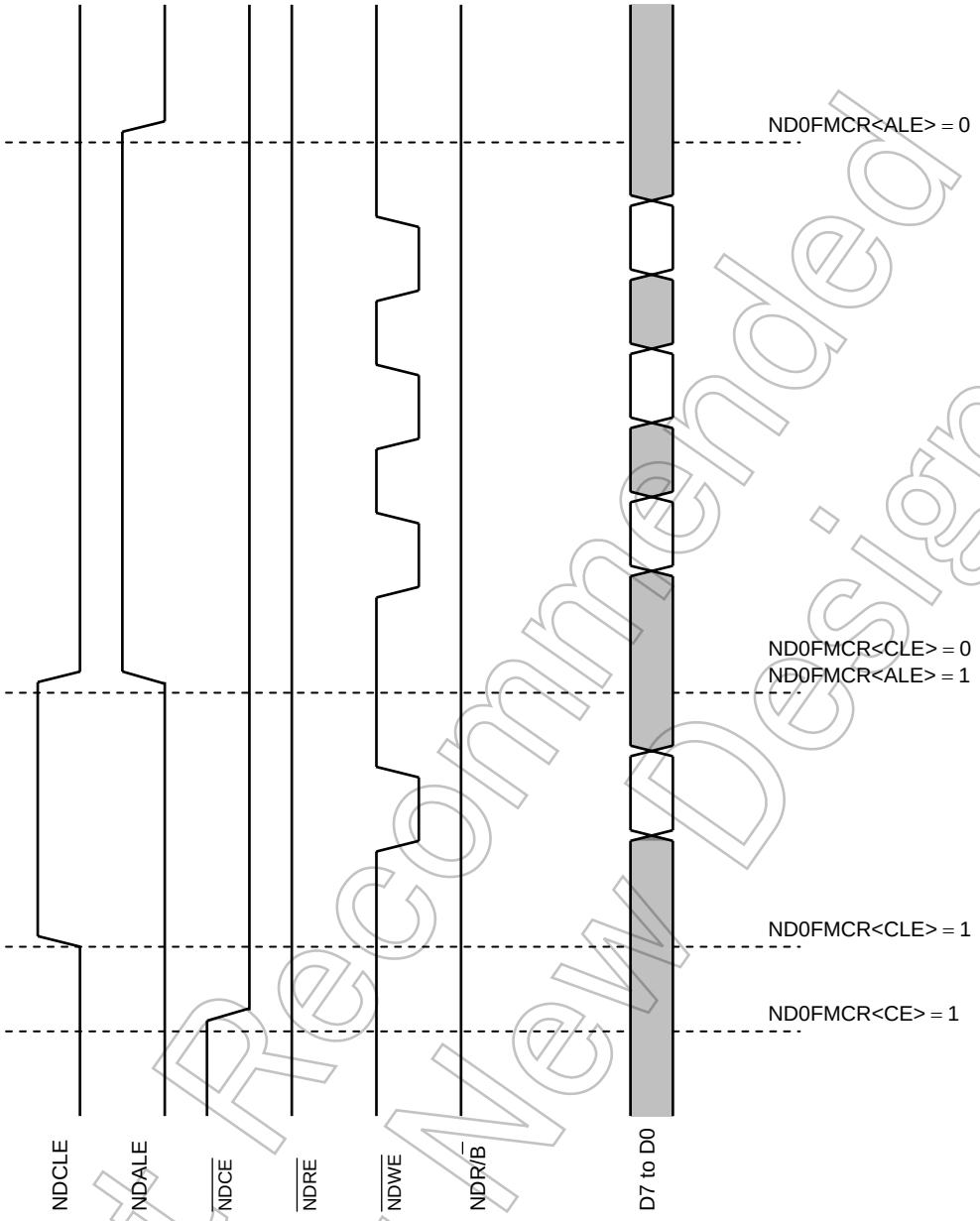


Figure 3.18.10 Command and Address Cycle

3.18.5.2 Data Read Cycle

Figure 3.18.11 shows a timing chart example for a Data Read cycle from the NAND-Flash at ND0FSPR = 02H.

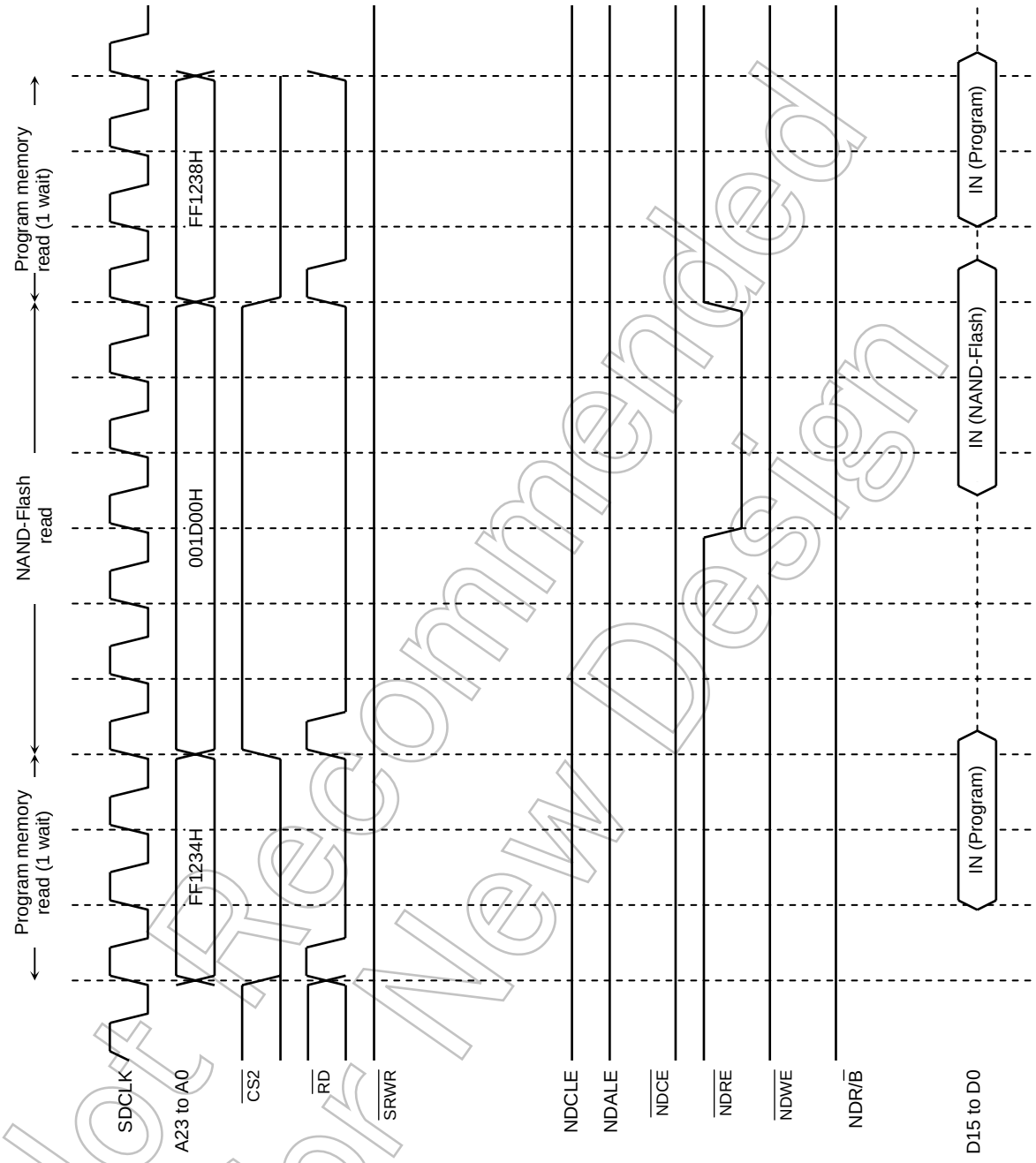


Figure 3.18.11 Data Read Cycle Example (ND0FSPR = 02H)

3.18.5.3 Data Write Cycle

Figure 3.18.12 shows a timing chart example for a Data Write cycle to the NAND-Flash at ND0FSPR = 02H.

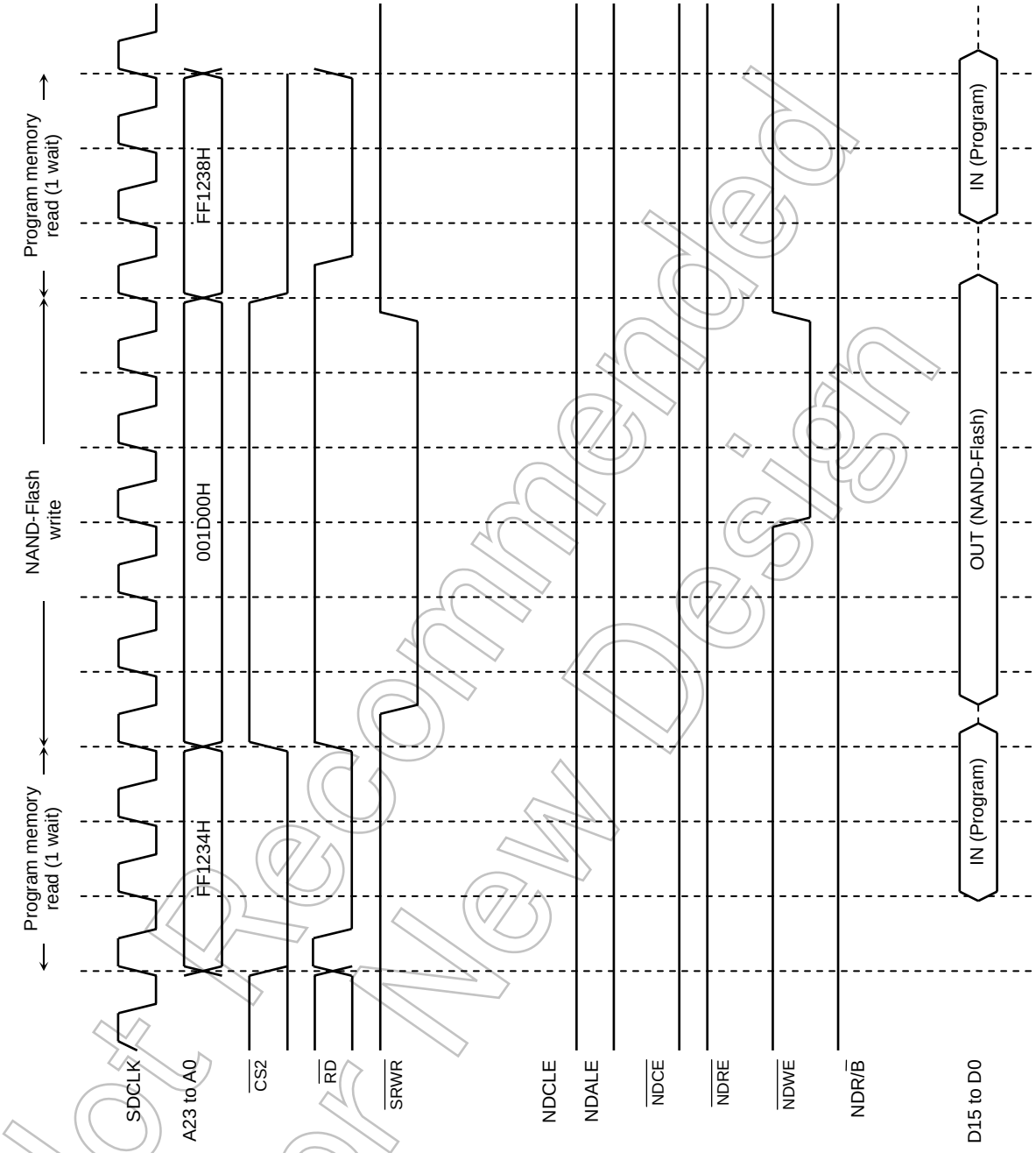
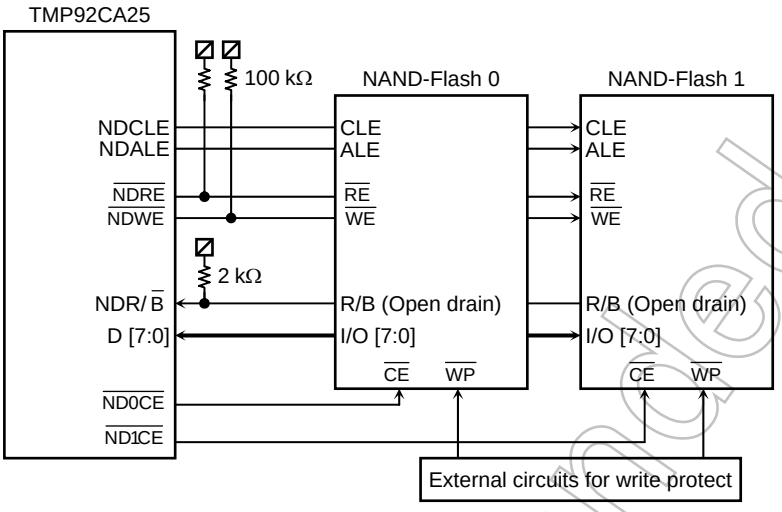


Figure 3.18.12 Data Write Cycle (ND0FSPR = 02H)

3.18.6 Example of NAND-Flash Use



Note 1: By reset, both $\overline{\text{NDRE}}$ and $\overline{\text{NDWE}}$ pins become input ports (Port 71 and Port 72) And so require pull-up resistors.

Note 2: Use the NAND-Flash memory and board capacitance to set the correct value for the NDR/$\overline{\text{B}}$ pin pull-up resistor . 2 kΩ is a typical value.

Note 3: The NAND-Flash $\overline{\text{WP}}$ (write protect) pin is not supported by the TMP92CA25.
It must be provided by an external circuit if required.

Figure 3.18.13 Example of NAND-Flash Connection

3.19 16-Bit Timer/Event Counters (TMRB0)

The TMP92CA25 incorporates one multifunctional 16-bit timer/event counter (TMRB0) which has the following operation modes:

- 16-bit interval timer mode
- 16-bit event counter mode
- 16-bit programmable pulse generation (PPG) mode

The timer/event counter consists of a 16-bit up counter, two 16-bit timer registers (one of them with a double buffer structure), a 16-bit capture register, two comparators, a capture input controller, a timer flip-flop and a control circuit.

The timer/event counter is controlled by an 11-byte control SFR.

This chapter includes the following sections:

Table 3.19.1 Pins and SFR of TMRB0

Spec. \ Channel		TMRB0
External pins	External clock/capture trigger input pins	None
	Timer flip-flop output pins	TB0OUT0 (also used as PC2)
SFR (Address)	Timer run register	TB0RUN (1180H)
	Timer mode register	TB0MOD (1182H)
	Timer flip-flop control register	TB0FFCR (1183H)
	Timer register	TB0RG0L (1188H) TB0RG0H (1189H) TB0RG1L (118AH) TB0RG1H (118BH)
	Capture register	TB0CP0L (118CH) TB0CP0H (118DH) TB0CP1L (118EH) TB0CP1H (118FH)

3.19.1 Block Diagrams

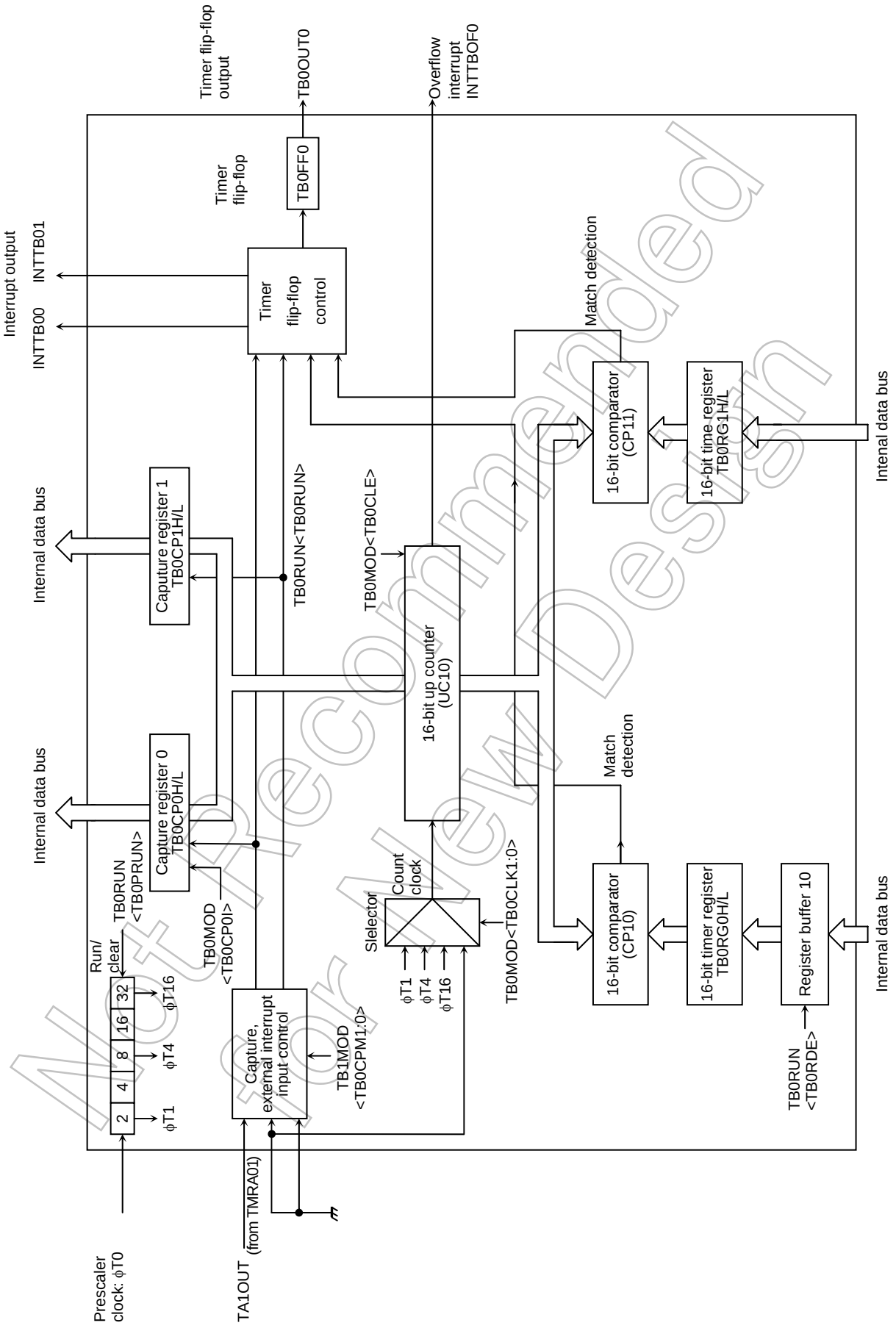


Figure 3.19.1 Block Diagram of TMRB0

3.19.2 Operation of Each Block

(1) Prescaler

The 5-bit prescaler generates the source clock for timer 0. The prescaler clock (ϕT0) is a divided clock (divided by 8) from the f_{FPH}.

This prescaler can be started or stopped using TB0RUN<TB0PRUN>. Counting starts when <TB0PRUN> is set to "1"; the prescaler is cleared to 0 and stops operation when <TB0PRUN> is cleared to "0".

Table 3.19.2 Prescaler Clock Resolution

System clock selection SYSCR1 <SYSCK>	Clock gear selection SYSCR1 <GEAR2:0>	–	Timer counter input clock TMRB prescaler TB0MOD<TB0CLK1:0>		
			ϕT1(1/2)	ϕT4 (1/8)	ϕT16 (1/32)
1 (fs)	–	1/8	fs/16	fs/64	fs/256
0 (fc)	000 (1/1)		fc/16	fc/64	fc/256
	001 (1/2)		fc/32	fc/128	fc/512
	010 (1/4)		fc/64	fc/256	fc/1024
	011 (1/8)		fc/128	fc/512	fc/2048
	100 (1/16)		fc/256	fc/1024	fc/4096

XXX: Don't care

(2) Up counter (UC10)

UC10 is a 16-bit binary counter which counts up pulses input from the clock specified by TB0MOD<TB0CLK1:0>.

Any one of the prescaler internal clocks ϕT1, ϕT4 and ϕT16 can be selected as the input clock. Counting or stopping and clearing of the counter is controlled by TB0RUN<TB0RUN>.

When clearing is enabled, the up counter UC10 will be cleared to "0" each time its value matches the value in the timer register TB0RG1H/L. If clearing is disabled, the counter operates as a free-running counter.

Clearing can be enabled or disabled using TB0MOD<TB0CLE>.

A timer overflow interrupt (INTTBOF0) is generated when UC10 overflow occurs.

(3) Timer registers (TB0RG0H/L and TB0RG1H/L)

These 16-bit registers are used to set the interval time. When the value in the up counter UC10 matches the value set in this timer register, the comparator match detect signal will go active.

Setting data for both Upper and Lower timer registers is always needed. For example, either using a 2-byte data transfer instruction or using a 1-byte data transfer instruction twice for the lower 8 bits and upper 8 bits in order.

The TB0RG0H/L timer register has a double-buffer structure, which is paired with a register buffer. The value set in TB0RUN<TB0RDE> determines whether the double-buffer structure is enabled or disabled: it is disabled when <TB0RDE> = "0", and enabled when <TB0RDE> = "1".

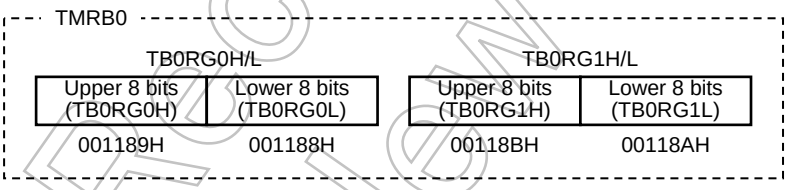
When the double buffer is enabled, data is transferred from the register buffer to the timer register when the values in the up counter (UC10) and the timer register TB0RG1H/L match.

After a reset, TB0RG0H/L and TB0RG1H/L are undefined. If the 16-bit timer is to be used after a reset, data should be written to it beforehand.

On a reset <TB0RDE> is initialized to "0", disabling the double buffer. To use the double buffer, write data to the timer register, set <TB0RDE> to 1, then write data to the register buffer as shown below.

TB0RG0H/L and the register buffer both have the same memory addresses (001188H and 001189H) allocated to them. If <TB0RDE> = "0", the value is written to both the timer register and the register buffer. If <TB0RDE> = "1", the value is written to the register buffer only.

The addresses of the timer registers are as follows:



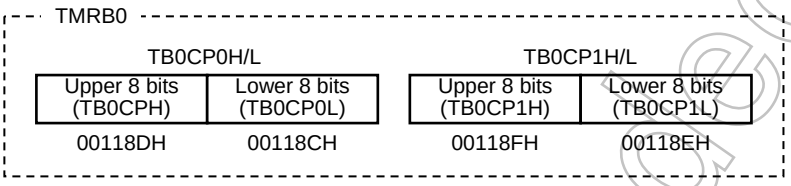
The timer registers are write-only registers and thus cannot be read.

(4) Capture registers (TB0CP0H/L and TB0CP1H/L)

These 16-bit registers are used to latch the values in the up counters.

All 16 bits of data in the capture registers should be read. For example, using a 2-byte data load instruction or two 1-byte data load instructions. The least significant byte is read first, followed by the most significant byte.

The addresses of the capture registers are as follows:



The capture registers are read-only registers and thus cannot be written to.

(5) Capture input control

This circuit controls the timing to latch the value of the up counter UC10 into TB0CP0H/L and TB0CP1H/L.

The value in the up counter can be loaded into a capture register by software. Whenever "0" is programmed to TB0MOD<TB0CP0I>, the current value in the up counter is loaded into capture register TB0CP0H/L. It is necessary to keep the prescaler in run mode (i.e., TB0RUN<TB0PRUN> must be held at a value of 1).

(6) Comparators (CP10 and CP11)

CP10 and CP11 are 16-bit comparators which compare the value in the up counter UC10 with the value set in TB0RG0H/L or TB0RG1H/L respectively, in order to detect a match. If a match is detected, the comparator generates an interrupt (INTTB00 or INTTB01 respectively).

(7) Timer flip-flops (TB0FF0)

These flip-flops are inverted by the match detect signals from the comparators and the latch signals to the capture registers. Inversion can be enabled and disabled for each element using TB0FFCR<TB0C0T1, TB0E1T1 and TB0E0T1>.

After a reset the value of TB0FF0 is undefined. If "00" is programmed to TB0FFCR <TB0FF0C1:0>, TB0FF0 will be inverted. If "01" is programmed to the capture registers, the value of TB0FF0 will be set to "1". If "10" is programmed to the capture registers, the value of TB0FF0 will be cleared to "0".

The values of TB0FF0 can be output via the timer output pin TB0OUT0 (which is shared with PC6). Timer output should be specified using the port B function register.

3.19.3 SFRs

TMRB0 Run Register

TB0RUN (1180H)

	7	6	5	4	3	2	1	0
Bit symbol	TB0RDE	–			I2TB0	TB0PRUN		TB0RUN
Read/Write	R/W				R/W			R/W
After reset	0	0			0	0		0
Function	Double buffer 0: Disable 1: Enable	Always write “0”			IDLE2 0: Stop 1: Operate	TMRB0 Prescaler 0: Stop and clear 1: Run (Count up)		Up counter UC10

→ Count operation

0	Stop and clear
1	Count

Note: 1, 4 and 5 of TB0RUN are read as undefined values.

Figure 3.19.2 The Registers for TMRB

TMRB0 Mode Register

	7	6	5	4	3	2	1	0
Bit symbol	–	–	TB0CP0I	TB0CPM1	TB0CPM0	TB0CLE	TB0CLK1	TB0CLK0
Read/Write	R/W		W*	R/W				
After reset	0	0	1	0	0	0	0	0
Function	Always write “0”		Execute software capture 0: Software capture 1: Undefined	Capture timing 00: Disable 01: Reserved 10: Reserved 11: TA1OUT↑ TA1OUT↓		Control up counter 0: Disable clearing 1: Enable clearing	TMRB0 source clock 00: Reserved 01: φT1 10: φT4 11: φT16	

TB0MOD (1182H)

Read-modify-write instruction is prohibited.

TMRB0 source clock

00	Reserved
01	φT1
10	φT4
11	φT16

Up counter clear control

0	Disable
1	Enable clearing on match with TB0RG1H/L

Capture/interrupt timing

00	Disable
01	Reserved
10	Reserved
11	Capture to TB0CP0H/L at rising edge of TA1OUT Capture to TB0CP1H/L at falling edge of TA1OUT

Software capture

0	The value in the up counter is captured to TB0CP0H/L.
1	Undefined

Figure 3.19.3 The Registers for TMRB0

TMRB0 Flip-Flop Control Register

		7	6	5	4	3	2	1	0
TB0FFCR (1183H)	Bit symbol	–	–	TB0C1T1	TB0C0T1	TB0E1T1	TB0E0T1	TB0FF0C1	TB0FF0C0
	Read/Write	W*		R/W				W*	
	After reset	1	1	0	0	0	0	1	1
Read-modify -write instruction is prohibited.	Function	Always write “11”.		TB0FF0 inversion trigger 0: Disable trigger 1: Enable trigger				Control TB0FF0 00: Invert 01: Set 10: Clear 11: Don’t care * Always read as 11.	
				Invert when the UC value is loaded into TB0CP1H/L.	Invert when the UC value is loaded into TB0CP0H/L.	Invert when the UC value matches the value in TB0RG1H/L.	Invert when the UC value matches the value in TB0RG0H/L.		

Timer flip-flop control (TB0FF0)

00	Invert
01	Set to 1
10	Clear to 0
11	Don’t care

Inverted when the UC10 value matches the value in TB0RG0H/L.

0	Disable trigger
1	Enable trigger

Inverted when the UC10 value matches the value in TB0RG1H/L.

0	Disable trigger
1	Enable trigger

Inverted when the UC10 value is loaded into TB0CP0.

0	Disable trigger
1	Enable trigger

Inverted when the UC10 value is loaded into TB0CP1H/L.

0	Disable trigger
1	Enable trigger

Figure 3.19.4 The Registers for TMRB

TMRB0 register

		7	6	5	4	3	2	1	0
TB0RG0L (1188H)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0RG0H (1189H)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0RG1L (118AH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0RG1H (118BH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0CP0L (118CH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0CP0H (118DH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0CP1L (118EH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							
TB0CP1H (118FH)	bit Symbol	–							
	Read/Write	W							
	After reset	Undefined							

Note: All registers are prohibited to execute read-modify-write instruction.

Figure 3.19.5 The Registers for TMRB

3.19.4 Operation in Each Mode

(1) 16-bit interval timer mode

Generating interrupts at fixed intervals.

In this example, the interrupt INTTB01 is set to be generated at fixed intervals. The interval time is set in the timer register TB0RG1H/L.

		7	6	5	4	3	2	1	0	
TB0RUN	←	0	0	X	X	–	0	X	0	Stop TMRB0.
INTETB01	←	X	1	0	0	X	0	0	0	Enable INTTB01 and set interrupt level 4. Disable INTTB00.
TB0FFCR	←	1	1	0	0	0	0	1	1	Disable the trigger.
TB0MOD	←	0	0	1	0	0	1	*	*	Select internal clock for input and disable the capture function. (** = 01, 10, 11)
TB0RG1	←	*	*	*	*	*	*	*	*	Set the interval time (16 bits).
		*	*	*	*	*	*	*	*	
TB0RUN	←	0	0	X	X	–	1	X	1	Start TMRB0.

X: Don't care, –: No change

(2) 16-bit programmable pulse generation (PPG) output mode

Square wave pulses can be generated at any frequency and duty ratio. The output pulse may be either low active or high active.

The PPG mode is obtained by inversion of the timer flip-flop TB0FF0 that is enabled by the match of the up counter UC10 with timer register TB0RG0H/L or TB0RG1H/L and is output to TB0OUT0. In this mode the following conditions must be satisfied.

(Value set in TB0RG0H/L) < (Value set in TB0RG1H/L)

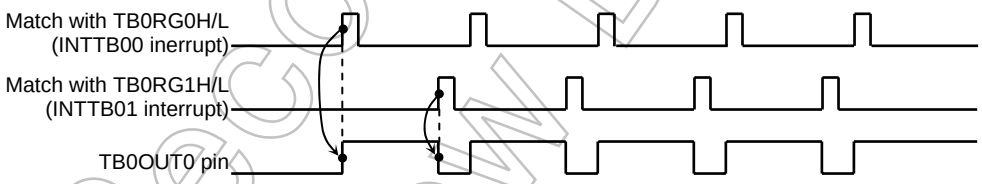


Figure 3.19.6 Programmable Pulse Generation (PPG) Output Waveforms

When the TB0RG0H/L double buffer is enabled in this mode, the value of register buffer 10 will be shifted into TB0RG0H/L at match with TB0RG1H/L. This feature facilitates the handling of low duty waves.

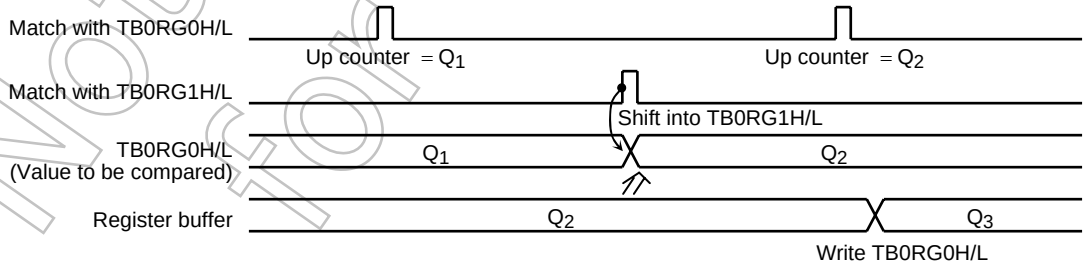


Figure 3.19.7 Operation of Register Buffer

The following block diagram illustrates this mode.

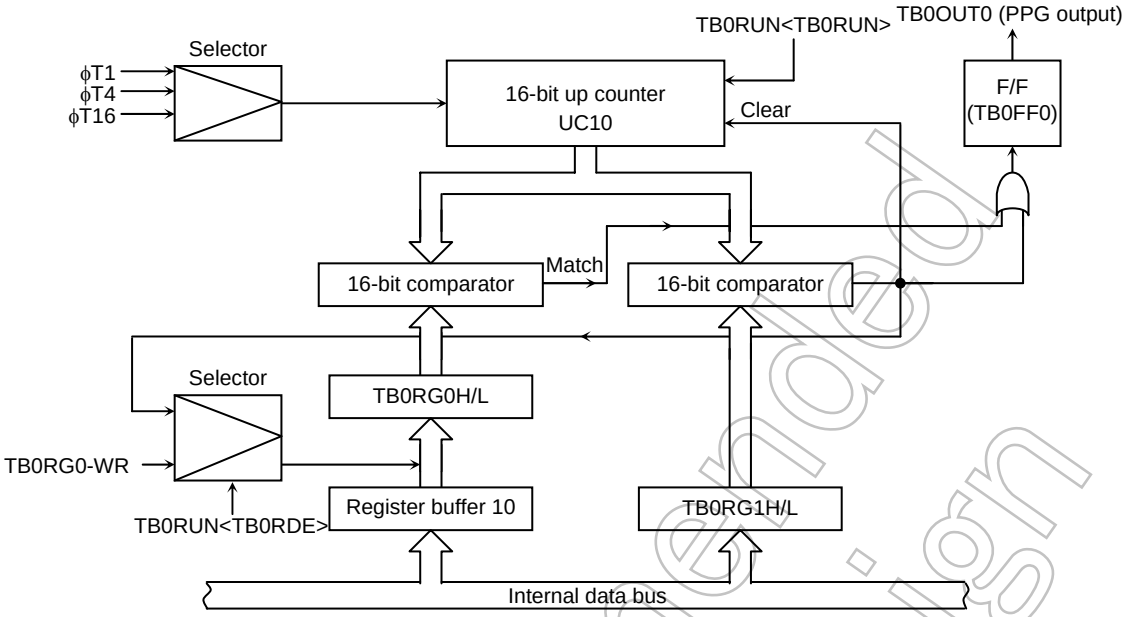


Figure 3.19.8 Block Diagram of 16-Bit Mode

The following example shows how to set 16-bit PPG output mode:

		7	6	5	4	3	2	1	0	
TB0RUN	←	0	0	X	X	–	0	X	0	Disable the TB0RG0H/L double buffer and stop TMRB0.
TB0RG0H/L	←	*	*	*	*	*	*	*	*	Set the duty ratio (16 bits).
		*	*	*	*	*	*	*	*	
TB0RG1H/L	←	*	*	*	*	*	*	*	*	Set the frequency (16 bits).
		*	*	*	*	*	*	*	*	
TB0RUN	←	1	0	X	X	–	0	X	0	Enable the TB0RG0H/L double buffer. (The duty and frequency are changed on an INTTB01 interrupt.)
TB0FFCR	←	1	1	0	0	1	1	1	0	Set the mode to invert TB0FF0 at the match with TB0RG0H/L/TB0RG1H/L. Set TB0FF0 to “0”.
TB0MOD	←	0	0	1	0	0	1	*	*	Select the Prescaler output clock as the input clock and disable the capture function. (** = 01, 10, 11)
PCCR	←	–	1	X	X	–	–	–	–	Set PC6 to function as TB0OUT0.
PCFC	←	–	1	X	X	–	–	–	–	
TB0RUN	←	1	0	X	X	–	1	X	1	Start TMRB0.

X: Don't care, –: No change

3.20 Touch Screen Interface (TSI)

The TMP92CA25 has an interface for a 4-terminal resistor network touch screen.

This interface supports two procedures: an X/Y position measurement and touch detection.

Each procedure is executed by setting the TSI control register (TSICR0 and TSICR1) and using an internal AD converter.

3.20.1 Touch Screen Interface Module Internal/External Connection

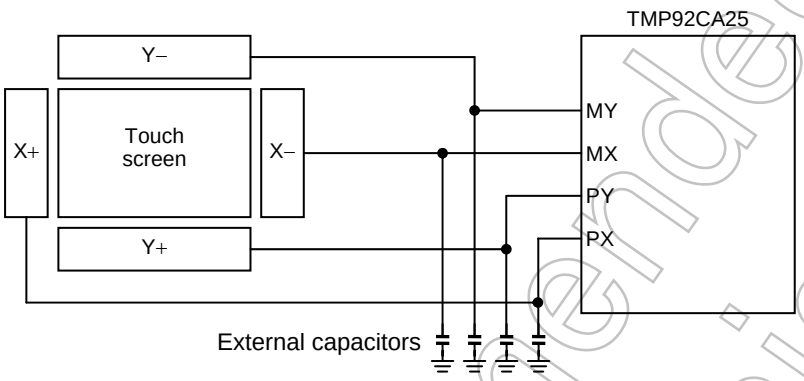


Figure 3.20.1 External Connection of TSI

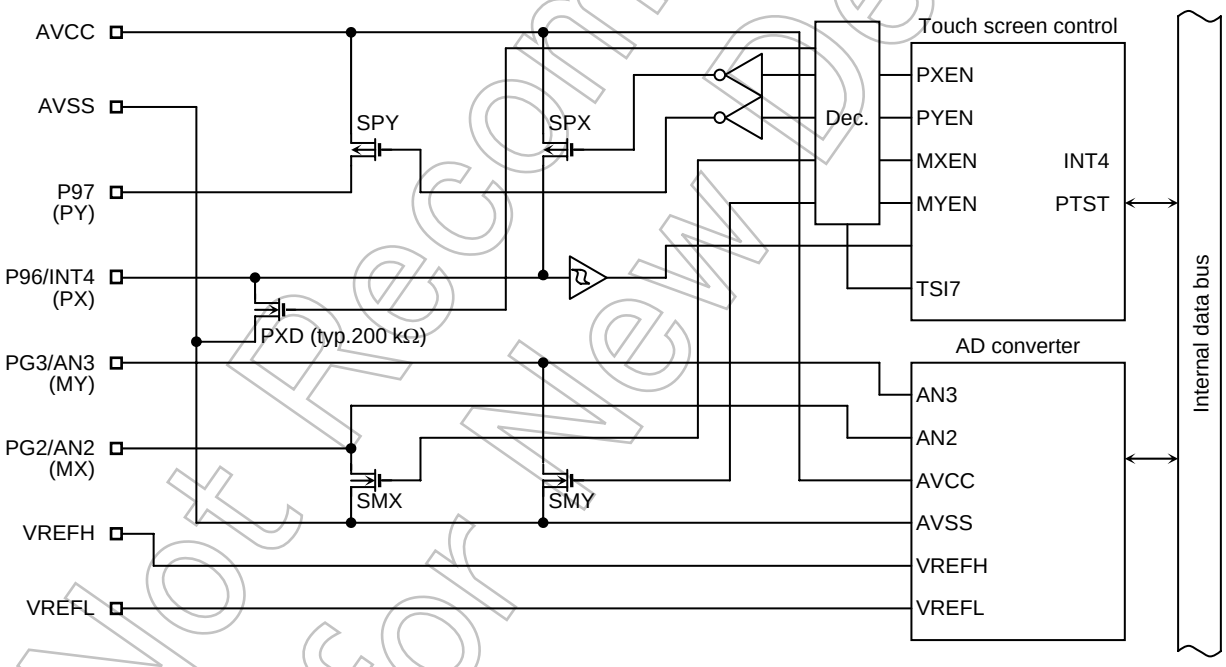


Figure 3.20.2 Internal Block Diagram of TSI

3.20.2 Touch Screen Interface (TSI) Control Register

TSI Control Register

TSICR0 (01F0H)

	7	6	5	4	3	2	1	0
Bit symbol	TSI7		PTST	TWIEN	PYEN	PXEN	MYEN	MXEN
Read/Write	R/W		R	R/W				
After reset	0		0	0	0	0	0	0
Function	0: Disable 1: Enable		Detection condition 0: no touch 1: touch	INT4 interrupt control 0: Disable 1: Enable	SPY 0 : OFF 1 : ON	SPX 0 : OFF 1 : ON	SMY 0 : OFF 1 : ON	SMX 0 : OFF 1 : ON

PXD (Internal Pull-down resistance) ON/OFF setting

<PXEN> / <TSI7>	0	1
0	OFF	OFF
1	ON	OFF

Debounce Time Setting Register

TSICR1 (01F1H)

	7	6	5	4	3	2	1	0
Bit symbol	DBC7	DB1024	DB256	DB64	DB8	DB4	DB2	DB1
Read/Write	R/W							
After reset	0	0	0	0	0	0	0	0
Function	0: Disable 1: Enable	1024	256	64	8	4	2	1
		Debounce time is set by the formula "$(N \times 64 - 16)/f_{SYS}$". "N" is the number of bits between bit6 and bit0 which are set to "1". Note2)						

Note1: Since an internal clock is used for the debounce circuit, when IDLE1, STOP mode, the de-bounce circuit don't operate and also interrupt which through this circuit is not generated. When IDLE1, STOP mode, set this circuit to disable (Write "0" to TSICR1<DBC7>) before entering HALT state.

Note2: Ex:

TSICR1=95H →N = 64 + 4 + 1 = 69

3.20.3 Touch Detection Procedure

The Touch detection procedure shows procedure until a pen is touched by the screen and it is detected.

By touching, TSI generates interrupt (INT4) and this procedure terminates. After an X/Y position measuring procedure is terminated, return to this procedure and wait for the next touch.

When the waiting state, make ON only the SPY switch ON and OFF the other 3 switches (SMY, SPX and SMX).

The pull-down resistor that is connected to the P96/INT4/PX pin is ON when the SPX switch is OFF.

During this waiting state, P96/INT4/PX pin's level is L because the internal Pull-down resistors (PXD) between the X and Y directions in the touch screen are not connected and INT4 is not generated.

When the pen touches the screen, P96/INT4/PX pin's level is H because the internal resistors between the X and Y directions in the touch screen are connected and INT4 is generated.

In order to avoid the generation of several interrupts from one touch, a debounce circuit is used, as below.

This can ignore the pulse under the time which is set to TSICR1 register.

The circuit detects the rising of signal, counts-up the time of the counter which is set, after count, receive the signal internal. During counting, when the signal is set to Low, counter is cleared. And the state become to state of waiting a rising edge.

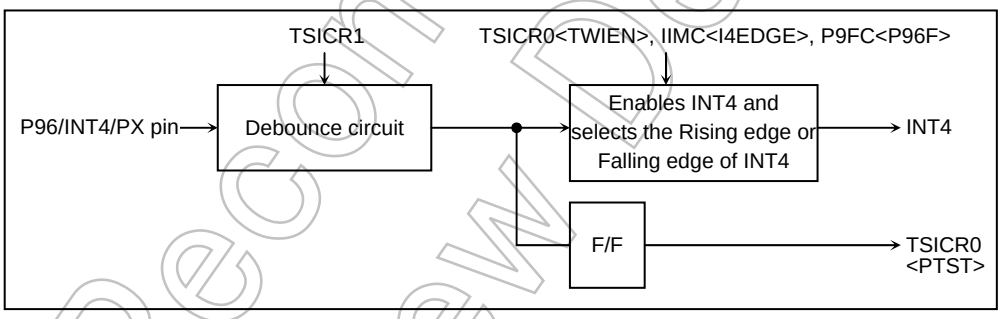


Figure 3.20.3 Block Diagram of Debounce Circuit

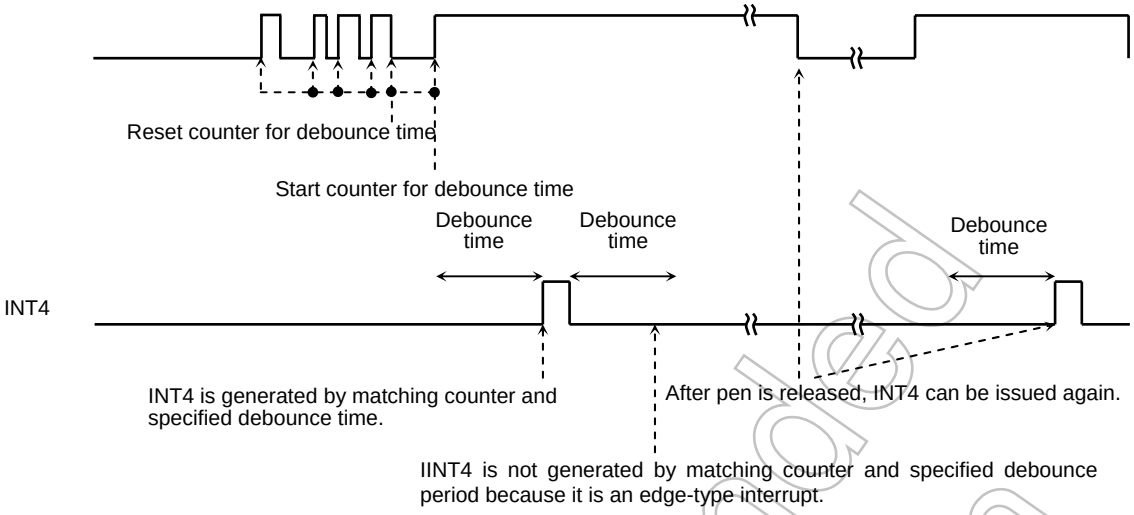


Figure 3.20.4 Timing Diagram of Debounce Circuit

3.20.4 X/Y Position Measuring Procedure

During the INT4 routine, execute an X/Y position measuring procedure as below.

<X position measurement>

Make both the SPX and SMX switches ON, and the SPY and SMY switches OFF.

With this setting, an analog voltage which shows the X position will be input to the PG3/MY/AN3 pin. The X position can be measured by converting this voltage to digital code using the AD converter.

<Y position measurement>

Next, make both the SPY and SMY switches ON and the SPX and SMX switches OFF.

With this setting, an analog voltage which shows the Y position will be input to the PG2/MX/AN2 pin. The Y position can be measured by converting this voltage to digital code using the AD converter.

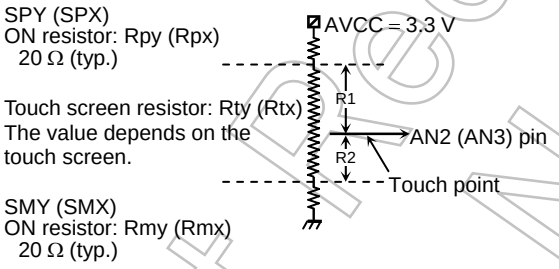
The above analog voltage which is inputted to AN3 or AN2 pin can be calculated as follows.

It is the ratio between the resistance value in the TMP92CA25F and the resistance value in the touch screen as shown in Figure 3.20.5.

Therefore, if the pen touches an area on the touch screen, the analog voltage will be neither 3.3 V nor 0.0 V.

Please remember to take into consideration the variation in the rate of resistance.

It is also recommended that an average taken from several AD conversions be adopted as the correct code.



[Formula to calculate analog voltage (E1) to AN2 or AN3 pin]

$E1 = ((R2 + Rmy)/(Rpy + Rty + Rmy)) \times AVCC$ [V]

Example: When AVCC = 3.3 V, Rpy = Rmy = 20 Ω,
R1 = 400 Ω and R2 = 100 Ω
$E1 = ((100 + 20)/(20 + 400 + 100 + 20)) \times 3.3$
$= 0.733$ V

Note 1: An X position can be calculated in the same way though the above formula is for Y position.

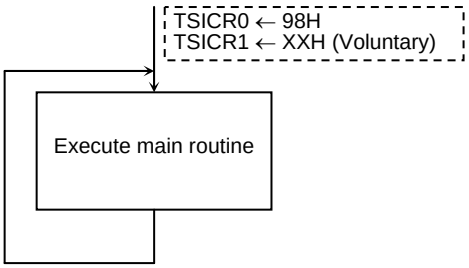
Note 2: Rty = R1 + R2.

Figure 3.20.5 Calculation Analog Voltage

3.20.5 Flow Chart for TSI

(1) Touch detection procedure

Main routine:



(2) X/Y position measurement procedure

INT4 routine:

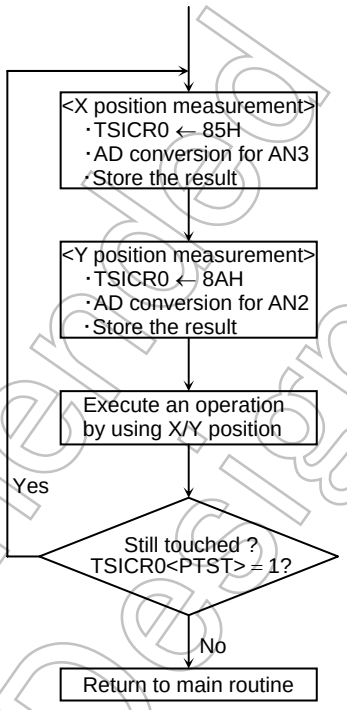


Figure 3.20.6 Flow Chart for TSI

Following pages explain each circuit condition of (a), (b) and (c) in above flow chart.

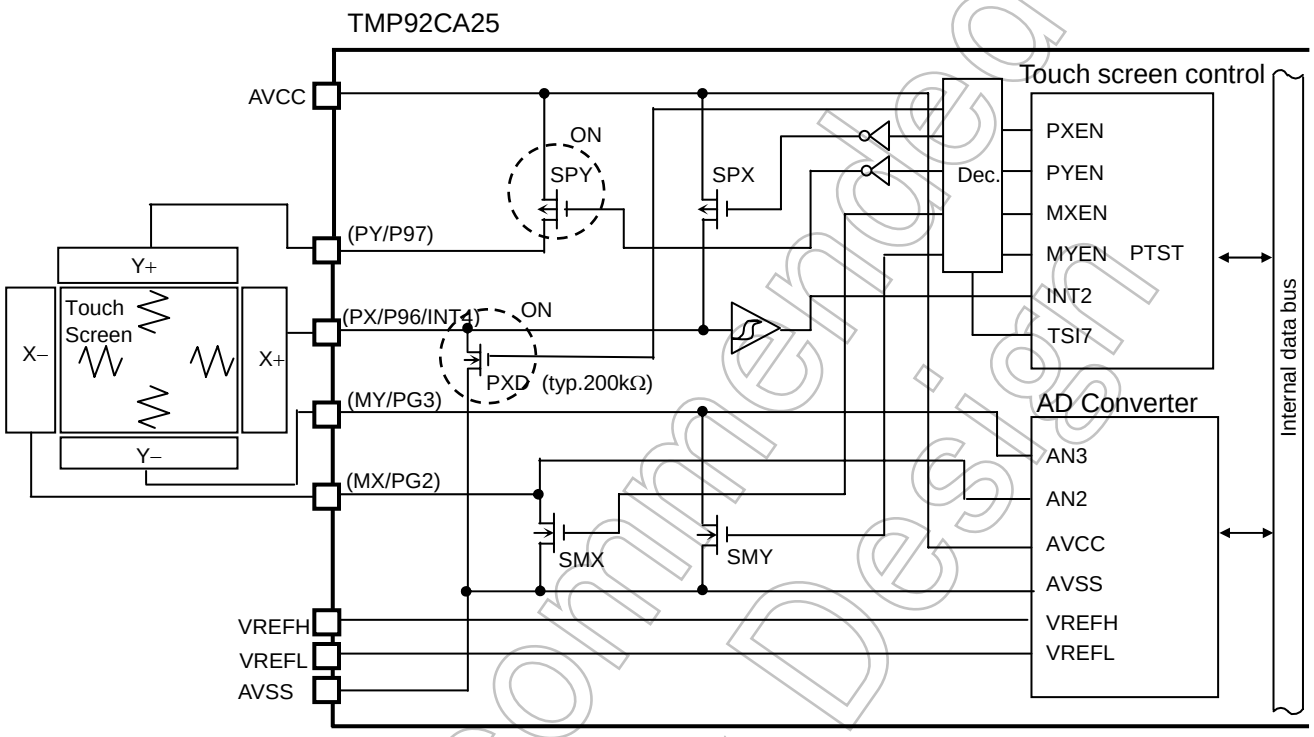
(a) Main routine (condition of waiting INT4 interrupt)

(pbfc)<P96F>,<P97F>= "1" : P96: int4/PX , P97:PY

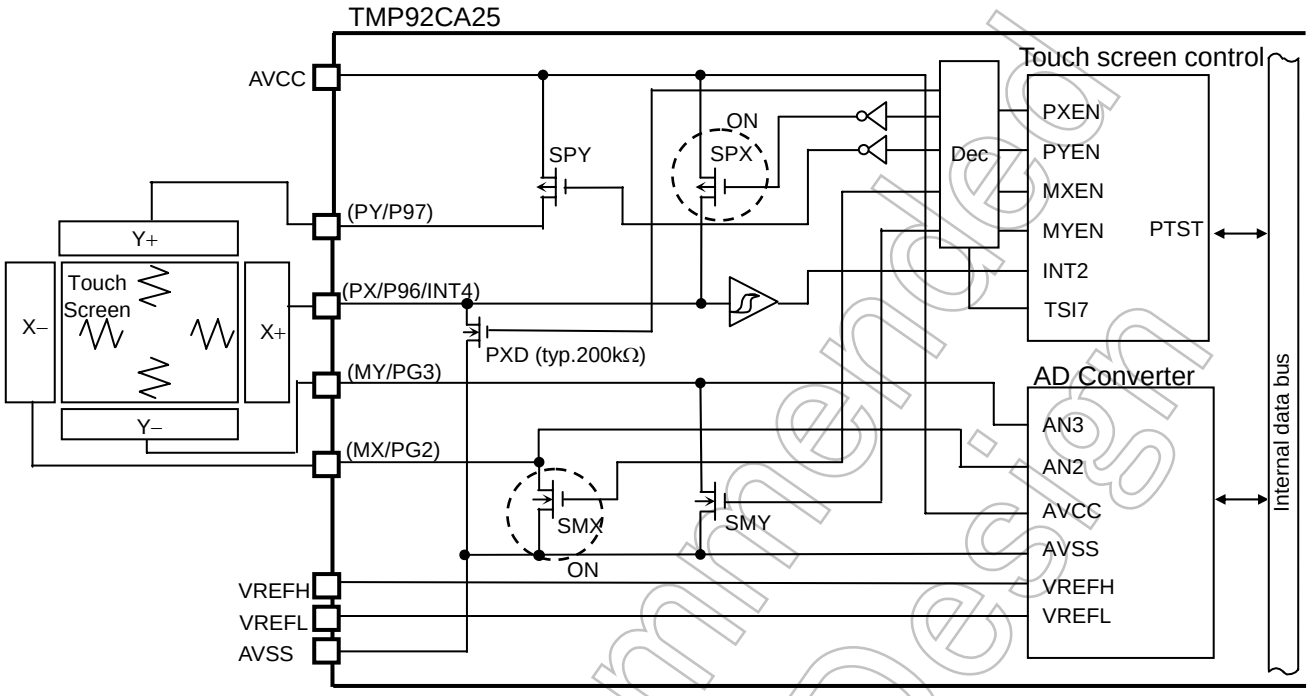
(inte34) : Set interrupts level of INT4

(tsicr0)=98h : Pull down resister on, SPY on, Interrupt-set<TWIEN>

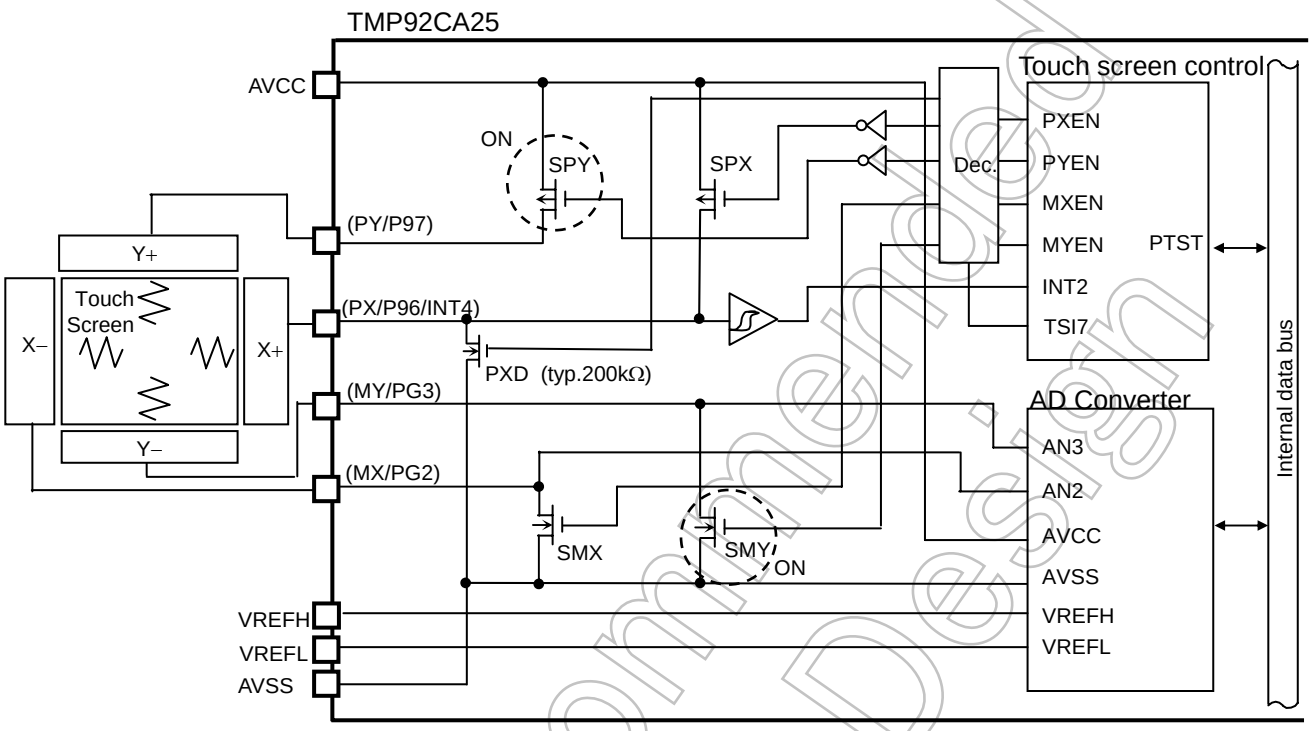
ei : Enable interrupt



(b) X position measurement (Start A/D conversion)
(tsicr0)=85h : SMX, SPX on
(admod1)=83h : AN3 measure
(admod0)=01h : A/D start



(c) Y position measurement (Start A/D conversion)
(tsicr0)=8ah : SMY, SPY on
(admod1)=82h : AN2 measure
(admod0)=01h : A/D start



3.21 I²S (Inter-IC Sound)

An I²S format compatible serial output circuit is built-in.

This product can be used in digital audio system applications by connecting LSI for sound generation (e.g., a DA converter).

This circuit has both I²S mode and general SIO mode. But both modes have only clock output and data transmitting functions.

Table 3.21.1 shows an outline for each mode.

Table 3.21.1 Outline for Each Mode

	I²S mode	SIO mode
1) Format	I²S-format compatible (Only master and transmitting)	General (Only master and transmitting)
2) Used pin	1. I2SCKO (Clock output) 2. I2SDO (Clock output) 3. I2SWS (Word select output)	1. I2SCKO (Clock output) 2. I2SDO (Data output)
3) WS frequency	Selectable either fs/4 or TA1OUT (TMRA1 output)	–
4) Baud rate (at fc = 40 MHz)	Selectable either 20, 10, 5, or 2.5 Mbps	
5) Transmittion buffer	16 bytes × 2 channels (Right, left)	32 bytes
6) Direction of data	Selectable either MSB first or LSB first	
7) Data length	Selectable either 8 bits or 16 bits	
8) Edge of clock	Selectable either rising edge or falling edge	
9) Interrupt	INTI2S (FIFO empty interrupt)	

3.21.1 Block Diagram

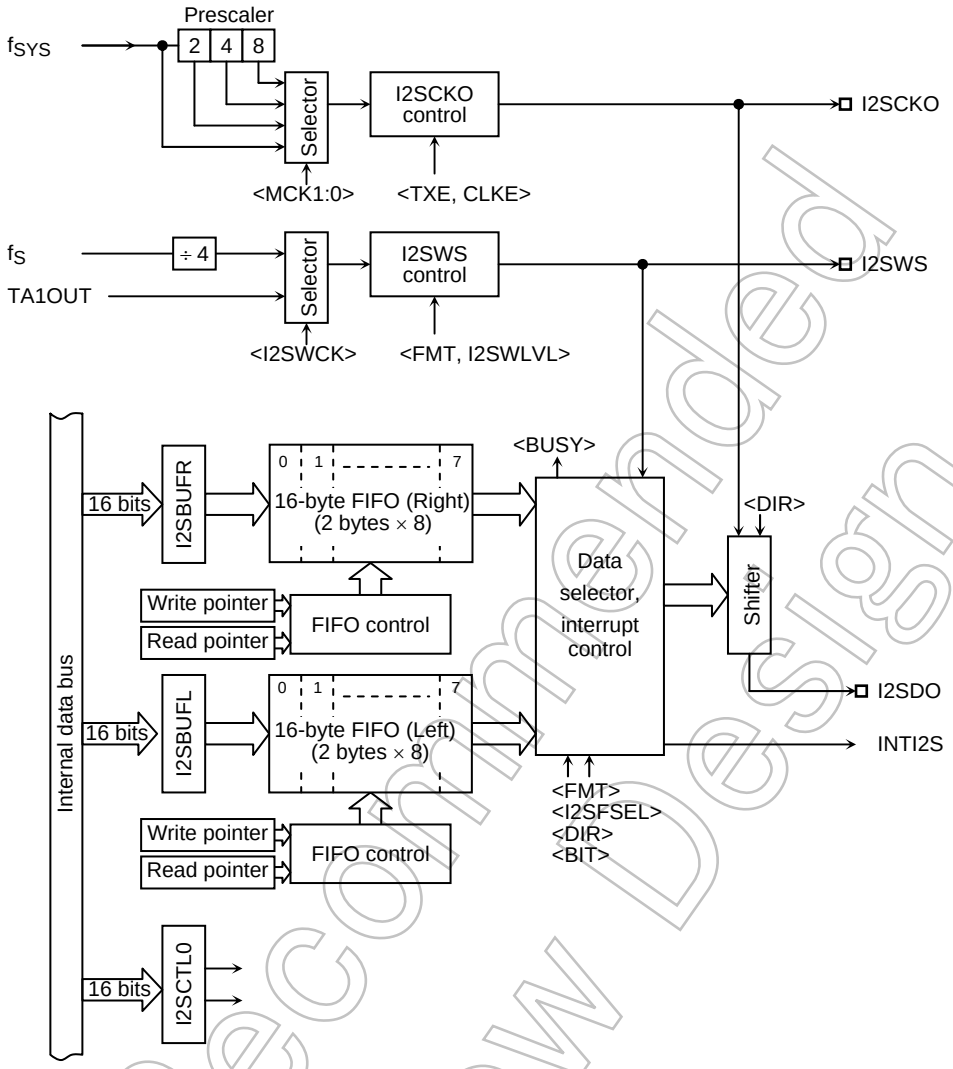


Figure 3.21.1 I²S Block Diagram

3.21.2 SFR

The following tables show the SFR for I²S. This I²S is connected to the CPU by the 16-bit data bus. When the CPU accesses the SFR, use a 2-byte load instruction.

I2SCTL0 Register

		7	6	5	4	3	2	1	0
I2SCTL0 (080EH)	Bit symbol	TXE	FMT	BUSY	DIR	BIT	MCK1	MCK0	I2SWCK
	Read/Write	R/W		R	R/W				
	After reset	0	0	0	0	0	0	0	0
	Function	Transmit 0: Stop 1: Start	Mode 0: I^2S 1: SIO	Status 0: Stop 1: Under transmitting	First bit 0: MSB 1: LSB	Bit number 0: 8 bits 1: 16 bits	Baud rate 00: f_{SYS} 01: $f_{SYS}/2$	10: $f_{SYS}/4$ 11: $f_{SYS}/8$	WS clock 0: fs/4 1: TA1OUT

Note: <I2SWCK> is effective only for I^2S mode.

		15	14	13	12	11	10	9	8
(080FH)	Bit symbol	I2SWLVL	EDGE	I2SFSEL	I2SCLKE				SYSCKE
	Read/Write	R/W							R/W
	After reset	0	0	0	0				0
	Function	WS level 0: Low left 1: High left	Clock edge for data out 0: Falling 1: Rising	Select for stereo 0: Stereo (2 channels) 1: Monaural (1 channel)	Clock enable (After transmit) 0: Operation 1: Stop				System clock 0: Disable 1: Enable

Note: <I2SWLVL>, <I2FSEL> and <I2SCLKE> are effective only in I^2S mode.

I2SBUFR Register

		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
I2SBUFR (0800H)	Bit symbol	R15	R14	R13	R12	R11	R10	R9	R8	R7	R6	R5	R4	R3	R2	R1	R0
Read-modify-write instruction is prohibited	Read/Write	W															
	After reset	Undefined															
	Function	Register for transmitting buffer (FIFO) (Right channel)															

I2SBUFL Register

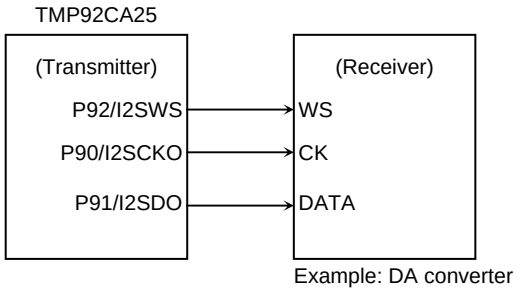
		15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
I2SBUFL (0808H)	Bit symbol	L15	L14	L13	L12	L11	L10	L9	L8	L7	L6	L5	L4	L3	L2	L1	L0
Read-modify-write instruction is prohibited	Read/Write	W															
	After reset	Undefined															
	Function	Register for transmitting buffer (FIFO) (Left channel)															

Figure 3.21.2 I^2S SFR

3.21.3 Explanation of I^2S Mode

(1) Connection example

Figure 3.21.3 shows an example with external LSI.



Note: After reset, P90 to P92 are placed in a high-impedance state. Connect each pin with a pull-up or pull-down resistor as necessary.

Figure 3.21.3 Example with External LSI

(2) Procedure

A 32-byte FIFO is built-in. If the FIFO's data becomes empty, an INTI2S interrupt is generated.

In the interrupt routine, write the next transmission data to the FIFO.

The following shows a setting example and timing diagram.

(Setting example) Transmitting by I^2S mode, I2SWS = 8.192 kHz, I2SCKO = 10 MHz, synchronous with rising edge
(at f_{SYS} = 20 MHz)

(Main routine)

	7	6	5	4	3	2	1	0	
INTE5I2S	X	0	0	1	X	–	–	–	Set interrupts level.
P9CR	–	–	–	–	–	0	0	0	Set pins to P90 (I2SCKO), P91 (I2SDO), and P92 (I2SWS).
P9FC	–	–	–	–	–	1	1	1	
I2SCTL0	0	0	–	0	0	0	1	0	Set I^2S mode, MSB first, 8 bits, f_{SYS}/2 clocks.
	0	1	0	1	0	0	0	1	Set rising edge, clock stop.
I2SBUFR	**	**	**	**	**	**	**	**	Write 16-byte data to FIFO for right (8 times).
I2SBUFL	**	**	**	**	**	**	**	**	Write 16-byte data to FIFO for left (8 times).
I2SCTL0	1	0	–	0	0	0	1	0	Start transmitting.
	0	1	0	1	0	0	0	1	

(INTI2S interrupt routine)

I2SBUFR	**	**	**	**	**	**	**	**	Write 16-byte data to FIFO for right (8 times).
I2SBUFL	**	**	**	**	**	**	**	**	Write 16-byte data to FIFO for left (8 times).

X: Don't care, –: No change

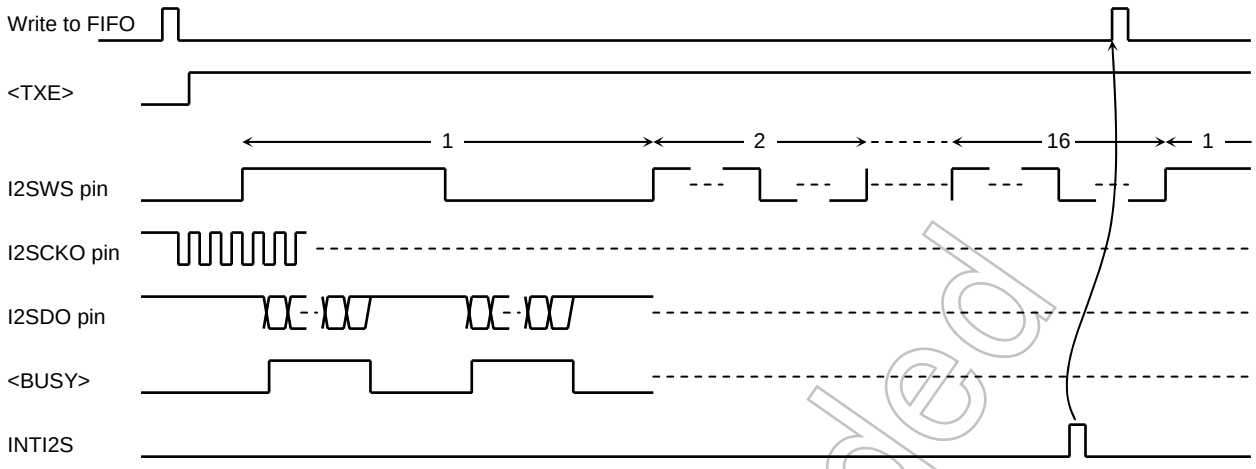


Figure 3.21.4 Whole Timing Diagram

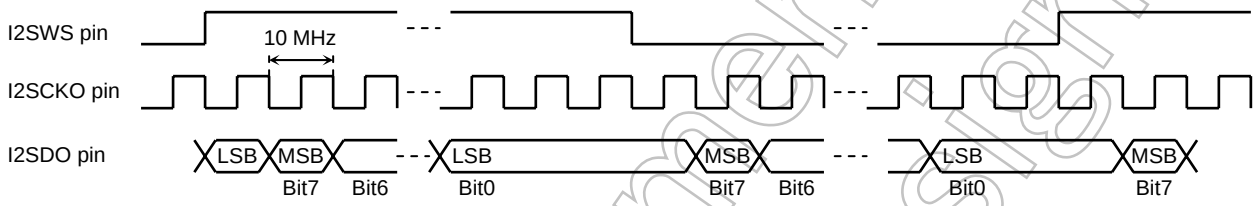


Figure 3.21.5 Detail Timing Diagram

(3) Notes

1) INTI2S timing

INTI2S is generated after the last data of FIFO is loaded to the internal shifter.

FIFO is now empty and it is possible to write the next data.

2) I2SCTL0<TXE>

A transmission is started by programming "1" to the <TXE> register and stopped by writing "0".

After<TXE> is programmed "1" once, the transmission is repeated automatically from right to left in order, alternately.

If a transmission should be stopped, program "0" to <TXE> after <BUSY> changes to "0" in the INTI2S interrupt routine.

When <TXE> is programmed "0" during transmitting, transmitting stops immediately.

3) FIFO size

A 16-byte FIFO is provided for both right and left channels. It is not necessary to use all data, but please use the even numbers (2, 4 ... 16).

4) I2SCTL0<I2SFSEL>

Write "1" to <I2SFSEL> and use the right channel FIFO for monaural.

It is not necessary to write data to the left channel FIFO. Channel transmission data is fixed at "0".

5) Address for I2SBUFR and I2SBUFL

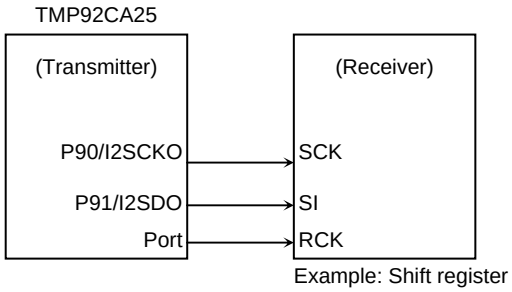
If writing data to I2SBUFR or I2SBUFL, use "word or long word data load instruction". A "byte data load instruction" cannot be used.

The address of I2SBUFR selectable from 0800H to 0803H, and I2SBUFL is selectable from 0808H to 080BH.

3.21.4 Explanation of SIO Mode

(1) Connection example

Figure 3.21.6 shows an example with external LSI.



Note: Since P90 to P91 become high impedance by reset, connect a pull-up or pull-down resistor if necessary.

Figure 3.21.6 Example with External LSI

(2) Procedure

A 32-byte FIFO is built-in. If the FIFO's data becomes empty, an INTI2S interrupt is generated.

In the interrupt routine, write the next transmission data to the FIFO.

The following shows a setting example and timing diagram.

(Setting example) Transmitting by SIO mode, I2SCKO = 10 MHz, synchronous with rising edge (at f_{SYS} = 20 MHz)

(Main routine)

	7	6	5	4	3	2	1	0	
INTE5I2S	X	0	0	1	X	–	–	–	Set interrupts level.
P9CR	–	–	–	–	–	–	0	0	Set pins to P90 (I2SCKO) and P91 (I2SDO).
P9FC	–	–	–	–	–	–	1	1	
I2SCTL0	0	1	–	1	0	0	1	–	Set SIO mode, LSB first, 8 bits, f_{SYS}/2 clocks.
	–	1	–	1	0	0	0	1	Set rising edge.
I2SBUFR	**	**	**	**	**	**	**	**	Write 32-byte data to FIFO (16 times).
I2SCTL0	1	1	–	1	0	0	1	–	Start transmitting.
	–	1	–	1	0	0	0	1	

(INTI2S interrupt routine)

I2SBUFR	**	**	**	**	**	**	**	**	Write 32-byte data to FIFO (16 times).
If <BUSY> = "1" then WAIT else NEXT									Confirm termination of the 32-byte data transfer.
I2SCTL0	1	1	–	1	0	0	1	–	Start transmitting.
	–	1	–	1	0	0	0	1	

X: Don't care, –: No change

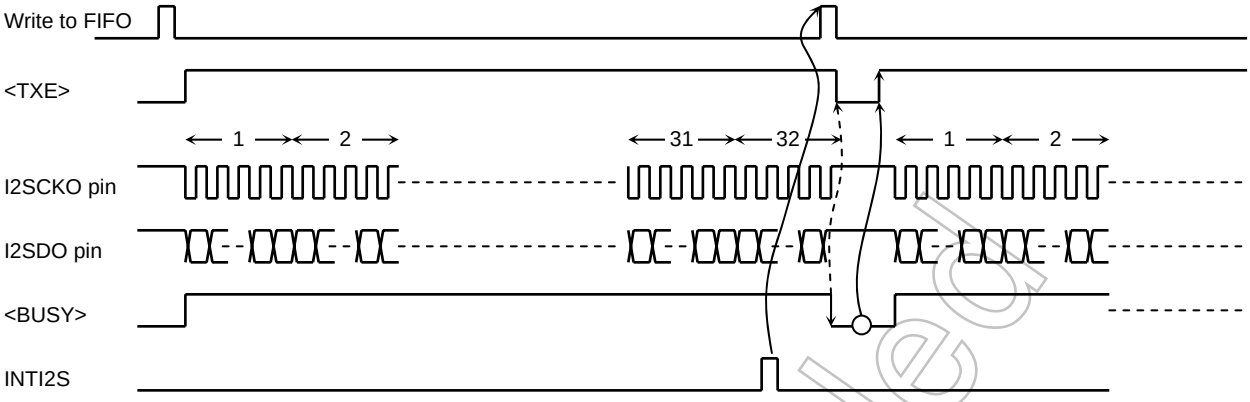


Figure 3.21.7 Whole Timing

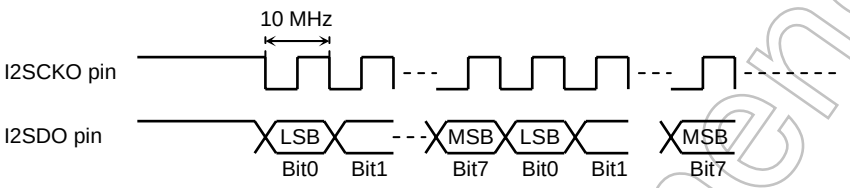


Figure 3.21.8 Detail Timing

(3) Notes

1) INTI2S timing

INTI2S is generated after the last data of FIFO is loaded to the internal shifter.

FIFO is now empty and it is possible to write the next data.

2) I2SCTL0 <TXE>

A transmission is started by programming "1" to the <TXE> register and stopped by programming "0".

<TXE> register is cleared to "0" when <BUSY> changes from "1" to "0".

When <TXE> is programmed "0" during transmitting, transmitting stops immediately.

3) FIFO size

A 32-byte FIFO is provided for SIO mode. It is not necessary to use all data but please use even numbers (2, 4 ... 32).

The <BUSY> will be changed to "0" and <TXE> will be cleared to "0" automatically after transmitting all programmed data to FIFO. In case of continuous transmitting, program "1" to <TXE> after programming data to FIFO.

The number of data programmed to FIFO is counted automatically and held by programming "1" to <TXE>.

4) Address for I2SBUFR and I2SBUFL

If writing data to I2SBUFR (I2SBUFL cannot be written), use "word or long word data load instruction". A "byte data load instruction" cannot be used.

The address of I2SBUFR is selectable from 0800H to 0803H.

3.22 Power Supply Backup (Power Supply Backup)

TMP92CA25 includes three type power supply systems.

Analog Power supply input (AVCC - AVSS)

Digital Power suppy input (DVCC - DVSS)

Power supply input for RTC (RTCVCC - DVSS)

Each Power supply is independent.

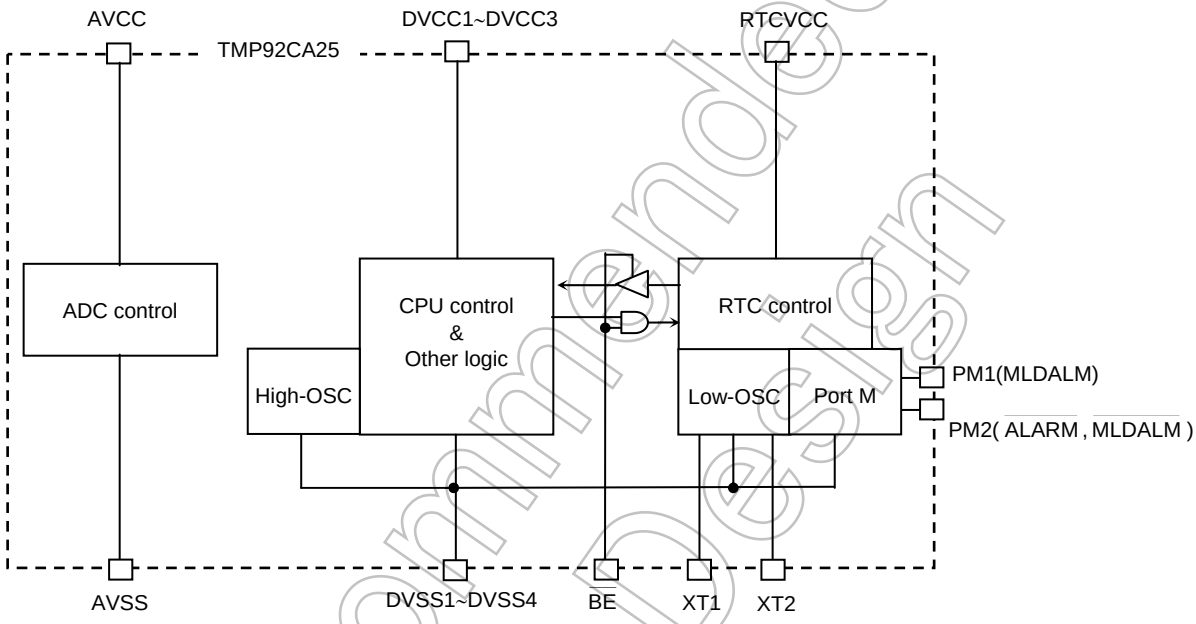


Figure 3.22.1 Power supply input system

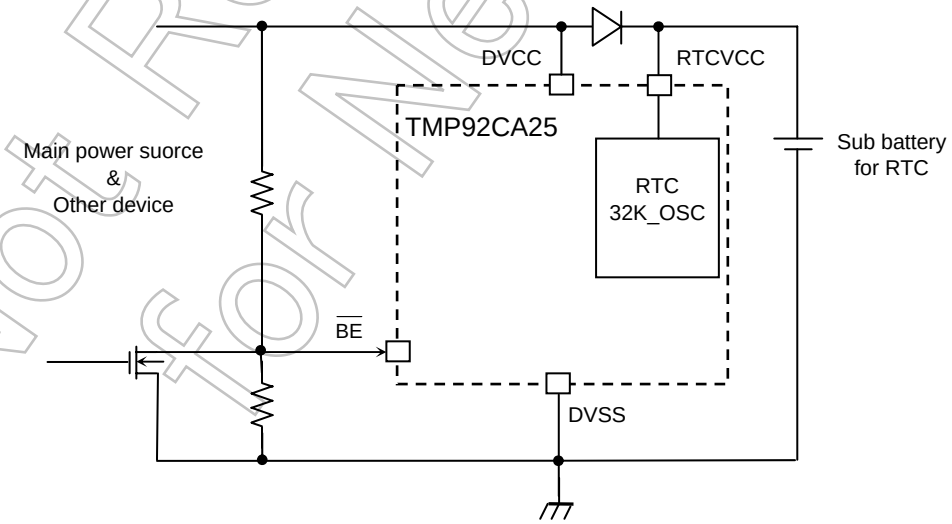


Figure 3.22.2 Outside circuit example for PSB

TMP92CA25 has the power supply backup mode which is desighed to work for only low-speed oscillator, RTC and port M under sub battery supply. TMP92CA25 is set to the power supply backup mode by using the $\overline{BE}$ pin (Backup enable) and the $\overline{RESET}$ pin.

Figure 3.22.3 and Figure 3.22.4 shows the timing diagram of $\overline{BE}$ pin and $\overline{RESET}$ pin.

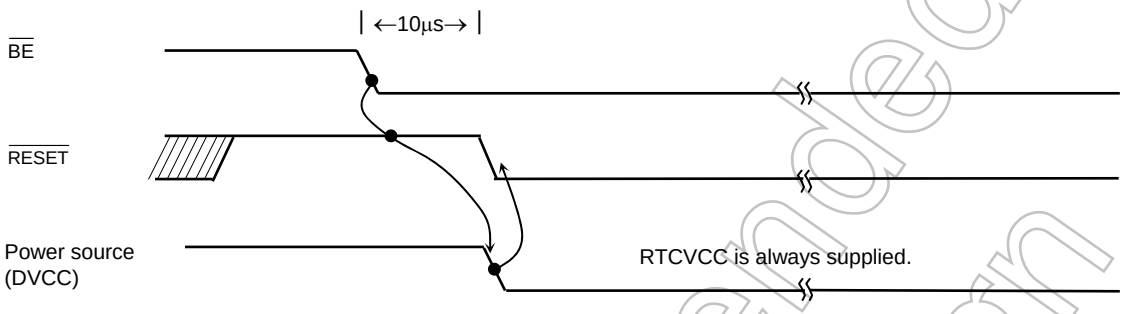


Figure 3.22.3 Shift from Normal Mode to PSB Mode

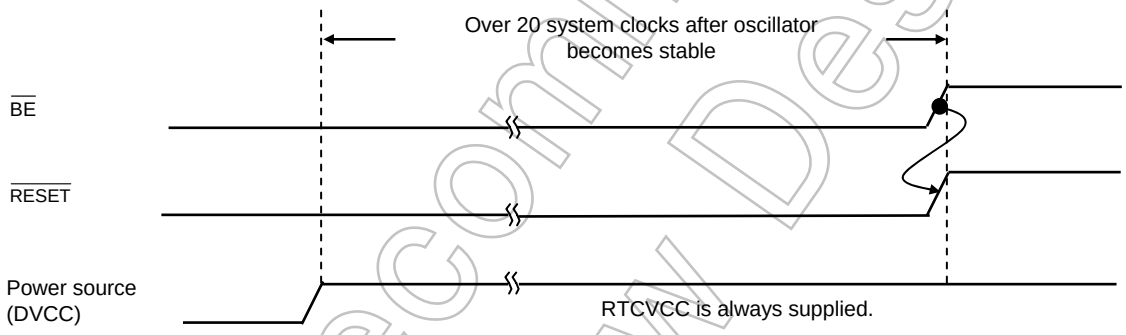


Figure 3.22.4 Shift from PSB Mode to NORMAL Mode

Backup enable pin ($\overline{BE}$)

Low frequency oscillator, RTC and Port M can work also if $\overline{BE}$ = "L".

If $\overline{BE}$ = "L", Low frequency oscillator, RTC and Port Mare separated from CPU and so on in internal. Therefore, it is prohibited accessing to RTC register and Port M. In addition, Low frequency oscillator (fs) isn't provided except RTC circuit (Melody Alarm generator etc.). So, $\overline{ALARM}$ (= output function of RTC) can output from PM2 pin, if port is set before set to $\overline{BE}$ = "L".

Note:

1: If "H" level signal was inputted to general purpose port with power off condition, current is used more than always. Therefore, set to "l" level or High-impedance condition. If this back up function is used, set $\overline{BE}$ pin to "L" level when DVCC power off.

2: When $\overline{BE}$ pin is set to "L", Low frequency oscillator operation become same with EMCCR0<DRVOSCL> = "0", forcibly. Therefore, don't set to $\overline{BE}$ = "L", when it is not operated Low frequency oscillator.

3: When $\overline{BE}$ pin is set to "L", PM2, PM1 pins condition change according to setting value of PMDR<PM2D, PM1D>. If keep output PM2, PM1 pins write "11" to <PM2D, PM1D> before set to $\overline{BE}$ = "L".

4: If release $\overline{RESET}$, release $\overline{RESET}$ after $\overline{BE}$ = "H".

3.23 External bus release function

TMP92CA25 have external bus release function that can connect bus master to external. Bus release request ($\overline{\text{BUSRQ}}$), bus release answer ($\overline{\text{BUSAK}}$) pin is assigned to Port L6 and L7. And, it become effective by setting to PLCR and PLFC.

Figure 3.23.1 shows operation timing. Time that from $\overline{\text{BUSRQ}}$ pin inputted "0" until busis released ($\overline{\text{BUSAK}}$ is set to "0") depend on instruction that CPU execute at that time.

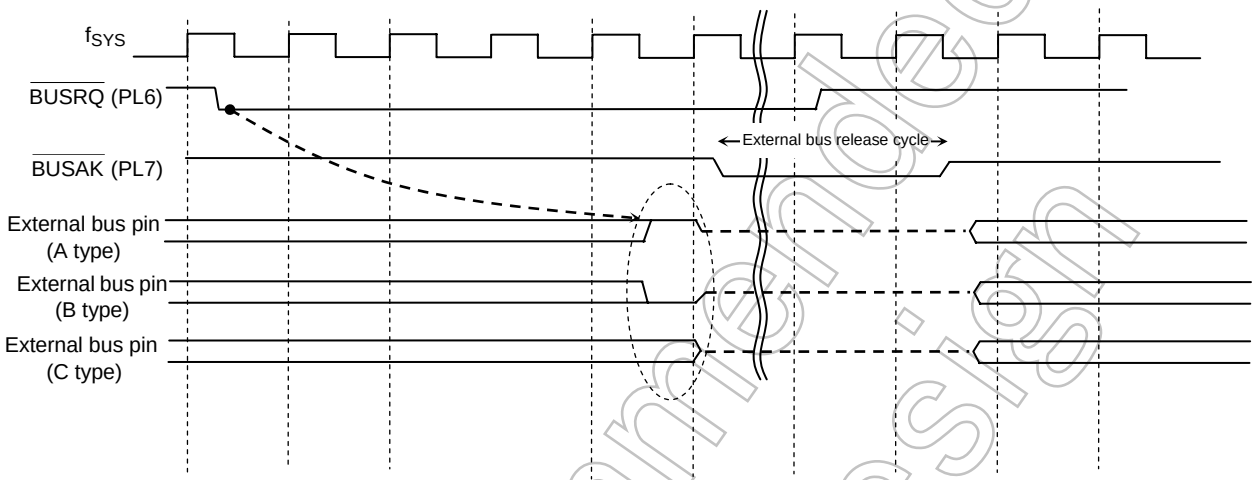


Figure 3.23.1 Bus release function operation timing

3.23.1 Non release pin

If it received bus release request, CPU release bus to external by setting $\overline{\text{BUSAK}}$ pin to "0" without start next bus. In this case, pin that is released have 3 types (A, B and C). Eve operation that set to high impedance (HZ) is different in 3 types. Table 3.23.1 shows support pin for 3 types. Any pin become non release pin only case of setting to that function by setting port. Therefore, if pin set to output port and so on, it is not set non relase pin, and it hold previous condition.

Table 3.23.1 Non release pin

Type	Eve operation that set to HZ	Support function (Pin name)
A	Drive "1"	A23-A16(P67-P60), A15-A0, $\overline{\text{RD}}$ (P70), $\overline{\text{WRLL}}$ (P71), $\overline{\text{WRLU}}$ (P72), EA24(P73), EA25(P74), R/$\overline{\text{W}}$ (P75), $\overline{\text{CS0}}$ (P80), $\overline{\text{CS1}}$ (P81), $\overline{\text{SDCS}}$ (P81), $\overline{\text{CS2}}$ (P82), $\overline{\text{CSZA}}$ (P82), $\overline{\text{CS3}}$ (P83), $\overline{\text{CSZB}}$ (P84), $\overline{\text{CSZC}}$ (P85), $\overline{\text{CSZD}}$ (P86), $\overline{\text{CSZE}}$ (P87), EA24(PC6), EA25(PC7), $\overline{\text{CSZF}}$ (PC7), $\overline{\text{SRLLB}}$, $\overline{\text{SDRAS}}$ (PJ0), $\overline{\text{SRLUB}}$, $\overline{\text{SDCAS}}$ (PJ1), $\overline{\text{SRWR}}$, $\overline{\text{SDWE}}$ (PJ2), SDCLK(PF7), SDLLDQM(PJ3), SDLUDQM(PJ4)
B	Drive "0"	SDCKE(PJ7)
C	None operation	D15-D8(P17-P10), D7-D0

3.23.2 Connection example

Figure 3.23.2 show connection example.

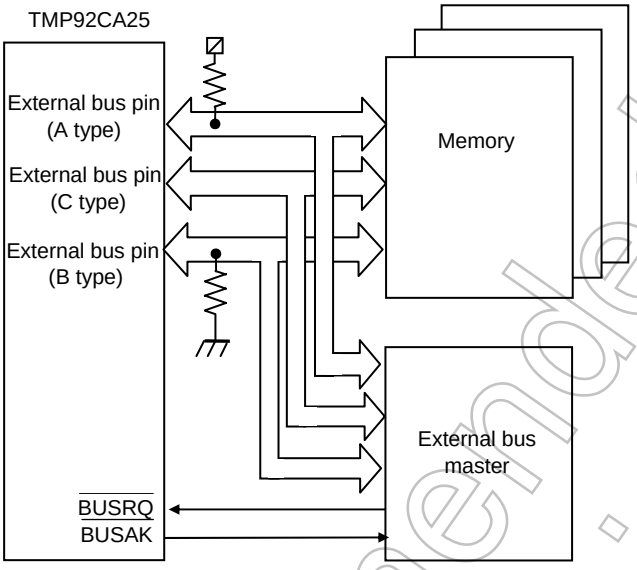


Figure 3.23.2 Connection example

3.23.3 Note

If use bus release function, be careful following notes.

1) Prohibit using this function together LCD controller and, SDRAM controller

If use this function, prohibit use LCD controller in SR mode. And, prohibitalso SDRAMC basically, but if external bus master use SDRAM, set SDRAM to SR (self refresh) condition before bus release request. And, when finish bus release, release SR condition. In this case, confirm each condition by handshake of general purpose port.

2) Support standby mode

The condition that can receive this function is only CPU operationg condition and during IDLE2 mode. During IDLE1 and STOP condition don't receive. (Bus release function is ignored).

3) Internal resource access disable

External bus master cannnot access to internal memory and interhal I/O of TMP92CA25. Internal I/O operation during bus releasing.

4) Internal I/O operation during bus releasing

Internal I/O continue operation during bus releasing, please be careful. And, if set the watchdog timer, set runaway time by consider bus release time.

5) Non release pin

Control output pin for NAND-Flash ($\overline{\text{ND0CE}}$, $\overline{\text{ND1CE}}$, NDALE, NDCLE, $\overline{\text{NDRE}}$, $\overline{\text{NDWE}}$) are not non release pins.

4. Electrical Characteristics

4.1 Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Power Supply Voltage	V_{CC}	−0.5 to 4.0	V
Input Voltage	V_{IN}	−0.5 to VCC + 0.5	V
Output Current	I_{OL}	2	mA
Output Current (MX, MY pin)	I_{OL}	15	mA
Output Current	I_{OH}	−2	mA
Output Current (PX, PY pin)	I_{OH}	−15	mA
Output Current (Total)	ΣI_{OL}	80	mA
Output Current (Total)	ΣI_{OH}	−80	mA
Power Dissipation (Ta = 85°C)	P_D	600	mW
Soldering Temperature (10 s)	T_{SOLDER}	260	°C
Storage Temperature	T_{STG}	−65 to 150	°C
Operation Temperature	T_{OPR}	−20 to 70	°C

Note: The Absolute maximum ratings are rated values which must not be exceeded during operation, even for an instant. Any one of the ratings must not be exceeded. If any absolute maximum rating is exceeded, the device may break down or its performance may be degraded, causing it to catch fire or explode resulting in injury to the user. Thus, when designing products which include this device, ensure that no absolute maximum rating value will ever be exceeded.

Solderability of lead free products

Test parameter	Test condition	Note
Solderability	(1) Use of Sn-37Pb solder Bath Solder bath temperature = 230°C, Dipping time = 5 seconds The number of times = one, Use of R-type flux	Pass: solderability rate until forming ≥ 95%
	(2) Use of Sn-3.0Ag-0.5Cu solder bath Solder bath temperature = 245°C, Dipping time = 5 seconds The number of times = one, Use of R-type flux (use of lead-free)	

4.2 DC Electrical Characteristics (1/2)

V_{CC} = 3.3 ± 0.3V/X1 = 6 to 40 MHz/Ta = −20 to 70°C
V_{CC} = 2.7 − 3.6V/X1 = 6 to 27 MHz/Ta = −20 to 70°C

Parameter	Symbol	Min	Typ.	Max	Unit	Condition	
Power supply voltage (DVCC = AVCC) (DVSS = AVSS = 0 V)	V_{CC}	3.0		3.6	V	X1 = 6 to 40 MHz	XT1 = 30 to 34 kHz
		2.7				X1 = 6 to 27 MHz	
Input low voltage for D0 to D7 P10 to P17 (D8 to D15)	V_{IL0}	−0.3		0.6	V		
Input low voltage for P40 to P47, P50 to P57, P60 to P67, P71 to P76, P90, P93 to P94, PC4 to PC7, PF3 to PF6, PG0 to PG3, PJ5 to PJ6, PK4 to PK7, PL4 to PL7	V_{IL1}			$0.3 \times V_{CC}$			
Input low voltage for P91 to P92, P96 to P97, PA0 to PA7, PC0 to PC3, PF0 to PF2, $\overline{BE}$, $\overline{RESET}$	V_{IL2}			$0.25 \times V_{CC}$			
Input low voltage for AM0 to AM1	V_{IL3}			0.3			
Input low voltage for X1, XT1	V_{IL4}			$0.2 \times V_{CC}$			
Input high voltage for D0 to D7 P10 to P17 (D8 to D15)	V_{IH0}	2.0		V_{CC} + 0.3	V		
Input high voltage for P40 to P47, P50 to P57, P60 to P67, P71 to P76, P90, P93 to P94, PC4 to PC7, PF3 to PF6, PG0 to PG3, PJ5 to PJ6, PK4 to PK7, PL4 to PL7	V_{IH1}	$0.7 \times V_{CC}$					
Input high voltage for P91 to P92, P96 to P97, PA0 to PA7, PC0 to PC3, PF0 to PF2, $\overline{BE}$, $\overline{RESET}$	V_{IH2}	$0.75 \times V_{CC}$					
Input high voltage for AM0 to AM1	V_{IH3}	V_{CC} − 0.3					
Input high voltage for X1, XT1	V_{IH4}	$0.8 \times V_{CC}$					

DC Electrical Characteristics (2/2)

Parameter	Symbol	Min	Typ.	Max	Unit	Condition	
Output low voltage	V_{OL}			0.45	V	I_{OL} = 1.6 mA	
Output high voltage	V_{OH1}	2.4				I_{OH} = –400 μA	
	V_{OH2}	0.9 × V_{CC}				I_{OH} = –20 μA	
Internal resistor (ON) MX, MY pins	IMon			30	Ω	V_{OL} = 0.2V	V_{CC} = 3.0 to 3.6 V
Internal resistor (ON) PX, PY pins	IMon			30		V_{OH} = V_{CC} –0.2V	
Input leakage current	I_{LI}		0.02	±5	μA	0.0 ≤ V_{IN} ≤ V_{CC}	
Output leakage current	I_{LO}		0.05	±10	μA	0.2 ≤ V_{IN} ≤ V_{CC} – 0.2 V	
Power down voltage at STOP (for internal RAM backup)	V_{STOP}	1.8		3.6	V	V_{IL2} = 0.2 × V_{CC}, V_{IH2} = 0.8 × V_{CC}	
Pull-up resistor for $\overline{RESET}$, PA0 to PA7	R_{RST}	80		500	kΩ		
Programmable pull down resistor for p96	R_{KH}						
Pin capacitance	C_{IO}			10	pF	fc = 1 MHz	
Schmitt width for P91 to P92, P96 to P97, PA0 to PA7, PC0 to PC3, PF0 to PF2, BE, $\overline{RESET}$	V_{TH}	0.4	1.0		V		
NORMAL (Note 2)	I_{CC}		42	65	mA	V_{CC} = 3.6 V, fc = 40 MHz	
IDLE2			13	26			
IDLE1			3.1	8.7			
SLOW (Note 2)			41	110	μA	Ta ≤ 70°C	V_{CC} = 3.6 V, fs = 32 kHz
				70		Ta ≤ 50°C	
IDLE2			15	80		Ta ≤ 70°C	
				30		Ta ≤ 50°C	
IDLE1			4	60		Ta ≤ 70°C	
				20		Ta ≤ 50°C	
STOP			0.2	50		Ta ≤ 70°C	V_{CC} = 3.6 V
				15		Ta ≤ 50°C	

Note 1: Typical values are for when Ta = 25°C and VCC = 3.3 V unless otherwise noted.

Note 2: ICC measurement conditions (NORMAL, SLOW):

All functions are operational; output pins except the bus pin are opened, and input pins are fixed.

Bus pin C_L = 30 pF

4.3 AC Characteristics

4.3.1 Basic Bus Cycle

Read cycle

No.	Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
			Min	Max				
1	OSC period (X1/X2)	t_{OSC}	25	166.7	25	27.7	37.0	ns
2	System clock period (= T)	t_{CYC}	50	333.3	50	55.5	74.0	
3	SDCLK low width	t_{CL}	0.5 T – 15		10	12.7	22	
4	SDCLK high width	t_{CH}	0.5 T – 15		10	12.7	22	
5-1	A0 to A23 valid → D0 to D15 Input at 0 waits	$t_{AD\ (3.0\ V)}$		2.0 T – 30	70	81	–	
		$t_{AD\ (2.7\ V)}$		2.0 T – 35	–	–	113	
5-2	A0 to A23 valid → D0 to D15 Input at 1 wait	$t_{AD3\ (3.0\ V)}$		3.0 T – 30	120	136.5	–	
		$t_{AD3\ (2.7\ V)}$		3.0 T – 35	–	–	187	
6-1	$\overline{RD}$ falling → D0 to D15 Input at 0 waits	$t_{RD(a)}$		1.5 T – 30	45	53.3	81	
		$t_{RD(b)}$		1.25 T – 30	32.5	39.5	62.5	
		$t_{RD(c)}$		1.0 T – 30	20	25.7	44	
6-2	$\overline{RD}$ falling → D0 to D15 Input at 1 wait	$t_{RD3(a)}$		2.5 T – 30	95	108.8	155	
		$t_{RD3(b)}$		2.25 T – 30	82.5	95	136.5	
		$t_{RD3(c)}$		2.0T – 30	70	312	118	
7-1	$\overline{RD}$ low width at 0 waits	$t_{RR(a)}$	1.5 T – 20		55	63.2	91	
		$t_{RR(b)}$	1.25 T – 20		42.5	49.4	72.5	
		$t_{RR(c)}$	1.0 T – 20		30	35.6	54	
7-2	$\overline{RD}$ low width at 1 wait	$t_{RR3(a)}$	2.5 T – 20		105	118.8	165	
		$t_{RR3(b)}$	2.25 T – 20		92.5	105	146.5	
		$t_{RR3(c)}$	2.0 T – 20		80	91.2	128	
8	A0 to A23 valid → $\overline{RD}$ falling	$t_{AR(a)}$	0.5 T – 20		5	7.7	17	
		$t_{AR(a)}$	0.75 T – 20		17.5	21.5	35.5	
		$t_{AR(a)}$	1.0 T – 20		30	35.3	54	
9	$\overline{RD}$ falling → SDCLK rising	$t_{RK(a)}$	0.5 T – 20		5	7.7	17	
		$t_{RK(b)}$	0.25 T – 20		–7.5	–6.1	–1.5	
		$t_{RK(c)}$	0 T – 20		–20	–20	–20	
10	A0 to A23 valid → D0 to D15 hold	t_{HA}	0		0	0	0	
11	$\overline{RD}$ rising → D0 to D15 hold	t_{HR}	0		0	0	0	
12	$\overline{WAIT}$ setup time	t_{TK}	15		15	15	15	
13	$\overline{WAIT}$ hold time	t_{KT}	5		5	5	5	
14	Data byte control access time for SRAM	t_{SBA}		1.5 T – 30	45	53.3	81	
15	$\overline{RD}$ high width	$t_{RRH(a)}$	0.5 T – 15		10	12.7	22	
		$t_{RRH(b)}$	0.75 T – 15		22.5	26.5	40.5	
		$t_{RRH(c)}$	1.0 T – 15		35	40.3	59	

AC measuring condition

- Output: High = 0.7 VCC, Low = 0.3 VCC, C_L = 50 pF
- Input: High = 0.9 VCC, Low = 0.1 VCC

Note1: The figures in the “Variable” column cover the whole VCC range (2.7 V to 3.6 V). Exceptions are shown by the VCC (min), “(3.0 V)” or “(2.7 V)”, added to the “Symbol” column.

Note2: The figures in the (a), (b) and (c) of “Symbol” column shows difference of falling timing of $\overline{RD}$ pin. Falling timing of $\overline{RD}$ pin is set by MEMECR0<RDTMG1:0>. If MEMCR0<RDTMG1:0> is “00”, it correspond with (a) in above table, and “01” is (b), “10” is (c).

Write cycle

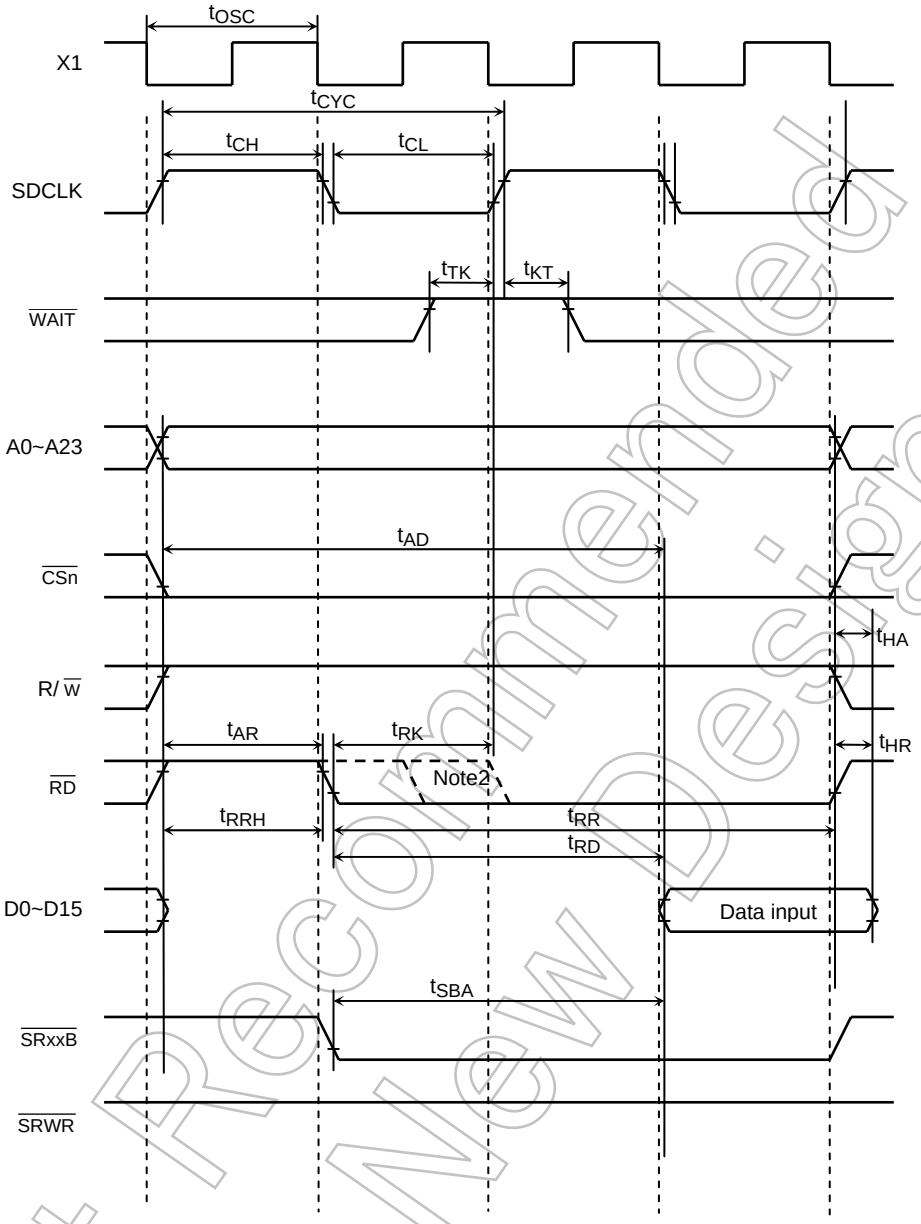
No.	Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
			Min	Max				
16-1	D0 to D15 valid → $\overline{WRxx}$ rising at 0 waits	t_{DW}	1.25T – 35		27.5	34.3	57.5	ns
16-2	D0 to D15 valid → $\overline{WRxx}$ rising at 1 wait	t_{DW3}	2.25T – 35		77.5	89.8	131.5	
17-1	$\overline{WRxx}$ low width at 0 waits	t_{WW}	1.25T – 30		32.5	34.3	62.5	
17-2	$\overline{WRxx}$ low width at 1 wait	t_{WW3}	2.25T – 30		82.5	89.8	136.5	
18	A0 to A23 valid → $\overline{WR}$ falling	t_{AW}	0.5T – 20		5	7.7	17	
19	$\overline{WRxx}$ falling → SDCLK rising	t_{WK}	0.5T – 20		5	7.7	17	
20	$\overline{WRxx}$ rising → A0 to A23 hold	t_{WA}	0.25T – 5		7.5	8.8	13.5	
21	$\overline{WRxx}$ rising → D0 to D15 hold	t_{WD}	0.25T – 5		7.5	8.8	13.5	
22	$\overline{RD}$ rising → D0 to D15 output	$t_{RDO\ (3.0\ V)}$	0.5T – 5		20	22.7	–	
		$t_{RDO\ (2.7\ V)}$	0.5T – 7		–	–	30	
23	Write pulse width for SRAM	t_{SWP}	1.25T – 30		32.5	39.3	62.5	
24	Data byte control to end of write for SRAM	t_{SBW}	1.25T – 30		32.5	39.3	62.5	
25	Address setup time for SRAM	t_{SAS}	0.5T – 20		5	7.7	17	
26	Write recovery time for SRAM	t_{SWR}	0.25T – 5		7.5	8.8	13.5	
27	Data setup time for SRAM	t_{SDS}	1.25T – 35		27.5	34.3	57.5	
28	Data hold time for SRAM	t_{SDH}	0.25T – 5		7.5	8.8	13.5	

AC measuring condition

- Output: High = 0.7 VCC, Low = 0.3 VCC, C_L = 50 pF
- Input: High = 0.9 VCC, Low = 0.1 VCC

Note: The figures in the “Variable” column cover the whole VCC range (2.7 V to 3.6 V). Exceptions are shown by the VCC (min), “(3.0 V)” or “(2.7 V)”, added to the “Symbol” column.

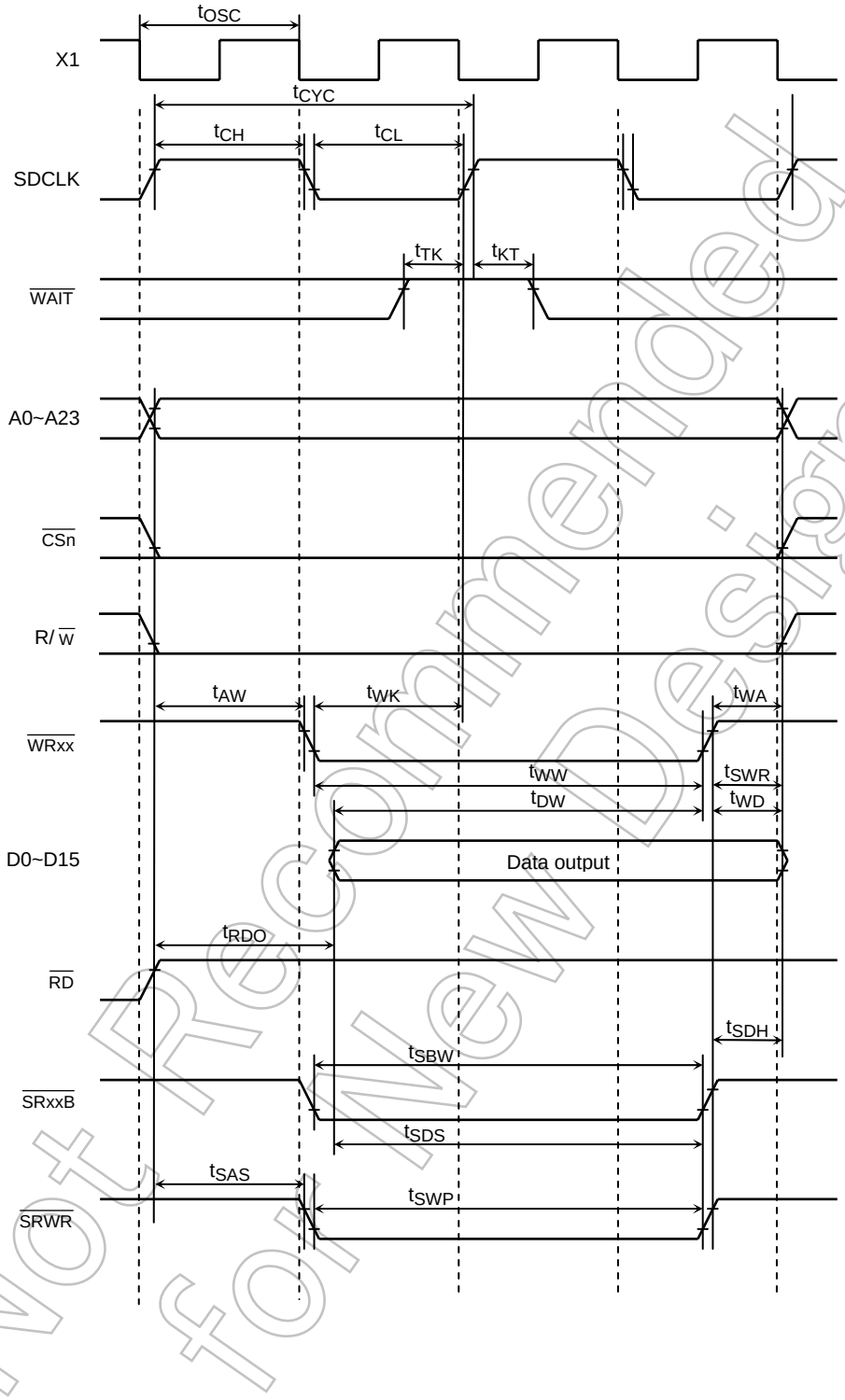
(1) Read cycle (0 waits)



Note1: The phase relation between X1 input signal and the other signals is undefined.
The above timing chart is an example.

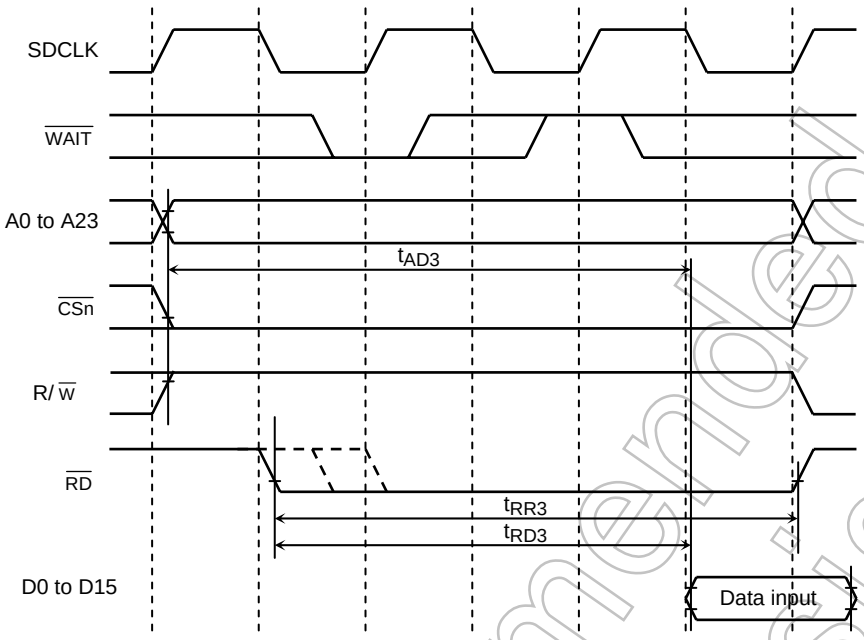
Note2: $\overline{RD}$ pin falling timing depends on MEMCR0<RDTMG1:0> setting in memory controller.

(2) Write cycle (0 waits)

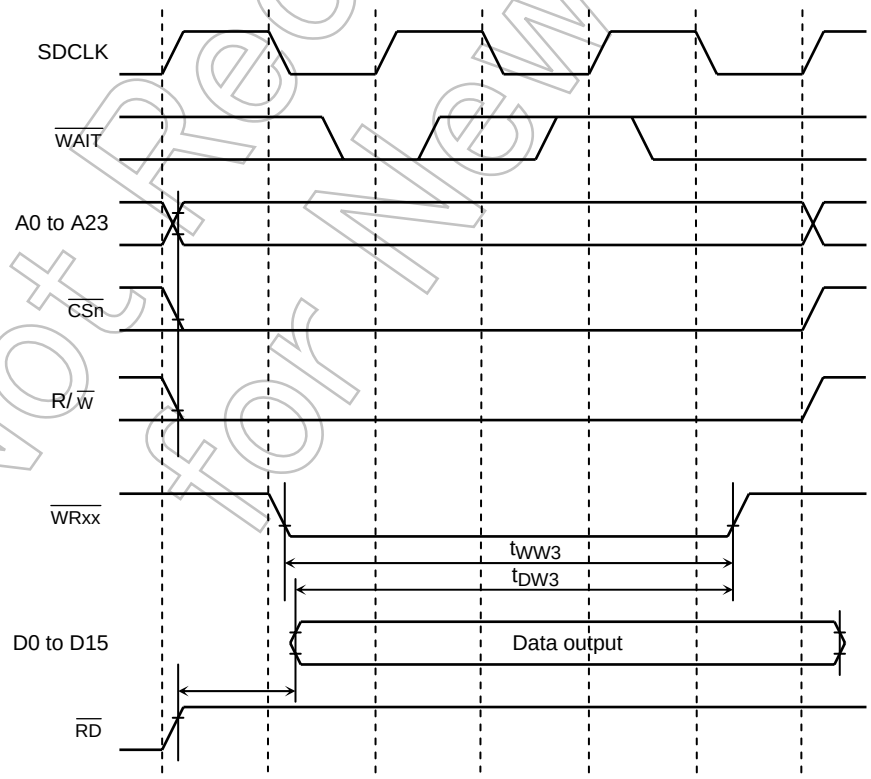


Note: The phase relation between X1 input signal and the other signals is undefined.
The above timing chart is an example.

(3) Read cycle (1 wait)



(4) Write cycle (1 wait)



4.3.2 Page ROM Read Cycle

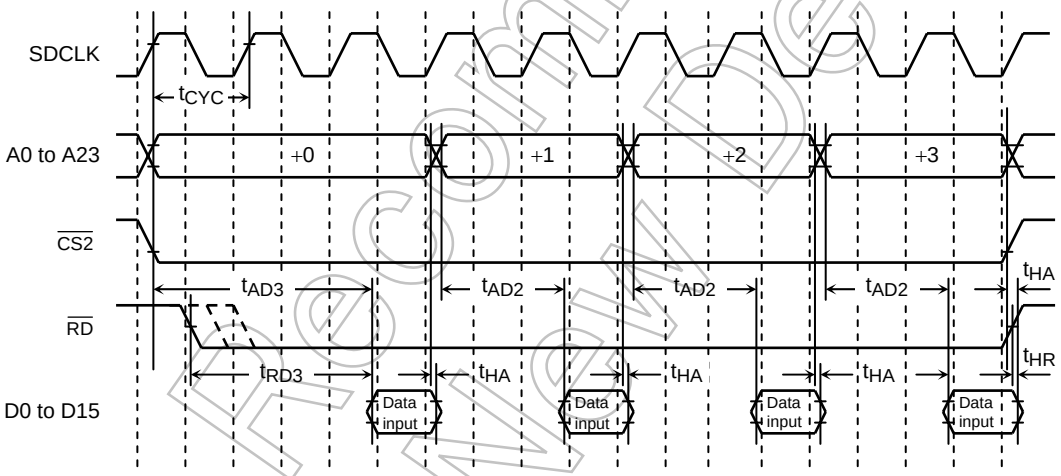
(1) 3-2-2-2 mode

No.	Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
			Min	Max				
1	System clock period (= T)	t_{CYC}	50	166.7	50	55.5	74	ns
2	A0, A1 → D0 to D15 input	t_{AD2}		2.0T – 50	50	61	98	
3	A2 to A23 → D0 to D15 input	t_{AD3}		3.0T – 50	100	116.5	172	
4	$\overline{RD}$ falling → D0 to D15 input	$t_{RD3(a)}$		2.5T – 45	80	93.8	140	
		$t_{RD3(b)}$		2.25T – 45	67.5	79.6	121.5	
		$t_{RD3(c)}$		2.0T – 45	55	66	103	
5	A0 to A23 Invalid → D0 to D15 hold	t_{HA}	0		0	0	0	
6	$\overline{RD}$ rising → D0 to D15 hold	t_{HR}	0		0	0	0	

AC measuring condition

- Output: High = 0.7 VCC, Low = 0.3 VCC, C_L = 50 pF
- Input: High = 0.9 VCC, Low = 0.1 VCC

Note: The figures in the (a), (b) and (c) of "Symbol" column shows difference of falling timing of $\overline{RD}$ pin. Falling timing of $\overline{RD}$ pin is set by MEMECR0<RDTMG1:0>. If MEMCR0<RDTMG1:0> is "00", it correspond with (a) in above table, and "01" is (b), "10" is (c).



Timing pulse (8-byte setting)

4.3.3 SDRAM Controller AC Characteristics

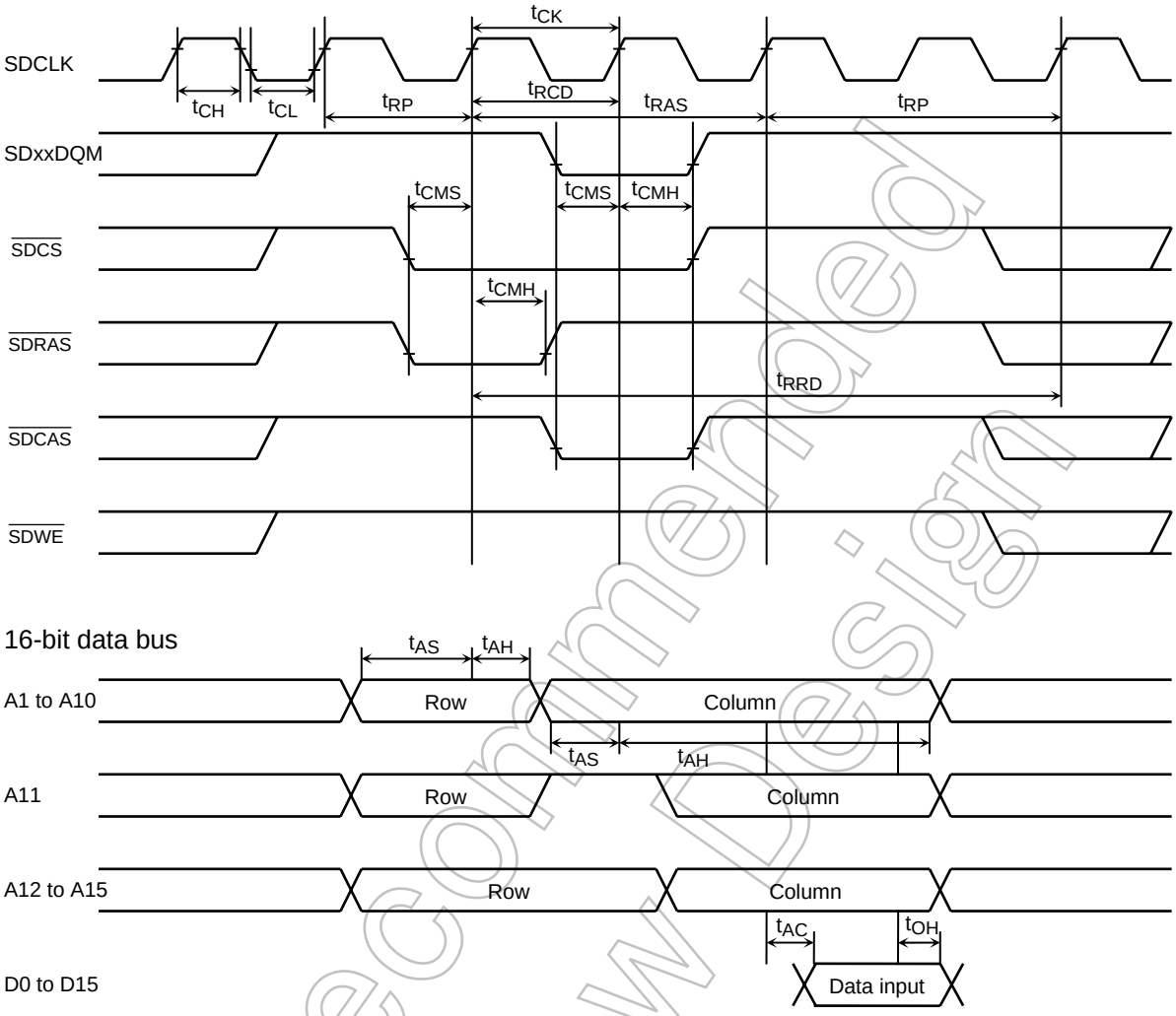
No.	Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
			Min	Max				
1	Ref/active to ref/active command period	t_{RC}	2T		100	111	148	ns
2	Active to precharge command period	t_{RAS}	2T	12210	100	111	148	
3	Active to read/write command delay time	t_{RCD}	T		50	55.5	74	
4	Precharge to active command period	t_{RP}	T		50	55.5	74	
5	Active to active command period	t_{RRD}	3T		150	166.5	222	
6	Write recovery time (CL* = 2)	t_{WR}	T		50	55.5	74	
7	Clock cycle time (CL* = 2)	t_{CK}	T		50	55.5	74	
8	Clock high level width	t_{CH}	0.5T – 15		10	12.7	22	
9	Clock low level width	t_{CL}	0.5T – 15		10	12.7	22	
10	Access time from clock (CL* =2)	t_{AC}		T – 30	20	25.5	44	
11	Output data hold time	t_{OH}	0		0	0	0	
12	Data in setup time	t_{DS}	0.5T – 10		15	17	27	
13	Data in hold time	t_{DH}	T – 15		35	40.5	59	
14	Address setup time	t_{AS}	0.75T – 30		7.5	11.6	25.5	
15	Address hold time	t_{AH}	0.25T – 9		3.5	4.8	9.5	
16	CKE setup time	t_{CKS}	0.5T – 15		10	12.7	22	
17	Command setup time	t_{CMS}	0.5T – 15		10	12.7	22	
18	Command hold time	t_{CMH}	0.5T – 15		10	12.7	22	
19	Mode register set cycle time	t_{RSC}	T		50	55.5	74	

CL*: CAS latency.

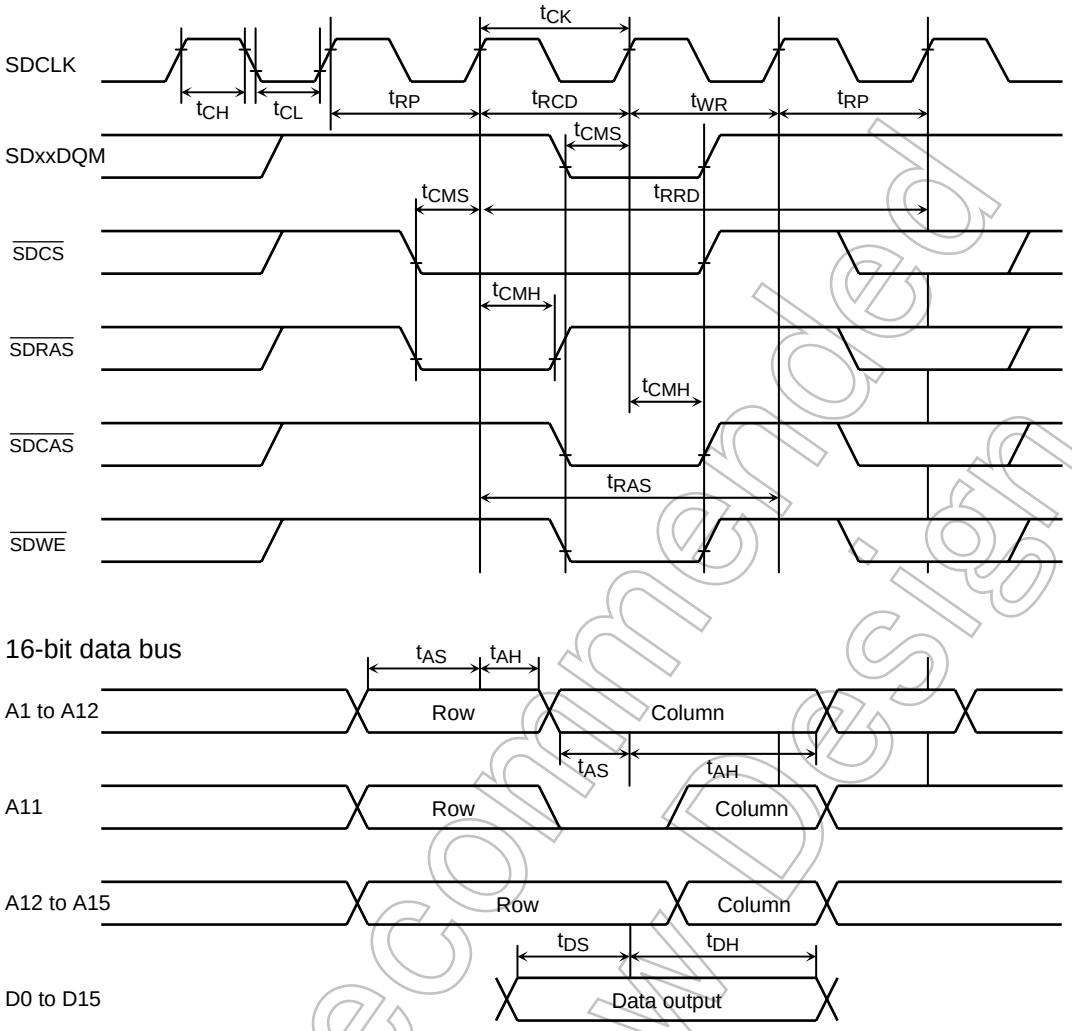
AC measuring conditions

- Output level: High = 0.7 VCC, Low = 0.3 VCC, C_L = 50 pF
- Input level: High = 0.9 VCC, Low = 0.1 VCC

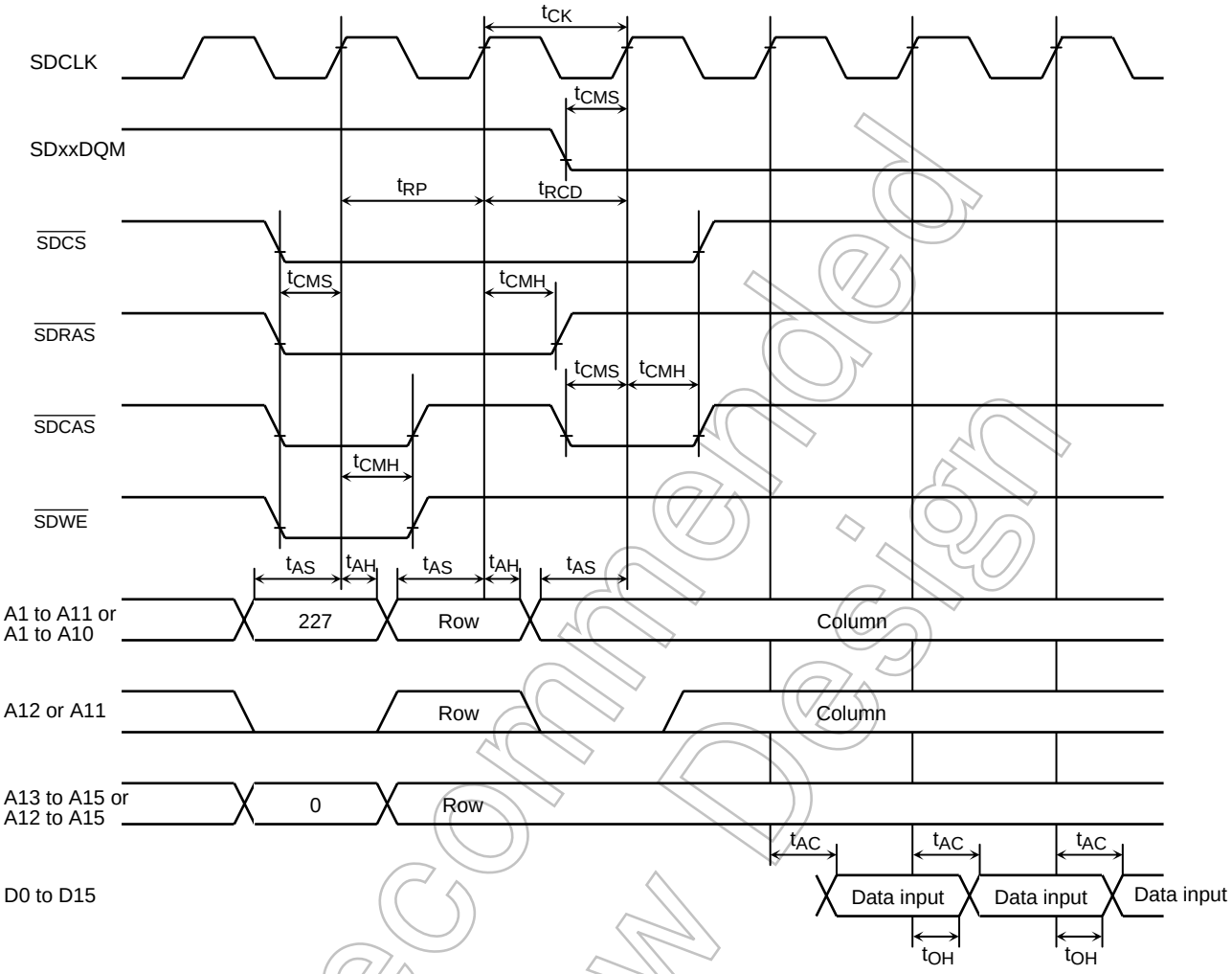
(1) SDRAM read timing (CPU access or LCDC normal access)



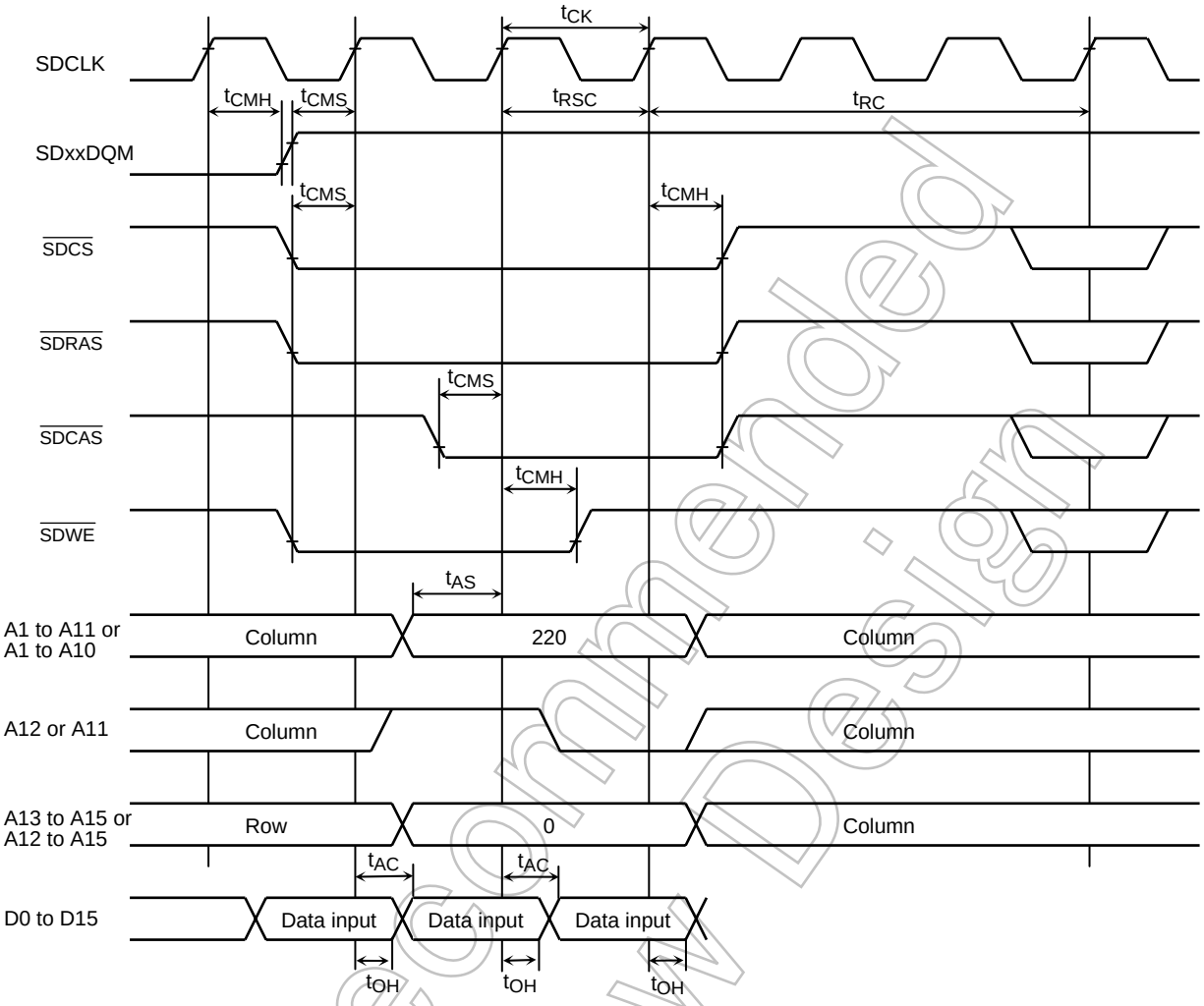
(2) SDRAM write timing (CPU access)



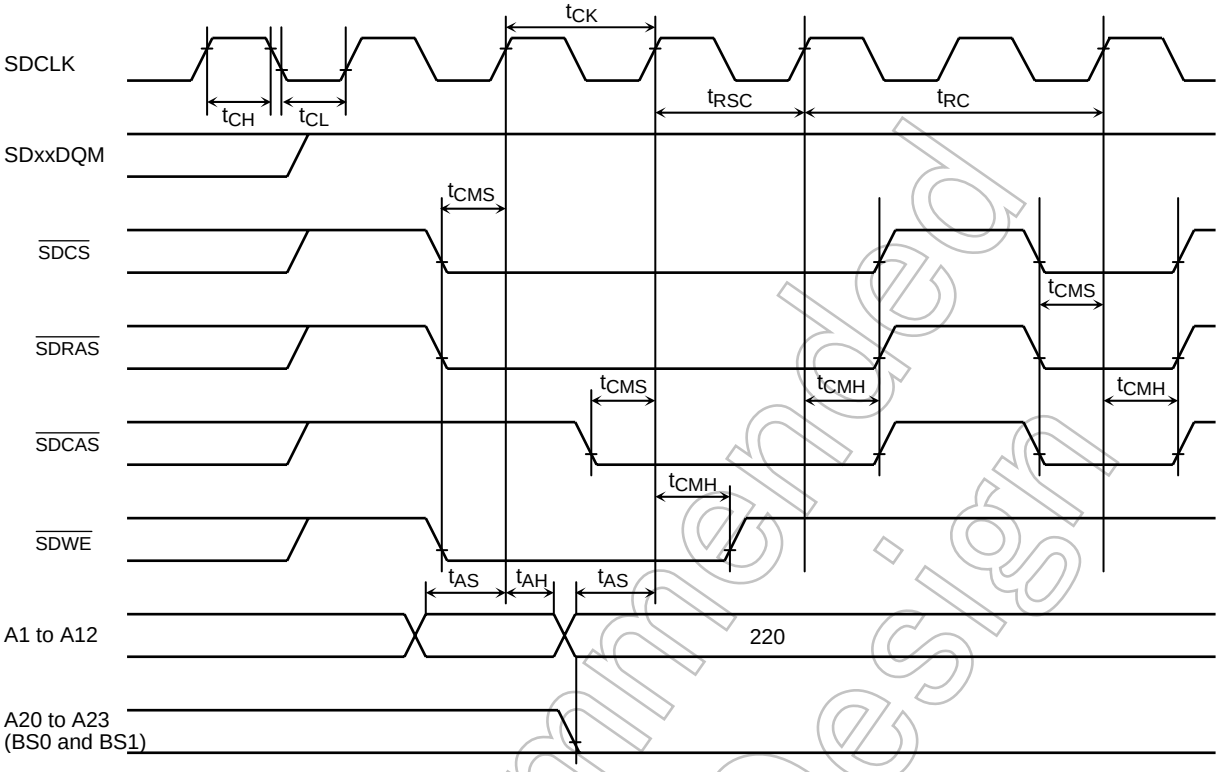
(3) SDRAM burst read timing (Start of burst cycle)



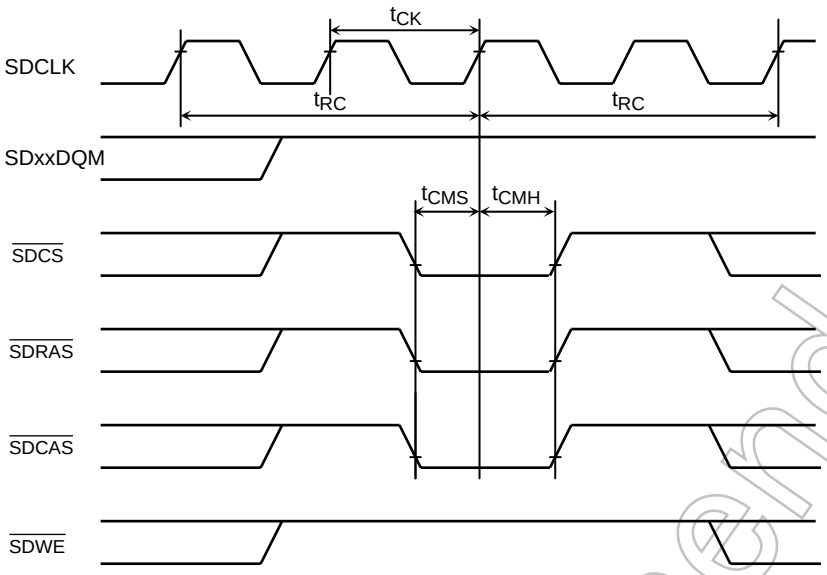
(4) SDRAM burst read timing (End of burst cycle)



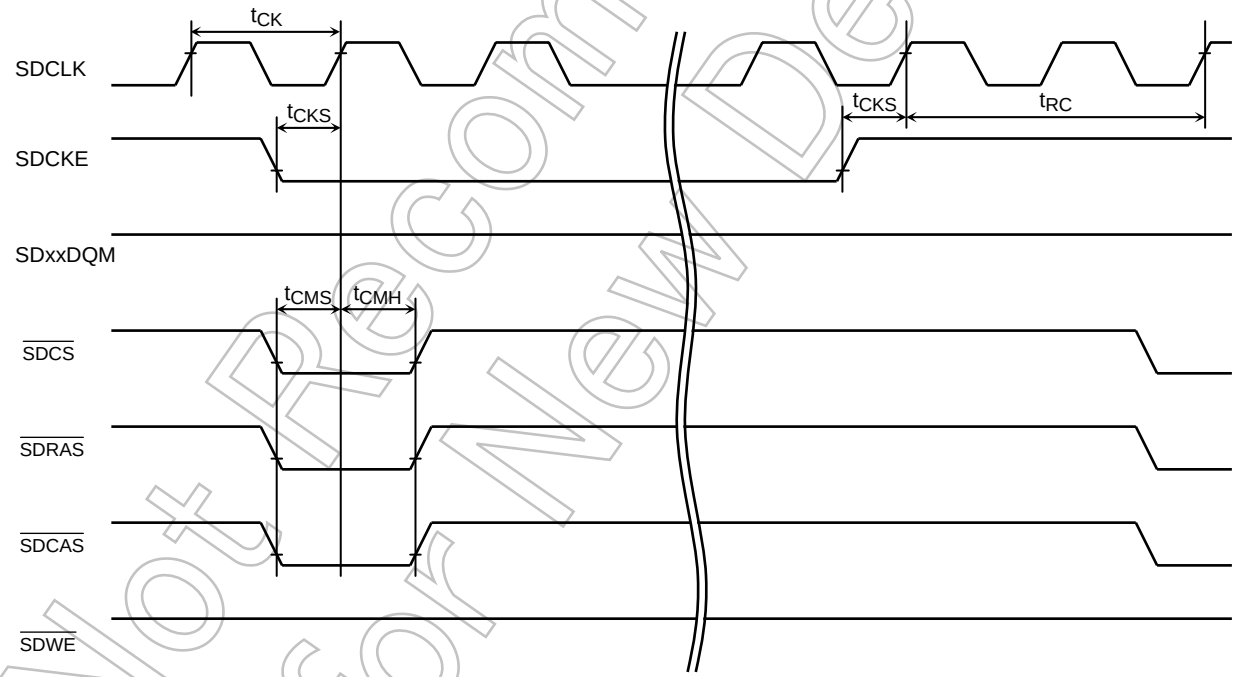
(5) SDRAM initialize timing



(6) SDRAM refresh timing



(7) SDRAM self refresh timing



4.3.4 NAND Flash Controller AC Characteristics

No.	Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
			Min	Max				
1	$\overline{\text{NDRE}}$ low width	t_{RP}	(1 + n) T – 12		38	43.5	62	ns
2	$\overline{\text{NDRE}}$ data access time	$t_{REA\ (3.0\ V)}$		(1 + n) T – 25	25	30.5	–	
		$t_{REA\ (2.7\ V)}$		(1 + n) T – 30	–	–	44	
3	Read data hold time	t_{OH}	0		0	0	0	
4	$\overline{\text{NDWE}}$ low width	t_{WP}	(0.75 + n) T – 20		17.5	21.6	35.5	
5	Write data setup time	t_{DS}	(3.25 + n) T – 30		132.5	150.3	210.5	
6	Write data hold time	t_{DH}	0.25 T – 2		10.5	11.8	16.5	

AC measuring conditions

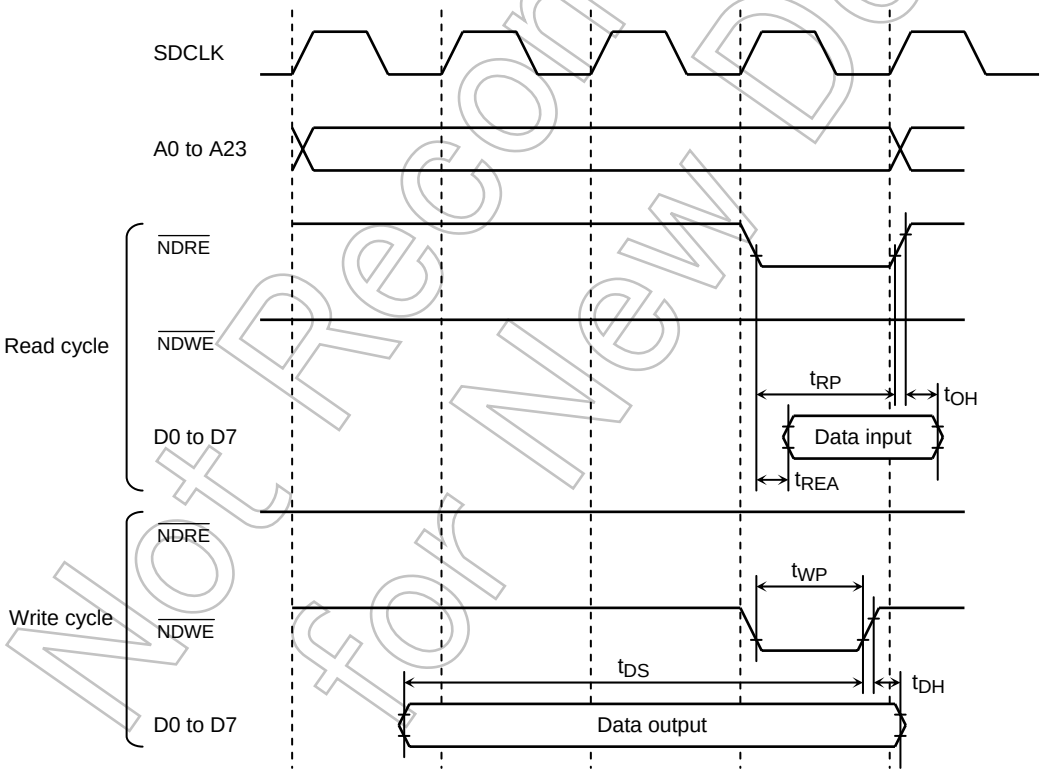
- Output level: High = 0.7 VCC, Low = 0.3 VCC, C_L = 50 pF
- Input level: High = 0.9 VCC, Low = 0.1 VCC

Note 1: The “n” shown in “Variable” refers to the wait number which is set to NDnFSPR<SPW3:0> register.

Example: When NDnFSPR<SPW3:0> = “0001”, t_{RP} = (1 + n) T – 12 = 2T – 12

Note 2: The figures in the “Variable” column cover the whole VCC range (2.7 V to 3.6 V). Exceptions are shown by the VCC (min), “(3.0 V)” or “(2.7 V)”, added to the “Symbol” column.

Example: (3.0V) : VCC range = 3.0V to 3.6V



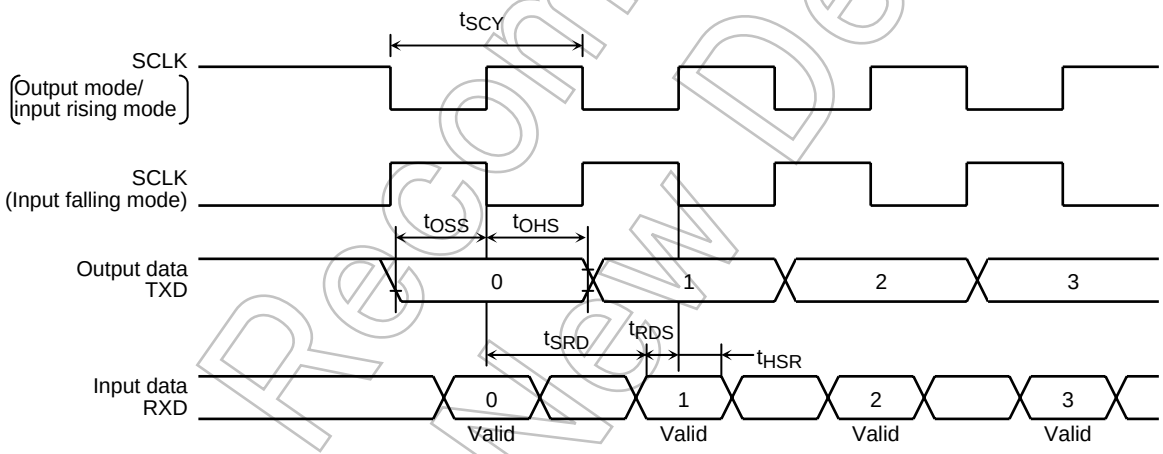
4.3.5 Serial Channel Timing

(1) SCLK input mode (I/O interface mode)

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
SCLK cycle	t_{SCY}	16T		0.8	0.888	1.184	μs
Output data → SCLK rising/falling	t_{OSS}	$t_{SCY}/2 - 4T - 110$		90	114	186	ns
SCLK rising/falling → Output data hold	t_{OHS}	$t_{SCY}/2 + 2T + 0$		500	554	740	
SCLK rising/falling → Input data hold	t_{HSR}	3 T + 10		160	175	232	
SCLK rising/falling → Input data valid	t_{SRD}		$t_{SCY} - 0$	800	888	1184	
Input data valid → SCLK rising/falling	t_{RDS}	0		0	0	0	

(2) SCLK output mode (I/O Interface mode)

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
SCLK cycle (Programmable)	t_{SCY}	16 T	8192T	0.8	0.888	1.184	μs
Output data → SCLK rising/falling	t_{OSS}	$t_{SCY}/2 - 40$		360	404	552	ns
SCLK rising/falling → Output data hold	t_{OHS}	$t_{SCY}/2 - 40$		360	404	552	
SCLK rising/falling → Input data hold	t_{HSR}	0		0	0	0	
SCLK rising/falling → Input data valid	t_{SRD}		$t_{SCY} - 1T - 180$	570	654	967	
Input data valid → SCLK rising/falling	t_{RDS}	1 T + 180		230	233	253	

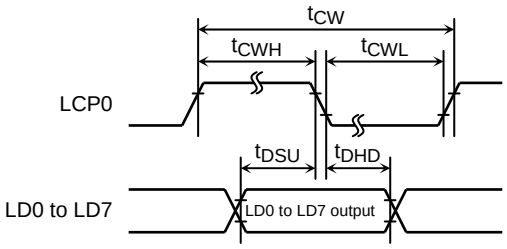


4.3.6 Interrupt Operation

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
INT0 to INT5 low width	t_{INTAL}	4 T + 40		240	262	336	ns
INT0 to INT5 high width	t_{INTAH}	4 T + 40		240	262	336	

4.3.7 LCD Controller (SR mode)

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
LCP0 clock period (= tm)	t_{CW}	2 T		100	111	148	ns
LCP0 high width	t_{CWH}	0.5 tm – 12		38	43.5	62	
LCP0 low width	t_{CWL}	0.5 tm – 12		38	43.5	62	
Data valid → LCP0 falling	t_{DSU}	0.5 tm – 20		30	35.5	54	
LCP0 falling → Data hold	t_{DHD}	0.5 tm – 5		45	50.5	69	

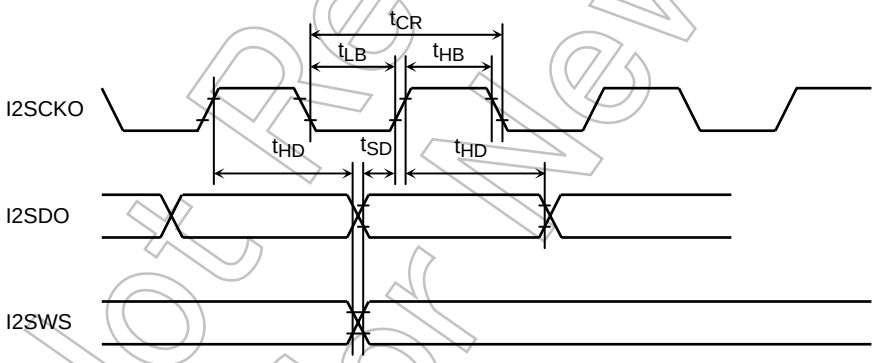


4.3.8 I^2S Timing (I^2S, SIO Mode)

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
I2SCKO clock period	t_{CR}	T		50	55	74	ns
I2SCKO high width	t_{HB}	0.5 t_{CR} – 15		10	12	22	
I2SCKO low width	t_{LB}	0.5 t_{CR} – 15		10	12	22	
I2SDO, I2SWS setup time	t_{SD}	0.5 t_{CR} – 15		10	12	22	
I2SDO, I2SWS hold time	t_{HD}	0.5 t_{CR} – 5		20	22	32	

AC measuring conditions

- Output level: High = 0.7 VCC, Low = 0.3 VCC, C_L = 10 pF

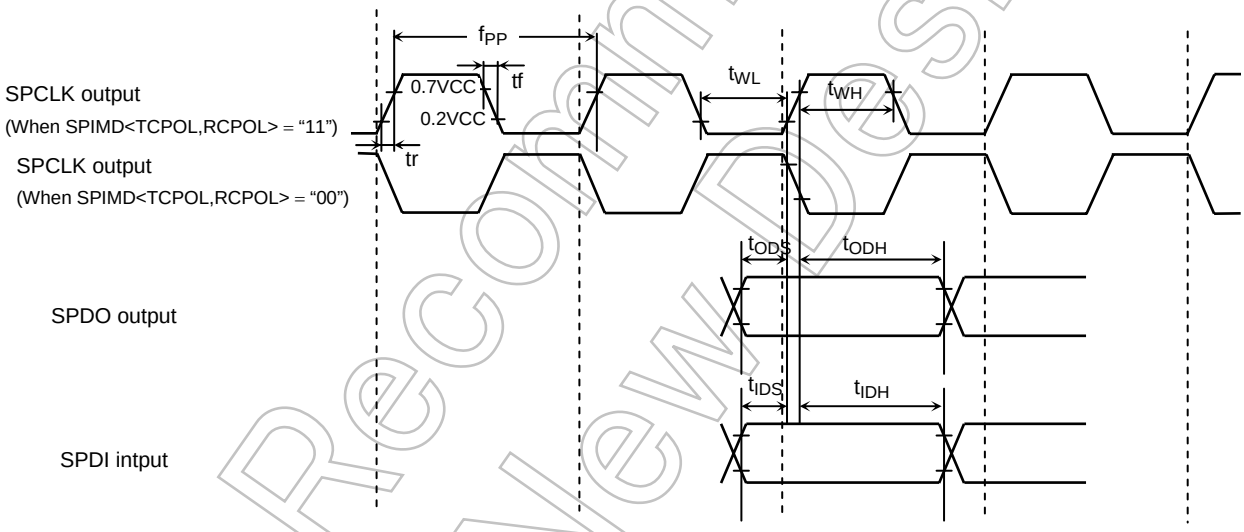


4.3.9 SPI control Timing

Parameter	Symbol	Variable		40 MHz	36 MHz	27 MHz	Unit
		Min	Max				
SPCLK frequency (=1/S)	t_{CR}		20	20	18	13.5	MHz
SPCLK rising time	t_{HB}		6	6	6	6	ns
SPCLK falling time	t_{LB}		6	6	6	6	
SPCLK Low pulse width	t_{SD}	0.5S −6		19	21	31	
SPCLK High pulse width	t_{HD}	0.5S −13		12	14	24	
Output data valid → SPCLK rise		0.5S −18		7	9	19	
Output data valid → SPCLK fall		0.5S −21		4	6	16	
SPCLK rise → Output data hold		0.5S −10		15	17	27	
Input data valid → SPCLK rise		0S + 5		5	5	5	
SPCLK rise → Input data hold		0S + 5		5	5	5	

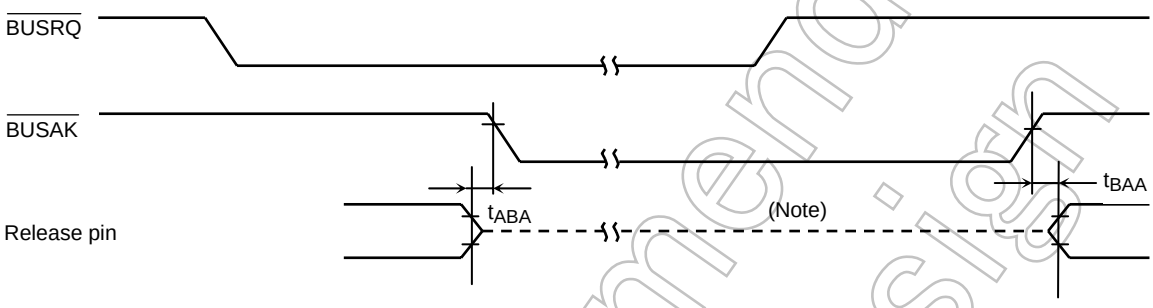
AC measuring conditions

- Output level: High = 0.7 VCC, Low = 0.3 VCC, C_L = 25 pF
- Input level: High = 0.9 VCC, Low = 0.1 VCC



4.3.10 External bus release function

Parameter	Symbol	Variable		40 MHz		36 MHz		27 MHz		Unit
		Min	Max							
Floating time until $\overline{BUSRQ}$ falling	t_{ABA}	0	30	0	30	0	30	0	30	MHz
Floating time until $\overline{BUSAK}$ rising	t_{BAA}	0	30	0	30	0	30	0	30	ns



Note: This line show only that output buffer is OFF. This line does not show that signal level is middle.

4.4 AD Conversion Characteristics

Parameter	Symbol	Min	Typ.	Max	Unit
Analog reference voltage (+)	V_{REFH}	V_{CC} − 0.2	V_{CC}	V_{CC}	V
Analog reference voltage (−)	V_{REFL}	V_{SS}	V_{SS}	V_{SS} + 0.2	
AD converter power supply voltage	AV_{CC}	V_{CC}	V_{CC}	V_{CC}	
AD converter ground	AV_{SS}	V_{SS}	V_{SS}	V_{SS}	
Analog input voltage	AV_{IN}	V_{REFL}		V_{REFH}	
Analog current for analog reference voltage <VREFON> = 1	I_{REF}		0.8	1.35	mA
Analog current for analog reference voltage <VREFON> = 0			0.02	5.0	μA
Total error (Quantize error of ± 0.5 LSB is included.)	E_T		±1.0	±4.0	LSB

Note 1: 1LSB = (VREFH – VREFL) / 1024 [V]

Note 2: Minimum frequency for operation

AD converter operation is guaranteed only when using fc (high-frequency oscillator). fs is not guaranteed. However, operation is guaranteed if the clock frequency selected by the clock gear is over 4MHz.

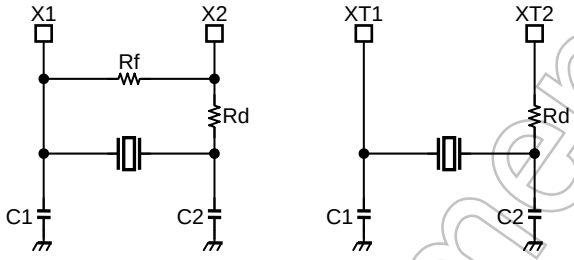
Note 3: The value for Icc includes the current which flows through the AV_{CC} pin.

4.5 Recommended Oscillation Circuit

The TMP92CA25 has been evaluated by the oscillator vender below. Use this information when selecting external parts.

Note: The total load value of the oscillator is the sum of external loads (C1 and C2) and the floating load of the actual assembled board. There is a possibility of operating error when using C1 and C2 values in the table below. When designing the board, design the minimum length pattern around the oscillator. We also recommend that oscillator evaluation be carried out using the actual board.

(1) Connection example



High-frequency oscillator Low-frequency oscillator

(2) Recommended ceramic oscillator: Murata Manufacturing Co., Ltd.

MCU	Oscillation Frequency [MHZ]	Oscillator Product Number	Parameter of elements				Running Condition	
			C1 [pF]	C2 [pF]	Rf [Ω]	Rd [Ω]	Voltage of Power [V]	Ta [°C]
TMP92CA25FG	6.00	CSTCR6M00G55-R0	(39)	(39)	Open	0	2.7 ~ 3.6	-20 ~ +80
	10.00	CSTCE10M0G55-R0	(33)	(33)				
	20.00	CSTCE20M0V53-R0	(15)	(15)				

Note 1: The figure in parentheses ( ) under C1 and C2 is the built-in condenser type.

Note 2: The product numbers and specifications of the oscillators made by Murata Manufacturing Co., Ltd. are subject to change. For up-to-date information, please refer to the following URL:

http://www.murata.co.jp

5. Table of Special function registers (SFRs)

The SFRs include the I/O ports and peripheral control registers allocated to the 4-Kbyte address space from 000000H to 001FFFH.

(1) I/O Port
(2) Interrupt control
(3) Memory controller
(4) MMU
(5) Clock gear, PLL
(6) LCD controller
(7) Touch screen I/F
(8) SDRAM controller
(9) 8-bit timer
(10) 16-bit timer
(11) UART/serial channel
(12) SBI
(13) SPI controller
(14) AD converter
(15) Watchdog timer
(16) RTC (Real time clock)
(17) Melody/alarm generator
(18) NAND flash controller
(19) I²S

Table layout

Symbol	Name	Address	7	6			1	0	
									→ Bit symbol
									→ Read/Write
									→ Initial value after reset
									→ Remarks

Note: “Prohibit RMW” in the table means that you cannot use RMW instructions on these register.

Example: When setting bit0 only of the register PxCR, the instruction “SET 0, (PxCR)” cannot be used. The LD (transfer) instruction must be used to write all eight bits.

Read/Write

R/W:	Both read and write are possible.
R:	Only read is possible.
W:	Only write is possible.
W*:	Both read and write are possible (when this bit is read as “1”.)
Prohibit RMW:	Read-modify-write instructions are prohibited. (The EX, ADD, ADC, BUS, SBC, INC, DEC, AND, OR, XOR, STCF, RES, SET, CHG, TSET, RLC, RRC, RL, RR, SLA, SRA, SLL, SRL, RLD and RRD instruction are read-modify-write instructions.)
R/W*:	Read-modify-write is prohibited when controlling the pull-up resistor.

Table 5.1 I/O Register Address Map

[1] Port

Address	Name
0000H	
1H	
2H	
3H	
4H	P1
5H	
6H	P1CR
7H	P1FC
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
0010H	
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	P6
9H	
AH	P6CR
BH	P6FC
CH	P7
DH	
EH	P7CR
FH	P7FC

Address	Name
0020H	P8
1H	P8FC2
2H	
3H	P8FC
4H	P9
5H	P9FC2
6H	P9CR
7H	P9FC
8H	PA
9H	
AH	
BH	PAFC
CH	
DH	
EH	
FH	

Address	Name
0030H	PC
1H	
2H	PCCR
3H	PCFC
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	PF
DH	PFFC2
EH	PFCR
FH	PFFC

Address	Name
0040H	PG
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	PJ
DH	
EH	PJCR
FH	PJFC

Address	Name
0050H	PK
1H	
2H	PKCR
3H	PKFC
4H	PL
5H	
6H	PLCR
7H	PLFC
8H	PM
9H	
AH	
BH	PMFC
CH	PN
DH	
EH	PNCR
FH	PNFC

Address	Name
0080H	
1H	P1DR
2H	
3H	
4H	P4DR
5H	P5DR
6H	P6DR
7H	P7DR
8H	P8DR
9H	P9DR
AH	PADR
BH	
CH	PCDR
DH	
EH	
FH	PFDR

Address	Name
0090H	PGDR
1H	
2H	
3H	PJDR
4H	PKDR
5H	PLDR
6H	PMDR
7H	PNDR
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Note: Do not access un-named addresses.

[2] INTC

Address	Name
00D0H	INTE12
1H	INTE34
2H	
3H	
4H	INTETA01
5H	INTETA23
6H	
7H	
8H	INTETB01
9H	
AH	INTETBO0
BH	INTES0
CH	
DH	
EH	
FH	

Address	Name
00E0H	INTESPI
1H	INTESBI
2H	Reserved
3H	Reserved
4H	Reserved
5H	INTALM01
6H	INTALM23
7H	INTALM4
8H	INTERTC
9H	INTEKEY
AH	INTELCD
BH	INTE5I2S
CH	INTEND01
DH	Reserved
EH	INTEP0
FH	Reserved

Address	Name
00F0H	INTE0AD
1H	INTETC01
2H	INTETC23
3H	INTETC45
4H	INTETC67
5H	SIMC
6H	IIMC
7H	INTWDT
8H	INTCLR
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
0100H	DMA0V
1H	DMA1V
2H	DMA2V
3H	DMA3V
4H	DMA4V
5H	DMA5V
6H	DMA6V
7H	DMA7V
8H	DMAB
9H	DMAR
AH	Reserved
BH	
CH	
DH	
EH	
FH	

[3] MEMC

Address	Name
0140H	B0CSL
1H	B0CSH
2H	MAMR0
3H	MSAR0
4H	B1CSL
5H	B1CSH
6H	MAMR1
7H	MSAR1
8H	B2CSL
9H	B2CSH
AH	MAMR2
BH	MSAR2
CH	B3CSL
DH	B3CSH
EH	MAMR3
FH	MSAR3

Address	Name
0150H	
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	BEXCSL
9H	BEXCSH
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
0160H	
1H	
2H	
3H	
4H	
5H	
6H	PMEMCR
7H	
8H	MEMCR0
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[4] MMU

Address	Name
01D0H	LOCALPX
1H	LOCALPY
2H	
3H	LOCALPZ
4H	LOCALLX
5H	LOCALLY
6H	
7H	LOCALLZ
8H	LOCALRX
9H	LOCALRY
AH	
BH	LOCALRZ
CH	LOCALWX
DH	LOCALWY
EH	
FH	LOCALWZ

Note: Do not access un-named addresses.

[5] CGEAR, PLL

Address	Name
10E0H	SYSCR0
1H	SYSCR1
2H	SYSCR2
3H	EMCCR0
4H	EMCCR1
5H	EMCCR2
6H	Reserved
7H	
8H	PLLCR0
9H	PLLCR1
AH	
BH	
CH	
DH	
EH	
FH	

[6] LCDC

Address	Name
0840H	LCDMODE0
1H	LCDFFP
2H	LCDDVM
3H	LCDSIZE
4H	LCDCTL0
5H	
6H	LCDSCC
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
0850H	LSARAL
1H	LSARAM
2H	LSARAH
3H	CMNAL
4H	CMNAH
5H	
6H	LSARBL
7H	LSARBM
8H	LSARBH
9H	CMNBL
AH	CMNBH
BH	
CH	LSARCL
DH	LSARCM
EH	LSARCH
FH	

Note: Do not access un-named addresses.

[7] TSI

Address	Name
01F0H	TSICR0
1H	TSICR1
2H	
3H	
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[8] SDRAMC

Address	Name
0250H	SDACR1
1H	SDACR2
2H	SDRCR
3H	SDCMM
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[9] 8-bit timer

Address	Name
1100H	TA01RUN
1H	
2H	TA0REG
3H	TA1REG
4H	TA01MOD
5H	TA01FFCR
6H	
7H	
8H	TA23RUN
9H	
AH	TA2REG
BH	TA3REG
CH	TA23MOD
DH	TA3FFCR
EH	
FH	

[10] 16-bit timer

Address	Name
1180H	TB0RUN
1H	
2H	TB0MOD
3H	TB0FFCR
4H	
5H	
6H	
7H	
8H	TB0RG0L
9H	TB0RG0H
AH	TB0RG1L
BH	TB0RG1H
CH	TB0CP0L
DH	TB0CP0H
EH	TB0CP1L
FH	TB0CP1H

[11] SIO

Address	Name
1200H	SC0BUF
1H	SC0CR
2H	SC0MOD0
3H	BR0CR
4H	BR0ADD
5H	SC0MOD1
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[12] SBI

Address	Name
1240H	SBI0CR1
1H	SBI0DBR
2H	I2C0AR
3H	SBI0CR2/SBI0SR
4H	SBI0BR0
5H	SBI0BR1
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Note: Do not access un-named addresses.

[13] SPI controller

Address	Name
0820H	SPIMD
1H	SPIMD
2H	SPICT
3H	SPICT
4H	SPIST
5H	SPIST
6H	SPICR
7H	SPICR
8H	SPIIS
9H	SPIIS
AH	SPIWE
BH	SPIWE
CH	SPIIE
DH	SPIIE
EH	SPIIR
FH	SPIIR

Address	Name
0830H	SPITD
1H	SPITD
2H	SPIRD
3H	SPIRD
4H	SPITS
5H	SPITS
6H	SPIRS
7H	SPIRS
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Note: Do not access un-named addresses.

[14] 10-bit ADC

Address	Name
12A0H	ADREG0L
1H	ADREG0H
2H	ADREG1L
3H	ADREG1H
4H	ADREG2L
5H	ADREG2H
6H	ADREG3L
7H	ADREG3H
8H	Reserved
9H	Reserved
AH	Reserved
BH	Reserved
CH	Reserved
DH	Reserved
EH	Reserved
FH	Reserved

Address	Name
12B0H	
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	ADMOD0
9H	ADMOD1
AH	ADMOD2
BH	Reserved
CH	
DH	
EH	
FH	

[15] WDT

Address	Name
1300H	WDMOD
1H	WDCR
2H	
3H	
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[16] RTC

Address	Name
1320H	SECR
1H	MINR
2H	HOURR
3H	DAYR
4H	DATER
5H	MONTHR
6H	YEARR
7H	PAGER
8H	RESTR
9H	
AH	
BH	
CH	
DH	
EH	
FH	

[17] MLD

Address	Name
1330H	ALM
1H	MELALMC
2H	MELFL
3H	MELFH
4H	ALMINT
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Note: Do not access un-named addresses.

[18] NAND flash controller

Address	Name
1CC0H	
1H	
2H	
3H	
4H	ND0FMCR
5H	
6H	
7H	
8H	ND0FSR
9H	
AH	
BH	
CH	ND0FISR
DH	
EH	
FH	

Address	Name
1CD0H	ND0FIMR
1H	
2H	
3H	
4H	ND0FSPR
5H	
6H	
7H	
8H	ND0FRSTR
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
1CE0H	
1H	
2H	
3H	
4H	ND1FMCR
5H	
6H	
7H	
8H	ND1FSR
9H	
AH	
BH	
CH	ND1FISR
DH	
EH	
FH	

Address	Name
1CF0H	ND1FIMR
1H	
2H	
3H	
4H	ND1FSPR
5H	
6H	
7H	
8H	ND1FRSTR
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Address	Name
1D00H	ND0FDTR,
to	ND1FDTR
1EFFH	

Address	Name
1CB0H	ND0ECCRD
to	ND1ECCRD
1CB5H	

Address	Name
01C0H	NDCR
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	
9H	
AH	
BH	
CH	
DH	
EH	
FH	

Note: Do not access un-named addresses.

[19] I²S

Address	Name
0800H	I2SBUFR
1H	
2H	
3H	
4H	
5H	
6H	
7H	
8H	I2SBUFL
9H	
AH	
BH	
CH	
DH	
EH	I2SCTL0
FH	I2SCTL0

Note: Do not access un-named addresses.

(1) I/O ports (1/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
P1	Port 1	0004H	P17	P16	P15	P14	P13	P12	P11	P10
			R/W							
			Data from external port (Output latch register is cleared to “0”)							
P6	Port 6	0018H	P67	P66	P65	P64	P63	P62	P61	P60
			R/W							
			Data from external port (Output latch register is cleared to “0”)							
P7	Port 7	001CH		P76	P75	P74	P73	P72	P71	P70
				R/W						
				Data from external port (Output latch register is set to “1”)		Data from external port (Output latch register is cleared to “0”)		Data from external port (Output latch register is set to “1”)		1
P8	Port 8	0020H	P87	P86	P85	P84	P83	P82	P81	P80
			R/W							
			1	1	1	1	1	0	1	1
P9	Port 9	0024H	P97	P96	P95	P94	P93	P92	P91	P90
			R		R/W					
			Data from external port		0	Data from external port (Output latch register is set to “1”)				
PA	Port A	0028H	PA7	PA6	PA5	PA4	PA3	PA2	PA1	PA0
			R							
			Data from external port							
PC	Port C	0030H	PC7	PC6	PC5	PC4	PC3	PC2	PC1	PC0
			R/W							
			Data from external port (Output latch register is set to “1”)							
PF	Port F	003CH	PF7	PF6	PF5	PF4	PF3	PF2	PF1	PF0
			R/W							
			1	Data from external port (Output latch register is set to “1”)						
PG	Port G	0040H					PG3	PG2	PG1	PG0
							R			
							Data from external port			
PJ	Port J	004CH	PJ7	PJ6	PJ5	PJ4	PJ3	PJ2	PJ1	PJ0
			R/W							
			1	Data from external port (Output latch register is set to “1”)		1	1	1	1	1
PK	Port K	0050H	PK7	PK6	PK5	PK4	PK3	PK2	PK1	PK0
			R/W							
			Data from external port (Output latch register is cleared to “0”)				0	0	0	0
PL	Port L	0054H	PL7	PL6	PL5	PL4	PL3	PL2	PL1	PL0
			R/W							
			Data from external port (Output latch register is cleared to “0”)				0	0	0	0
PM	Port M	0058H						PM2	PM1	
								R/W		
								1	1	
PN	Port N	005CH	PN7	PN6	PN5	PN4	PN3	PN2	PN1	PN0
			R/W							
			Data from external port (Output latch register is set to “1”)							

(1) I/O ports (2/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
P1CR	Port 1 control register	0006H (Prohibit RMW)	P17C	P16C	P15C	P14C	P13C	P12C	P11C	P10C
			W							
			0	0	0	0	0	0	0	0
			0: Input 1: Output							
P1FC	Port 1 function register	0007H (Prohibit RMW)								P1F
										W
										0/1
										0:Port 1:Data bus (D8 to D15)
P6CR	Port 6 control register	001AH (Prohibit RMW)	P67C	P66C	P65C	P64C	P63C	P62C	P61C	P60C
			W							
			0	0	0	0	0	0	0	0
			0: Input 1: Output							
P6FC	Port 6 function register	001BH (Prohibit RMW)	P67F	P66F	P65F	P64F	P63F	P62F	P61F	P60F
			W							
			1	1	1	1	1	1	1	1
			0: Port 1: Address bus (A16 to A23)							
P7CR	Port 7 control register	001EH (Prohibit RMW)		P76C	P75C	P75C	P74C	P72C	P71C	
				W						
				0	0	0	0	0	0	
				0: Input 1: Output						
P7FC	Port 7 function register	001FH (Prohibit RMW)		P76F	P75F	P74F	P73F	P72F	P71F	P70F
				W						
				0	0	0	0	0	0	1
				0: Port 1: $\overline{WAIT}$	0: Port 1: NDR/$\overline{B}$ at <P75>=1, R/$\overline{W}$	0: Port 1: EA25	0: Port 1: EA24	0: Port 1: $\overline{NDWE}$ at<P72>=0, $\overline{WRLU}$ at<P72>=1	0: Port 1: $\overline{NDRE}$ at<P71>=0, $\overline{WRLL}$ at<P71>=1	0: Port 1: $\overline{RD}$
P8FC	Port 8 function register	0023H (Prohibit RMW)	P87F	P86F	P85F	P84F	P83F	P82F	P81F	P80F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: $\overline{CSZE}$	0: Port 1: $\overline{CSZD}$	0: Port 1: $\overline{CSZC}$, $\overline{ND1CE}$	0: Port 1: $\overline{CSZB}$, $\overline{ND0CE}$	0: Port 1: $\overline{CS3}$	0: Port, $\overline{CSZA}$ 1: $\overline{CS2}$	0: Port 1: $\overline{CS1}$	0: Port 1: $\overline{CS0}$
P8FC2	Port 8 function register2	0021H (Prohibit RMW)	P87F2	P86F2	P85F2	P84F2	–	P82F2	P81F2	–
			W							
			0	0	0	0	0	0	0	0
			0: <P87F> 1:Reserved	0: <P86F> 1: Reserved	0: Port, $\overline{CSZC}$ 1: $\overline{ND1CE}$	0: Port, $\overline{CSZB}$ 1: $\overline{ND0CE}$	Always write “0”	0: Port $\overline{CS2}$ 1: $\overline{CSZA}$	0: <P81F> 1: $\overline{SDCS}$	Always write “0”

(1) I/O ports (3/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
P9CR	Port 9 control register	0026H (Prohibit RMW)			P95C	P94C	P93C	P92C	P91C	P90C
					W					
					0	0	0	0	0	0
					0: Port 1: CLK32KO	0: Port 1: Port, SCL	0:Port 1: Port, SDA	0:Port, SCLK0, CTS0 I2SWS 1:Port, SCLK0	0: Port, RXD0 I2SDO 1: Port	0:Port, I2SCKO 1: Port, TXD0
P9FC	Port 9 function register	0027H (Prohibit RMW)	P97F	P96F	P95F	P94F	P93F	P92F	P91F	P90F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: INT5	0: Port 1: INT4	0:Port, CLK32KO 1: Reserved	0: Port 1: SCL	0: Port 1: SDA	0: Port, SCLK0, CTS0 1: I2SWS, SCLK0	0: Port, RXD0 1: I2SDO	0: Port 1: I2SCKO, TXD0
P9FC2	Port 9 function register2	0025H (Prohibit RMW)				P94F2	P93F2			P90FC2
						W				W
						0	0			0
						0: CMOS 1: Open drain	0: CMOS 1: Open drain			0: CMOS 1: Open drain
PAFC	Port A function register	002BH (Prohibit RMW)	PA7F	PA6F	PA5F	PA4F	PA3F	PA2F	PA1F	PA0F
			W							
			0	0	0	0	0	0	0	0
			0: Key-in disable 1: Key-in enable							
PCCR	Port C control register	0032H (Prohibit RMW)	PC7C	PC6C	PC5C	PC4C	PC3C	PC2C	PC1C	PC0C
			W							
			0	0	0	0	0	0	0	0
			0: Input 1: Output							
PCFC	Port C function register	0033H (Prohibit RMW)	PC7F	PC6F	PC5F	PC4F	PC3F	PC2F	PC1F	PC0F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: CSZF , EA25 at <PC7> = 0	0: Port 1:KO8 (Open -Drain) EA24 at <PC6> = 0	0: Port 1:Reserved	0: Port 1:Reserved	0: Port 1: INT3	0: Port 1: INT2, TB0OUT0	0: Port 1: INT1, TA3OUT	0: Port 1: INT0, TA1OUT

(1) I/O ports (4/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
PFCR	Port F control register	003EH (Prohibit RMW)		PF6C	PF5C	PF4C	PF3C	PF2C	PF1C	PF0C
				W						
				0	0	0	0	0	0	0
				0: Port 1: Port	0: Port 1: Port	0: Port 1: Port	0: Port 1: Port	0: Port, SCLK0, $\overline{CTS0}$, (From PF2 at <PF2> = 0) (from P92 at <PF2> = 1) 1: Port, SCLK0	0: Port, RXD0 1: Port	0: Port 1: Port, TXD0
PFFC	Port F function register	003FH (Prohibit RMW)	PF7F	PF6F	PF5F	PF4F	PF3F	PF2F	PF1F	PF0F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: SDCLK	0: Port 1: Reserved	0: Port 1:Reserved	0: Port 1:Reserved	0: Port 1:Reserved	0: Port, SCLK0, $\overline{CTS0}$ (from PF2 at <PF2>=0) (from P92 at <PF2> =1) 1:SCLK0	0: Port RXD0 (from PF1 pin) 1: RXD0 (from P91 pin)	0: Port 1: TXD0
PFFC2	Port F function register2	003DH (Prohibit RMW)	–					–		PF0F2
			W					W		W
			0					0		0
			Always write “0”					Always write “0”		Output buffer 0: CMOS 1: Open-drain
PJCR	Port J control register	004EH (Prohibit RMW)		PJ6C	PJ5C					
				W						
				0	0					
				0:Input 1: Output						
PJFC	Port J function register	004FH (Prohibit RMW)	PJ7F	PJ6F	PJ5F	PJ4F	PJ3F	PJ2F	PJ1F	PJ0F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: SDCKE at <PJ7>=1	0: Port 1: NDCLE at <PJ6>=0	0: Port 1: NDALE at <PJ5>=0	0: Port 1: SDLUDQM at <PJ4>=1	0: Port 1: SDLLDQM at <PJ3>=1	0: Port 1: $\overline{SDWE}$, $\overline{SDWR}$	0: Port 1: $\overline{SDCAS}$, $\overline{SRLUB}$	0: Port 1: $\overline{SDRAS}$, $\overline{SRLLB}$
PKCR	Port K Control Register	0052H (Prohibit RMW)	PK7C	PK7C	PK7C	PK7C				
			W							
			0	0	0	0				
			0:Input 1: Output							
PKFC	Port K function register	0053H (Prohibit RMW)	PK7F	PK6F	PK5F	PK4F	PK3F	PK2F	PK1F	PK0F
							W			
			0	0	0	0	0	0	0	0
			0: Port 1: SPCLK	0: Port 1: SPCS	0: Port 1: SPDO	0: Port 1: SPDI	0: Port 1: LBCD	0: Port 1: LFR	0: Port 1: LLP	0: Port 1: LCP0

(1) I/O ports (5/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
PLCR	Port L control register	0056H (Prohibit RMW)	PL7C	PL6C	PL5C	PL4C				
			W							
			0	0	0	0				
			0: Input 1: Output							
PLFC	Port L function register	0057H (Prohibit RMW)	PL7F	PL6F	PL5F	PL4F	PL3F	PL2F	PL1F	PL0F
			W							
			0	0	0	0	0	0	0	0
			0: Port 1: LD7, BUSAK	0: Port 1: LD6, BUSRQ	0: Port 1: LD5	0: Port 1: LD4	0: Port	1: Data bus for LCDC (LD3 to LD0)		
PMFC	Port M function register	005BH (Prohibit RMW)						PM2F	PM1F	
								W		
								0	0	
								0: Port 1: $\overline{\text{ALARM}}$ / MLDALM	0: Port 1: MLDALM output	
PNCR	Port N Control Register	005EH (Prohibit RMW)	PN7C	PN6C	PN5C	PN4C	PN3C	PN2C	PN1C	PN0C
			W							
			0	0	0	0	0	0	0	0
			0:Input 1: Output							
PNFC	Port N Function Register	005FH (Prohibit RMW)	PN7F	PN6F	PN5F	PN4F	PN3F	PN2F	PN1F	PN0F
			W							
			0	0	0	0	0	0	0	0
			0: CMOS output 1: Open drain output							

(1) I/O ports (6/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
P1DR	Port 1 drive register	0081H	P17D	P16D	P15D	P14D	P13D	P12D	P11D	P10D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
P4DR	Port 4 drive register	0084H	P47D	P46D	P45D	P44D	P43D	P42D	P41D	P40D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
P5DR	Port 5 drive register	0085H	P57D	P56D	P55D	P54D	P53D	P52D	P51D	P50D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
P6DR	Port 6 drive register	0086H	P67D	P66D	P65D	P64D	P63D	P62D	P61D	P60D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
P7DR	Port 7 drive register	0087H		P76D	P75D	P74D	P73D	P72D	P71D	P70D
				R/W						
				1	1	1	1	1	1	1
				Input/Output buffer drive register for standby mode						
P8DR	Port 8 drive register	0088H	P87D	P86D	P85D	P84D	P83D	P82D	P81D	P80D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
P9DR	Port 9 drive register	0089H	P97D	P96D	P95D	P94D	P93D	P92D	P91D	P90D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PADR	Port A drive register	008AH	PA7D	PA6D	PA5D	PA4D	PA3D	PA2D	PA1D	PA0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PCDR	Port C drive register	008CH	PC7D	PC6D	PC5D	PC4D	PC3D	PC2D	PC1D	PC0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PFDR	Port F drive register	008FH	PF7D	PF6D	PF5D	PF4D	PF3D	PF2D	PF1D	PF0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PGDR	Port G drive register	0090H					PG3D	PG2D		
							R/W			
							1	1		
							Input/Output buffer drive register for standby mode			

(1) I/O ports (7/7)

Symbol	Name	Address	7	6	5	4	3	2	1	0
PJDR	Port J drive register	0093H	PJ7D	PJ6D	PJ5D	PJ4D	PJ3D	PJ2D	PJ1D	PJ0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PKDR	Port K drive register	0094H	PK7D	PK6D	PK5D	PK4D	PK3D	PK2D	PK1D	PK0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PLDR	Port L drive register	0095H	PL7D	PL6D	PL5D	PL4D	PL3D	PL2D	PL1D	PL0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							
PMDR	Port M drive register	0096H						PM2D	PM1D	
								R/W		
								1	1	
								Input/Output buffer drive register for standby mode		
PNDR	Port N drive register	0097H	PN7D	PN6D	PN5D	PN4D	PN3D	PN2D	PN1D	PN0D
			R/W							
			1	1	1	1	1	1	1	1
			Input/Output buffer drive register for standby mode							

(2) Interrupt control (1/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTE12	INT1 & INT2 enable	00D0H	INT2				INT1			
			I2C	I2M2	I2M1	I2M0	I1C	I1M2	I1M1	I1M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTE34	INT3 & INT4 enable	00D1H	INT4				INT3			
			I4C	I4M2	I4M1	I4M0	I3C	I3M2	I3M1	I3M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETA01	INTTA0 & INTTA1 enable	00D4H	INTTA1 (TMRA1)				INTTA0 (TMRA0)			
			ITA1C	ITA1M2	ITA1M1	ITA1M0	ITA0C	ITA0M2	ITA0M1	ITA0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETA23	INTTA2 & INTTA3 enable	00D5H	INTTA3 (TMRA3)				INTTA2 (TMRA2)			
			ITA3C	ITA3M2	ITA3M1	ITA3M0	ITA2C	ITA2M2	ITA2M1	ITA2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETB01	INTTB0 & INTTB1 enable	00D8H	INTTB1 (TMRB1)				INTTB0 (TMRB0)			
			ITB1C	ITB1M2	ITB1M1	ITB1M0	ITB0C	ITB0M2	ITB0M1	ITB0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETBO0	INTTBO0 (Overflow) enable	00DAH	–				INTTBO0 (TMRB0)			
			–	–	–	–	ITBO0C	ITBO0M2	ITBO0M1	ITBO0M0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTES0	INTRX0 & INTTX0 enable	00DBH	INTTX0				INTRX0			
			ITX0C	ITX0M2	ITX0M1	ITX0M0	IRX0C	IRX0M2	IRX0M1	IRX0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTESPI	INTSPI enable	00E0H	INTSPI				–			
			ISPIC	ISPIM2	ISPIM1	ISPIM0	–	–	–	–
			R	R/W			–	–		
			0	0	0	0	Always write “0”			
INTESBI	INTSBI enable	00E1H	–				INTSBI			
			–	–	–	–	ISBIC	ISBIM2	ISBIM1	ISBIM0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTEALM01	INTALM0 & INTALM1 enable	00E5H	INTALM1				INTALM0			
			IA1C	IA1M2	IA1M1	IA1M0	IA0C	IA0M2	IA0M1	IA0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTEALM23	INTALM2 & INTALM3 enable	00E6H	INTALM3				INTALM2			
			IA3C	IA3M2	IA3M1	IA3M0	IA2C	IA2M2	IA2M1	IA2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0

(2) Interrupt control (2/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTEALM4	INTALM4 enable	00E7H	–				INTALM4			
			–	–	–	–	IA4C	IA4M2	IA4M1	IA4M0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTERTC	INTRTC enable	00E8H	–				INTRTC			
			–	–	–	–	IRC	IRM2	IRM1	IRM0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTEKEY	INTKEY enable	00E9H	–				INTKEY			
			–	–	–	–	IKC	IKM2	IKM1	IKM0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTELCD	INTLCD enable	00EAH	–				INTLCD			
			–	–	–	–	ILCD1C	ILCDM2	ILCDM1	ILCDM0
			–	–			R	R/W		
			Always write “0”				0	0	0	0
INTE5I2S	INT5 & INTI2S enable	00EBH	INTI2S				INT5			
			II2SC	II2SM2	II2SM1	II2SM0	I5C	I5M2	I5M1	I5M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTEND01	INTNDF0 & INTNDF1 enable	00ECH	INTNDF1				INTNDF0			
			IN1C	IN1M2	IN1M1	IN1M0	IN0C	IN0M2	IN0M1	IN0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTEP0	INTP0 enable	00EEH	–				INTP0			
			–	–	–	–	IP0C	IP0M2	IP0M1	IP0M0
			–	–			R	R/W		
			Always write “0”				0	0	0	0

(2) Interrupt control (3/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
INTE0AD	INT0 & INTAD enable	00F0H	INTAD				INT0			
			IADC	IADM2	IADM1	IADM0	I0C	I0M2	I0M1	I0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC01	INTTC0 & INTTC1 enable	00F1H	INTTC1 (DMA1)				INTTC0 (DMA0)			
			ITC1C	ITC1M2	ITC1M1	ITC1M0	ITC0C	ITC0M2	ITC0M1	ITC0M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC23	INTTC2 & INTTC3 enable	00F2H	INTTC3 (DMA3)				INTTC2 (DMA2)			
			ITC3C	ITC3M2	ITC3M1	ITC3M0	ITC2C	ITC2M2	ITC2M1	ITC2M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC45	INTTC4 & INTTC5 enable	00F3H	INTTC5 (DMA5)				INTTC4 (DMA4)			
			ITC5C	ITC5M2	ITC5M1	ITC5M0	ITC4C	ITC4M2	ITC4M1	ITC4M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
INTETC67	INTTC6 & INTTC7 enable	00F4H	INTTC7 (DMA7)				INTTC6 (DMA6)			
			ITC7C	ITC7M2	ITC7M1	ITC7M0	ITC6C	ITC6M2	ITC6M1	ITC6M0
			R	R/W			R	R/W		
			0	0	0	0	0	0	0	0
SIMC	SIO interrupt mode control	00F5H (Prohibit RMW)	–						–	IR0LE
			W						W	
			0						1	1
			Always write “0”.						Always write “1”.	0: INTRX0 edge mode 1: INTRX0 level mode
IIMC	Interrupt input mode control	00F6H (Prohibit RMW)	I5EDGE	I4EDGE	I3EDGE	I2EDGE	I1EDGE	I0EDGE	I0LE	–
			W						R/W	
			0	0	0	0	0	0	0	0
			INT5 edge 0: Rising 1: Falling	INT4 edge 0: Rising 1: Falling	INT3 edge 0: Rising 1: Falling	INT2 edge 0: Rising 1: Falling	INT1 edge 0: Rising 1: Falling	INT0 edge 0: Rising 1: Falling	0: INT0 edge mode 1:INT0 level mode	Always write “0”.
INTWDT	INTWD enable	00F7H	–				INTWD			
			–	–	–	–	ITCWD	–	–	–
			–	–			R			
			Always write “0”				0	–	–	–
INTCLR	Interrupt clear control	00F8H (Prohibit RMW)	CLRV7	CLRV6	CLRV5	CLRV4	CLRV3	CLRV2	CLRV1	CLRV0
			W							
			0	0	0	0	0	0	0	0
			Interrupt vector							

(2) Interrupt control (4/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
DMA0V	DMA0 start vector	0100H			DMA0V5	DMA0V4	DMA0V3	DMA0V2	DMA0V1	DMA0V0
					R/W					
					0	0	0	0	0	0
					DMA0 start vector					
DMA1V	DMA1 start vector	0101H			DMA1V5	DMA1V4	DMA1V3	DMA1V2	DMA1V1	DMA1V0
					R/W					
					0	0	0	0	0	0
					DMA1 start vector					
DMA2V	DMA2 start vector	0102H			DMA2V5	DMA2V4	DMA2V3	DMA2V2	DMA2V1	DMA2V0
					R/W					
					0	0	0	0	0	0
					DMA2 start vector					
DMA3V	DMA3 start vector	0103H			DMA3V5	DMA3V4	DMA3V3	DMA3V2	DMA3V1	DMA3V0
					R/W					
					0	0	0	0	0	0
					DMA3 start vector					
DMA4V	DMA4 start vector	0104H			DMA4V5	DMA4V4	DMA4V3	DMA4V2	DMA4V1	DMA4V0
					R/W					
					0	0	0	0	0	0
					DMA4 start vector					
DMA5V	DMA5 start vector	0105H			DMA5V5	DMA5V4	DMA5V3	DMA5V2	DMA5V1	DMA5V0
					R/W					
					0	0	0	0	0	0
					DMA5 start vector					
DMA6V	DMA6 start vector	0106H			DMA6V5	DMA6V4	DMA6V3	DMA6V2	DMA6V1	DMA6V0
					R/W					
					0	0	0	0	0	0
					DMA6 start vector					
DMA7V	DMA7 start vector	0107H			DMA7V5	DMA7V4	DMA7V3	DMA7V2	DMA7V1	DMA7V0
					R/W					
					0	0	0	0	0	0
					DMA7 start vector					
DMAB	DMA burst	0108H	DBST7	DBST6	DBST5	DBST4	DBST3	DBST2	DBST1	DBST0
			R/W							
			0	0	0	0	0	0	0	0
			1: DMA request on burst mode							
DMAR	DMA request	0109H (Prohibit RMW)	DREQ7	DREQ6	DREQ5	DREQ4	DREQ3	DREQ2	DREQ1	DREQ0
			R/W							
			0	0	0	0	0	0	0	0
			1: DMA request in software							

(3) Memory controller (1/3)

Symbol	Name	Address	7	6	5	4	3	2	1	0
B0CSL	BLOCK0 CS/WAIT control register low	0140H (Prohibit RMW)		B0WW2	B0WW1	B0WW0		B0WR2	B0WR1	B0WR0
				W				W		
				0	1	0		0	1	0
				Write waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved				Read waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved		
B0CSH	BLOCK0 CS/WAIT control register high	0141H (Prohibit RMW)	B0E	–	–	B0REC	B0OM1	B0OM0	B0BUS1	B0BUS0
			W							
			0	0	0	0	0	0	0/1	0/1
			CS select 0: Disable 1: Enable	Always write “0”.	Always write “0”.	Dummy cycle 0:No insert 1: Insert	00: ROM/SRAM 01: Reserved 10: Reserved 11: Reserved		Data bus width 00: 8 bits 01: 16 bits 10: 32 bits 11: Reserved	
B1CSL	BLOCK1 CS/WAIT control register low	0144H (Prohibit RMW)		B1WW2	B1WW1	B1WW0		B1WR2	B1WR1	B1WR0
				W				W		
				0	1	0		0	1	0
				Write waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved				Read waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved		
B1CSH	BLOCK1 CS/WAIT control register high	0145H (Prohibit RMW)	B1E	–	–	B1REC	B1OM1	B1OM0	B1BUS1	B1BUS0
			W							
			0	0	0	0	0	0	0/1	0/1
			CS select 0: Disable 1: Enable	Always write “0”.	Always write “0”.	Dummy cycle 0:No insert 1: Insert	00: ROM/SRAM 01: Reserved 10: Reserved 11: SDRAM		Data bus width 00: 8 bits 01: 16 bits 10: 32 bits 11: Reserved	
B2CSL	BLOCK2 CS/WAIT control register low	0148H (Prohibit RMW)		B2WW2	B2WW1	B2WW0		B2WR2	B2WR1	B2WR0
				W				W		
				0	1	0		0	1	0
				Write waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved				Read waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1+ N) waits 111: 4 waits Others: Reserved		
B2CSH	BLOCK2 CS/WAIT control register high	0149H (Prohibit RMW)	B2E	B2M	–	B2REC	B2OM1	B2OM0	B2BUS1	B2BUS0
			W							
			1	0	0	0	0	0	0/1	0/1
			CS select 0: Disable 1: Enable	0: 16 MB 1: Sets area	Always write “0”.	Dummy cycle 0:No insert 1: Insert	00: ROM/SRAM 01: Reserved 10: Reserved 11: SDRAM		Data bus width 00: 8 bits 01: 16 bits 10: 32 bits 11: Reserved	

(3) Memory controller (2/3)

Symbol	Name	Address	7	6	5	4	3	2	1	0
B3CSL	BLOCK3 CS/WAIT control register low	014CH (Prohibit RMW)		B3WW2	B3WW1	B3WW0		B3WR2	B3WR1	B3WR0
				W				W		
				0	1	0		0	1	0
				Write waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1 + N) waits 111: 4 waits Others: Reserved				Read waits 001: 0 waits 010: 1 wait 101: 2 waits 110: 3 waits 011: (1 + N) waits 111: 4 waits Others: Reserved		
B3CSH	BLOCK3 CS/WAIT control register high	014DH (Prohibit RMW)	B3E	–	–	B3REC	B3OM1	B3OM0	B3BUS1	B3BUS0
			W							
			0	0	0	0	0	0	0/1	0/1
			CS select 0: Disable 1: Enable	Always write “0”.	Always write “0”.	Dummy cycle 0:No insert 1: Insert	00: ROM/SRAM 01: Reserved 10: Reserved 11: Reserved		Data bus width 00: 8 bits 01: 16 bits 10: 32 bits 11: Reserved	
BEXCSL	BLOCK EX CS/WAIT control register low	0158H (Prohibit RMW)		BEXWW2	BEXWW1	BEXWW0		BEXWR2	BEXWR1	BEXWR0
				W				W		
				0	1	0		0	1	0
				Write waits 001: 2 waits 010: 1 wait 101: 2 waits 110: 2 waits 011: (1 + N) waits Others: Reserved				Read waits 001: 2 waits 010: 1 wait 101: 2 waits 110: 2 waits 011: (1 + N) waits Others: Reserved		
BEXCSH	BLOCK EX CS/WAIT control register high	0159H (Prohibit RMW)					BEXOM1	BEXOM0	BEXBUS1	BEXBUS0
							W			
							0	0	0/1	0/1
							00: ROM/SRAM 01: Reserved 10: Reserved 11: Reserved		00: 8 bits 01: 16 bits 10: 32 bits 11: Reserved	
PMEMCR	Page ROM control register	0166H				OPGE	OPWR1	OPWR0	PR1	PR0
						R/W				
						0	0	0	1	0
						ROM page access 0: Disable 1: Enable	Wait number on page 00: 1 CLK (n-1-1-1 mode) 01: 2 CLK (n-2-2-2 mode) 10: 3 CLK (n-3-3-3 mode) 11: Reserved		Byte number in a page 00: 64 bytes 01: 32 bytes 10: 16 bytes 11: 8 bytes	

(3) Memory controller (3/3)

Symbol	Name	Address	7	6	5	4	3	2	1	0
MAMR0	Memory address mask register 0	0142H	M0V20	M0V19	M0V18	M0V17	M0V16	M0V15	M0V14-9	M0V8
			R/W							
			1	1	1	1	1	1	1	1
			0: Compare enable 1: Compare disable							
MSAR0	Memory start address register 0	0143H	M0S23	M0S22	M0S21	M0S20	M0S19	M0S18	M0S17	M0S16
			R/W							
			1	1	1	1	1	1	1	1
			Set start address A23 to A16							
MAMR1	Memory address mask register 1	0146H	M1V21	M1V20	M1V19	M1V18	M1V17	M1V16	MV15-9	M1V8
			R/W							
			1	1	1	1	1	1	1	1
			0: Compare enable 1: Compare disable							
MSAR1	Memory start address register 1	0147H	M1S23	M1S22	M1S21	M1S20	M1S19	M1S18	M1S17	M1S16
			R/W							
			1	1	1	1	1	1	1	1
			Set start address A23 to A16							
MAMR2	Memory address mask register 2	014AH	M2V22	M2V21	M2V20	M2V19	M2V18	M2V17	M2V16	M2V15
			R/W							
			1	1	1	1	1	1	1	1
			0: Compare enable 1: Compare disable							
MSAR2	Memory start address register 2	014BH	M2S23	M2S22	M2S21	M2S20	M2S19	M2S18	M2S17	M2S16
			R/W							
			1	1	1	1	1	1	1	1
			Set start address A23 to A16							
MAMR3	Memory address mask register 3	014EH	M3V22	M3V21	M3V20	M3V19	M3V18	M3V17	M3V16	M3V15
			R/W							
			1	1	1	1	1	1	1	1
			0:Compare enable 1:Compare disable							
MSAR3	Memory start address register 3	014FH	M3S23	M3S22	M3S21	M3S20	M3S19	M3S18	M3S17	M3S16
			R/W							
			1	1	1	1	1	1	1	1
			Set start address A23 to A16							
MEMCR0	Memory control register 0	0168H						CSDIS	RDTMG1	RDTMG0
								R/W		
								0	0	0
								0: Disable 1: Enable	00: RD "H" pulse width = 0.5T (Default) 01: RD "H" pulse width = 0.75T 10: RD "H" pulse width =1.0T 11: Reserved	

(4) MMU

Symbol	Name	Address	7	6	5	4	3	2	1	0
LOCALPX	LOCALX register for program	01D0H	LXE			X4	X3	X2	X1	X0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALX 1: Enable			BANK number for LOCALX Setting				
LOCALPY	LOCALY register for program	01D1H	LYE			Y4	Y3	Y2	Y1	Y0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALY 1: Enable			BANK number for LOCALY Setting				
LOCALPZ	LOCALZ register for program	01D3H	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
			R/W	R/W						
			0	0	0	0	0	0	0	0
			LOCALZ 1: Enable	BANK number for LOCALZ Setting						
LOCALLX	LOCALX register for LCDC	01D4H	LXE			X4	X3	X2	X1	X0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALX 1: Enable			BANK number for LOCALX Setting				
LOCALLY	LOCALY register for LCDC	01D5H	LYE			Y4	Y3	Y2	Y1	Y0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALY 1: Enable			BANK number for LOCALY Setting				
LOCALLZ	LOCALZ register for LCDC	01D7H	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
			R/W	R/W						
			0	0	0	0	0	0	0	0
			LOCALZ 1: Enable	BANK number for LOCALZ Setting						
LOCALRX	LOCALX register for read	01D8H	LXE			X4	X3	X2	X1	X0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALX 1: Enable			BANK number for LOCALX Setting				
LOCALRY	LOCALY register for read	01D9H	LYE			Y4	Y3	Y2	Y1	Y0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALY 1: Enable			BANK number for LOCALY Setting				
LOCALRZ	LOCALZ register for read	01DBH	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
			R/W	R/W						
			0	0	0	0	0	0	0	0
			LOCALZ 1: Enable	BANK number for LOCALZ Setting						
LOCALWX	LOCALX register for write	01DCH	LXE			X4	X3	X2	X1	X0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALX 1: Enable			BANK number for LOCALX Setting				
LOCALWY	LOCALY register for write	01DDH	LYE			Y4	Y3	Y2	Y1	Y0
			R/W			R/W				
			0			0	0	0	0	0
			LOCALY 1: Enable			BANK number for LOCALY Setting				
LOCALWZ	LOCALZ register for write	01DFH	LZE	Z6	Z5	Z4	Z3	Z2	Z1	Z0
			R/W	R/W						
			0	0	0	0	0	0	0	0
			LOCALZ 1: Enable	BANK number for LOCALZ Setting						

(5) Clock gear, PLL

Symbol	Name	Address	7	6	5	4	3	2	1	0
SYSCR0	System clock control register 0	10E0H	XEN	XTEN				WUEF		
			R/W					R/W		
			1	1				0		
			H-OSC (fc) 0: Stop 1: Oscillation	L-OSC (fs) 0: Stop 1: Oscillation				Warm-up timer		
SYSCR1	System clock control register 1	10E1H					SYSCK	GEAR2	GEAR1	GEAR0
							R/W			
							0	1	0	0
							Select system clock 0: fc 1: fs	Select gear value of high frequency (fc) 000: fc 001: fc/2 010: fc/4 011: fc/8 101: (Reserved) 110: (Reserved) 111: (Reserved) 100: fc/16		
SYSCR2	System clock control register 2	10E2H	–		WUPTM1	WUPTM0	HALTM1	HALTM0		
			R/W		R/W					
			0		1	0	1	1		
			Always write “0”		Warm-up timer 00: Reserved 01: 2^8/Inputted frequency 10: 2^{14}/Inputted frequency 11: 2^{16}/Inputted frequency		HALT mode 00: Reserved 01: STOP mode 10: IDLE1 mode 11: IDLE2 mode			
EMCCR0	EMC control register 0	10E3H	PROTECT					EXTIN	DRVOSCH	DRVOSCL
			R					R/W		
			0					0	1	1
			Protect flag 0: OFF 1: ON					1: External clock	High frequency oscillator driver ability 1: NORMAL 0: WEAK	Low frequency oscillator driver ability 1: NORMAL 0: WEAK
EMCCR1	EMC control register 1	10E4H	Switching the protect ON/OFF by write to following 1st KEY, 2nd KEY 1st KEY: EMCCR1=5AH, EMCCR2=A5H in succession write 2nd KEY: EMCCR1=A5H, EMCCR2=5AH in succession write							
EMCCR2	EMC control register 2	10E5H								
PLLCR0	PLL control register 0	10E8H		FCSEL	LUPFG					
				R/W	R					
				0	0					
				Select fc clock 0: f_{OSCH} 1: f_{PLL}	Lock up timer status flag					
PLLCR1	PLL control register 1	10E9H	PLLON							
			R/W							
			0							
			Control on/off 0: OFF 1: ON							

(6) LCD controller (1/2)

Symbol	Name	Address	7	6	5	4	3	2	1	0
LCDMODE0	LCD mode 0 register	0840H	RAMTYPE1	RAMTYPE0	SCPW1	SCPW0	LMODE	INTMODE	LDO1	LDO0
			R/W							
			0	0	1	0	0	0	0	0
			Display RAM 00: Internal SRAM1 01: External SRAM 10: SDRAM 11: Internal SRAM2		LD bus transmission speed 00: Reserved 01: 2 × f_{SYS} 10: 4× f_{SYS} 11: 8× f_{SYS}		LCDD type 0: SR 1: Built-in RAM type	Select interrupt 0: LP 1: BCD	LD bus width control 00: 4bit width A_type 01: 4bit width B_type 10: 8bit width type Others: Reserved	
LCDFFP	LCD frame frequency register	0841H	FP7	FP6	FP5	FP4	FP3	FP2	FP1	FP0
			R/W							
			0	0	0	0	0	0	0	0
			bit7 to bit0 f_{FP} setting							
LCDDVM	LCD divide FRM register	0283H	FMN7	FMN6	FMN5	FMN4	FMN3	FMN2	FMN1	FMN0
			R/W							
			0	0	0	0	0	0	0	0
			DVM bit7 to bit0 setting							
LCDSIZE	LCD size register	0843H	COM3	COM2	COM1	COM0	SEG3	SEG2	SEG1	SEG0
			R/W							
			0	0	0	0	0	0	0	0
			Common setting 0000: Reserved 0101: 200 0001: 64 0110: 240 0010: 120 0111: 320 0011: 128 1000: 480 0100: 160 Others: Reserved				Segment setting 0000: Reserved 0101: 320 0001: 64 0110: 480 0010: 128 0111: 640 0011: 160 0100: 240 Others: Reserved			
LCDCTL0	LCD control 0 register	0844H		ALL0	FRMON	–	FP9	MMULCD	FP8	START
				R/W						
				0	0	0	0	0	0	0
				Segment Data setting 0: Normal 1: All display data “0”	FR divide setting 0: Disable 1: Enable	Always write “0”	f_{FP} setting bit 9	Built-in RAM LCDD setting 0: Sequential access 1: Random access	f_{FP} setting bit 8	LCDC start 0: STOP 1: START
LCDSCC	LCD source clock counter register	0846H	SCC7	SCC6	SCC5	SCC4	SCC3	SCC2	SCC1	SCC0
			R/W							
			0	0	0	0	0	0	0	0
			LCDC source clock counter bit7 to bit0							

(6) LCD controller (2/2)

Symbol	Name	Address	7	6	5	4	3	2	1	0
LSARAL	Start address register A area (L)	0850H	SA7	SA6	SA5	SA4	SA3	SA2	SA1	SA0
			R/W							
			0	0	0	0	0	0	0	0
			Start address for A area (bit7 to bit0)							
LSARAM	Start address register A area (M)	0851H	SA15	SA14	SA13	SA12	SA11	SA10	SA9	SA8
			R/W							
			0	0	0	0	0	0	0	0
			Start address for A area (bit15 to bit8)							
LSARAH	Start address register A area (H)	0852H	SA23	SA22	SA21	SA20	SA19	SA18	SA17	SA16
			R/W							
			0	1	0	0	0	0	0	0
			Start address for A area (bit23 to bit16)							
CMNAL	Common number register A area (L)	0853H	CA7	CA6	CA5	CA4	CA3	CA2	CA1	CA0
			R/W							
			0	0	0	0	0	0	0	0
			Common number setting for A area (bit7 to bit0)							
CMNAH	Common number register A area (H)	0854H								CA8
										R/W
										0
										A area (bit8)
LSARBL	Start address register B area (L)	0856H	SB7	SB6	SB5	SB4	SB3	SB2	SB1	SB0
			R/W							
			0	0	0	0	0	0	0	0
			Start address for B area (bit7 to bit0)							
LSARBM	Start address register B area (M)	0857H	SB15	SB14	SB13	SB12	SB11	SB10	SB9	SB8
			R/W							
			0	0	0	0	0	0	0	0
			Start address for B area (bit15 to bit8)							
LSARBH	Start address register B area (H)	0858H	SB23	SB22	SB21	SB20	SB19	SB18	SB17	SB16
			R/W							
			0	1	0	0	0	0	0	0
			Start address for B area (bit23 to bit16)							
CMNBL	Common number register B area (L)	0859H	CB7	CB6	CB5	CB4	CB3	CB2	CB1	CB0
			R/W							
			0	0	0	0	0	0	0	0
			Common number setting for B area (bit7 to bit0)							
CMNBH	Common number register B area (H)	085AH								CB8
										R/W
										0
										B area (bit8)
LSARCL	Start address register C area (L)	085CH	SC7	SC6	SC5	SC4	SC3	SC2	SC1	SC0
			R/W							
			0	0	0	0	0	0	0	0
			Start address for C area (bit7 to bit0)							
LSARCM	Start address register C area (M)	085DH	SC15	SC14	SC13	SC12	SC11	SC10	SC9	SC8
			R/W							
			0	0	0	0	0	0	0	0
			Start address for C area (bit15 to bit8)							
LSARCH	Start address register C area (H)	085EH	SC23	SC22	SC21	SC20	SC19	SC18	SC17	SC16
			R/W							
			0	1	0	0	0	0	0	0
			Start address for C area (bit23 to bit16)							

(7) Touch screen I/F

Symbol	Name	Address	7	6	5	4	3	2	1	0
TSICR0	Touch screen I/F control register 0	01F0H	TSI7		PTST	TWIEN	PYEN	PXEN	MYEN	MXEN
			R/W		R	R/W				
			0		0	0	0	0	0	0
			0: Disable 1: Enable		Detection condition 0: no touch 1: touch	INT4 interrupt control 0: Disable 1: Enable	SPY 0 : OFF 1 : ON	SPX 0 : OFF 1 : ON	SMY 0 : OFF 1 : ON	SMX 0 : OFF 1 : ON
TSICR1	Touch screen I/F control register 1	01F1H	DBC7	DB1024	DB256	DB64	DB8	DB4	DB2	DB1
			R/W							
			0	0	0	0	0	0	0	0
			0: Disable 1: Enable	1024	256	64	8	4	2	1
			Debounce time is set by the formula “(N × 64 − 16)/f_{SYS}” − formula. “N” is sum ofthe number of bits between bit6 and bit0 which is are set to “1”							

(8) SDRAM controller

Symbol	Name	Address	7	6	5	4	3	2	1	0
SDACR1	SDRAM access control register 1	0250H	−	−	SMRD	SWRC	SBST	SBL1	SBL0	SMAC
			R/W							
			0	0	0	0	0	1	0	0
			Always write “0”	Always write “0”	Mode register set delay time	Write recovery time	Burst stop command	Select read burst length 00: Reserved 01: Full page read, Burst write 10: 1 word read, Single write 11: Full page read Single write		0: Disable 1: Enable
SDACR2	SDRAM access control register 2	0251H				SBS	SDRS1	SDRS0	SMUXW1	SMUXW0
						R/W				
						0	0	0	0	0
						Number of banks	Selecting ROW address size		Selecting address Multiplex type	
SDRCR	SDRAM refresh control register	0252H	−			SSAE	SRS2	SRS1	SRS0	SRC
			R/W			R/W				
			0			1	0	0	0	0
			Always write “0”			SR Auto exit function 0: Disable 1: Enable	Refresh interval 000: 47 states 100: 156 states 001: 78 states 101: 295 states 010: 97 states 110: 249 states 011: 124 states 111: 312 states			Auto refresh 0: Disable 1: Enable
SDCMM	SDRAM command register	0253H						SCMM2	SCMM1	SCMM0
								R/W		
								0	0	0
								Issuing command		

(9) 8-bit timer

Symbol	Name	Address	7	6	5	4	3	2	1	0
TA01RUN	TMRA01 RUN register	1100H	TA0RDE				I2TA01	TA01PRUN	TA1RUN	TA0RUN
			R/W				R/W			
			0				0	0	0	0
			Double buffer 0: Disable 1: Enable				IDLE2 0: Stop 1: Operate	TMRA01 prescaler	UP counter (UC1)	UP counter (UC0)
								0: Stop and clear 1: Run (Count up)		
TA0REG	8-bit timer register 0	1102H (Prohibit RMW)	–							
			W							
			Undefined							
TA1REG	8-bit timer register 1	1103H (Prohibit RMW)	–							
			W							
			Undefined							
TA01MOD	TMRA01 mode register	1104H	TA01M1	TA01M0	PWM01	PWM00	TA1CLK1	TA1CLK0	TA0CLK1	TA0CLK0
			R/W							
			0	0	0	0	0	0	0	0
			Operation mode 00: 8-bit timer mode 01: 16-bit timer mode 10: 8-bit PPG mode 11: 8-bit PWM mode		PWM cycle 00: Reserved 01: 2^6 10: 2^7 11: 2^8		Source clock for TMRA1 00: TA0TRG 01: ϕT1 10: ϕT16 11: ϕT256		Source clock for TMRA0 00: Reserved 01: ϕT1 10: ϕT4 11: ϕT16	
TA1FFCR	TMRA1 flip-flop control register	1105H (Prohibit RMW)					TA1FFC1	TA1FFC0	TA1FFIE	TA1FFIS
							W		R/W	
							1	1	0	0
							00: Invert TA1FF 01: Set TA1FF 10: Clear TA1FF 11: Don't care		TA1FF control for inversion 0: Disable 1: Enable	TA1FF Inversion select 0: TMRA0 1: TMRA1
TA23RUN	TMRA23 RUN register	1108H	TA1RDE				I2TA23	TA23PRUN	TA3RUN	TA2RUN
			R/W				R/W			
			0				0	0	0	0
			Double buffer 0: Disable 1: Enable				IDLE2 0: Stop 1: Operate	TMRA23 prescaler	UP counter (UC3)	UP counter (UC4)
								0: Stop and clear 1: Run (Count up)		
TA2REG	8-bit timer register 2	110AH (Prohibit RMW)	–							
			W							
			Undefined							
TA3REG	8-bit timer register 3	110BH (Prohibit RMW)	–							
			W							
			Undefined							
TA23MOD	TMRA23 mode register	110CH	TA23M1	TA23M0	PWM21	PWM20	TA3CLK1	TA3CLK0	TA2CLK1	TA2CLK0
			R/W							
			0	0	0	0	0	0	0	0
			Operation mode 00: 8-bit timer mode 01: 16-bit timer mode 10: 8-bit PPG mode 11: 8-bit PWM mode		PWM cycle 00: Reserved 01: 2^6 10: 2^7 11: 2^8		Source clock for TMRA3 00: TA2TRG 01: ϕT1 10: ϕT16 11: ϕT256		Source clock for TMRA2 00: Reserved 01: ϕT1 10: ϕT4 11: ϕT16	
TA3FFCR	TMRA3 flip-flop control register	110DH (Prohibit RMW)					TA3FFC1	TA3FFC0	TA3FFIE	TA3FFIS
							W		R/W	
							1	1	0	0
							00: Invert TA3FF 01: Set TA3FF 10: Clear TA3FF 11: Don't care		TA3FF control for inversion 0: Disable 1: Enable	TA3FF inversion select 0: TMRA2 1: TMRA3

(10) 16-bit timer

Symbol	Name	Address	7	6	5	4	3	2	1	0
TB0RUN	TMRB0 RUN register	1180H	TB0RDE	–			I2TB0	TB0PRUN		TB0RUN
			R/W				R/W			R/W
			0	0			0	0		0
			Double buffer 0: Disable 1: Enable	Always write “0”			IDLE2 0: Stop 1: Operate	TMRB0 Prescaler		Up counter UC10
								0: Stop and clear 1: Run (Count up)		
TB0MOD	TMRB0 mode register	1182H (Prohibit RMW)	–	–	TB0CP0I	TB0CPM1	TB0CPM0	TB0CLE	TB0CLK1	TB0CLK0
			R/W		W*	R/W				
			0	0	1	0	0	0	0	0
			Always write “00”.		Execute software capture 0: Software capture 1: Undefined	Capture timing 00: Disable 01: Reserved 10: Reserved 11: TA1OUT↑ TA1OUT↓		Control up counter 0: Disable clearing 1: Enable clearing	TMRB0 source clock 00: Reserved 01: φT1 10: φT4 11: φT16	
TB0FFCR	TMRB0 flip-flop control register	1183H (Prohibit RMW)	–	–	TB0CT1	TB0C0T1	TB0E1T1	TB0E0T1	TB0FF0C1	TB0FF0C0
			W*			R/W			W*	
			1	1	0	0	0	0	1	1
			Always write “11”.		TB0FF0 inversion trigger 0: Disable trigger 1: Enable trigger				Control TB0FF0 00: Invert 01: Set 10: Clear 11: Don’t care * Always read as “11”	
					Invert when the UC value is loaded into TB0CP1.	Invert when the UC value is loaded into TB0CP0.	Invert when the UC value matches the value in TB0RG1.	Invert when the UC value matches the value in TB0RG0.		
TB0RG0L	16-bit timer register 0 low	1188H (Prohibit RMW)	–							
			W							
			Undefined							
TB0RG0H	16-bit timer register 0 high	1189H (Prohibit RMW)	–							
			W							
			Undefined							
TB0RG1L	16-bit timer register 1 low	118AH (Prohibit RMW)	–							
			W							
			Undefined							
TB0RG1H	16-bit timer register 1 high	118BH (Prohibit RMW)	–							
			W							
			Undefined							
TB0CP0L	Capture register 0 low	118CH	–							
			R							
			Undefined							
TB0CP0H	Capture register 0 high	118DH	–							
			R							
			Undefined							
TB0CP1L	Capture register 1 low	118EH	–							
			R							
			Undefined							
TB0CP1H	Capture register 1 high	118FH	–							
			R							
			Undefined							

(11) UART/serial channel

Symbol	Name	Address	7	6	5	4	3	2	1	0
SC0BUF	Serial channel 0 buffer register	1200H (Prohibit RMW)	RB7 TB7	RB6 TB6	RB5 TB5	RB4 TB4	RB3 TB3	RB2 TB2	RB1 TB1	RB0 TB0
			R (Receiving)/W (Transmission)							
			Undefined							
SC0CR	Serial channel 0 control register	1201H	RB8	EVEN	PE	OERR	PERR	FERR	SCLKS	IOC
			R	R/W		R (Clear 0 after reading)			R/W	
			Undefined	0	0	0	0	0	0	0
			Receive data bit8	Parity 0: Odd 1: Even	Parity 0: Disable 1: Enable	1: Error Overrun	Parity	Framing	0: SCLK0↑ 1: SCLK0↓	0: Baud rate generator 1: SCLK0 pin input
SC0MOD0	Serial channel 0 mode 0 register	1202H	TB8	CTSE	RXE	WU	SM1	SM0	SC1	SC0
			R/W							
			0	0	0	0	0	0	0	0
			Trans-mission data bit8	0: CTS disable 1: CTS enable	0: Receive disable 1: Receive enable	Wake-up 0: Disable 1: Enable	00: I/O Interface mode 01: 7-bit UART mode 10: 8-bit UART mode 11: 9-bit UART mode		00: TA0TRG 01: Baud rate generator 10: Internal clock f_{IO} 11: External clock (SCLK0 input)	
BR0CR	Serial channel 0 baud rate control register	1203H	–	BR0ADDE	BR0CK1	BR0CK0	BR0S3	BR0S2	BR0S1	BR0S0
			R/W							
			0	0	0	0	0	0	0	0
			Always write “0”	(16-K)/16 divided 0: Disable 1: Enable	00: ϕT0 01: ϕT2 10: ϕT8 11: ϕT32		Set the frequency divisor “N” (0 to F)			
BR0ADD	Serial channel 0 K setting register	1204H					BR0K3	BR0K2	BR0K1	BR0K0
							R/W			
							0	0	0	0
							Set the frequency divisor “K” (1 to F)			
SC0MOD1	Serial channel 0 mode 1 register	1205H	I2S0	FDPX0						
			R/W							
			0	0						
			IDLE2 0: Stop 1: Operate	I/O interface mode 0: Half duplex 1: Full duplex						
SIRCR	IrDA control register	1207H	PLSEL	RXSEL	TXEN	RXEN	SIRWD3	SIRWD2	SIRWD1	SIRWD0
			R/W							
			0	0	0	0	0	0	0	0
			Select transmit pulse width 0: 3/16 1: 1/16	Receive data 0: “H” pulse 1: “L” pulse	Transmit 0: Disable 1: Enable	Receive 0: Disable 1: Enable	Select receive pulse width Set effective pulse width for equal or more than 2x × (value + 1) + 100ns Can be set: 1 to 14 Can not be set: 0,15			

(12) Serial bus interface (SBI)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SBI0CR1	Serial bus interface 0 control register 1	1240H (I^2C Mode) (Prohibit RMW)	BC2	BC1	BC0	ACK		SCK2	SCK1	SCK0/ SWRMON
			W			R/W		W		R/W
			0	0	0	0		0	0	0/1
			Number of transfer bits 000: 8 001: 1 010: 2 011: 3 100: 4 101: 5 110: 6 111: 7			Acknowle -dge mode 0: Disable 1: Enable		Setting for the devisor value “n” 000: 5 001: 6 010: 7 011: 8 100: 9 101: 10 110: 11 111: Reserved		
SBI0DBR	Serial bus interface buffer register	1241H (Prohibit RMW)	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0
			R (Receiving)/W (Transmission)							
			Undefined							
I2C0AR	I2CBUS0 address register	1242H (Prohibit RMW)	SA6	SA5	SA4	SA3	SA2	SA1	SA0	ALS
			W							
			0	0	0	0	0	0	0	0
			Slave address setting							Address recognition 0: Disable 1: Enable
SBI0CR2	Serial bus interface Interface control register 2	1243H (I^2C Mode) (Prohibit RMW)	MST	TRX	BB	PIN	SBIM1	SBIM0	SWRST1	SWRST0
			W							
			0	0	0	1	0	0	0	0
			0: Slave 1: Master	0: Receiver 1: Transmit	Start/Stop condition generation 0: Stop condition 1: Start condition (Case of MST, TRX, Pin are “1”)	INTSBI interrupt monitor 0: Request 1: Cancel	SBI operation mode selection 00: Port mode 01: Reserved 10: I^2C mode 11: Reserved		Software reset generate write “10” and “01”, then an internal reset signal is generated.	
SBI0SR	Serial bus interface status register	1243H (I^2C Mode) (Prohibit RMW)	MST	TRX	BB	PIN	AL	AAS	AD0	LRB
			R							
			0	0	0	1	0	0	0	0
			0: Slave 1: Master	0: Receiver 1: Transmit	Bus status monitor 0:Free 1:Busy	INTSBI interrupt 0: Request 1: Cancel	Arbitration lost detection monitor 0: – 1: Detected	Slave address match detection monitor 0: Undetected 1: Detected	GENERAL CALL detection monitor 0: Undetected 1: Detected	Last received bit monitor 0: 0 1: 1
SBI0BR0	Serial bus interface Baud rate register 0	1244H (Prohibit RMW)	–	I2SBI0						
			W	R/W						
			0	0						
			Always write “0”	IDLE2 0: Stop 1: Run						
SBI0BR1	Serial bus interface Baud rate register 1	1245H (Prohibit RMW)	P4EN	–						
			W							
			0	0						
			Internal clock 0: Stop 1: Run	Always write “0”						

(13)SPI controller (1/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SPIMD	SPI mode setting register	0820H		XEN				CLKSEL2	CLKSEL1	CLKSEL0
				R/W				R/W		
				0				1	0	0
				SYSCK 0: Disable 1: Enable				Baud rate selection 000: f_{SYS} 100: $f_{SYS}/16$ 001: $f_{SYS}/2$ 101: $f_{SYS}/32$ 010: $f_{SYS}/4$ 110: $f_{SYS}/64$ 011: $f_{SYS}/8$ 111: Reserved		
		0821H	LOOPBACK	MSB1ST	DOSTAT		TCPOL	RCPOL	TDINV	RDINV
			R/W				R/W			
			0	1	1		0	0	0	0
			LOOPBACK test mode 0: Disable 1: Enable	Start bit for transmit 0: LSB 1: MSB	SPDO pin (No transmit) 0: Fixed to "0" 1: Fixed to "1"		Synchronous clock edge during transmitting 0: Falling 1: Rising	Synchronous clock edge during receiving 0: Falling 1: Rising	Invert data during transmitting 0: Disable 1: Enable	Invert data during receiving 0: Disable 1: Enable
SPICT	SPI control register	0822H	CEN	SPCS_B	UNIT16			ALGNEN	RXWEN	RXUEN
			R/W					R/W		
			0	1	0			0	0	0
			Communication control 0: Disable 1: Enable	$\overline{\text{SPCS}}$ pin 0: Output "0" 1:Output "1"	Data length 0: 8bit 1: 16bit			Full duplex alignment 0: Disable 1: Enable	Sequential receive 0: Disable 1: Enable	Receive UNIT 0: Disable 1: Enable
		0823H	CRC16_7_B	CRCRX_TX_B	CRCRESET_B				DMAERFW	DMAERFR
			R/W						R/W	
			0	0	0				0	0
			CRC selection 0: CRC7 1: CRC16	CRC data 0: Transmit 1: Receive	CRC Calculation register 0:Reset 1:Relese reset				Micro DMA 0: Disable 1: Enable	Micro DMA 0: Disable 1: Enable
SPIST	SPI status register	0824H					TEND	REND	RFW	RFR
							R			
							1	0	1	0
							Receiving 0: Operation 1: No operation	Receive shift t register 0: No data 1: Exist data	Transmit buffer 0: Exist un-transmitted data 1: No un-transmitted data	Receive buffer 0: No valid data 1: Exist valid data
		0825H								

(13)SPI controller (2/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SPICR	SPI CRC register	0826H	CRCD7	CRCD6	CRCD5	CRCD4	CRCD3	CRCD2	CRCD1	CRCD0
			R							
			0	0	0	0	0	0	0	0
			CRC calculation result load register [7:0]							
		0827H	CRCD15	CRCD14	CRCD13	CRCD12	CRCD11	CRCD10	CRCD9	CRCD8
			R							
			0	0	0	0	0	0	0	0
			CRC calculation result load register [15:8]							
SPIIS	SPI interrupt status register	0828H					TENDIS	RENDIS	RFWIS	RFRIS
							R/W			
							0	0	0	0
							Read 0:No interrupt 1:interrupt Write 0:Don't care 1:Clear	Read 0:No interrupt 1:interrupt Write 0:Don't care 1:Clear	Read 0:No interrupt 1:interrupt Write 0:Don't care 1:Clear	Read 0:No interrupt 1:interrupt Write 0:Don't care 1:Clear
		0829H								
SPIWE	SPI interrupt status write enable register	082AH					TENDWE	RENDWE	RFWWE	RFRWE
							R			
							0	0	0	0
							Clear SPIIS <TENDIS> 0: Disable 1: Enable	Clear SPIIS <RENDIS> 0: Disable 1: Enable	Clear SPIIS <RFWIS> 0: Disable 1: Enable	Clear SPIIS <RFRIS> 0: Disable 1: Enable
		082BH								

(13) SPI controller (3/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SPIIE	SPI interrupt enable register	082CH					TENDIE	RENDIE	RFWIE	RFRIE
							R/W			
							0	0	0	0
							TEND interrupt 0: Disable 1: Enable	REND interrupt 0: Disable 1: Enable	RFW interrupt 0: Disable 1: Enable	RFR interrupt 0: Disable 1: Enable
		082DH								
SPIIR	SPI interrupt request register	082EH					TENDIR	RENDIR	RFWIR	RFRIR
							R			
							0	0	0	0
							TEND interrupt 0: None 1: Generate	REND interrupt 0: None 1: Generate	RFW interrupt 0: None 1: Generate	RFR interrupt 0: None 1: Generate
		082FH								
SPITD	SPI transmission data register	0830H	TXD7	TXD6	TXD5	TXD4	TXD3	TXD2	TXD1	TXD0
			R/W							
			0	0	0	0	0	0	0	0
			Transmission data register [7:0]							
		0831H	TXD15	TXD14	TXD13	TXD12	TXD11	TXD10	TXD9	TXD8
			R/W							
			0	0	0	0	0	0	0	0
			Transmission data register [15:8]							

(13) SPI controller (4/4)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SPIRD	SPI receive register	0832H	RXD7	RXD6	RXD5	RXD4	RXD3	RXD2	RXD1	RXD0
			R							
			0	0	0	0	0	0	0	0
			Receive data register [7:0]							
		0833H	RXD15	RXD14	RXD13	RXD12	RXD11	RXD10	RXD9	RXD8
			R							
			0	0	0	0	0	0	0	0
			Receive data register [15:8]							
SPITS	SPI transmission data shift register	0834H	TSD7	TSD6	TSD5	TSD4	TSD3	TSD2	TSD1	TSD0
			R							
			0	0	0	0	0	0	0	0
			Transmission data shift register [7:0]							
		0835H	TSD15	TSD14	TSD13	TSD12	TSD11	TSD10	TSD9	TSD8
			R							
			0	0	0	0	0	0	0	0
			Transmission data register [15:8]							
SPIRS	SPI receive data register	0836H	RSD7	RSD6	RSD5	RSD4	RSD3	RSD2	RSD1	RSD0
			R							
			0	0	0	0	0	0	0	0
		0837H	RSD15	RSD14	RSD13	RSD12	RSD11	RSD10	RSD9	RSD8
			R/W							
			0	0	0	0	0	0	0	0

(14) AD converter (1/2)

Symbol	Name	Address	7	6	5	4	3	2	1	0
ADMOD0	AD mode control register 0	12B8H	EOCF	ADBF	–	–	ITM0	REPEAT	SCAN	ADS
			R		R/W					
			0	0	0	0	0	0	0	0
			AD conversion end flag 1:END	AD conversion BUSY flag 1: Busy	Always write "0"	Always write "0"	0: Every 1 time 1: Every 4 times	Repeat mode 0: Single mode 1: Repeat mode	Scan mode 0: Fixed channel mode 1: Channel scan mode	AD conversion start 1: Start always read as "0"
ADMOD1	AD mode control register 1	12B9H	VREFON	I2AD	–	–	–	–	ADCH1	ADCH0
			R/W	R/W	R/W					
			0	0	0	0	0	0	0	0
			Ladder resistance 0: OFF 1: ON	IDLE2 0: Stop 1: Operate	Always write "0"	Always write "0"	Always write "0"	Always write "0"	Input channel 000: AN0 001: AN1 010: AN2 011: AN3	
ADMOD2	AD mode control register 1	12BAH	–	–	–	–	–	–	–	ADTRG
			R/W							
			0	0	0	0	0	0	0	0
			Always write "0"	Always write "0"	Always write "0"	Always write "0"	Always write "0"	Always write "0"	Always write "0"	AD external trigger start control 0: Disable 1: Enable
ADREG0L	AD result register 0 low	12A0H	ADR01	ADR00						ADR0RF
			R							R
			Undefined							0
ADREG0H	AD result register 0 high	12A1H	ADR09	ADR08	ADR07	ADR06	ADR05	ADR04	ADR03	ADR02
			R							
			Undefined							
ADREG1L	AD result register 1 low	12A2H	ADR11	ADR10						ADR1RF
			R							R
			Undefined							0
ADREG1H	AD result register 1 high	12A3H	ADR19	ADR18	ADR17	ADR16	ADR15	ADR14	ADR13	ADR12
			R							
			Undefined							
ADREG2L	AD result register 2 low	12A4H	ADR21	ADR20						ADR2RF
			R							R
			Undefined							0
ADREG2H	AD result register 2 high	12A5H	ADR29	ADR28	ADR27	ADR26	ADR25	ADR24	ADR23	ADR22
			R							
			Undefined							
ADREG3L	AD result register 3 low	12A6H	ADR31	ADR30						ADR3RF
			R							R
			Undefined							0
ADREG3H	AD result register 3 high	12A7H	ADR39	ADR38	ADR37	ADR36	ADR35	ADR34	ADR33	ADR32
			R							
			Undefined							

(15) Watchdog timer

Symbol	Name	Address	7	6	5	4	3	2	1	0
WDMOD	WDT mode register	1300H	WDTE	WDTP1	WDTP0		–	I2WDT	RESCR	–
			R/W				R/W			
			1	0	0		0	0	0	0
			WDT control 1: Enable	Select detecting time 00: $2^{15}/f_{IO}$ 01: $2^{17}/f_{IO}$ 10: $2^{19}/f_{IO}$ 11: $2^{21}/f_{IO}$			Always write "0"	IDLE2 0: Stop 1: Operate	1: Internally connects WDT out to the reset pin	Always write "0"
WDCR	WDT control register	1301H (Prohibit RMW)	–							
			W							
			–							
			B1H: WDT disable code 4E: WDT clear code							

(16) RTC (Real time clock)

Symbol	Name	Address	7	6	5	4	3	2	1	0
SECR	Second register	1320H		SE6	SE5	SE4	SE3	SE2	SE1	SE0
				R/W						
				Undefined						
			"0" is read	40 sec.	20 sec.	10 sec.	8 sec.	4 sec.	2 sec.	1 sec.
MINR	Minute register	1321H		MI6	MI5	MI4	MI3	MI2	MI1	MI0
				R/W						
				Undefined						
			"0" is read	40 min.	20 min.	10 min.	8 min.	4 min.	2 min.	1 min.
HOURR	Hour register	1322H			HO5	HO4	HO3	HO2	HO1	HO0
					R/W					
					Undefined					
			"0" is read		20 hours (PM/AM)	10 hours	8 hours	4 hours	2 hours	1 hour
DAYR	Day register	1323H						WE2	WE1	WE0
								R/W		
								Undefined		
			"0" is read					W2	W1	W0
DATER	Date register	1324H			DA5	DA4	DA3	DA2	DA1	DA0
					R/W					
					Undefined					
			"0" is read		20 days	10 days	8 days	4 days	2 days	1 day
MONTHR	Month register	1325H				MO4	MO3	MO2	MO1	MO0
						R/W				
						Undefined				
		PAGE0	"0" is read			10 month	8 month	4 month	2 month	1 month
		PAGE1	"0" is read							0: Indicator for 12 hours 1: Indicator for 24 hours
YEARR	Year register	1326H	YE7	YE6	YE5	YE4	YE3	YE2	YE1	YE0
			R/W							
			Undefined							
		PAGE0	80 years	40 years	20 years	10 years	8 years	4 years	2 years	1 year
		PAGE1	"0" is read						Leap year setting 00: Leap year 01: One year after 10: Two years after 11: Three years after	
PAGER	Page register	1327H (Prohibit RMW)	INTENA			ADJUST	ENATMR	ENAALM		PAGE
			R/W			W	R/W			R/W
			0			Undefined	Undefined			Undefined
			INTRTC 0: Disable 1: Enable	"0" is read		0: Don't care 1: Adjust	Clock enable	Alarm / enable	"0" is read	PAGE setting
RESTR	Reset register	1328H (Prohibit RMW)	DIS1HZ	DIS16HZ	RSTTMR	RSTALM	–	–	–	–
			W							
			Undefined							
			1Hz 0: Enable 1: Disable	16Hz 0: Enable 1: Disable	1: Reset Clock	1: Reset alarm	Always write "0"			

(17) Melody/alarm generator

Symbol	Name	Address	7	6	5	4	3	2	1	0
ALM	Alarm pattern register	1330H	AL8	AL7	AL6	AL5	AL4	AL3	AL2	AL1
			R/W							
			0	0	0	0	0	0	0	0
			Alarm pattern set							
MELALMC	Melody/ alarm control register	1331H	FC1	FC0	ALMINV	–	–	–	–	MELALM
			R/W							
			0	0	0	0	0	0	0	0
			Free run counter control 00: Hold 01: Restart 10: Clear 11: Clear and start		Alarm frequency invert 1: Invert	Always write “0”				Output frequency 0: Alarm 1: Melody
MELFL	Melody frequency L-register	1332H	ML7	ML6	ML5	ML4	ML3	ML2	ML1	ML0
			R/W							
			0	0	0	0	0	0	0	0
			Melody frequency set (Low 8bit)							
MELFH	Melody frequency H-register	1333H	MELON				ML11	ML10	ML9	ML8
			R/W				R/W			
			0				0	0	0	0
			Melody counter control 0: Stop and clear 1: Start				Melody frequency set (Upper 4 bits)			
ALMINT	Alarm interrupt enable register	1334H			–	IALM4E	IALM3E	IALM2E	IALM1E	IALM0E
					R/W					
					0	0	0	0	0	0
					Always write “0”	INTALM4 to INTALM0 alarm interrupt enable				

(18) NAND flash controller (1/2)

Symbol	Name	Address	7	6	5	4	3	2	1	0
ND0FDTR	NAND flash data transfer register	1D00H	D7	D6	D5	D4	D3	D2	D1	D0
			R/W							
			Undefined							
			Data window to read/write NAND flash							
ND0FMCR	NAND flash mode control register	1CC4H	WE	ECC1	ECC0	CE	PCNT1	PCNT0	ALE	CLE
			R/W							
			0	0	0	0	0	0	0	0
			0: Disable write operation 1: Enable write operation	ECC circuit 11 (at <CE>=X): Reset 00 (at <CE>=1): Disable 01 (at <CE>=1): Enable 10 (at <CE>=1): Read ECC data calculated by NDFC 10 (at <CE>=0): Read ID data		Chip enable 0: Disable ($\overline{\text{NDCE}}$ is high) 1: Enable ($\overline{\text{NDCE}}$ is low)	Power Control Always write "11"		Address Latch Enable 0: Low 1: High	Command Latch Enable 0: Low 1: High
ND0FSR	NAND flash status register	1CC8H	BUSY							
			R							
			Undefined							
			0: Ready 1: Busy							
ND0FISR	NAND flash interrupt status register	1CCCH								RDY
										R/W
										0
										Read: 0: None 1: Change NDR/$\overline{\text{B}}$ signal from BUSY to READY. Write: 0: No change 1: Clear to "0"
ND0FIMR	NAND flash interrupt mask register	1CD0H	INTEN							MRDY
			R/W							R/W
			0							0
			0: Disable 1: Enable							Mask for RDY
ND0FSPR	NAND flash strobe pulse width register	1CD4H					SPW3	SPW2	SPW1	SPW0
							R/W			
							0	0	0	0
							Pulse width for $\overline{\text{NDRE}}$, $\overline{\text{NDWE}}$ = f_{SYS} × (This register's value + 1)			
ND0FRSTR	NAND flash reset register	1CD8H								RST
										R/W
										0
										Reset controller
NDCR	NAND flash control register	01C0H	CHSEL							
			R/W							
			0							
			Channel selection 0: Channel 0 1: Channel 1							
ND0ECCRD	NAND flash ECC code register	1CB0H	D7	D6	D5	D4	D3	D2	D1	D0
			R							
			Data window to read ECC code							

(17) NAND flash controller (2/2)

Symbol	Name	Address	7	6	5	4	3	2	1	0
ND1FDTR	NAND flash data transfer register	1D00H	D7	D6	D5	D4	D3	D2	D1	D0
			R/W							
			Undefined							
			Data window to read/write NAND flash							
ND1FMCR	NAND flash mode control register	1CE4H	WE	ECC1	ECC0	CE	PCNT1	PCNT0	ALE	CLE
			R/W							
			0	0	0	0	0	0	0	0
			0: Disable write operation 1: Enable write operation	ECC circuit 11 (at <CE>=X): Reset 00 (at <CE>=1): Disable 01 (at <CE>=1): Enable 10 (at <CE>=1): Read ECC data calculated by NDFC 10 (at <CE>=0): Read ID data		Chip enable 0: Disable ($\overline{\text{NDCE}}$ is high) 1: Enable ($\overline{\text{NDCE}}$ is low)	Power Control Always write "11"		Address Latch Enable 0: Low 1: High	Command Latch Enable 0: Low 1: High
ND1FSR	NAND flash status register	1CE8H	BUSY							
			R							
			Undefined							
			0: Ready 1: Busy							
ND1FISR	NAND flash interrupt status register	1CECH								RDY
										R/W
										0
										Read: 0: None 1: Change NDR/$\overline{\text{B}}$ signal from BUSY to READY. Write: 0: No change 1: Clear to "0"
ND1FIMR	NAND flash interrupt mask register	1CF0H	INTEN							MRDY
			R/W							R/W
			0							0
			0: Disable 1: Enable							Mask for RDY
ND1FSPR	NAND flash strobe pulse width register	1CF4H					SPW3	SPW2	SPW1	SPW0
							R/W			
							0	0	0	0
							Pulse width for $\overline{\text{NDRE}}$, $\overline{\text{NDWE}}$ = f_{SYS} × (This register's value +1)			
ND1FRSTR	NAND flash reset register	1CF8H								RST
										R/W
										0
										Reset controller
ND1ECCRD	NAND flash ECC code register	1CB0H	D7	D6	D5	D4	D3	D2	D1	D0
			R							
			Data window to read ECC code							

(19) I²S

Symbol	Name	Address	7	6	5	4	3	2	1	0
I2SBUFR	I²S FIFO buffer (R)	0800H (Prohibit RMW)	R15/R7	R14/R6	R13/R5	R12/R4	R11/R3	R10/R2	R9/R1	R8/R0
			W							
			Undefined							
			Register for transmitting buffer (FIFO) (Right channel)							
I2SBUFL	I²S FIFO buffer (L)	0808H (Prohibit RMW)	L15/L7	L14/L6	L13/L5	L12/L4	L11/L3	L10/L2	L9/L1	L8/L0
			W							
			Undefined							
			Register for transmitting buffer (FIFO) (Left channel)							
I2SCTL0	I²S control register 0	080EH	TXE	FMT	BUSY	DIR	BIT	MCK1	MCK0	I2SWCK
			R/W		R	R/W				
			0	0	0	0	0	0	0	0
			Transmit 0: Stop 1: Start	Mode 0: I²S 1: SIO	Status 0: Stop 1: Under transmitting	First bit 0: MSB 1: LSB	Bit number 0: 8 bits 1: 16 bits	Baud rate 00: f_{SYS} 10: $f_{SYS}/4$ 01: $f_{SYS}/2$ 11: $f_{SYS}/8$		WS clock 0: fs/4 1: TA1OUT
		080FH	I2SWLVL	EDGE	I2SFSEL	I2SCKE				SYSCKE
			R/W							R/W
			0	0	0	0				0
			WS level 0: Low left 1: High left	Clock edge 0: Falling 1: Rising	Select for stereo 0: Stereo (2 channel) 1: Monaural (1 channel)	Clock enable (After transmit) 0: Operation 1: Stop				System clock 0: Disable 1: Enable

6. Notes and Restrictions

6.1 Notation

(1) The notation for built-in I/O registers is as follows: Register symbol <Bit symbol>

Example: TA01RUN<TA0RUN> denotes bit TA0RUN of register TA01RUN.

(2) Read-modify-write instructions (RMW)

An instruction in which the CPU reads data from memory and writes the data to the same memory location in one instruction.

Example 1: SET 3, (TA01RUN); Set bit3 of TA01RUN.

Example 2: INC 1, (100H); Increment the data at 100H.

- Examples of read-modify-write instructions on the TLCS-900

Exchange instruction

EX (mem), R

Arithmetic operations

ADD (mem), R/#	ADC (mem), R/#
SUB (mem), R/#	SBC (mem), R/#
INC #3, (mem)	DEC #3, (mem)

Logic operations

AND (mem), R/#	OR (mem), R/#
XOR (mem), R/#	

Bit manipulation operations

STCF#3/A, (mem)	RES #3, (mem)
SET #3, (mem)	CHG #3, (mem)
TSET#3, (mem)	

Rotate and shift operations

RLC (mem)	RRC (mem)
RL (mem)	RR (mem)
SLA (mem)	SRA (mem)
SLL (mem)	SRL (mem)
RLD (mem)	RRD (mem)

(3) f_{OSCH}, fc, f_{FPH}, f_{SYS}, f_{IO} and one state

The clock frequency input on pins X1 and 2 is referred to as f_{OSCH}. The clock selected by PLLCR0<FCSEL> is referred as fc.

The clock selected by SYSCR1<SYSCK> is refer to as f_{FPH}. The clock frequency give by f_{FPH} divided by 2 is referred to as system clock f_{SYS}. The clock frequency give by f_{SYS} divided by 2 is referred to as f_{IO}.

One cycle of f_{SYS} is referred to as one state.

6.2 Notes

(1) AM0 and AM1 pins

These pins are connected to the V_{CC} (Power supply level) or the V_{SS} (Grand level) pin. Do not alter the level when the pin is active.

(2) Reserved address areas

The 16 bytes area (FFFFF0H ~ FFFFFFH) cannot be used since it is reserved for use as internal area. If using an emulator, an optional 64 Kbytes of the 16M bytes area is used for emulator control. Therefore, if using an emulator, this area cannot be used.

(3) Standby mode (IDLE1)

When the HALT instruction is executed in IDLE1 mode (in which only the oscillator operates), the internal RTC (Real-time-clock) and MLD (Melody-alarm-generator) operate. When necessity, stop the circuit before the HALT instruction is executed.

(4) Warm-up counter

The warm-up counter operates when STOP mode is released, even if the system is using an external oscillator. As a result, a time equivalent to the warm-up time elapses between input of the release request and output of the system clock.

(5) Watchdog timer

The watchdog timer starts operation immediately after a reset is released. Disable the watchdog timer when is not to be used.

(6) AD converter

The string resistor between the VREFH and VREFL pins can be cut by program so as to reduce power consumption. When STOP mode is used, disable the resistor using the program before the HALT instruction is executed.

(7) CPU (Micro DMA)

Only the “LDC cr, r” and “LDC r, cr” instructions can be used to access the control registers in the CPU. (e.g., the transfer source address register (DMASn).)

(8) Undefined SFR

The value of an undefined bit in an SFR is undefined when read.

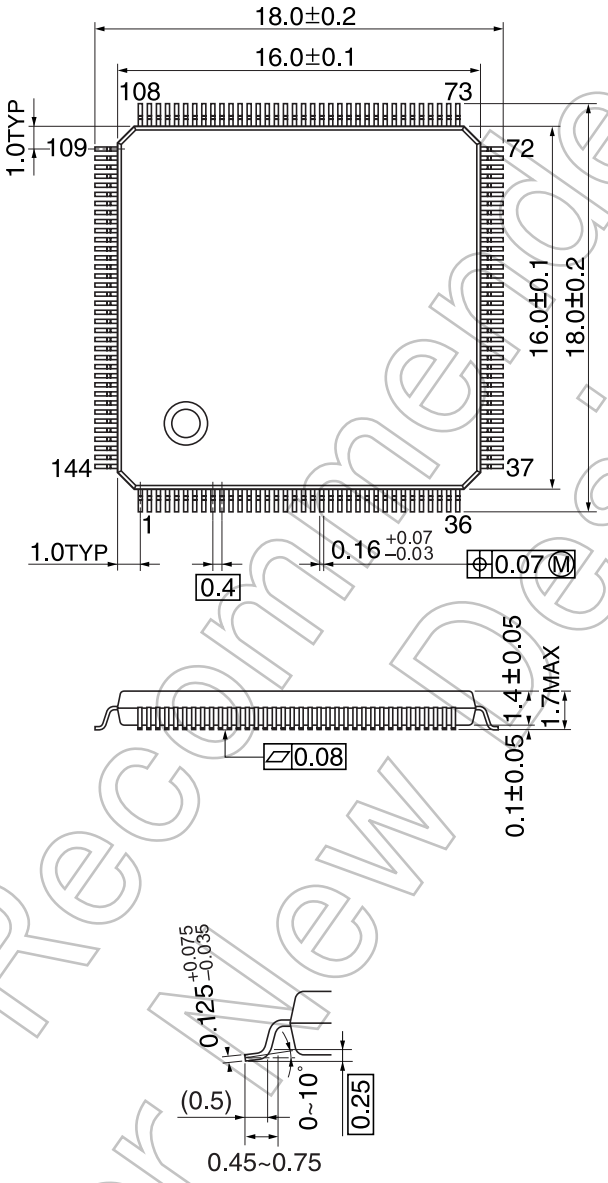
(9) POP SR instruction

Please execute the POP SR instruction during DI condition.

7. Package Dimensions

Package Name: P-LQFP144-1616-0.40C

Unit: mm



Note: Palladium plating